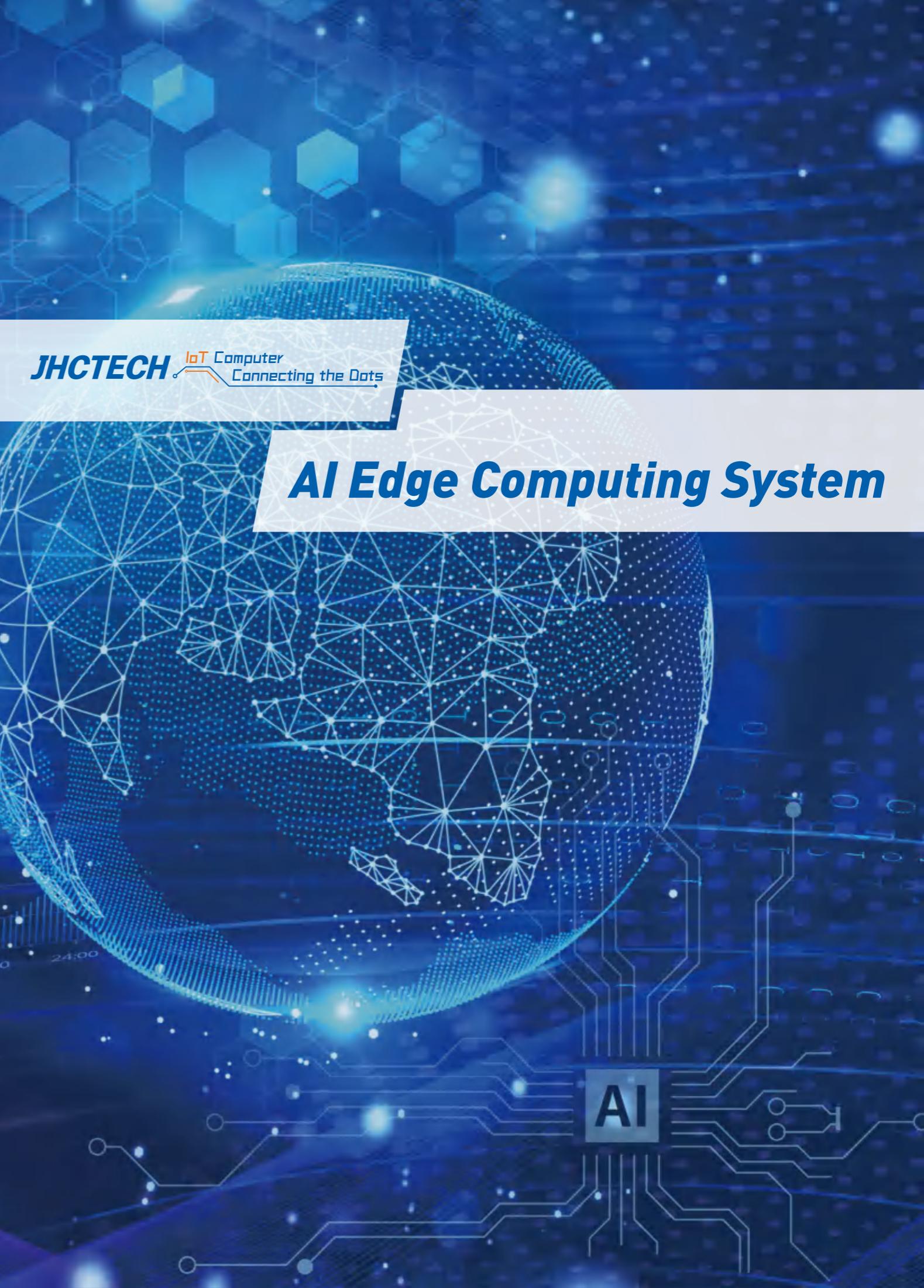




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About JHCTECH

JHCTECH, established in 2002, is an intelligent IoT system supplier with extensive capabilities in research and development, production, sales, and service. With over two decades of experience in the industry and a strong scientific research background, JHCTECH is committed to a strategic approach of "Scenario Empowering Product Innovation". Continuously focusing on developing AI edge computing and system application platforms to usher in the intelligent era of "IoT computer connecting the dots."

JHCTECH offers a diverse range of products and services, including AI edge computing, edge controllers, fanless in-vehicle computers, industrial panel PCs, embedded box computers, domestically produced fanless box computers, industrial control computers, single-board computers, and customized solutions focused on industrial applications and AI value-added services, empowering digital transformation across all industries. These products have passed safety regulations and industry certifications such as 3C, CE, FCC, E-Mark, and EN50155, and are widely used in various fields such as intelligent transportation, digital factories, smart logistics, smart healthcare, energy, and environmental protection.

Corporate Culture

Brand Strategy: Scenario Empowering Product Innovation

Business Philosophy: Focus on the industry, specialize in products, and excel in services

Strategic Slogan: IoT Computer, Connecting the Dots

Core Values: Integrity, gratitude, and responsibility

Corporate Spirit: Customer-centric, tenacious, dedicated, learning, innovative, collaborative, inclusive, altruistic, and virtuous.

Corporate Mission: Committed to building a smarter earth and a more intelligent tomorrow, helping to improve everyone's progress and long-term development, and contributing to the world.

Corporate Vision: Rather lose everything than lose integrity. Become a model of smart IoT ecological and commercial civilization that keeps integrity, emphasizes quality, is courageous and seeks win-win outcomes.

Eight Corporate Values

1.Value: Creating maximum value for users through technological innovation.

2.Strive: Upholding long-termism, striving hard, and enjoying the joy of work.

3.Spirit: All methodologies are measured by core values and corporate spirit.

4.Learning: Learning is vital as all achievements ultimately reflect one's capabilities.

5.Team: Empowering individual growth, activating organizational creativity, and co-building a mutually fulfilling organization.

6.Action: The standard of success is goal achievement; efficiency and action are the keys.

7.Affection: Valuing emotions and principles, opposing egalitarianism and opportunism.

8.Win-Win: Linking symbiosis, synergizing for increased efficiency; achieving success for others, benefiting society as a whole.

BRAV • Edge Computing System A

CNTI • Fanless Computer

KGEC • Edge Controller B

KMDA • Embedded Box Computer C

ECC • Embedded Box PC

ALAD • Industrial Panel PC D

WPPC • Industrial Waterproof Panel PC

SIGM • Fanless In-Vehicle Computer E

ICS • Intelligent control system

SBC • Embedded Single Board Computer F

NODE • NODE Core Module

PADR • IPC-PADR Series

JHCTECH IoT Computer
Connecting the Dots

BRAV
Edge Computing system





APPLICATION

Internet of Vehicles and
Autonomous Driving



AI Automation



AI Medical

AI Security



Products
Listing ----- A01

Acceleration
Module ----- A05

BRAV-7131 ----- A07

BRAV-7201 ----- A09

BRAV-7220 ----- A11

BRAV-7302 ----- A13

BRAV-7501 ----- A15

BRAV-7520 ----- A17

BRAV-7521 ----- A19

BRAV-7601-S ----- A21

BRAV-7601-T ----- A23

BRAV-7720 ----- A25

BRAV-7720-WP ----- A27

BRAV-7721 ----- A29

BRAV-7721-WP ----- A31

CNTI-3A51 ----- A33

CNTI-R351 ----- A35

CNTI-2K10 ----- A37

								
BRAV-7131 (NVIDIA Jetson)	BRAV-7201	BRAV-7220	BRAV-7302	BRAV-7501	BRAV-7520	BRAV-7521	BRAV-7601-S	
System								
CPU	8*cores Arm® Cortex®-A78AE v8.2 64 bit CPU 12*cores Arm® Cortex®-A78AE v8.2 64 bit CPU	6th gen Intel® SkyLake-U Celeron 3855U; Core-U: i3-6100U; i5-6200U; i7-6500U; 7th gen Intel® Kabylake-U Celeron 3865U; Core-U: i3-7100U; i5-7200U; i7-7500U	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W/28W	Intel® Skylake-S Intel® Kabylake-S Celeron/Pentium/Core i3/i5/i7 CPU,LGA 1151 socket, TDP35W/54W/65W/91W with active cooling fan	Intel® Xeon® E or 9th/8th-Gen Core™ i7/i5/i3 LGA1151 processor, up to 8 cores 16 threads	Intel® Xeon® E or 9th/8th-Gen Core™ i7/i5/i3 LGA1151 processor, up to 8 cores 16 threads	Intel® Xeon® E or 9th/8th-Gen Core™ i7/i5/i3 LGA1151 processor, up to 8 cores 16 threads	Intel® Comet lake 10th-Gen Celeron/Pentium/ Corei9/i7/i5/i3 CPU, Intel® Q470 PCH
RAM	S001:32GB; S002:64GB 256 bit LPDDR5	2* DDR4 2133MHz, 32GB max.	2*DDR4 3200MHz, 64GB max.	2* DDR4 2133/2400MHz, 32GB max.	4* DDR4 2666/2400MHz DIMM, 128GB max.	4* DDR4 2666/2400MHz SODIMM, 128GB max.	4* DDR4 2666/2400MHz SODIMM, 128GB max.	2*DDR4 SO-DIMM,2933MHz, 64GB max.
Graphics	S001:NVIDIA Ampere GPU, 1792 Cuda cores+ 56 Tensor Cores; S002:NVIDIA Ampere GPU, 2048 Cuda cores+ 64 Tensor Cores	CPU integrated Intel 9th gen HD Graphics, HEVC/H265 HW HD codec, HDMI: 3940*2160@30Hz, DP: 4096*2160@60Hz	Intel UHD / Iris®Xe Graphics , Supports Intel DeepLearning boost, DirectX12.1, OpenGL 4.6 and OpenCL 3.0; HDMI2.0:4096x2304@60Hz, DP 1.4: 7680x4320@60Hz	Intel Gen. 9 HD Graphics, HEVC/H265 HW, DP/HDMI/VGA (DP&HDMI 4K); 1* MXM3.1(NVIDIA GTX/AMD RX GPU up to 120W, 3*DP & 1*HDMI 4K)	Intel UHD Graphics, DirectX11.1, OpenGL 5.0 and OpenCL 2.1, DP: 4096*2304@60Hz, DP:4096*2304@60Hz, HDMI: 3840*2160@30Hz, 3 independent displays	Intel UHD Graphics, DirectX11.1, OpenGL 5.0 and OpenCL 2.1, DP: 4096*2304@60Hz, DP:4096*2304@60Hz, VGA: 1900*1200@60Hz, 3 independent displays	Intel UHD Graphics, DirectX11.1, OpenGL 5.0 and OpenCL 2.1, 2*HDMI: 4096x2304@24Hz, 1*VGA: 1920*1200@60Hz; 1*MXM3.1, GPU/AI card<190W, 2*DP, 4K display	Intel® UHD Graphics, DirectX12, OpenGL 4.5, 2*HDMI: 4096x2304@24Hz, 1*VGA: 1920*1200@60Hz; 1*MXM3.1, GPU/AI card<190W, 2*DP, 4K display
I/O Interfaces								
LAN	5*Intel I210AT, 10-1000M, NTP	4* Intel I211AT/I210AT, 10-1000M, 1*Intel I219LM, 10-1000M,iVpro	3*Intel I226V, 10M-2.5G ,iAMT 13.0/iVpro	2* / 6* Intel I210AT, 10-1000M; 1*Intel I219LM,10-1000M,iVpro	2* Intel I211AT/I210AT, 10-1000M; 1* Intel I219LM, 10-1000M, iVpro	2* Intel I211AT/I210AT, 10-1000M; 1* Intel I219LM, 10-1000M, iVpro	2* Intel I226V,3*2.5G-LAN, iAMT 13.0/iVpro; 4* Intel I226 with POE+, 10-1000M(S002)	
USB	2*USB3.2 Gen2(10Gbps); 2*USB2.0	4* USB3.0 + 2* USB2.0	2* USB3.2 + 2* USB2.0	4*6* USB3.0 + 2* USB2.0	4*USB3.1 + 6* USB2.0	6* USB3.1 + 2* USB2.0	6* USB3.1 + 2* USB2.0	4* USB3.2(10G)+2*USB2.0+2*USB3.0(optional); 2* USB3.2(S002)
Display	1* HDMI	1* DP + 1* HDMI	1* DP + 1* HDMI	1* DP & HDMI; GPU:3* DP +1* HDMI	2* DP + 1* HDMI	2* DP + 1* VGA	2* DP + 1* VGA	2* HDMI + 1* VGA; GPU 2*DP
Audio	1*Line out, Realtek ALC5640	1* Line out + 1* MIC	/	1* Line out + 1* MIC	1* Line out + 1* MIC	1* Line out + 1* MIC	1* Line out + 1* MIC	1* Line out + 1* MIC,optional audio
Serial Port	2*RS232/422; 2*RS232	2*RS232/422/485 + 4*RS232	2*RS232/422/485	2*RS232/422/485 + 2*RS232	2*RS232/422/485	2*RS232/422/485 + 2*RS232	2*RS232/422/485 + 2*RS232	2*RS232/422/485 + 2*RS232
DIO	8bit DIO, TTL, 2.5KV optical isolation input/output	8-bit TTL programmable input/output; 8-bit 2.5KV input opto-isolator(H:5-24V, L:0-1.5V),input/output	8bit DIO, TTL, 2.5KV optical isolation input/output	16-bit TTL programmable input/output;	8-bit TTL programmable input/output;	16-bit Iso DIO, 8-bit 2.5KV input opto-isolator(H:5-24V, L:0-1.5V), 8-bit 2.5KV output opto-isolator (200mA)	16-bit Iso DIO, 8-bit 2.5KV input opto-isolator(H:5-24V, L:0-1.5V), 8-bit 2.5KV output opto-isolator (200mA)	8 bit TTL, programmable input/output +16 bit TTL, programmable input/output(S002)
Storage								
Storage	64GB eMMC, optional 1*2.5" SATA3; 1*M.2 2280 M-Key(PCIeX4),NVMe; 1*Micro SD	1*2.5" SATA3+ 1*mSATA	1*2.5"SATA3+ 1*mSATA; 2*M.2 M-Key 2280(PCIeX2), NVMe	2*2.5"SATA3 + 1*mSATA	2*3.5"SATA3+1*M.2(S001); 4*2.5"SATA3+1*M.2(S002)	2*2.5"SATA3; 1*M.2 NVMe	4*2.5"SATA3; 1*M.2, NVMe	2*2.5"SATA3 HDD(RAID0,1),15mm; 1*M.2 2280 M-Key(PCIeX4), NVME; 1*mSATA(optional)
Expansion								
Expansion Port	1*Mini PCIe(PCIeX2+USB+SIM), 4G LTE/LAN/CAN; 1*M.2 3052 B-Key(PCIeX2+USB+SIM), 4G LTE/5G; 1*M.2.2280 M-Key(PCIeX4), NVMe/AI module 1*M.2 2230 E-Key(PCIeX1+USB), WiFi6/BT5.0	1*Mini PCIe with SIM slot 1*M.2 B-Key 3042(PCIe X1/USB+SIM),4G LTE 1*M.2 B-Key 3052(PCIe X1/USB+SIM),4G LTE/5G 1*M.2 M-Key 2280(PCIe4.0X2), NVMe/AI module 1*M.2 M-Key 2280(PCIe3.0X2), NVMe/AI module	1*M.2 B-Key 3042(PCIe X1/USB+SIM),4G LTE 1*M.2 B-Key 3052(PCIe X1/USB+SIM),4G LTE/5G 1*M.2 M-Key 2280(PCIe4.0X2), NVMe/AI module 1*M.2 M-Key 2280(PCIe3.0X2), NVMe/AI module	1*Mini PCIe with SIM slot; 1*M.2 with SIM slot, 1* full size mSATA; 1*half size Mini PCIe, 1*M.2 M-Key 2280(PCIe4.0X2), NVMe/AI module 1*M.2 M-Key 2280(PCIe3.0X2), NVMe/AI module	1*Mini PCIe(PCIeX1/USB+SIM); 2*PCle3.0X16(1*PCIe X16 or 2*PCIe X8) up to NVIDIA 3080Ti FE; 2*PCle3.0X8(X4)	1*Mini PCIe(PCIeX1/USB+SIM,BIOS to mSATA); 1*M.2 E-Key(+SIM),WiFi6/BT5.0; 1*M.2 B-Key(+SIM),5G NR; 1*M.2 M-Key(PCIe3.0X4),NVMe; 1*PCle3.0X16(X16),GPU<350W<300mm 1*PCle3.0X16(x4), AI card<75W<300mm	1*Mini PCIe(PCIeX1/USB+SIM,BIOS to mSATA); 1*M.2 E-Key(+SIM),WiFi6/BT5.0; 1*M.2 B-Key(+SIM),5G NR; 1*M.2 M-Key(PCIe3.0X4),NVME; 2*PCle3.0X16(X8),GPU<350W<300mm 1*PCle3.0X16(x4), AI card	1*Mini PCIe(USB2.0+SIM),mSATA/4G LTE; 1*M.2 2230 E-key(PCIeX1/USB+CNVio), WiFi6/BT5.0; 1*M.2 3052 B-key(PCIeX1/USB+SIM), 5G/4G LTE; 1*M.2 2280 M-Key(PCIeX4), NVME/PCIe; 1*M.2 2230 E-Key(PCIeX1+USB), WiFi6/BT5.0; 1*MXM3.1(PCIeX16),up to 190W; JHC TECH-02 E/IO, 2*PCIeX4, 2*USB3.2, 2*USB2.0
Power Supply								
Pwr Consumption	DC9-36V; DC out 12V 3A(Max); 50.4W (Jetson AGX Orin 32GB)	DC9-30V; 24W (i3-6100 CPU 4G DDR4)	DC9-36V; 38.4W (i5-1135G7 CPU/16G DDR4/256G SSD)	DC6-48V; 144W (35W CPU+78W GPU)	24-pin ATX/8-pin ATX 12V, 600W power supply	DC 12V 5-pin Term; Consumption:12V/27A (i7-8700 CPU 32GB DDR4 single 2080TI GPU)	DC 12V 5-pin Term. Consumption: 12V/47A (i7-8700 CPU 32GB DDR4 dual 2080TI GPU)	DC 9-36V 3-pin, with short circuit protection, over voltage& over current protection
Mechanical								
Structure	Fan cooling design, SGCC chassis	Aluminum Case, SGCC chassis	Aluminum Case,SGCC chassis	Aluminum Case, SGCC chassis	Aluminum-magnesium alloy, SGCC chassis	Aluminum-magnesium alloy, SGCC chassis	Aluminum-magnesium alloy, SGCC chassis	Temperature controlled fan,SGCC
Dimension (W*H*D)	256.4*168*86.5mm	225*144.3*87.5mm	326.4*183*96.6mm	255*222*84.1mm	150*309*375mm	230*350*160mm	230*350*210mm	284*222*82mm
Net Weight	3.25KG	2.2kg	4.67KG	4.62kg	8.14kg	7.5kg	8.3kg	6.70kg
Environmental								
Operating Temp	-20°C~60°C,with air flow	-25°C~60°C,Fanless, SSD, with air flow, -10°C~50°C,Fanless, HDD, with air flow	-20°C~70°C,with air flow(CPU,non VPU); -20°C~60°C,with air flow(CPU+2*VPU)	-25°C~50°C - 65W CPU+78W GPU -25°C~40°C - 91W CPU+120W GPU	-25~50°C, SSD, with air flow	-25~60°C, SSD, with air flow	-25~60°C, SSD, with air flow	-20~60°C, SSD, airflow
Storage Temp	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C
Storage Humidity	10~90%@40°C, Non-condensing	10~90%@40°C, No-condensation	10~95%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No condensation
Vibration	5 grms/5~500Hz/random/during operation(SSD);5 grms/5~500Hz/random/during operation(SSD);5 grms/5~500Hz/random/during operation(HDD);1 grms/5~500Hz/random/during operation(HDD)	1 grms/5~500Hz/random/during operation(HDD)	1 grms/5~500Hz/random/during operation(HDD)	1 grms/5~500Hz/random/during operation(HDD)	5grms/5~500Hz/random/during operation(SSD); 1grms/5~500Hz/random/during operation(HDD)	5grms/5~500Hz/random/during operation(SSD); 1grms/5~500Hz/random/during operation(HDD)	5grms/5~500Hz/random/during operation(SSD); 1grms/5~500Hz/random/during operation(HDD)	5grms/5~500Hz/random/during operation(SSD); 1grms/5~500Hz/random/during operation(HDD)
Shock	50g peak acceleration(duration;11ms)(SSD); 20g peak acceleration(duration;11ms)(HDD)	50g peak acceleration(duration;11ms)(SSD); 20g peak acceleration(duration;11ms)(HDD)	50g peak acceleration(duration;11ms)(SSD); 20g peak acceleration(duration;11ms)(HDD)	50g peak acceleration(duration;11ms)(SSD); 20g peak acceleration(duration;11ms)(HDD)	50g peak acceleration(duration;11ms)(SSD); 20g peak acceleration(duration;11ms)(HDD)	50g peak acceleration(duration;11ms)(SSD); 20g peak acceleration(duration;11ms)(HDD)	50g peak acceleration(duration;11ms)(SSD); 20g peak acceleration(duration;11ms)(HDD)	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)
Certification/EMC	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A
OS	Linux Ubuntu 18.04/20.04 with JetPack	Linux Fedora Ubuntu	Windows 10 64 bit,Windows 11 64 bit, SUSE, Linux, Wind River	Windows 7, Windows 10, Linux Fedora Ubuntu	Windows10/Windows Server 2016 (Intel® Xeon® E) Ubuntu/SuSe/Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R)	Windows10/Windows Server 2016 (Intel® Xeon® E) Ubuntu/SuSe/Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R)	Windows10/Windows Server 2016 (Intel® Xeon® E) Ubuntu/SuSe/Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R)	Windows 10 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7

							
BRAV-7601-T	BRAV-7720-S001	BRAV-7720-WP	BRAV-7721-S001	BRAV-7721-WP	CNTI-3A51 (Loongson 3A5000)	CNTI-R351 (Rockchip RK3588)	CNTI-2K10
System							
CPU	Intel® Comet lake 10th-Gen Celeron/Pentium/Core i9/i7/i5/i3 CPU, Intel® Q470 PCH	Intel® Alder lake-S 12th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® Q670 PCH	Intel® Alder lake-S 12th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® Q670 PCH	Intel® Alder lake-S 12th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® Q670 PCH	Intel® Alder lake-S 12th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® Q670 PCH	Loongson3A5000, 4 Cores, 2.3GHz-2.5GHz, LSTA1000 PCH	Rockchip RK3588, 4 Cortex-A76 and 4 Cortex-A55, 2.4GHz
RAM	2*DDR4 SO-DIMM, 2933MHz, 64GB max.	2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.	2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.	2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.	2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.	2*288 Pin DIMM, DDR4 3200MHz, 64GB max.	Onboard memory, 4GB LPDDR4
Graphics	Intel® UHD Graphics, support DirectX 12, OpenGL 4.5, OpenCL 3.0, 2*HDMI 1.4: 4096x2304@24Hz 1*VGA: 1920x1200@60Hz	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0, DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, 3 independent displays	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0, DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, 3 independent displays	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0, DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, 3 independent displays	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0, DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, 3 independent displays	Nuclear display	Mali-G610 GPU, OpenGL ES3.2/OpenCL2.2/Vulkan1.1, 2D&3D acceleration hardware; HDMI:1920*1080@60Hz NPU:6 TOPS, INT4/INT8/INT16/FP16
I/O Interfaces							
LAN	3*Intel I226V,3*2.5G-LAN,iAMT 13.0/iVpro; 4* Intel I226V with POE+, 10-1000M(T002)	2* Intel I226V, 10-1000M; 1* Intel I219LM,10-1000M, iAMT 12.0	2* Intel I226V, 10-1000M; 1* Intel I219LM,10-1000M, iAMT 12.0	2* Intel I226V, 10-1000M; 1* Intel I219LM,10-1000M, iAMT 12.0	2* Intel I226V, 10-1000M; 1* Intel I219LM,10-1000M, iAMT 12.0	2*88E1512, 10-1000M	2*RTL8211F, 10-1000M; 2*RTL8111H,10-1000M
USB	4* USB3.2(10G)+2*USB2.0; 2* USB3.2(5G,T002)	4* USB3.2(10G)+2*USB3.0(5G)	4* USB3.2(10G)+2*USB3.0(5G)	4* USB3.2(10G)+2*USB3.0(5G)	4* USB3.2(10G)+2*USB3.0(5G)	4* USB3.0 + 2* USB2.0	2*USB2.0
Display	HD graphics 2* HDMI + 1* VGA	1* DP+1*HDMI+1* VGA	1* DP+1*HDMI+1* VGA	1* DP+1*HDMI+1* VGA	1* DP+1*HDMI+1* VGA	1* HDMI + 1* VGA	/
Audio	1* Line out + 1* MIC,Realtek ALC662VD	/	/	/	/	1*Line out+1*MIC, Realtek ALC269Q-VC	/
Serial Port	2*RS232/422/485 + 2*RS232	2*RS232/422/485	2*RS232/422/485	2*RS232/422/485	2*RS232/422/485	12*RS232/422/485(3*DB44)	1*RS232+1*RS485; 2*CAN (CAN Open2.0,DB9)
DIO	T001: 8 bit TTL, programmable input/output; T002: 8 bit TTL, programmable input/output, 8 bit PNP/NPN 2.5KV input/output	Optional 16bit DIO, TTL, programmable input/output	Optional 16bit DIO, TTL, programmable input/output	Optional 16bit DIO, TTL, programmable input/output	Optional 16bit DIO, TTL signal, programmable input/output	24bit isolated DIO(12bit DI, 12bit DO)	1*8 bit DIO(DB9)
Storage							
Storage	2*2.5"SATA3 HDD(support RAID0,1), max support dual 15mm HDD, 1* M.2 2280 M-Key(Pcie4.0X4), NVMe, 1*mSATA(optional)	2*2.5"SATA3 HDD(RAID0/1), 15mm thickness, 1*M.2 2280 M-Key(Pcie4.0X4), NVMe, 1*mSATA(optional)	2*2.5"SATA3 HDD(RAID0/1), 15mm thickness, 1*M.2 2280 M-Key(Pcie4.0X4), NVMe, 1*mSATA(optional)	2*2.5"SATA3 HDD(RAID0/1), 15mm thickness, 1*M.2 2280 M-Key(Pcie4.0X4), NVMe, 1*mSATA(optional)	2*2.5"SATA3 HDD(RAID0/1), 15mm, 1*M.2 2280 M-Key(Pcie4.0X4), NVMe, 1*mSATA(optional)	2*2.5"SATA3; 1*M.2 M-Key 2280(Pcie2.0X4), NVMe	Onboard 32G eMMC, 1*M.2 2242 M-key, NVMe
Expansion							
Expansion Port	1*Mini PCIe(USB2.0+SIM), mSATA/4G LTE; 1*M.2 2230 E-key(PcieX1/USB+CNVio), WiFi6/BT5.0; 1*M.2 3052 B-key(PcieX1/USB+SIM), 5G/4G LTE; 1*M.2 2280 M-Key(PcieX4), NVME/PCIe; 1*MXM3.1, MLU220-MXM AI card; JHCTECH-02 E/I: 2*PCleX4, 2*USB3.2, 2*USB2.0	1*Mini PCIe(PcieX1/USB+SIM), 4G LTE/PCIe; 1*Mini PCIe(PcieX1/SATA),mSATA; 1*M.2 3052 B-Key(PcieX1/USB+SIM),5G NR; 1*M.2 2280 M-Key(Pcie4.0X4), NVMe; 1*PCle5.0X16(X16),GPU<450W<300mm 1*PCle4.0X16(X4),AI card<75W<300mm	1*Mini PCIe(PcieX1/USB+SIM), 4G LTE/PCIe; 1*Mini PCIe(PcieX1/SATA),mSATA; 1*M.2 3052 B-Key(PcieX1/USB+SIM),5G NR; 1*M.2 2280 M-Key(Pcie4.0X4), NVMe; 1*PCle5.0X16(X16),GPU<450W<300mm; 1*PCle4.0X16(X4),AI card<75W<300mm	1*Mini PCIe(PcieX1/USB+SIM), 4G LTE/PCIe; 1*Mini PCIe(PcieX1/SATA),mSATA; 1*M.2 3052 B-Key(PcieX1/USB+SIM),5G NR; 1*M.2 2280 M-Key(Pcie4.0X4), NVMe; 1*PCle5.0X16(X8),GPU<450W<300mm; 2*PCle5.0X16(X8),GPU<450W<300mm; 2*PCleX16(4.0X4+3.0X4),AI card<75W<300mm	1*Mini PCIe(PcieX1/USB+SIM), 4G LTE/PCIe; 1*Mini PCIe(PcieX1/SATA),mSATA; 1*M.2 3052 B-Key(PcieX1/USB+SIM),5G NR; 1*M.2 2280 M-Key(Pcie4.0X4), NVMe; 1*PCle5.0X16(X8),GPU<450W<300mm; 2*PCleX16(4.0X4+3.0X4),AI card<75W<300mm	1*M.2 2280 M-Key(Pcie2.0X4), NVMe	1*Full size Mini PCIe(+SIM), 4G LTE; (Opt.) onboard WiFi6/BT5.0
Power Supply							
Pwr Consumption	DC 9-36V 3-pin, with short circuit protection, over voltage& over current protection	DC 12V, 1000W max. ; TDP:TBD	DC 9-55V, 600W max. ; TDP:TBD	DC 12V 5-pin 1000W max. ; TDP:TBD	DC 9-55V , 1000W max. ; TDP:TBD	DC 12-36V; TDP: TBD	DC 9-36V ; TDP:TBD
Input Voltage							
Mechanical							
Structure	Aluminum chassis, SGCC	SGCC frame, Aluminum-magnesium alloy chassis, temperature control by PWM fan	SGCC frame, Aluminum-magnesium alloy chassis, temperature control by PWM fan	SGCC frame, Aluminum-magnesium alloy chassis, temperature control by PWM fan	SGCC frame, Aluminum-magnesium alloy chassis, temperature control by PWM fan	Aluminum chassis, SGCC	Aluminum-magnesium alloy, SGCC frame
Dimension (W*H*D)	284*222*80.5mm	195*374.7*254.8mm	262*374.7*178mm	245*376.8*254.8mm	230*350*210mm	312*220*78mm	169*100*44.2mm
Net Weight	6.40kg	TBD	TBD	TBD	TBD	TBD	0.82KG
Environmental							
Operating Temp	-20~60°C, SSD, airflow	-20~60°C, SSD, with air flow	-20°C~60°C, SSD ,with air flow;	-20~60°C, SSD, air flow			
Storage Temp	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C
Storage Humidity	10~90%@40°C, No condensation	10~95%@40°C, No-condensation	10~95%@40°C, Non-condensing				
Vibration	5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(HDD); 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD)	5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD)	5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD)	5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD)	5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD)	5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD)	5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 5grms/5~500Hz/random/during operation(SSD); 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD) 1grms/5~500Hz/random/during operation(HDD)
Shock	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)
Certification/ EMC	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A
OS	Windows 10 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7	Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7	Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7	Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7	Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7	UOS / KylinOS / LOONGNIX / openEuler	Android, Linux
							Buildroot / OpenHarmony / Loongnix / SylixOS

Optional AI card/GPU

MLU220-MXM



Port Type	MXM 3.1 (PCIe3.0 X2)
RAM	8GB, LPDDR4x 64bit, 3200Mhz
AI Comp Pwr	16TOP(INT8)
Pwr Cosumption	16.5W
Surface temp	-20~70 °C
Heat dissipation	Passive cooling
Dimension	70*82mm (non cooler)

MLU220-M.2



Port Type	M.2 2280, B+M key (PCIe3.0 X2)
RAM	LPDDR4x 64bit, 4GB
AI Comp Pwr	8TOPS(INT8)
Pwr Cosumption	8.25W
Surface temp	-20~80 °C
Heat dissipation	Passive cooling
Dimension	80*22mm*[7.3mm(non cooler)/21.3mm (with cooler)]

Optional AI card/GPU

Goldwasser-L128



Port Type	PCIe3.0X16
RAM	32/64GB
AI Comp Pwr	128TOPS(INT8)
Pwr Cosumption	40W
Surface temp	0~50 °C
Shape	Half height and half length,single slot
Heat dissipation	Passive cooling
Dimension	167.65*68.9mm

Goldwasser-L256



Port Type	PCIe3.0X16
RAM	32/64GB
AI Comp Pwr	256TOPS(INT8)
Pwr Cosumption	70W
Surface temp	0~50 °C
Shape	Half height and half length, single slot
Heat dissipation	Passive cooling
Dimension	167.65*68.9mm

MLU370-S4



Port Type	PCIe4.0X16
RAM	24GB
AI Comp Pwr	192TOPS(Dense, INT8)
Pwr Cosumption	75W
Surface temp	0~50 °C
Shape	Half height and half length, single slot
Heat dissipation	Passive cooling
Dimension	68.9*167.5mm

MLU370-X4



Port Type	PCIe4.0X16
RAM	24GB
AI Comp Pwr	256TOPS(Dense, INT8)
Pwr Cosumption	150W
Surface temp	0~45 °C
Shape	Full height and full length, single slot
Heat dissipation	Passive cooling
Dimension	111.5*266.7mm

Goldwasser-UL32/64



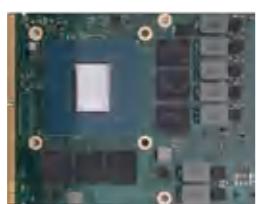
Port Type	PCIe2.0X4	PCIe3.0X4
RAM	2/4GB	4/8GB
AI Comp Pwr	32TOPS(INT8)	64TOPS(INT8)
Pwr Cosumption	28W	35W
Surface temp	-20~60 °C	-20~60 °C
Shape	Half height, single slot	Half height, single slot
Heat dissipation	Passive cooling	Passive cooling
Dimension	114.2*68.9mm	114.2*68.9mm

Goldwasser-UL32/64-MXM



Port Type	PCIe2.0X4	PCIe3.0X4
RAM	4/8GB	8/16GB
AI Comp Pwr	32TOPS(INT8)	64TOPS(INT8)
Pwr Cosumption	10W	15W
Surface temp	-20~55 °C	-20~55 °C
Shape	MXM,TYPE-A	MXM,TYPE-A
Heat dissipation	Active/Passive cooling	Active/Passive cooling
Dimension	82*70mm	82*70mm

CFI-3060-MXM



Port Type	MXM 3.1 (PCIe4.0)
RAM	12GB, GDDR6, 192bit, 15Gbps
AI Comp Pwr	210GFLOPS(FP64)/13TFLOPS(FP32)/12TFLOPS(FP16)
CUDA	3584
Surface temp	-20~55 °C
Pwr Cosumption	140W
Heat dissipation	Passive cooling
Dimension	105*82mm

CFI-1660S-MXM



Port Type	MXM 3.1 (PCIe3.0)
RAM	6GB, GDDR6, 192bit, 14Gbps
AI Comp Pwr	157GFLOPS(FP64)/5TFLOPS(FP32)/10TFLOPS(FP16)
CUDA	1048
Surface temp	-20~55 °C
Pwr Cosumption	95W
Heat dissipation	Passive cooling
Dimension	105*82mm

MR V50



Port Type	PCIe4.0X16
RAM	16GB HBM2E
AI Comp Pwr	256TOPS(INT8), 64TFLOPS(FP32), 16TFLOPS(FP16)
Pwr Cosumption	75W
Surface temp	0~50 °C
Shape	PCIe, Half height and half length
Heat dissipation	Passive cooling
Dimension	68.9*167.5mm

MR V100



Port Type	PCIe4.0X16
RAM	32GB HBM2E
AI Comp Pwr	384TOPS(INT8), 96TFLOPS(FP32), 24TFLOPS(FP16)
Pwr Cosumption	150W
Surface temp	0~45 °C
Shape	PCIe, Full height and full length
Heat dissipation	Passive cooling
Dimension	111.5*266.7mm

BRAV-7131

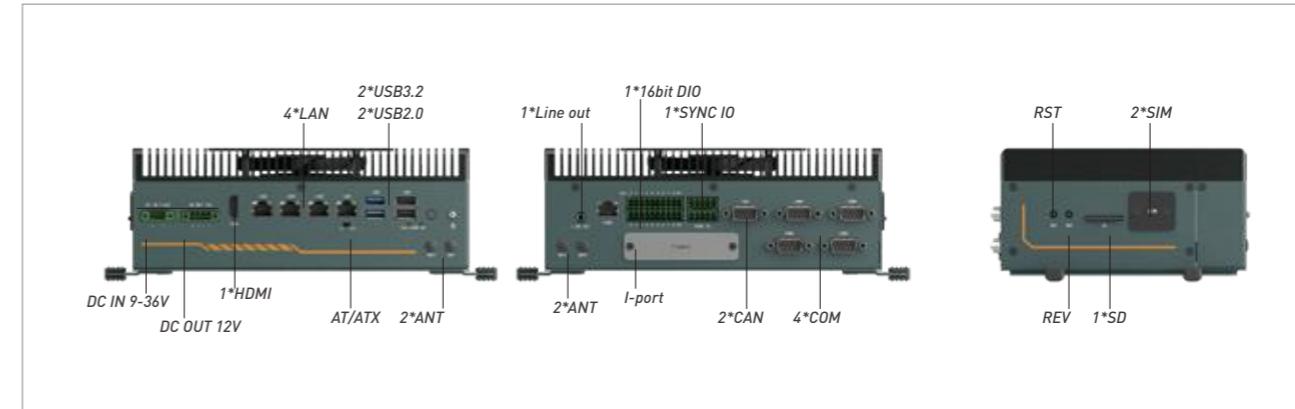
NVIDIA Jetson AGX Orin 32/64GB, 5*LAN, 2*USB3.2, 2*USB2.0, 4*COM, 2*CAN, 1*16-bit DIO, 1*HDMI, Time SYNC, DC 9~36V

Key Specification

- NVIDIA Jetson AGX Orin 32/64G, 200/275TOPS
- 8/12*cores ARM Cortex-A78AE CPU, 2.2GHz
- NVIDIA Ampere GPU with Tensor Cores
- Onboard 32/64G 256bit LPDDR5 Ram and 64GB eMMC, 1*M.2 M-Key NVME and optional 1*2.5"SATA bay
- 1*HDMI, 1*Audio Line-out, 5*LAN, 2*USB3.2, 2*USB2.0,
- 4*COM, 2*CAN, 16-bit DIO, 1*SYNC IO
- 1*Mini PCIe and 1*M.2 B-Key support 4G LTE or 5G NR, 1*M.2 E-Key support WiFi&BT wireless routes
- DC9~36V wide power input, with OVP,OCP and SCP
- Aluminum-magnesium alloy chassis, Fan cooling design



I/O View



Product Overview

BRAV-7131 is equipped with NVIDIA Jetson AGX Orin 32/64GB module, 8/12 cores ARM CPU and high performance GPU, up to 200/275TOPS AI performance, onboard 32/64G memory and 64G storage, multichannel IO and clock synchronization, DC 9~36V wide voltage power supply. It can be used as MEC(Multi-Access Edge Computing) for intelligent transportation, machine vision, intelligent logistics and other industries.

Product Parameters

System

Processor 8*cores Arm® Cortex®-A78AE v8.2 64 bit CPU, 2.2 GHz(S001)
12*cores Arm® Cortex®-A78AE v8.2 64 bit CPU, 2.2 GHz(S002)

RAM Onboard 32GB(S001)/64GB(S002) 256 bit LPDDR5, 204.8 GB/S max.
1792*cores NVIDIA Ampere GPU 930MHz, 56*Tensor Cores(S001)

2048*cores NVIDIA Ampere GPU 1.3GHz, 64*Tensor Cores(S002)
Video code (H.265)H.264, AV1:

1*4K60,3*4K30,6*1080p60,12*1080p30 (S001);
2*4K60,4*4K30,8*1080p60,16*1080p30 (S002);
Video code (H.265)H.264, VP9, AV1:
1*8K30,2*4K60,4*4K30,9*1080p60,18*1080p30(S001);
1*8K30,3*4K60,7*4K30,11*1080p60,22*1080p30(S002);

DL/VS Accelerator 2*NVDLA v2,PVA v2.0, AI performance up to 200(S001)/
275(S002) TOPS(INT8)

LAN 5*Intel I210AT, 10-1000M, NTP;

USB 2*USB3.2(10G), 2*USB2.0

Display 1*HDMI(4096*2304@60Hz)

COM/others 2*RS232/422/485(DB9); 2*RS232; 2*CAN;
1*Sync IO(GPS/BDS clock timing); optional 1*MIPI CSI 60pin

DIO 16bit DIO, TTL, 2.5KV isolated input/output

Storage Onboard 64GB eMMC 5.1; optional 1*2.5" SATA3.0;
2*M.2 2280 M-Key(PCleX4), NVMe; 1*Micro SD

LED 1*PowerLED, 1*HDD LED, 1*CPU Temp LED

Control Switch 1*Power SW, 1*RST, 1*AT/ATX, 1*REV

OS Linux Ubuntu 18.04 and 20.04 with JetPack

Expansion 1*Mini PCIe(PCle X1/USB2.0+SIM), 4G LTE/CAN;
1*M.2 3052 B-Key(PCle X1/USB2.0+SIM), 4G LTE/5G NR;
1*M.2 2280 M-Key(PCleX4), NVMe/AI Cards;
1*M.2 2230 E-Key(PCleX1/USB2.0), WIFI6/BT5.0

Power requirement DC IN 9~36V, with short circuit, over voltage and over current protection;
50.4W (Jetson AGX Orin 32GB)

Mechanical

Structure Aluminum-magnesium alloy chassis, fan cooling, SGCC frame

Color Granite gray + Graphite black

Mounting Desktop mounting with anti-vibration rubber pads

Dimension 256.4*168*86.5mm(W*H*D)

Net weight 3.25KG

Environmental

Operating Temp -20°C~60°C, with air flow

Storage Temp -40°C~85°C

Storage Humidity 10~90%@40°C, No-condensation

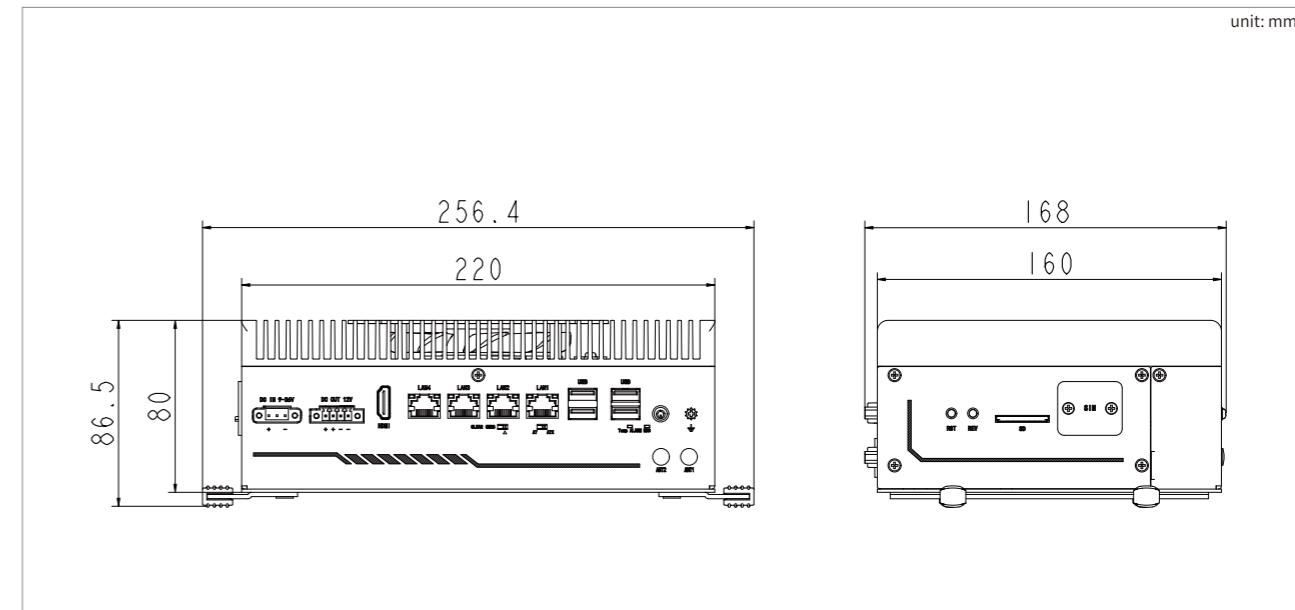
Vibration 5 grms/5~500Hz/random/during operation(SSD);
1 grms/5~500Hz/random/during operation(HDD)

Shock 50g peak acceleration(11ms duration)(SSD);
20g peak acceleration(11ms duration)(HDD)

Certification CE/FCC Class A

EMC

Dimensions



Ordering Information

Model	Core	Specifications
BRAV-7131/S001	Jetson AGX Orin 32GB, 64GB eMMC	1*HDMI, 5*RJ45, 2*USB3.2, 2*USB2.0, 2*Iso. RS232/422, 2*RS232, 2*Iso. CAN, 1*16-bit Iso. DIO, 1*Sync IO, 1*Line out, 1*Mini PCIe w/SIM, 1*M.2 B-Key w/SIM, 1*M.2 E-key, 1*M.2 M-Key, 1*Micro SD, 1*I-port, Optional 1*2.5"SATA Bay, DC-IN 9~36V, DC-OUT 12V
BRAV-7131/S002	Jetson AGX Orin 64GB, 64GB eMMC	AC/DCpower adapter, DC19V@6.32A 120W
PA-120DC19		AC/DCpower adapter, DC24V@9.17A 220W(When DC-OUT 12V is used.)
PA-220DC24		

BRAV-7201

Intel Skylake-U/Kabylake-U CPU, 5*LAN, 6*USB, 6*COM, support dual 4K display, 8+16-bit Iso DIO,iVpro tech, DC 9~30V, CPU LED Temp Display.

Key Specification

- Aluminium case, fanless box air cooling design
- Intel Skylake-U/Kabylake-U CPU
- 2*DDR4 2133MHz SODIMM RAM, max 32GB
- 1*HDMI and 1*DP, support dual 4K display port
- 5*Gig LAN, 4*USB3.0, 3*USB2.0(1 internal)
- 6*COM, 16-bit Iso DIO, Audio out & Mic
- 1*Mini PCIe(PCle+USB)full size
- 1*mSATA, 1*2.5" SATA Shock Absorber drive bay
- Support iVpro and optional support TPM 2.0 encryption
- DC 9~30Vwide range power supply input, overcurrent, overvoltage, short circuit and reverse connection protection



Product Overview

BRAV-7201 is a new industrial computer design that comes with aluminum profile case and fanless box. Equipped with Intel Skylake-U / Kabylake-U processor, BRAV-7201 supports iVpro technology and optional support on TPM2.0 hardware encryption technology, with high reliability of 9-30V wide range voltage power supply, which are widely used in the artificial intelligence, machine vision and robotics industries.

Product Parameters

System

CPU 6th gen Intel Skylake-U Celeron 3855U; Core-U: I3-6100U ; I5-6200U; I7-6500U 7th gen Intel Kabylake-U Celeron 3865U; Core-U: I3-7100U ; I5-7200U; I7-7500U

RAM 2*260-Pin SODIMM, dual DDR4 2133MHz, max 32GB

Expansion 1* full size Mini PCIe with PCIe X1+USB signal SIM slot;

Graphics CPU integrated Intel Gen. 9th HD Graphics, HEVC/H265 HW HD codec, HDMI max res. 3940*2160@30Hz, DP max res. 4096*2160@60Hz

Audio Optional support Realtek ALC662VD HD audio, support 5.1 soundtrack

LAN 2*Intel I210AT, 2*Intel I211AT(optional I210AT)Gig. Ethernet, 10/100/1000Mbps self-adaptive; 1*Intel I219LM support vPro tech

Storage 1*2.5" shock absorber drive bay, SATA3 6.0Gbps HDD/SDD; 1*mSATA full size, support AHCI mode

DIO 8-bit TTL programmable input/output, 8-bit 2.5KV input opto-isolator (H:5-24V, L:0-1.5V), 8-bit 2.5KV output opto-isolator(100mA)

I/O port 1*HDMI and 1*DP, 5*RJ45 Gig-LAN , 4*USB3.0 ,2*USB2.0 ,1*USB2.0 internal, 2*5Pin Phoenix terminal (8-bit DIO), 1*10pin Phoenix terminal (8-bit Iso DIO), 1*10pin Phoenix terminal (8-bit Iso DO), 2*RS232/422/485 DB9 male connector, 4*RS232 DB9 male connector, 1*Audio-out and 1*MIC

LED 1*Power LED indicator, 1*HDD LED indicator, 3*CPU TEMP grade LED indicator (Red as warning, Yellow as high temp, Green as norm temp)

Control Switch 1*Power button, 1*2pin terminal switch signal, 1*AT/ATX switch

Pwr Supply DC IN 9~30V, 3pin terminal, with reverse connection, short circuit, over voltage and over current protection Cosumption: 24W (I3-6100U CPU 4G DDR4)

OS Linux Fedora Ubuntu

Watchdog Programmable timeout interruption period or system reset from , Timer(WDT) 1 to 255 secs

Cambricon AI module (optional)

Model MLU220-M.2

RAM 4GB, LPDDR4x 64bit, 3200Mhz

AI computing 8TOPS (INT8)

Codec capability Support H.264 , HEVC (H.265) , VP8, VP9

Picture decoding Coding performance:support 16X 1080P @30fps

Decoding performance: support 8X 1080P@30fps

Port M.2 2280, B+M key (PCIe3.0 X2)

Pwr supply & heat dissipation 8.25W / Passive cooling

Mechanical

Structure Aluminum, heat dissipation case, SGCC coated on panel surface

Color Graphite black + granite gray

Installation Desktop Installation

Dimension (W*H*D):225*144.3*87.5mm

Net weight 2.2kg

Environmental

Operating Temp -25°C~60°C – fanless, with wide temp SSD, with air flow -10°C~50°C – fanless, with norm temp HDD, with air flow

Storage Temp -40°C~85°C

Storage Humidity 10~90%@40°C, No-condensation

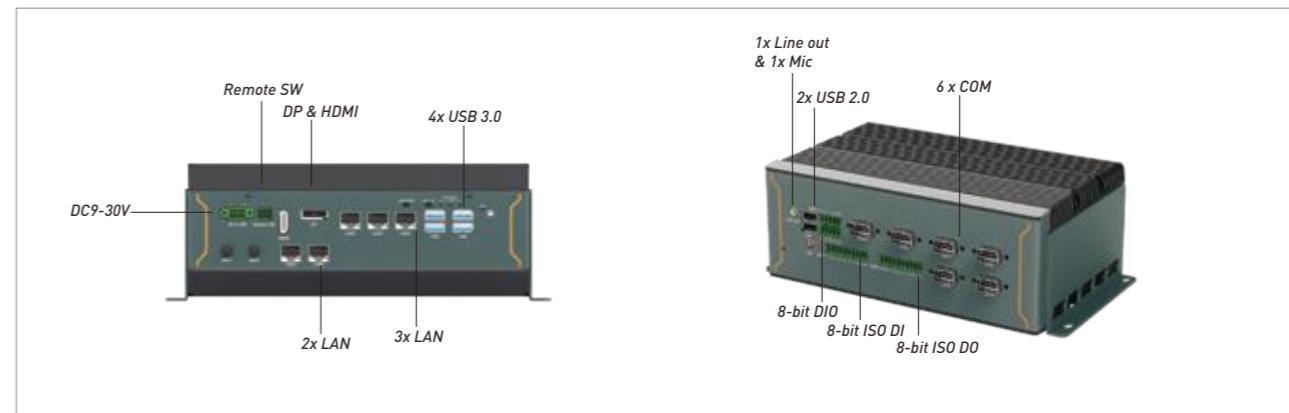
Vibration 5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)

Shock 50g peak acceleration(duration:11ms)(SSD);

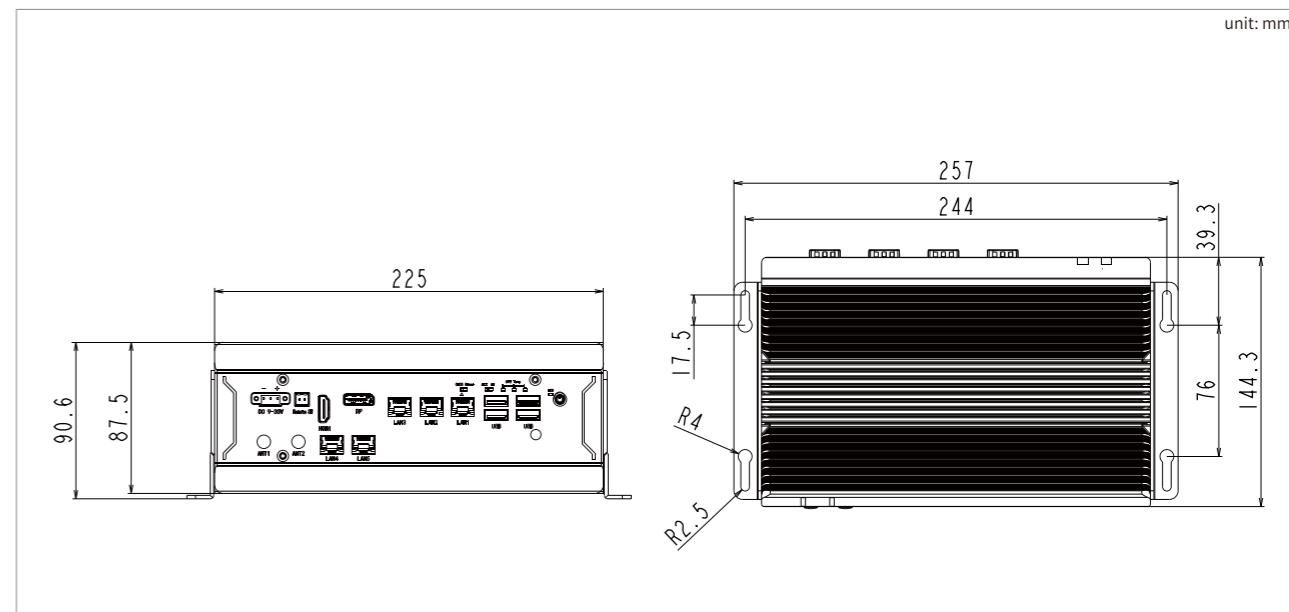
20g peak acceleration(duration: 11ms)(HDD)

Certification /EMC CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	RAM	Display	I/O Port	DIO	Audio	Expansion	Storage	Power Supply
BRAV-7201/S001	Intel I3-6100U/I3-7100U				5x LAN				
BRAV-7201/S002	Intel I5-6200U/I5-7200U	2x DDR4 MAX 32GB	1x HDMI 1x DP		4x USB3.0 3x USB2.0	8-bit TTL signal 16-bit Iso DIO	1x LINE OUT 1x MIC	1x Mini PCIe	1x mSATA 1x "2.5" driver bay
BRAV-7201/S003	Intel I7-6500U/I7-7500U				6x COM				
BRAV-7201/S004	Intel 3855U/3865U								
MLU220-M.2	Cambricon AI Accelerator module, M.2 2280 M+B key(PCIeX2), LPDDR4 4GB, 8TOPS(INT8)								
PA-60DC12	AC/DC power adaptor, DC12V@5A 60W								

BRAV-7220

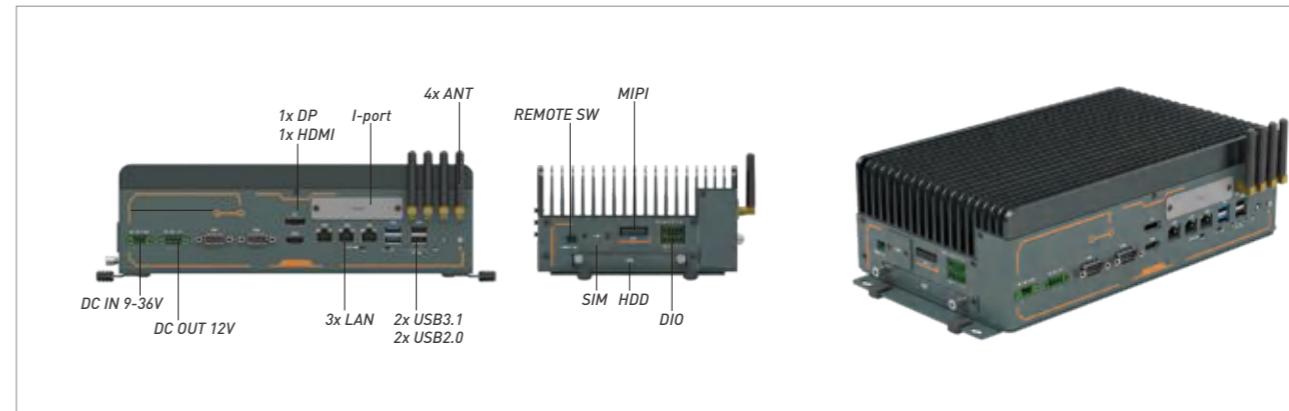
Intel® Tiger lake UP3 CPU, 3*LAN, 5*USB, 2*COM, 1*DIO, HDMI+DP, 2*M.2 support 4G LTE/5G NR, 2*M.2 support AI module

Key Specification

- Intel® Tiger lake U Soc CPU
- Aluminum-magnesium alloy, fanless passive heat dissipation design
- Intel® I225V chip, 3*2.5G LAN
- 1*DP+1*HDMI for 8K+4K dual display, 1*MIPI CSI (Opt.)
- 2*M.2 B-Key support 4G LTE or 5G NR wireless routes
- 2*M.2 M-key is PCIe X2 signal, supports nvme or edge AI module
- 1*mSATA and 1*easy pluggable 2.5" SATA dual storage disks
- 2*COM, 2*USB3.2 + 3*USB2.0, 1*DIO
- DC9~36V wide power input, with short circuit, over voltage and over current protection
- DC 12V/2A radar power supply output



I/O View



Product Overview

BRAV-7220 is an AI MEC computing system with a high energy efficiency ratio, powered by the Intel® Tiger Lake UP3 ULT SoC series CPU. It features a 2.5G network port and 5G NR wireless network, supports dual M.2 edge AI calculation modules, and has fanless heat dissipation and DC 9-36V wide power input. It can enable multilateral access and can be used as MEC edge computing for intelligent transportation and machine vision detection.

Product Parameters

System

Processor Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W/28W

RAM 2*DDR4 SO-DIMM, 3200MHz, 64GB max.

Graphics Intel UHD or Iris® Xe Graphics , Supports Intel DL boost, DirectX12.1, OpenGL 4.6 and OpenCL 3.0, HDMI 2.0: 4096x2304@60Hz, DP 1.4:7680x4320@60Hz

LAN 3*Intel I225V, 10M-2.5G, support iAMT 13.0, I5/I7 CPU support iVpro

USB 2*USB3.2, 2*USB2.0, 1*USB2.0(built-in)

Display 1*HDMI+1*DP

COM/others 2*RS232/422/485(DB9); optional1*MIPI CSI 60pin high-speed port (Opt.);

DIO 8bit DIO, TTL, 2.5KV isolated input/output

Storage 1*2.5"SATA3, easy plug design,6Gbps;1*mSATA(SATA3) 2*M.2 2280 M-Key(PCIeX2),support NVMe

LED 1*PowerLED, 1*HDD LED, 3*CPU Temp LED (Red is warning , Yellow is high, Green is normal)

Control Switch 1*Power SW, 1*Remote SW, 1*AT/ATX

Watchdog Timer Watchdog timeout programmable via software 1 to 255 second

OS Windows 10 64 bit, Windows 11 64 bit, SUSE, Linux, Wind River

Expansion

1*M.2 3042 B-Key(PCIe X1/USB2.0)+SIM, 4G LTE;
1*M.2 3052 B-Key(PCIe X1/USB2.0)+SIM, 4G LTE or 5G NR;
1*M.2 2280 M-Key(PCIe4.0X2), support NVMe/AI module;
1*M.2 2280 M-Key(PCIe3.0X2), support NVMe/AI module

Power Requirement DC IN 9~36V, with short circuit, over voltage and over current protection; TDP:38.4W (i5-1135G7 CPU/16G DDR4/256G SSD)

Mechanical

Structure Aluminum-magnesium alloy, SGCC frame

Color Granite gray + Graphite black

Mounting Desktop Mounting with shock-absorbing and anti-skid foot pad, optional Din-Rail installation

Dimension 326.4*174*96.6mm(W*H*D)

Net weight 4.67KG

Environmental

Operating Temp -20°C~70°C, with air flow(CPU, non. VPU)
-20°C~60°C, with air flow(CPU+2*VPU)

StorageTemp -40°C~85°C

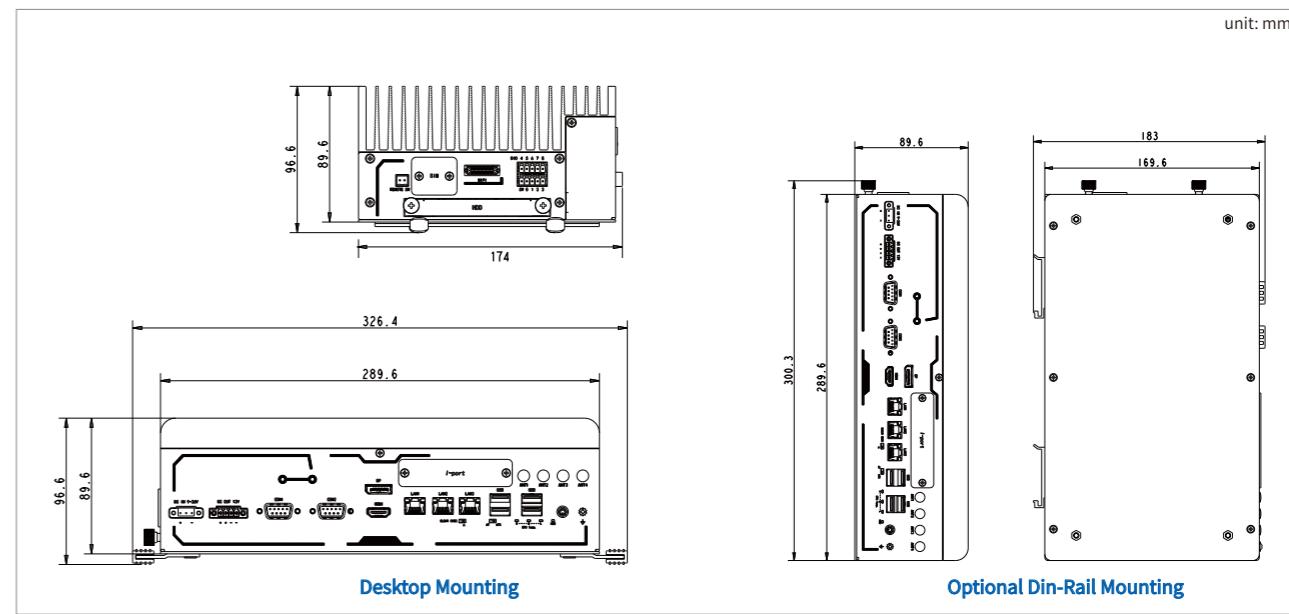
Humidity 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/during operation(SSD);
1 grms/5~500Hz/random/during operation(HDD)

Shock 50g peak acceleration(11ms duration)(SSD);
20g peak acceleration(11ms duration)(HDD)

Certification/ EMC CE/FCC Class A
EMC

Dimensions



Ordering Information

Model	Processor	Specifications
BRAV-7220/S001	Intel® Core i3-1115G4	3*2.5G LAN, 2*USB3.2, 3*USB2.0, 2*COM, 1*8bit Isolated DIO, 1*HDMI, 1*DP, optional1*MIPI CSI, 2*M.2 M-Key, 2*M.2 B-Key (+2*SIM), 1*mSATA, 1*2.5" SATA bay, DC-IN 9~36V, DC-OUT 12V
BRAV-7220/S002	Intel® Core i5-1135G7	
BRAV-7220/S003	Intel® Core i7-1165G7	
BRAV-7220/S004	Intel® Celeron 6305E	
MLU220-M.2		Cambrian edge AI module, M.2 2280 M+B key(PCIeX2), LPDDR4 4GB, 8TOPS(INT8)
PA-120DC19		AC/DC power adapter, DC19V@6.32A 120W
PA-60DC12		AC/DC power adapter, DC12V@5A 60W

BRAV-7302

Intel® Skylake-S/Kabylake-S Core i3/i5/i7 CPU, 3/7*LAN, 4/6*USB3.0, MXM3.1 GPU, 6*4K display, iVpro support, DC 6~48V wide power input.

Key Specification

- CPU and GPU cooling fan, independent air duct design.
- Intel® Kabylake-S/Skylake-S Core i3/i5/i7 CPU
- 2*DDR4 2400/2133MHz SODIMM RAM, max 32GB
- MXM3.1 NVIDIA/AMD GPU module
- Intel 1*DP+1*HDMI+1*VGA, GPU 3*DP+1*HDMI
- 3/7*LAN, 4/6*USB3.0, 3*USB2.0, 4*COM, 16*DIO, Audio
- 2*Mini PCIe(PCle+USB), 1*M.2 2242 B-Key
- 1*mSATA, 1/2*2.5" SATA3 drive bay, support RAID0,
- Support Intel iVpro and optional support TPM2.0 secure encryption
- DC 6~48V wide power input, short-circuit, overvoltage, overcurrent and undervoltage protection



Product Overview

BRAV-7302 is a high-performance GPU box computer with dual independent air duct heat dissipation design for CPU and GPU. It is equipped with Intel®Skylake-S/Kabylake-S full series range power processors, CPU+GPU dual processors, high performance, multiple network ports, multiple displays and multiple IO functions, suitable for applications in video security, machine vision, intelligent AI and other industries.

Product Parameters

System	
CPU	Intel®Skylake-S / Intel®Kabylake-S Celeron/Pentium/Core i3/i5/i7 CPU, LGA 1151 socket, TDP35W/54W/65W/91W with active cooling fan
RAM	2*260-Pin SODIMM, dual port DDR4 2400/2133MHz, max 32GB
Expansion	1*full size Mini PCIeX1+USB with SIM slot, 1*M.2 B-key with SATA3+USB with SIM slot, 1*full size mSATA (SATA3+USB), 1*half size Mini PCIe with PCIeX1 and USB, 1*JHC-Express-02 EIO Express bus (PCIe,USB,LPC,SMBus,PS2)
Graphics	Intel Gen. 9 HD Graphics, HEVC/H265 HW HD codec, Integrated graphics card DP/HDMI/VGA dual 4K, 1x MXM3.1 support NVIDIA Gforce GTX/AMD RX Series 120W pwr consumption GPU, 3* DP & 1* HDMI 4K
Audio	Optional Support Realtek ALC662VD, Audio out and MIC
LAN	2/6*Intel I210AT PCIe Gig. Ethernet, 10/100/1000Mbps self-adaptive, 1*Intel I219LM support vPro tech
Storage	2*2.5"HDD SATA3 shock absorber drive bay, support RAID0,1; 1*mSATA full size; 1*M.2 B-key
DIO	16-bit TTL programmable input/output;
I/O Port	3/7*RJ45 Gig-LAN 4/6*USB3.0; 2*USB2.0 ,1*USB2.0 internal 16-bit DIO 2*10-pin terminal; 2*RS232/422/485 DB9 male connector, 2*RS232 DB9 male connector 1*Audio-out and 1*MIC 3.5 audio port Discrete GPU 3*DP+1*HDMI; CPU Integrated graphic card 1*HDMI +1*DP+1*VGA;
LED	1*Power LED indicator, 1*HDD LED indicator, 3*CPU TEMP grade LED indicator (Red as warning, Yellow as high temp, Green as norm temp)

Mechanical

Structure Aluminum profile panel, SGCC chassis, Aluminum plate, on upper & rear panel

Color Black + Granite Grey

Installation Method Desktop Installation

Dimension (W*H*D):255*222*84.1mm

Net weight 4.62kg

Environmental

Operating temp -25°C~50°C – 65W CPU+78W GPU
-25°C~40°C – 91W CPU+120W GPU

Storage temp -40°C~85°C

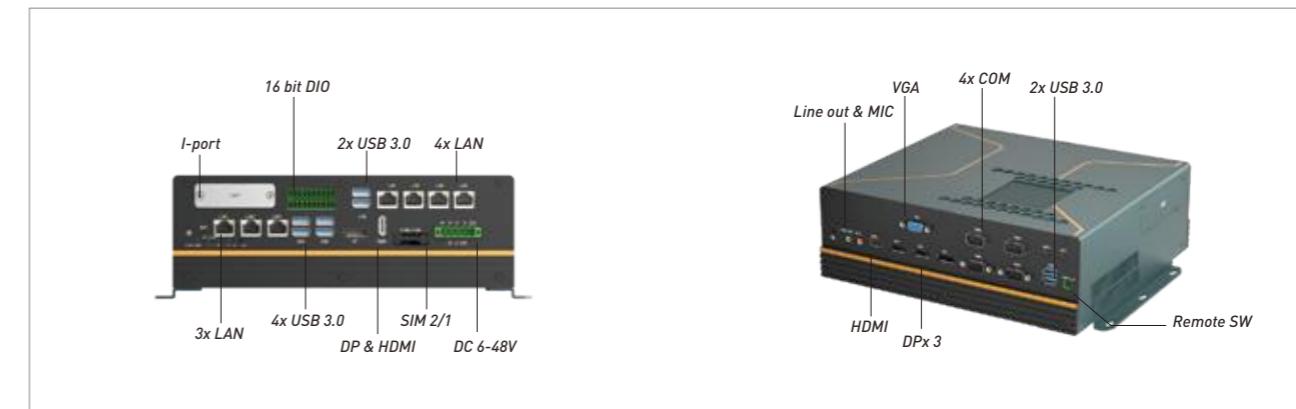
Storage humidity 10~90%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/during operation(SSD);
1 grms/5~500Hz/random/during operation(HDD)

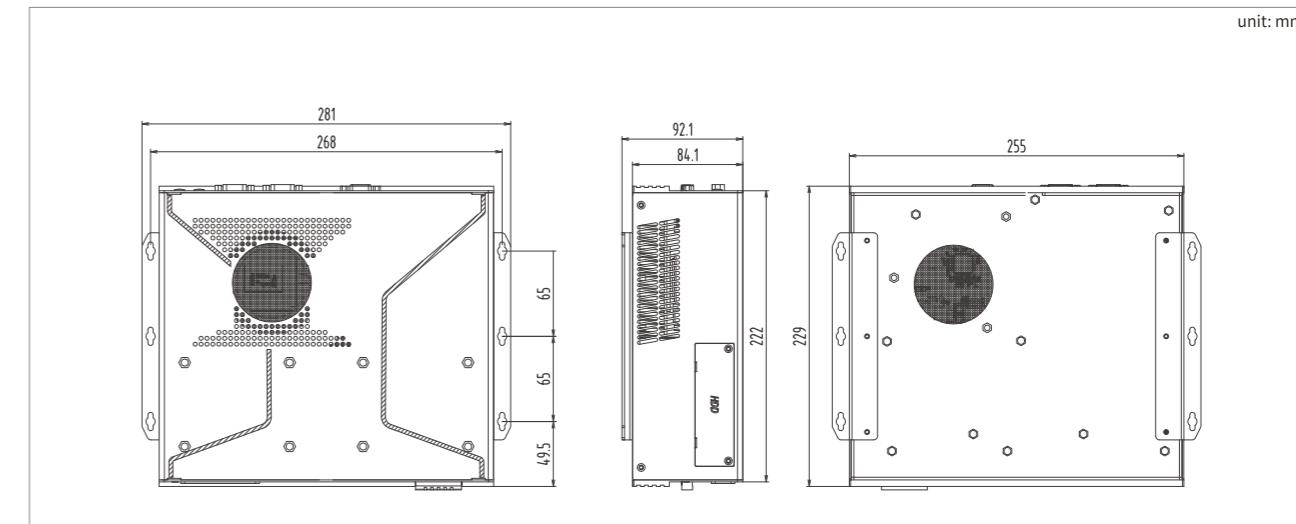
Shock 50g peak acceleration(duration:11ms)(SSD);
20g peak acceleration(duration:11ms)(HDD)

Certification /EMC CE/FCC Class A

I/O View



Dimensions View



Ordering Information

Model	Processor	RAM	Discrete graphics card	Integrated graphics card	I/O Port	DIO	Audio	Expansion	Storage	Power Supply
BRAV-7302/S001	Intel® Skylake-S/Kabylake-S LGA1151 CPU	2x DDR4 MAX 32GB	MXM 3.1 3x DP 1x HDMI	1x HDMI 1x DP 1x VGA	3x LAN/4x COM 4x USB3.0 3x USB2.0	16-bit TTL signal DIO	1x LINE OUT 1x MIC	2x Mini PCIe 1x M.2 B-Key	1x mSATA 2x"2.5"drive bay	DC 6~48V
BRAV-7302/S002	Intel® Skylake-S/Kabylake-S LGA1151 CPU				7x LAN/4x COM 6x USB3.0 3x USB2.0			1x Mini PCIe 1x M.2 B-Key	1x mSATA 1x"2.5"drive bay	
NVIDIA GT 1030-2G										
	MXM3.1 Type A, NVIDIA GT 1030, GDDR5 2GB, 64bit, 384 CUDA Cores, with cooler									
NVIDIA GTX 1050	MXM3.1 Type A, NVIDIA GTX 1050, GDDR5 2GB, 128bit, 768 CUDA Cores, with cooler									
NVIDIA GTX 1050TI	MXM3.1 Type A, NVIDIA GTX 1050TI, GDDR5 4GB, 128bit, 768 CUDA Cores, with cooler									
NVIDIA GTX 1060M	MXM3.1 Type B, NVIDIA GTX 1060M, GDDR5 6GB, 192bit, 1280 CUDA Cores, with cooler									
NVIDIA GTX 1070M	MXM3.1 Type B, NVIDIA GTX 1070M, GDDR5 8GB, 256bit, 2048 CUDA Cores, with cooler									
NVIDIA GTX 1650	MXM3.1 Type A, NVIDIA GTX 1650, GDDR5 4GB, 128bit, 896 CUDA Cores, with cooler									
NVIDIA GTX 1660S	MXM3.1 Type B, NVIDIA GTX 1660S, GDDR6 6GB, 192bit, 1408 CUDA Cores, with cooler									
MLU220-MXM	MXM3.1 Type A, Cambicon MLU-220, LPDDR4 8GB, 64bit, 16TOPS(INT8), with cooler									
PA-120DC19	AC/DC power adapter, DC19V/6.32A, 120W									
PA-220DC24	AC/DC power adapter, DC24V@9.17A, 220W									
PA-300DC24	AC/DC power adapter, DC24V@12.5A, 300W									
NDR-480DC24	AC/DC power adapter, DC24V@20A, 90-264ACV/127-370DCV input, DC 24V output, 480W									

BRAV-7501

Intel® Coffee Lake LGA1151 CPU, 3*LAN, 4*USB3.1, 1*HDMI, 2*DP, 3*4K Displays, 4*PCIe slots, 2/4*SATA3, ATX 600W Power Supply.

Key Specification

- Intel® Xeon®/ 8th/9th Gen Core™ i7/i5/i3 processor
- Intel® Q370/C246 Chipset
- 4*DDR4 2400/2666MHz DIMM RAM, max 128GB
- support 2*DP, 1*HDMI, 3 independent displays
- 3*LAN, 4*USB3.1, 7*USB2.0, 2*COM, 8-bit DIO
- 1*PCIeX16 or 2*PCIeX8+2*PCIeX4 expansions
- 1*Mini PCIe, with SIM slot, support 4G/WIFI/GPS/GSM/BT
- 2/4*SATA3, 1*M.2 2280 M-Key, support NVMe
- Optional support TPM2.0 secure encryption, AMT12.0, Intel® iVpro tech
- ATX 600W Power supply



Product Overview

BRAV-7501 is a high-performance Embedded Box Computer with expansions. It is equipped with Intel® Coffee Lake series processor, C246/Q370 chipset, workstation level performance. It is a complete equipment with rich expansion flexibility and industrial standard product design suitable for industrial automation, AI edge computing system, small intelligent workstations, multimedia service systems, visual control and so on

Product Parameters

System	
CPU	Intel® C246/Intel® Q370 Chipset, Intel Xeon E-2124G/E-2176G, Core i3/i5/i7 CPU;Pentoum G4930 / G5400
RAM	4*288-Pin DIMM, dual port DDR4 2666/2400MHz, max 128GB
Expansion	1*full size Mini PCIeX1+USB with SIM slot, 2*PCIe X16 slot (1*PCIe X16 or 2*PCIe X8) support up to NVIDIA 2080Ti series reference graphic card 2*PCIe X8 slot (Gen 3, 2*PCIeX4 signal)
Graphics	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 DP max res. 4096*2304@60Hz, HDMI max res. 3840*2160@30Hz, support 3 independent display
Audio	Optional Support Realtek ALC662VD audio, Audio out and MIC, support 5.1 audio track
LAN	2*Intel I210AT PCIe GbE, 10/100/1000Mbps self-adaptive; 1*Intel I219LM PCIe GbE, support iVpro tech
Storage	2*3.5"SATA3 (S001) / 4*2.5"SATA3 swappable hard disk bay, support Raid 0/1/5/10 (S002) 1*M.2 2280 M-key(PCIe X4), support NVMe storage
DIO	8-bit DIO, TTL signal, programmable input and output
I/O Port	3*RJ45 Gig-LAN; 2*DP+1*HDMI 4*USB3.1; 6*USB2.0; 1*USB2.0 (internal); 1*8-bit DIO (DB9), 2*RS232/422/485 (DB9); 1*Audio-out and 1*MIC (3.5audio port);
LED Control Switch	1*Power indicator, 4* HDD status indicator 1*Power SW

Power Requirement	24-pin ATX/8-pin ATX 12V, 600W power
OS	Windows 10 Enterprise & IOT Enterprise (64 bit)(CFL-R) Windows Server 2016 (Intel® Xeon® E) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R) Wind River VxWorks 7(CFL-R)
Watchdog Timer	Programmable timeout interruption period or system reset from 1 to 255 secs

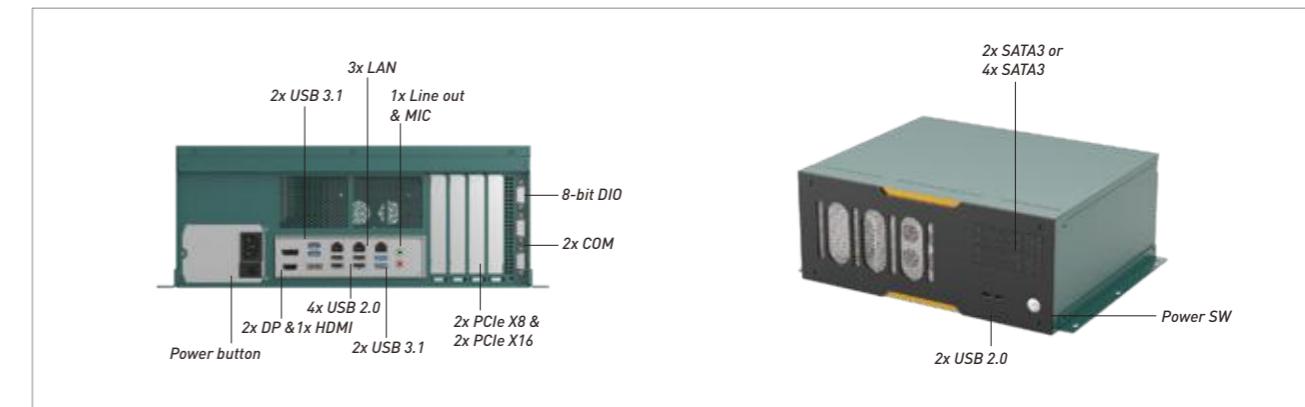
Mechanical	
Structure	Aluminum-magnesium alloy, SGCC coated box
Color	Black + Granite Grey
Installation Method	Desktop installation / wall mount installation

Dimension	(W*H*D):150*309*375mm
Net weight	8.14kg
Environmental	

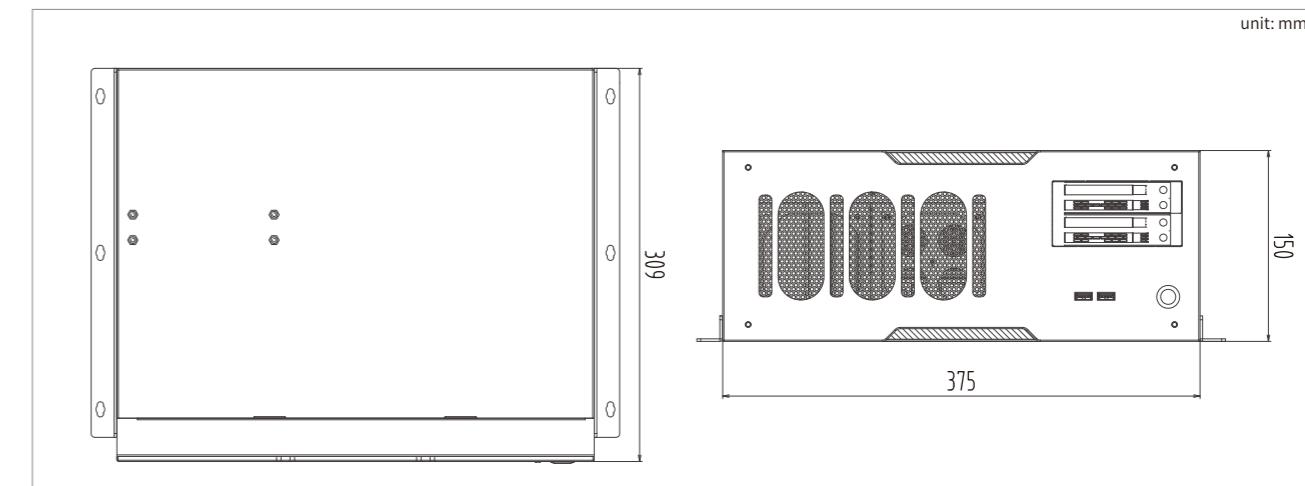
Operating Temp	-25°C~50°C , SSD , with air flow
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)
Shock	50g peak acceleration(duration:11ms)(SSD); 20g peak acceleration(duration:11ms)(HDD)

Certification /EMC	CE/FCC Class A
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I/O View



Dimensions



Ordering Information

Model	Processor	RAM	Display	I/O Port	DIO	Audio	Expansion	Storage	Power Supply
BRAV-7501/S001	Intel® CoffeeLake LGA1151 CPU Q370 PCH	4x DDR4 MAX 128GB	1x HDMI 2x DP	3x LAN/2x COM 4x USB3.1 7x USB2.0	8-bit DIO	1x LINE OUT 1x MIC	1x Mini PCIe (or 2x PCIeX8) 2x PCIeX4	2x "3.5"SATA 1x M.2 2280 4x "2.5"SATA 1x M.2 2280	ATX 600W Power
BRAV-7501/S002	Intel® CoffeeLake LGA1151 CPU C246 PCH								
Recommended Graphics card	Support up to NVIDIA 2080Ti reference graphics card series (for non reference graphics card, card length need to be less than 245mm)								

CPU Support

Series	Intel® Xeon®		Intel® Core™				Intel® Pentium®		Intel® Celeron®	
9th Gen	E-2278G	8C16T	I7-9700	8C8T	I7-9700T	8C8T	G5500	2C4T	G4950	2C2T
	E-2224G	8C16T	I5-9500	6C6T	I5-9500T	6C6T				
8th Gen			I3-9100	4C4T	I3-9100T	4C4T				
	E-2176G	6C12T	I7-8700	6C12T	I7-8700T	6C12T	G5400	2C4T	G4930	2C2T
	E-2124G	4C4T	I5-8500	6C6T	I5-8500T	6C6T				

BRAV-7520

Intel® Coffee Lake-R LGA1151 CPU, 3*LAN, 6*USB3.1, 1*VGA, 2*DP, 2*4K Displays, 2*PCIe slots, 2* swappable SATA3, max support 350W GPU.

Key Specification

- Intel® Xeon® E or 9th/8th-Gen Core™ i7/i5/i3 processor
- Intel® Q370/C246 Chipset
- Large RAM volume 4*DDR4 up to 128G ECC/non-ECC
- UHD Dual 4K, 3 independent displays 2*DP, 1*VGA
- 3*Gig-LAN(support iATM), optional multi channel 10 Gig-SFP
- Multi PCIe standard slots, support multiple high-speed extension modules
- Super storage capacity, 2*SATA3.0, 1*M.2 2280 M-Key, support NVMe
- Optional Support TPM2.0 secure encryption, support iAMT12.0, Intel® iVpro tech
- Fanless CPU, AI/GPU modules with efficient air cooling heat dissipation design
- Powerful deep learning ability, support 350W GPU /75W PGPU/AI accelerator card



Product Overview

BRAV-7520 is a workstation-level edge computing system, equipped with Intel® Coffee Lake-R series processors, C246/Q370 chipset, powerful system performance, complete features, and rich expansion flexibility, industrial control grade product design, a best fit for industrial automation, AI edge computing, small smart workstations, multimedia service systems, high-precision machine vision and other industries.

Product Parameters

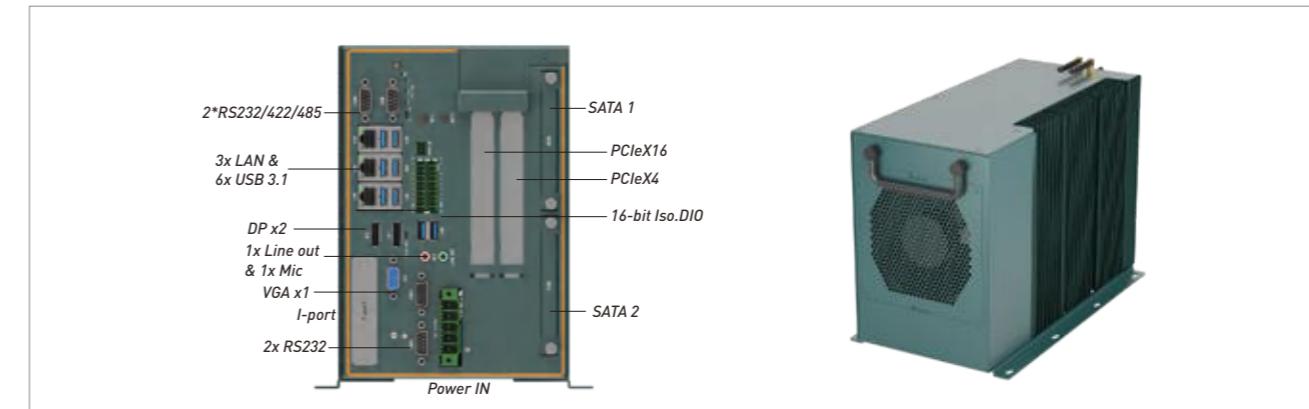
System

CPU	Intel® Xeon® E or 9th/8th-Gen Core™ i7/i5/i3 processor, chipset Intel® Q370(7520-S001)/ Intel® C246(7520-S002) max 8C16T	Power Requirement	DC 12V 5-pin Term. Consumption: 324W (i7-8700 CPU 32GB DDR4 single 2080TI)
RAM	4*260-Pin SODIMM, dual channel DDR4 2666/2400MHz, max support 128GB	OS	Windows 10 Enterprise & IOT Enterprise (64 bit)(CFL-R) Windows Server 2016 (Intel® Xeon® E) Ubuntu, SuSe, Redhat Enterprise 1,2(Kernel 4.14) (CFL-R) Wind River VxWorks 7 (CFL-R)
Expansion	1*Mini PCIe with SIM slot; 1*M.2 E-Key support WiFi6/BT5.0 1*M.2 B-Key , with SIM slot support 5G; 1*M.2 M-Key(PCle3.0X4); 1*PCleX16,max support 350W graphics card (length<300mm) 1*PCle X4 (in X16 slot), max support 75W AI accelerator card (length<300mm)	Watchdog Timer	Programmable timeout interuption or system reset from 1 to 255 secs
Graphics	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 / 2.1 or PCIe X16, DP max res. 4096*2304@60Hz, VGA max res.1900*1200@60Hz, support 3 independent displays	Mechanical	
Audio	optional support Realtek ALC662VD audio, Audio out& MIC, support 5.1 audio track	Structure	Aluminum heat dissipation case, SGCC box
LAN	2*Intel I210AT PCIe GbE, 10/100/1000Mbps self adaptive; 1*Intel I219LM PCIe GbE, support iVpro tech	Color	Black + Granite Grey
Storage	2*2.5" SATA3 swappable hard disk bay, support RAID0/1 1*M.2 2280 M-Key(PCle X4), support NVMe storage	Installation Method	Desktop Installation
DIO	16-bit Iso DIO,8-bit 2.5KV input (H:5-24V, L:0-1.5V), 8-bit 2.5KV output(200mA)	Dimension	(W*H*D):230*350*160mm
I/O Port	3*RJ45 Gig-LAN; 6*USB3.1; 2*USB2.0 16-bit Iso DIO, 2*RS232/422/485 ,2*RS232 1*Audio-out & 1*MIC; 1*VGA+2*DP	Net weight	7.5kg
LED Control Switch	1*Power indicator , 1* HDD status indicator 1*Power SW, 1*AT/ATX SW, 1*Clear CMOS SW	Environmental	

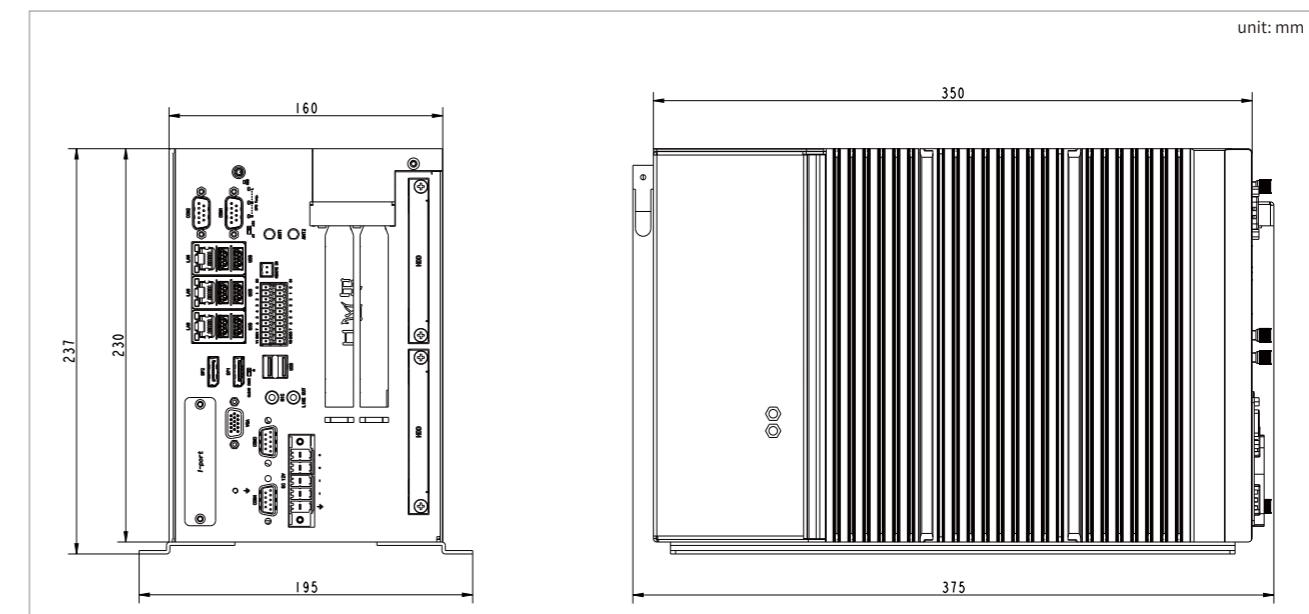
Environmental

Operating temp	-25°C~60°C , with air flow
Storage temp	-40°C~85°C
Storage humidity	10~90%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)
Shock	50g peak acceleration(duration;11ms)(SSD); 20g peak acceleration(duration;11ms)(HDD)
Certification /EMC	CE/FCC Class A

I/O View



Dimension



Ordering Information

Model	Processor	RAM	Display	I/O Port	DIO	Audio	Expansion	Storage	Power Supply
BRAV-7520/S001	Intel® Coffeelake-R LGA1151 CPU Q370 PCH	4x DDR4	1x VGA	3x LAN/4x COM 6x USB3.1 2x USB2.0	16-bit Iso DIO	1x LINE OUT 1x MIC	1x Mini PCIe 1x M.2 E-Key 1x M.2 B-Key 1x PCIeX16; 1x PCIeX4	2x "2.5"SATA 1x M.2 2280 M-Key	DC12V
BRAV-7520/S002	Intel® Coffeelake-R LGA1151 CPU C246 PCH	MAX 128GB	2x DP						
Recom graphics card /AI accelerator card UHP-500DC12	max support 350W GPU or 75W AI accelerator card (card length <300mm) AC/DC power switch, DC12V@4.1A ,90-264V AC input, DC 12V output, fanless, wide temp, 500W								
SE-600DC12	AC/DC power switch, DC12V@50A ,180-264V AC input, DC 12V output, 600W								

CPU Support

Series	Intel® Xeon®		Intel® Core™			Intel® Pentium®		Intel® Celeron®	
9th Gen	E-2278G	8C16T	I7-9700	8C8T	I7-9700T	8C8T	G5500	2C4T	G4950 2C2T
	E-2224G	8C16T	I5-9500	6C6T	I5-9500T	6C6T			
			I3-9100	4C4T	I3-9100T	4C4T			
8th Gen	E-2176G	6C12T	I7-8700	6C12T	I7-8700T	6C12T	G5400	2C4T	G4930 2C2T
	E-2124G	4C4T	I5-8500	6C6T	I5-8500T	6C6T			
			I3-8100	4C4T	I3-8100T	4C4T			

BRAV-7521

Intel® Coffee Lake-R LGA1151 CPU, 3*LAN, 6*USB3.1, 1*VGA, 2*DP, 2*4K Displays, 4*PCIe slots, 4*SATA3, max support 2*350W GPU.

Key Specification

- Intel® Xeon® E or 9th/8th-Gen Core™ i7/i5/i3 processor
- Intel® Q370/C246 Chipset
- Large memory volume 4*DDR4 up to 128G ECC/non-ECC
- UHD dual 4K, 3 independent displays, 2*DP, 1*VGA
- 3*Gig-LAN(support iATM) , optional multi channel 10 Gig-SFP
- multi PCIe Standard slot, supports multiple high - speed extension modules
- Super storage capacity 4*SATA3.0, 1*M.2 2280 M-Key, support NVMe
- Optional support TPM2.0 secure encryption,support iAMT12.0, Intel® iVpro tech
- Fanless CPU,AI/GPU modules efficient air cooling heat dissipation design
- Powerful deep learning ability, support 350W GPU /75W PGPU/AI accelerator card



Product Overview

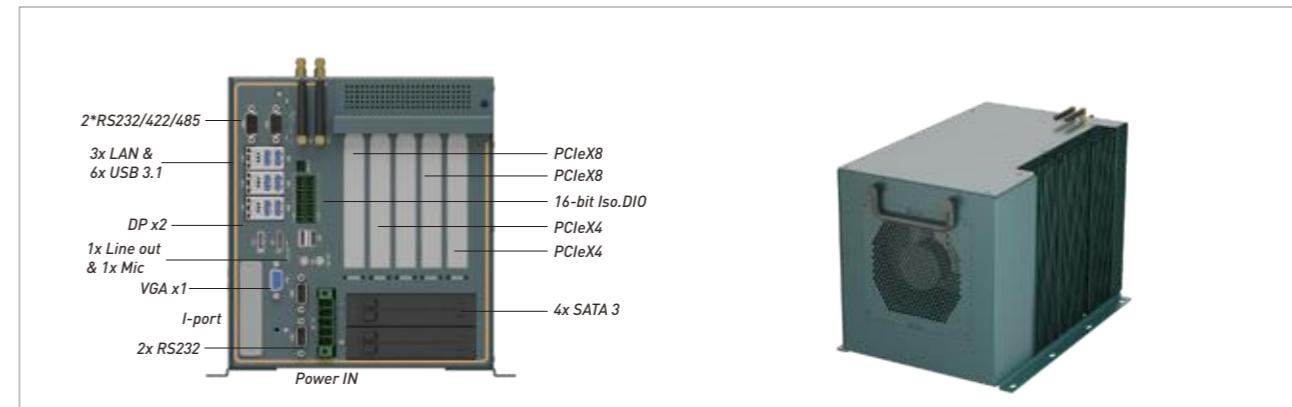
BRAV-7521 is a workstation-level edge computing system, equipped with Intel® Coffee Lake-R series processors and C246/Q370 chipset. It has a very powerful system performance with complete features including rich expansion flexibility, is an industrial grade product design which is the best fit for industrial automation, AI edge computing, small smart workstations, multimedia service systems, high-precision machine vision and other industries.

Product Parameters

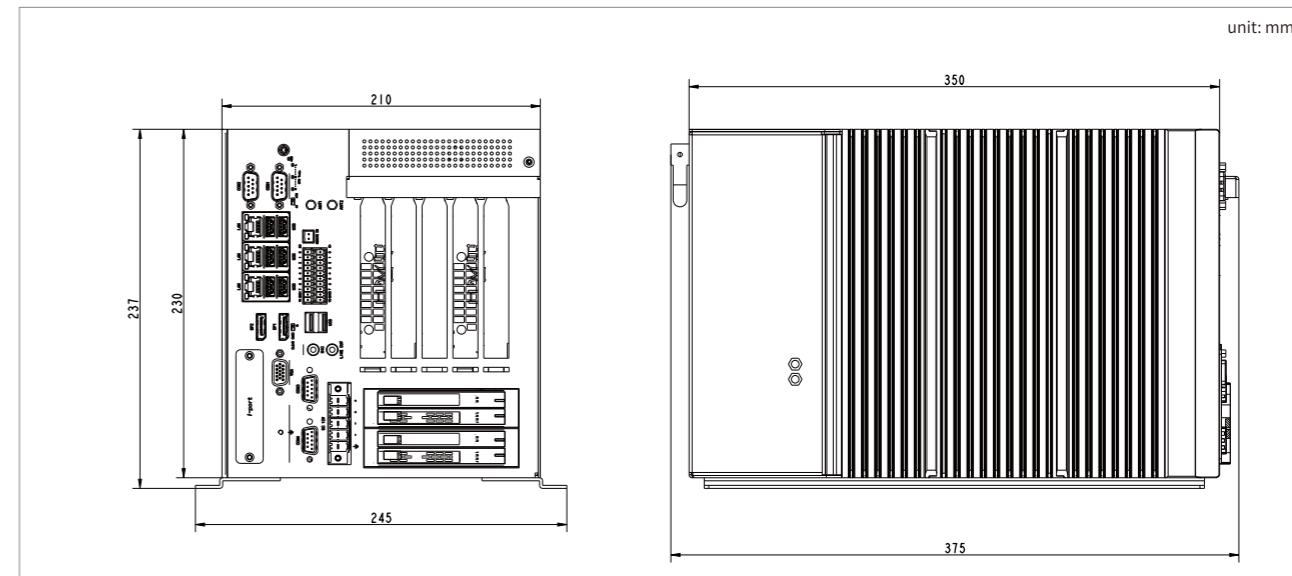
System

Processor	Intel® Xeon® E or 9th/8th-Gen Core™ i7/i5/i3 processor, Chipset: Intel® Q370(7521-S001) /Intel® C246(7521-S002) max 8C16T	Power Requirement	DC 12V 5-pin Term. Consumption: 564W (i7-8700 CPU 32GB DDR4, dual 2080TI)
RAM	4*260-Pin SODIMM, dual port DDR4 2666/2400MHz,max support 128GB	OS	Windows 10 Enterprise & IOT Enterprise (64 bit)(CFL-R) Windows Server 2016 (Intel® Xeon® E) Ubuntu, SuSe, Redhat Enterprise 1,2(Kernel 4.14) (CFL-R) Wind River VxWorks 7 (CFL-R)
Expansion	1*Mini PCIe with SIM slot; 1*M.2 E-Key support WiFi6/BT5.0 1*M.2 B-Key , with SIM slot, support 5G; 1*M.2 M-Key(PCle3.0X4); 2*PCleX8(in X16 slot)max support 2*350W graphics card(length <300mm) 2*PCle X4 (in X16 slot), max support 2*75W AI accelerator card (card length <300mm)	Watchdog timer	Programmable timeout interuption or system reset from 1 to 255 secs
Graphics	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 / 2.1 or PCIe X16, DP: 4096*2304@60Hz, VGA: 1900*1200@60Hz, support 3 independent displays	Mechanical	
Audio	optional support Realtek ALC662VD audio, Audio out & MIC, support 5.1audio	Structure	Aluminum-magnesium alloy, SGCC box
LAN	2*Intel I210AT PCIe GbE, 10/100/1000Mbps self-adaptive; 1*Intel I219LM PCIe GbE, support iVpro tech	Color	Black + Granite Grey
Storage	4*2.5" SATA3 swappable hard disk bay, support RAID0/1/5/10 1*M.2 2280 M-key(PCle X4), support NVMe storage	Installation Method	Desktop Installation
DIO	16-bit Iso DIO,8位2.5KV input(H:5-24V, L:0-1.5V), 8-bit 2.5KV output(200mA)	Dimension	(W*H*D):230*350*210mm
I/O Port	3*RJ45 Gig-LAN; 6*USB3.1; 2*USB2.0; 2*DP+1*VGA 16-bit Iso DIO; 2*RS232/422/485; 2*RS232; 1*Audio-out & 1*MIC	Net weight	8.3kg
LED Control Switch	1*Power indicator, 5*HDD status indicator 1*Power SW, 1*AT/ATX SW, 1*Clear CMOS SW	Environmental	
		Operating temp	-25°C~60°C , with air flow
		Storage temp	-40°C~85°C
		Storage Humidity	10~90%@40°C, No-condensation
		Vibration	5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz//random/during operation(HDD)
		Shock	50g peak acceleration(duration;11ms)(SSD); 20g peak acceleration(duration;11ms)(HDD)
		Certification /EMC	CE/FCC Class A

I/O view



Dimensions



Ordering Information

Model	Processor	RAM	Display	I/O Port	DIO	Audio	Expansion	Storage	Power Supply
BRAV-7521/S001	Intel® CoffeeLake-R LGA1151 CPU Q370 PCH	4x DDR4	1x VGA	3x LAN/4x COM 6x USB3.1 2x USB2.0	16-bit Iso DIO	1x LINE OUT 1x MIC	1x Mini PCIe 1x M.2 E-Key 1x M.2 B-Key 2x PCIe8; 2x PCIeX4	4x "2.5"SATA 1x M.2 2280 M Key	DC12V
BRAV-7521/S002	Intel® CoffeeLake-R LGA1151 CPU C246 PCH	MAX 128GB	2x DP						
Suggested graphics card / AI accelerator card	max support 2*350W GPU 2*75W AI accelerarator card (graphics card/AI accelerator card length <300mm)								
SE-1000DC12	AC/DC power switch ,DC12V@83.3A ,180-264V AC input, DC 12V output, 1000W								

CPU Support

Series	Intel® Xeon®		Intel® Core™			Intel® Pentium®		Intel® Celeron®	
9th Gen	E-2278G	8C16T	I7-9700	8C8T	I7-9700T	8C8T	G5500	2C4T	G4950 2C2T
	E-2224G	8C16T	I5-9500	6C6T	I5-9500T	6C6T			
			I3-9100	4C4T	I3-9100T	4C4T			
8th Gen	E-2176G	6C12T	I7-8700	6C12T	I7-8700T	6C12T	G5400	2C4T	G4930 2C2T
	E-2124G	4C4T	I5-8500	6C6T	I5-8500T	6C6T			

BRAV-7601-S

Intel® Comet lake 10th-Gen Celeron/Pentium/Core™ i9/i7/i5/i3 CPU, 7*LAN, 8*USB, 2*COM, 3*M.2, 8+16 bit DIO

Key Specification

- Intel® Comet lake 10th-Gen Celeron/Pentium/Core™ i9/i7/i5/i3 CPU
- Aluminum chassis, two temperature controlled fan
- 3*2.5G-LAN+4*Gig-LAN with POE function
- VGA+2*HDMI, 3 independent display, 2*DP GPU display
- 3*M.2 support Gig+WiFi6, 4G LTE, 5G NR module
- 1*MXM3.1 (PCIeX16 signal), support MXM GPU modules and AI accelerators with power consumption lower than 190W
- DC9~36V wide power input



Product Overview

BRAV-7601-S is a high-performance Edge AI computing system, powered by Intel® Comet lake 10th-Gen CPU. CPU+GPU, multiple LAN & display, rich IO function, DC9-36V wide voltage power supply. It is suitable for C-V2X, special vehicle, smart security, high-precision machine vision, medical imaging and other fields.

Product Parameters

System

CPU Intel® Comet lake 10th-Gen Celeron/Pentium/Core™ i9/i7/i5/i3 CPU; Intel® Q470 PCH

RAM 2*DDR4 SO-DIMM slot, support 2933MHz, up to 64GB
1*Mini-PCIe, PCIeX1/SATA3, USB2.0+SIM, support mSATA or 4G LTE;
1*M.2 Type 2230 E-key, PCIeX1, USB2.0 & CNVi, support WiFi6 & BT5.0;
1*M.2 Type 3052 B-key, PCIeX1, USB2.0+SIM, support 5G/4G;

Expansion 1*M.2 Type 2280 M-Key(PCIeX4 signal), support NVME, or PCIe;
1*MXM3.1, PCIeX16, up to 190W power supply, support MXM GPU modules & AI accelerator with power consumption lower than 190W;
JHCTECH-02 E/IO : 2*PCIeX4, 2*USB3.2, 2*USB2.0, 160pin

Display Intel® UHD Graphics, support DirectX 12, OpenGL 4.5,
2*HDMI 1.4, :4096 x 2304@24Hz;
1*VGA: 1920*1200@60Hz;
1*M.2, up to 190W, support GPU/AI accelerator, 2*DP, 4K display

Audio 1*Line out+1*MIC(optional),support 5.1 channel
2*Intel I225V+1*I225 LM, 3*2.5G-LAN, support iAMT 13.0,
(Core i5/i7 CPU support Intel vPro)

LAN 4*Intel I210AT, with POE , 10/100/1000Mbps, PCIe 3.0 X1 bandwidth
2*2.5"HDD SATA3(RAID0,1), max support dual 15mm HDD, 6.0Gbps;

Storage 1*M.2 Type 2280 M-Key(PCIeX4 signal), support NVMe;
1*mSATA(optional)

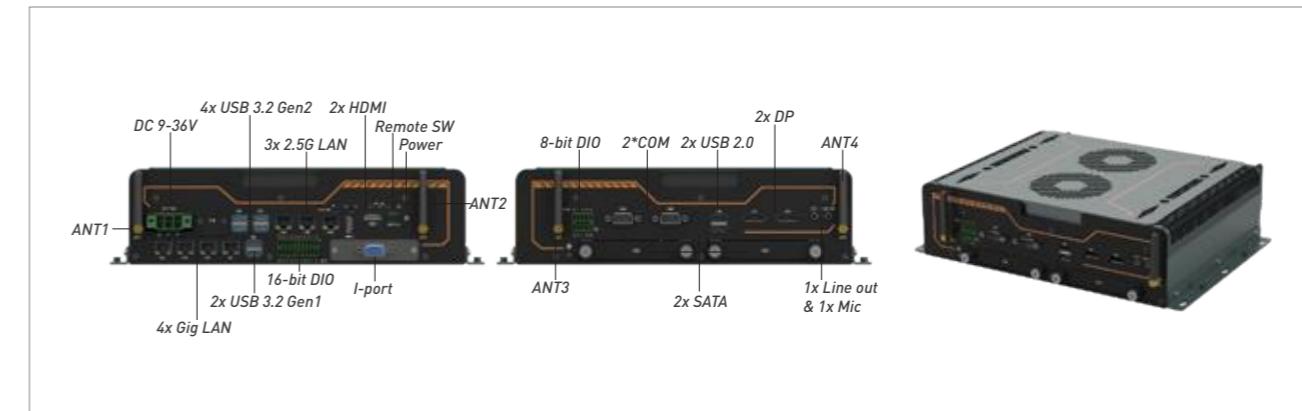
DIO 8bit TTL signal, programmable input & output;
8+16 bit TTL signal, programmable input & output (S002)

I/O Port 3*2.5G-LAN, 4*POE(S002),
4*USB3.2 Gen2(10Gbps), 2*USB3.2 Gen1(S002), 2*USB2.0,
1*USB2.0 DB pin header, 1*USB2.0 typeA (built-in), 2*SIM slot
2*RS232/422/485, (DB9), 2*RS232(built-in)

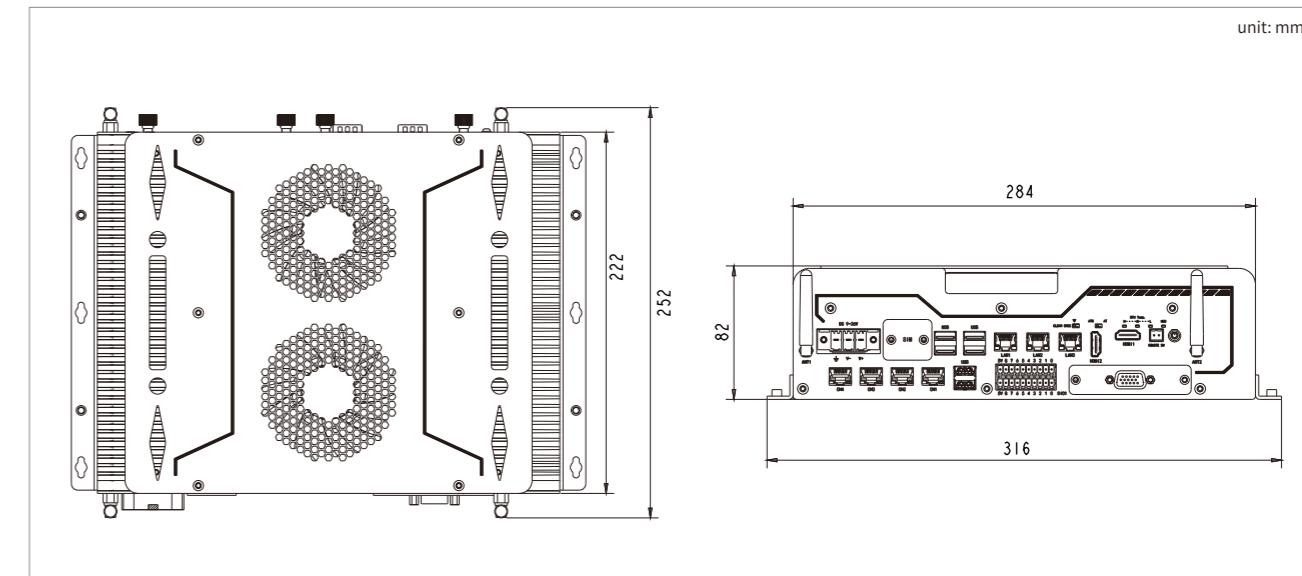
LED 1*HDD LED, 3*CPU Temp LED(Red: warning, Yellow: high temp, Green: normal)

Control switch 1* Power, 1*2-pin SW, 1*F-panel, 1*AT-ATX, 1*Clear CMOS

I/O view



Dimensions



Ordering Information

Model	Specifications	
BRAV-7601/S001	3*2.5G LAN, 8bit DIO Temperature controlled fan, AI edge computing system	Intel Q470 PCH, +Intel CML LGA1200 CPU, 1*MXM 3.1, 4*USB3.2 Gen2, 2*USB2.0, 2*COM, 1*Mini PCIe, 1*M.2 E-Key, 1*M.2 B-Key, 2*HDMI, 1*VGA, 2*DP, 1*MIC and 1*Audio-out(optional), 1*mSATA(optional), 1*M.2 M-Key, 2*2.5"SATA bay, 1*I-Port, DC 9-36V
BRAV-7601/S002	3*2.5G LAN, 4* POE 8+16bit DIO, 2*USB3.2 Gen1	
MXM3.1 GPU	MLU220-MXM, NVIDIA GTX 16 Series/RTX 30 Series mobile MXM GPU	
PA-220DC24	AC/DC power adapter, DC24V@9.17A, 220W	
PA-300DC24	AC/DC power adapter, DC24V@12.5A, 300W	

BRAV-7601-T

Intel® Comet lake 10th-Gen Celeron/Pentium/Core™ i9/i7/i5/i3 CPU, 7*LAN, 8*USB, 2*COM, 3*M.2, 8+16 bit DIO

Key Specification

- Intel® Comet lake 10th-Gen Celeron/Pentium/Core™ i9/i7/i5/i3 CPU
- Aluminum chassis, fanless,
- 3*2.5G-LAN+4*Gig-LAN with POE function
- VGA+2*HDMI, 3 independent display
- 3*M.2 support Gig+WiFi6, 4G LTE, 5G NR
- 1*MXM3.1, support MLU220-MXM AI accelerator
- DC9~36V wide power input, with short circuit, over voltage and over current protection



Product Overview

BRAV-7601-T is a high performance fan-less AI Edge computing system, powered by Intel® Comet lake CPU. It supports Cambricon MLU220 acceleration module, multi-network port, multi-display, rich I/O function, DC9-36V wide power input, which makes it very suitable for C-V2X, Special vehicle mounted, high-precision machine vision, medical imaging and other applications.

Product Parameters

System

CPU Intel® Comet lake 10th-Gen Celeron/Pentium/Core™ i9/i7/i5/i3 CPU; Intel® Q470 PCH

RAM 2*DDR4 SO-DIMM slot, support 2933MHz, up to 64GB

1*Mini-PCIe, PCIeX1/SATA3, USB2.0+SIM, support mSATA or 4G LTE;

1*M.2 Type 2230 E-key, PCIeX1, USB2.0 & CNVio, support WiFi6/BT5.0;

Expansion 1*M.2 Type 3052 B-key, PCIeX1, USB2.0+SIM, support 5G/4G; 1*M.2 Type 2280 M-Key(PCIeX4 signal), support NVME, or PCIe; 1*MXM3.1, PCIeX16, support MLU220-MXM; JHCTECH-02 E/I/O: 2*PCIeX4, 2*USB3.2, 2*USB2.0, 160pin

Display Intel® UHD Graphics, support DirectX 12, OpenGL 4.5, 2*HDMI 1.4, : 4096 x 2304@24Hz, 1*VGA: 1920*1200@60Hz

Audio 1*Line out+1*MIC(Optional), support 5.1 channel

2*Intel I25V+1*I225 LM, 3*2.5G-LAN, support iAMT 13.0, Core i5/i7 CPU support Intel vPro

4*Intel I210AT, with POE , 10/100/1000Mbps,PCIe 3.0 X1 bandwidth

2*2.5" HDD SATA3(support RAID0,1), max support 15mm HDD, 6.0Gbps; 1*M.2 Type 2280 M-Key(PCIeX4 signal), support NVMe; optional 1*mSATA

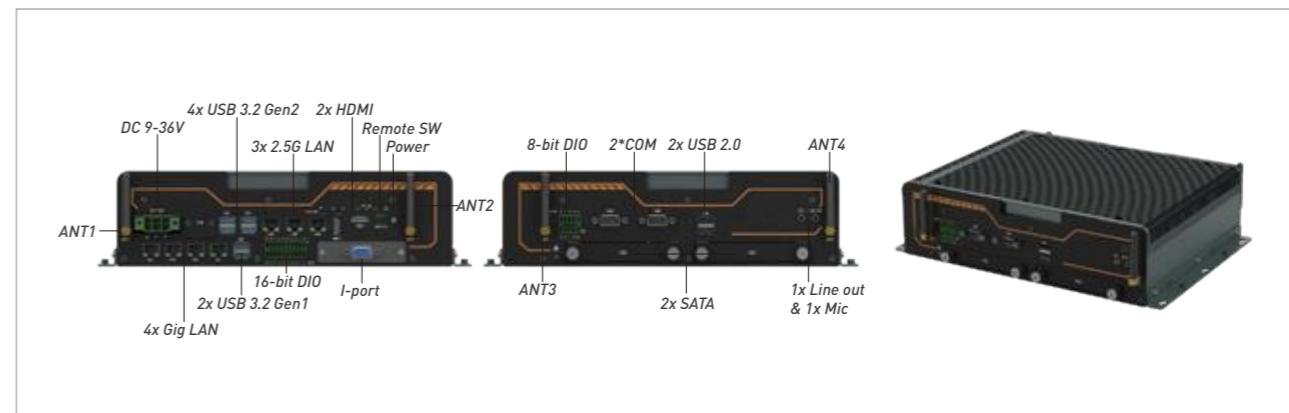
DIO 8bit TTLsignal, programmable input and output; 8+16 bit TTL signal, programmable input and output(T002)

3*2.5G-LAN; 4*POE(T002), 4*USB3.2 Gen2(10Gbps), 2*USB3.2 Gen1(T002), 2*USB2.0, 2*SIM slot 2*RS232/422/485, (DB9), 2*RS232(built-in)

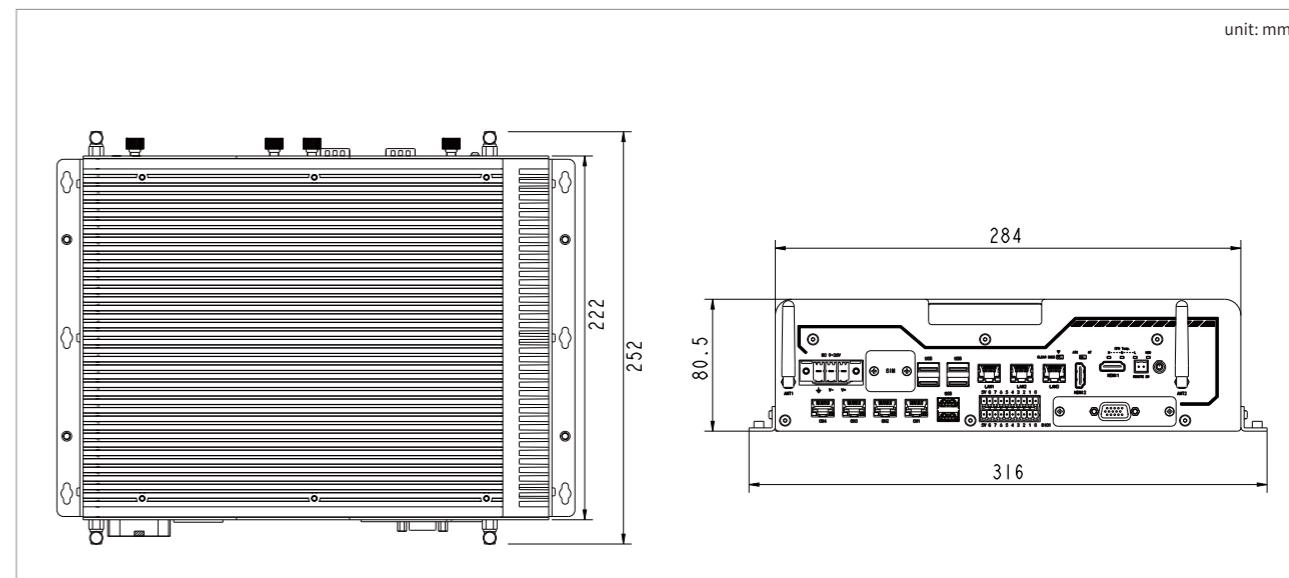
LED 1*HDD LED, 3*CPU Temp LED (Red: warning, Yellow: high temp, Green: normal)

Control switch 1* Power, 1*2-pin SW, 1*F-panel, 1*AT-ATX, 1*Clear CMOS

I/O view



Dimensions



Ordering Information

Model	Specifications
BRAV-7601/T001	3*2.5G LAN, 8bit DIO Fanless AI Edge Computing System
BRAV-7601/T002	3*2.5G LAN, 4* POE 8+16bit DIO, 2*USB3.2 Gen1
MXM3.1 GPU	Cambricon MLU220-MXM
PA-120DC19	AC/DC power adapter, DC19V/6.32A,120W
PA-220DC24	AC/DC power adapter, DC24V@9.17A,220W

BRAV-7720-S001

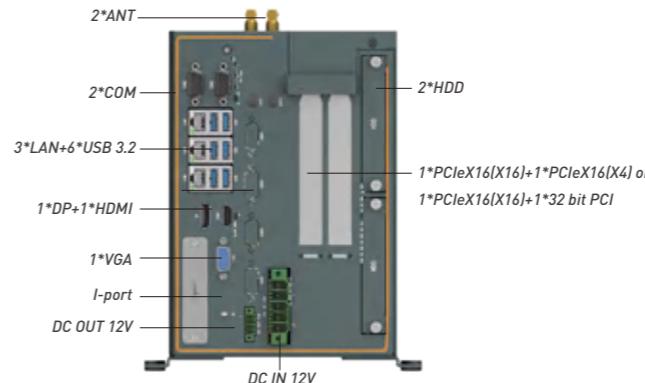
Intel® Alder lake-S LGA1700 CPU, 3*LAN, 6*USB3.2, 8K DP+4K HDMI , PCIe5.0 X16+PCIe4.0 X4, 2*2.5" SATA bay , DC IN 12V 1000W

Key Specification

- Intel® 12th Gen Alder lake-S LGA1700 CPU
- Intel® Q670 Chipset
- 2*DDR5 4800MHz SODIMM, up to 64GB
- 1*DP+1*HDMI and 1*VGA, UHD 8K+4K three independent displays
- 2*Intel® I226V Gigabit LAN, 1*Intel® I219LM Gigabit LAN, support iAMT12.0
- 1*PCIe X16 (X16 signal)+1*PCIe X16 (X4 signal), dual PCIe expansions
- 2*2.5" SATA3.0 Bays, 1*M.2 2280 PCIeX4 NVMe
- Support TPM2.0 and iVpro technology
- Fanless cooling for CPU , AI/GPU card with efficient fan cooling design
- Support 450W GPU or dual 75W/150W AI acceleration cards
- 1000W DC IN 12V, and wide temperature fanless AC-DC power adapter with PFC



I/O View



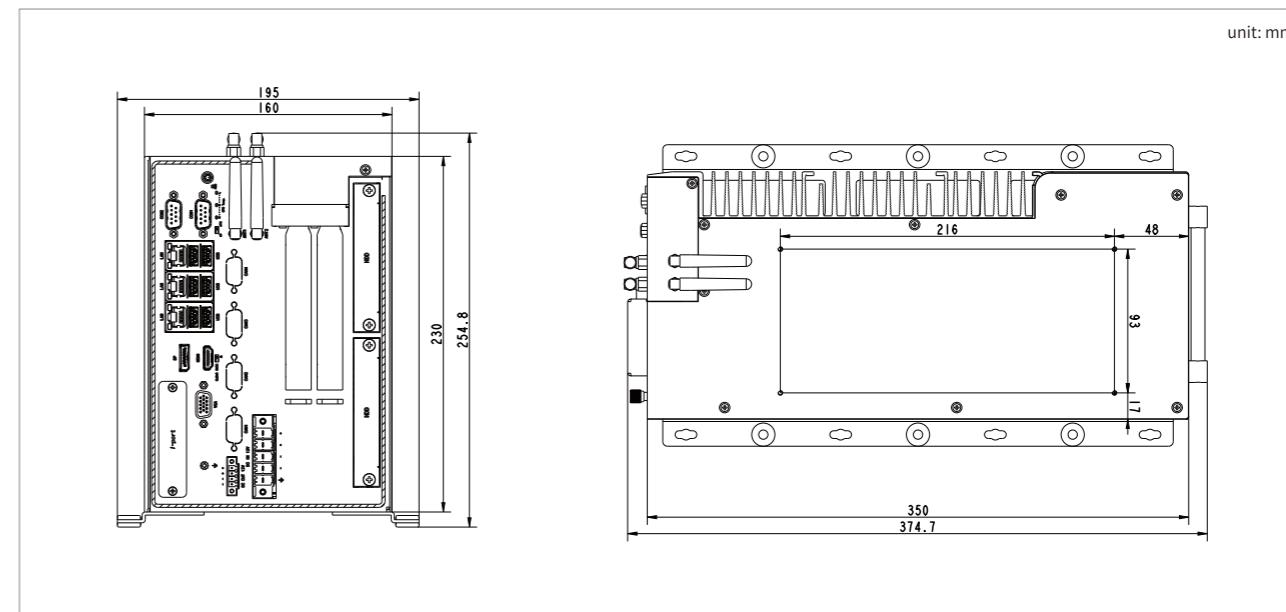
Product Overview

BRAV-7720-S001 is a workstation-grade edge computing system, powered by the Intel® Alder Lake-S series CPU, Q670 chipset, dual-channel DDR5 memory, and dual PCIe expansions. It offers flexible optional computing power, multiple IO interfaces, a high PFC power supply, a high-efficiency cooling solution, and an industrial-grade reliability design. It is well-suited for V2X MEC, highway event detection, unmanned experimental vehicles, high-precision machine vision, and other fields and applications.

Product Parameters

System	
Processor	Intel® Alder lake-S 12th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® Q670 PCH
RAM	2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, support 3 independent displays
LAN	2* Intel I226V, 10-1000M; 1* Intel I219LM,10-1000M, iAMT 12.0
USB	4* USB3.2(10G)+2*USB3.0(5G)
Display	1* DP+1*HDMI+1*VGA
Audio	/
COM/others	2*RS232/422/485
DIO	optional 16 bit DIO, TTL, programmable input/output
Storage	2*2.5" SATA3 HDD(RAID0/1), 15mm thickness; 1*M.2 2280 M-Key(PCIe4.0X4), NVMe; 1*mSATA(optional)
LED	1*PowerLED, 1*HDD LED
Control Switch	1*Power SW, 1*AT/ATX SW, 1*Clear CMOS SW
Power Requirement	DC IN 12V, 1000W max. ; TDP:TBD
Watchdog Timer	Watchdog timeout programmable via software 1 to 255 second
OS	Windows 10 Enterprise & IoT Enterprise (64 bit)(CFL-R) Windows Server 2016 (Intel® Xeon® E) Ubuntu, SuSe, Redhat Enterprise 1,2(Kernel 4.14) (CFL-R) Wind River VxWorks 7 (CFL-R)
Expansion	
	1*Mini PCIe(PCIeX1/USB+SIM), 4G LTE/PCIe; 1*Mini PCIe(PCIeX1/SATA), mSATA; 1*M.2 3052 B-Key(PCIeX1/USB+SIM), 5G NR; 1*M.2 2280 M-Key(PCIe4.0X4), NVMe; 1*PCIe5.0X16(X16), GPU<450W<300mm 1*PCIe4.0X16(X4), AI card<75W<300mm
Mechanical	
Structure	SGCC frame, Aluminum-magnesium alloy chassis, temperature control by PWM fan
Color	Granite gray + Black
Mounting	Desktop mounting with anti-vibration rubber pads
Dimension	195*374.7*254.8mm(W*H*D)
Net weight	TBD
Environmental	
Operating Temp	-25°C~60°C , with air flow
StorageTemp	-40°C~85°C
Storage Humidity	10~95%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)
Shock	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)
Certification/ EMC	CE/FCC Class A

Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
BRAV-7720/S001	Intel® Alder lake-S 12th-Gen LGA1700 CPU, Q670 PCH	2*DDR5 SODIMM, 3*LAN, 6*USB3.2, 2*USB2.0(built-in), 2*COM, 1*VGA, 1*DP, 1*HDMI, 16bit DIO(built-in), 1*I-Port, 2*2.5" SATA bay, 2*Mini PCIe, 1*M.2 B-Key, 1*M.2 M-Key, DC 12V	Default: ECX-255 1*PCIeX16(X16)+1*PCIeX16(X4) Optional: ECX-271 1*PCIeX16(X16)+1*32bit PCI
Recommend GPU/AI Module			Support a maximum 1*450W GPU or 2*75W/150W AI module (GPU/AI module<300mm)
UHP-500DC12			AC/DC power adapter, DC12V@41.7A, 90-264V AC IN, DC OUT 12V , wide temperature fanless, 500W

BRAV-7720-WP

Intel® Alder lake-S LGA1700 CPU, 3*LAN, 6*USB3.2, 8K DP+4K HDMI , PCIe5.0 X16+PCIe4.0 X4, 2*2.5"SATA bay , DC IN 9-55V 600W

Key Specification

- Intel® 12th Gen Alder lake-S LGA1700 CPU
- Intel® Q670 Chipset
- 2*DDR5 4800MHz SODIMM, up to 64GB
- 1*DP+1*HDMI and 1*VGA, UHD 8K+4K three independent displays
- 2*Intel® I226V Gigabit LAN, 1*Intel® I219LM Gigabit LAN, support iAMT12.0
- 1*PCIe X16 (X16 signal)+1*PCIe X16 (X4 signal), dual PCIe expansions
- 2*2.5"SATA3.0 Bays, 1*M.2 2280 PCIeX4 NVMe
- Support TPM2.0 and iVpro technology
- Fanless cooling for CPU , AI/GPU card with efficient fan cooling design
- Support 450W GPU or dual 75W/150W AI acceleration cards
- 600W DC IN 9-55V, and wide temperature fanless AC-DC power adapter with PFC



Product Overview

BRAV-7720-WP是一款工作站等级边缘计算System,搭载Intel® Alder Lake-S系列Processor, Q670芯片组, 双通道DDR5RAM, 双PCIeExpansion。算力弹性化optional、完整IO功能配置、高PFC供电效能、高效率散热方案和工业等级可靠性设计, 非常适用于车联网MEC, 高速路事件检测、无人驾驶实验车载和高精度机器视觉等行业和应用

Product Parameters

System

Processor Intel® Alder lake-S 12th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® Q670 PCH

RAM 2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.

Graphics Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, support 3 independent displays

LAN 2* Intel I226V, 10-1000M; 1* Intel I219LM, 10-1000M, iAMT 12.0

USB 4* USB3.2(10G)+2*USB3.0(5G)

Display 1* DP+1*HDMI+1* VGA

Audio /

COM/others 2*RS232/422/485

DIO optional 16 bit DIO, TTL, programmable input/output

Storage 2*2.5"SATA3 HDD(RAID0/1), 15mm thickness; 1*M.2 2280 M-Key(PCIe4.0X4), NVMe; 1*mSATA(optional)

LED 1*PowerLED, 1*HDD LED

Control Switch 1*Power SW, 1*AT/ATX SW, 1*Clear CMOS SW

Power Requirement DC IN 9-55V, 600W max.; TDP:TBD

Watchdog Timer Watchdog timeout programmable via software 1 to 255 second

OS Windows 11 , Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7

Expansion

1*Mini PCIe(PCIeX1/USB+SIM), 4G LTE/PCIe; 1*Mini PCIe(PCIeX1/SATA), mSATA; 1*M.2 3052 B-Key(PCIeX1/USB+SIM), 5G NR; 1*M.2 2280 M-Key(PCIe4.0X4), NVMe; 1*PCIe5.0X16(X16), GPU<450W<300mm 1*PCIe4.0X16(X4), AI card<75W<300mm

Mechanical

Structure SGCC frame, Aluminum-magnesium alloy chassis, temperature control by PWM fan

Color Granite gray + Black

Mounting Desktop mounting with anti-vibration rubber pads

Dimension 262*374.7*178 mm(W*H*D)

Net weight TBD

Environmental

Operating Temp -20°C~60°C , with air flow

StorageTemp -40°C~85°C

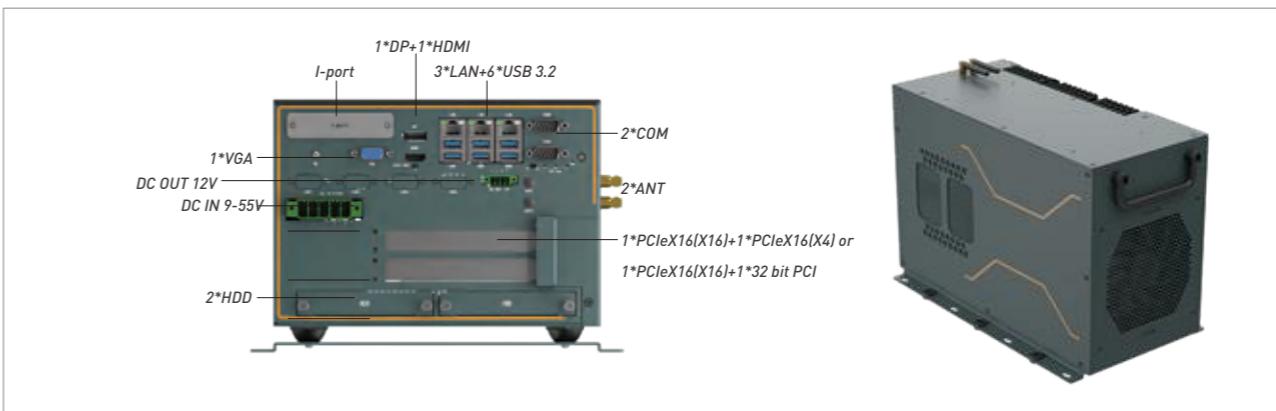
Storage Humidity 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)

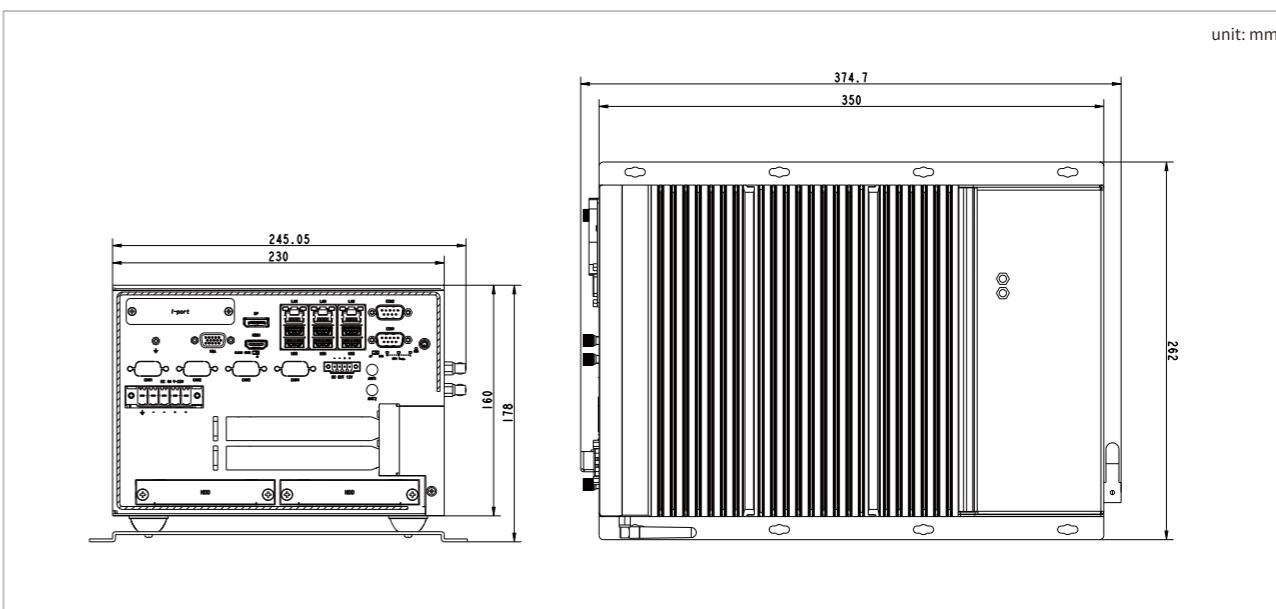
Shock 50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)

Certification/ EMC CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
BRAV-7720-WP-S001	Intel® Alder lake-S 12th-Gen LGA1700 CPU, Q670 PCH	2*DDR5 SODIMM, 3*LAN, 6*USB3.2, 2*USB2.0(built-in), 2*COM, 1*VGA, 1*DP, 1*HDMI, 16bit DIO(built-in), 1*I-Port, 2*2.5"SATA bay, 2*Mini PCIe, 1*M.2 B-Key, 1*M.2 M-Key, DC 9-55V	Default: ECX-255 1*PCIeX16(X16)+1*PCIeX16(X4) Optional: ECX-271 1*PCIeX16(X16)+1*32bit PCI
Recommend GPU/AI Module		Support a maximum 1*450W GPU or 2*75W/150W AI module (GPU/AI module<300mm)	
UHP-500DC12		AC/DC power adapter, DC12V@41.7A, 90-264V AC IN, DC OUT 12V , wide temperature fanless, 500W	

BRAV-7721-S001

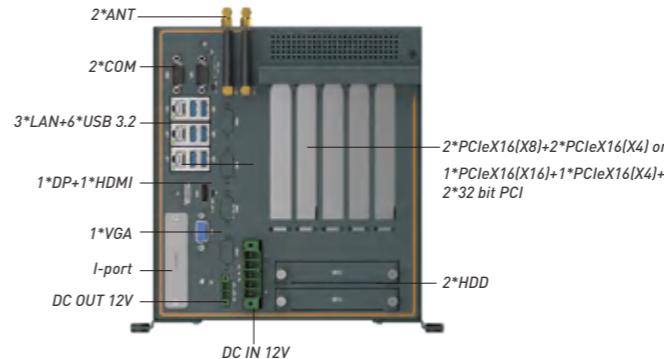
Intel® Alder lake-S LGA1700 CPU, 3*LAN, 6*USB3.2, 8K DP+4K HDMI , 2*PCIe5.0 X8+2*PCIe4.0 X4, 2*2.5"SATA bay , DC IN 12V 1000W

Key Specification

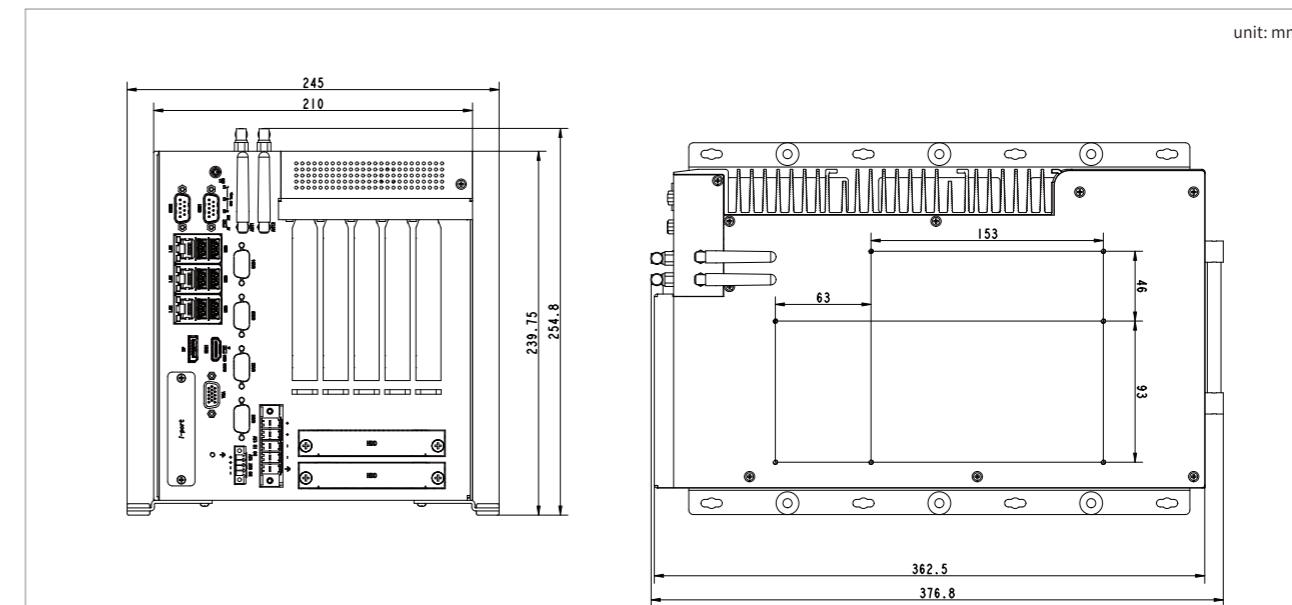
- Intel® 12th Gen Alder lake-S LGA1700 CPU
- Intel® Q670 Chipset
- 2*DDR5 4800MHz SODIMM, up to 64GB
- 1*DP+1*HDMI and 1*VGA, UHD 8K+4K three independent displays
- 2*Intel® I226V , 1*Intel® I219LM, support iAMT12.0
- 2*PCIe X16 (X8)+2*PCIe X16 (X4), four PCIe expansions
- 2*2.5"SATA3.0 Bays, 1*M.2 2280 PCIeX4 NVMe
- Support TPM2.0 and iVpro technology
- Fanless cooling for CPU , AI/GPU card with efficient fan cooling design
- Support dual 450W GPU + dual 75W/150W AI acceleration cards
- 1000W DC IN 12V, and wide temperature fanless AC-DC power adapter with PFC



I/O View



Dimensions



Product Overview

BRAV-7721-S001 is a workstation-grade edge computing system, powered by the Intel® Alder Lake-S series CPU, Q670 chipset, dual-channel DDR5 memory, and four PCIe expansions. It offers flexible optional computing power, multiple IO interfaces, a high PFC power supply, a high-efficiency cooling solution, and an industrial-grade reliability design. It is well-suited for V2X MEC, highway event detection, unmanned experimental vehicles, high-precision machine vision, and other fields and applications.

Product Parameters

System

Processor Intel® Alder lake-S 12th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® Q670 PCH

RAM 2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.

Graphics Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, support 3 independent displays

LAN 2* Intel I226V, 10-1000M; 1* Intel I219LM, 10-1000M, iAMT 12.0

USB 4* USB3.2(10G)+2*USB3.0(5G)

Display 1* DP+1*HDMI+1* VGA

Audio /

COM/others 2*RS232/422/485

DIO optional 16 bit DIO, TTL, programmable input/output

Storage 2*2.5"SATA3 HDD(RAID0/1), 15mm thickness; 1*M.2 2280 M-Key(PCIe4.0X4), NVMe; 1*mSATA(optional)

LED 1*PowerLED, 1*HDD LED

Control Switch 1*Power SW, 1*AT/ATX SW, 1*Clear CMOS SW

Power Requirement DC IN 12V, 1000W max.; TDP:TBD

Watchdog Timer Watchdog timeout programmable via software 1 to 255 second

OS Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7

Mechanical

Structure SGCC frame, Aluminum-magnesium alloy chassis, temperature control by PWM fan

Color Granite gray + Black

Mounting Desktop mounting with anti-vibration rubber pads

Dimension 245*376.8*254.8mm(W*H*D)

Net weight TBD

Environmental

Operating Temp -20°C~60°C , with air flow

StorageTemp -40°C~85°C

Storage Humidity 10~95%@40°C, No-condensation

Vibration 5 grms/5-500Hz/random/during operation(SSD); 1 grms/5-500Hz/random/during operation(HDD)

Shock 50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)

Certification/ EMC CE/FCC Class A

Ordering Information

Model	Processor	Specifications	Expansion
BRAV-7721-S001	Intel® Alder lake-S 12th-Gen LGA1700 CPU, Q670 PCH	2*DDR5 SODIMM, 3*LAN, 6*USB3.2, 2*USB2.0(built-in), 2*COM, 1*VGA, 1*DP, 1*HDMI, 16bit DIO(built-in), 1*I-Port, 2*2.5"SATA bay, 2*Mini PCIe, 1*M.2 B-Key, 1*M.2 M-Key, DC 12V	Default: ECX-254 2*PCIeX16(X8)+2*PCIeX16(X4) Optional: ECX-275 1*PCIeX16(X16)+1*PCIeX16(X4) 2*32bit PCI
		Recommend GPU/AI Module	Support a maximum 2*450W GPU+2*75W/150W AI module (GPU/AI module<300mm)
		UHP-500DC12	AC/DC power adapter, DC12V@41.7A, 90-264V AC IN, DC OUT 12V , wide temperature fanless, 500W
		LMF1000-20B12	AC/DC power adapter, DC12V@80A, 90-264V AC IN or 120-370V DC IN, DC OUT 12V, 1000W, low-noise fan

BRAV-7721-WP

Intel® Alder lake-S LGA1700 CPU, 3*LAN, 6*USB3.2, 8K DP+4K HDMI , 2*PCIe5.0 X8+2*PCIe4.0 X4, 2*2.5"SATA bay , DC IN 9-55V 1000W

Key Specification

- Intel® 12th Gen Alder lake-S LGA1700 CPU
- Intel® Q670 Chipset
- 2*DDR5 4800MHz SODIMM, up to 64GB
- 1*DP+1*HDMI and 1*VGA, UHD 8K+4K three independent displays
- 2*Intel® I226V Gigabit LAN, 1*Intel® I219LM Gigabit LAN, support iAMT12.0
- 2*PCIe X16 (X8 signal)+2*PCIe X16 (X4 signal), four PCIe expansions
- 2*2.5"SATA3.0 Bays, 1*M.2 2280 PCIeX4 NVMe
- Support TPM2.0 and iVpro technology
- Fanless cooling for CPU , AI/GPU card with efficient fan cooling design
- Support dual 450W GPU + dual 75W/150W AI acceleration cards
- 1000W DC IN 9-55V, and wide temperature fanless AC-DC power adapter with PFC



Product Overview

BRAV-7721-WP is a workstation-grade edge computing system, powered by the Intel® Alder Lake-S series CPU, Q670 chipset, dual-channel DDR5 memory, and four PCIe expansions. It provides flexible computing power options, multiple IO interfaces, a high PFC power supply, a high-efficiency cooling solution, and an industrial-grade reliability design. It is highly suitable for applications in V2X MEC, highway event detection, unmanned experimental vehicles, high-precision machine vision, and other fields.

Product Parameters

System

Processor Intel® Alder lake-S 12th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® Q670 PCH

RAM 2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.

Graphics Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, support 3 independent displays

LAN 2* Intel I226V, 10-1000M; 1* Intel I219LM,10-1000M, iAMT 12.0

USB 4* USB3.2(10G)+2*USB3.0(5G)

Display 1* DP+1*HDMI+1* VGA

Audio /

COM/others 2*RS232/422/485

DIO optional16 bit DIO, TTL, programmable input/output

Storage 2*2.5"SATA3 HDD(RAID0/1),15mm thickness; 1*M.2 2280 M-Key(PCIe4.0X4), NVMe; 1*mSATA(optional)

LED 1*PowerLED, 1*HDD LED

Control Switch 1*Power SW, 1*AT/ATX SW, 1*Clear CMOS SW

Power Requirement DC IN 9-55V, 1000W max.; TDP:TBD

Watchdog Timer Watchdog timeout programmable via software 1 to 255 second

OS Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7

Expansion

1*Mini PCIe(PCIeX1/USB+SIM),4G LTE/PCIe; 1*Mini PCIe(PCIeX1/SATA),mSATA; 1*M.2 3052 B-Key(PCIeX1/USB+SIM),5G NR; 1*M.2 2280 M-Key(PCIe4.0X4), NVMe; 2*PCIe5.0X16(X8),GPU<450W<300mm 2*PCIeX16(4.0X4+3.0X4),AI card<75W(150W)<300mm

Mechanical

Structure SGCC frame, Aluminum-magnesium alloy chassis, temperature control by PWM fan

Color Granite gray + Black

Mounting Desktop mounting with anti-vibration rubber pads

Dimension 245*376.8*254.8mm(W*H*D)

Net weight TBD

Environmental

Operating Temp -20°C~60°C , with air flow

StorageTemp -40°C~85°C

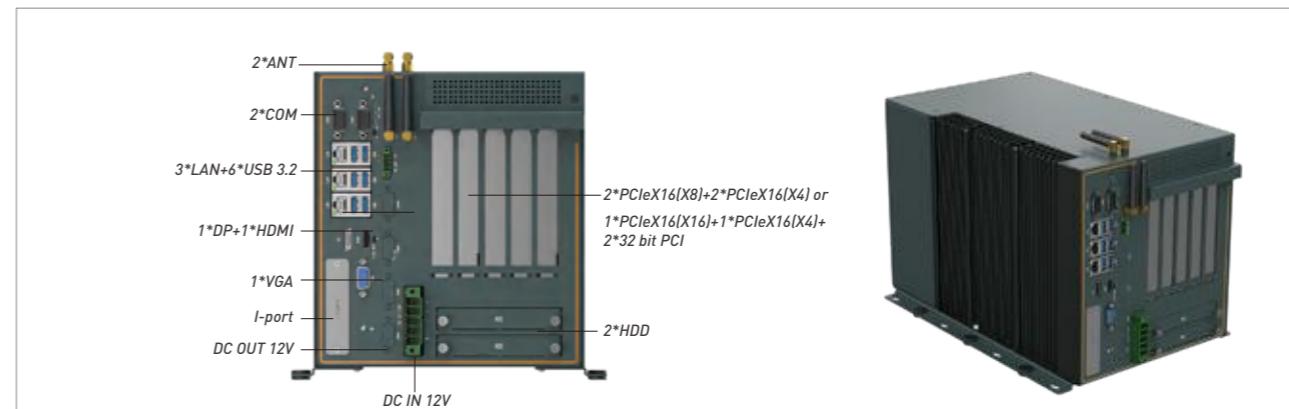
StorageHumidity 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)

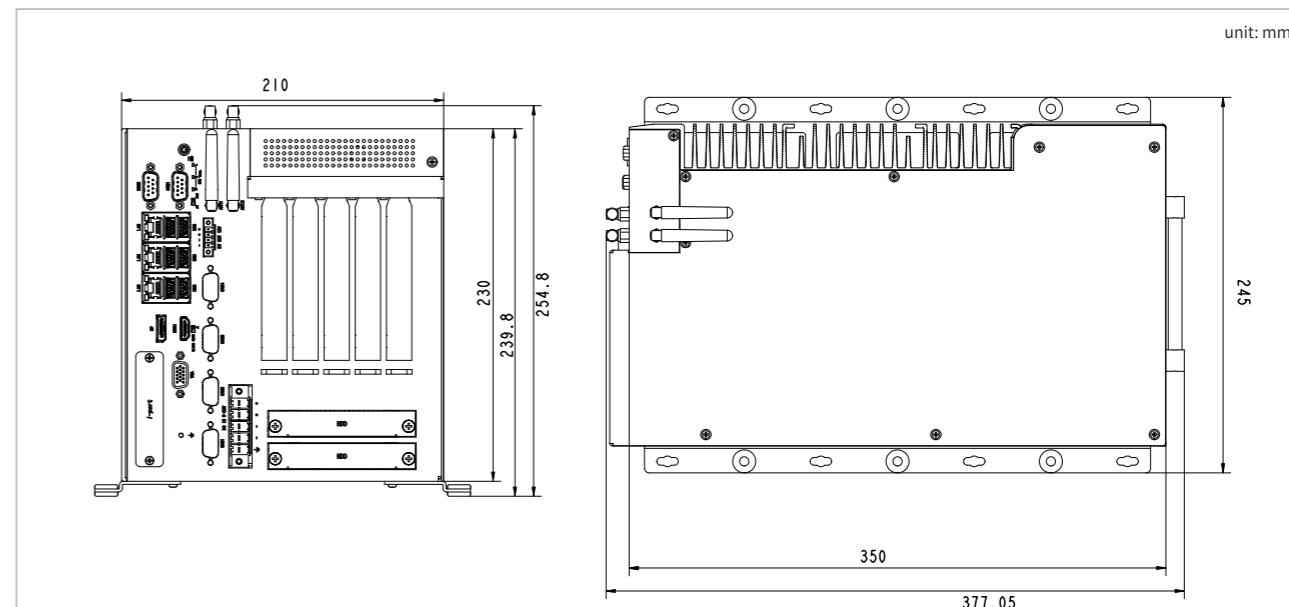
Shock 50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)

Certification/EMC CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
BRAV-7721-WP	Intel® Alder lake-S 12th-Gen LGA1700 CPU, Q670 PCH	2*DDR5 SODIMM, 3*LAN, 6*USB3.2, 2*USB2.0(built-in), 2*COM, 1*VGA, 1*DP, 1*HDMI, 16bit DIO(built-in), 1*I-Port, 2*2.5"SATA bay, 2*Mini PCIe, 1*M.2 B-Key, 1*M.2 M-Key, DC 9-55V	Default: ECX-254 2*PCIeX16(X8)+2*PCIeX16(X4) Optional: ECX-275 1*PCIeX16(X16)+1*PCIeX16(X4) 2*32bit PCI
Recommend GPU/AI Module			Support a maximum 2*450W GPU+2*75W/150W AI module (GPU/AI module<300mm)
UHP-500DC12			AC/DC power adapter, DC12V@41.7A, 90-264V AC IN, DC OUT 12V , wide temperature fanless, 500W
LMF1000-20B12			AC/DC power adapter, DC12V@80A, 90-264V AC IN or 120-370V DC IN, DC OUT 12V, 1000W, low-noise fan

CNTI-3A51

Loongson 3A5000 CPU, 2*LAN, 4*USB3.0, 2*USB2.0, 1*VGA, 1*HDMI, 12*RS232/422/485, 24 bit DIO, 1*M.2 M-KEY, 1*M.2 E-KEY, DC 12-36V

Key Specification

- Loongson3A5000 CPU, 4 Cores, 2.3-2.5GHz Primary Frequency
- LS7A1000 Chipset
- 2*DDR4 3200MHz DIMM memory, up to 64GB
- 1*VGA+1*HDMI
- 2*LAN, 4*USB3.0, 2*USB2.0, 12*COM(RS232/422/485), 1*24bit Iso. DIO
- 1*M.2 2230 E-Key, optional support WiFi / Bluetooth
- 1*2.5"SATA bay, 1*M.2 2280 M-Key, support NVMe storage
- DC 9~36V wide power input, with overcurrent, overvoltage, short
- circuit and reverse connection protection



Product Overview

CNTI-3A51 is a domestically-made fanless box computer, equipped with the Loongson 3A5000 processor, LS7A1000 chipset, 2*DDR4 3200MHz dual-channel memory, up to 32GB. It supports dual display with VGA + HDMI, 2*LAN, 4*USB3.0, 2*USB2.0, 12*multi-mode isolated COM ports (RS232/422/485), 1*124bit isolated DIO, 2*2.5" SATA3.0, 1*M.2 2280 M-KEY supporting NVMe storage, 1*M.2 2230 E-KEY WIFI interface, and DC 9-36V wide voltage power supply. It is suitable for applications in industries such as highway toll collection, rail transit ticketing, and power automation.

Product Parameters

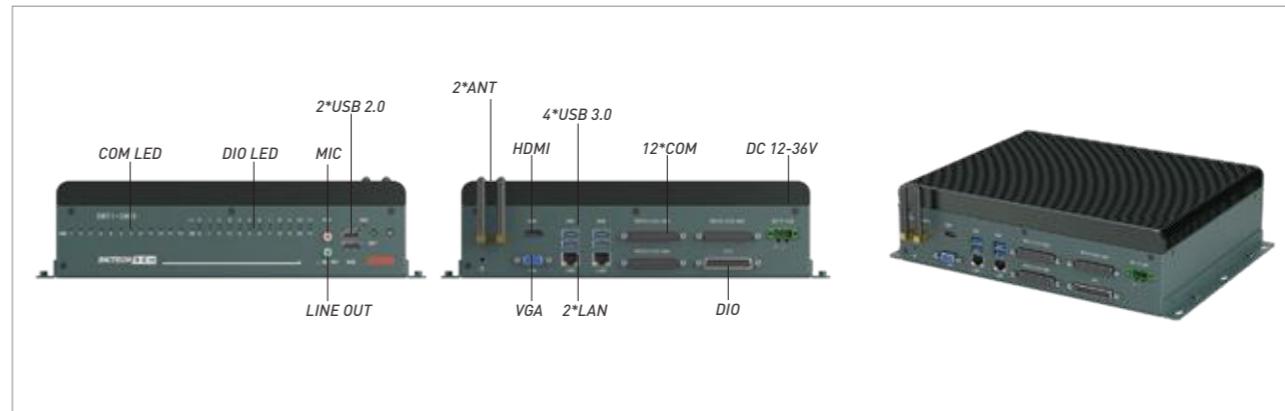
System

Processor	Loongson3A5000, 4 cores, 2.3GHz-2.5GHz, LS7A1000PCH	Power Requirement	DC 12~36V; TDP: TBD
RAM	2*288 Pin DIMM, DDR4 3200MHz, 64GB max.		
Graphics	nuclear display		
LAN	2*88E1512, 10-1000M	Structure	Aluminum-magnesium alloy, SGCC chassis
USB	4*USB3.0, 2*USB2.0	Color	Granite Gray + Graphite Black
Display	1*HDMI+1*VGA	Mounting	Desktop mounting
Audio	1*Line out+1*MIC, Realtek ALC269Q-VC	Dimension	312*220.2*78mm(W*H*D)
COM/others	12*RS232/422/485(3*DB44)	Net weight	TBD
DIO	24 bit isolated DIO(12bit DI, 12bit DO,DB25)		
Storage	2*2.5" SATA3.0; 1*M.2 2280 M-key(PCle2.0X4),NVMe		
LED	1*PW LED, 1*HDD LED, DIO LED, COM LED		
Control Switch	1*Power SW, 1*RST		
OS	UOS/KylinOS/LOONGNIX/openEuler		
Expansion	1*M.2 2280 M-key(PCle2.0X4), NVMe; 1*M.2 2230 E-key(PCleX1/USB), WIFI;		

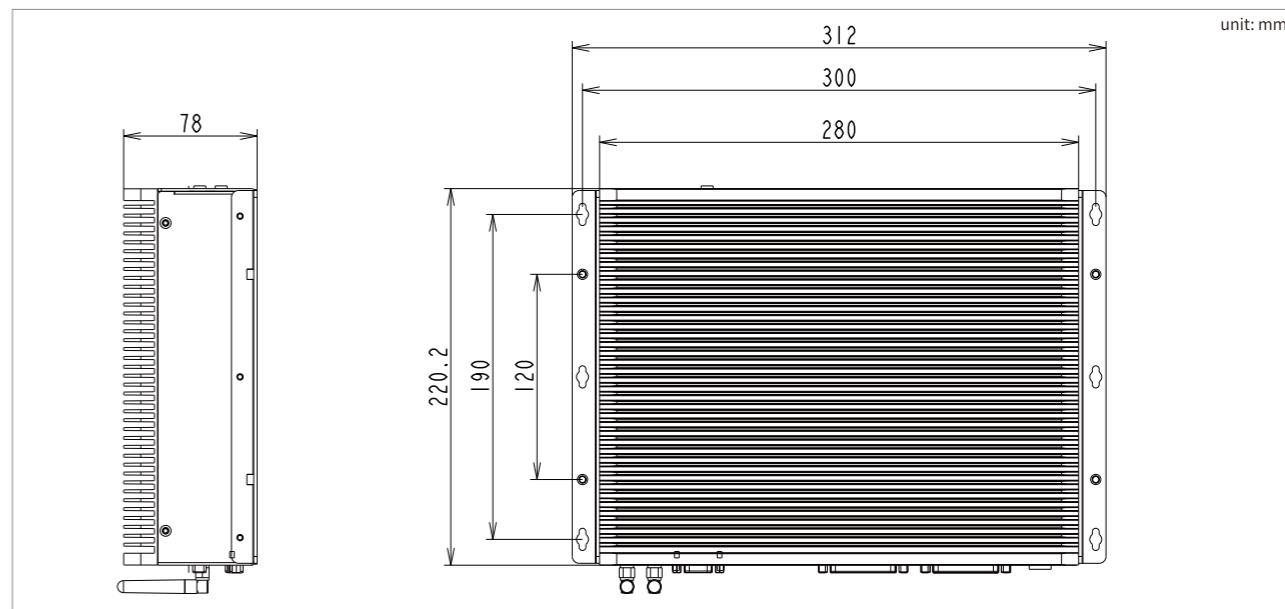
Environmental

Operating Temp	-20°C~60°C , SSD, with air flow
Storage temp.	-40°C~85°C
StorageHumidity	10~95%@40°C, No-condensation
Vibration	5 grms/5-500Hz/random/during operation(SSD); 1 grms/5-500Hz/random/during operation(HDD)
Shock	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)
Certification/EMC	CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
CNTI-3A51-S001	Loongson 3A5000 CPU, LS7A1000 PCH	2*DDR4, 2*LAN, 4*USB3.0, 2*USB2.0, 12*RS232/422/485, 24 bit isolatedDIO, 1*VGA, 1*HDMI, Audio OUT + Mic, 2*2.5"SATA3.0, 1*M.2 2280 M-Key, 1*M.2 2230 E-KEY WIFI, DC 12-36V
PA-120DC19		AC/DC power adapter, DC19V@6.32A,120W

CNTI-R351

Rockchip RK3588 CPU, 4GB Ram, 32GB eMMC, 4*LAN, 2*USB3.0, 2*USB2.0, 1*HDMI, 2*COM, 1*DIO, 2*CAN, 1*Audio out, 1*Mini PCIe, 1*M.2 M-Key, opt. WiFi6+BT5.0, DC 9-36V

Key Specification

- Aluminum magnesium alloy profile shell with fanless heat dissipation
- Rockchip RK3588 CPU, 4 Cortex-A76 and 4 Cortex-A55, 2.4GHz
- Onboard 4GB memory
- 1*HDMI
- 4*LAN, 2*USB3.0, 2*USB2.0, 2*COM, 1*8bit DIO, 2*Iso. CAN2.0,
- 1*Audio out
- 1*Full size Mini PCIe, with SIM card slot, supports 4G LTE
- Opt. onboard Gigabit WiFi6/Bluetooth 5.0
- Onboard 32GB eMMC + 1*M.2 2242 M-Key dual storage
- DC 9~36V wide power input, with overcurrent, overvoltage and reverse connection protection



Product Overview

CNTI-R351 is a fanless box computer, powered by Rockchip RK3588 processor, on-board 4GB memory, and on-board 32GB eMMC storage. HDMI display, 4*LAN, 2*USB3.0, 2*USB2.0, 2*COM (1*RS485, 1*RS232), 1*8bit DIO, 2*Iso. CAN2.0, 1*M.2 2242 M-Key, 1*full size Mini PCIe, with SIM card slot, supports 4G LTE, opt. onboard WiFi6+ BT5.0. DC 9-36V wide power input, is suitable for industrial applications such as logistics visual inspection, AGV, AMR and intelligent connected vehicle MEC.

Product Parameters

System

Processor Rockchip RK3588, 4 Cortex-A76 and 4 Cortex-A55, 2.4GHz

RAM Onboard memory, 4GB LPDDR4

Graphics Mali-G610 GPU, 支持OpenGL ES3.2/OpenCL2.2/Vulkan1.1, 2D and 3D acceleration hardware; HDMI:1920*1080@60Hz

NPU: 6.0TOPS, INT4/INT8/INT16/FP16

LAN 2*RTL8211F, 10-1000M; 2*RTL8111H, 10-1000M

USB 2*USB3.0+2*USB2.0

Display 1*HDMI

Audio Audio out , Realtek ALC5640

COM/others 1*RS232+1*RS485; 2*2.5KV optical iso. CAN (CAN Open2.0,DB9)

DIO 1*8 bit DIO(DB9)

Storage Onboard 32G eMMC, 1*M.2 2242 M-key, NVMe

LED 1*Power LED(on power button), 1*HDD LED

Control 1*Power Button, 1*Remote SW, 1*Recover SW

OS Android,Linux

Expansion 1*Full size Mini PCIe(+SIM), 4G LTE/PCIe moudle; Opt. onboard WiFi6/BT5.0

Mechanical

Structure Aluminum-magnesium alloy, SGCC frame

Color Granite gray + Graphite black

Mounting Desktop mounting, optional DIN-rail/Wall mounting

Dimension 169*100*44.2mm

Net weight

Environmental

Operating Temp -20°C~60°C , SSD, with air flow

Storage temp. -40°C~85°C

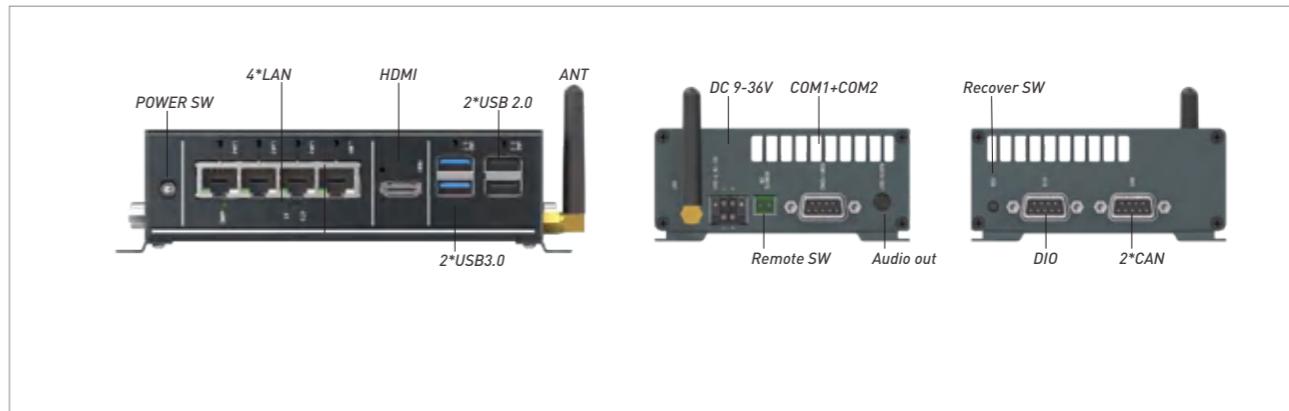
StorageHumidity 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)

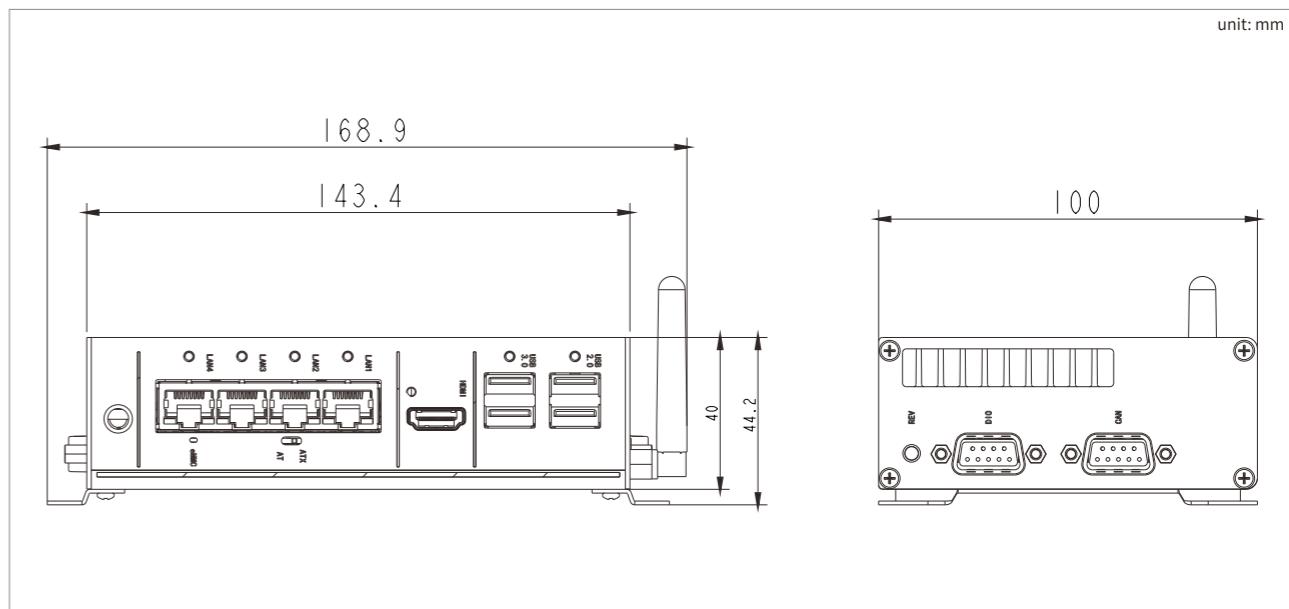
Shock 50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)

Certification/EMC CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
CNTI-R351-S001-4G	Rockchip RK3588 CPU	Rockchip RK3588 CPU, 4GB memory, 32GB eMMC, 4*LAN, 2*USB3.1, 2*USB2.0, 2 *COM (1*RS485, 1*RS232), 1*8bit DIO, 2*Iso. CAN, 1*HDMI, Audio out, 1*Mini PCIe, 1*M.2 2242 M-Key, opt. onboard WiFi6+BT5.0, DC 9-36V
PA-60DC12		AC/DC adapter, DC12V/5A 60W

CNTI-2K10

Loongson 2K1000LA CPU, 2*LAN, 2*CAN2.0, 2*USB2.0, 4*COM, 8*GPIO, 1*M.2 2242 B-KEY, 1*M.2 E-KEY, DC 5V/3A

Key Specification

- Loonson 2K1000LA dual-core processor, 800MHz-1.0GHz
- On-board DDR3 particles, 1GB standard, maximum support 2GB
- 1*SATA2.0 M.2 2242 B-KEY, standard with 32G SSD
- 1*M.2 2230 E-KEY, optional support 4G/WiFi/ Bluetooth
- 2*LAN, 2*USB2.0, 4*COM(2*RS232+2*RS485), 2*CAN2.0, 8*GPIO
- Supports automatic startup or manual startup of the system
- DC 5V/3A power supply



Product Overview

CNTI-2K10 is a domestic fan-less box computer, equipped with Loongson 2K1000LA processor, on-board DDR3 particles, standard memory capacity of 1GB, maximum support 2GB. 2*LAN, 2*CAN2.0, 2*USB2.0, 4*COM, 1*SATA2.0 M.2 2242 interface, 1*M.2 NGFF E-KEY (PCIe2.0X1+USB2.0 signal). DC 5V/3A power supply, suitable for highway tolling, industrial control, Internet of Things data acquisition and other application scenarios.

Product Parameters

System

CPU Loonson 2K1000LA, 800MHz-1.0GHz

RAM Onboard memory, 1GB DDR3 (2GB max.)

Expansion 1*SATA2.0 M.2 2242 B-KEY;
1*M.2 NGFF 2230 E-KEY(PCIe2.0X1+USB2.0), 4G/WIFI/BT

LAN 10M-1000M

USB 2*USB2.0

Display /

Audio /

COM/others 2*RS232+2*RS485; 2*CAN; 1*Micro USB

DIO 8*GPIO (DB9)

Storage 1*SATA2.0 M.2 2242 B-KEY,
standard with32GB SSD

LED 1*Power LED, 1*HDD LED

Control 1*Power Button, 1*RST Button

OS Buildroot/OpenHarmony/Loongnix/SylixOS

Power & TDP DC 5V/3A;
TBD

Mechanical

Structure SGCC frame

Color Granite gray + Pastel blue

Mounting Desktop mounting

Dimension 153*154*46mm

Net weight 0.82KG

Environmental

Operating Temp -10°C~60°C, SSD, with air flow

Storage temp. -40°C~85°C

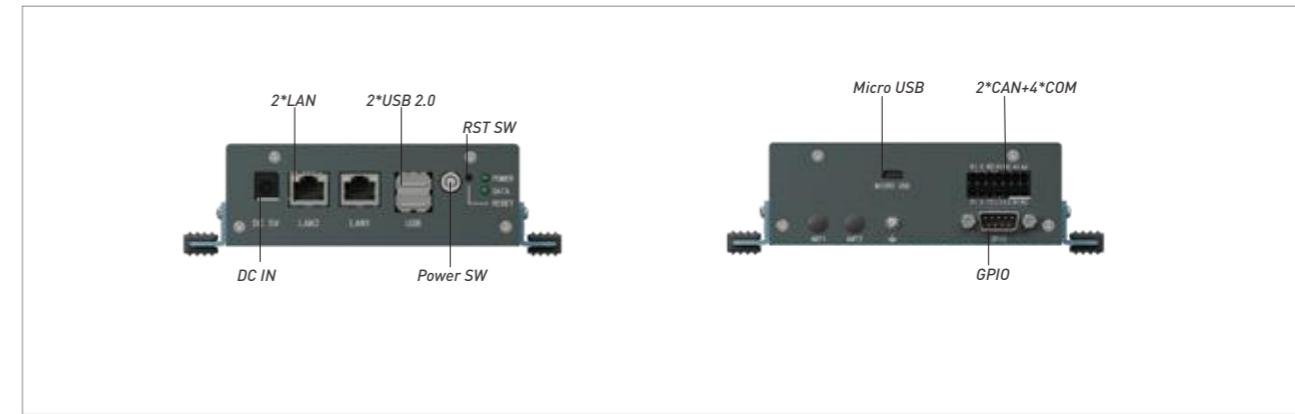
StorageHumidity 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/during operation(SSD);
1 grms/5~500Hz/random/during operation(HDD)

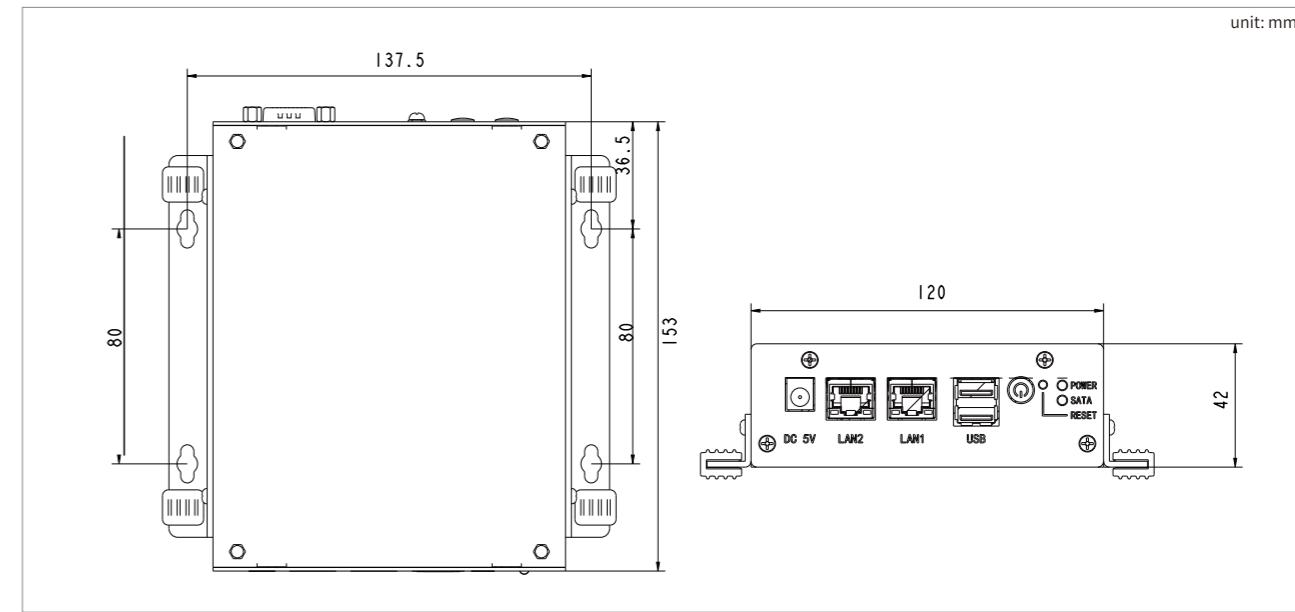
Shock 50g peak acceleration(11ms duration)(SSD);
20g peak acceleration(11ms duration)(HDD)

Certification/ EMC CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
CNTI-2K10	Loongson 2K1000LA CPU	Onboard DDR3 memory, 2*LAN, 2*CAN2.0, 2*USB2.0, 4*COM, 8*GPIO, 1*M.2 2242 B-KEY, 1*M.2 E-KEY, DC 5V/3A

JHCTECH IoT Computer
Connecting the Dots



JHCTECH IoT Computer
Connecting the Dots

KGEC
Edge controller



APPLICATION
▶▶▶
Industrial Robotics

Product Listing B01

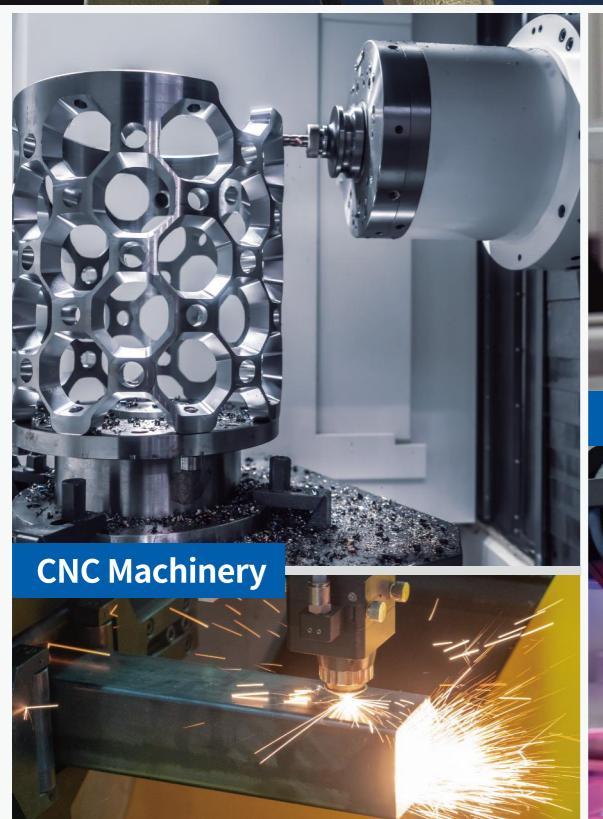
KAGO-6200 B03

KAGO-6300 B05

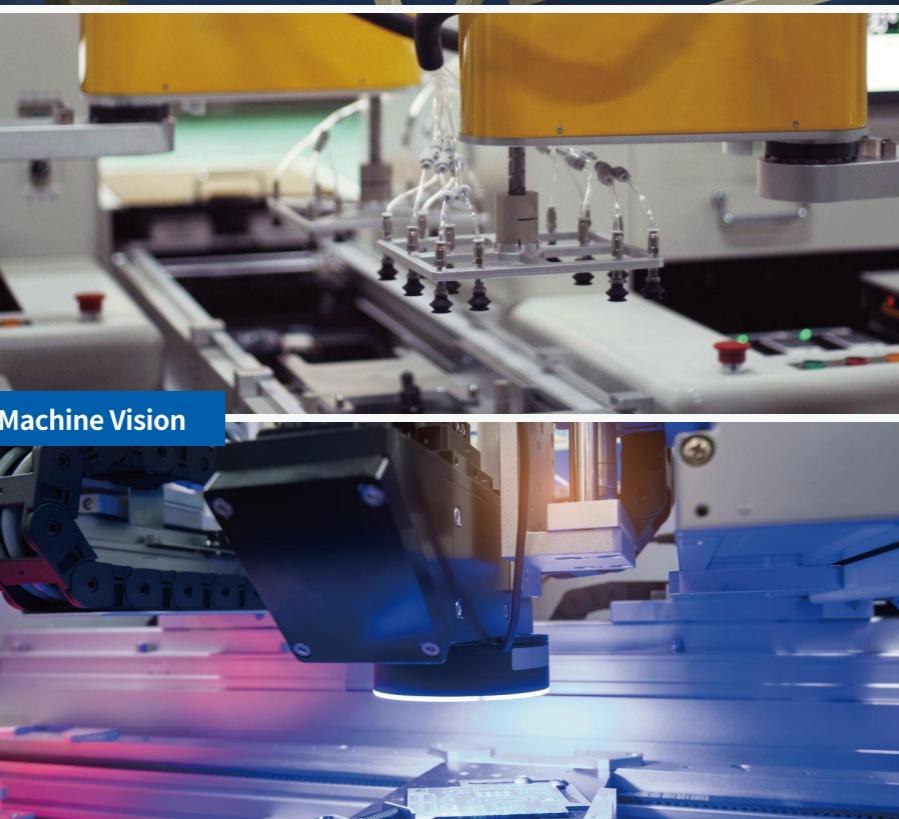
KAGO-6301 B07

KAGO-6310 B09

KAGO-6500 B11



CNC Machinery



Machine Vision



					
KGECA-6200					
System					
CPU	Intel® Elkhart lake Soc CPU, Celeron J6412; Celeron N6210	6th/7th Gen Intel® Skylake-S/Kabylake-S Pentium/Core i3/i5/i7 CPU LGA 1151 socket,max support 65W	6th/7th Gen Intel® Skylake-S/Kabylake-S Pentium/Core i3/i5/i7 CPU LGA 1151 socket,max support 65W	8th gen Intel Whiskeylake U:Celeron 4305U; Core U: i3-8145U; i5-8265U; i7-8565U	Intel 10th Gen. Cometlake-S Core i9/i7/i5/i3/Celeron CPU,LGA 1200 Socket
RAM	1* DDR4 SODIMM 3200MHz, 32GB max.	1* DDR4 2400/2133MHz, 16GB max.	1* DDR4 2400/2133MHz, 16GB max.	2* DDR4 2400MHz ,32GB max.	2*DDR4 SO-DIMM 2933MHz ,64GB max.
Graphics	Intel Gen10 UHD Graphics, H.265/HEVC,HW; HDMI2.0: 4096*2304@60Hz	IntelGen.9 HD Graphics,HEVC/H265 HW DP: 4096*2304@60Hz, DVI-I(DVI-D+VGA) DVI-D: 1920*1200@60Hz, VGA: 2560*1600@60Hz	IntelGen.9 HD Graphics,HEVC/H265 HW DP: 4096*2304@60Hz; DVI-I(DVI-D+VGA) DVI-D: 1920*1200@60Hz, VGA: 2560*1600@60Hz	Intel Gen. 9 UHD Graphics,HEVC/H265 HW HD codec HDMI: 4096*2304@60Hz DVI-D: 2560x1600,60Hz	Intel® UHD Graphics,Supports DirectX 12, OpenGL 4.5&OpenCL 2.1 HDMI: 4096*2160@30Hz, DVI-I(DVI-D+VGA): 1920x1200,60Hz
I/O Interface					
LAN	2*Intel I226V, 10-1000M	2*Intel I210AT,10-1000M	2*Intel I210AT, 10-1000M; 4*Intel I210AT(+POE),802.3af(15.4W)	3*Intel I210AT,10-1000M; 1*Intel® I219LM,iAMT12.0 and iVpro	1*Intel I226V, 10M-2.5G,support WOL; 1*Intel® I219LM , support WOL
USB	2* USB3.1,2*USB2.0	4* USB3.0	4* USB3.0	2*USB3.1 + 2* USB2.0	4*USB3.2 + 3* USB2.0(Build-in)
Display	1* HDMI	1* DP + 1* DVI-I	1* DP + 1* DVI-I	1* DVI-I + 1* HDMI	1* DVI-I + 1*HDMI
Audio	/	/	/	1* Line out + 1* MIC	/
Serial Port	1*RS232/422/485; 1*RS232	2*RS232/422/485 with isolated TVS	2*RS232/422/485 with isolated TVS	2*RS232/422/485	2*RS232/422/485
DIO	6 bit DIO(MI/O)		16-bit Isolator DIO(Phoenix terminal)	8-bit DIO(Phoenix terminal)	/
Storage					
Storage	1*mSATA Full Size,AHCI	1*mSATA full height card	1*2.5" SATA3.0 HDD/SSD 1*mSATA full height card	1*2.5" SATA3.0, 1*mSATA ,AHCI	1*2.5" SATA3.0, 1*mSATA ,AHCI
Expansion					
Expansion	1*Mini PCIe(PCIeX1/USB+SIM),4G/Wifi/BT	1*Mini PCIe(PCIeX1/USB+SIM),4G/Wifi/BT; Optional 1*PCIe3.0 X4(X1) + 1*32bit-PCI; Optional 1*PCIe3.0 X4(X1)	1*Mini PCIe(PCIeX1/USB+SIM),4G/Wifi/BT; Optional 1*PCIe3.0 X4(X1) + 2*32bit-PCI	1*M.2 E-key(PCIe X1/USB2.0),Wifi/BT; 1*Mini PCIe(PCIe X1/USB+SIM),4G/Wifi/ BT	1*Mini PCIe(PCIe X1/USB2.0+SIM),4G/Wifi/BT; Optional 1*PCIe3.0 X4(X4), 4*PoE+LAN
Power Supply					
Power& TDP	DC 12V;Optional DC 9~36V(OFX-075) 15.6W(Celeron J6412,32G DDR4,128G SSD)	DC 12~24V input, 2*2-pin; S001(43.7W I7-7700 4GB)/ (49.4W I7-7700 4GB,+Expansion)	DC 12~24V , 2*2-pin; S001(49.2W I7-6700T 4GB) / (52.8W I7-6700T 4GB,+Expansion)	DC 12~24V, 2*2-pin; 31.68W (CPU I3-8145U 4GB)	DC 12~24V, 2*2-pin; 64.8W(I5-10500E,32GB DDR4,128G HDD)
Mechanical					
Structure	Aluminum chassis, SGCC frame	Aluminum chassis, SGCC frame	Aluminum chassis, SGCC frame	Aluminum chassis, SGCC frame	Aluminum chassis, SGCC frame
Dimension (W*H*D)	130*100*40mm	S001(202*151*57.8mm/ 202*151*109.8mm,+Expansion)	S001(202*151*80.8mm/ 202*151*151mm,+Expansion)	202*151*81mm	202*154*57.8mm/202*154*89.5mm(+Expansion)
Weight	750g	S001: 2.52KG/3.52KG(+Expansion)	S001: 3KG/4.4KG(+Expansion)	2.59KG	1.85KG/2.20KG(+Expansion)
Environmental					
Operating temp	-20°C~60°C , SSD	-20°C~60°C , SSD	-20°C~60°C , SSD	-20°C~60°C , SSD	-20°C~60°C , SSD
Storage temp	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C
Storage Humidity	10~95%@40°C, non-condensing	10~95%@40°C, non-condensing	10~95%@40°C, non-condensing	10~95%@40°C, non-condensing	10~90%@40°C, non-condensing
Vibration	5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)	5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)	5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)	5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)	5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)
Shock	50g peak acceleration(duration;11ms)(SSD); 20g peak acceleration(duration;11ms)(HDD)	50g peak acceleration(duration;11ms)(with SSD); 20g peak acceleration(duration;11ms)(with HDD)	50g peak acceleration(duration;11ms)(with SSD); 20g peak acceleration(duration;11ms)(with HDD)	50g peak acceleration(duration;11ms)(with SSD); 20g peak acceleration(duration;11ms)(with HDD)	50g peak acceleration(duration;11ms)(with SSD); 20g peak acceleration(duration;11ms)(with HDD)
Certification /EMC	CE/FCC Class A RTOS: Intime, EC-Win, RTX-2014/2016, Ubuntu Preempt-RT,Win11/Win10,SUSE, Ubuntu, Wind River, Red Hat Enterprise	CE/FCC Class A RTOS: Intime, EC-Win, RTX-2014/2016 and Ubuntu Preempt-RT,Windows 7, Windows 10, Linux Fedora Ubuntu (Note: 7th gen Intel® Kabylake-S processor does not support Windows 7 32-bit)	CE/FCC Class A RTOS: Intime, EC-Win, RTX-2014/2016 and Ubuntu Preempt-RT Windows 10, SUSE, Ubuntu, Wind River, Red Hat Enterprise (Note: 7th gen Intel® Kabylake-S processor does not support Windows 7 32-bit)	CE/FCC Class A RTOS: Intime, EC-Win, RTX-2014/2016 and Ubuntu Preempt-RT Windows 10, SUSE, Ubuntu, Wind River, Red Hat Enterprise	CE/FCC Class A RTOS: Intime, EC-Win, RTX-2014/2016, Ubuntu Preempt-RT&Xenomai Windows 10, SUSE, Ubuntu, VXWork, Red Hat Enterprise
OS					

KGEC-6200

Intel Elkhart lake CPU, 1*HDMI, 2*LAN, 2*USB3.1, 2*USB2.0, 2*COM, 1*Mini PCIe, 1*mSATA, Mini size, DC 9~36V

Key Specification

- Intel® Elkhart lake SoC CPU
- 1*DDR4 3200 SODIMM, Up to 32GB
- 1*HDMI display, 4K UHD
- 2*USB3.1, 2*USB2.0, 2*COM, 1*MI/O
- 1*Mini PCIe Full Size(PCIeX1+USB2.0)w/ SIM
- 1*mSATA Full Size 6.0Gbps for storage
- Multi mounting, wall mounting , optional DIN-rail Rail /Desktop mounting
- Mini size and Lightweight, fanless cooling design
- DC 12V power input, optional 9~36V wide power input, support OVP,OCP and SCP



I/O View



Product Overview

KGEC-6200 is a brand new edge controller, powered by Elkhart lake SoC series Processor, 1*DDR4 3200 SODIMM, maximum 32GB, Multi IO interfaces, two power supply designs. The mini size is suitable for installation in limited space. It is very suitable for AGV and AMR, machine vision, industrial control and other fields.

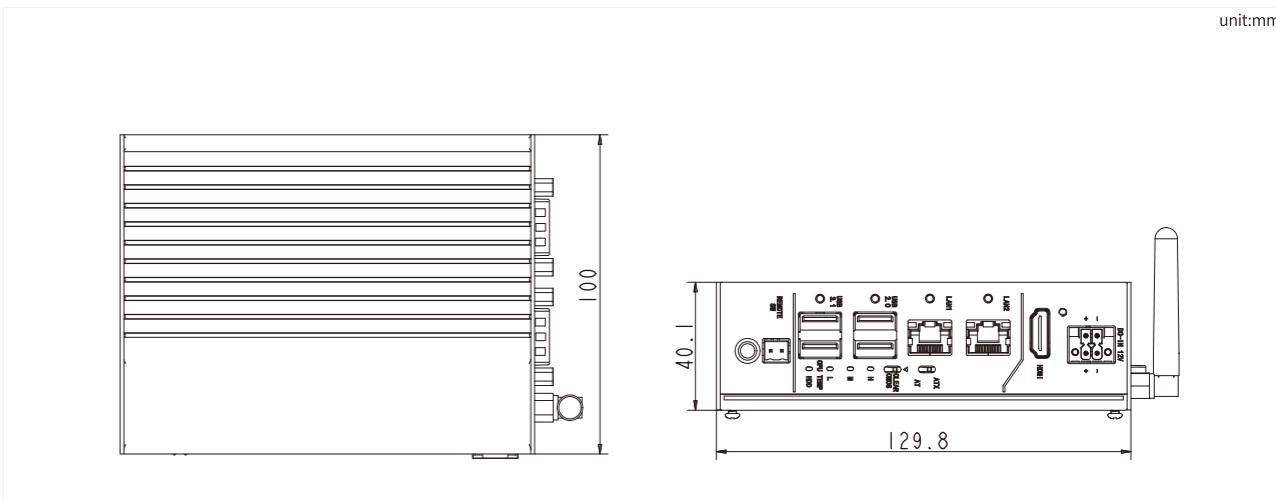
Product Parameters

System	
CPU	Intel® Elkhart lake Soc CPU, Celeron J6412; Celeron N6210
RAM	1*260-Pin SODIMM, DDR4 3200MHz, 32GB max.
Graphics	Intel Gen10 UHD Graphics, HW Encode: H.265/HEVC, H.264/MPEG-4 AVC, MPEG-2, JPEG/MJPEG, VP8; HW Decode: H.265/HEVC, H.264/MPEG-4 AVC, MPEG-2, VC-1/WMV9, JPEG/MJPEG, VP8, VP9 HDMI2.0: 4096*2304@60Hz
LAN	2*Intel I226V, 10-1000M
USB	2*USB 3.1; 2*USB2.0
Display	1*HDMI
COM/others	1*RS232/422/485; 1*RS232; 1*MI/O(6 bit DIO,Optional 2*CAN2.0)
Storage	1*mSATA Full Size, AHCI
LED	1*Power LED, 1*HDD LED, 3*CPU Temp LED (Red is warning, Yellow is high, Green is normal)
Switch	1*Power SW, 1*AT/ATX, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
os	RTOS: INtime, EC-Win, RTX-2014/2016&Ubuntu Preempt-RT Win11/Win10, SUSE, Ubuntu, Wind River, Red Hat Enterprise

Mechanical	
Structure	Aluminum chassis, SGCC frame
Color	Silk grey+Graphite black
Installation	Wall mounting/ DIN-rail Rail mounting/Desktop mounting
Dimension (W*H*D)	130*100*40mm
Weight	750g

Environment	
Operating Temp	-20°C~60°C, wide operating temp. SSD
Storage Temp	-40°C~85°C
Storage Humidity	10~95%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)
Shock	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Certificate/EMC	CE/FCC Class A

Dimensions



Ordering Information

KAGO-6200/S001	Celeron J6412	1*DDR4, 1*HDMI, 2*LAN, 2*USB3.1, 2*USB2.0, 1*RS232/422/485, 1*RS232, 1*Mini PCIe Full Size, 1*mSATA Full Size, , 1*MI/O(Default: 1*6-bit DIO), DC 12V, with wall mounting kit
KAGO-6200/S002	Celeron N6210	
KAGO-6200/S001/WP	Celeron J6412	1*DDR4, 1*HDMI, 2*LAN, 2*USB3.1, 2*USB2.0, 1*RS232/422/485, 1*RS232, 1*Mini PCIe Full Size, 1*mSATA Full Size, , 1*MI/O(Default: 1*6-bit DIO), DC 9-36V, with wall mounting kit
KAGO-6200/S002/WP	Celeron N6210	
Din-Rail mounting (optional)		Stainless steel bracket for 6200 main box +1 Din-Rail fastener
Desktop mounting(optional)		1 Pair of SGCC1.0 horizontal mounting kit
PA-60DC12		AC/DC adapter, DC12V/5A 60W

KGEC-6300

Intel® Skylake-S/Kabylake-S CPU, 2*LAN, 4*USB3.0, DP, DVI-I, 2*COM, modular expansion components, Real-time Operating System RTOS, and Time Sensitive Networking TSN.

Key Specification

- Intel® Skylake-S/Kabylake-S CPU with max 65W
- CPU equipped with active and passive heat dissipation, smart temperature control fan, silent and dustproof
- H110 chipset, CPU (optional dual & quad core)
- 1*DP, 1*DVI-I, dual display interface, prolong display without attenuation
- 2*I210AT internet chipset and optional support for time sensitive networking (TSN)
- 1*PCIe X4 slot/1*32bit-PCI slot, support multiple expansions
- BIOS optimization and support real-time operating system (RTOS)
- Support third-party software platform (optional)
- DC12~24V wide voltage power supply, with reverse polarity protection, overcurrent and overvoltage protection
- Suitable for wall-mounting and Din-rail mounting



Expansion module

Product Overview

KGCE-6300 is a brand-new edge controller with expansion module where the host can be dismantled easily. The CPU is equipped with active and passive heat dissipation design and smart temperature control fan. It is suitable for both wall-mounting and Din-rail mounting, and the extension quantity is flexible. For different application scenario, we offer different expansion modules for selection, which makes it extremely suitable for machine vision, CNC machine tools, construction machinery and other fields.

Product Parameters

System

CPU 6th gen Intel® Skylake-S/
7th gen Intel® Kabylake-S Pentium/Core i3/i5/i7 CPU
Intel® H110 chipset, LGA 1151 slot, max support 65W

RAM 1*260-Pin SODIMM, DDR4 2400/2133MHz, max 16GB

Expansion 1*Mini PCIe(PCIeX1/USB+SIM), 4G/Wifi/BT;
Optional 1*PCIe3.0 X4(X1) + 1*32bit-PCI;
Optional 1*PCIe3.0 X4(X1)

Graphics Intel Gen. 9 HD Graphics, HEVC/H.265 HW codec
DP max resolution 4096*2304@60Hz; DVI-I(DVI-D+VGA) DVI-D max resolution 1920*1200@60Hz, VGA max resolution 2560*1600@60Hz

LAN Storage 2*Intel I210AT, 10-1000M

1*mSATA full size card (SATA & USB2.0)

I/O Port 2*Gig-LAN(RJ45)
4*USB3.0(Type A)
2*RS232/422/485 with isolated TVS (DB9)

1*DP+1*DVI-I

LED 1*power LED, 1*HDD LED, 3*CPU temperature indicator (Red as warning, Yellow as high temperature, Green as green temperature)

Switch 1*power button, 1*AT/ATX switch, 1*Clear CMOS switch

Power & TDP DC 12~24V input, 2*2-pin terminal block connector,
Consumption: S001(43.7W I7-7700 4GB),
with expansion module (49.4W I7-7700 4GB)

Operating System RTOS: INtime, EC-Win, RTX-2014/2016 and Ubuntu Preempt-RT
Windows 7, Windows 10, Linux Fedora Ubuntu
(Note: 7th gen Intel® Kabylake-S processor does not support Windows 7 32-bit)

Mechanical

Structure Aluminum chassis with heat dissipation, SGCC frame

Color Dark gray

Installation method Wall-mounting, Din-Rail mounting

Dimension (W*H*D) S001(202*151*57.8mm), with expansion module(202*151*109.8mm)

Net weight S001: 2.52KG; with expansion module: 3.52KG

Environmental

Operating temperature -20°C~60°C, wide operating temp. SSD

Storage temperature -40°C~85°C

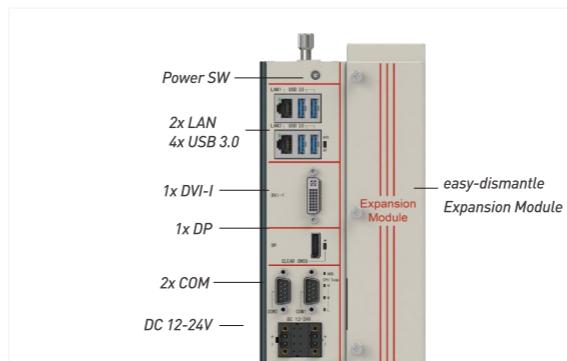
Storage humidity 10~90%@40°C, non-condensing

Vibration 5 grms/5~500Hz/random/during operation (with SSD);
1 grms/5~500Hz/random/during operation (with HDD)

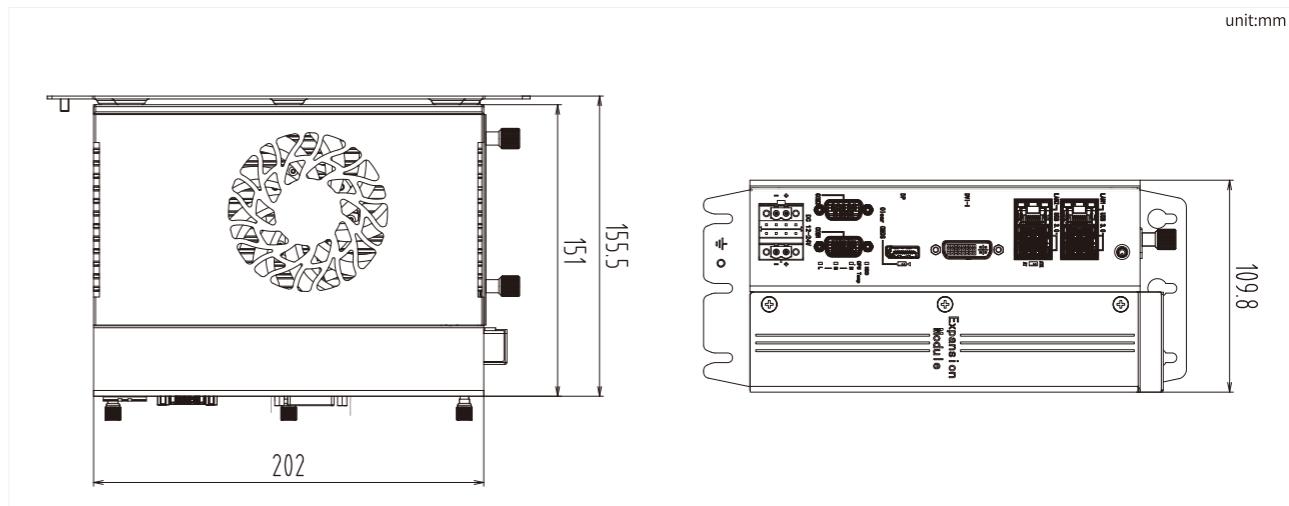
Shock 50g peak acceleration (duration: 11ms) (with SSD);
20g peak acceleration (duration: 11ms) (with HDD)

Certification /EMC CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	RAM	Display	I/O Port	Expansion	Storage	Power Supply
KGEC-6300/S001	Intel® Skylake-S/Kabylake-S LGA1151 CPU	1x DDR4 MAX 16GB	1x DVI-I 1x DP	2x LAN 4x USB3.0 2x COM	1x Mini PCIe	1x mSATA	DC 12~24V
1 Slot Expansion module	1*PCIeX4 Slot(X1signal) or 1*PCI single expansion slot						
2 Slot Expansion module	1*PCIeX4 Slot(X1signal)+1*PCI dual expansion slot						
PA-120DC19	AC/DC adapter, direct current of 19V/6.32A 120W						

CPU Support

Model	Intel® Core™				Intel® Pentium®			
	Series	I7-7700	4C8T	I7-7700T	4C8T	G4600	2C2T	G4600T
7th Gen	I5-7500	4C4T	I5-7500T	4C4T				
	I3-7100	2C4T	I3-7100T	2C4T				
	I7-6700	4C8T	I7-6700T	4C8T	G4400	2C2T	G4400T	2C2T
6th Gen	I5-6500	4C4T	I5-6500T	4C4T				
	I3-6100	2C4T	I3-6100T	2C4T				

KGEC-6301

Intel® Skylake-S/Kabylake-S CPU,2*LAN,4*POE,4*USB3.0,DP,DVI-I,2*COM,16-bit Iso DIO, Modular expansion components,Real-time Operating System RTOS, and Time Sensitive Networking TSN.

Key Specification

- Intel® Kabylake-S/Skylake-S CPU,max 65W
- CPU equipped with active and passive heat dissipation,smart temperature control fan,silent and dustproof
- H110 chipset,CPU(optional dual & quad core)
- 1*DP, 1*DVI-I,dual display interface,prolong display without attenuation
- 2*I210AT internet chipset and optional support for time sensitive networking (TSN)
- 1*PCIe X4 slot, 2*32bit-PCI slot,support multiple expansion modules
- 4 * I210 AT chipset POE camera interface and 16 optical isolation DIO
- BIOS optimization and support real-time operating system (RTOS)
- Support third-party software platform (optional)
- DC12~24V wide voltage power supply,with reverse polarity protection, overcurrent and overvoltage protection
- Suitable for wall-mounting and Din-rail mounting



Expansion module

Product Overview

KGEC-6301 is a brand new edge controller with 2*LAN and 4*POE. It adopts Intel I210AT internet chipset, which support EtherCAT time sensitive networking (TSN) and can connect to network cameras. The CPU is built with active and passive heat dissipation design and supports wall-mounting and Din-rail mounting. It is also equipped with smart temperature control fan, the expansion module can be easily dismantled from the host, and the expansion quantity is flexible. For different application scenario, we offer different expansion modules for selection, which makes it extremely suitable for machine vision, CNC machine tools, construction machinery and other fields.

Product Parameters

System

CPU 6th gen Intel® Skylake-S/7th gen Intel® Kabylake-S Pentium/Core i3/i5/i7
CPU LGA 1151 slot,max support 65W

RAM 1*260-Pin SODIMM, DDR4 2400/2133MHz, max16GB

Expansion 1*Mini PCIe(PCIeX1/USB+SIM),4G/Wifi/BT;
Optional 1*PCIe3.0 X4(X1)+2*32bit-PCI

Graphics Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec
DP: 4096*2304@60Hz ;
DVI-I(DVI-D+VGA),DVI-D: 1920*1200@60Hz,
VGA: 2560*1600@60Hz

LAN 2*Intel I210AT, 10-1000M;
4*Intel I210AT(+POE),802.3af(15.4W)

Storage 1*2.5" SATA3.0 HDD/SSD
1*mSATA full size card (SATA & USB2.0)

DIO 16-bit Iso DIO,8-bit 2.5KV opto-isolator input (H:5-24V, L:0-1.5V),
8-bit 2.5KV opto-isolator output(200mA)

I/O Port 2*Gig-LAN(RJ45),4*POE (RJ45),1*DP+1*DVI-I
4*USB3.0; 1*MIO with CAN,Uart signal,
16-bit Iso DIO(Phoenix terminal),
2*RS232/422/485 with isolated TVS(DB9)

LED 1*power LED, 1*HDD LED, 3*CPU temperature indicator(Red as warning,
Yellow as high temperature, Green as normal temperature)

Switches 1*power button, 1*AT/AT switch, 1*Clear CMOS switch

Power DC 12~24V input, 2*2-pin terminal block connector, power consumption:
Requirement S001(49.2W I7-6700T 4GB) ,with expansion module (52.8W I7-6700T 4GB)

Operating System RTOS: INtime, EC-Win, RTX-2014/2016 and Ubuntu Preempt-RT
Windows 7, Windows 10, Linux Fedora Ubuntu
(Note: 7th gen Intel® Kabylake-S processor does not support Windows 7 32-bit)

Watchdog timer programmable via software 1 to 255 second

Mechanical

Structure Aluminum chassis, SGCC frame

Color Dark Grey

Installation Method Wall-mounting,Din-Rail mounting

Dimension (W*H*D) S001(202*151*80.8mm), with expansion module (202*151*151mm)

Net weight S001: 3KG; with expansion module: 4.4KG

Environmental

Operating temperature -20°C~60°C with wide temperature SSD

Storage temperature -40°C~85°C

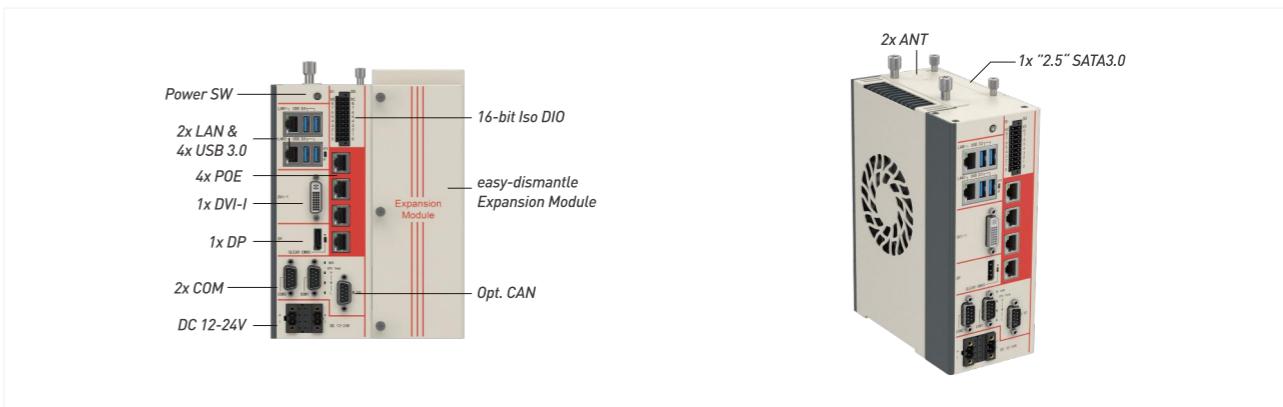
Storage humidity 10~95%@40°C, Non-condensing

Vibration 5 grms/5~500Hz/random/during operation(with SSD);
1 grms/5~500Hz/random/during operation(with HDD)

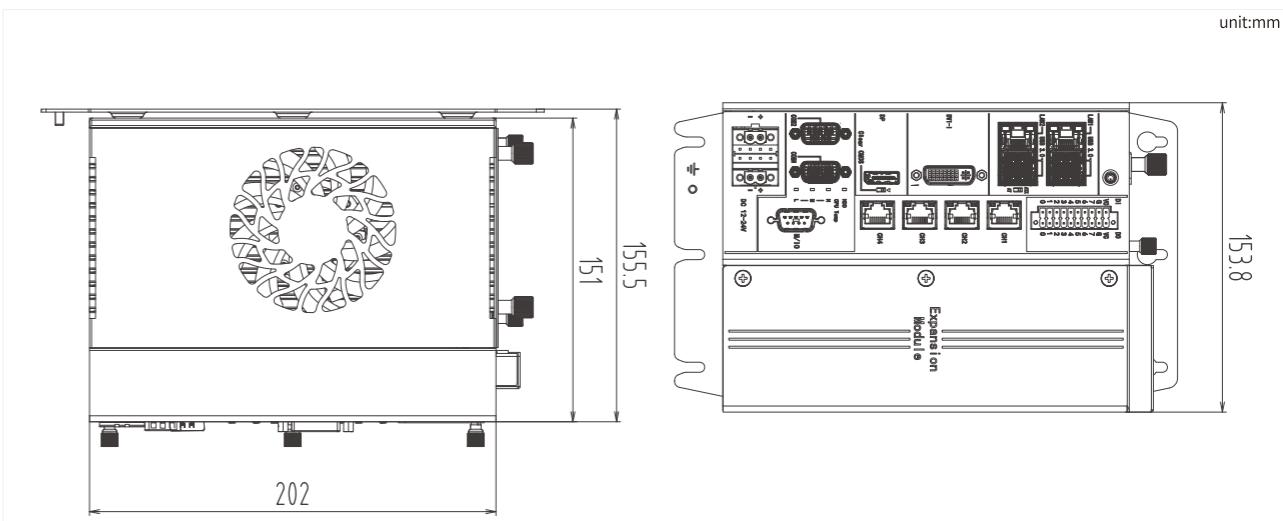
Shock 50g peak acceleration(duration:11ms)(with SSD);
20g peak acceleration(duration:11ms)(with HDD)

Certification /EMC CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	RAM	Display	I/O Port	Expansion	Storage	Power Supply
KGEC-6301/S001	Intel® Skylake-S/Kabylake-S LGA1151 CPU	1x DDR4 MAX 16GB	1x DVI-I 1x DP	2x LAN/4x POE 4x USB3.0 2x COM 16bit Iso DIO	1x Mini PCIe	1x mSATA	DC 12~24V
3 slot expansion module	1*PCIeX4 Slot(X1 signal)+2*PCI,3 expansion slot						
PA-120DC19	AC/DC adapter,direct current of 19V/6.32A 120W						
PA-220DC24	AC/DC adapter,direct current of 24V/9.17A 220W						

CPU Support

Model	Intel® Core™						Intel® Pentium®			
	Series	I3-7100	2C4T	I5-7500	4C4T	I7-7700	4C8T	G4600	2C2T	G4600T
7th Gen	I3-7100T	2C4T	I5-7500T	4C4T	I7-7700T	4C8T				
	I3-6100	2C4T	I5-6500	4C4T	I7-6700	4C8T	G4400	2C2T	G4400T	2C2T
6th Gen	I3-6100T	2C4T	I5-6500T	4C4T	I7-6700T	4C8T				

KGEC-6310

Intel® Whiskey lake-U CPU, 4*LAN, 2*USB3.1, 3*USB2.0, HDMI, DVI-D, 2*COM, 8-bit DIO, Real-time Operating System RTOS, and Time Sensitive Networking TSN.

Key Specification

- Intel® Whiskey lake-U CPU
- Aluminum chassis and fanless heat dissipation design
- 1*HDMI, 1*DVI-D, Dual display interface, prolong display without attenuation
- 3*I210AT Internet chipset, optional support for time sensitive networking (TSN)
- 1*I219LM, support iAMT12.0
- BIOS optimization and support real-time operating system (RTOS)
- 1*Mini PCIe with SIM slot, 1*M.2,2230 E-Key
- Support third-party software platform (optional)
- DC12~24V wide voltage power supply, with reverse polarity protection, overcurrent and overvoltage protection
- Suitable for wall-mounting and Din-rail mounting



Product Overview

KGEC-6310 is a brand new edge controller with 4*LAN ports. Three of the four LAN ports use Intel I210AT internet chipset, which support EtherCAT Protocol and able to connect to network cameras. It is suitable for both wall-mounting and Din-Rail mounting. BIOS optimize and support real-time system (RTOS), Ubuntu preempt-RT and optional support to INTIME. With compact aluminum chassis and fanless heat dissipation design, KGEC-6310 is extremely powerful and suitable for machine vision, CNC machine tools, construction machinery and other fields.

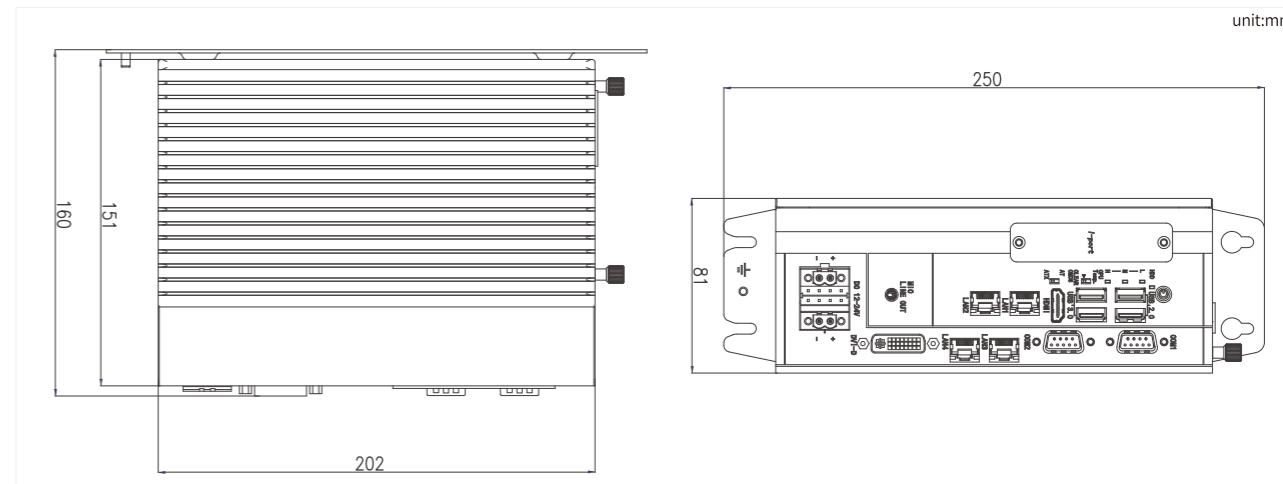
Product Parameters

System	
CPU	8th gen Intel Whiskeylake U:Celeron 4305U; Core U:I3-8145U; I5-8265U; I7-8565U
RAM	dual channel DDR4 SO-DIMM , max support 2400MHz, max32GB
Expansion	1*M.2 E-key(PCIe X1/USB2.0), WiFi/BT; 1*Mini PCIe(PCIe X1/USB+SIM),4G/Wifi/ BT
Graphics	Intel Gen. 9 UHD Graphics,HEVC/H265 HW HD codec HDMI max resolution 4096*2304@60Hz DVI-D max resolution 2560x1600,60Hz
Audio	Optional support Realtek ALC662 audio, 1*Line out & Mic High fidelity audio support 5.1audio channel
LAN	3*Intel I210AT PCIe Gig. Ethernet, 10/100/1000Mbps; 1*Intel®I219LM , support iAMT12.0 and iVpro tech
Storage	1*2.5"SATA3.0 HDD/SSD, 1*mSATA full-size card,support AHCI
I/O Port	4*Gig-LAN(RJ45); 2*USB3.1(Type A), 2*USB2.0(Type A) 2*RS232/422/485 (DB9) 1*8-bit DIO (1*10Pin Phoenix terminal) 1*HDMI+1*DVI-D 1*Line out&Mic 3.5mm phone jack
I-port	1*I-port support 1*USB2.0, 1*DVI-D, Mini-PCIe, M.2 and other expansions
LED	1*power LED, 1*HDD LED, 3*CPU temperature indicator(Red as warning, Yellow as high temperature, Green as green temperature)
Switch	1*power button, 1*AT/ATX switch, 1*Clear CMOS switch
Mechanical	
Power Requirement	DC 12~24V input, 2*2-pin terminal block connector, Consumption:12V/2.64A (CPU I3-8145U 4GB)
Operating System	RTOS: INTIME, EC-Win, RTX-2014/2016 and Ubuntu Preempt-RT Windows 10, SUSE, Ubuntu, Wind River, Red Hat Enterprise
Watchdog timer	Programmable timeout interruption period or system reset from 1 to 255 secs
Environmental	
Structure	Aluminum chassis, SGCC frame
Color	Dark grey
Installation Method	Wall-mounting,Din-Rail mounting
Dimension (W*H*D)	202*151*81mm
Net Weight	2.59KG
Operating temp	-20°C~60°C wide operating temp. SSD
Storage temp	-40°C~85°C
Storage humidity	10~95%@40°C, Non-condensing
Vibration	5 grms/5~500Hz/random/during operation(with SSD); 1 grms/5~500Hz/random/during operation(with HDD)
Shock	50g peak acceleration(duration;11ms)(with SSD); 20g peak acceleration(duration;11ms)(with HDD)
Certification /EMC	CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	RAM	Display	I/O Port	Audio	Expansion	Storage	Power Supply
KGEC-6310/S001	Intel® Core I3-8145U							
KGEC-6310/S002	Intel® Core I5-8265U	2x DDR4 MAX 32GB	1x HDMI	4x LAN 2x USB 3.1 2x USB 2.0 8-bit DIO 2x COM	1x Line out 1x MIC	1x Mini PCIe 1x M2	1x mSATA 1x "2.5" SATA3.0	DC 12~24V
KGEC-6310/S003	Intel® Core I7-8565U							
KGEC-6310/S004	Intel® Celeron 4305U							
PA-60DC12	AC/DC adapter, direct current of 12V/5A 60W							

KGEC-6500

Intel® Comet lake-S CPU+H420E PCH, 2*DDR4, dual displays, 2*LAN, 4*USB3.2, 3*USB2.0, 2*COM, 1* PCIeX4 expansion slot, DC 12~24V

Key Specification

- Intel® Comet Lake-S CPU, up to 10 cores 65W
- Dual-channel DDR4 2933MHz SODIMM, up to 64GB
- Intel® H420E chipset, long life cycle
- 1*HDMI and 1*DVI-I dual displays, display signal extension without attenuation
- Intel® I226V supports multiple real-time industrial Ethernet protocols
- 1 * PCIeX4 slot (X4) can be flexibly removed from the modular design, supporting the expansion of POE network cards and motion control cards
- DC 12~24V wide voltage supply, with reverse connection, overcurrent, overvoltage protection
- Wall mounting and DIN-rail Rail mounting



Expansion

Product Overview

KGEC-6500 is a high-performance industrial edge controller equipped with Intel Comet Lake-S CPU series processor, with dual channel memory, dual storage. I226V network supports EtherCAT and other real-time industrial Ethernet protocols, active and passive cooling design, compact size, flexible modular expansion components, a variety of installation methods, and it is suitable for CNC machinery and industrial robots and other fields.

Product Parameters

System

CPU Intel 10th Gen. Cometlake-S Core i9/i7/i5/i3/Celeron CPU, LGA 1200 Socket, 65W; Intel H420E chip

RAM Dual-channel 2 *260pin DDR4 SODIMM,2933MHz, 64GB max.

Graphics Intel® UHD Graphics, DirectX 12, OpenGL 4.5 & OpenCL 2.1, HDMI:4096*2160@30Hz(4K), DVI-I (DVI-D+VGA): 1920x1200@60Hz, VGA: 1920x1200@60Hz

LAN 1*Intel I226V, 10M-2.5G,WOL; 1*Intel®I219LM, WOL

USB 2*USB3.1, 2*USB2.0(Build-in)

Display 1*HDMI+1*DVI-I

COM/others 2*RS232/422/485(DB9), 1*RS232(Build-in)

Storage 1*2.5" SATA3.0 HDD/SSD, 1*mSATA Full Size, AHCI

LED 1*Power LED, 1*HDD LED, 3*CPUTemp LED (Red is warning, Yellow is high, Green is normal)

Switch 1*Power SW, 1*AT/ATX, 1*Clear CMOS, COM1/COM2

WDT programmable via software 1 to 255 second

OS RTOS: INTIME, EC-WIN, RTX-2014/2016, Ubuntu Preempt-RT& Xenomai, Windows 10, SUSE, Ubuntu, VXWORK, Red Hat Enterprise

Expansion 1*Mini PCIe(PCIe X1/USB2.0+SIM), 4G LTE/Wifi+BT; 1*PCIe3.0 X4(X4), 4*IEEE-802.3at(PoE+)+LAN

Power&TDP DC 12~24V, 2*2-pin; 64.8W (i5-10500E, 32GB DDR4, 128G HDD)

Mechanical

Structure Aluminum chassis, SGCC frame

Color Silk grey+Graphite black

Installation Wall mounting and DIN-rail Rail mounting(without expansion)

Dimension (W*H*D) 202*154*57.8mm; 202*154*89.5mm(+expansion)

Weight 1.85KG; 2.20KG(+expansion)

Environment

Operating Temp -20°C~60°C ,wide operating temp. SSD

Storage Temp -40°C~85°C

Storage Humidity 10~90%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)

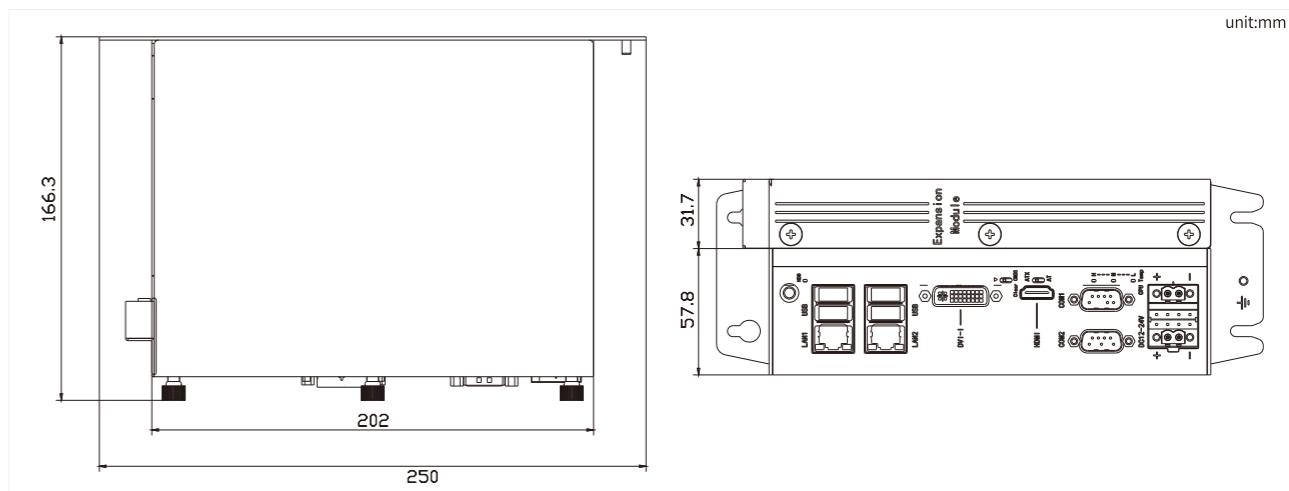
Shock 50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)

Certificate CE/FCC Class A

I/O View



Dimensions

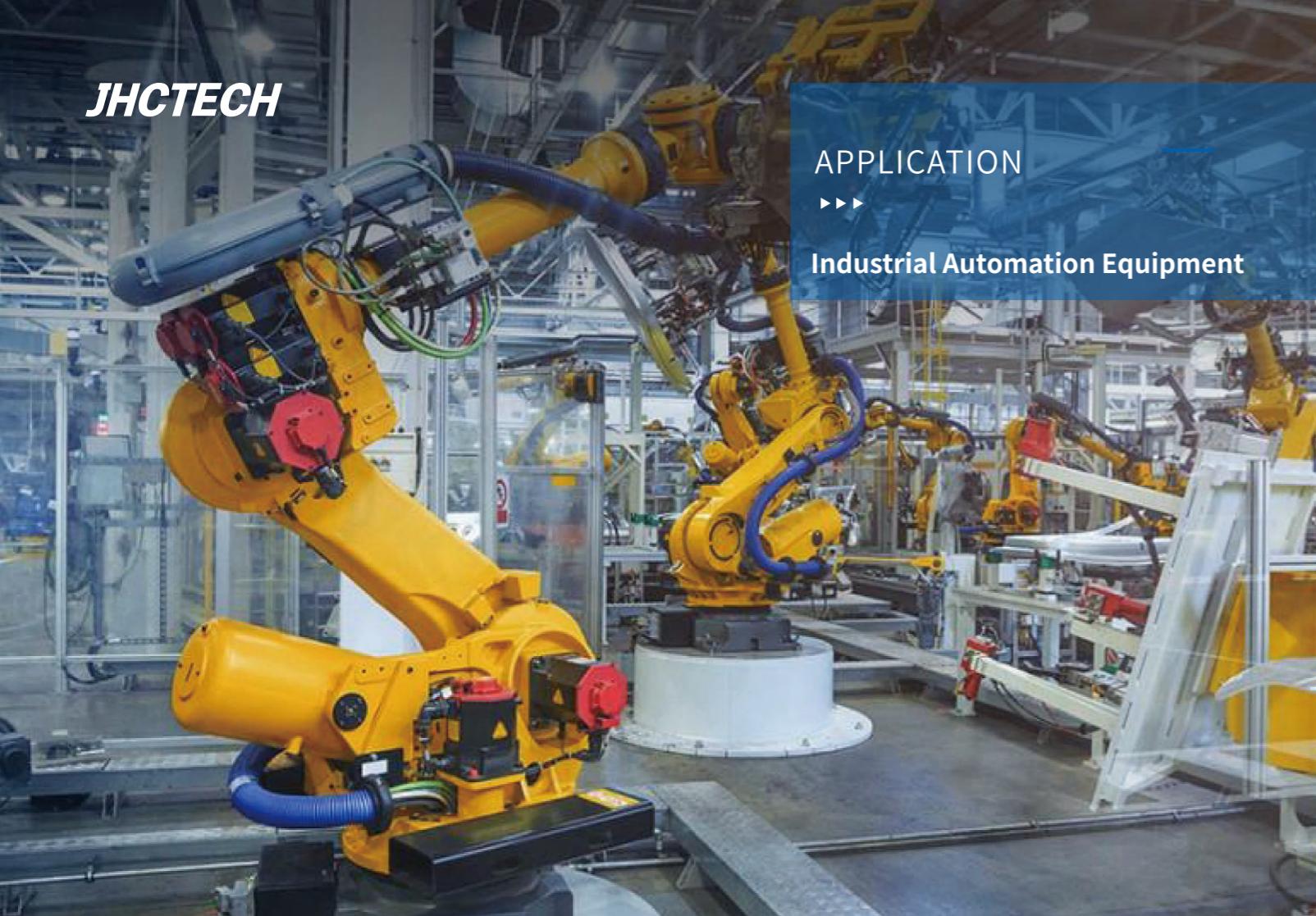


Ordering Information

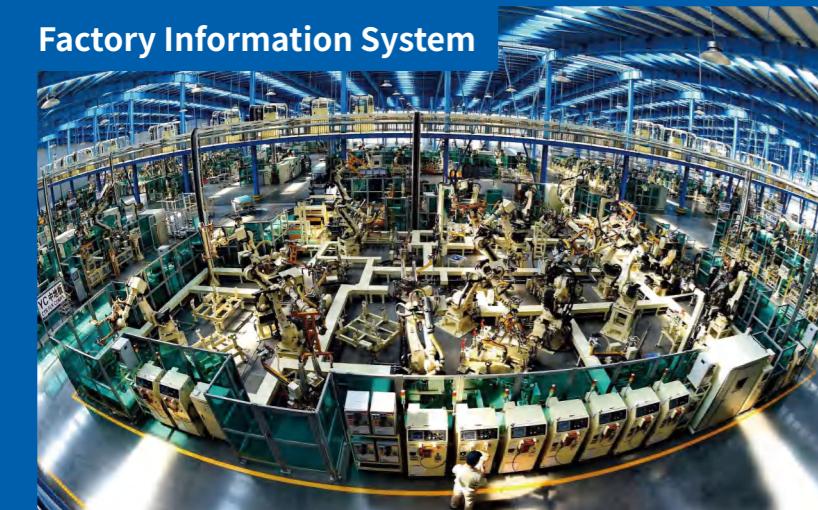
Model	Processor	
KAGO-6500/S001	Intel® 10th Gen Comet lake-S LGA1200 CPU	2*DDR4, 1*DVI-I, 1*HDMI, 2*LAN, 4*USB3.2, 3*USB2.0, 2*RS232/422/485, 1*RS232, 1*Mini PCIe Full Size, 1*mSATA Full Size, 1*2.5"SATA bay, DC 12~24V
1 slot expansion		ECX-273: 1*PCIe3.0X4(X4)
PA-120DC19		AC/DC adapter, DC12V/5A 60W
PA-220DC24		AC/DC adapter, DC12V/5A 60W
6500-S001 Din-Rail mounting		Stainless steel bracket for 6500 main box +2 Din-Rail fastener

JHCTECH IoT Computer
Connecting the Dots





Product Listing	C01	KMDA-3820	C23	KMDA-7920	C53
KMDA-2602	*C1	KMDA-3610	C25	KMDA-7921	C55
KMDA-2620	C5	KMDA-3920	*C27	KMDA-2630	*C57
KMDA-2701	C7	KMDA-3921	C31	KMDA-3301	C61
KMDA-2702	C9	KMDA-5610	*C33	KMDA-3302	C63
KMDA-3201	C11	KMDA-5920	*C37	KMDA-5611	*C65
KMDA-3202	C13	KMDA-5921	*C41	KMDA-6611	*C69
KMDA-3212	C15	KMDA-6610	C45	KMDA-7611	*C73
KMDA-3230	C17	KMDA-6920	C47	SCC-3116	C77
KMDA-3601	C19	KMDA-6921	C49	ECC-U5000	C79
KMDA-3602	C21	KMDA-7610	C51		



 KMDA-2602	 KMDA-2602/T002	 KMDA-2620	 KMDA-2701	 KMDA-2702	 KMDA-3201	 KMDA-3202	 KMDA-3212
Processor							
CPU	Intel Baytrail-D Celeron J1900 ,Frequency 2.0~2.42GHz, 4C4T,2M cache,22nm, TDP 10W	Intel Baytrail-D Celeron J1900 ,Frequency 2.0~2.42GHz, 4C4T,2M cache,22nm, TDP 10W	Intel® Apollo Lake Atom E3940 CPU	Intel Baytrail-D Celeron J1900 ,Frequency 2.0~2.42GHz, 4C4T,2M cache,22nm, TDP 10W	Intel Baytrail-D Celeron J1900 ,Frequency 2.0~2.42GHz, 4C4T,2M cache,22nm, TDP 10W	Intel Skylake-U/KabyLake-U CPU Celeron/Core i3/i5/i7	Intel Skylake-U/KabyLake-U CPU Celeron/Core i3/i5/i7
RAM	1*DDR3L,1333MHz,SODIMM, 8GB max.	1*DDR3L,1333MHz,SODIMM, 8GB max.	1*DDR3L, 1866MHz, SODIMM, 8GB max.	1*DDR3L, 1333MHz, SODIMM, 8GB max.	1*DDR3L, 1333MHz, SODIMM, 8GB max.	2*260-Pin SODIMM, DDR4,2133MHz, 32GB max. 2*260-Pin SODIMM, DDR4,2133MHz, 32GB max.	1*DDR4,SODIMM,2133MHz, 16GB max.
Graphics	Intel HD Graphics, Support synchronous or asynchronous dual display, VGA:1920*1200@60Hz, HDMI:1920*1080@60Hz, support OpenGL 3.2, DirectX 11, OpenCL 1.2, MPGE2/H.264	Intel HD Graphics, Support synchronous or asynchronous dual display, VGA:1920*1200@60Hz, HDMI:1920*1080@60Hz, support OpenGL 3.2, DirectX 11, OpenCL 2.0, MPGE2, H.265	Gen. 9th Intel HD Graphics, DP:4096*2160@60Hz, HDMI:3840*2160@30Hz,support OpenGL 4.3, DirectX 11, OpenCL 2.0, MPGE2, H.265	Intel HD Graphics, Support dual independent display, VGA:1920*1200@60Hz, HDMI:1920*1080@60Hz,support OpenGL 3.2, DirectX 11, OpenCL 1.2, MPGE2/H.264	Intel HD Graphics, Support dual independent display, VGA:1920*1200@60Hz, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz	Intel Gen. 9th HD Graphics, HEVC/H265 HW HD codec, HDMI:3940*2160@30Hz, DP:4096*2160@60Hz	Intel Gen. 9th HD Graphics, HEVC/H265 HW HD codec, HDMI:4096*2304@24Hz, DP:4096*2304@60Hz
I/O Port							
LAN	4*Intel I211AT PCIe, 10-1000M	2*Intel I211AT PCIe, 10-1000M	4/2*Intel I211AT PCIe, 10-1000M	4*Intel I211AT PCIe, 10-1000M	3*Intel I211AT PCIe, 10-1000M	2*Intel I211AT PCIe, 10-1000M 1*Intel I219 LM support Intel Vpro	2*Intel I211AT PCIe, 10-1000M, 1*Intel I219 LM support Intel Vpro, 4*Intel I211AT PCIe Full bandwidth POE
USB	1* USB3.0,5*USB2.0 ,1*USB2.0 (Build-in)	1* USB3.0, 3*USB2.0	2* USB3.0, 4/2*USB2.0 ,1*USB2.0 (Build-in)	1* USB3.0, 5*USB2.0 ,1*USB2.0 (Build-in)	1* USB3.0, 5*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0, 2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0, 2*USB2.0 ,1*USB2.0 (Build-in)
Display	1*HDMI+ 1*VGA	1*HDMI+ 1*VGA	1*DP+1*HDMI	1*VGA+1*HDMI	1*VGA+1*HDMI	1*DP+1*HDMI	1*DP+1*HDMI+1*VGA
Audio	1*Line out,Realtek ALC662VD	1*Line out,Realtek ALC662VD	1*Line out,Realtek ALC662VD	1*Line out+1*Mic, Realtek ALC662VD	1*Line out+1*Mic, Realtek ALC662VD	1*Line out, Realtek ALC662VD	1*Line out+1*Mic, Realtek ALC662VD
COM/ Others	2*RS232/422/485, 2*RS232, 2*RS232/485, 1*2 pin terminal, Remote switch, USB mouse/keyboard	2*RS232/422/485, 2*RS232, 1*2 pin terminal, Remote switch, USB mouse/keyboard	4/2*RS232/422/485, 2*RS232, 1*2 pin terminal, Remote switch, USB mouse/keyboard	8*RS232/422/485, 2*RS232, 1*2 pin terminal, Remote switch, USB mouse/keyboard	2*RS232/422/485, 4*RS232, 1*2 pin terminal, Remote switch, USB mouse/keyboard	2*RS232/422/485, 4*RS232, 1*PS/2(mouse/keyboard)	2*RS232/422/485, 2*RS232, 1*PS/2(mouse/keyboard)
DIO	8-bit TTL, Programmed input-output	8-bit TTL, Programmed input-output	8-bit TTL, Programmed input-output	24-bit TTL, Programmed input-output	16-bit TTL, Programmed input-output	8-bit TTL, Programmed input-output	8-bit TTL, Programmed input-output
Storage							
Storage	1*2.5" HDD SATA2 Bay, 3.0 Gbps, 1*mSATA Full-height card, support AHCI	1*2.5" HDD SATA2 Bay, 3.0 Gbps, 1*mSATA Full-height card, support AHCI	1*2.5" HDD SATA3 Bay, 6.0 Gbps, 1*mSATA Full-height card, support AHCI	1*3.5" HDD SATA2 Bay, 3.0 Gbps, 1*mSATA Full-height card, support AHCI	1*2.5" HDD SATA2 Bay, 3.0 Gbps, 1*mSATA Full-height card, support AHCI	1/2*2.5" HDD SATA3 Bay, 6.0 Gbps, 1*mSATA Full-height card, support AHCI	1*2.5" SATA3 Bay, 6.0 Gbps, SSD/HDD, 1*mSATA Full-height card, support AHCI
Expansion							
Expansion Port	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*l-port(LPT/USB2.0/Mini PCIe)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT,	1*M.2 B-key, with SIM slot, support 4G/Wifi/BT, 1*I-port (LPT/USB2.0/Mini PCIe)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT	1*Mini PCIe, with SIM slot, 1*M.2 B-key with PCIe+USB signal &SIM slot, support dual 4G/Wifi/BT, 1*I-port(LPT/USB2.0/Mini PCIe)	1*Mini PCIe, with SIM slot, 1*M.2 B-key with PCIe+USB signal &SIM slot, support dual 4G/Wifi/BT, 1*I-port(LPT/USB2.0/Mini PCIe)
Power Supply							
Input voltage	DC IN 9~36V, D-Jack with M8 interface, short circuit protection, OVP&OCP	DC IN 9~36V, D-Jack with M8 interface, short circuit protection, OVP&OCP	DC IN 9~36V, D-Jack with M8 interface, short circuit protection, OVP&OCP	DC IN 9~36V, D-Jack with M8 interface, short circuit protection, OVP&OCP	DC IN 9~36V, D-Jack with M8 interface, short circuit protection, OVP&OCP	DC IN 9~30V, 3pin terminal, With reverse polarity protection, short circuit protection, OVP&OCP	DC IN 9~30V, 3pin terminal, With reverse polarity protection, short circuit protection, OVP&OCP
TDP	14.4W(2.5" HDD)	14.4W(2.5" HDD)	20.04W(E3940 CPU,4G DDR3L)	19.2W(3.5" HDD)	15.6W(2.5" HDD)	27.72W(I5-7200U 8GB)	27.72W(I5-7200U 8GB)
Mechanical							
Structure	Top/Bottom Aluminum Chassis, SGCC frame	Top/Bottom Aluminum Chassis, SGCC frame	Top/Bottom Aluminum Chassis, SGCC frame	U-shaped Aluminum Chassis, SGCC frame	U-shaped Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame
Color	Silver gray	Silver gray	Silver gray	Silver gray	Silver gray	Silver gray	Silver gray
Installation	desktop mounting & VESA 100*100mm	desktop mounting & VESA 100*100mm	desktop mounting & VESA 100*100mm	desktop mounting	desktop mounting	desktop mounting	desktop mounting
Dimension	155*111.8*65mm	155*111.6*49mm	155*111.8*65mm	210*144*82.7mm	210*144*82.7mm	210*144.3*75.5mm	200*200*85.3mm
Net Weight	1.30KG	1.05KG	1.30KG	2.60KG	2.60KG	2.20KG	3.3KG
Environmental							
Operating Temp	-20°C~65°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~65°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~70°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~70°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~70°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~70°C,SSD,with air flow -10°C~50°C,HDD,with air flow	-20°C~70°C,SSD,with air flow -10°C~50°C,HDD,with air flow
Storage Temp	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C
Storage Humidity	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)
Shock	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)
Certificate/ EMC	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A
OS	Windows 7, Windows 8.1, Windows 10, Linux Fedora,Ubuntu	Windows 7, Windows 8.1, Windows 10, Linux Fedora,Ubuntu	Windows 7, Windows 8.1, Windows 10, Linux Fedora,Ubuntu	Windows 7, Windows 8.1, Windows 10, Linux Fedora,Ubuntu	Windows 7, Windows 10, Linux Fedora,Ubuntu	Windows 7, Windows 10, Linux Fedora,Ubuntu	Windows 7, Windows 10, Linux Fedora,Ubuntu
Watchdog timer	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second

Product Listing



KMDA-3230		KMDA-3601		KMDA-3602		KMDA-3820		KMDA-3610		KMDA-3920		KMDA-3920ETC		KMDA-3921	
Processor															
CPU	Intel® Whiskey lake U Celeron/Core i3/i5/i7	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, Q170 Chipset	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, Q170 Chipset	Intel Skylake-U 3855/Kabylake-U Celeron/Core i3/i5/i7	Intel Skylake-U 3855/Kabylake-U Celeron/Core i3/i5/i7	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 Chipset	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 Chipset,optional Q170 Chipset	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 Chipset	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 Chipset,optional Q170 Chipset	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 Chipset	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 Chipset,optional Q170 Chipset	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 Chipset	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 Chipset,optional Q170 Chipset		
RAM	2*DDR4 SODIMM,2400MHz, 32GB max.	2*260-Pin SODIMM, DDR4,2133MHz, 32GB max.	2*260-Pin ,DDR4,2133/2400MHz, 32GB max.	1*260-Pin ,DDR4,2133/2400MHz, Max. 16GB		2*260-Pin ,DDR4,2133/2400MHz, 32GB max.									
Graphics	Intel® Gen. 9 UHD Graphics,Support dual independent display HDMI:4096*2304@24Hz DP:4096*2304@60Hz	Intel Gen. 9 HD Graphics, HEVC/H265 HW HD codec,DP/HDMI support dual 4K display Intel Gen. 9th HD Graphics, HEVC/H265 HW HD codec, 1*MMX3.1 GPU module, support max. 120W GPU, DP:4096*2304@60Hz,VGA:2650*1600@60Hz, HDMI:3840*2160@30Hz,	Intel Gen. 9 HD Graphics, HEVC/H265 HW HD codec,DP/HDMI support dual 4K display Intel Gen. 9th HD Graphics, HEVC/H265 HW HD codec, 1*MMX3.1 GPU module, support max. 120W GPU, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, HDMI:3840*2160@30Hz,	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, support 2 independent display+1 copy display	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, support 3 independent display(Intel Q170)	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, support 3 independent display(Intel Q170)	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, support 3 independent display(Intel Q170)	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, support 3 independent display(Intel Q170)	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, support 3 independent display(Intel Q170)	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, support 3 independent display(Intel Q170)	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, support 3 independent display(Intel Q170)	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, support 3 independent display(Intel Q170)	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz, support 3 independent display(Intel Q170)		
I/O Port															
LAN	4*Intel I210AT PCIe, 10-1000M, 1*Intel®I219LM	2*Intel I210AT PCIe,10-1000M, 1*Intel I219 LM support Intel Vpro, 4*Intel I210AT Full bandwidth POE, optional 8/11*Gig LAN	2*Intel I211AT PCIe,10-1000M, 1*Intel I219 LM support Intel Vpro, 4*Intel I210AT PCIe Full bandwidth POE, optional 4*LAN	2*Intel I211AT PCIe ,10-1000M, 1*Intel I219 LM support Intel Vpro, 4*Intel I210AT PCIe Full bandwidth POE, optional 4*LAN	1*Intel I211AT PCIe ,10-1000M, 1*Intel I219 LM,support Intel Vpro, 4*USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	1*Intel I211AT PCIe ,10-1000M, 1*Intel I219 LM support Intel Vpro(Intel Q170), 4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	1*Intel I211AT PCIe ,10-1000M, 1*Intel I219 LM support Intel Vpro(Intel Q170), 4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	1*Intel I211AT PCIe ,10-1000M, 1*Intel I219 LM support Intel Vpro(Intel Q170), 4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	1*Intel I211AT PCIe ,10-1000M, 1*Intel I219 LM support Intel Vpro(Intel Q170), 4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	1*Intel I211AT PCIe ,10-1000M, 1*Intel I219 LM support Intel Vpro(Intel Q170), 4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	1*Intel I211AT PCIe ,10-1000M, 1*Intel I219 LM support Intel Vpro(Intel Q170), 4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	1*Intel I211AT PCIe ,10-1000M, 1*Intel I219 LM support Intel Vpro(Intel Q170), 4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	1*Intel I211AT PCIe ,10-1000M, 1*Intel I219 LM support Intel Vpro(Intel Q170), 4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)		
USB	4* USB3.1,2*USB2.0	6* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	6* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)	4* USB3.0,2*USB2.0 ,1*USB2.0 (Build-in)		
Display	1*DP+1*HDMI	1*DP+1*HDMI+1*VGA		1*DP+1*HDMI+1*VGA											
Audio	1*Line out+1*Mic, Realtek ALC662VD	1*Line out+1*Mic,Realtek ALC662VD		1*Line out+1*Mic,Realtek ALC662VD											
COM/ Others	2*RS485, 3*RS232,	2*RS232/422/485, 2*RS232,		2*RS232/422/485	2*RS232/422/485, 2*RS232, 1*PS/2(mouse/keyboard)		2*RS232/422/485, 2*RS232, 1*PS/2(mouse/keyboard)		2*RS232/422/485, 2*RS232, 1*PS/2(mouse/keyboard)	2*RS232/422/485, 2*RS232, 1*PS/2(mouse/keyboard)	2*RS232/422/485, 8*RS232, 1*PS/2(mouse/keyboard)	2*RS232/422/485 ,2*RS232, 1*PS/2(mouse/keyboard)	2*RS232/422/485 ,2*RS232, 1*PS/2(mouse/keyboard)	2*RS232/422/485 ,2*RS232, 1*PS/2(mouse/keyboard)	
DIO	8-bit iso DIO(4-bit 2.5KV optical Iso. DO,4-bit 2.5KV optical Iso. DI)	16/24-bit optical Iso. DIO optional 16-bit TTL Programmable input and output	16/24-bit optical Iso. DIO optional 16-bit TTL Programmable input and output	8-bit TTL, Programmable DIO optional 16-bit TTL Programmable input and output	8-bit TTL, Programmable DIO optional 16-bit TTL Programmable input and output	8-bit TTL, Programmable DIO optional 16-bit TTL Programmable input and output	8-bit TTL, Programmable DIO optional 16-bit TTL Programmable input and output	8-bit TTL, Programmable DIO optional 16-bit TTL Programmable input and output	8-bit TTL, Programmable DIO optional 16-bit TTL Programmable input and output	16-bit Programmable DIO (2*10Pin)	16-bit Programmable DIO(DB25),TTL programmable input & output	8-bit DIO(2*5Pin)	16-bit DIO(build-in),TTL, programmable input & output	8-bit DIO(2*5Pin)	
Storage															
Storage	1*2.5" SATA port, 1*mSATA Full-height card, support AHCI	2*2.5" SATA,HDD/SSD, 1*mSATA Full-height card, 1*M.2 B-key with SIM slot	1*2.5" SATA3,HDD/SSD, 1*mSATA Full-height card, 1*M.2 B-key with SIM slot	1*2.5" SATA3,HDD/SSD, 1*mSATA Full-height card, support AHCI	2*2.5" SATA3,HDD, 1*mSATA Full-height card,1*M.2 2242 B-key	2*2.5" SATA3 HDD,support RAID0,1(intel Q170), 1*mSATA,1*M.2 2242 B-key	2*2.5" SATA3 HDD,support RAID0,1(intel Q170), 1*mSATA,1*M.2 2242 B-key	2*2.5" SATA3,HDD,support RAID0,1(intel Q170), 1*mSATA,1*M.2 2242 B-key							
Expansion															
Expansion Port	1*Mini PCIe, with SIM slot, support 3G/4G/Wifi/BT/GPRS,1*M.2 E-key 2230 WiFi/BT module expansion, 1*I-Port(LPT/USB2.0/Mini PCIe)	1*Mini PCIe, with SIM slot, 1*half length Mini PCIe, support dual 4G LTE/Wifi/BT, 1*I-Port(LPT/USB2.0/Mini PCIe)	1*Mini PCIe, with SIM slot,, 1*half length Mini PCIe,support dual 4G LTE/Wifi/BT & GPS/BDS 1*I-port(LPT/USB2.0/Mini PCIe)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT,1* PCIe X4(X4 signal), 1*PCIe X4(X1signal),or 2*PCI 1*I-port(LPT/USB2.0/Mini PCIe)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*PCIe X16, 1*PCIe X4, or 2*PCI, 1*I-port(LPT/USB2.0/Mini PCIe)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*PCIe X16, 1*PCIe X4(X1 signal)+2*PCI, or 2*PCIe X16(X8)+1*PCIe X8(X4)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*PCIe X16, 1*PCIe X4(X1 signal)+2*PCI, or 2*PCIe X16(X8)+1*PCIe X8(X4)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*PCIe X16, 1*PCIe X4(X1 signal)+2*PCI, or 2*PCIe X16(X8)+1*PCIe X8(X4)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*PCIe X16, 1*PCIe X4(X1 signal)+2*PCI, or 2*PCIe X16(X8)+1*PCIe X8(X4)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*PCIe X16, 1*PCIe X4(X1 signal)+2*PCI, or 2*PCIe X16(X8)+1*PCIe X8(X4)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*PCIe X16, 1*PCIe X4(X1 signal)+2*PCI, or 2*PCIe X16(X8)+1*PCIe X8(X4)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*PCIe X16, 1*PCIe X4(X1 signal)+2*PCI, or 2*PCIe X16(X8)+1*PCIe X8(X4)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*PCIe X16, 1*PCIe X4(X1 signal)+2*PCI, or 2*PCIe X16(X8)+1*PCIe X8(X4)	1*Mini PCIe, with SIM slot, support 4G/Wifi/BT, 1*PCIe X16, 1*PCIe X4(X1 signal)+2*PCI, or 2*PCIe X16(X8)+1*PCIe X8(X4)
Power Supply															
Input voltage	DC IN 9~36V, 3pin terminal,	DC 6~48V input,	DC 6~48V input,	DC 12~24V input,		DC 12~24V input,		DC 12~24V input,		DC 12~24V input,		DC 12~24V input,		DC 12~24V input,	
TDP	30W(I5-8265U ,8GB DDR4, 128GB SSD)	38W(I5-7500T ,4GB RAM, 128G SSD)	115.92W (I5-7500T +GTX 1060 GPU)	58.56W (I5-7200U 16GB DDR4)		68.4W (I7-6700T CPU 16GB DDR4)		68.78W (I7-6700T ,4GB DDR4, 1TB HDD)		68.78W (I7-6700T ,4GB DDR4, 1TB HDD)		68.78W (I7-6700T ,4GB DDR4, 1TB HDD)		68.78W (I7-6700T ,4GB DDR4, 1TB HDD)	
Mechanical															
Structure	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC cover	Aluminum Chassis, SGCC frame and cover	Aluminum rectangular cooling plates, SGCC paint main cabinet		Aluminum rectangular cooling plates, SGCC paint main cabinet		Aluminum rectangular cooling plates, SGCC paint main cabinet		Aluminum rectangular cooling plates, SGCC paint main cabinet		Aluminum rectangular cooling plates, SGCC paint main cabinet		Aluminum Chassis, SGCC frame	
Color	Silver gray	Silver gray	Silver gray	Silver gray		Silver gray		Silver gray		Silver gray		Silver gray		Silver gray	
Installation	desktop mounting	desktop mounting	desktop mounting,Anti-vibration plane	desktop mounting		desktop mounting		desktop mounting		desktop mounting,wall-mount		desktop mounting,wall-mount		desktop mounting,wall-mount	
Dimension	210*147*78mm	284*222*84.7mm	284*222*81mm	200*200*128.3mm		221*251*88mm									

Product Listing

							
KMDA-5610/S001	KMDA-5610/S002	KMDA-5920/S001	KMDA-5920/S002	KMDA-5921/S001	KMDA-5921/S002	KMDA-6610	KMDA-6920
Processor							
CPU	Intel® Coffee lake 9th/8th-Gen Core™ i7/i5/i3/Pentium/Celeron LGA1151 processor H310 chipset	Intel® Coffee lake 9th/8th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1151 CPU Q370 chipset	Intel® Coffee lake 9th/8th-Gen Core™ i7/i5/i3/Pentium/Celeron LGA1151 processor H310 chipset	Intel® Coffee lake 9th/8th-Gen Core™ i7/i5/i3/Pentium/Celeron LGA1151 processor Q370 chipset	Intel® Coffee lake 9th/8th-Gen Core™ i7/i5/i3/Pentium/Celeron LGA1151 processor H310 chipset	Intel® Comet lake 10th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU H420E Chipset	Intel® Comet lake 10th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU H420E Chipset
RAM	2*260-Pin ,DDR4,2400/2666MHz, 64GB max.	4*260-Pin ,DDR4,2400/2666MHz, 128GB max.	2*260-Pin ,DDR4,2400/2666MHz, 64GB max.	4*260-Pin ,DDR4,2400/2666MHz, 128GB max.	2*260-Pin ,DDR4,2400/2666MHz, 64GB max.	4*260-Pin ,DDR4,2400/2666MHz, 128GB max.	2*260-Pin ,DDR4,2933MHz, 64GB Max.
Graphics	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 or PCIe X16, DP:4096*2304@60Hz,VGA:1900*1200@60Hz, HDMI:3840*2160@30Hz(2 independent displays, 1 Copy Display)	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 or PCIe X16, DP:4096*2304@60Hz,VGA:1900*1200@60Hz, HDMI:4096*2160@30Hz(3 independent displays, 1 Copy Display)	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 or PCIe X16, DP:4096*2304@60Hz,VGA:1900*1200@60Hz, HDMI: support 3 independent display	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 or PCIe X16, DP:4096*2304@60Hz,VGA:1900*1200@60Hz, HDMI: support 3 independent display	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 or PCIe X16, DP:4096*2304@60Hz,VGA:1900*1200@60Hz, HDMI: support 3 independent display	Intel UHD Graphics, Supports DirectX12, OpenGL 4.5; DP:4096*2304@60Hz, VGA:1900*1200@60Hz, HDMI: 4096*2160@30Hz(2 independent display)	Intel UHD Graphics, Supports DirectX12, OpenGL 4.5; DP:4096*2304@60Hz, VGA:1900*1200@60Hz, HDMI: 4096*2160@30Hz(2 independent display)
I/O Port							
LAN	1*Intel I210AT PCIe,10-1000M, 1*Intel I219 LM,	2*Intel I211AT/I210AT, 10-1000M, WOL; 1*Intel I219 LM, 10-1000M, iAMT13.0,vPro;	1*Intel I210AT PCIe,10-1000M, 1*Intel I219 LM,	2*Intel I210AT PCIe,10-1000M, 1*Intel I219 LM, support Intel Vpro	1*Intel I210AT PCIe,10-1000M, 1*Intel I219 LM	2*Intel I210AT PCIe,10-1000M, 1*Intel I219 LM support Intel Vpro	1*Intel I226V, PCIe X1, 10M-2.5G, WOL; 1*Intel I219 LM, 10-1000M, WOL
USB	4* USB3.1, 2*USB2.0, 1*USB2.0(Build-in)	6* USB3.1, 2*USB2.0, 2*USB2.0(Build-in)	4* USB3.1, 2*USB2.0, 1*USB2.0(Build-in)	6* USB3.1, 2*USB2.0, 2*USB2.0(Build-in)	4* USB3.1, 2*USB2.0, 1*USB2.0(Build-in)	6* USB3.1, 2*USB2.0, 2*USB2.0(Build-in)	4* USB3.2 Gen1, 2*USB2.0, 2*USB2.0(Build-in) 4* USB3.2 Gen1, 2*USB2.0, 2*USB2.0(Build-in)
Display	1*DP+1*HDMI+1*VGA	2*DP+1*VGA	1*DP+1*HDMI+1*VGA	2*DP+1*VGA	1*DP+1*HDMI+1*VGA	2*DP+1*VGA	1*DP+1*HDMI+1*VGA 1*DP+1*HDMI+1*VGA
Audio	1*Line out+1*Mic, Realtek ALC662VD	1*Line out+1*Mic, Realtek ALC662VD	1*Line out+1*Mic, Realtek ALC662VD	1*Line out+1*Mic, Realtek ALC662VD	1*Line out+1*Mic, Realtek ALC662VD	1*Line out+1*Mic, Realtek ALC662VD	1*Line out+1*Mic, Realtek ALC 897 1*Line out+1*Mic, Realtek ALC 897
COM/ Others	2*RS232/422/485, 2*RS232;	2*RS232/422/485, 2*RS232;	2*RS232/422/485, 2*RS232,	2*RS232/422/485, 2*RS232,	2*RS232/422/485, 2*RS232,	2*RS232/422/485, 2*RS232;	2*RS232/422/485, 2*RS232; 1*LPT, 1*PS/2
DIO	16-bit iso DIO: 8-bit Iso. DI(High:5-24V,Low:0-1.5V) and 8-bit Iso. DO(200mA)	16 bit iso. DIO(2*10pin); 16 bit DIO(2*10pin)	16-bit iso DIO: 8-bit Iso. DI(High:5-24V,Low:0-1.5V) and 8-bit Iso. DO(200mA)	16-bit iso DIO: 8-bit Iso. DI(High:5-24V,Low:0-1.5V) and 8-bit Iso. DO(200mA)	16-bit iso DIO: 8-bit Iso. DI(High:5-24V,Low:0-1.5V) and 8-bit Iso. DO(200mA)	16-bit iso DIO: 8-bit Iso. DI(High:5-24V,Low:0-1.5V) and 8-bit Iso. DO(200mA)	8-bit DIO,TTL 16-bit DIO(2*10 pin)
Storage							
Storage	2*2.5" SATA3,HDD, 1*mSATA,with SIMslot,support 4G	2*2.5" SATA3,RAID0,1; 1*Mini PCIe(SATA3.0/USB2.0), mSATA	2*2.5" SATA3,HDD, 1*mSATA,with SIM slot ,support 4G	2*2.5" SATA3,support RAID0,1, 1*M.2 M-Key,PCIeX4 Gen3.0, support NVME storage	2*2.5" SATA3,HDD, 1*full length Msata with SIM slot,support 4G	2*2.5" SATA3, support RAID0,1, 1*M.2 M-Key,PCIeX4 Gen3.0, support NVME storage	2*2.5" SATA3, 6Gbps; 1*mSATA(SATA3.0/USB2.0)
Expansion							
Expansion Port	1*M.2 E-Key 2230, Support Gigabit WiFi module, 1*I-port(LPT/USB2.0/16-bit DIO/Mini PCIe)	1*M.2 E-Key 2230(PcieX1&USB2.0); 1*Mini PCIe(SATA3.0/USB2.0+SIM)	1*M.2 E-Key 2230, Support Gigabit WiFi module, 1*PCle X16, 1*PCle X4, 1*I-port(LPT/USB2.0/16-bit DIO/Mini PCIe)	1*M.2 B-Key,with SIM slot. support5G, 1*M.2 E-Key, 1*PCle X16,1*PCle X4, 1*Mini PCIe,with SIM slot. support4G/WIFI/BT 1*I-port(LPT/USB2.0/16-bit DIO/Mini PCIe)	1*M.2 E-Key 2230, Support Gigabit WiFi module/BT5.0 1*PCle X16, 1*PCle X4 ,2*32-bit PCI 1*I-port(LPT/USB2.0/16-bit DIO/Mini PCIe)	1*M.2 E-Key, 1*Mini PCIe,with SIM slot. support4G/WIFI/BT, 1*I-port(LPT/USB2.0/16-bit DIO/Mini PCIe), 2*PCle X8,2*PCle X4 or 1*PCle X16,1*PCle X4,2*PCI	1*PCle3.0 X16(X16)+1*PCle3.0 X16(X4) ; or 1*PCle3.0 X16(X16)+1*32-bit PCI; 1*Mini PCIe(PcieX1/USB2.0+SIM), 4G LTE/PCI;
Power Supply							
Input voltage	DC IN 9-36V ,with protection of short circuit, over voltage, over current;	DC IN 9-36V ,with protection of short circuit, over voltage, over current	DC IN 9-36V ,with protection of short circuit, over voltage, over current	DC IN 9-36V ,with protection of short circuit, over voltage, over current	DC IN 9-36V ,with protection of short circuit, over voltage, over current	DC IN 9-36V ,with protection of short circuit, over voltage, over current	DC IN 9-36V ,with protection of short circuit, over voltage, over current
TDP	96W(i7-8700 ,32G DDR4,128G SSD)	96W(i7-8700T ,32G DDR4,128G SSD)	60.5W(i7-8700T,16G DDR4,128G SSD)	60.5W(i7-8700T,16G DDR4,128G SSD)	48.5W(i7-9700,16G DDR4,128G SSD)	48.5W(i7-9700,16G DDR4,128G SSD)	57.2W(i7-10700TE /4G DDR4/256G SSD)
Mechanical							
Structure	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame
Color	Silver white + Aquamarine	Silver white + Aquamarine	Silver white + Aquamarine	Silver white + Aquamarine	Silver white + Aquamarine	Silver white + Aquamarine	Silver white + Aquamarine
Installation	desktop mounting	desktop mounting	desktop mounting	desktop mounting	desktop mounting	desktop mounting	desktop mounting
Dimension	230*267.3*92mm	230*267.3*92mm	230*273*143mm	230*273*143mm	230*273*204mm	230*273*204mm	230*267.3*92mm
Net Weight	5.1KG	5.1KG	5.9KG	5.9KG	7.25KG	7.25KG	5.12KG
Environmental							
Operating Temp	-20°C~60°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~60°C,SSD, with air flow -10°C~55°C,HDD,with air flow;	-20°C~60°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~60°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~60°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~60°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~60°C,SSD,with air flow -10°C~55°C,HDD,with air flow
Storage Temp	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C
Storage Humidity	10~90%@40°C, No-condensation	10~95%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)
Shock	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)
Certificate /EMC	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A
OS	Windows 10 Enterprise & IOT Enterprise(64 bit) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) Wind River VxWorks 7	Windows 10 Enterprise & IOT Enterprise (64-bit) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) Wind River VxWorks 7	Windows 10 Enterprise & IOT Enterprise (64-bit) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) Wind River VxWorks 7	Windows 10 Enterprise & IOT Enterprise (64-bit) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) Wind River VxWorks 7	Windows 10 Enterprise & IOT Enterprise (64-bit) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) Wind River VxWorks 7	Win11, Windows 10 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7	Win11, Windows 10 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7
Watchdog timer	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second	Programmable via software 1 to 255 second

KMDA-6921	KMDA-7610	KMDA-7920	KMDA-7921	KMDA-2630-S	KMDA-2630-T	KMDA-3301	KMDA-3302
Processor							
CPU	Intel® Comet lake 10th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU, Intel® H420E Chipset	Intel® Alder lake-S 12th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH	Intel® Alder lake-S 12th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH	Intel® Alder lake-S 12th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH	Intel® Elkhart lake SoC CPU: Celeron J6412/Celeron N6210	Intel® Elkhart lake SoC CPU: Celeron J6412/Celeron N6210	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU i3-1115G4/i5-1135G7/i7-1165G7, Celeron 6305E),
RAM	2*260-Pin ,DDR4,2933MHz, 64GB Max.	2*262-Pin, DDR5,4800MHz, 64GB max.	2*262-Pin, DDR5,4800MHz, 64GB max.	2*262-Pin, DDR5,4800MHz, 64GB max.	1*DDR4 SO-DIMM , 3200MHz, 32GB max.	1*DDR4 SO-DIMM , 3200MHz, 32GB max.	2*DDR4 SO-DIMM, 3200MHz, 64GB max.
Graphics	Intel UHD Graphics, Supports DirectX12, OpenGL 4.5; DP:4096*2304@60Hz, VGA:1900*1200@60Hz, HDMI:4096*2160@60Hz, 4096*2160@30Hz(2 independent display)	Intel UHD Graphics, Supports DirectX 12, OpenGL 4.5; OpenCL 3.0	Intel UHD Graphics, Supports DirectX 12, OpenGL 4.5; OpenCL 3.0	Intel UHD Graphics, Supports DirectX 12, OpenGL 4.5; OpenCL 3.0	Intel Gen11 UHD Graphics, HDMI2.0: 4096*2304@60Hz DP:8K@60Hz,HDMI:4096*2160@60Hz, VGA: 1920*1200@60Hz	Intel Gen11 UHD Graphics, HDMI2.0: 4096*2304@60Hz VGA: 1920*1200@60Hz	Intel UHD Graphics / Iris® Xe Graphics , DirectX12.1, OpenGL 4.6 and OpenCL 3.0
I/O Port							
LAN	1*Intel I226V, PCIe X1, 10M-2.5G, WOL; 1*Intel I219 LM, 10M-1000M, WOL	1*Intel I226V, 10-1000M, WOL; 1*Intel I219 LM, 10-1000M, WOL	1*Intel I226V, 10-1000M, WOL; 1*Intel I219 LM, 10-1000M, WOL	1*Intel I226V, 10-1000M, WOL; 1*Intel I219 LM, 10-1000M, WOL	2*Intel I226V, 10M-2.5G, WOL; 2*Realtek 8111H, 10-1000M	2*Intel I226V, 10M-2.5G, WOL;	3*Intel I225V, 10M-2.5G, iAMT 13.0
USB	4* USB3.2 Gen1, 2*USB2.0, 2*USB2.0(Build-in) 2* USB3.2(10G),2*USB3.2(5G),2*USB2.0	2* USB3.2(10G),2*USB3.2(5G),2*USB2.0	2* USB3.2(10G),2*USB3.2(5G),2*USB2.0	2* USB3.2(10G),2*USB3.2(5G),2*USB2.0	2*USB3.2 Gen2, 6*USB2.0, 1*USB2.0(Build-in) 2*USB3.2 Gen2, 2*USB2.0, 1*USB2.0(Build-in) 2* USB3.2 Gen2, 2*USB2.0, 2*USB2.0(internal)	2*USB3.2 Gen2, 2*USB2.0	2* USB3.2 Gen2, 2*USB2.0
Display	1*DP+1*HDMI+1*VGA	1*DP+1*HDMI+1*VGA	1*DP+1*HDMI+1*VGA	1*DP+1*HDMI+1*VGA	1*HDMI+1*VGA	1*HDMI+1*VGA	1*HDMI+1*HDMI
Audio	1*Line out+1*Mic, Realtek ALC 897	1*Line out+1*Mic, Realtek ALC 897	1*Line out+1*Mic, Realtek ALC 897	1*Line out+1*Mic, Realtek ALC 897	Audio out+1*Line in+1*Mic,Realtek ALC897	1*Line out,Realtek ALC897	1*Line out+1*Mic,Realtek ALC662VD
COM/ Others	2*RS232/422/485, 2*RS232; 1*LPT, 1*PS/2	2*RS232/422/485, 2*RS232; 1*SM Bus	2*RS232/422/485, 2*RS232; 1*SM Bus	2*RS232/422/485, 2*RS232; 1*SM Bus	2*RS232/422/485, 2*RS232	2*RS232/422/485, 2*RS232	2*RS232/422/485; 1*MIO
DIO	8-bit DIO,TTL 16-bit DIO(2*10 pin)	16 bit iso. DIO,8bit DI(PNP/NPN),8bit DO 16 bit iso. DIO(2*10pin)	16 bit iso. DIO,8bit DI(PNP/NPN),8bit DO 16 bit iso. DIO(2*10pin)	16 bit iso. DIO,8bit DI(PNP/NPN),8bit DO 16 bit iso. DIO(2*10pin)	8 bit DIO(DB9)	8 bit DIO(DB9)	8-bit DIO(2*5pin)
Storage							
Storage	2*2.5" SATA3, 6Gbps; 1*mSATA(SATA3.0 & USB2.0)	2*2.5" SATA3, 15mm; 1*mSATA(SATA3)	2*2.5" SATA3, 15mm; 1*mSATA(SATA3)	2*2.5" SATA3; 1*mSATA, AHCI	1*2.5"SATA3; 1*mSATA, AHCI	1*2.5"SATA3, 6Gbps; 1*mSATA, support AHCI; 1*M.2 22080 M-Key NVME(PCIe4.0 X2)	2*mSATA;
Expansion							
Expansion Port	1*PCIe3.0 X16(X16)+1*PCIe3.0 X4(X2), 2*32-bit PCI; 1*Mini PCIe(PCleX1/USB2.0+SIM), 4G LTE/PCI;	1*Mini PCIe(PCleX1/USB+SIM), 4G LTE/PCI;	1*PCIe5.0X16(X16)+1*PCIe3.0X4(X4); or 1*PCIe5.0X16(X16)+1*32bit PCI; 1*Mini PCIe(PCleX1/USB+SIM),4G LTE	1*PCIe5.0X16(X16)+1*PCIe3.0X4(X2)+ 2*32bit PCI; 1*Mini PCIe(PCleX1/USB+SIM),4G LTE	1*M.2 B-key 3052(PCle X1/USB2.0+SIM), 5G NR/4G LTE; 1*JHCTECH Express-01 80pin:2*PCleX1, 4*USB2.0, Front-Audio; 1*PS/2, Front-Panel, 1*Sm bus, 1*eSPI	1*Mini PCIe(PCle X1+USB2.0), support Wifi/BT; 1*M.2 3052 B-Key(PCle X1+USB2.0), with SIM slot, support 4G LTE/5G NR; 1*M.2 22080 M-Key ,(PCIe4.0 X2), support high speed signal function card	1*Mini PCIe(PCle X1/USB2.0), CAN2.0; 1*M.2 3042/3052 B-Key (PCleX1/USB2.0+SIM),4G LTE/5G NR; 1*M.2 2230 E-Key (PCleX1+USB2.0), Wifi/BT
Power Supply							
Input voltage	DC IN 9-36V ,with protection of short circuit, over voltage, over current	DC IN 9-36V 3-pin, with protection of short circuit, over voltage, over current;	DC IN 9-36V 3-pin, with protection of short circuit, over voltage, over current;	DC IN 9-36V 3-pin, with protection of short circuit, over voltage, over current;	DC 12V or DC 9-36V, short circuit protection, OVP&OCP	DC 12V or DC 9-36V, short circuit protection, OVP&OCP	DC 9-36V, 1*3-pin,with short circuit, over voltage & over current protection
TDP	60W(i7-10700K /4G DDR4/256G SSD)	TDP:TBD	TDP:TBD	TDP:TBD			TBP
Mechanical							
Structure	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum chassis, SGCC
Color	Silver white + Aquamarine	Silver white+Aquamarine	Silver white+Aquamarine	Silver white+Aquamarine	Silver white+Aquamarine	Silver white+Aquamarine	Silver gray
Installation	desktop mounting	desktop mounting	desktop mounting	desktop mounting	desktop mounting	desktop mounting/optional Din-Rail mounting	desktop mounting;(Opt.)-Din-Rail
Dimension	230*273*204mm	256.68*267.3*99mm	256.68*312.7*149.9mm	256.68*312.7*210.9mm	162*111.8*65mm	162*111.8*65mm	250*154*61.9mm
Net Weight	6.84KG	TBD	TBD	TBD	1.32KG	1.30KG	2.55KG
Environmental							
Operating Temp	-20°C~60°C,SSD,with air flow -10°C~55°C,HDD,with air flow	-20°C~60°C,SSD, with air flow; -10°C~55°C,HDD, with air flow;	-20°C~60°C,SSD, with air flow; -10°C~55°C,HDD, with air flow;	-20°C~60°C,SSD, with air flow; -10°C~55°C,HDD, with air flow;	-20°C~60°C, SSD, with air flow	-20°C~60°C, SSD, with air flow	-20°C~65°C, SSD, with air flow
Storage Temp	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C
Storage Humidity	10~90%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~90%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)
Shock	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD) 20g peak acceleration(duration 11ms,HDD)
Certificate /EMC	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A
OS	Win11, Windows 10 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7	Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7	Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7	Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7	Windows 10 64 bit, SUSE, Ubuntu, Wind River, Linux	Windows 10 64 bit, SUSE, Ubuntu, Wind River, Linux	Windows 10 64 bit, SUSE, Ubuntu, Wind River, Linux
Watchdog timer	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second

Product Listing

KMDA-5611-S001	KMDA-5611-S002	KMDA-6611-S001	KMDA-6611-S002	KMDA-7611-S	KMDA-7611-T	SCC-3116	ECC-U5000
Processor							
CPU	Intel® Coffee lake 9th/8th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1151 CPU, up to 65W, Intel® H310 PCH	Intel® Coffee lake 9th/8th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1151 CPU, up to 65W, Intel® H310 PCH	Intel® Comet lake 10th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU, up to 65W, Intel® H420E PCH	Intel® Comet lake 10th Gen Core™ i9/i7/i5/Pentium/Celeron LGA1200 CPU, up to 65W, Intel® H420E PCH	Intel® Alder lake-S/Raptor Lake-S 12/13th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU; H610 PCH	Intel® Alder lake-S/Raptor Lake-S 12/13th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU; H610 PCH	Intel® Baytrail-D Celeron J1900, frequency 2.0~2.42GHz, quad-core with 4 threads, 2M cache, 22nm, TDP 10W
RAM	2*DDR4 SODIMM, 2666MHz, 64GB max.	2*DDR4 SODIMM, 2666MHz, 64GB max.	2*DDR4 SODIMM, 2933MHz, 64GB max.	2*DDR4 SODIMM, 2933MHz, 64GB max.	2*DDR5 SODIMM, 4800MHz, 64GB max.	2*DDR5 SODIMM, 4800MHz, 64GB max.	1*DDR3L, 1333MHz SODIMM, 8GB max.
Graphics	Intel® UHD Graphics, Supports DirectX 11.1, OpenGL 5.0, OpenCL 2.1; HDMI : 4096x2160@24Hz, VGA: 1920*1200@60Hz	Intel® UHD Graphics, Supports DirectX 11.1, OpenGL 5.0, OpenCL 2.1; HDMI : 4096x2160@24Hz, VGA: 1920*1200@60Hz	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5;	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5;	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; HDMI : 4096x2160@60Hz,	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; HDMI : 4096x2160@60Hz,	Intel HD Graphics, OpenGL 3.2, DirectX 11, OpenCL 1.2, MPGE2/H.264, Dual independent display, VGA : 1920*1200@60Hz, HDMI:1920*1080@60Hz
I/O Port							
LAN	1*Intel I210AT+1*I219LM, 10M-1000M, WOL; 4*Intel I210AT POE+, 10M-1000M, WOL	1*Intel I210AT+1*I219LM, 10M-1000M, WOL; 4*Intel I210AT POE+, 10M-1000M, WOL	1*Intel I210AT+1*I219LM, 10M-1000M, WOL; 4*Intel I210AT POE+, 10M-1000M, WOL	1*Intel I210AT+1*I219LM, 10M-1000M, WOL; 4*Intel I210AT POE+, 10M-1000M, WOL	3*Intel I210AT, 10M-1000M, WOL; 1*Intel I219LM, 10M-1000M, WOL	1*Intel I210AT, 10M-1000M, WOL; 1*Intel I219LM, 10M-1000M, WOL	3*Intel I210AT, 10-1000M
USB	2* USB3.1+ 2*USB2.0	2* USB3.1+ 2*USB2.0+8*USB3.0	2* USB3.2+ 2*USB2.0	2* USB3.1+ 2*USB2.0+8*USB3.0	2* USB3.2 Gen2, 2* USB3.2 Gen1	2* USB3.2 Gen2, 2* USB3.2 Gen1	1* USB3.0; 6*USB2.0
Display	1*HDMI+1*VGA	1*HDMI+1*VGA	1*HDMI+1*VGA	1*HDMI+1*VGA	1*HDMI	1*HDMI	1*HDMI+1*VGA
Audio	/	/	/	/	1*Line out+1*Mic, Realtek ALC897	/	1*Line out+1*Mic, Realtek ALC662VD
COM/ Others	1*RS232/485; 1*RS232	1*RS232/485; 1*RS232	1*RS232/485; 1*RS232	1*RS232/485; 1*RS232	2*RS232/422/485; 4*RS232	2*RS232/422/485	4*RS232/422/485, 1*RS232; 1*PS/2
DIO	32 bit iso. DIO(2*18pin)	32 bit iso. DIO(2*18pin)	32 bit iso. DIO(2*18pin)	32 bit iso. DIO(2*18pin)	8 bit iso. DIO(2*5pin)	8 bit iso. DIO(2*5pin)	8bit DIO (DB9), TTL
Storage							
Storage	1*2.5"SATA3.0, 6Gbps; 1*mSATA, 6Gbps	1*2.5"SATA3.0, 6Gbps; 1*mSATA, 6Gbps	1*2.5"SATA3.0, 6Gbps; 1*mSATA, 6Gbps	1*2.5"SATA3.0, 6Gbps; 1*mSATA, 6Gbps	1*2.5"SATA3.0, 6Gbps; 1*mSATA, 6Gbps	1*2.5" SATA2, HDD/SSD; 1*mSATA, AHCI	1*mSATA, 6Gbps
Expansion							
Expansion Port	1*Mini PCIe(+SIM), 4G/WIFI/PCIe;	1*Mini PCIe(+SIM), 4G/WIFI/PCIe;	1*Mini PCIe(+SIM), 4G/WIFI/PCIe;	1*Mini PCIe(+SIM), 4G/WIFI/PCIe;	2*Mini PCIe(PCIe X1/USB2.0), PCIe module; 1*M.2 3052/3042 B-Key (PCIe X1/USB2.0+SIM), 5G NR;	2*Mini PCIe(PCIe X1/USB2.0), PCIe module; 1*M.2 3052/3042 B-Key (PCIe X1/USB2.0+SIM), 5G NR;	1*Mini PCIe(+SIM), 4G LTE/Wifi/BT; 1*Mini PCIe(PCIeX1+USB2.0)
Power Supply							
Input voltage	DC 9-36V, with SCP,OVP,OCP; TBD	DC 9-36V, with SCP,OVP,OCP; TBD	DC 9-36V, with SCP,OVP,OCP; TBD	DC 9-36V, with SCP,OVP,OCP; TBD:105.84W	DC 9-36V, with SCP,OVP,OCP; TBD:105.84W (Intel I3-12100/128GB SSD/32GB RAM)	DC IN 9-36V,OVP&OCP; 14.4W(2.5" HDD)	DC IN 12V/9-36V,OVP&OCP; 18.35W(Celeron J6412/2.00GHz, 8G DDR4, 128G mSATA)
Mechanical							
Structure	Aluminum-magnesium alloy, SGCC frame	Aluminum-magnesium alloy, SGCC frame	Aluminum-magnesium alloy, SGCC frame	Aluminum-magnesium alloy, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame	Aluminum Chassis, SGCC frame
Color	Silver gray	Silver gray	Silver gray	Silver gray	Silver gray	Silver gray	Silver gray
Installation	Wall/Desktop/Din-Rail mounting	Wall/Desktop/Din-Rail mounting	Wall/Desktop/Din-Rail mounting	Wall/Desktop/Din-Rail mounting	desktop/Wall/Din-Rail mounting	desktop/Wall/Din-Rail mounting	desktop mounting
Dimension	225*154*75.6mm	225*154*75.6mm	225*154*75.6mm	225*154*75.6mm	238*169*75.6mm	238*169*61.8mm	268*160*57.6mm
Net Weight	TBD	TBD	TBD	TBD	2.55KG	2.32KG	2.15KG
Environmental							
Operating Temp	-20°C~60°C,SSD, with air flow; -10°C~55°C,HDD, with air flow;	-20°C~60°C,SSD, with air flow; -10°C~55°C,HDD, with air flow;	-20°C~60°C,SSD, with air flow; -10°C~55°C,HDD, with air flow;	-20°C~60°C,SSD, with air flow; -10°C~55°C,HDD, with air flow;	-20°C~60°C,SSD, with air flow; -10°C~55°C,HDD, with air flow;	-20°C~60°C,SSD, with air flow; -10°C~55°C,HDD, with air flow;	-20°C~65°C,SSD,with air flow
Storage Temp	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-10°C~55°C,HDD,with air flow
Humidity	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~90%@40°C, No- condensation
Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)	5 grms/5~500Hz/random/operation (SSD) 1 grms/5~500Hz/random/operation (HDD)
Shock	50g peak acceleration(duration 11ms,SSD); 20gpeak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20gpeak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20gpeak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20gpeak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20gpeak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20gpeak acceleration(duration 11ms,HDD)	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Certificate /EMC	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A
OS	Windows 10 Enterprise(/IOT,64bit) (CFL-R) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R) Wind River VxWorks 7 (CFL-R)	Windows 10 Enterprise(/IOT,64bit) (CFL-R) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R) Wind River VxWorks 7 (CFL-R)	Windows11/10 IoT Enterprise (64-bit), Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7	Windows11/10 IoT Enterprise (64-bit), Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7	Windows 11/10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7	Windows 11/10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7	Windows 7, Windows 8.1, Windows 10, Linux Fedora Ubuntu
Watchdog timer	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second

KMDA-2602

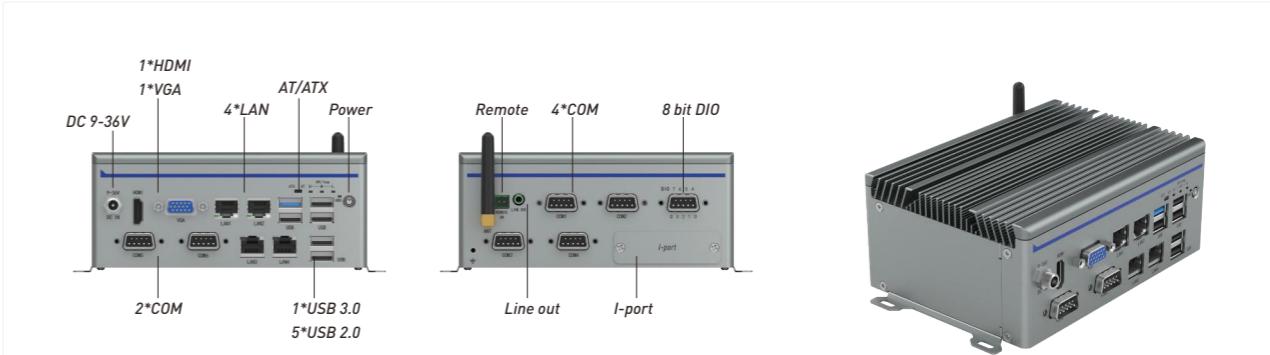
Intel Celeron J1900 CPU, 4*LAN, 7*USB, 6*COM, Dual display, DC-IN 9~36V, LED Temperature control display

Key Specification

- Compact Aluminum Chassis, fanless heat dissipation design
- Intel Baytrail Celeron J1900 2.0-2.42G CPU
- 1*DDR3L 1333MHz SODIMM RAM, 8GB max.
- 4*Intel I211-AT PCIe Gig LAN
- 1*HDMI & 1*VGA Dual display, Audio Line out
- 1*USB3.0, 6*USB2.0, 6*COM, 8-bit DIO
- 1*Mini PCIe(PCIE+USB)
- 1*2.5" SATA2 bay, 1*Mini PCIe(SATA+USB)
- DC 9~36V wide voltage power supply



I/O View



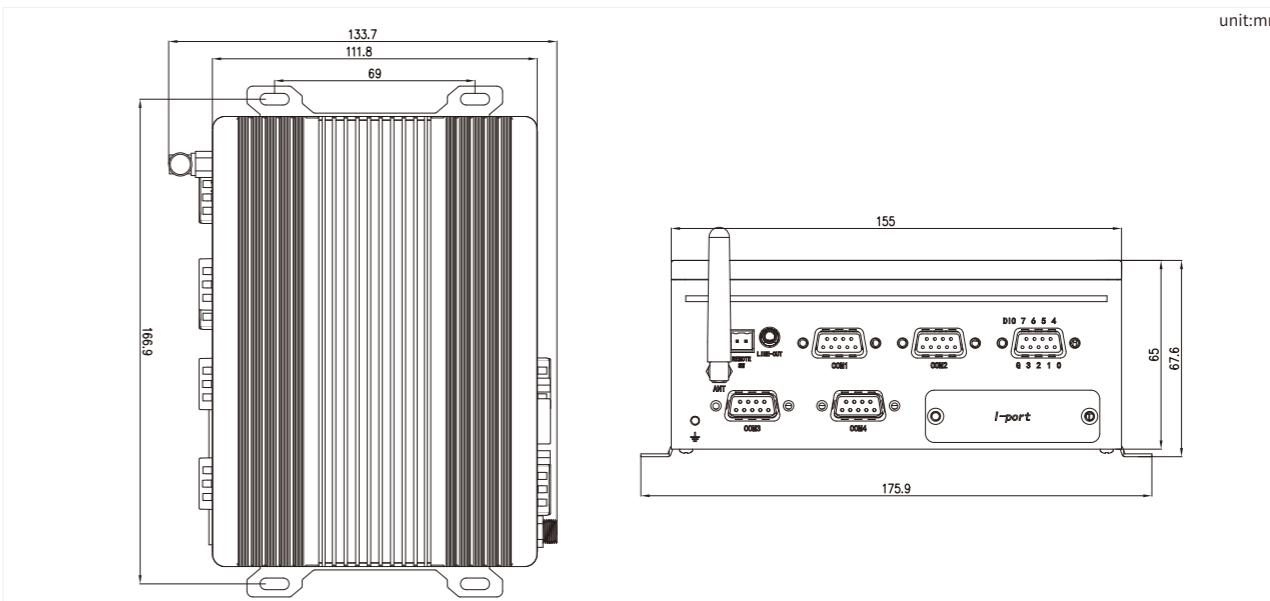
Product Overview

KMDA-2602 is a compact box PC, equipped with low-power processor, HDMI and VGA dual display, 2*Mini PCIe internal expansion, 1*2.5" SATA storage. DC 9~36V wide voltage power supply, Real-time operating temperature LED simulation display, It is economical and applicable with high reliability, which is suitable for equipment automation and IoT signal acquisition, etc.

Product Parameters

Processor	
CPU	Intel Baytrail-D Celeron J1900, frequency 2.0~2.42GHz, 4C4T, 2M cache, 22nm, TDP 10W
RAM	1*DDR3L, 1333MHz, SODIMM, 8GB max.
Graphics	
Graphics	Intel HD Graphics, Support dual independent display VGA: 1920*1200@60Hz, HDMI: 1920*1080@60Hz, support OpenGL 3.2, DirectX 11, OpenCL 1.2, MPGE2/H.264
I/O Port	
LAN	4*Intel I211AT PCIe Gigabit Ethernet, 10-1000M
USB	1*USB3.0, 5*USB2.0, 1*USB2.0 (Build-in)
Display	1*HDMI + 1*VGA
Audio	1*Line out, Realtek ALC662VD
COM/ Others	2*RS232/422/485, 2*RS232(rear panel), 2*RS232/485(front panel), 1*2pin terminal, remote switch signal, USB(mouse/keyboard)
DIO	8-bit TTL, programmable input & output
Storage	
Storage	1*2.5" HDD SATA2 bay, 3.0 Gbps, 1*mSATA Full-height card, support AHCI
Others	
Indicator light	1*power indicator, 1*hard disk indicator, 3*CPU temperature indicator (Red is high temperature, Yellow is normal temperature, Green is low temperature)
Control switch	1*power switch (front panel), 1*2pin terminal switch signal (rear panel), 1*AT/ATX selector switch (front panel)
Watchdog timer	Programmable timeout interrupt or system reset, 1 to 255 seconds

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-2602/S002	Intel® J1900 CPU	4*LAN, 1*USB3.0, 6*USB2.0, 6*COM, 8-bit DIO, 1*HDMI, 1*VGA, 1*Line out, 2*Mini PCIe (One of them shares slots with mSATA), 1*I-port, 1*2.5" SATA bay, DC 9~36V
KMDA-2602/T001	Intel® J1900 CPU	2*LAN, 1*USB3.0, 4*USB2.0, 4*COM, 8-bit DIO, 1*HDMI, 1*VGA, 1*Line out, 2*Mini PCIe (One of them shares slots with mSATA), 1*I-port, 1*2.5" SATA bay, DC 9~36V
PA-60DC12	AC/DC adaptor, DC12V/5A 60W	
OS		
Operating System	Windows 7, Windows 8.1, Windows 10, Linux Fedora, Ubuntu	

KMDA-2602/T002

Intel® Celeron J1900 CPU, 2*LAN, 4*USB, 8-bit DIO, 2*COM, Dual independent display,support Din Rail mounting

Key Specification

- Compact Aluminum Chassis, fanless heat dissipation design
- Intel® Baytrail Celeron J1900 2.0~2.42G CPU
- 1*DDR3L 1333MHz SODIMM RAM, 8GB max.
- 2*Intel I211-AT PCIe Gig LAN
- 1*HDMI & 1*VGA Dual display, Audio Line out
- 1*USB3.0, 3*USB2.0, 2*COM, 8-bit DIO
- 1*Mini PCIe(PCle+USB)
- 1*2.5" SATA2 bay, 1*Mini PCIe(SATA+USB)
- DC 9~36V wide voltage power supply
- Compact and thin structure design, support rail installation, flexible and convenient



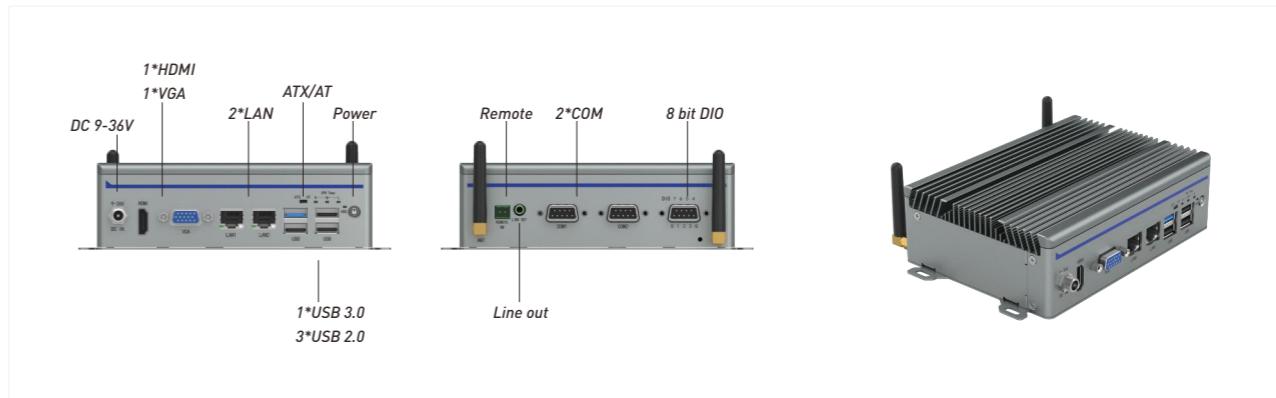
Product Overview

KMDA-2602-T002 is a compact box PC with thin and light design, which can support Din Rail mounting, flexible and convenient. 2*Mini PCIe internal expansion, 2.5" SATA storage. DC9-36V wide voltage power supply, real-time working temperature LED simulation display, economical and high reliability, suitable for equipment automation and IoT data acquisition.

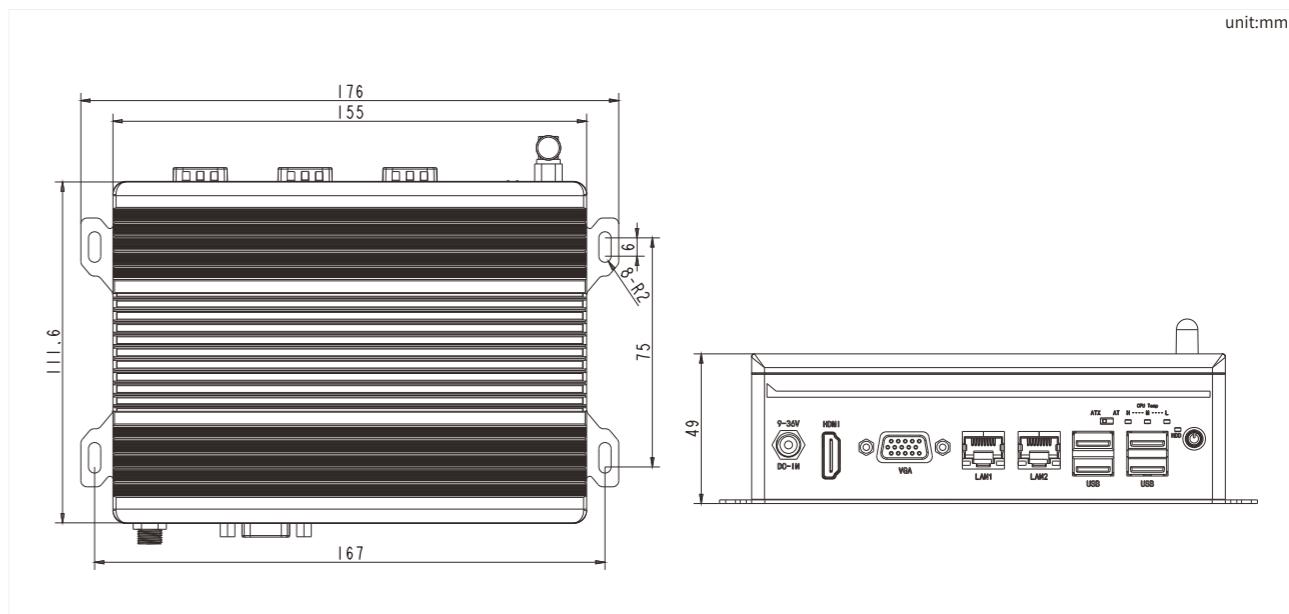
Product Parameters

Processor	Expansion
CPU	Intel Baytrail-D Celeron J1900 , frequency 2.0~2.42GHz, 4C4T, 2M cache, 22nm, TDP 10W
RAM	1*DDR3L,1333MHz,SODIMM, 8GB max.
Graphics	Intel HD Graphics, Support dual independent display VGA:1920*1200@60Hz, HDMI:1920*1080@60Hz, support OpenGL 3.2, DirectX 11, OpenC 1.2, MPGE2/H.264
I/O Port	Power Supply
LAN	2*Intel I211AT PCIe Gigabit Ethernet, 10-1000M
USB	1* USB3.0, 3*USB2.0
Display	1*HDMI+1*VGA
Audio	1*Line out,Realtek ALC662VD,1*3W Speaker pin
COM/ Others	2*RS232/422/485(rear panel), 1*2pin terminal, Remote switch,USB mouse/keyboard
DIO	8-bit TTL, programmable input & output
Storage	Mechanical
Storage	1*2.5" HDD SATA2 bay, 3.0 Gbps, 1*mSATA Full-height card, support AHCI
Others	Environmental
Indicator	1*power indicator, 1*hard disk indicator, 3*CPU temperature indicator (Red is high temperature, Yellow is normal temperature, Green is low temperature)
Control	1*power switch (front panel), 1*2pin terminal switch signal (rear panel), 1*AT/ATX selector switch (front panel)
Watchdog timer	Programmable timeout interrupt or system reset, 1 to 255 seconds
OS	Dimensions
Operating system	Windows 7, Windows 8.1, Windows 10, Linux Fedora,Ubuntu

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-2602/T002	Intel® J1900 CPU	2*LAN, 1*USB3.0, 3*USB2.0, 2*COM, 8-bit DIO, 1*HDMI, 1*VGA, 1*Line out, 2*Mini PCIe, 1*2.5" SATA bay, DC 9~36V
PA-120DC19		AC/DC adaptor, DC 12V/5A 60W
Din-rail mounting module		KMDA-2602-T002 Din-rail mounting module

KMDA-2620

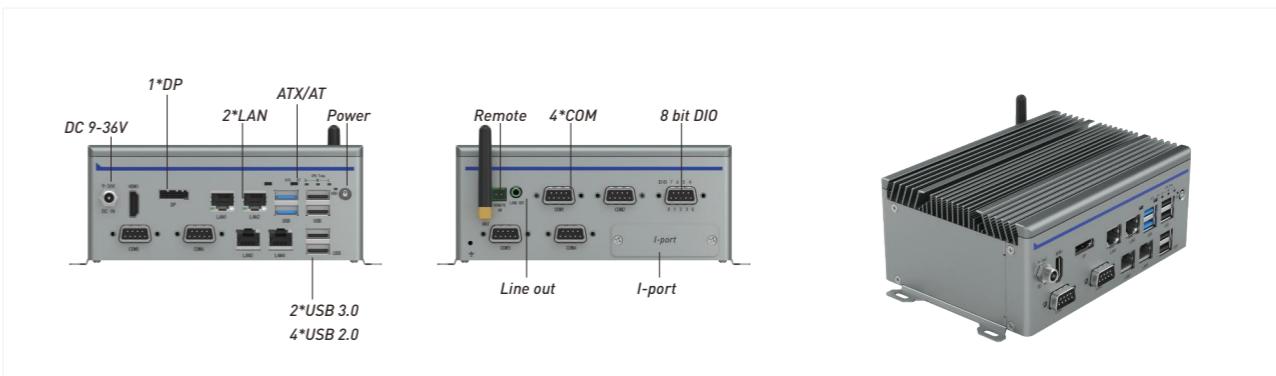
Intel® Apollolake E3940 CPU, 4*LAN, 7*USB, 8-bit DIO, 6*COM, 4K Dual independent display, LED Temperature control display, DC-IN 9-36V

Key Specification

- Compact Aluminum Chassis, fanless heat dissipation design
- Intel® Apollolake Atom E3940 CPU
- 1*DDR3L 1866MHz SODIMM RAM, 8GB max.
- 4*Intel I211-AT PCIe Gig LAN
- 1*HDMI & 1*VGA 4K Dual display, Audio Line out
- 2*USB3.0, 5*USB2.0, 6*COM, 8 bit DIO
- 1*M.2 2242 B-key
- 1*2.5" SATA3 bay, 1*mSATA
- Aluminum cover for HDD heat dissipation, increasing hard disk operating temperature (3-5°C)
- DC 9~36V wide voltage power supply



I/O View



Product Overview

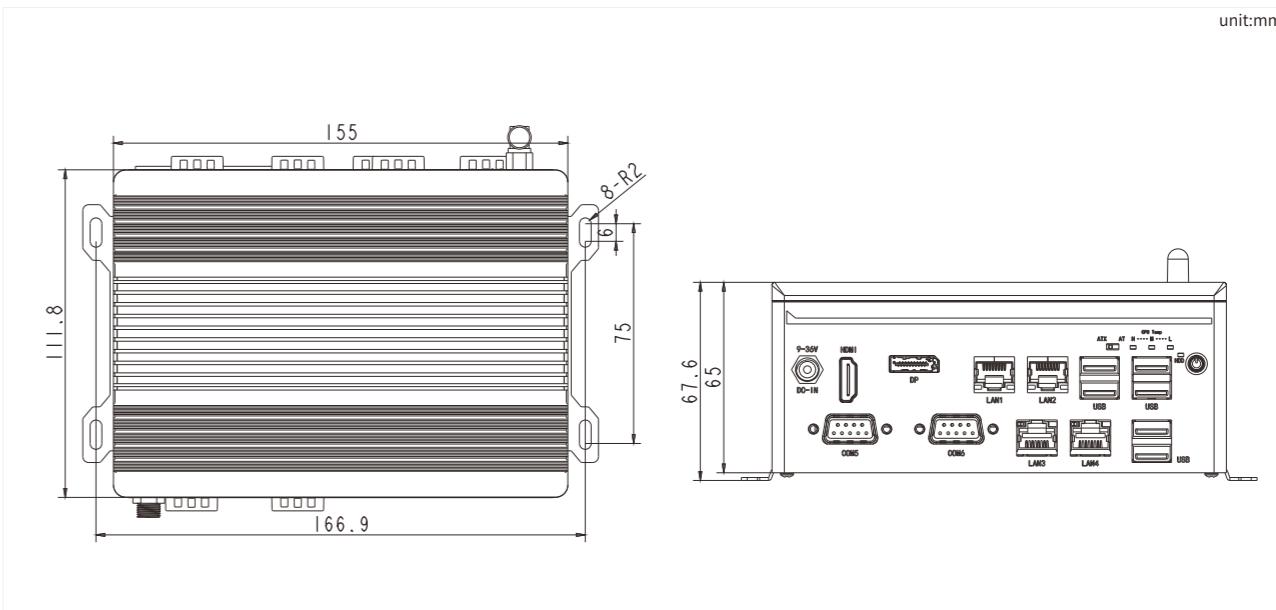
KMDA-2620 is a compact box PC equipped with Intel® Apollolake Atom E3940 CPU, HDMI and DP dual 4K displays, 8-bit DIO, 1 M.2 2242 B-key, 1 mSATA and 1 2.5-inch SATA Disk storage. DC9-36V wide voltage power supply, real-time working temperature LED simulation display, economical and high reliability, suitable for equipment automation and IoT data acquisition...etc

Product Parameters

Processor	
CPU	Intel® Apollolake Atom E3940 CPU
RAM	1*DDR3L, 1866MHz, SODIMM, 8GB max.
Graphics	Gen. 9th Intel HD Graphics, DP:4096*2160@60Hz, HDMI:3840*2160@30Hz,support OpenGL 4.3, DirectX 11, OpenCL 2.0, MPGE2, H.265
LAN	4/2*Intel I211AT PCIe Gigabit Ethernet, 10-1000M
USB	2* USB3.0, 4/2*USB2.0, 1*USB2.0 (Build-in)
Display	1*DP+1*HDMI
Audio	1*Line out,Realtek ALC662VD
COM/ Others	4/2*RS232/422/485, 2*RS232, 1*2 pin terminal, Remote switch,USB mouse/keyboard
DIO	8-bit TTL, programmable input & output
Storage	
Storage	1*2.5" HDD SATA3 bay,6.0 Gbps, 1*mSATA Full-height card,support AHCI
Others	
Indicator	1*power indicator, 1*HDD indicator, 3*CPU temperature indicator (Red is high temperature, Yellow is normal temperature, Green is low temperature)
Control switch	1*power switch (front panel), 1*2pin terminal switch signal(rear panel), 1*AT/ATX selector switch (front panel)
Watchdog timer	Programmable timeout interrupt or system reset, 1 to 255 seconds

Expansion	
Expansion Port	1*M.2 B-key with PCIe+USB signal & SIM slot, support dual 4G/Wifi/BT,
Power Supply	
Input voltage	DC IN 9~36V, with protection of short circuit, over voltage, over current
TDP	20.04W(E3940 CPU,4G DDR3L)
Mechanical	
Structure	Top/Bottom Aluminum Chassis, SGCC frame
Color	Silver gray
Installation	desktop mounting & VESA 100*100mm
Dimension(W*H*D)	155*111.8*65mm
Net Weight	1.30KG
Environmental	
Operating Temp	-20°C~70°C - fanless design, wide-temperature SSD -10°C~55°C - fanless design, HDD
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)
Shock	50g peak acceleration(duration 11ms) with SSD, 20g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class A
OS	
Operating system	Windows 7, Windows 8.1, Windows 10, Linux Fedora,Ubuntu

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-2620/S001	Intel® Apollolake Atom E3940 CPU	4*LAN, 2*USB3.0, 5*USB2.0, 6*COM, 8-bit DIO, 1*HDMI, 1*DP, 1*Line out, 1*M.2, 1*mSATA, 1*I-port, 1*2.5" SATA bay, DC 9~36V
KMDA-2620/T002	Intel® Apollolake Atom E3940 CPU	2*LAN, 2*USB3.0, 3*USB2.0, 4*COM, 8-bit DIO, 1*HDMI, 1*DP, Line out, 1*M.2, 1*mSATA, 1*Port, 1*2.5" SATA bay, DC 9~36V
PA-120DC19		AC/DC adaptor, DC 12V/5A 60W

KMDA-2701

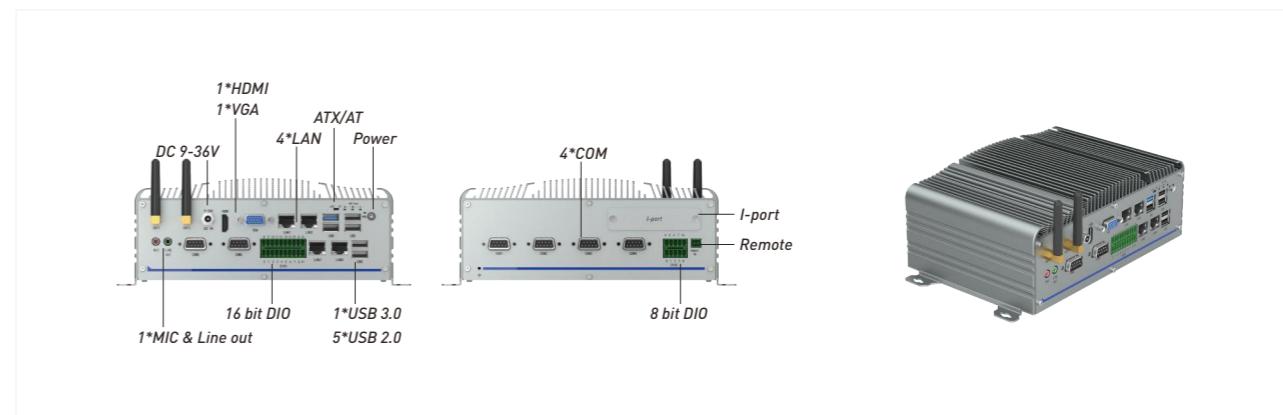
Intel Baytrail-D Celeron J1900 CPU, 4*LAN, 7*USB, 6*COM, Dual display, DC-IN 9~36V, Audio Line out & Mic, 24-bit DIO

Key Specification

- Aluminum Chassis, fanless heat dissipation design
- Intel Baytrail-D Celeron J1900 2.0-2.42G CPU
- 1*DDR3L 1333MHz SODIMM RAM, 8GB max.
- 4*Intel I211-AT PCIe Gig LAN
- 1*HDMI & 1*VGA Dual display, Audio Line out
- 1*USB3.0, 6*USB2.0, 6*COM, 24-bit DIO
- 1*Mini PCIe(PCle+USB), 1*Mini PCIe(SATA+USB)
- 1*3.5" SATA2 bay, 1*mSATA
- DC 9~36V wide voltage power supply



I/O View



Product Overview

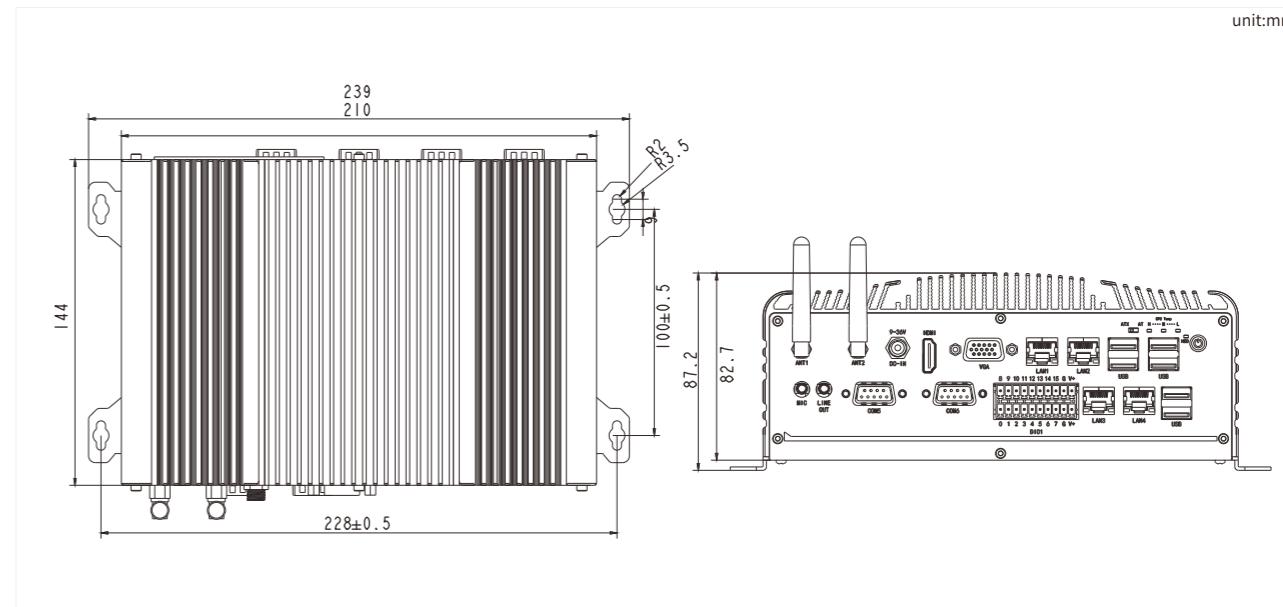
KMDA-2701 is a general-purpose box PC, equipped with Intel Baytrail-D Celeron J1900 2.0-2.42GHz quad-core processor, HDMI and VGA dual display, 24-bit DIO, DC9-36V wide-voltage power supply, real-time operating temperature LED simulation Display, economical and high reliability, suitable for intelligent security and equipment automation.

Product Parameters

Processor	
CPU	Intel Baytrail-D Celeron J1900 , frequency 2.0~2.42GHz, 4C4T, 2M cache, 22nm, TDP 10W
RAM	1*DDR3L, 1333MHz, SODIMM, 8GB max.
Graphics	
Graphics	Intel HD Graphics, Support dual independent display VGA:1920*1200@60Hz, HDMI:1920*1080@60Hz,support OpenGL 3.2, DirectX 11, OpenCL 1.2, MPGE2/H.264
LAN	4*Intel I211AT PCIe Gigabit Ethernet,10-1000M
USB	1*USB3.0, 5*USB2.0, 1*USB2.0 (Build-in)
Display	1*VGA+1*HDMI
Audio	1*Line out+1*Mic, Realtek ALC662VD,build-in 3W Speaker pin
COM/ Others	4*RS232/422/485, 2*RS232, 1*2 pin terminal, Remote switch,USB mouse/keyboard
DIO	16-bit TTL, programmable input & output 8-bit TTL, programmable input & output
Storage	
Storage	1*3.5" HDD SATA2 bay, 3.0 Gbps, 1*mSATA Full-height card, support AHCI
Others	
Indicator light	1*power indicator, 1*hard disk indicator, 3*CPU temperature indicator (Red is high temperature, Yellow is normal temperature, Green is low temperature)
Control switch	1*power switch (front panel), 1*2pin terminal switch signal(rear panel), 1*AT/ATX selector switch (front panel)
Watchdog timer	Programmable timeout interrupt or system reset, 1 to 255 seconds

Expansion	
Expansion Port	1*Mini PCIe, with SIM slot , support 4G LTE,Wifi/BT, I-Port 1*USB2.0 or other Mini PCIe interface(i.e. CAN Bus & Gig. LAN)
Power Supply	
Input voltage	DC IN 9~36V, D-Jack with M8 interface, short circuit protection, over voltage & over current protection
TDP	19.2W(3.5" HDD)
Mechanical	
Structure	U-shaped Aluminum Chassis, SGCC frame
Color	Silver gray
Installation	desktop mounting
Dimension(W*H*D)	210*144*82.7mm
Net Weight	2.60KG
Environmental	
Operating Temp	-20°C~70°C – fanless design, wide-temperature SSD -10°C~55°C – fanless design, HDD
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No- condensation
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)
Shock	50g peak acceleration(duration 11ms) with SSD, 20g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class A
OS	
Operating system	Windows 7, Windows 8.1, Windows 10, Linux Fedora,Ubuntu

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-2701/S002	Intel® J1900 CPU	4*LAN, 1*USB3.0, 6*USB2.0, 6*COM, 24-bit DIO, 1*HDMI, 1*VGA, 1*Line out, 1*Mic, 1*Mini PCIe(shares slots with mSATA), 1*mSATA, 1*I-port, 1*3.5" SATA bay, DC 9-36V
KMDA-2701/T001	Intel® J1900 CPU	2*LAN, 1*USB3.0, 4*USB2.0, 4*COM, 8-bit DIO, 1*HDMI, 1*VGA, Line out 2*Mini PCIe(shares slots with mSATA), 1*mSATA, 1*I-port, 1*3.5" SATA bay, DC 9-36V
PA-60DC12		AC/DC adaptor,DC 12V/5A 60W

KMDA-2702

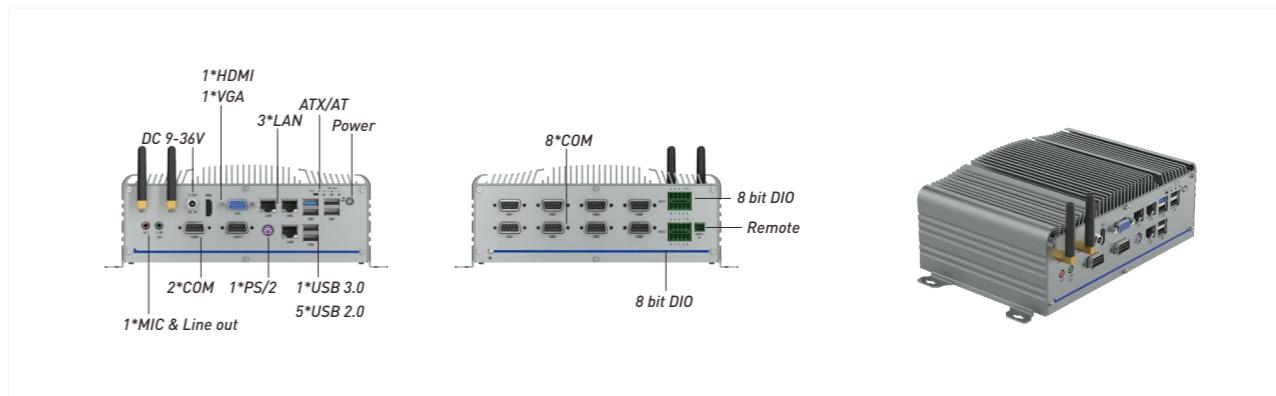
Intel Baytrail-D Celeron J1900 CPU, 3*LAN, 7*USB, 10*COM, Dual display, DC-IN 9~36V, Audio Line out & Mic, 16-bit DIO

Key Specification

- Aluminum Chassis, fanless heat dissipation design
- Intel Baytrail-D Celeron J1900 2.0-2.42G CPU
- 1*DDR3L 1333MHz SODIMM RAM, 8GB max.
- 3*Intel I211-AT PCIe Gig LAN
- 1*HDMI & 1*VGA Dual display, Audio Line out
- 1*USB3.0, 6*USB2.0, 10*COM, 1*PS2, 16-bit DIO
- 1*Mini PCIe(PCle+USB), 1*Mini PCIe(SATA+USB)
- 1*2.5" SATA2 bay, 1*mSATA
- DC 9~36V wide voltage power supply



I/O View



Product Overview

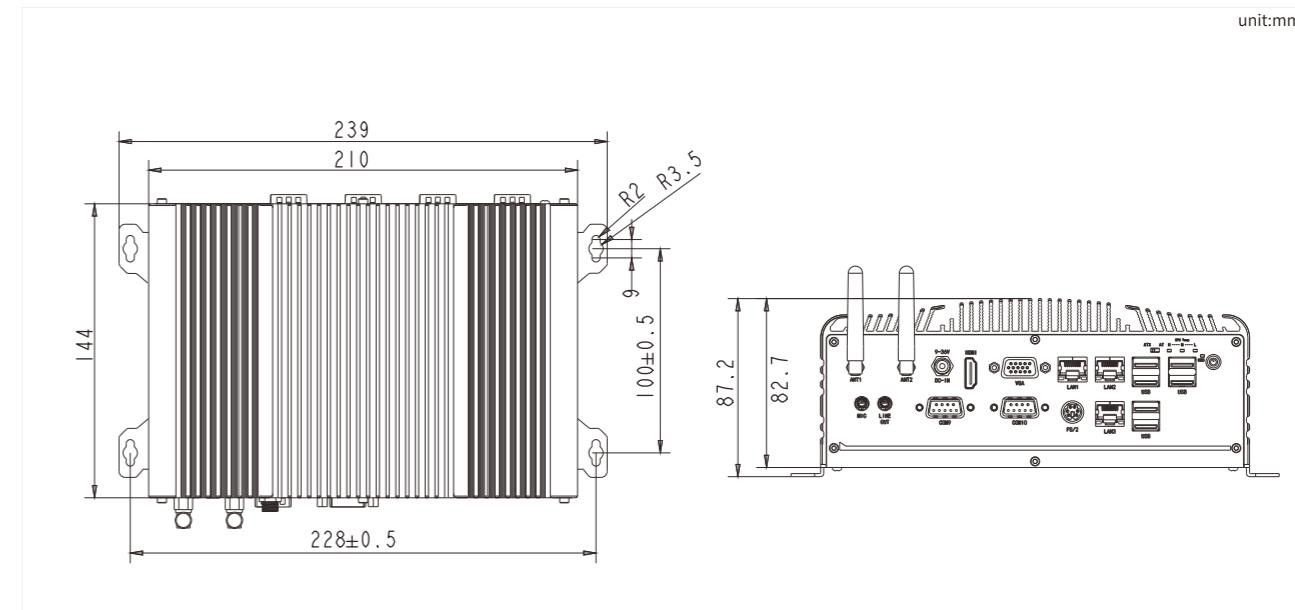
KMDA-2702 is a general-purpose box PC, equipped with Intel Baytrail-D Celeron J1900 2.0-2.42GHz quad-core processor, DC9-36V wide voltage power supply, real-time working temperature LED simulation display, economical, high reliability, suitable for environment Monitoring and new energy industry, etc.

Product Parameters

Processor	Intel Baytrail-D Celeron J1900 , frequency 2.0~2.42GHz, 4C4T, 2M cache, 22nm, TDP 10W
CPU	RAM 1*DDR3L, 1333MHz, SODIMM, 8GB max.
RAM	Intel HD Graphics, Support dual independent display VGA:1920*1200@60Hz, HDMI:1920*1080@60Hz, support OpenGL 3.2, DirectX 11, OpenCL 1.2, MPGE2/H.264
Graphics	3*Intel I211AT PCIe Gig. Ethernet, 10-1000M
LAN	1*USB3.0, 5*USB2.0, 1*USB2.0 (Build-in)
USB	1*VGA+1*HDMI
Display	1*Line out+1*Mic, Realtek ALC662VD, build-in 3W Speaker pin
Audio	8*RS232/422/485, 2*RS232, 1*2 pin terminal, Remote Switch, PS2 mouse/keyboard
COM/ Others	16-bit TTL, programmable input & output (2*5Pin Phoenix terminal*2)
DIO	1*power indicator, 1*hard disk indicator, 3*CPU temperature indicator (Red is high temperature, Yellow is normal temperature, Green is low temperature)
Storage	1*2.5" HDD SATA2 bay, 3.0 Gbps, 1*mSATA Full-height card, support AHCI
Others	1*power switch (front panel), 1*2pin terminal switch signal (rear panel), 1*AT/ATX selector switch (front panel)
Control switch	Programmable timeout interrupt or system reset, 1 to 255 seconds timer
Watchdog	Windows 7, Windows 8.1, Windows 10, Linux Fedora, Ubuntu

Expansion	Expansion Port 1*Mini PCIe, with SIM slot support 4G LTE/Wifi/BT
Power Supply	Input voltage DC IN 9~36V, D-Jack, D-Jack with M8 interface, short circuit protection, over voltage & over current protection TDP 15.6W(2.5" HDD)
Mechanic	Structure U-shaped Aluminum Chassis, SGCC frame Color Silver gray Installation desktop mounting Dimension(w*h*d) 210*144*82.7mm Net Weight 2.60KG
Environmental	Operating Temp -20°C~70°C – fanless design, wide-temperature SSD -10°C~55°C – fanless design, HDD Storage Temp -40°C~85°C Storage Humidity 10~90%@40°C, No condensation Vibration 5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD) Shock 50g peak acceleration(duration 11ms) with SSD, 20g peak acceleration(duration 11ms) with HDD Certificate/EMC CE/FCC Class A
OS	Operating system Windows 7, Windows 8.1, Windows 10, Linux Fedora, Ubuntu

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-2702/S001	Intel® J1900 CPU	3*LAN, 1*USB3.0, 6*USB2.0, 10*COM, 16-bit DIO, 1*HDMI, 1*VGA, 1*Line out, 1*Mic, 2*Mini PCIe (one of them shares slots with mSATA), 1*2.5" SATA bay, DC 9~36V
PA-60DC12		AC/DC adaptor, DC12V/5A 60W

KMDA-3201

Intel Skylake-U/Kabylake-U CPU, 3*LAN, 7*USB, 6*COM, 4K Dual independent display, 8-bit DIO, Intel Vpro, TPM2.0, DC 9~30V

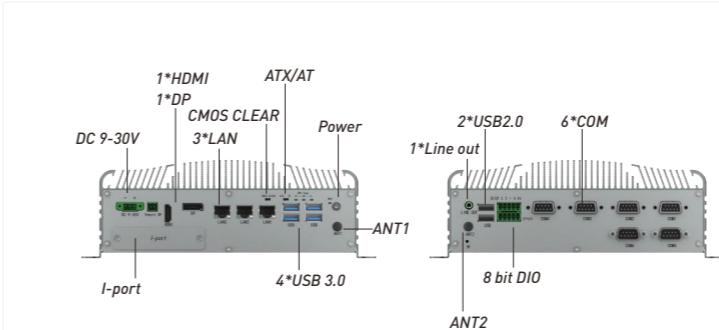
Key Specification

- Aluminum Chassis, fanless heat dissipation design
- Intel Skylake-U/Kabylake-U CPU
- 2*DDR4 2133MHz SODIMM RAM, 32GB max.
- 1*HDMI & 1*DP display, support 4K Dual display
- 3*Gig LAN, 4*USB3.0, 3*USB2.0(one build-in)
- 6*COM, 8-bit DIO, Line out
- 1*Mini PCIe(PCle+USB) full-height card, 1*M.2 2242 B-key
- 1*mSATA, 1/2*2.5" SATA bay
- Support Intel vPro technology and optional TPM 2.0 security encryption
- DC 9~36V wide voltage power supply,

With reverse polarity protection, short circuit protection, over voltage & over current protection



I/O View



Product Overview

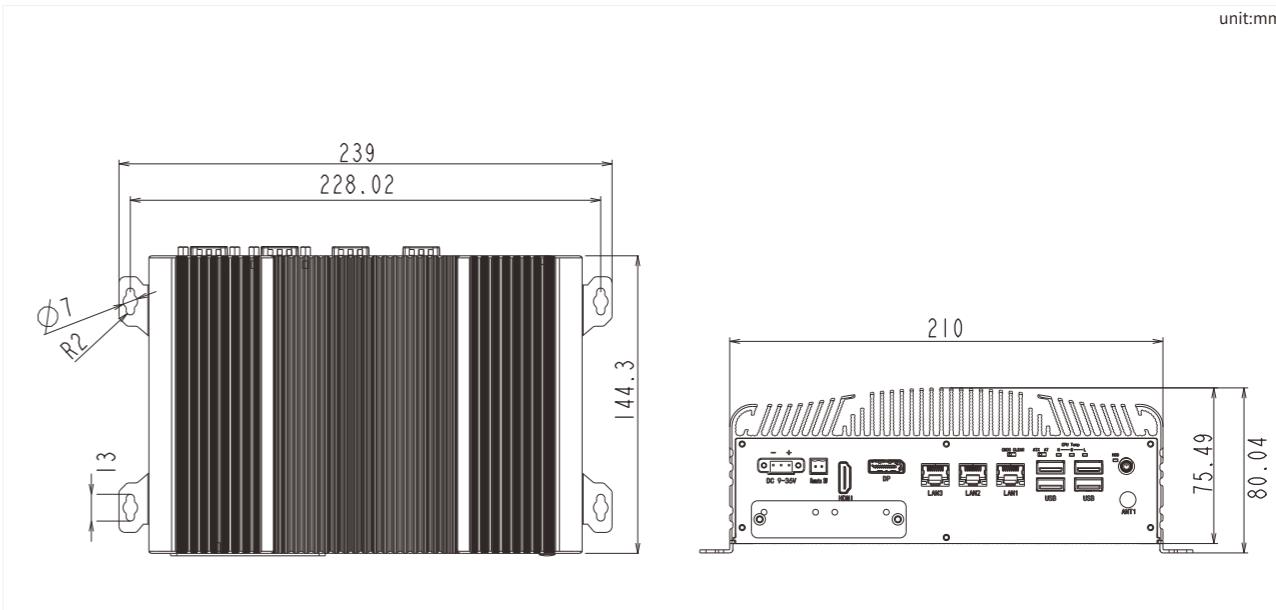
KMDA-3201 is a new industrial design Box Computer with aluminum chassis and fanless design. It is equipped with Intel Skylake-U/Kabylake-U processor. It supports Intel vPro technology and optional TPM2.0 hardware encryption technology, high reliability, DC9-30V wide-voltage power supply, widely used in artificial intelligence, machine vision and intelligent transportation industries.

Product Parameters

Processor	Intel Skylake-U/Kabylake-U CPU Celeron/ Core i3/i5/i7 U
CPU	2*260-Pin SODIMM, DDR4,2133MHz, 32GB max.
RAM	Intel Gen. 9th HD Graphics, HEVC/H265 HW HD codec, HDMI: 3840*2160@30Hz, DP: 4096*2304@60Hz
Graphics	2*Intel I211AT PCIe Gig. Ethernet, 10-1000M, 1*Intel I219 LM support Intel Vpro
LAN	4* USB3.0, 2*USB2.0 , 1*USB2.0 (Build-in)
USB	1*DP+1*HDMI
Display	1*Line out , Realtek ALC662VD
Audio	2*RS232/422/485, 4*RS232, 1*2 pin terminal, remote switch,USB mouse/keyboard
COM/ Others	8-bit TTL, programmable input & output (2*5Pin Phoenix terminal)
DIO	1*power indicator, 1*hard disk indicator, 3*CPU temperature indicator (Red is high temperature, Yellow is normal temperature, Green is low temperature)
Storage	1*2.5" HDD SATA3 bay, 6.0 Gbps, 1*mSATA Full-height card, support AHCI
Others	1*power switch (front panel), 1*2pin terminal switch signal(rear panel), 1*AT/ATX selector switch (front panel)
Control switch	Programmable timeout interrupt or system reset, 1 to 255 seconds
Watchdog timer	

Expansion	1*Mini PCIe with SIM slot , 1*M.2 B-key with PCIe+USB signal & SIM slot,support dual 4G/Wifi/BT, I-port:optional 2*USB2.0,LVDS or Mini PCIe interface
Power Supply	DC IN 9~30V, 3pin terminal, With reverse polarity protection, short circuit protection, over voltage & over current protection
Expansion Port	27.72W (I5-7200U 8GB)
Mechanical	Sturcture Aluminum Chassis, SGCC frame Color Silver gray Installation desktop mounting Dimension(W*H*D) 210*144.3*75.5mm Net Weight 2.20KG
Environmental	Operating Temp -20°C~70°C – fanless design, wide-temperature SSD -10°C~50°C – fanless design, HDD Storage Temp -40°C~85°C Storage Humidity 10~90%@40°C, No-condensation Vibration 5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD) Shock 50g peak acceleration(duration 11ms) with SSD, 20g peak acceleration(duration 11ms) with HDD Certificate/EMC CE/FCC Class A OS Windows 7, Windows 10, Linux Fedora,Ubuntu

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-3201/S001	Intel Core i3-6100U/i3-7100U	3*LAN, 4*USB3.0, 3*USB2.0, 6*COM, 8-bit DIO, 1*Mini PCIe, 1*M.2, 1*HDMI, 1*DP , 1*Line out, 1*I-port, 1*2.5" SATA bay, 1*mSATA, DC 9~30V
KMDA-3201/S002	Intel Core i5-6200U/i5-7200U	
KMDA-3201/S003	Intel Core i7-6500U/i7-7500U	
KMDA-3201/S004	Intel Celeron 3855U/3865U CPU	
PA-60DC12		AC/DC adaptor,DC12V@5A 60W
PA-120DC19		AC/DC adaptor,DC19V/6.32A,120W

KMDA-3202

Intel Skylake-U/Kabylake-U CPU, 3*LAN, 4*POE, 9*USB, 6*COM, Dual 4K display, 8-bit DIO+16-bit iso DIO, Intel Vpro, TPM2.0, DC 9~30V

Key Specification

- Aluminum Chassis, fanless heat dissipation design
- Intel Skylake-U/Kabylake-U CPU
- 2*DDR4 2133MHz SODIMM RAM, 32GB max.
- 1*HDMI & 1*DP display, support 4K Dual display
- 3*Gig LAN, 4*POE, 4*USB3.0, 5*USB2.0 (one build-in)
- 6*COM, 1*PS2, 16bit iso DIO, 8-bit DIO, Line out & Mic
- 1*Mini PCIe(PCIe+USB) full-height card, 1*M.2 2242 B-key
- 1*mSATA, 1/2*2.5" SATA bay
- Support Intel vPro technology and optional TPM 2.0 security encryption
- DC 9~36V wide voltage power supply, With reverse polarity protection, short circuit protection, over voltage & over current protection



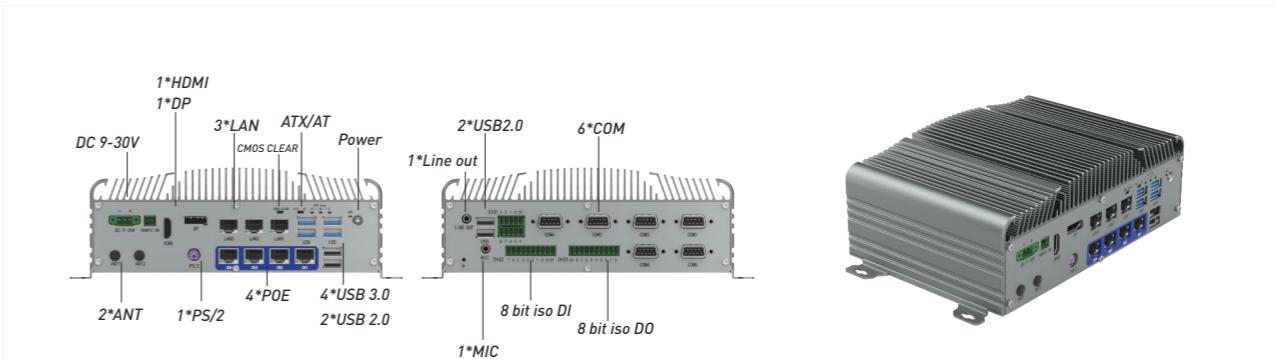
Product Overview

KMDA-3202 is a new industrial design Box Computer with aluminum chassis and fanless design. Using Intel Skylake-U/Kabylake-U processors, dual-channel DDR4 2133MHz SODIMM, up to 32GB, it is widely used in industries such as artificial intelligence, machine vision and robotics.

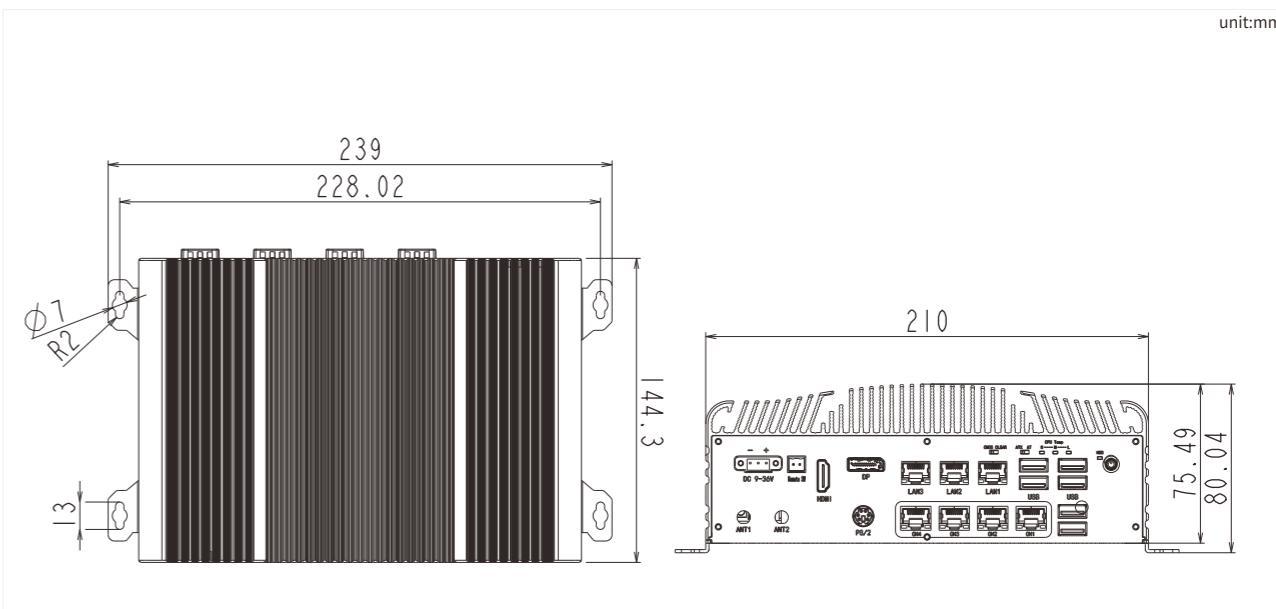
Product Parameters

Processor	Intel Skylake-U/Kabylake-U CPU Celeron/ Core i3/i5/i7 U
CPU	2*260-Pin SODIMM, DDR4, 2133MHz, 32GB max.
RAM	Intel Gen. 9th HD Graphics, HEVC/H265 HW HD codec, HDMI: 3940*2160@30Hz, DP: 4096*2160@60Hz
Graphics	2*Intel I211AT PCIe Gig. Ethernet, 10-1000M, 1*Intel I219 LM support Intel Vpro, 4*Intel I211AT PCIe Full bandwidth POE
LAN	4* USB3.0, 4*USB2.0, 1*USB2.0 (Build-in)
USB	1*DP+1*HDMI
Display	1*Line out+1*Mic, Realtek ALC662VD
Audio	2*RS232/422/485, 4*RS232, 1*2pin terminal, Remote switch interface, 1*PS/2(mouse/keyboard)
COM/ Others	8-bit TTL, programmable input & output (2*5Pin Phoenix terminal) 8-bit Iso. DI (1*10Pin Phoenix terminal), 8-bit Iso. DO (100mA) (1*10Pin Phoenix terminal)
Storage	1*2.5" SATA3 bay, 6.0 Gbps HDD/SSD, 1*mSATA Full-height card, support AHCI
Others	1*power indicator, 1*hard disk indicator, 3*CPU temperature indicator (Red is high temperature, Yellow is normal temperature, Green is low temperature) 1*power switch (front panel), 1*2pin terminal switch signal (rear panel), 1*AT/ATX selector switch (front panel)
Watchdog timer	Programmable timeout interrupt or system reset, 1 to 255 seconds

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-3202/S001	Intel i3-6100U/i3-7100U	3*LAN, 4*POE, 4*USB3.0, 5*USB2.0, 6*COM, 16-bit iso. DIO, 8-bit DIO, 1 *Mini PCIe, 1*M.2, 1*PS/2, 1*HDMI, 1*DP, 1*Line out, 1*Mic, 1*2.5" SATA bay, 1*mSATA, DC 9~30V
KMDA-3202/S002	Intel i5-6200U/i5-7200U	
KMDA-3202/S003	Intel i7-6500U/i7-7500U	
KMDA-3202/S004	Intel Celeron 3855U/3865U	
PA-60DC12		AC/DC adaptor, DC12V/5A 60W--for KMDA-3202-T00X
PA-120DC19		AC/DC adaptor, DC19V/6.32A 120W--for KMDA-3202-S00X

KMDA-3212

Intel® Skylake-U/Kabylake-U CPU, 2/3*LAN, 7*USB, 4*COM, Dual 4K display, 8-bit DIO, Intel Vpro, TPM2.0, DC IN 12~24V

Key Specification

- Aluminum Chassis, fanless heat dissipation design
- Intel Skylake-U/Kabylake-U CPU
- 1*DDR4 2133MHz SODIMM RAM, Max. 16GB
- 1*HDMI & 1*DP display, support 4K Dual display, 1*VGA
- 2/3*Gig LAN, 4*USB3.0, 3*USB2.0 (one build-in)
- 4*COM, 8-bit DIO, 1*Line out, 1*Mic
- 1*MiniPCIe(PCle+USB)
- 1*mSATA, 1*2.5" SATA bay
- Support Intel vPro technology and optional TPM 2.0 security encryption
- DC 12~24V wide voltage power supply



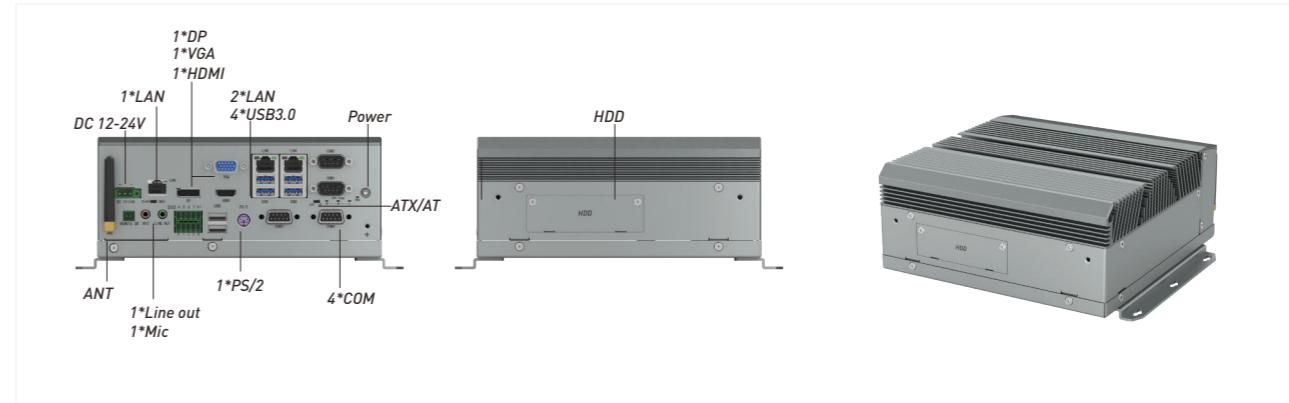
Product Overview

KMDA-3212 is a new industrial design Box Computer of JHCTECH with aluminum chassis and fanless design. Equipped with Intel® Skylake-U/Kabylake-U CPU, 1*mSATA, dual storage, optional support for TPM2.0 and support for iVpro technology. DC12~24V, It is suitable for ITS, medical imaging, intelligent transportation fields.

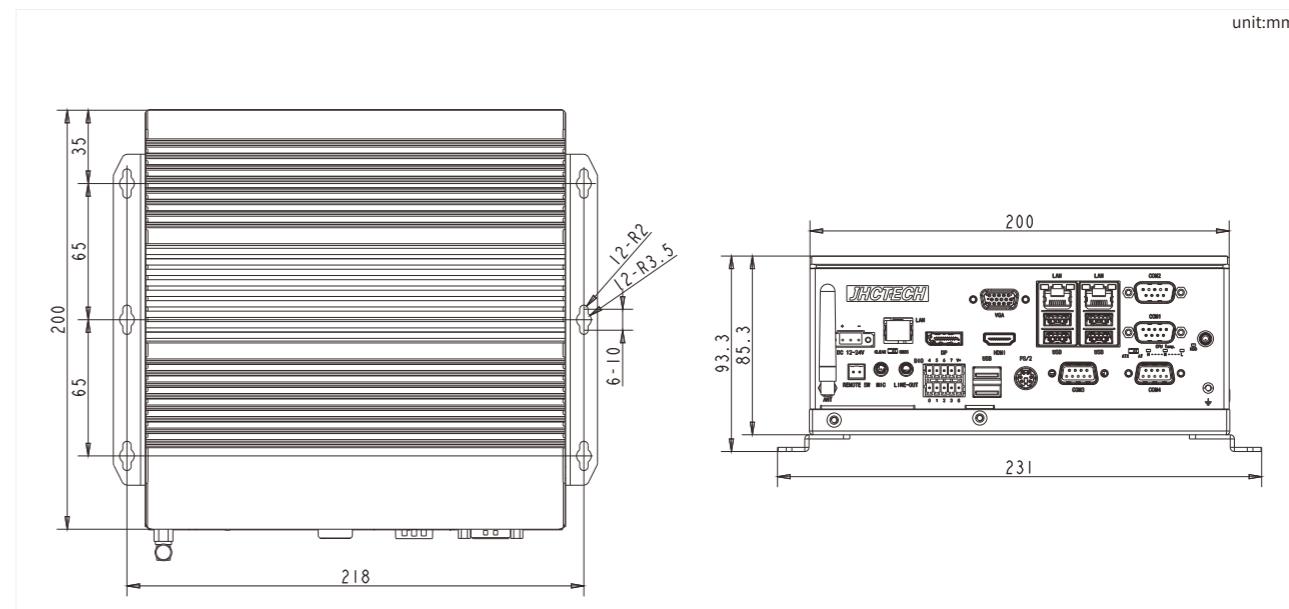
Product Parameters

Processor	Intel Skylake-U/Kabylake-U CPU Celeron/ Core i3/i5/i7 U
CPU	1*260-Pin SODIMM, DDR4,2133MHz, Max. 16GB
RAM	Intel Gen. 9th HDGraphics, HEVC/H265 HW codec, HDMI:4096*2304@24Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz
Graphics	2*Intel I211AT PCIe Gig. Ethernet,10-1000M; 1*Intel I219 LM support Intel Vpro,
LAN	4* USB3.0, 2*USB2.0 , 1*USB2.0 (Build-in)
USB	1*DP+1*HDMI+1*VGA
Display	1*Line out+1*Mic, Realtek ALC662VD
Audio	1*RS232/422/485, 2*RS232, 1*PS/2(mouse/keyboard)
DIO	8-bit TTL, programmable input & output(2*5Pin Phoenix terminal)
Storage	1*2.5" SATA3 bay, 6.0 Gbps HDD/SSD, 1*mSATA , support AHCI
Others	1*power indicator, 1*hard disk indicator, 3*CPU temperature indicator (Red is high temperature, Yellow is normal temperature, Green is low temperature)
Indicator light	1*power switch (front panel), 1*2pin terminal switch signal(rear panel), 1*AT/ATX selector switch (front panel)
Control switch	Programmable timeout interrupt or system reset, 1 to 255 seconds
Watchdog timer	
Expansion	1*Mini PCIe, with SIM slot, support 4G LTE, WiFi/BT
Power Supply	DC IN 12~24V, 3pin terminal(front panel), 58.56W(I5-7200U 16GB DDR4)
Mechanical	Structure Aluminum Chassis, SGCC frame Color Silver gray Installation desktop mounting Dimension(W*H*D) 200*200*85.3mm Net Weight 3.3KG
Environmental	Operating Temp -20°C~70°C – fanless design, wide-temperature SSD -10°C~50°C – fanless design, HDD Storage Temp -40°C~85°C Storage Humidity 10~90%@40°C, No-condensation Vibration 5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD) Shock 50g peak acceleration(duration 11ms) with SSD, 20g peak acceleration(duration 11ms) with HDD Certificate/EMC CE/FCC Class A
OS	Windows 7, Windows 10, Linux Fedora,Ubuntu

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-3212/S001	Intel I3-6100U/I3-7100U	3*LAN, 4*USB3.0, 3*USB2.0, 4*COM, 8-bit DIO, 1*Mini PCIe, 1*HDMI, 1*DP, 1*VGA, 1*PS/2, 1*Line out, 1*Mic, 1*2.5" SATA bay, 1*mSATA, DC 12~24V
KMDA-3212/S002	Intel I5-6200U/I5-7200U	
KMDA-3212/S003	Intel I7-6500U/I7-7500U	
KMDA-3212/S004	Intel Celeron 3855U/3865U	
PA-60DC12		AC/DC adaptor, DC12V/5A 60W
PA-120DC19		AC/DC adaptor, DC19V/6.32A 120W

KMDA-3230

Intel® Whiskey lake U CPU, 2-CH DDR4, 1*HDMI, 1*DP, 5*G-LAN, 5*COM, 4*USB3.1 , 2*USB2.0, DC 9~36V

Key Specification

- Aluminum Chassis, fanless heat dissipation design
- 8th-Gen Intel® Whiskey lake U series CPU
- 2-Ch DDR4 2400MHz SODIMM, 32GB max.
- 1*HDMI & 1*DP display, support 4K Dual display
- 1*Line out&Mic,4*USB3.1,2*USB2.0
- 5* GbE LAN,5*COM ,8-bit iso DIO
- 1*mSATA,1*2.5"SATA bay
- 1*M.2,2230 E-Key, 1*Mini-PCIe,1*SIM slot
- DC 9~36V wide voltage power supply



Product Overview

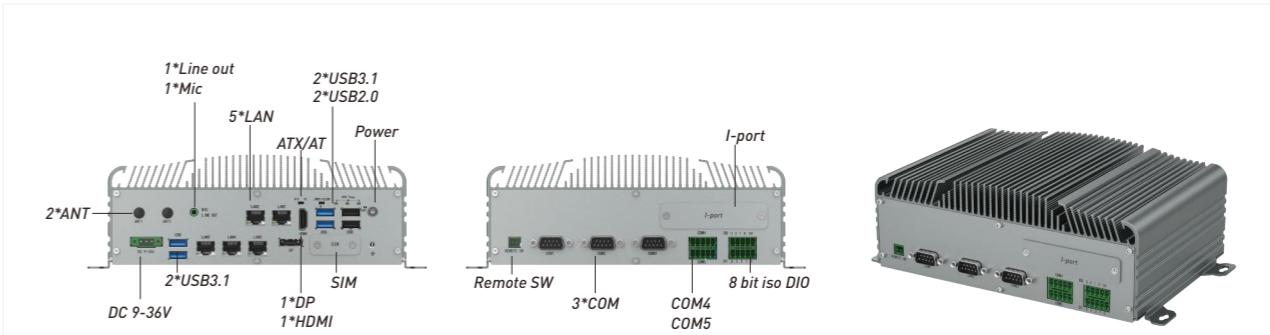
KMDA-3230 is a fanless embedded box PC, equipped with the 8th generation Intel® Whiskey lake U series processor. DC9~36V wide voltage power supply, Aluminum chassis for hard disk heat dissipation. It is small, powerful and exquisite, suitable for applications such as industrial IoT and machine vision.

Product Parameters

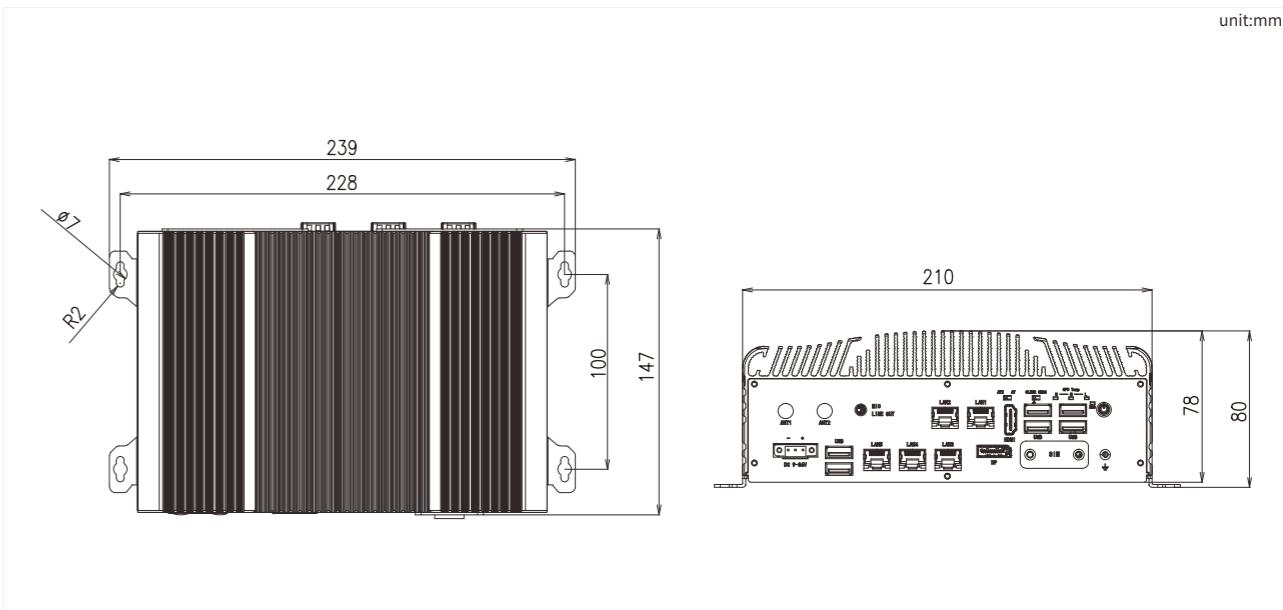
Processor	
CPU	Intel® Whiskey lake U Celeron/Core i3/i5/i7
RAM	
RAM	2*DDR4 SODIMM,2400MHz, 32GB max.
Graphics	
Graphics	Intel® Gen. 9 UHD Graphics,Support dual independent display HDMI:4096*2304@24Hz DP:4096*2304@60Hz
LAN	
LAN	4*Intel® I210AT PCIe, Gig. Ethernet, 10-1000M; 1*Intel®I219LM
USB	
USB	4* USB3.1,2*USB2.0
Display	
Display	1*DP+1*HDMI
Audio	
Audio	1*Line out+1*Mic, Realtek ALC662VD
COM/ Others	
COM/ Others	2*RS485, 3*RS232,
DIO	
DIO	8-bit Iso. DIO(4-bit 2.5KV optical Iso. DO,4-bit 2.5KV optical Iso. DI)
Storage	
Storage	1*2.5" SATA port, 1*mSATA Full-height card, support AHCI
Others	
Indicator light	1*power indicator, 1*hard disk indicator, 3*CPU temperature indicator (Red is high temperature, Yellow is normal temperature, Green is low temperature)
Control switch	1*Power switch, 1*AT/ATX mode selection switch, 1*Clear CMOS data switch
Watchdog timer	Programmable timeout interrupt or system reset, 1 to 255 seconds

Expansion	
Expansion Port	1*Mini PCIe, with SIM slot, support 3G/4G/Wifi/ BT/ GPRS, 1*M.2 E-key 2230 Wifi/BT module expansion, 1*I-port(LPT/USB2.0/16-bit DIO/Mini PCIe,etc)
Power Supply	
Input voltage	DC IN 9~36V, 3pin terminal,
TDP	30W (I5-8265U , 8GB DDR4, 128GB SSD)
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Silver gray
Installation	desktop mounting
Dimension(W*H*D)	210*147*78mm
Net Weight	2.29KG
Environmental	
Operating Temp	-20°C~70°C – fanless design, wide-temperature SSD -10°C~50°C – fanless design, HDD
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No- condensation
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)
Shock	50g peak acceleration(duration 11ms) with SSD, 20g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class A
OS	
Operating system	Windows 10, SUSE, Ubuntu, Wind River, Red Hat Enterprise

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-3230/S001	Intel I3-8145U	2*DDR4 SO-DIMM,1*HDMI,1*DP,1*Line out,1*Mic, 5*LAN,4*USB3.1,2*USB2.0,5*COM,8-bit DIO,1*M.2,1*Mini PCIe,1*SIM slot, 1*mSATA,1*2.5"SATA,DC9~36V
KMDA-3230/S002	Intel I5-8265U	
KMDA-3230/S003	Intel I7-8565U	
KMDA-3230/S004	Intel Celeron 4305U	
PA-60DC12		AC/DC adaptor, DC 12V/5A 60W

KMDA-3601

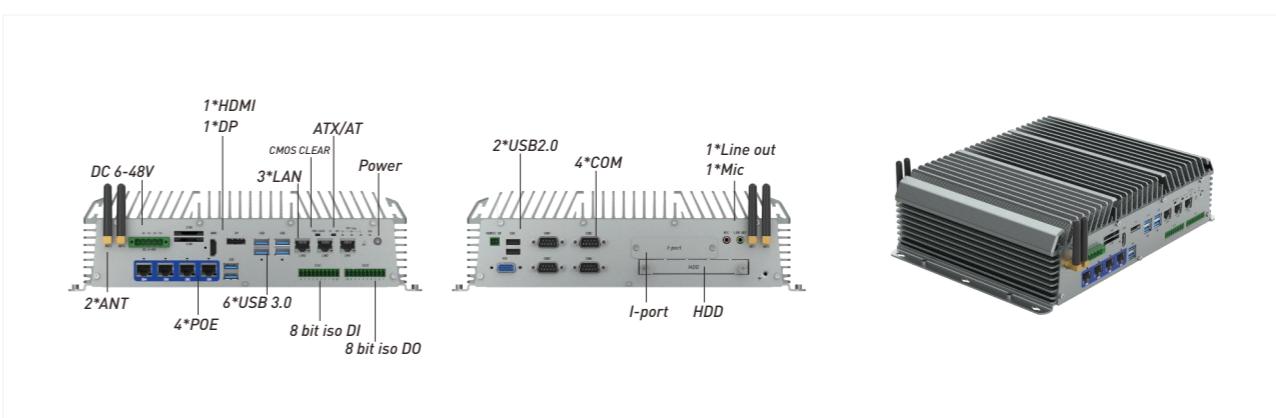
Intel Skylake-S/Kabylake-S CPU, 3*LAN, 4*POE, 6*USB3.0, Dual 4K display, 16-bit iso DIO, iVpro, Wide voltage DC 6~48V

Key Specification

- Aluminum Chassis, fanless heat dissipation design
- Intel Skylake-S/Kabylake-S CPU
- 2*DDR4 2133/2400MHz SODIMM RAM, Max. 32GB
- 1*DP, 1*HDMI & 1*VGA three display, DP and HDMI 4K support
- 3*Gbe LAN, 4*POE/8/11*LAN, 6*USB3.0, 3*USB2.0
- 4*COM, 16 or 24-bit iso DIO, 1*Line out, 1*Mic
- 2*Mini PCIe(PCle+USB), 1*M.2 2242 B-Key
- 1*mSATA, 2*2.5" SATA3 bay, support RAID 0,1 support Intel vPro & optional support TPM2.0 security encryption
- DC 6~48V Wide-voltage power supply, short-circuit, over-voltage, over-current and under-voltage protection



I/O View



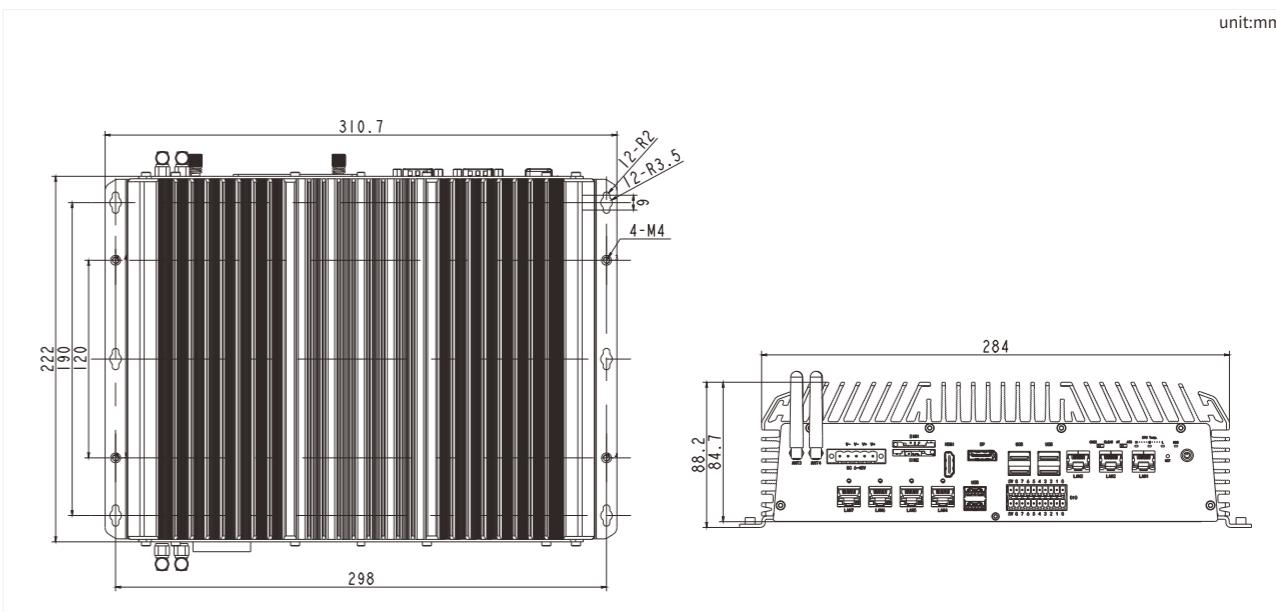
Product Overview

KMDA-3601 is a high-performance box PC with aluminum chassis and fanless design. Equipped with the latest Intel® Skylake-S/Kabylake-S processor, supporting 4G and WiFi/BT wireless communication, DC 6-48V wide-voltage power supply, suitable for applications such as intelligent transportation, video security and machine vision, etc.

Product Parameters

Processor	
CPU	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, Q170 chipset
RAM	2*260-Pin SODIMM, DDR4, 2133MHz, Max. 32GB
Graphics	
Graphics	Intel Gen. 9 HD Graphics, HEVC/H265 HW HD codec, support 3 independent displays DP: 4096*2304@60Hz, VGA: 2650*1600@60Hz, HDMI: 3840*2160@30Hz,
LAN	
LAN	2*Intel I210AT PCIe, 10/100/1000Mbps ; 1*Intel I219 LM, support iVpro, 4*Intel I210AT PCIe, Full bandwidth POE, optional 8/11*LAN
USB	
USB	6* USB3.0, 2*USB2.0, 1*USB2.0 (build-in)
Display	
Display	1*DP+1*HDMI+1*VGA
Audio	
Audio	1*Line out+1*Mic, optional audio
Serial port /Others	
Serial port /Others	2*RS232/422/485, 2*RS232, 8/12-bit 2.5KV Iso. DI(1*10Pin Phoenix terminal), 8/12-bit 2.5KV Iso. DO (1*10Pin Phoenix terminal)
DIO	Optional 16-bit TTL programming input and output/ 24-bit iso DIO
Storage	
Storage	2*2.5" SATA, HDD/SSD, 1*mSATA full-height card, 1*M.2 2242 B-key
Others	
Indicator light	1*power indicator, 1*hard disk indicator, 3*CPU temperature indicator (Red is alarm, Yellow is high temperature, Green is normal temperature)
Control switch	1*Power switch, 1*Reset switch; 1*2pin terminal switch signal, 1*AT/ATX selector switch, 1*CMOS/Clear selector switch
Watchdog timer	Watchdog timeout programmable via software 1 to 255 second

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-3601/S001	Intel® Q170 chip+ SKL/KAL-S LGA1151 CPU	3*LAN, 4*POE, 6*USB3.0, 3*USB2.0, 4*COM, 16-bit Iso.DIO, 1*M.2, 2*Mini PCIe, 1*HDMI, 1*DP, 1*VGA, 1*Line out, 1*Mic, 1*I-port, 2*2.5" SATA bay, 1*mSATA, DC 6~48V
KMDA-3601/S002	Intel® Q170 chip+ SKL/KAL-S LGA1151 CPU	7*LAN, 6*USB3.0, 3*USB2.0, 4*COM, 16-bit DIO, 1*M.2, 2*Mini PCIe, 1*HDMI, 1*DP, 1*VGA, 1*Line out, 1*Mic, 1*I-port, 2*2.5" SATA bay, 1*mSATA, DC 6~48V
KMDA-3601/S003	Intel® Q170 chip+ SKL/KAL-S LGA1151 CPU	11*LAN, 4*USB3.0, 3*USB2.0, 4*COM, 24-bit Iso. DIO, 1*M.2, 2*Mini PCIe, 1*HDMI, 1*DP, 1*VGA, 1*Line out, 1*Mic, 1*I-port, 2*2.5" SATA bay, 1*mSATA, DC 6~48V
PA-120DC19		AC/DC power adapter, DC19V/6.32A, 120W
PA-220DC24		AC/DC Power Adapter, DC24V@9.17A, 220W

KMDA-3602

Intel Skylake-S/Kabylake-S CPU,3*LAN,4*POE,6*USB3.0,MXM3.1GPU,6*4K display, 16-bit iso DIO,ITPS vehicle power

Key Specification

- Aluminum Chassis, CPU with fanless heat dissipation design
- Intel Skylake-S/Kabylake-S CPU
- 2*DDR4 2133/2400MHz SODIMM RAM, Max. 32GB
- MXM3.1 NVIDIA/AMDGPU module
- Integrated 1*DP+1*HDMI+1*VGA, Independent Graphics 3*DP+1*HDMI
- 3*Gig LAN, 4*POE, 6*USB3.0,3*USB2.0
- 2*COM, 16-bit iso DIO, 1*Line out,1*Mic,2*Mini PCIe
- 1*M.2 2242B-Key
- 1*2.5" SATA3 bay, 1*mSATA, Anti-vibration design
- DC 6~48V wide voltage power supply, ITPS vehicle management function



Product Overview

KMDA-3602 is a high-performance vehicle computer with the latest combination of active and passive heat dissipation design. It is equipped with Intel®Skylake-S/Kabylake-S processor, DC 6~48V wide voltage power supply, ITPS time-delay switch function. CPU+GPU dual processor, high performance, multiple network ports, multiple displays, multiple wireless communications and shock absorption design. It is suitable for mobile law enforcement vehicles and special vehicles.

Product Parameters

Processor	
CPU	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7 Q170 chipset
RAM	
RAM	2*260-Pin ,DDR4,2133/2400MHz, Max. 32GB
Intel® Gen. 9 HD Graphics, HEVC/H265 HW HD codec	
Graphics	
Graphics	Integrated DP/HDMI, Support dual 4K ultra-high-definition display, Independent Graphics 3*DP+1*HDMI four 4K display
1*MXM 3.1 GPU Module, support up to 120W power consumption GPU	
2*Intel I210AT PCIe ,10/100/1000Mbps ;	
LAN	1*Intel I219 LM, support iVpro,
4*Intel I210AT PCIe ,Full bandwidth POE,4*LAN (optional)	
USB	6* USB3.0, 2*USB2.0 ,1*USB2.0 (build-in)
Display	Integrated 1*DP+1*HDMI+1*VGA; Discrete 3*DP+1*HDMI
Audio	1*Line out+1*Mic, optional audio
Serial port /Others	2*RS232/422/485
8/12-bit 2.5KV Optically isolated input (1*10Pin Phoenix terminal)	
DIO	8/12-bit 2.5KV Optically isolated output (1*10PinPhoenix terminal)
Optional 16-bit TTL programming input and output /24-bit iso DIO	
Storage	
Storage	1*2.5" SATA3,HDD/SSD,1*mSATA full-height card,1*M.2 2242 B-key
Others	
Indicator light	1*power indicator, 1*hard disk indicator, 3*CPU temperature indicator (Red is alarm, Yellow is high temperature, Green is normal temperature)
Control switch	1*Power switch, 1*Reset switch; 1*2pin terminal switch signal, 1*AT/ATX selector switch, 1*CMOS/Clear selector switch
Watchdog timer	Watchdog timeout programmable via software 1 to 255 second

Expansion	
Expansion Port	1*Mini PCIe, with SIM slot, 1*half-length Mini PCIe, 1*M.2 B-key,with SIM slot,,support dual 4G LTE/Wifi/BT and GPS/BDS navigation, I-Port:optional 1*LPT, 16-bit DIO, or 2*Mini PCIe/M.2 Function card, i.e. CAN BUS
Power Supply	
Input voltage	DC 6~48V input,

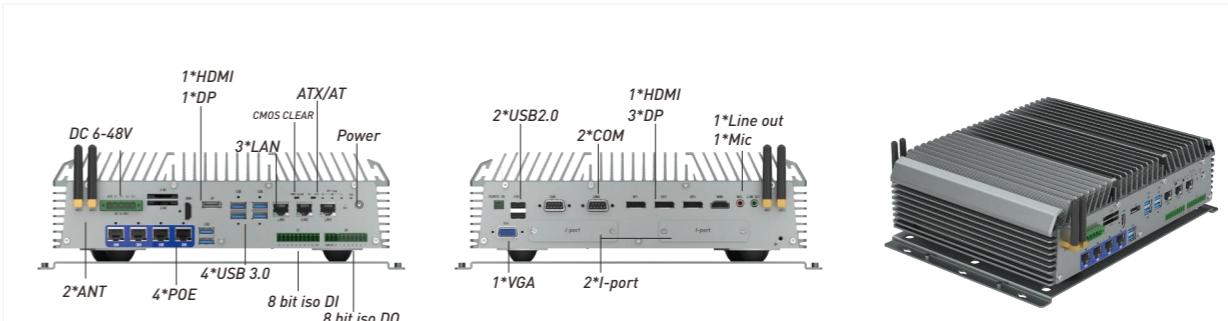
Power Supply	
Power consumption	115.92W(I5-7500T +GTX 1060M GPU)

Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Silver gray
Installation	Desktop mounting,Anti-vibration plane
Dimension(W*H*D)	284*222*81mm
Net Weight	5.60KG (with Anti-vibration plane,no GPU)

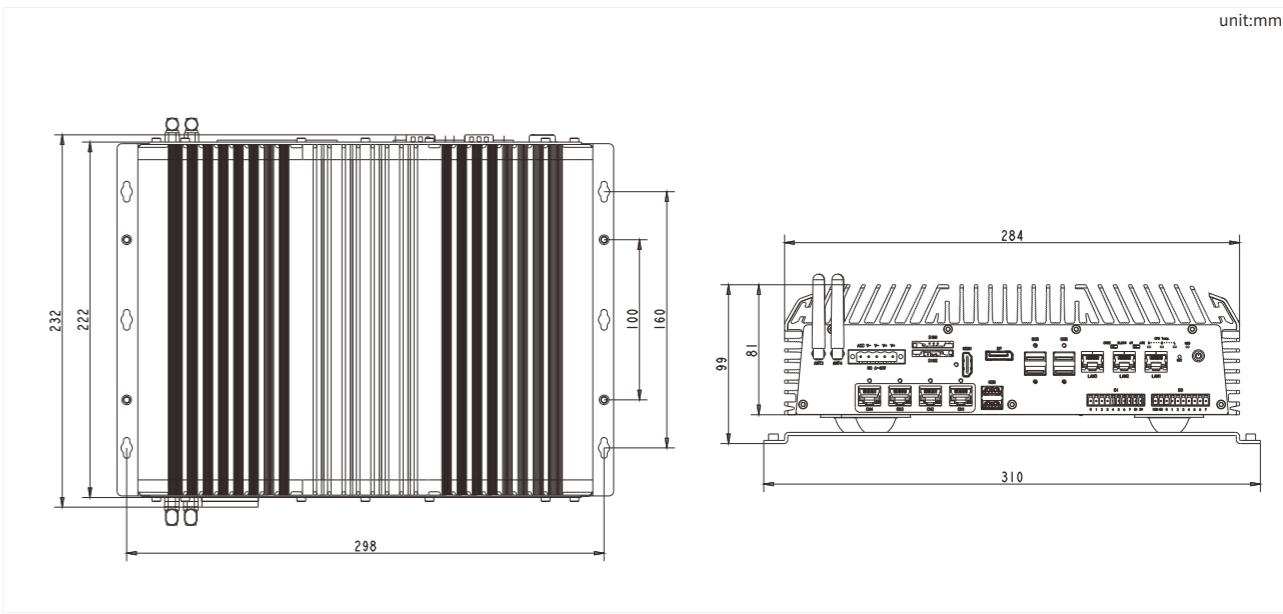
Environment	
Operating Temp	-20°C~65°C - 35W CPU,Fanless design,no GPU,-10°C~50°C - 35W CPU,with Fan, 80W GPU;
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No condensation
Vibration	5.5 grms/5~500Hz/random/during operation (SSD) 1.5 grms/5~500Hz/random/during operation (HDD)
Shock	55g peak acceleration(duration 11ms) with SSD; 25g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class B,E-Mark

OS	
OS	Windows 7, Windows 10, Linux Fedora,Ubuntu

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-3602/S001	Intel® Q170 chip set+SKL/KAL-S LGA1151 CPU	MXM3.1 GPU slot, 3*LAN, 4*POE, 6*USB3.0, 3*USB2.0, 2*COM, 16-bit iso DIO, 1*M.2, 2*Mini PCIe, 2*HDMI, 4*DP, 1*VGA, 1*Line out, 1*Mic, 2*I-port, 1*2.5" SATA3 bay, 1*mSATA, ITPS, DC 6~48V
KMDA-3602/T001		7*LAN, 6*USB3.0, 3*USB2.0, 2*COM, 16-bit DIO, 1*M.2, 2*Mini PCIe, 1*HDMI, 1*DP, 1*VGA, 1*Line out, 1*Mic, 2*I-port, 1*2.5" SATA3 bay, 1*mSATA, ITPS DC 6~48V
NVIDIA GT 1030-2G		MXM3.1 Type A, NVIDIA GT 1030, GDDR5 2GB, 64bit, 384 CUDA Cores, with radiator
NVIDIA GTX 1050-2G		MXM3.1 Type A, NVIDIA GTX 1050, GDDR5 2GB, 128bit, 768 CUDA Cores, with radiator
NVIDIA GTX 1050TI-4G		MXM3.1 Type A, NVIDIA GTX 1050TI, GDDR5 4GB, 128bit, 768 CUDA Cores, with radiator
NVIDIA GTX 1060M-6G		MXM3.1 Type B, NVIDIA GTX 1060M, GDDR5 6GB, 192bit, 1280 CUDA Cores, with radiator
NVIDIA GTX 1070M-8G		MXM3.1 Type B, NVIDIA GTX 1070M, GDDR5 8GB, 256bit, 2048 CUDA Cores, with radiator
VIDIA GTX 1650-4G		MXM3.1 Type A, NVIDIA GTX 1650, GDDR5 4GB, 128bit, 896 CUDA Cores, with radiator
NVIDIA GTX 1660S-6G		MXM3.1 Type B, NVIDIA GTX 1660S, GDDR6 6GB, 192bit, 1408 CUDA Cores, with radiator
MLU220-MXM		MXM3.1 Type A, Cambricon MLU-220, LPDDR4 8GB, 64bit, 16TOPS(INT8), with radiator
PA-120DC19		AC/DC power adapter, DC19V/6.32A, 120W
PA-220DC24		AC/DC power adapter, DC24V@9.17A, 220W

KMDA-3820

Intel® Skylake-U/Kabylake-U CPU, 2/3*LAN, 7*USB, 4*COM, Dual 4K display, 8/24-bit DIO, iVpro, 2*PCIe/PCI slot, DC IN 12~24V

Key Specification

- Aluminum Chassis, fanless heat dissipation design
- Intel Skylake-U/Kabylake-U CPU
- 1*DDR4 2133MHz SODIMM RAM, Max. 16GB
- 1*HDMI and 1*DP dual 4K display, 1*VGA
- 2/3*Gig LAN, 4*USB3.0, 3*USB2.0 (one is built-in)
- 4*COM, 8-bit DIO, 1*Line out, 1*Mic
- 2*PCIeX4/PCI slot, 1*Mini PCIe(PCle+USB)
- 1*mSATA, 1*2.5" SATA bay, Anti-vibration design
- Support Intel vPro technology and optional TPM 2.0 security encryption
- DC 12~24V wide voltage power supply
- Half-open L-shaped folding cover, convenient for disassembly and assembly of functional modules and hard drives



Product Overview

KMDA-3820 is a new industrial design box PC, with aluminum chassis and fanless design, equipped with Intel® Skylake-U/Kabylake-U processor, optional support TPM2.0 and support iVpro technology, DC 12~24V. L-shaped folding Cover design makes function modules installation easily, very suitable for AI, ITS, Machine Vision and other fields.

Product Parameters

Processor	
CPU	Intel Skylake-U /Kabylake-U / Celeron/Core i3/i5/i7
RAM	
RAM	1*260-Pin ,DDR4,2133MHz, Max. 16GB
Graphics	
Graphics	Intel Gen. 9th HD Graphics, HEVC/H265 HW HD codec, HDMI:4096*2304@24Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz
LAN	
LAN	2*Intel I211AT PCIe ,10/100/1000Mbps ; 1*Intel I219 LM, support iVpro,
USB	
USB	4*USB3.0, 2*USB2.0, 1*USB2.0 (build-in)
Display	
Display	1*DP+1*HDMI+1*VGA
Audio	
Audio	1*Line out+1*Mic, Realtek ALC662VD
COM/Others	
COM/Others	2*RS232/422/485, 2*RS232, 1*PS/2 (Mouse and keyboard)
DIO	
DIO	8-bit DIO, TTL Programmable input-output (2*5Pin) Optional 16-bit DIO, TTL, Programmable input and output

Storage	
Storage	1*2.5" SATA3,HDD/SSD,1*mSATA full-height card,Support AHCI mode

Others	
LED	1*power LED, 1*hard disk LED, 3*CPU temperature LED (Red is alarm, Yellow is high temperature, Green is normal temperature)

Switch	
Switch	1*Power switch (front panel), 1*2 pin terminal switch signal (front panel), 1*AT/ATX selector switch (front panel)

WDT	
WDT	Watchdog timeout programmable via software 1 to 255 second

TCPM/TPM	
TCPM/TPM	support TPM2.0 (optional)

Expansion	
Expansion	1*Mini PCIe, with SIM slot, support 4G LTE/Wifi/BT, 1* PCIe X4 (X4)+1*PCIe X4 (X1); or 2*32bit PCI

Power Supply	
Power& TDP	DC 12~24V input, 58.56W (I5-7200U 16GB DDR4)

Mechanical	
Structure	Aluminum Chassis, SGCC frame

Color	
Installation	Desktop mounting

Dimension(W*H*D)	
Dimension(W*H*D)	200*200*128.3mm

Weight	
Weight	3.65KG

Environment	
Operating Temp	-20°C~70°C - Fanless design, with air flow, wide-temperature SSD; -10°C~50°C - Fanless design, with air flow, normal temperature HDD

Storage Temp	
Storage Temp	-40°C~85°C

Storage Humidity	
Storage Humidity	10~90%@40°C, No condensation

Vibration	
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)

Shock	
Shock	50g peak acceleration(duration 11ms) with SSD; 20g peak acceleration(duration 11ms) with HDD

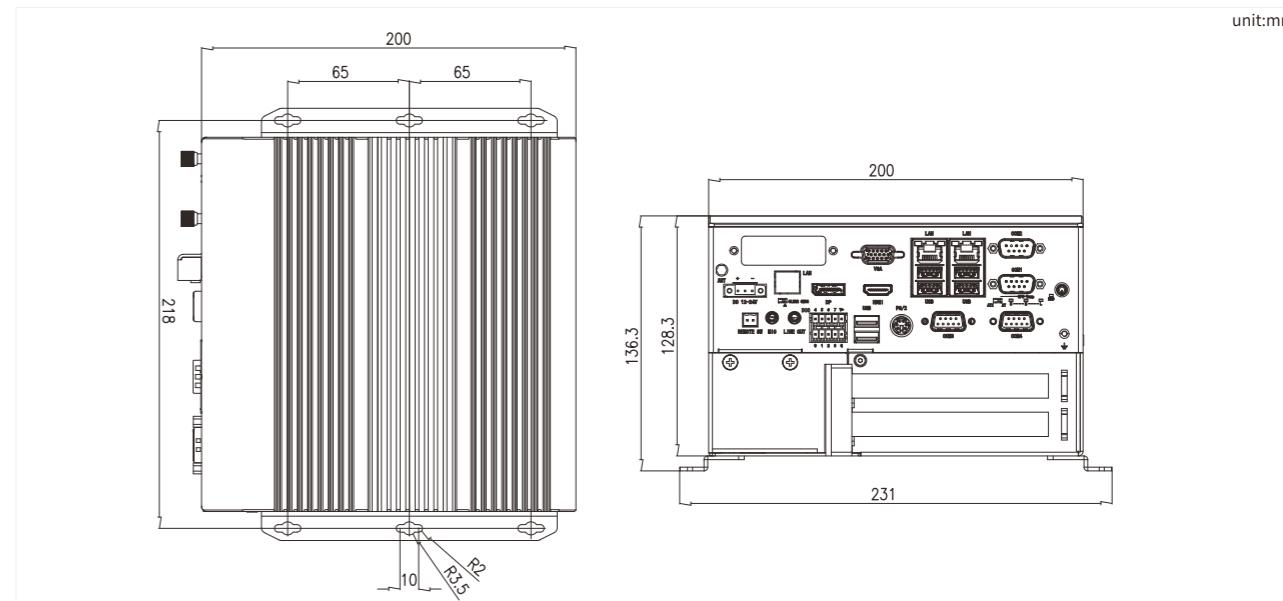
Certificate/EMC	
Certificate/EMC	CE/FCC Class A

OS	
OS	Windows 7, Windows 10, Linux Fedora,Ubuntu

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-3820/S001	Intel I3-6100U/I3-7100U	1*DDR4 SODIMM, 3*G-LAN, 4*USB3.0, 3*USB2.0, 4*COM, 8bit.DIO, 1*Mini PCIe, 1*HDMI, 1*DP, 1*VGA, Audio out and Mic, 1*2.5"SATA, 1*mSATA, I-Port, DC 12-24V	Standard:ECX-238 1*PCIeX4(X4)+1*PCIeX4(X1)
KMDA-3820/S002	Intel I5-6200U/I5-7200U		Optional:ECI-239 2*32bit PCI
KMDA-3820/S003	Intel I7-6500U/I7-7500U		
KMDA-3820/S004	Intel Celeron 3855U/3865U		
PA-60DC12		AC/DC adapter, DC 12V/5A 60W	

KMDA-3610

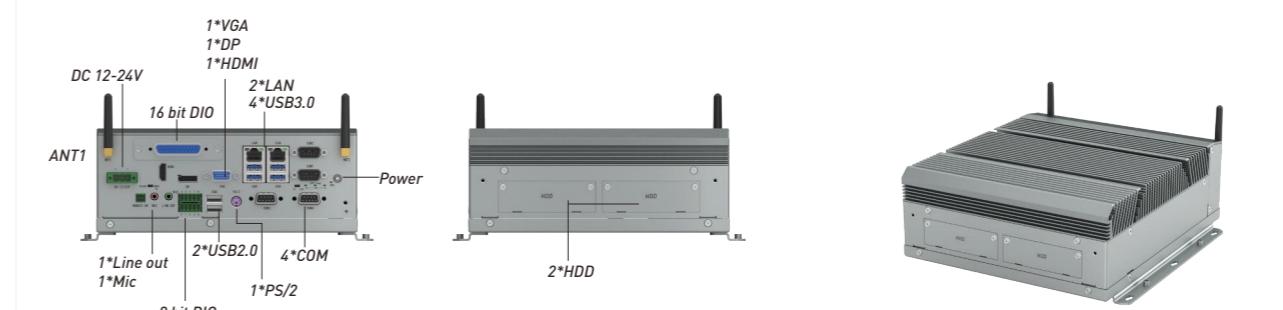
Intel® Skylake-S/Kabylake-S CPU, 2*LAN, 4*USB3.0, HDMI, DP, VGA, 3 Displays, 2*SATA3, DC 12~24V wide voltage power supply

Key Specification

- Aluminum Chassis, fanless heat dissipation design
- Intel Skylake-S/Kabylake-S CPU
- 2*DDR4 2400/2133MHz SODIMM RAM, Max. 32GB
- 1*DP, 1*HDMI & 1*VGA three display
- 2*LAN, 4*USB3.0, 3*USB2.0, 4*COM, (8+16)- bit DIO
- 1*Mini PCIe(PCIe+USB), 1*M.2 2242 B-Key
- 1*mSATA, 2*2.5" SATA3
- Optional support TPM2.0 security encryption
- DC 12~24V wide voltage power supply



I/O View



Product Overview

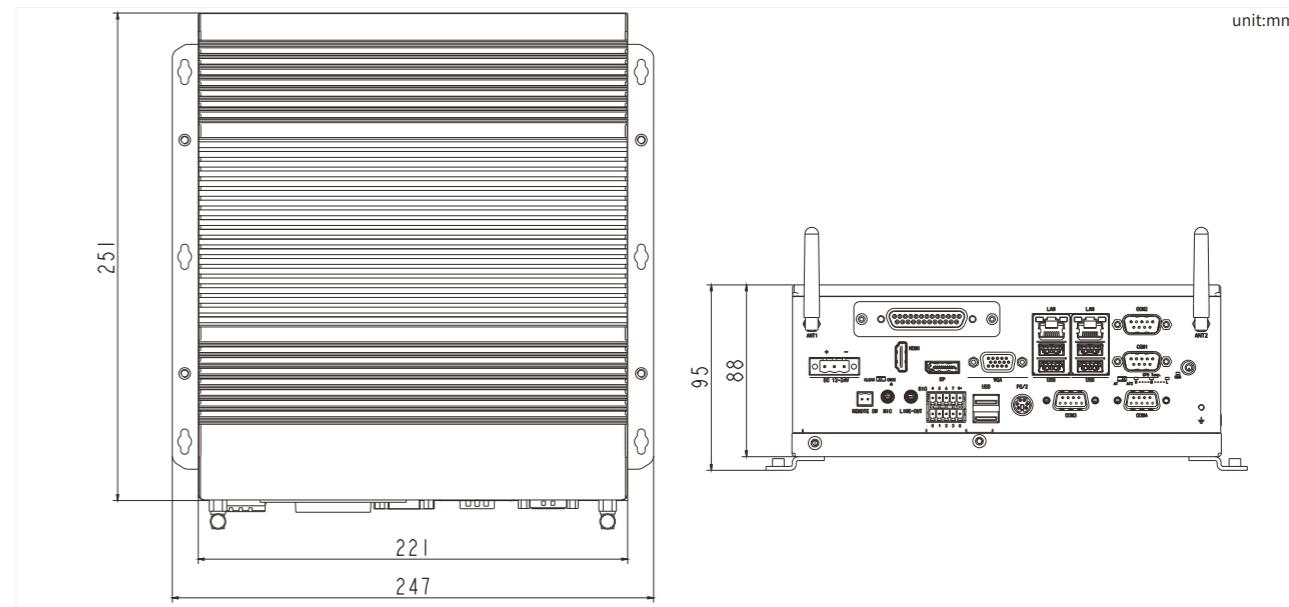
KMDA-3610 is a fanless high-performance box PC, equipped with Intel® Skylake-S/Kabylake-S series processors, and supports 4G and Wifi/BT wireless functions. DC 12~24V wide voltage power supply, high performance, rich IO function interface. It is suitable for applications in automation, machine vision and intelligent transportation industries.

Product Parameters

Processor	
CPU	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 chipset
RAM	2*260-Pin ,DDR4,2133/2400MHz, Max. 32GB
Graphics	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, DP:4096*2304@60Hz, VGA:1920*1200@60Hz, Support 2 independent display, 1 mirror display
LAN	1*Intel I211AT PCIe ,10/100/1000Mbps; 1*Intel I219 LM,
USB	4*USB3.0, 2*USB2.0, 1*USB2.0 (build-in)
Display	1*DP+1*HDMI+1*VGA
Audio	1*Line out+1*Mic,Realtek ALC662VD
Serial port /Others	2*RS232/422/485, 2*RS232,1*PS/2 (Mouse and keyboard)
DIO	8-bit DIO, TTL Programmable input and output (2*5Pin) 16-bit DIO, TTL Programmable input and output (DB25)
Storage	
Storage	2*2.5" SATA3,HDD,1*mSATA full-height card,1*M.2 2242 B-key
Others	
LED light	1*power LED, 1*hard disk LED, 3*CPU temperature LED (Red is alarm, Yellow is high temperature, Green is normal temperature)
Control switch	1*Power switch, 1*Reset switch, 1*2pin terminal switch signal, 1*AT/ATX selector switch, 1*CMOS/Clear selector switch
Watchdog timer	Watchdog timeout programmable via software 1 to 255 second
TCPM/TPM	support TPM2.0 (optional)

Expansion	
Expansion Port	1*Mini PCIe, with SIM slot, support m4G LTE/Wifi/BT,
Power Supply	
Input voltage	DC 12~24V input,
Power consumption	68.4W(I7-6700T CPU 16GB DDR4)
Mechanical	
Structure	Aluminum Chassis, SGCC
Color	Silver gray
Installation	Desktop mounting
Dimension(W*H*D)	221*251*88mm
Weight	4.84KG
Environment	
Operating Temp	-20°C~65°C - with air flow, wide-temperature SSD, -10°C~55°C - with air flow, normal temperature HDD
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No condensation
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)
Shock	50g peak acceleration(duration 11ms) with SSD; 20g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class A
OS	
OS	Windows 7, Windows 10, Linux Fedora,Ubuntu

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-3610/S001	Intel® Skylake-S/Kabylake-S LGA1151 CPU	H110 Chipset, 2*DDR4, 2*LAN, 4*USB3.0, 3*USB2.0, 4*COM, 1*Mini PCIe, 1*DP, 1*VGA, 1*Line out, 1*Mic, 8+16-bit DIO, 1*PS/2, 2*2.5" SATA bay, 1*M.2, 1*mSATA, DC 12~24V
PA-120DC19		AC/DC adapter, DC 19V/6.32A 120W
AC-140		8-channel optical isolation input\8-channel high-power relay board

KMDA-3920

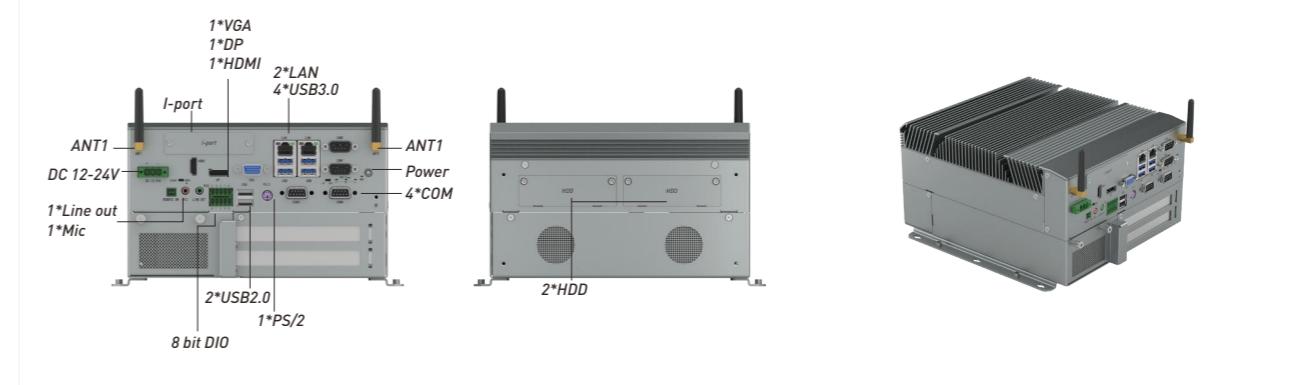
Intel® Skylake-S/Kabylake-S CPU, 2*LAN, 4*USB3.0, PCIe X16+PCIe X4/2*PCI expansion, DC 12~24V wide voltage power supply

Key Specification

- Aluminum Chassis, SGCC frame
- Intel Skylake-S/Kabylake-S CPU
- 2*DDR4 2400/2133MHz SODIMM RAM, 32GB max.
- 1*DP, 1*HDMI & 1*VGA, Optional three independent displays(Intel Q170)
- 2*LAN, 4*USB3.0, 3*USB2.0, 4*COM, 8-bit DIO
- Support PCIe X16+PCIeX4 or 2*PCI expansion
- 1*Mini PCIe(PCle+USB),1*M.2 2242 B-Key
- 1*mSATA, 2*2.5" SATA3, support RAID0,1(Intel Q170)
- Optional TPM2.0 security encryption, support Intel vPro technology(Intel Q170)
- DC 12~24V wide voltage power supply



I/O View



Product Overview

KMDA-3920 is a high-performance box computer with expansion, equipped with Intel® Skylake-S/Kabylake-S series processors, H110/Q170 chipset, 2*DDR4 2133/2400MHz dual-channel memory supports up to 32GB. The easy-to-detach L-shaped folding cover facilitates the installation of functional modules. It is very suitable for applications in video security, machine vision and intelligent AI industries.

Product Parameters

Processor	
CPU	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7 H110 chipset, optional Q170 chipset
RAM	
RAM	2*260-Pin ,DDR4,2133/2400MHz, Max. 32GB
Graphics	
Graphics	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, Support 3 independent displays(Intel Q170) , HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz,
LAN	
LAN	1*Intel I211AT PCIe ,10/100/1000Mbps ; 1*Intel I219 LM, support iVpro (Intel Q170),
USB	
USB	4*USB3.0, 2*USB2.0, 1*USB2.0 (build-in)
Display	
Display	1*DP+1*HDMI+1*VGA
Audio	
Audio	1*Line out+1*Mic, Realtek ALC662VD
COM/Others	
COM/Others	2*RS232/422/485, 2*RS232, 1*PS/2 (Mouse and keyboard)
DIO	
DIO	8-bit DIO, TTL Programmable input and output (1*10pin)
Storage	
Storage	2*2.5" SATA3,HDD,support RAID0,1(Intel Q170), 1*mSATA full-height card,1*M.2 2242 B-key
Others	
LED	1*power LED, 1*HDD LED, 3*CPU temperature LED (Red is alarm, Yellow is high temperature, Green is normal temperature)
Switch	1*Power SW, 1*Reset SW; 1*2pin terminal SW, 1*AT/ATX SW, 1*Clear CMOS
WDT	Watchdog timeout programmable via software 1 to 255 second
TCPM/TPM	support TPM2.0 (optional)

Expansion	
Expansion	1*Mini PCIe,with SIM slot, support 4G LTE/Wifi/BT, 1*PCIe X16+1*PCIe X4,or 2*32bit PCI

Power Supply	
Power&	DC 12~24V input,
TDP	68.78W (I7-6700T , 4GB DDR4, 1TB HDD,Install card)

Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Silver gray
Installation	Desktop mounting, wall mounting
Dimension(W*H*D)	220*250*131mm
Weight	5.27KG

Environment	
Operating Temp	-20°C~65°C SSD, with air flow, -10°C~55°C HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No condensation

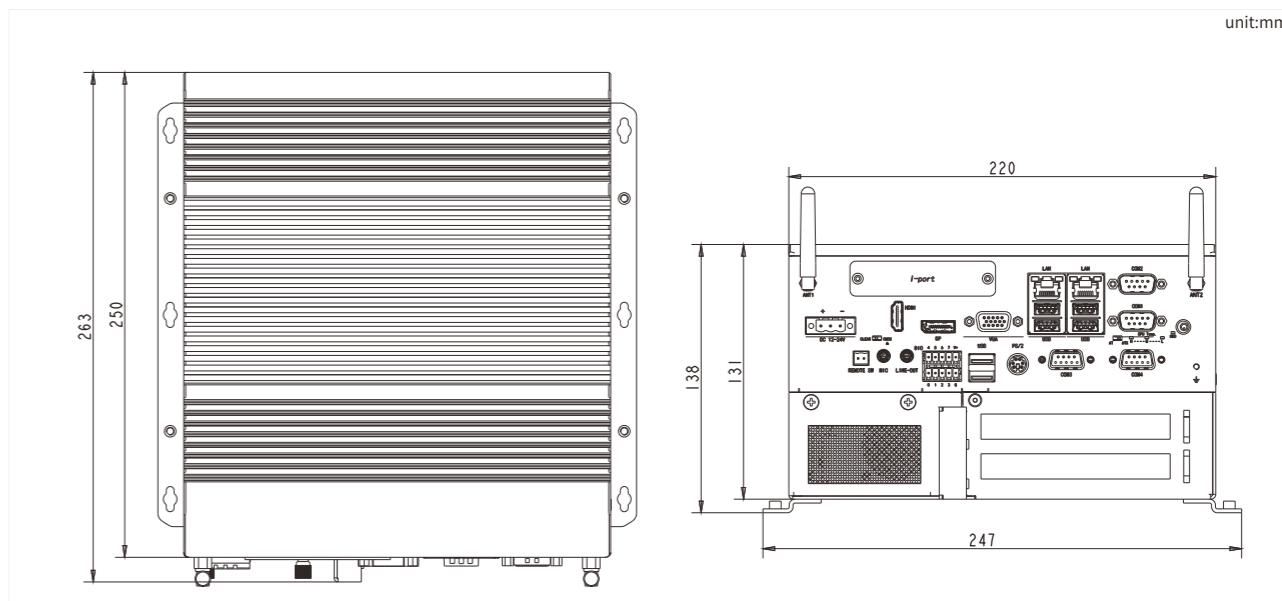
Vibration	
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)

Shock	
Shock	50g peak acceleration(duration 11ms) with SSD; 20g peak acceleration(duration 11ms) with HDD

Certificate/EMC	
Certificate/EMC	CE/FCC Class A

OS	
OS	Windows 7, Windows 10, Linux Fedora,Ubuntu

Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-3920/S001	Intel® Skylake-S/Kabylake-S LGA1151 CPU,H110 Chipset	2*DDR4, 2*LAN, 4*USB3.0, 3*USB2.0, 4*COM, 1*Mini PCIe, 1*HDMI, 1*DP, 1*VGA, 1*Line out, 1*Mic, 8-bit DIO, 1*PS/2, 2*2.5" SATA bay, 1*M.2, 1*mSATA, DC 12~24V	Standard: ECX-241 1*PCIeX16(X16)+1*PCIeX4(X4)
KMDA-3920/S002	Intel® Skylake-S/Kabylake-S LGA1151 CPU, Q170 Chipset	PA-120DC19 PA-220DC24 AC-140	Optional: ECI-245 2*32bit PCI AC/DC adapter, DC19V/6.32A 120W AC/DC adapter, DC24V/9.17A 220W 8-channel optical isolation input\8-channel high-power relay board

KMDA-3920ETC

Intel® Skylake-S/Kabylake-S CPU, 2*LAN, 4*USB3.0, HDMI, DP, VGA, 10*COM, 16+16-bit DIO, 1*PCIeX16/1*PCI expansion,DC 12~24V

Key Specification

- Aluminum Chassis, fanless heat dissipation design
- Intel Skylake-S/Kabylake-S CPU
- 2*DDR4 2400/2133MHz SODIMM RAM, 32GB max.
- 1*DP, 1*HDMI & 1*VGA, Optional three independent displays(Intel Q170)
- 2*LAN, 4*USB3.0, 10*COM, 16+16-bit DIO
- Support 1*PCIe X16 or 1*PCI expansion slot
- 1*Mini PCIe(PCle+USB),1*M.2 2242 B-Key
- 1*mSATA, 2*2.5" SATA3, support RAID0,1(Intel Q170)
- Optional TPM2.0 security encryption, support Intel vPro technology (Intel Q170)
- DC 12~24V wide voltage power supply



I/O View



Product Overview

KMDA-3920-ETC is a fanless box computer with expansion, equipped with Intel® Skylake-S/Kabylake-S processor, H110/Q170 chipset, 2*DDR4 2133/2400MHz, dual channel memory, support Max. 32GB. It is very suitable for video security, machine vision and highway Electronic Toll Collection(ETC) industry applications.

Product Parameters

Processor	
CPU	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 chipset,optional Q170 chipset
RAM	
RAM	2*260-Pin ,DDR4,2133/2400MHz, Max. 32GB
Graphics	
Graphics	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, HDMI:3840*2160@30Hz, Support 3 independent displays(Intel Q170), DP:4096*2304@60Hz,VGA:1920*1200@60Hz,
LAN	
LAN	1*Intel I211AT/I210AT , 10-1000M;
USB	
USB	1*Intel I219 LM, support iVpro (Intel Q170) , 4* USB3.0, 1*USB2.0 (build-in)
Display	
Display	1*DP+1*HDMI+1*VGA
Audio	
Audio	1*Line out+1*Mic, Realtek ALC662VD
COM/Others	
COM/Others	2*RS232/422/485, 8*RS232, 1*PS/2 (Mouse and keyboard)
DIO	
DIO	16-bit DIO, TTL Programmable input and output (2*10Pin)
Storage	
Storage	16-bit DIO, TTL Programmable input and output (DB25)
Others	
LED	1*power LED, 1*hard disk LED, 3*CPU temperature LED (Red is alarm, Yellow is high temperature, Green is normal temperature)
Switch	1*Power switch, 1*Reset switch; 1*2pin terminal switch signal, 1*AT/ATX selector switch, 1*CMOS/Clear selector switch
WDT	Watchdog timeout programmable via software 1 to 255 second
TCPM/TPM	support TPM2.0 (optional)

Expansion	
Expansion	1*PCIe3.0X16(X16)+1*PCIe3.0X4(X4) or 2*32bit PCI 1*Mini PCIe, withSIM slot, support 4G LTE/Wifi/BT,

Power Supply	
Power& TDP	DC 12~24V input, 68.78W (I7-6700T , 4GB DDR4, 1TB HDD,Install card)

Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Silver gray
Installation	Desktop mounting, wall mounting
Dimension(W*H*D)	220*250**131.5mm
Weight	5.27KG

Environment	
Operating Temp	-20°C~65°C SSD, with air flow, -10°C~55°C HDD, with air flow;

Storage	
Storage	2*2.5" SATA3,HDD,support RAID0,1(Intel Q170), 1*mSATA full-height card,1*M.2 2242 B-key

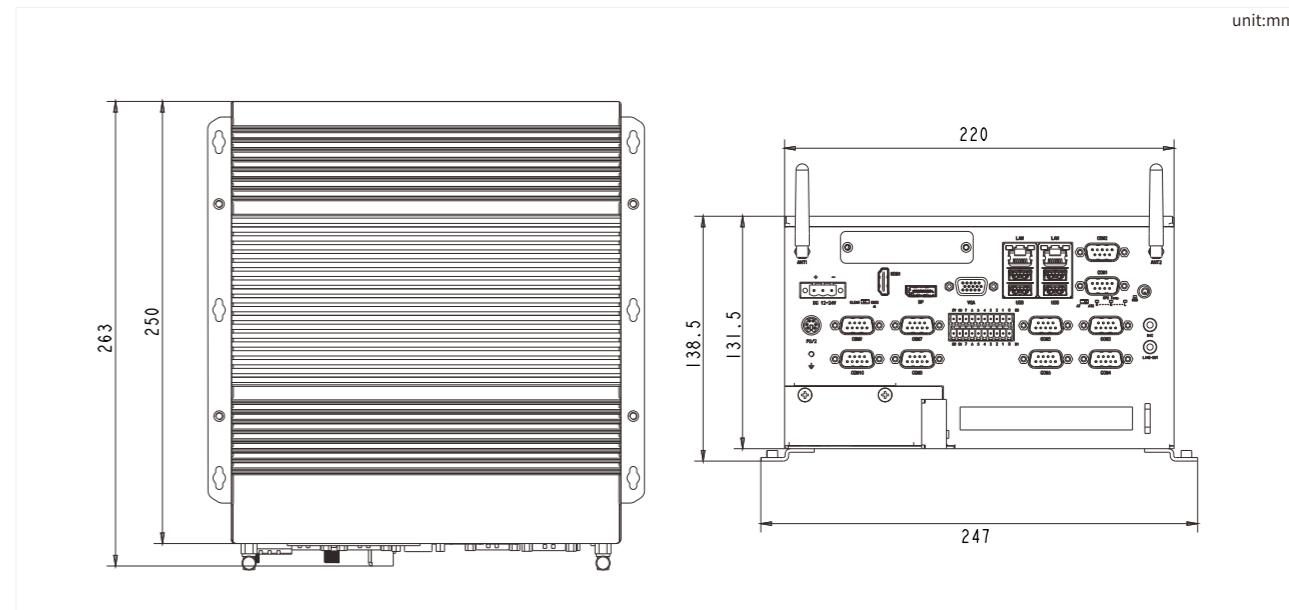
Others	
LED	1*power LED, 1*hard disk LED, 3*CPU temperature LED (Red is alarm, Yellow is high temperature, Green is normal temperature)

Switch	
Switch	1*Power switch, 1*Reset switch; 1*2pin terminal switch signal, 1*AT/ATX selector switch, 1*CMOS/Clear selector switch

WDT	
WDT	Watchdog timeout programmable via software 1 to 255 second

TCPM/TPM	
TCPM/TPM	support TPM2.0 (optional)

Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-3920-ETC/S001	Intel® Skylake-S/Kabylake-S LGA1151 CPU, H110 Chipset	2*DDR4 SODIMM, 2*G-LAN, 10*COM, 4* USB3.0, 1*USB2.0, 16bit DIO, 1*PS2, DP/HDMI/VGA, 1*Mini PCIe, Audio out/Mic, 2*2.5" SATA, 1*M.2, 1*mSATA, DC 12-24V	Standard: ECX-241 1*PCIeX16(X16)+1*PCIeX4(X4)
PA-120DC19		AC/DC power adapter,DC19V/6.32A,120W	Optional: ECI-245 2*32bit PCI
PA-220DC24		AC/DC power adapter,DC24V/9.17A,220W	
PA-300DC24		AC/DC power adapter,DC24V/12.5A,300W	
AC-140		8-channel isolated input and 8-channel power relay output terminal board,DC 12V,source signal: 16-bit TTL GPIO	

KMDA-3921

Intel® Skylake-S/Kabylake-S CPU, 2*LAN, 4*USB3.0, HDMI, DP, VGA, 3 Displays, PCIe X16+PCIe X1+2*PCI expansion, DC 12~24V power in

Key Specification

- Aluminum Chassis, SGCC box
- Intel Skylake-S/Kabylake-S CPU
- 2*DDR4 2400/2133MHz SODIMM, 32GB max.
- 1*DP, 1*HDMI & 1*VGA, Optional three independent displays(Intel Q170)
- 2*LAN, 4*USB3.0, 3*USB2.0, 4*COM, 8-bit DIO
- 1*PCIe X16+1*PCIeX1+2*PCI expansion
- 1*Mini PCIe(PCIe+USB),1*M.2 2242 B-Key
- 1*mSATA, 2*2.5" SATA3, support RAID0,1(Intel Q170)
- Optional TPM2.0 security encryption, support Intel vPro technology (Intel Q170)
- DC 12~24V wide voltage power supply



Product Overview

KMDA-3921 is a embedded high-performance box computer with expansion, equipped with Intel® Skylake-S/Kabylake-S processor, H110/Q170 chipset, 2*DDR4 2133/2400MHz, dual channel memory, support Max. 32GB. The easy-to-detach L-shaped folding cover is convenient for the installation of functional modules. It is very suitable for applications in video security, machine vision and intelligent AI industries.

Product Parameters

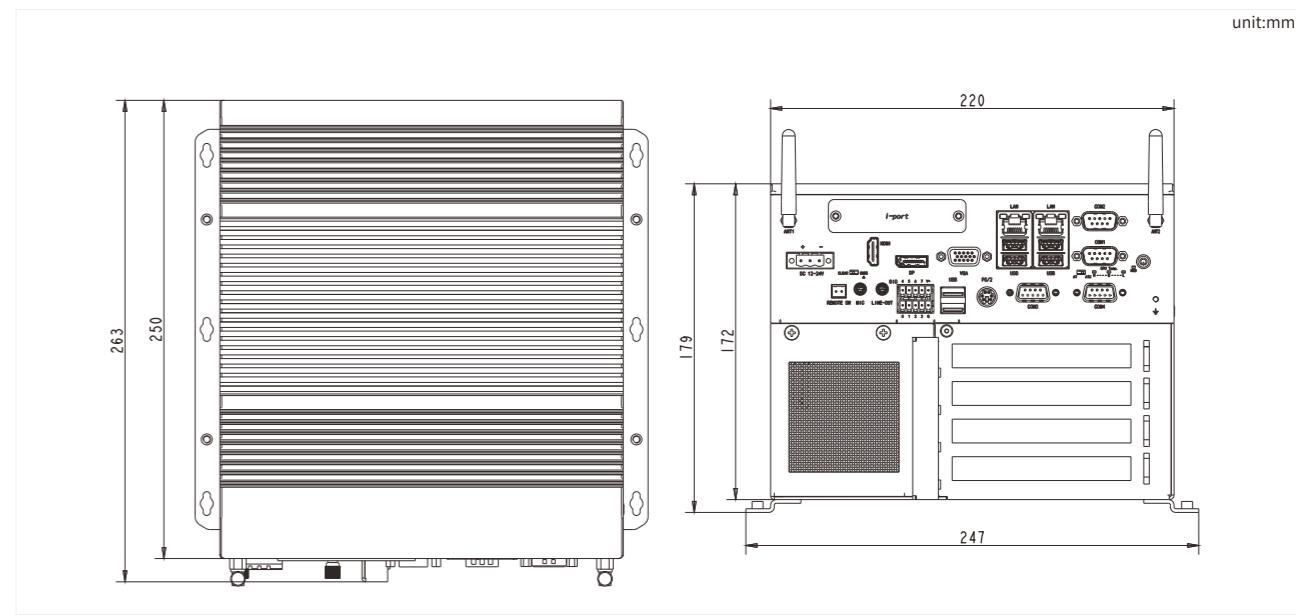
Processor	
CPU	Intel Skylake-S/Kabylake-S Celeron/Pentium/Core i3/i5/i7, H110 chipset,optional Q170 chipset
RAM	2*260-Pin ,DDR4,2133/2400MHz,Max. 32GB
Graphics	Intel Gen. 9 HD Graphics,HEVC/H265 HW HD codec, support 3 independent displays (Intel Q170), HDMI:3840*2160@30Hz, DP:4096*2304@60Hz,VGA:1920*1200@60Hz,
LAN	1*Intel I211AT PCIe ,10/100/1000Mbps ; 1*Intel I219 LM, support iVpro(Intel Q170) ,
USB	4*USB3.0, 2*USB 2.0, 1*USB2.0 (build-in)
Display	1*DP+1*HDMI+1*VGA
Audio	1*Line out+1*Mic, Realtek ALC662VD
COM/ Others	2*RS232/422/485, 2*RS232, 1*PS/2 (Mouse and keyboard)
DIO	8-bit DIO (10PinPhoenix terminal) 16-bit DIO (build-in), TTL Programmable input and output
Storage	
Storage	2*2.5" SATA3,HDD,support RAID0,1(Intel Q170), 1*mSATA full-height card,1*M.2 2242 B-key
Others	
LED	1*Power LED, 1*HDD LED, 3*CPU temperature LED
Control switch	1*Power SW, 1*Reset SW; 1*2pin terminal SW, 1*AT/ATX SW, 1*CMOS/Clear SW
WDT	Watchdog timeout programmable via software 1 to 255 second
TCPM/TPM	support TPM2.0 (optional)
OS	
OS	Windows 7, Windows 10, Linux Fedora,Ubuntu

Expansion	
Expansion	1*PCIe3.0X16(X16)+1*PCIe3.0 X4(X1)+2*32bit PCI, GPU/AI Card<150W<225mm or 2*PCIe3.0 X16(X8)+1*PCIe3.0 X8(X4) 1*Mini PCIe(+SIM),4G LTE/Wifi/BT, I-port:1*LPT/USB2.0/16-bit DIO/1*Mini PCIe
Power Supply	
Power &	DC 12~24V input,
TDP	68.78W (I7-6700T ,4GB DDR4, 1TB HDD)
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Silver gray
Installation	Desktop mounting, wall mounting
Dimension(W*H*D)	220*250**172mm
Weight	5.58KG
Environment	
Operating Temp	-20°C~65°C SSD, with air flow, -10°C~55°C HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No condensation
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)
Shock	50g peak acceleration(duration 11ms) with SSD; 20g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-3921/S001	Intel® Skylake-S/Kabylake-S LGA1151 CPU,H110 Chipset	2*DDR4, 2*LAN, 4*USB3.0,3*USB2.0, 4*COM, 1*Mini PCIe, 1*HDMI,1*DP,1*VGA, 1*Line out,1*Mic, 8-bit DIO,1*PS/2, 1*I-port, 2*2.5" SATA3 bay, 1*M.2, 1*mSATA, DC 12~24V	Standard: ECX-242 1*PCIeX16(X16)+1*PCIeX4(X1)+2*32 bit PCI
KMDA-3921/S002	Intel® Skylake-S/Kabylake-S LGA1151 CPU, Q170 Chipset		Standard: ECX-242 1*PCIeX16(X16)+1*PCIeX4(X1)+2*32 bit PCI Optional: ECI-249 2*PCIeX16(X8)+1*PCIeX8(X4)
PA-120DC19		AC/DC adapter, DC 19V/6.32A 120W	
PA-220DC24		AC/DC adapter, DC 24V/9.17A 220W	
PA-300DC24		AC/DC adapter, DC 24V/12.5A 300W	
AC-140		8-channel optical isolation input\8-channel high-power relay board	

KMDA-5610/S001

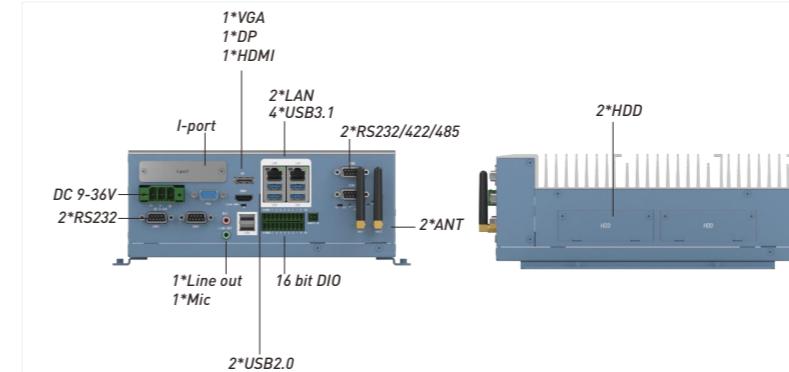
Intel® 9th/8th-Gen Coffee Lake LGA1151 CPU, 2*LAN, 4*USB3.1, 1*VGA, 1*DP, 1*HDMI, 2*4K Displays, 1*M SATA, 2*SATA3.0, DC 9-36V

Key Specification

- Intel® 9th/8th-Gen Coffee Lake LGA1151 CPU
- Intel® H310 chipset
- 2*DDR4 2400/2666MHz SODIMM RAM, 64GB max.
- 1*DP, 1*HDMI, 1*VGA, 2+1 display
- 2*LAN, 4*USB3.1, 2*USB2.0, 4*COM, 16-bit Iso.DIO
- 1*M.2 E-key 2230, Support 10/100/1000Mbps WiFi module
- 2*SATA3.0, 1*mSATA with SIM card slot
- Wide voltage power supply 9-36V, with short circuit, overvoltage and overcurrent protection



I/O View



Product Overview

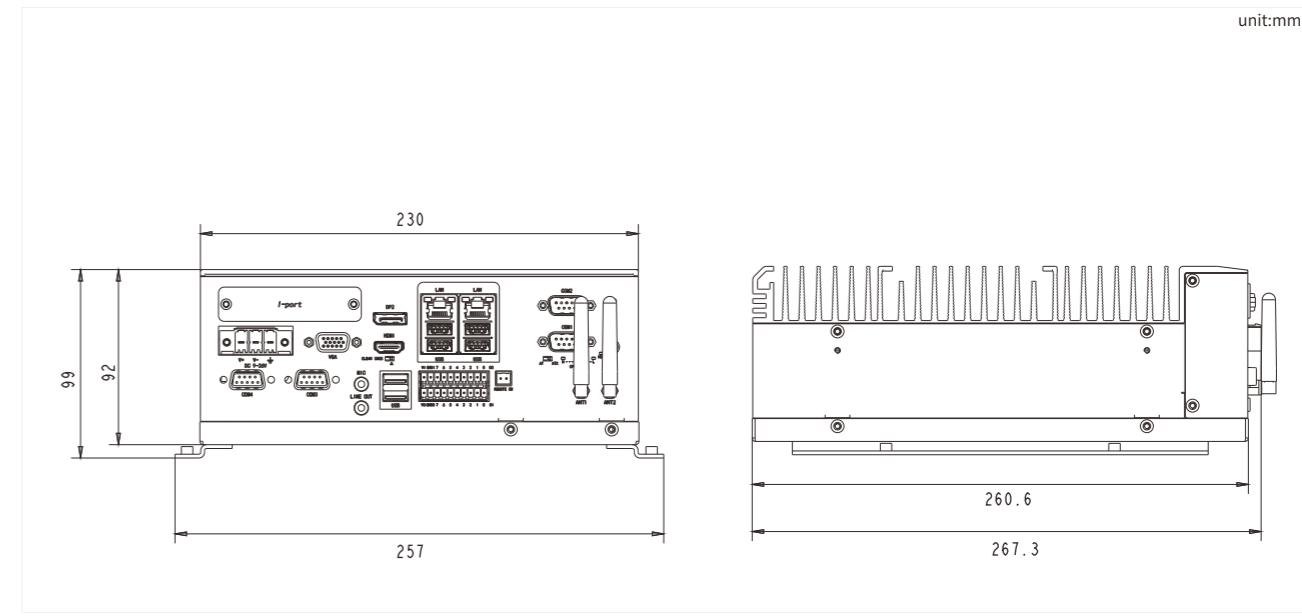
KMDA-5610 is a fanless high-performance box PC, equipped with Intel® 8th/9th generation Coffee lake series processors, H310 chipset, 2*DDR4 2400/2666MHz, and Max. support upto 64GB. Industrial grade product design. It is very suitable for industrial automation, AI edge computing, small smart workstations, multimedia service systems, high-precision machine vision and other applications.

Product Parameters

Processor	
CPU	Intel® Coffee lake 9th/8th-Gen Corei7/i5/i3/Pentium/Celeron LGA1151 processor, H310 chipset
RAM	2*260-Pin ,DDR4,2400/2666MHz, Max. 64GB
Graphics	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 or PCIe X16, DP:4096*2304@60Hz, VGA:1900*1200@60Hz, HDMI:4096*2160@24Hz (Support 2 independent display, 1 mirror display)
LAN	1*Intel I210AT PCIe ,10/100/1000Mbps ; 1*Intel I219 LM
USB	4* USB3.1, 2*USB2.0, 1*USB2.0 (build-in)
Display	1*DP+1*HDMI+1*VGA
Audio	1*Line out+1*Mic, Optional Realtek ALC662VD
COM/ Others	2*RS232/422/485, 2*RS232 16-bit iso DIO DIO 8-bit 2.5KV Iso. DI(High:5-24V,Low:0-1.5V) and 8-bit 2.5KV Iso. DO (200mA)
Storage	2*2.5" SATA3,HDD,1*full length mSATA, with SIM slot,support 4G
Others	1*power LED, 1*hard disk LED, 3*CPU temperature LED 1*Power SW,1*Remote switch,1*AT/ATX SW, 1*Clear CMOS SW watchdog timeout programmable via software 1 to 255 second TPCM/TPM support TPM2.0 (optional)

Expansion	
Expansion	1*M.2 E-Key 2230, Support 10/100/1000Mbps WiFi module I-port:optional USB2.0/ 16-bitDIO/serial ports/others
Power Supply	
Power & TDP	DC IN 9-36V,3-pin Term. 7.62mm,With short circuit, OVP & OCP, 96W(i7-8700,32G DDR4,128G SSD)
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Pigeon blue + White aluminum grey
Installation	Desktop mounting
Dimension(W*H*D)	230*267.3*92mm
Weight	5.1KG
Environment	
Operating Temp	-20°C~60°C SSD, with air flow, -10°C~55°C HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No condensation
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)
Shock	50g peak acceleration(duration 11ms) with SSD; 20g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class A
OS	
OS	Windows 10 Enterprise & IOT Enterprise,Ubuntu,SuSe,Redhat Enterprise 1,2 (Kernel 4.14), Wind River VxWorks 7

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-5610/S001	Intel® 9th/8th Coffeekale LGA1151 CPU, H310 PCH	2*DDR4, 2*LAN, 4*USB3.1, 2*USB2.0, 4*COM, M.2 E-Key, 1*VGA, 1*DP, 1*HDMI, 1*Line out, 1*Mic, 16-bit iso DIO, 2*2.5" SATA, 1*Mini PCIe(mSATA), DC 9-36V
PA-120DC19		AC/DC power adapter,DC19V/6.32A,120W
AC-140		8bit iso input, 8bit power relay output terminal board, DC 12V, the source signal is a 16bit TTL signal GPIO

KMDA-5610/S002

Intel® 9th/8th-Gen Coffee Lake LGA1151 CPU, 3*LAN, 4*COM, 6*USB3.1, 1*VGA, 2*DP, 3*M.2, 1*mSATA, 2*SATA3.0, DC 9-36V

Key Specification

- Intel® 8th /9th Gen Coffee lake LGA1151 CPU
- Intel® Q370 high-performance chipset
- 4*DDR4 2400/2666MHz SODIMM, up to 128GB
- Supports 2*DP dual 4K and 1*VGA, 3 independent displays
- 3*LAN, 6*USB3.1, 2*USB2.0, 4*COM, 16bit Iso. DIO
- 1*Mini PCIe with SIM slot, support 4G and WIFI/BT
- 1*M.2 B-Key 3052 with SIM slot, support 5G module
- 1*M.2 E-key 2230, supports Gigabit WiFi/BT modules
- 2*SATA3.0 SATA bay, supports RAID0, 1 and hot swap design
- 1*mSATA and 1*M.2 M-Key, supports NVMe high speed storage
- Wide power input 9-36V, with short circuit, over voltage and over current protection



Product Overview

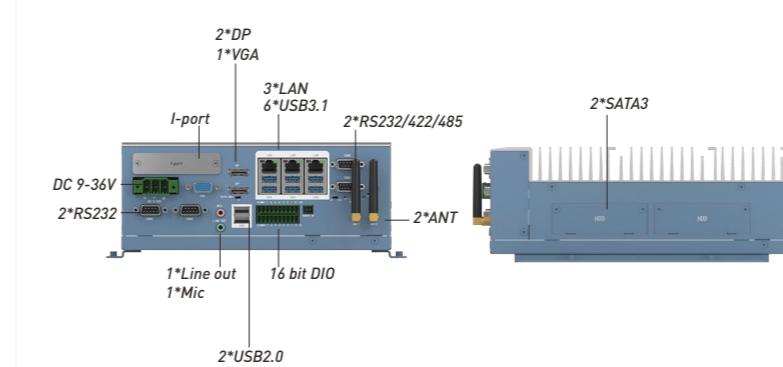
KMDA-5610 is a fanless and high-performance box computer with Q370 chipset, powered by Intel® 8th /9th Gen Coffee lake CPU has complete IO function, high-speed storage and RAID storage, wide voltage DC power supply and moderate size. It is suitable for industrial automation, highway tolling, security monitoring, environmental detection, and other industries and fields.

Product Parameters

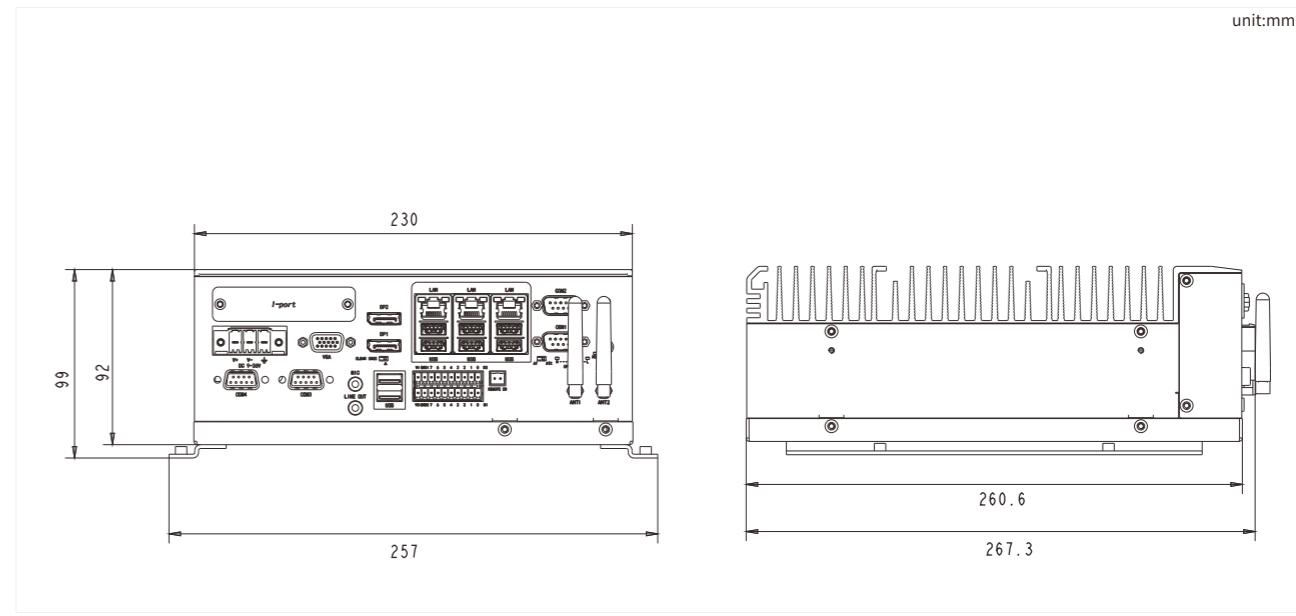
System	
CPU	Intel® Coffee lake 9th/8th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1151 CPU, Intel® Q370 PCH
RAM	4*260-Pin SODIMM, DDR4 2666/2400MHz, 128GB max.
Graphics	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 , DP:4096*2304@60Hz, VGA:1920*1200@60Hz, DP:4096*2304@60Hz(3 independent display)
LAN	2*Intel I211AT/I210AT, 10-1000M ; 1*Intel I219 LM, 10-1000M, iAMT 13.0, iVpro(i5/i7/i9)
USB	6* USB3.1(5Gbps), 2*USB2.0 , 2*USB2.0(Built-in)
Display	2*DP+1*VGA
Audio	1*Line out+1*Mic,Optional Realtek ALC662
COM/Others	2*RS232/422/485, 2*RS232; 16 bit Iso. DIO:
DIO	8 bit 2.5KV Iso. DI(H:5-24V, L:0-1.5V), 8 bit 2.5KV Iso. DO(200mA)
Storage	
Storage	2*2.5" SATA3; 1*M.2 2280 M-key(X4), NVMe; 1*mSATA(Optional)
Others	
LED	1*PowerLED, 1*HDD LED, 3*CPUoperationLED
Switch	1*Power SW, 1*Remote SW, 1*AT/ATX SW, 1*Clear CMOS SW
WDT	programmable via software 1 to 255 second
TCPM/TPM	Optional TPM2.0

Expansion	
Expansion	1*Mini PCIe(SATA3.0/USB2.0+SIM),mSATA/4G LTE; 1*M.2 2230 E-Key(PCleX1/USB2.0+CNvio), WIFI6/BT5.0; 1*M.2 3052 B-Key(PCleX1/USB2.0+SIM), 5G NR/4G LTE; 1*M.2 2280 M-Key(PCleX4),NVME/PCIe module; I-port:OptionalUSB2.0/ 16 bitDIO/COM/Others
Power	
Power& TDP	DC IN 9-36V , 3-pin Term. 7.62mm,With short circuit, OVP & OCP TDP:60.5W (i7-8700T, 32G DDR4, 128G SSD)
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Pigeon blue + White aluminum grey
Installation	desktop mounting
Dimension (W*D*H)	230*267.3*92mm
Weight	5.02KG
Environment	
Operating Temp	-20°C~60°C, SSD, with air flow; -10°C~55°C , HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~95%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)
Shock	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Certificate/EMC	CE/FCC Class A
OS	
OS	Windows 10 Enterprise & IOT Enterprise (64 bit) (CFL-R) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R) Wind River VxWorks 7 (CFL-R)

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-5610/S002	Intel® 9th/8th Coffeelake LGA1151 CPU, Q370 PCH	4*DDR4 SODIMM, 3*LAN, 6*USB3.1, 2*USB2.0, 4*COM, M.2 E-Key, 1*VGA, 2*DP, Audio Line out & Mic, 16bit Iso.DIO, 1*M.2 E-Key, 1*M.2 B-Key, 1*M.2 M-Key, 2*2.5"SATA bay, 1*Mini PCIe(mSATA), 1*I-port, DC 9-36V
PA-120DC19		AC/DC power adapter, DC 19V/6.32A,120W
AC-140		8bit iso input, 8bit power relay output terminal board, DC 12V, the source signal is a 16bit TTL signal GPIO

KMDA-5920/S001

Intel® 9th/8th-Gen Coffee Lake LGA1151 series CPU ,2*LAN, 4*USB3.1, 2*SATA3.0, 1*PCIe X16, 1*PCIeX4, DC 9-36V

Key Specification

- Intel® 8th /9th Gen Coffee lake LGA1151 CPU
- Intel® H310 PCH
- 2*DDR4 2400/2666MHz SODIMM, up to 64GB
- 1*DP, 1*HDMI, 1*VGA, tri-display
- 2*LAN, 4*USB3.1, 2*USB2.0, 16bit Iso. DIO
- 2*RS232/422/485 and 2*RS232
- 1*PCIeX16 and 1*PCIeX16 (X4 signal) dual expansion
- 1*M.2 E-key 2230, supports Gigabit WIFI module
- 2*2.5-inch SATA bay and 1*mSATA
- Wide power input DC 9-36V, with short circuit, over voltage and over current protection



Product Overview

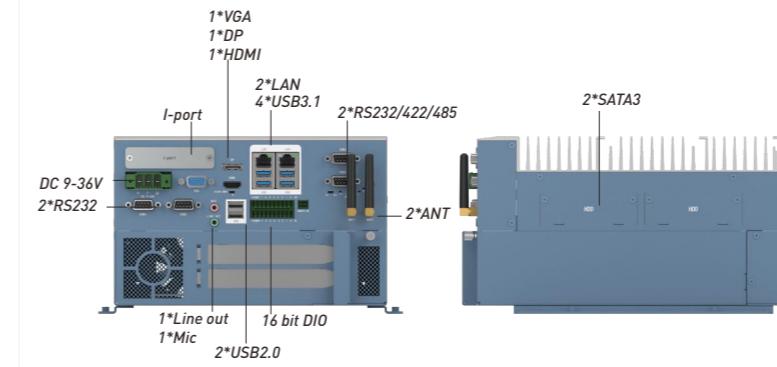
KMDA-5920 is a fanless high-performance box computer with H310 chipset, powered by Intel® 8th /9th Gen Coffee lake CPU has complete IO function, dual PCIe extensions, wide voltage DC power supply and moderate size. It is suitable for industrial automation, highway tolling, AI edge computing, security monitoring and environmental detection and other industries and fields.

Product Parameters

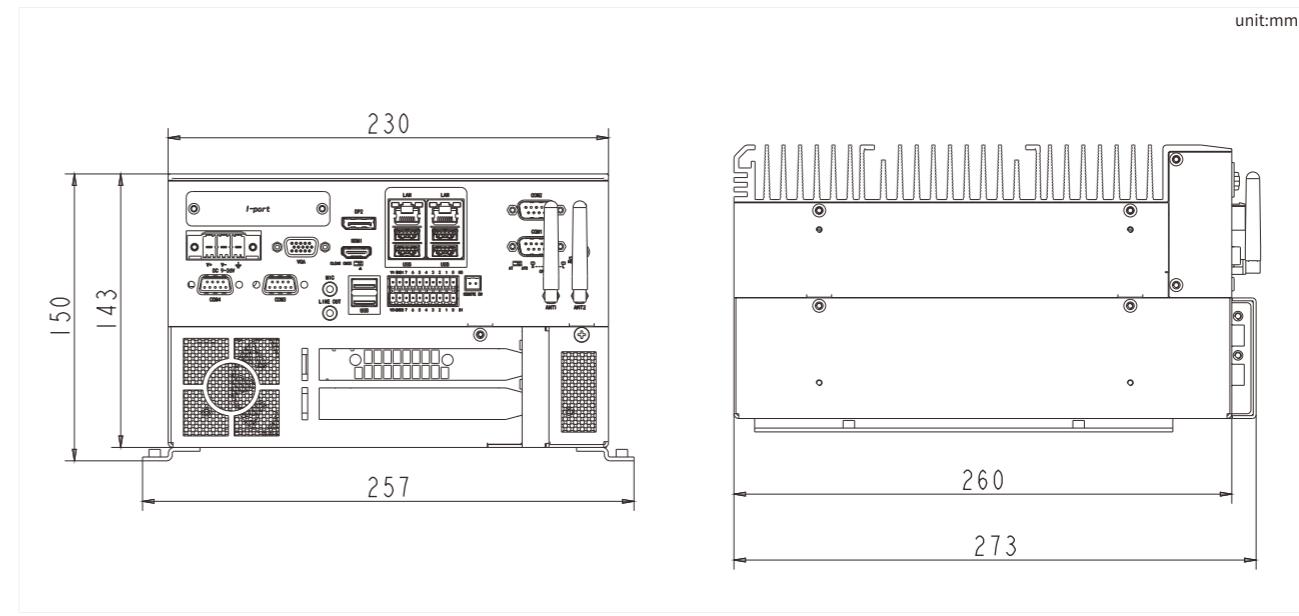
Processor	
CPU	Intel® Coffee lake 9th/8th-Gen Corei7/i5/i3/Pentium/Celeron LGA1151 processor, H310 chipset
RAM	
RAM	2*260-Pin ,DDR4,2400/2666MHz, Max. 64GB
Graphics	
Graphics	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 or PCIe X16,DP:4096*2304@60Hz, VGA:1900*1200@60Hz, HDMI:4096*2160@24Hz (Support 2 independent display, 1 mirror display)
LAN	
LAN	1*Intel I210AT PCIe ,10/100/1000Mbps; 1*Intel I219 LM
USB	
USB	4* USB3.1, 2*USB2.0,1*USB2.0 (build-in)
Display	
Display	1*DP+1*HDMI+1*VGA
Audio	
Audio	1*Line out+1*Mic,Realtek ALC662VD
COM/Others	
COM/Others	2*RS232/422/485, 2*RS232, 16-bit iso DIO
DIO	
DIO	8-bit 2.5KV Iso. DI(High:5-24V,Low:0-1.5V) and 8-bit 2.5KV Iso. DO (200mA)
Storage	
Storage	2*2.5" SATA3,HDD,1*mSATA, with SIM slot,support 4G
Others	
LED	1*power LED, 1*hard disk LED, 3*CPU temperature LED
Switch	1*Power SW,1*Remote switch,1*AT/ATX SW, 1*Clear CMOS SW
WDT	Watchdog timeout programmable via software 1 to 255 second
OS	
OS	Windows 10 Enterprise & IOT Enterprise, Ubuntu,SuSe,Redhat Enterprise 1,2 (Kernel 4.14) Wind River VxWorks 7

Expansion	
Expansion	1*PCIe3.0 X16(X16),GPU/AI Card<150W<210mm + 1*PCIe2.0X16(X4), AI Card<75W<230mm; or 1*PCIe3.0 X16(X16)+1*32bit PCI ; 1*M.2 E-Key 2230(PCIeX1/USB2.0), WIFI/BT; 1*Mini PCIe(SATA3.0/USB2.0T+SIM),mSATA/4G LTE; I-port:USB2.0/ 16bit DIO/COM/others
Power Supply	
Power& TDP	DC IN 9-36V 3-pin Term. 7.62mm,With short circuit, OVP & OCP 60.48W (I7-8700T CPU/16G DDR4/128G SSD)
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Pigeon blue + White aluminum grey
Installation	Desktop mounting
Dimension(W*H*D)	230*273*143mm
Weight	5.9KG
Environment	
Operating Temp	-20°C~60°C SSD, with air flow, -10°C~55°C HDD, with air flow
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No condensation
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)
Shock	50g peak acceleration(duration 11ms) with SSD; 20g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-5920/S001	Intel® 9th/8th Coffeecake LGA1151 CPU, H310	2*DDR4 SODIMM, 2*LAN, 4*USB3.1, 2*USB2.0, 4*COM, M.2 E-Key, 1*VGA, 1*DP, 1*HDMI, Audio Line out & Mic, 16bit Iso.DIO, 2*2.5" SATA bay, 1*Mini PCIe(mSATA), 1*I-port, DC 9-36V	Standard: ECX-255 1*PCIeX16(X16)+1*PCIeX16(X4)
PA-120DC19		AC/DC power adapter, DC19V/6.32A 120W	Optional: ECX-271 1*PCIeX16(X16)+1*32bit PCI
PA-220DC24		AC/DC power adapter, DC 24V/9.17A 220W	
PA-300DC24		AC/DC power adapter, DC24V/12.5A, 300W	
AC-140		8bit iso input, 8bit power relay output terminal board, DC 12V, the source signal is a 16bit TTL signal GPIO	

KMDA-5920/S002

Intel® 8th/9th Coffee Lake LGA1151 CPU, 3*LAN, 4*USB3.1, 1*VGA, 2*DP, 4*COM, 16bit Iso.DIO, 2*PCIe, 1*Mini PCIe, 3*M.2, 2*SATA3.0, DC 9-36V

Key Specification

- Intel® 8th/9th Gen Coffeelake LGA1151 CPU
- Intel® Q370 high-performance chipset
- 4*DDR4 2400/2666MHz SODIMM, up to 128GB
- Supports 2*DP dual 4K and 1*VGA, 3 independent displays
- 3*LAN, 6*USB3.1, 2*USB2.0, 4*COM, 16bit Iso. DIO
- 1*Mini PCIe with SIM slot, support 4G and WIFI/BT
- 1*M.2 B-Key 3052 with SIM slot, support 5G module
- 1*M.2 E-key 2230, supports Gigabit WiFi/BT modules
- 1*PCIeX16 and 1*PCIeX16 (X4 signal) dual expansion
- 2*SATA3.0 SATA bay, supports RAID0, 1 and hot swap design
- Optional 1*mSATA and 1*M.2 M-Key supports NVMe high-speed storage
- Wide power input DC 9-36V, with short circuit, over voltage and over current protection



Product Overview

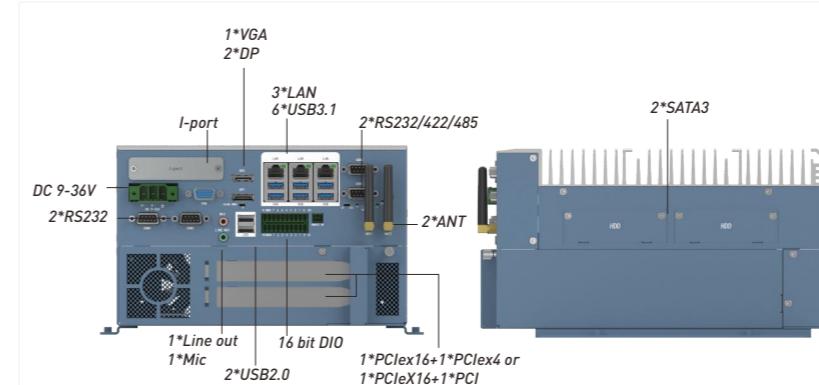
KMDA-5920 is a fanless and high-performance box computer with Q370 chipset, powered by Intel® 8th /9th Gen Coffee lake CPU has complete IO function, dual PCIe extensions, wide voltage DC power supply and moderate size. It is suitable for industrial automation, highway tolling, AI edge computing, security monitoring and environmental detection and other industries and fields.

Product Parameters

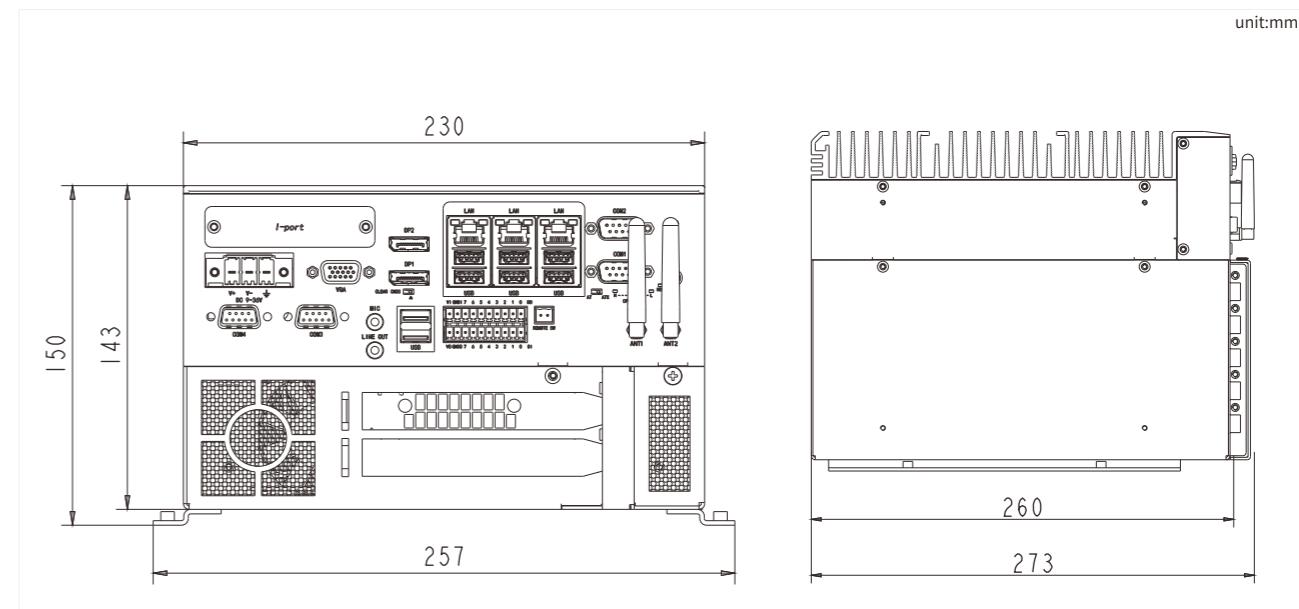
Processor	
CPU	Intel® Coffee lake 9th/8th-Gen Corei7/i5/i3/Pentium/Celeron LGA1151 processor, Q370 chipset
RAM	
RAM	4*260-Pin ,DDR4,2400/2666MHz, Max. 128GB
Graphics	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 or PCIe X16,DP:4096*2304@60Hz, VGA1900*1200@60Hz,support 3 independent displays
LAN	2*Intel I210AT PCIe ,10/100/1000Mbps ; 1*Intel I219 LM, support iPro
USB	6* USB3.1, 2* USB2.0,2*USB2.0 (build-in)
Display	2*DP+1*VGA
Audio	1*Line out+1*Mic, Realtek ALC662VD
COM/Others	2*RS232/422/485, 2*RS232, 16-bit iso DIO
DIO	8-bit 2.5KV Iso. DI(High:5-24V,Low:0-1.5V) and 8-bit 2.5KV Iso. DO (200mA)
Storage	
Storage	2*2.5" SATA3, supportRAID0,1, 1*M.2 M-Key,PClex4 Gen3.0, support NVME storage
Others	
LED	1*power LED, 1*hard disk LED, 3*CPU temperature LED
Switch	1*Power SW,1*Remote switch,1*AT/ATX SW, 1*Clear CMOS SW
WDT	Watchdog timeout programmable via software 1 to 255 second
OS	
OS	Windows 10 Enterprise & IOT Enterprise, Ubuntu,SuSe,Redhat Enterprise 1,2 (Kernel 4.14),Wind River VxWorks 7

Expansion	
Expansion	1*PCIe3.0 X16(X16),GPU/AI card<150W<210mm + 1*PCIe3.0X16(X4),AI Card<75W<230mm; or 1*PCIe3.0 X16(X16)+1*32bit PCI; 1*M.2 E-Key 2230(PCIeX1/USB2.0+CNvio), WIFI6/BT5.0; 1*M.2 B-key 3052(PCIeX1/USB2.0+SIM),5G NR/4G LTE; 1*M.2 M-Key 2280(PCIeX4), NVME/PCIe module; 1*Mini PCIe(SATA3.0/PCIeX1+SIM),mSATA/4G LTE; I-port:16bit DIO/2*USB2.0/M.2/Mini PCIe
Power Supply	
Power&	DC IN 9-36V 3-pin Term. 7.62mm,with short circuit protection, over voltage and over current protection,
TDP	60.48W (I7-8700T CPU/16G DDR4/128G SSD)
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Pigeon blue + White aluminum grey
Installation	Desktop mounting
Dimension(W*H*D)	230*273*143mm
Weight	5.9KG
Environment	
Operating Temp	-20°C~60°C SSD, with air flow, -10°C~55°C HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No condensation
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)
Shock	50g peak acceleration(duration 11ms) with SSD; 20g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-5920/S002	Intel® 9th/8th Coffeelake LGA1151 CPU, Q370	4*DDR4,3*LAN, 6*USB3.1, 2*USB2.0, 4*COM, 1*Mini PCIe(mSATA), 1*M.2 E-Key, 1*M.2 B-Key, 1*VGA, 2*DP, 1*Line out,1*Mic, 16-bit Iso. DIO,2*2.5" SATA, 1*M.2 2280 M-Key, I-Port, DC 9-36V	Standard: ECX-255 1*PCIeX16(X16)+1*PCIeX16(X4) Optional: ECX-271 1*PCIeX16(X16)+1*32bit PCI
PA-120DC19		AC/DC power adapter, DC19V/6.32A 120W	
PA-220DC24		AC/DC power adapter,DC 24V/9.17A 220W	
PA-300DC24		AC/DC power adapter,DC24V/12.5A,300W	
AC-140		8-channel isolated input and 8-channel power relay output terminal board,DC 12V,source signal: 16-bit TTL GPIO	

KMDA-5921/S001

Intel® 8th/9th Gen Coffee Lake LGA1151 CPU, 2*LAN, 4*USB3.1, 1*VGA, 1*DP, 1*HDMI, 4*COM, 16bit Iso.DIO, 2*PCIe+2*PCI,DC 9-36V

Key Specification

- Intel® 8th/9th Gen Coffee lake LGA1151 CPU
- Intel® H310 PCH
- 2*DDR4 2400/2666MHz SODIMM, up to 64GB
- 1*DP, 1*HDMI, 1*VGA, tri-display
- 2*LAN, 4*USB3.1, 2*USB2.0, 16bit Iso.DIO
- 2*RS232/422/485 and 2*RS232
- 1*PCIeX16+1*PCIeX4 (X2 signal)+2*PCI Quad expansion
- 1*M.2 E-key 2230, supports Gigabit WIFI module
- 2*2.5-inch SATA bay and 1*mSATA
- Wide power input DC 9-36V, with short circuit, over voltage and over current protection



Product Overview

KMDA-5921 is a fanless high-performance box computer with H310 chipset, powered by Intel® 8th /9th Gen Coffee lake CPU has complete IO function, dual PCIe plus dual PCI quad expansions, wide voltage DC power supply and moderate size. It is suitable for industrial automation, highway tolling, AI edge computing, security monitoring and environmental detection and other industries and fields.

Product Parameters

Processor

CPU Intel® Coffee lake 9th/8th-Gen Core i7/i5/i3/Pentium/Celeron
LGA1151 processor, H310 chipset

RAM 2*260-Pin ,DDR4,2400/2666MHz, Max. 64GB
Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL

Graphics 2.1 or PCIe X16, DP:4096*2304@60Hz,
VGA:1900*1200@60Hz,HDMI:4096*2160@24Hz
(Support 2 independent display, 1 mirror display)

LAN 1*Intel I211AT,10-1000M ;
1*Intel I219 LM,WOL

USB 4* USB3.1, 2*USB2.0

Display 1*DP+1*HDMI+1*VGA

Audio 1*Line out+1*Mic, Optional Realtek ALC662VD

Serial port /Others 2*RS232/422/485, 2*RS232,
16-bit iso DIO

DIO 8-bit 2.5KV Iso. DI(High:5-24V,Low:0-1.5V) and
8-bit 2.5KV Iso. DO (200mA)

Storage
Storage 2*2.5" SATA3,HDD; 1*MiniPCIe(SATA3/USB2.0),mSATA

Others

LED 1*power LED, 1*HDD LED, 3*CPU temperature LED

Switch 1*Power SW,1*Remote SW,1*AT/ATX SW, 1*Clear CMOS SW

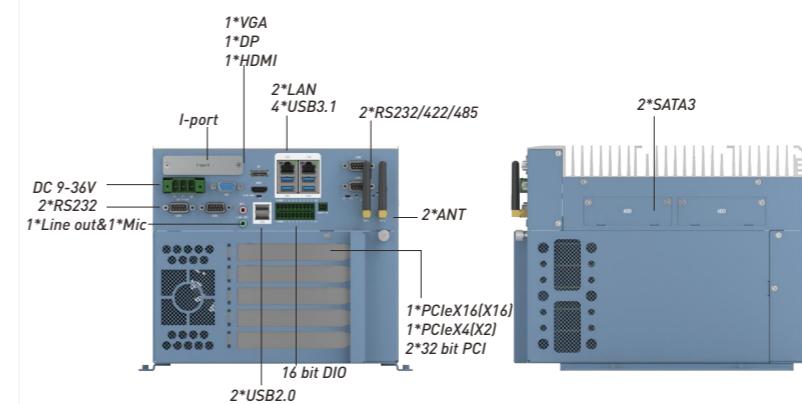
WDT Watchdog timeout programmable via software 1 to 255 second

TCPM/TPM support TPM2.0 (optional)

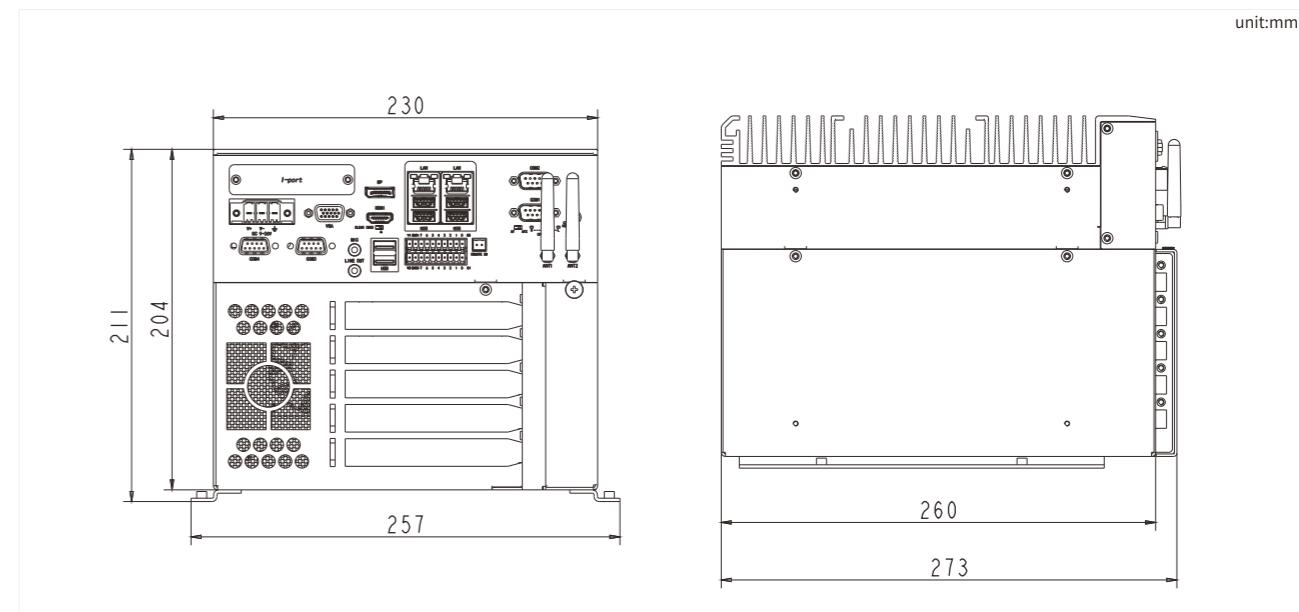
OS

OS Windows 10 Enterprise & IOT Enterprise, Ubuntu,SuSe,Redhat
Enterprise 1.2 (Kernel 4.14), Wind River VxWorks 7

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-5921/S001	Intel® 9th/8th Coffee lake LGA1151 CPU, H310 PCH	2*DDR4 SODIMM,2*LAN, 4*USB3.1, 2*USB2.0,4*COM, 1*Mini PCIe, M.2 E-Key, 1*VGA, 1*DP,1*HDMI, 1*Line out,1*Mic, 16-bit iso DIO,2*2.5" SATA, DC 9-36V	Standard: ECX-266 1*PCIeX16(X16) +1*PCIeX4(X2) +2*32bit PCI
PA-120DC19		AC/DC adapter, DC19V/6.32A 120W	
PA-220DC24		AC/DC adapter, DC 24V/9.17A 220W	
PA-300DC24		AC/DC power adapter, DC24V@12.5A ,300W	
AC-140		8bit isolating input and 8bit power relay output terminal board, DC 12V, signal is 16bit TTL GPIO	

KMDA-5921/S002

Intel® 9th/8th-Gen Coffee Lake LGA1151 CPU, 3*LAN, 6*USB3.1, 2*easy-swappable SATA3, 4*PCIe slots, DC 9-36V

Key Specification

- Intel® 8th/9th Gen Coffee lake LGA1151 CPU
- Intel® Q370 high-performance chipset
- 4*DDR4 2400/2666MHz SODIMM, up to 128GB
- Supports 2*DP dual 4K and 1*VGA, 3 independent displays
- 3*LAN, 6*USB3.1, 2*USB2.0, 4*COM, 16bit Iso. DIO
- 1*Mini PCIe with SIM slot, support 4G and WIFI/BT
- 1*M.2 B-Key 3052 with SIM slot, support 5G module
- 1*M.2 E-key 2230, supports Gigabit WiFi/BT modules
- 2*PCIeX16 (X8 signal)+2*PCIeX16 (X4 signal) Quad expansion
- 2*SATA3.0 SATA bay, supports RAID0, 1 and hot swap design
- Optional 1*mSATA and 1*M.2 M-Key supports NVMe high-speed storage
- Wide power input DC 9-36V, with short circuit, over voltage and over current protection



Product Overview

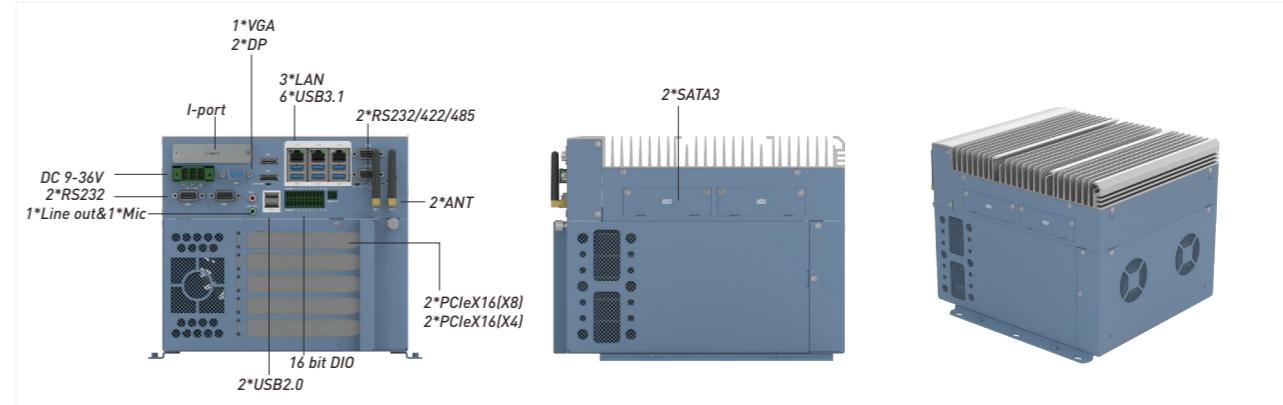
KMDA-5921 is a fanless and high-performance box computer with Q370 chipset, powered by Intel® 8th /9th Gen Coffee lake CPU has complete IO function, quad PCIe extensions, wide voltage DC power supply and moderate size. It is suitable for industrial automation, highway tolling, AI edge computing, security monitoring and environmental detection and other industries and fields.

Product Parameters

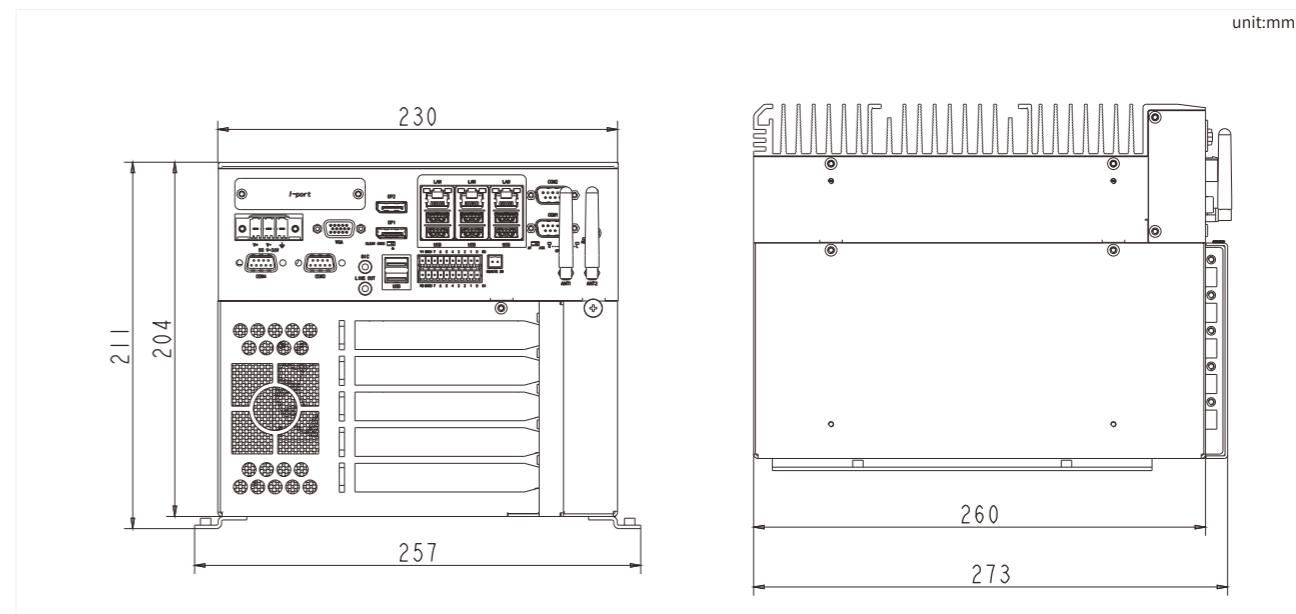
Processor	
CPU	Intel® Coffee lake 9th/8th-Gen Corei7/i5/i3/Pentium/Celeron LGA1151 processor, Q370 chipset
RAM	
RAM	4*260-Pin ,DDR4,2400/2666MHz, Max. 128GB
Intel UHD Graphics; Supports DirectX11.1, OpenGL 5.0 and OpenCL	
Graphics	
Graphics	2.1 or PCIe X16, support 3 independent displays
DP:4096*2304@60Hz, VGA:1900*1200@60Hz,	
LAN	
LAN	2*Intel I211AT/210AT or 1*Intel I211AT/I210AT+1*I219LM,10-1000M,iAMT13.0,iVpro;
USB	
USB	6* USB3.1, 2*USB2.0
Display	
Display	2*DP+1*VGA
Audio	
Audio	1*Line out+1*Mic, Realtek ALC662VD
COM/Others	
COM/Others	2*RS232/422/485, 2*RS232
16-bit iso DIO	
DIO	8-bit 2.5V Iso. DI(High:5-24V,Low:0-1.5V) and 8-bit 2.5V Iso. DO (200mA)
Storage	
Storage	2*2.5" SATA3, RAID0,1, 1*M.2 M-Key(PCIe3.0x4), NVME
Others	
LED	1*power LED, 1*H LED, 3*CPU temperature LED
Switch	1*Power SW,1*Remote switch,1*AT/ATX SW, 1*Clear CMOS SW
WDT	Watchdog timeout programmable via software 1 to 255 second
TCPM/TPM	Optional TPM2.0
OS	
OS	Windows 10 Enterprise & IOT Enterprise, Ubuntu,SuSe,Redhat Enterprise 1,2 (Kernel 4.14), Wind River VxWorks 7

Expansion	
Expansion	2*PCIe3.0X16(X8), GPU/AI Card<150W<210mm+ 2*PCIe3.0X16(X4), AI Card<75W<230mm; or 1*PCIe3.0 X16(X16)+1*PCIe3.0X16(X4)+2*32bit PCI; 1*M.2 E-Key 2230(PCIeX1/USB2.0+CNVi),WIFI6/BT5.0; 1*M.2 B-key 3052(PCIeX1/USB2.0+SIM),5G NR/4G LTE; 1*M.2 M-Key 2280(PCIeX4), NVME/PCIe module; 1*Mini PCIe(SATA3.0/PCIeX1+SIM), mSATA/4G LTE; I-port:USB2.0/ 16 bit DIO/COM/others
Power Supply	
Power&	DC IN 9-36V ,with short circuit protection, over voltage and over current protection
TDP	60.5W(I7-8700T,32G DDR4,128G SSD)
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Pigeon blue + White aluminum grey
Installation	Desktop mounting
Dimension(W*H*D)	230*273*204mm
Weight	7.25KG
Environment	
Operating Temp	-20°C~60°C SSD, with air flow, -10°C~55°C HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No condensation
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)
Shock	50g peak acceleration(duration 11ms) with SSD; 20g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-5921/S002	Coffee lake-R 9th/8th-Gen LGA1151 CPU, Q370 PCH	4*DDR4 SODIMM, 3*LAN, 6*USB3.1, 2*USB2.0, 4*COM, 1*VGA, 2*DP, Audio Line out & Mic, 16bit Iso.DIO, 1*M.2 E-Key, 1*M.2 B-Key, 1*M.2 M-Key, 2*2.5"SATA bay, 1*Mini PCIe(mSATA), 1*I-port, DC 9-36V	Standard: ECX-254 2*PCIeX16(X8)+2*PCIeX16(X4)
PA-120DC19		AC/DC power adapter, DC19V/6.32A 120W	Optional: ECX-275 1*PCIeX16(X16)+1*PCIeX16(X4)+2*32bit PCI
PA-220DC24		AC/DC power adapter, DC24V/9.17A 220W	
PA-300DC24		AC/DC power adapter, DC24V/12.5A, 300W	
AC-140		8-channel isolated input and 8-channel power relay output terminal board, DC 12V, source signal: 16-bit TTL GPIO	

KMDA-6610

Intel® 10th Comet Lake LGA1200 CPU, 2*LAN, 4*USB3.2, 1*VGA, 1*DP, 1*HDMI, 4*COM, 8bit DIO, 1*mSATA, 1*Mini PCIe, 2*SATA3.0, DC 9-36V

Key Specification

- Intel® 10th Gen Comet lake LGA1200 CPU
- Intel® H420E Chipset
- 2*DDR4 2933MHz SODIMM, up to 64GB
- 1*DP, 1*HDMI and 1*VGA three display ports, supporting two independent displays
- 2*LAN, 4*USB3.2, 2*USB2.0, 8bit DIO, 1*MIC+1*LINE OUT, 1*PS/2
- 2*RS232/422/485 and 2*RS232
- 1*Mini-PCIe full size with SIM card slot, supporting 4G LTE module
- 2*2.5-inch SATA bay and 1*mSATA
- Wide power input 9-36V, with short circuit, over voltage and over current protection



Product Overview

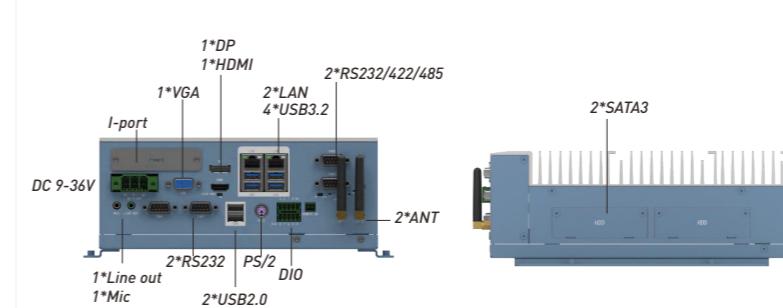
KMDA-6610 is a fanless high-performance box computer with H420E chipset, powered by Intel® 10th Gen Comet lake CPU has complete IO function, wide voltage DC power supply and moderate size. It is suitable for industrial automation, highway tolling, security monitoring and environmental detection and other industries and fields.

Product Parameters

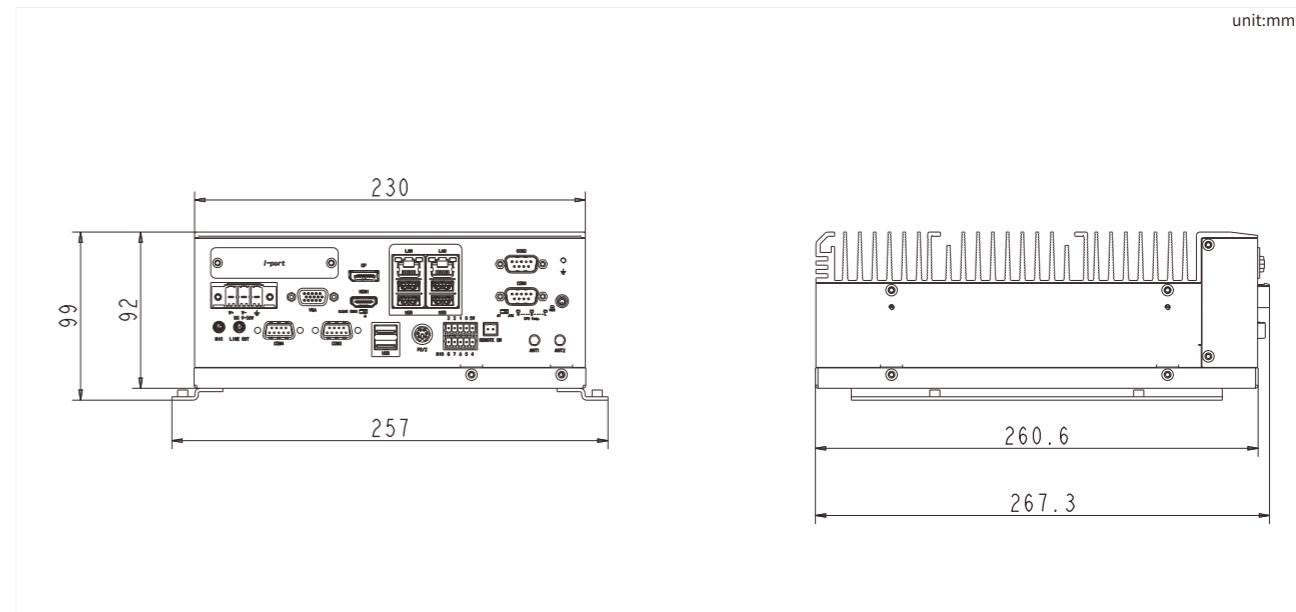
System	
CPU	Intel® Comet lake 10th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU, Intel® H420E PCH
RAM	2*260-Pin ,DDR4,2933MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, DP:4096*2304@60Hz, HDMI:4096*2160@30Hz, VGA:1920*1200@60Hz, 2 independent display
LAN	1*Intel I226V, 2.5G(PCleX1),10M-2.5G,WOL; 1*Intel I219 LM(PCleX1),10-1000M, WOL
USB	4* USB3.2 Gen1, 2*USB2.0 , 2*USB2.0 (Build-in)
Display	1*DP+1*HDMI+1*VGA
Audio	1*Line out+1*MIC,Realtek ALC897
COM/Others	2*RS232/422/485, 2*RS232;
DIO	8 bit non Iso. DIO (2*5pin); 16 bit non Iso. DIO(2*10pin)
Storage	2*2.5" SATA3.0; 1*mSATA(SATA3.0+USB2.0)
Others	
LED	1*PowerLED, 1*HDD LED,3*CPUoperationLED
Switch	1*Power SW, 1*Remote SW, 1*AT/ATX SW, 1*Clear CMOS SW
WDT	programmable via software 1 to 255 second
TCPM/TPM	Optional TPM

Expansion	
Expansion	1*Mini-PCIe(PCleX1/USB2.0+SIM),4G LTE/PCIe module; I-port: 16bit DIO/USB2.0/LPT/Mini PCIe
Power	
Power& TDP	DC IN 9-36V , short circuit protection, OVP&OCP TDP:59.52W(i5-10500 CPU/4G DDR4/256G SSD)
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Pigeon blue + White aluminum grey
Installation	desktop mounting
Dimension (W*H*D)	230*267.3*92mm
Weight	5.12KG
Environment	
Operating Temp	-20°C~60°C SSD, with air flow; -10°C~55°C HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~95%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)
Shock	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Certificate/EMC	CE/FCC Class A
OS	
OS	Windows11, Windows 10 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-6610/S001	Intel® 10th Cometlake LGA1200 CPU, H420E PCH	2*DDR4 SODIMM, 2*LAN, 4*USB3.2, 2*USB2.0, 1*PS/2, 4*COM, 1*VGA, 1*DP, 1*HDMI, Audio Line out & Mic, 8bit DIO, 1*I-Port, 2*2.5"SATA bay, 1*mSATA, 1*Mini PCIe, DC 9-36V
PA-120DC19		AC/DC power adapter, DC 19V/6.32A,120W

KMDA-6920

Intel® 10th Comet Lake LGA1200 CPU, 2*LAN, 4*USB3.2, 1*VGA, 1*DP, 1*HDMI, 4*COM, 8bit DIO, 1*mSATA, 1*Mini PCIe, 2*PCIe, 2*SATA3.0, DC 9-36V

Key Specification

- Intel® 10th Gen Comet lake LGA1200 CPU
- Intel® H420E PCH
- 2*DDR4 2933MHz SODIMM, up to 64GB
- 1*DP, 1*HDMI and 1*VGA three display ports, supporting two independent displays
- 2*LAN, 4*USB3.2, 2*USB2.0, 8bit DIO, 1*MIC+1*LINE OUT, 1*PS/2
- 2*RS232/422/485 and 2*RS232
- 1*Mini PCIe full size with SIM card slot, supporting 4G LTE module
- 1*PCIeX16 and 1*PCIeX16 (X4 signal) dual expansion
- 2*2.5-inch SATA bay and 1*mSATA
- Wide power input DC 9-36V, with short circuit, over voltage and over current protection



Product Overview

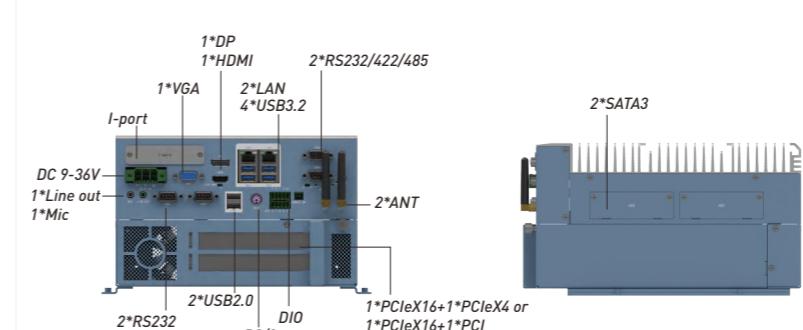
KMDA-6920 is a fanless high-performance box computer with H420E chipset, powered by Intel® 10th Gen Comet lake CPU has complete IO function, dual PCIe extensions, wide voltage DC power supply and moderate size. It is suitable for industrial automation, highway tolling, AI edge computing, security monitoring and environmental detection and other industries and fields.

Product Parameters

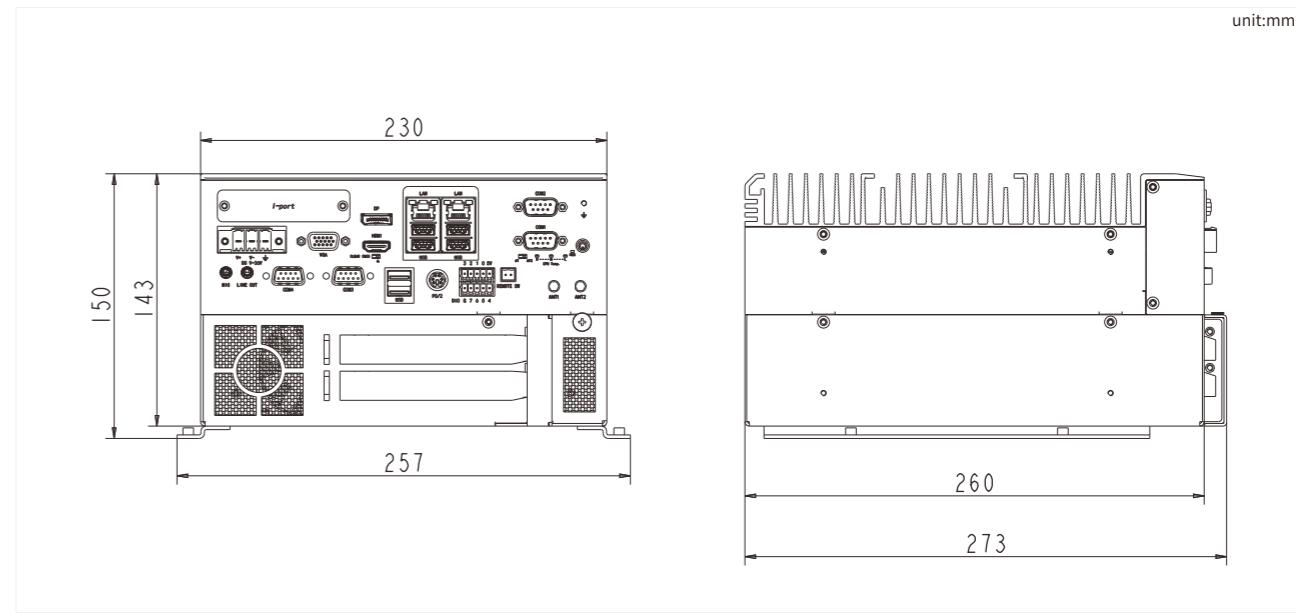
System	
CPU	Intel® Comet lake 10th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU, Intel® H420E PCH
RAM	2*260-Pin ,DDR4,2933MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, DP:4096*2304@60Hz, HDMI:4096*2160@30Hz, VGA:1920*1200@60Hz, 2 independent display
LAN	1*Intel I226V, 2.5G(PCleX1),10M-2.5G,WOL; 1*Intel I219 LM(PCleX1), 10-1000M, WOL
USB	4* USB3.2 Gen1, 2*USB2.0 , 2*USB2.0 (Build-in)
Display	1*DP+1*HDMI+1*VGA
Audio	1*Line out+1*MIC,Realtek ALC897
COM/Others	2*RS232/422/485, 2*RS232;
DIO	8bit non-isolated DIO, TTL , programmable 16 bit non-isolated DIO(2*10 pin)
Storage	
Storage	2*2.5" SATA3.0; 1*mSATA(SATA3.0+USB2.0)
Others	
LED	1*PowerLED, 1*HDD LED, 3*CPUoperationLED
Switch	1*Power SW, 1*Remote SW, 1*AT/ATX SW, 1*Clear CMOS SW
WDT	programmable via software 1 to 255 second
TCPM/TPM	Optional TPM

Expansion	
Expansion	1*PCIe3.0 X16(X16),GPU/AI Card<150W<210mm+ 1*PCIe3.0X16(X4) ,AI Card<75W<230mm; or 1*PCIe3.0 X16(X16)+1*32bit PCI; 1*Mini PCIe(PCleX1/USB2.0+SIM),4G LTE/PCIe module; I-port: 16bit DIO/USB2.0/LPT/Mini PCIe
Power	
Power& TDP	DC IN 9-36V, short circuit protection, OVP&OCP TDP:57.12W(i7-10700TE CPU/4G DDR4/256G SSD)
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Pigeon blue + White aluminum grey
Installation Dimension (W*H*D)	230*273*143mm
Weight	5.899KG
Environment	
Operating Temp	-20°C~60°C SSD, with air flow; -10°C~55°C HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~95%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)
Shock	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Certificate/EMC	CE/FCC Class A
OS	
OS	Windows11, Windows 10 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-6920/S001	Intel® 10th Cometlake LGA1200 CPU, H420E PCH	2*DDR4 SODIMM, 2*LAN, 4*USB3.2, 2*USB2.0, 1*PS/2, 4*COM, 1*VGA, 1*DP, 1*HDMI, Audio Line out & Mic, 8bit DIO, 1*I-Port, 2*2.5" SATA bay, 1*mSATA, 1*Mini PCIe, DC 9-36V	Standard: ECX-255 1*PCIeX16(X16)+1*PCIeX16(X4) Optional: ECX-271 1*PCIeX16(X16)+1*32bit PCI
PA-120DC19		AC/DC power adapter, DC 19V/6.32A, 120W	
PA-220DC24		AC/DC power adapter, DC 24V/9.17A, 220W	
PA-300DC24		AC/DC power adapter, DC 24V/12.5A, 300W	

KMDA-6921

Intel® 10th Comet Lake LGA1200 CPU, 2*LAN, 4*USB3.2, 1*VGA, 1*DP, 1*HDMI, 4*COM, 8bit DIO, 1*mSATA, 1*Mini PCIe, 2*PCIe+2*PCI, 2*SATA, DC 9-36V

Key Specification

- Intel® 10th Gen Comet lake LGA1200 CPU
- Intel® H420E PCH
- 2*DDR4 2933MHz SODIMM, up to 64GB
- 1*DP, 1*HDMI and 1*VGA three display ports, supporting two independent displays
- 2*LAN, 4*USB3.2, 2*USB2.0, 8bit DIO, 1*MIC+1*LINE OUT, 1*PS/2
- 2*RS232/422/485 and 2*RS232
- 1*Mini PCIe full size with SIM card slot, supporting 4G LTE module
- 1*PCIeX16+1*PCIeX4 (X2 signal)+2*PCI Quad expansion
- 2*2.5-inch SATA bay and 1*mSATA
- Wide power input DC 9-36V, with short circuit, over voltage and over current protection



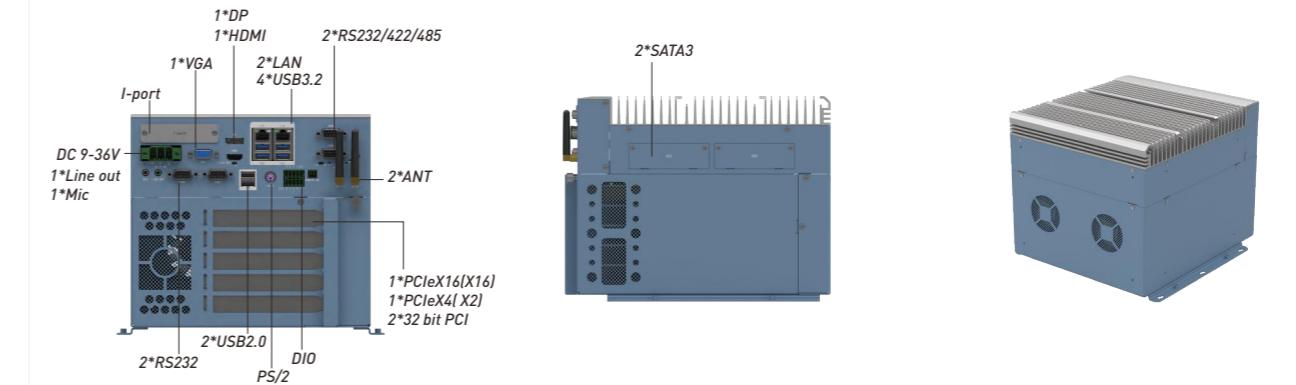
Product Overview

KMDA-6921 is a fanless high-performance box computer with H420E chipset, powered by Intel® 10th Gen Comet lake CPU has complete IO function, dual PCIe plus dual PCI quad expansions, wide voltage DC power supply and moderate size. It is suitable for industrial automation, highway tolling, AI edge computing, security monitoring and environmental detection and other industries and fields.

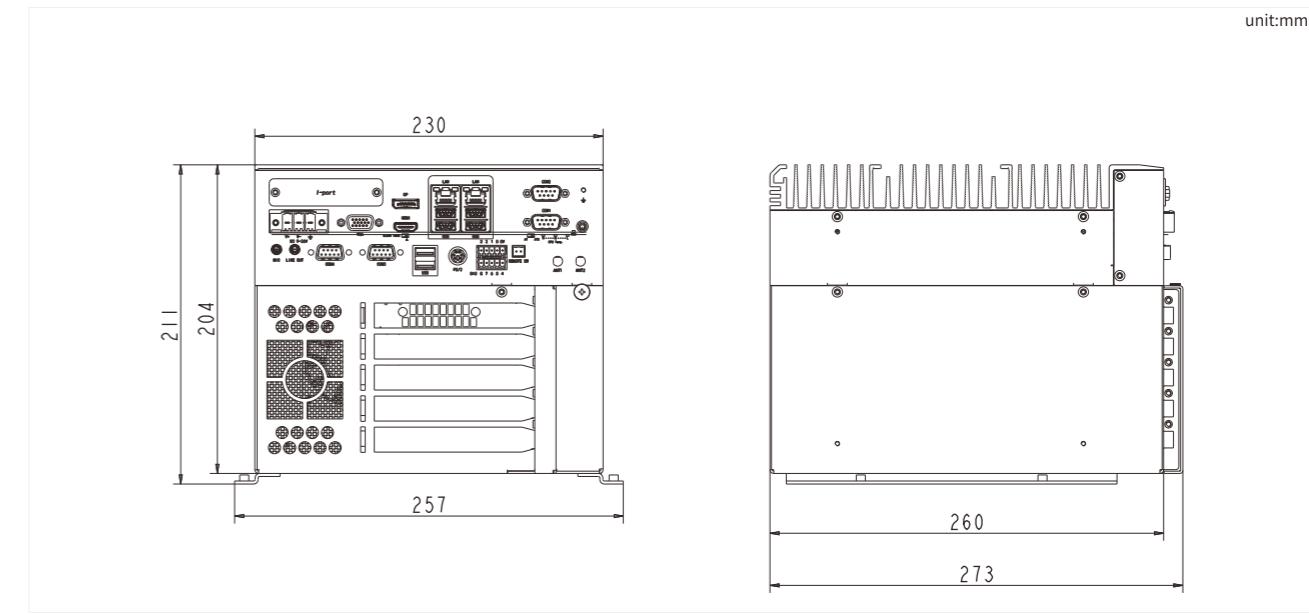
Product Parameters

System		Expansion	
CPU	Intel® Comet lake 10th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU, Intel® H420E PCH	Expansion	1*PCIe3.0 X16(X16),GPU/AI Card<150W<210mm + 1*PCIe3.0X4(X2),Function card<230mm + 2*32bit PCI; 1*Mini PCIe(PCIeX1/USB2.0+SIM),4G LTE/PCIe module, I-port: 16bit DIO/USB2.0/LPT/Mini PCIe
RAM	2*260-Pin ,DDR4,2933MHz, 64GB max.	Power	DC IN 9-36V, short circuit protection, OVP&OCP TDP:60W(i7-10700K CPU/4G DDR4/256G SSD)
Graphics	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, DP:4096*2304@60Hz, HDMI:4096*2160@30Hz, VGA:1920*1200@60Hz, 2 independent display	Mechanical	Structure Aluminum Chassis, SGCC frame Color Pigeon blue + White aluminum grey Installation desktop mounting Dimension(W*H*D) 230*273*204mm
LAN	1*Intel I226V, 10M-2.5G,WOL; 1*Intel I219 LM, 10-1000M, WOL	Weight	6.837KG
USB	4* USB3.2 Gen1, 2*USB2.0, 2*USB2.0 (Build-in)	Environment	Operating Temp -20°C~60°C SSD, with air flow; -10°C~55°C HDD, with air flow; Storage Temp -40°C~85°C Storage Humidity 10~95%@40°C, No-condensation Vibration 5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD) Shock 50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Display	1*DP+1*HDMI+1*VGA	Certificate/EMC	CE/FCC Class A
Audio	1*Line out+1*MIC,Realtek ALC897	OS	OS Windows11,Windows 10 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7
COM/Others	2*RS232/422/485, 2*RS232;		
DIO	8 bitnon Iso.DIO (2*5pin); 16 bitnon Iso.DIO(2*10)		
Storage	2*2.5" SATA3.0; 1*mSATA(SATA3.0+USB2.0)		
Others	1*PowerLED, 1*HDD LED, 3*CPUoperationLED 1*Power SW, 1*Remote SW, 1*AT/ATX SW, 1*Clear CMOS SW programmable via software 1 to 255 second Optional TPM		

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-6921/S001	Intel® 10th Cometlake LGA1200 CPU, H420E PCH	2*DDR4 SODIMM, 2*LAN, 4*USB3.2, 2*USB2.0, 1*PS/2, 4*COM, 1*Mini PCIe, 1*mSATA, 1*VGA, 1*DP, 1*HDMI, Audio Line out & Mic, 8bit DIO, 1*I-Port, 2*2.5" SATA bay, DC 9-36V	Standard: ECX-266 1*PCIeX16 (X16) +1*PCIeX4 (X2) +2*32bit PCI
PA-120DC19		AC/DC power adapter, DC 19V/6.32A, 120W	
PA-220DC24		AC/DC power adapter, DC 24V/9.17A, 220W	
PA-300DC24		AC/DC power adapter, DC 24V/12.5A, 300W	

KMDA-7610

Intel® Alder Lake-S 12th Gen LGA1700 CPU, 2*LAN, 4*USB3.2, 1*VGA, 1*DP, 1*HDMI, 4*COM, 16bit DIO, 1*Mini PCIe, 2*SATA3.0, DC 9-36V

Key Specification

- Intel® 12th Gen Alder lake-S LGA1700 CPU
- Intel® H610 Chipset
- 2*DDR5 4800MHz SODIMM, up to 64GB
- 1*DP, 1*HDMI and 1*VGA, 3 independent displays
- 2*LAN, 4*USB3.2, 2*USB2.0, 16bit Iso. DIO
- Audio 1*MIC+1*LINE OUT
- 2*RS232/422/485 and 2*RS232 COM
- 1*Mini-PCIe full size with SIM card slot, support 4G LTE modem
- 2*2.5"Easy-plug SATA3.0 bay and 1*mSATA
- DC IN 9-36V, wide power input, with OVP,OCP and SCP



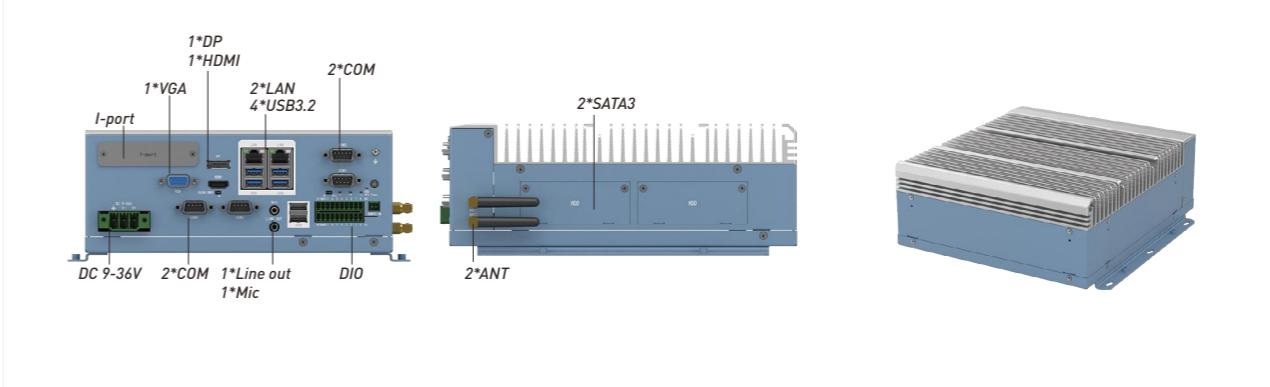
Product Overview

KMDA-7610 is a fanless high-performance box computer with H610 chipset, powered by Intel® 12th Gen Alder lake-S CPU, multi IO interfaces and moderate size. It is suitable for industrial automation, highway tolling, security monitoring and environmental detection and other industries and fields.

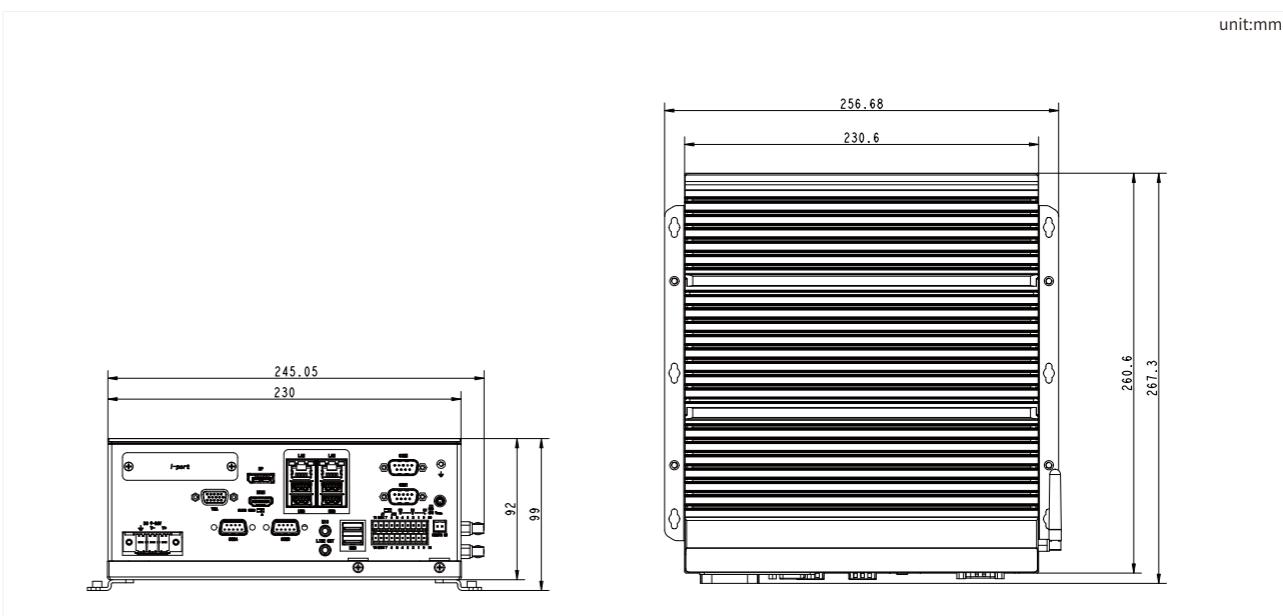
Product Parameters

System	
CPU	Intel® Alder lake-S 12th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH
RAM	2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, 3 independent display
LAN	1*Intel I226V, 10-1000M,WOL; 1*Intel I219 LM, 10-1000M, WOL
USB	2* USB3.2(10G), 2*USB3.2(5G), 2*USB2.0
Display	1*DP+1*HDMI+1*VGA
Audio	1*Line out+1*MIC,Realtek ALC897
COM/Others	2*RS232/422/485, 2*RS232; 16bit Iso.DIO(8bit DI-2.5KV-PNP/NPN;8bit DO-2.5KV-200mA);
DIO	16bit non Iso.DIO(2*10pin)
Storage	
Storage	2*2.5" SATA3.0; 1*mSATA(SATA3.0)
Others	
LED	1*PowerLED, 1*HDD LED, 3*CPU Temp LED
Switch	1*Power SW, Remote SW,1*AT/ATX SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
TCPM/TPM	Optional TPM2.0

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-7610/S001	Intel® Alder lake-S 12th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH	2*DDR5 SODIMM, 2*LAN, 4*USB3.2, 2*USB2.0, 4*COM, 1*VGA, 1*DP, 1*HDMI, Line out & Mic, 16bit Iso.DIO, 1*I-Port, 2*2.5"SATA bay, 1*mSATA, 1*Mini PCIe, DC 9-36V

KMDA-7920

Intel® Alder Lake-S 12th Gen LGA1700 CPU, 2*LAN, 4*USB3.2, 1*VGA, 1*DP, 1*HDMI, 4*COM, 16bit DIO, 2*PCIe, 2*SATA3.0, DC 9-36V

Key Specification

- Intel® 12th Gen Alder lake-S LGA1700 CPU
- Intel® H610 PCH
- 2*DDR5 4800MHz SODIMM, up to 64GB
- 1*DP, 1*HDMI and 1*VGA, 3 independent displays
- 2*LAN, 4*USB3.2, 2*USB2.0, 16bit Iso. DIO
- Audio 1*MIC+1*LINE OUT
- 2*RS232/422/485 and 2*RS232 COM
- 1*Mini-PCIe full size with SIM card slot, support 4G LTE modem
- 1*PCIeX16+1*PCIeX16 (X4 signal) dual expansions
- 2*2.5"Easy-plug SATA3.0 bay and 1*mSATA
- DC IN 9-36V, wide power input, with OVP,OCP and SCP



Product Overview

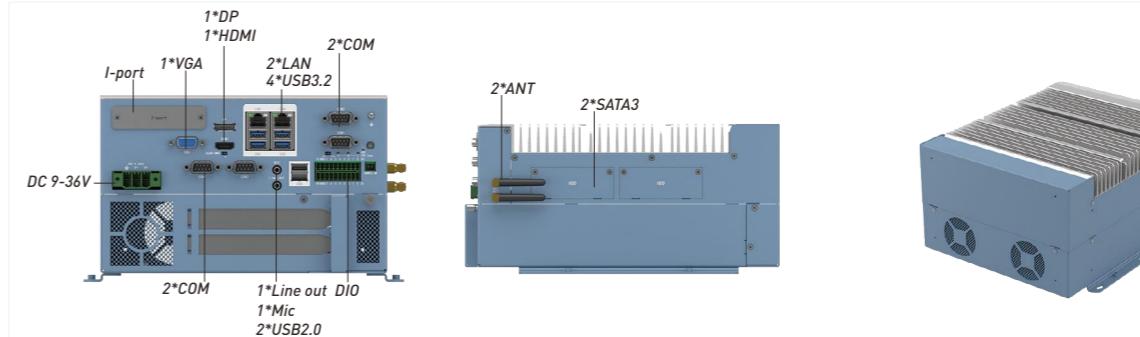
KMDA-7920 is a fanless high-performance box computer with H610 chipset, powered by Intel® 12th Gen Alder lake-S CPU, multi IO interfaces, dual PCIe extensions and moderate size. It is suitable for industrial automation, highway tolling, AI edge computing, security monitoring and environmental detection and other industries and fields.

Product Parameters

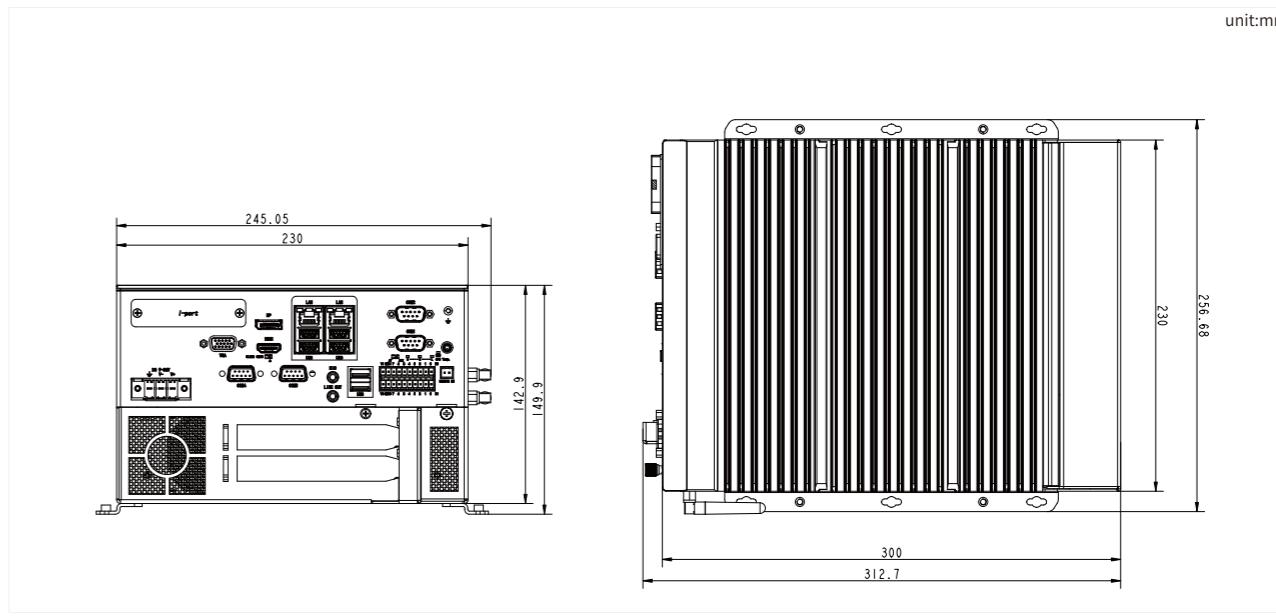
System	
CPU	Intel® Alder lake-S 12th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH
RAM	2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, 3 Independent Display
LAN	1*Intel I226V, 10-1000M,WOL; 1*Intel I219 LM, 10-1000M, WOL
USB	2* USB3.2(10G), 2*USB3.2(5G), 2*USB2.0
Display	1*DP+1*HDMI+1*VGA
Audio	1*Line out+1*MIC, Realtek ALC897
COM/Others	2*RS232/422/485, 2*RS232; 16bit Iso.DIO(8bit DI-2.5KV-PNP/NPN;8bit DO-2.5KV-200mA); 16bit non Iso.DIO(2*10pin)
DIO	
Storage	
Storage	2*2.5" SATA3.0; 1*mSATA(SATA3.0)
Others	
LED	1*PowerLED, 1*HDD LED, 3*CPU TempLED
Switch	1*Power SW, Remote SW, 1*AT/ATX SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
TCPM/TPM	Optional TPM2.0

Expansion	
Expansion	1*PCIe5.0X16(X16)+1*PCIe3.0X16(X4), GPU<150W<250mm/ AI Card<75W<280mm; or 1*PCIe5.0X16(X16)+1*32bit PCI
Power	1*Mini-PCIe(PCIeX1/USB2.0+SIM),4G LTE/PCIe module;
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Pigeon blue + White aluminum grey
Installation Dimension (W*H*D)	256.68*312.7*149.9mm
Weight	TBD
Environment	
Operating Temp	-20°C~60°C SSD, with air flow; -10°C~55°C HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~95%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)
Shock	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Certificate/EMC	CE/FCC Class A
OS	
OS	Win11, Win10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-7920/S001	Intel® Alder lake-S 12th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH	2*DDR5 SODIMM, 2*LAN, 4*USB3.2, 2*USB2.0, 4*COM, 1*VGA, 1*DP, 1*HDMI, Line out & Mic, 16bit Iso.DIO, 1*I-Port, 2*2.5"SATA bay, 1*mSATA, 1*Mini PCIe, DC 9-36V	Standard:ECX-255 1*PCIeX16(X16)+1*PCIeX16(X4) Optional:ECX-271 1*PCIeX16(X16)+1*32bit PCI

KMDA-7921

Intel® Alder Lake-S 12th Gen LGA1700 CPU, 2*LAN, 4*USB3.2, 1*VGA, 1*DP, 1*HDMI, 4*COM, 16bit DIO, 2*PCIe+2*PCI, 2*SATA3.0, DC 9-36V

Key Specification

- Intel® 12th Gen Alder lake-S LGA1700 CPU
- Intel® H610 PCH
- 2*DDR5 4800MHz SODIMM, up to 64GB
- 1*DP, 1*HDMI and 1*VGA, 3 independent displays
- 2*LAN, 4*USB3.2, 2*USB2.0, 16bit Iso. DIO
- Audio 1*MIC+1*LINE OUT
- 2*RS232/422/485 and 2*RS232 COM
- 1*Mini-PCIe full size with SIM card slot, support 4G LTE modem
- 1*PCIeX16+1*PCIeX4 (X2 signal)+2*PCI Quad expansions
- 2*2.5"Easy-plug SATA3.0 bay and 1*mSATA
- DC IN 9-36V, wide power input, with OVP,OCP and SCP



Product Overview

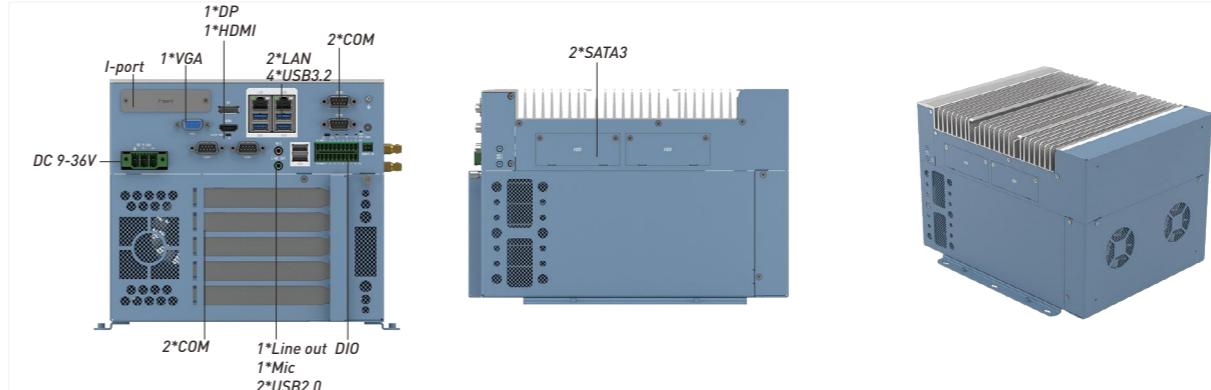
KMDA-7921 is a fanless high-performance box computer with H610 chipset, powered by Intel® 12th Gen Alder lake-S CPU, multi IO interfaces, dual PCIe dual PCI quad expansions and moderate size. It is suitable for industrial automation, highway tolling, AI edge computing, security monitoring and environmental detection and other industries and fields.

Product Parameters

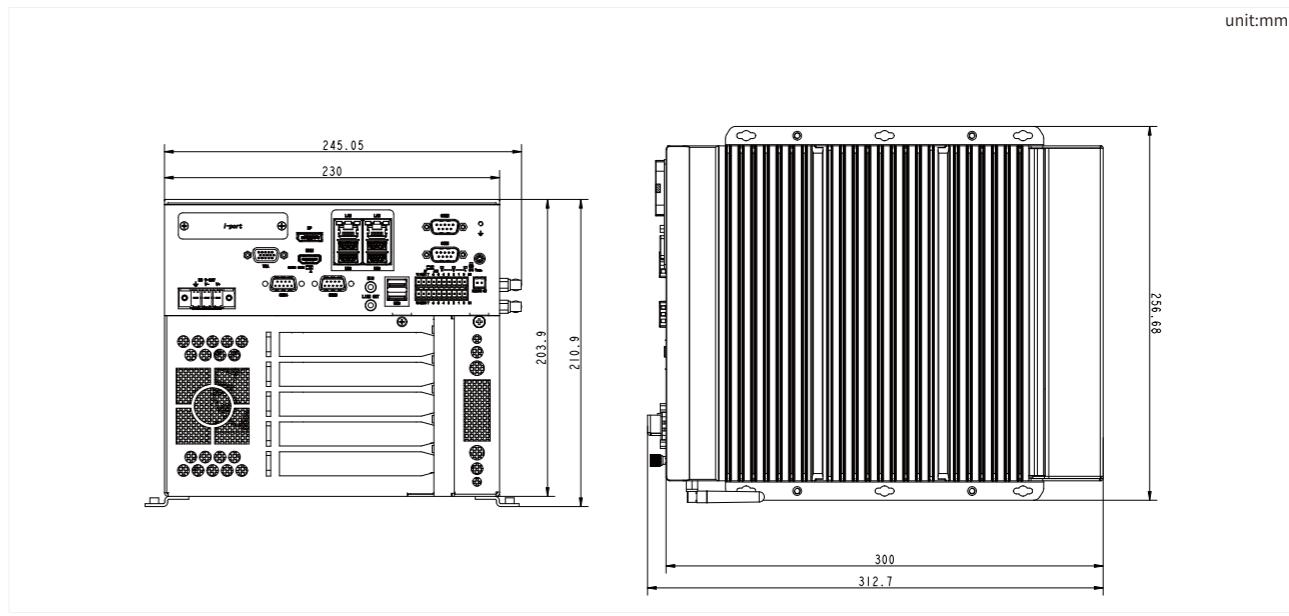
System	
CPU	Intel® Alder lake-S 12th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH
RAM	2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz, 3 independent display
LAN	1*Intel I226V, 10-1000M,WOL; 1*Intel I219 LM, 10-1000M, WOL
USB	2* USB3.2(10G), 2*USB3.2(5G), 2*USB2.0
Display	1*DP+1*HDMI+1*VGA
Audio	1*Line out+1*MIC,Realtek ALC897
COM/Others	2*RS232/422/485, 2*RS232
DIO	16bit Iso.DIO(8bit DI-2.5KV-PNP/NPN;8bit DO-2.5KV-200mA); 16bit non Iso.DIO(2*10pin)
Storage	
Storage	2*2.5" SATA3.0; 1*mSATA(SATA3.0)
Others	
LED	1*PowerLED, 1*HDD LED, 3*CPU Temp LED
Switch	1*Power SW, Remote SW, 1*AT/ATX SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
TCPM/TPM	Optional TPM2.0

Expansion	
Expansion	1*PCIe5.0X16(X16)+1*PCIe3.0X4(X2)+2*32bit PCI, GPU<150W<250mm/AI Card<75W<280mm; 1*Mini-PCIe(PcieX1/USB2.0+SIM), 4G LTE/PCIe module;
Power	
Power&TDP	DC IN 9-36V , short circuit protection, OVP&OCP TDP:TBD
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Pigeon blue + White aluminum grey
Installation Dimension (W*H*D)	256.68*312.7*210.9mm
Weight	TBD
Environment	
Operating Temp	-20°C~60°C SSD, with air flow; -10°C~55°C HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~95%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)
Shock	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Certificate/EMC	CE/FCC Class A
OS	
OS	Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Expansion
KMDA-7921/S001	Intel® Alder lake-S 12th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH	2*DDR5 SODIMM, 2*LAN, 4*USB3.2, 2*USB2.0, 4*COM, 1*VGA, 1*DP, 1*HDMI, Line out & Mic, 16bit Iso.DIO, 1*I-Port, 2*2.5"SATA bay, 1*mSATA, 1*Mini PCIe, DC 9-36V	Standard:ECX-266 1*PCIeX16(X16)+1*PCIeX4(X2) +2*32bit PCI

KMDA-2630-S

Intel® Elkhart lake CPU, VGA+HDMI, 4*LAN, 2*USB3.1, 4*COM, 8-bit DIO, Audio out + Line in + Mic, mSATA + 2.5"SATA bay

Key Specification

- Compact aluminum frame, Fanless cooling design
- Intel® Elkhart lake Celeron Soc CPU
- 1*DDR4 3200MHz SODIMM, up to 32GB
- Intel® UHD Graphics, 1*HDMI+1*VGA
- 2*Intel® I226V, up to 2.5Gbps, 2*Realtek 8111H Gig. Ethernet
- 2*USB3.1 Gen2, 6*USB2.0, Audio out + Line in + Mic
- 2*RS232, 2*RS232/422/485, 8-bit DIO
- 1*mSATA, 1*2.5"SATA bay
- DC 12V or DC 9-36V power in



Product Overview

KMDA-2630 is a ULT fan-less and compact size box computer, powered by Intel Elkhart lake SoC Celeron 4 cores or dual-core CPU, supporting 2.5G network and dual USB3.1 gen2 10G High-speed ports. It has a multy IO interface, with fanless aluminum frame, which is cabinet and delicate, and also support wide power input, so it is suitable for machine vision, AGV/ARM, self service terminal and other fields.

Product Parameters

System	
CPU	Intel® Elkhart lake SoC CPU:Celeron J6412 2.0-2.6GHz; Celeron N6210 1.2-2.6GHz
RAM	1*DDR4 SO-DIMM ,3200MHz, 32GB max.
Graphics	Intel Gen10 UHD Graphics, HW Encode: H.265/HEVC, H.264/MPEG-4 AVC, MPEG-2, JPEG/MJPEG ,VP8; HW Decode: H.265/HEVC, H.264/MPEG-4 AVC, MPEG-2, VC-1/WMV9, JPEG/MJPEG, VP8, VP9 HDMI2.0: 4096*2304@60Hz VGA: 1920*1200@60Hz
LAN	2*Intel I226V, 10M-2.5G, WOL; 2*Realtek 8111H, 10-1000M
USB	2* USB3.2 Gen2, 2*USB2.0 ,4*USB2.0(5V System, 1A)
Display	1*HDMI+1*VGA
Audio	1*Line out,Realtek ALC897
COM/Others	2*RS232/422/485, 2*RS232;
DIO	8 bitDIO(DB9)
Storage	
Storage	1*2.5" SATA3,6Gbps; 1*mSATA, AHCI
Others	
LED	1*PowerLED, 1*HDD LED, 3*CPU Temp LED
Switch	1*PowerSW, 1*Remote SW, 1*AT/ATX模式选择SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second

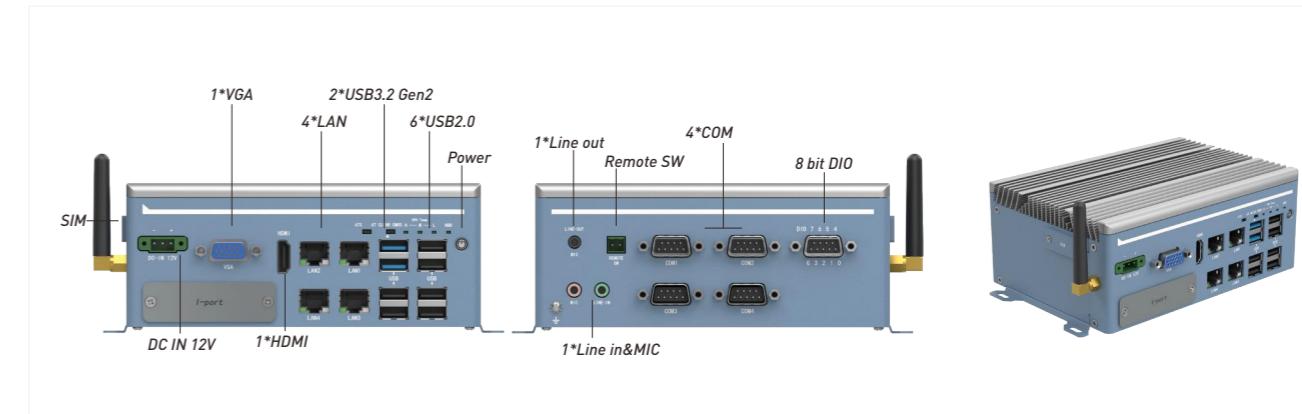
Expansion	
Expansion	1*M.2 B-key 3052(PCIe X1/USB2.0+SIM), 5G NR/4G LTE; 1*Full size Mini PCIe(PCIe X1)

Power	
Power& TDP	DC 12V or DC 9-36V, short circuit protection, OVP&OCP TDP: 26.4W (J6412 CPU/4G DDR4/64G SSD)

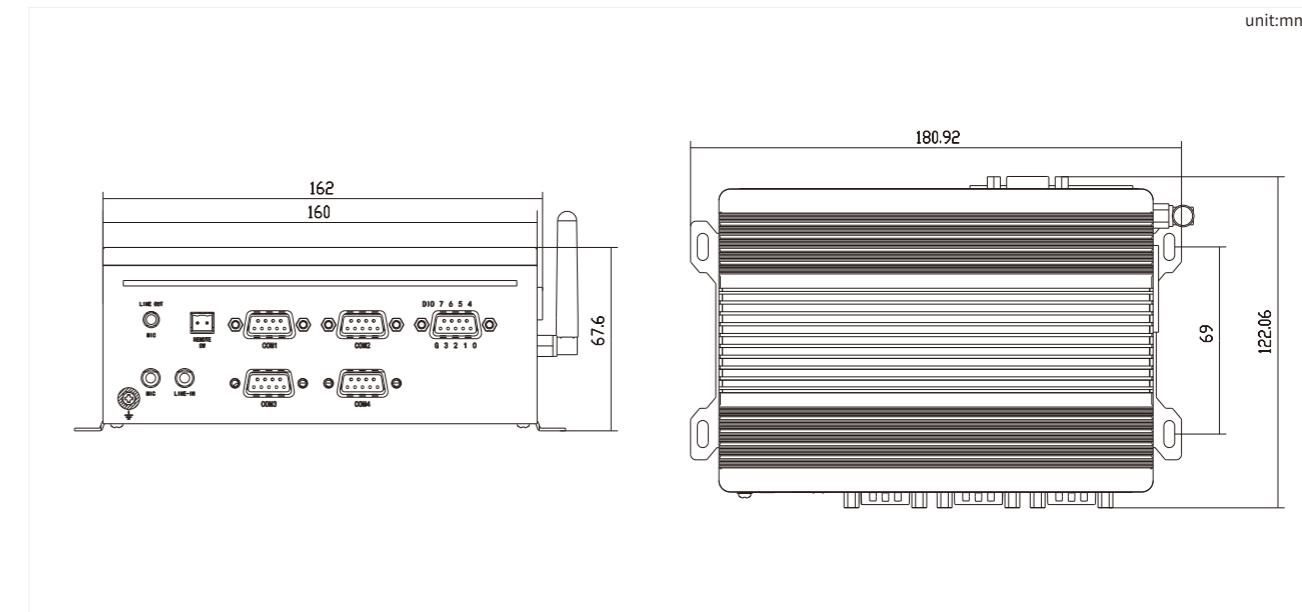
Mechanical	
Structure	Aluminum Chassis, SGCC frame
Color	Pigeon blue + White aluminum grey
Installation	desktop mounting
Dimension (W*D*H)	162*111.8*65 mm
Weight	1.32KG

Environment	
Operating Temp	-20°C~60°C, SSD, with air flow
Storage Temp	-40°C~85°C
Storage Humidity	10~95%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)
Shock	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Certificate/EMC	CE/FCC Class A
OS	
OS	Windows 10 64 bit, SUSE, Ubuntu, Wind River, Linux

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-2630/S001	Intel® Celeron J6412	1*DDR4 SODIMM, 4*LAN, 2*USB3.1, 6*USB2.0, 4*COM, 8-bit DIO, 1*M.2, 1*Mini PCIe, 1*VGA, 1*HDMI, 1*Line out + 1*Line in + 1*Mic, 1*mSATA, 1*2.5"SATA bay, I-port, DC-IN 12V
KMDA-2630/S002	Intel® Celeron N6210	
KMDA-2630/S001/WP	Intel® Celeron J6412	1*DDR4 SODIMM, 4*LAN, 2*USB3.1, 6*USB2.0, 4*COM, 8-bit DIO, 1*M.2, 1*Mini PCIe, 1*VGA, 1*HDMI, 1*Line out + 1*Line in + 1*Mic, 1*mSATA, 1*2.5"SATA bay, I-port, DC-IN 9~36V
KMDA-2630/S002/WP	Intel® Celeron N6210	
PA-60DC12		AC/DC power adapter, DC 12V/5A, 60W

KMDA-2630-T

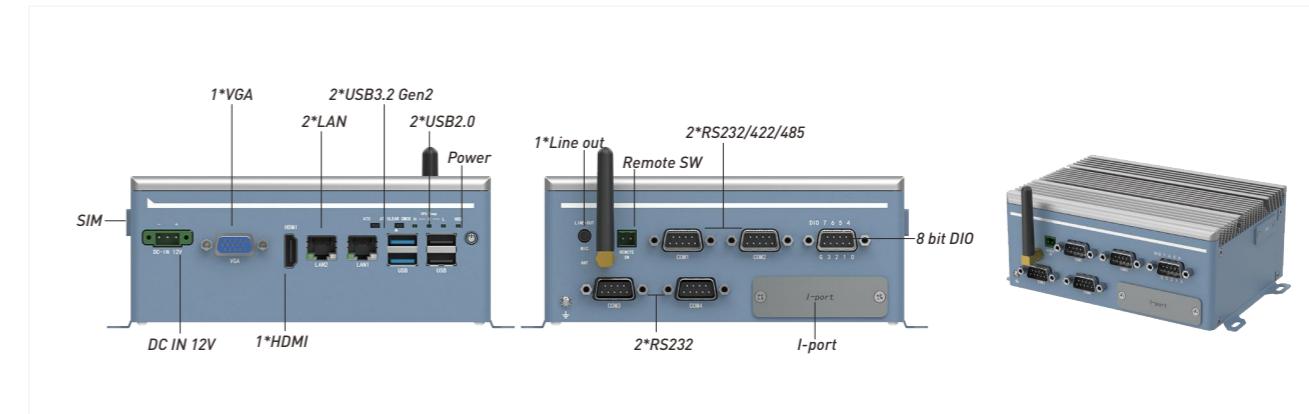
Intel® Elkhart lake CPU, VGA+HDMI, 2*2.5G-LAN, 2*USB3.1, 4*COM, 8-bit DIO, Audio out, mSATA+2.5"SATA bay

Key Specification

- Compact aluminum frame, Fanless cooling design
- Intel® Elkhart lake Celeron Soc CPU
- 1*DDR4 3200MHz SODIMM, up to 32GB
- Intel® UHD Graphics, 1*HDMI+1*VGA
- 2*Intel® I226V, up to 2.5Gbps
- 2*USB3.1 Gen2, 2*USB2.0, Audio out
- 2*RS232, 2*RS232/422/485, 8-bit DIO
- 1*mSATA, 1*2.5"SATA bay
- DC 12V or DC 9-36V power in



I/O View



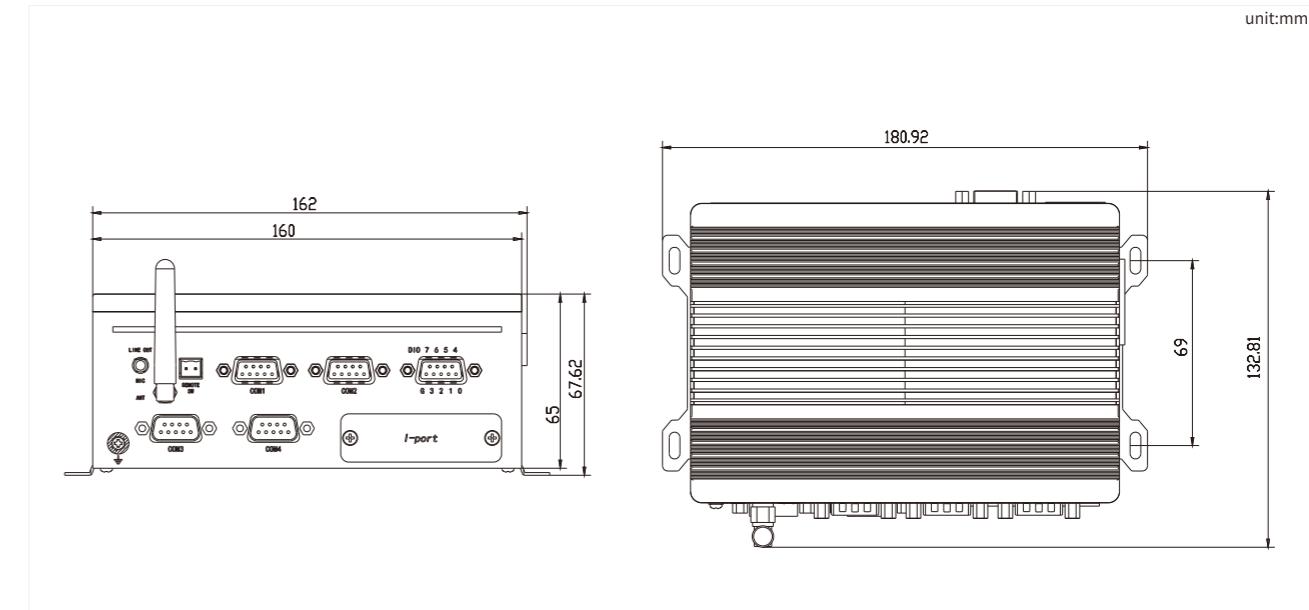
Product Overview

KMDA-2630 is a ULT fan-less and compact size box computer, powered by Intel Elkhart lake SoC Celeron 4 cores or dual-core CPU, supporting 2.5G network and dual USB3.1 gen2 10G High-speed ports. It has a multy IO interface, with fanless aluminum frame, which is cabinet and delicate, and also support wide power input, so it is suitable for machine vision, AGV/ARM, self service terminal and other fields.

Product Parameters

System	
CPU	Intel® Elkhart lake SoC CPU:Celeron J6412 2.0-2.6GHz; Celeron N6210 1.2-2.6GHz
RAM	1*DDR4 SO-DIMM ,3200MHz, 32GB max.
Graphics	Intel Gen10 UHD Graphics, HW Encode: H.265/HEVC, H.264/MPEG-4 AVC, MPEG-2, JPEG/MJPEG ,VP8; HW Decode: H.265/HEVC, H.264/MPEG-4 AVC, MPEG-2, VC-1/WMV9, JPEG/MJPEG, VP8, VP9 HDMI2.0: 4096*2304@60Hz VGA: 1920*1200@60Hz
LAN	2*Intel I226V, 10M-2.5G, WOL
USB	2* USB3.2 Gen2, 2*USB2.0
Display	1*HDMI+1*VGA
Audio	1*Line out,Realtek ALC897
COM/Others	2*RS232/422/485, 2*RS232;
DIO	8 bitDIO(DB9)
Storage	
Storage	1*2.5" SATA3,6Gbps; 1*mSATA, AHCI
Others	
LED	1*Power LED, 1*HDD LED, 3*CPU Temp LED
Switch	1*PowerSW, 1*Remote SW, 1*AT/ATX SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
OS	
OS	Windows 10 64 bit, SUSE, Ubuntu, Wind River, Linux

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-2630/T001	Intel® Celeron J6412	1*DDR4 SODIMM, 2*LAN, 2*USB3.1, 2*USB2.0, 4*COM, 8-bit DIO, 1*M.2, 1*VGA, 1*HDMI, 1*Line out, 1*mSATA, 1*2.5"SATA bay, I-port, DC-IN 12V
KMDA-2630/T002	Intel® Celeron N6210	
KMDA-2630/T001/WP	Intel® Celeron J6412	1*DDR4 SODIMM, 2*LAN, 2*USB3.1, 2*USB2.0, 4*COM, 8-bit DIO, 1*M.2, 1*VGA, 1*HDMI, 1*Line out, 1*mSATA, 1*2.5"SATA bay, I-port, DC-IN 9-36V
KMDA-2630/T002/WP	Intel® Celeron N6210	
PA-60DC12		AC/DC power adapter, DC 12V/5A, 60W

KMDA-3301

Intel® Tiger lake U Soc CPU, DP+HDMI, 3*LAN, 2*COM, 6*USB , 1*Mini PCIe, 1*mSATA, 2*M.2, support 5G NR, DC 9-36V wide power input

Key Specification

- Intel® Tiger lake U Soc CPU
- Aluminum chassis, fanless design
- 3*I226V LAN, support iAMT13.0
- 1*DP+1*HDMI, 8K+4K dual display output
- 1*Mini PCIe support Wifi/BT, 1*M.2 B-Key with SIM slot, support 5G NR
- 1*M.2 M-Key , 1*mSATA, 1*SATA3.0
- DC 9~36V, with short circuit, over voltage & over current protection
- Support desktop mounting and Din-Rail mounting



Product Overview

KMDA-3301 is a new fanless box PC, powered by Intel® Tiger lake U Soc CPU series, support Intel Boost Deep Learning technology. With shock absorption design, it is suitable for C-V2X MEC computing, AGV, machine vision and other applications.

Product Parameters

Processor

CPU	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU
Storage	2* DDR4 SO-DIMM slot, support 3200MHz, max up to 64GB
Graphics	Intel UHD Graphics or iRIS® Xe Graphics , Supports Intel Boost Deep Learning technology, DirectX12.1, OpenGL 4.6/OpenCL 2.0, HDMI 2.0: 4096x2304@60Hz, DP 1.4: 7680x4320@60Hz
LAN	3*Intel I226V, 10M/ 100M/1000M/2.5G, support iAMT 13.0
USB	2*USB3.2 Gen 2(10Gbps), 2*USB2.0, 1*USB2.0(TypeA), 1*USB2.0 (internal pinheader)
Display	1*HDMI+1*DP
Audio	1*Line out+1*Mic, Realtek ALC897
Serial Ports	2*RS232/422/485(DB9), 1*MIO(opt support built-in expansion module)
Others	1*SIM slot (on the side)
DIO	1*8-bit DIO (2*5Pin)

Storage

Storage	1*2.5" SATA bay; 1* full size mSATA, support AHCI; 1*M.2 2280 M-Key NVME(PCIe4.0 X2)
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Others

LED	1*Power LED, 1*HDD LED, 3*CPU Temp LED
Switch	1*Power SW, 1*AT/ATX SW, 1*Clear CMOS SW
WDT	Watchdog timeout programmable via software 1 to 255 second

Expansion

Expansion	1*Mini PCIe(PCle X1+USB2.0), support Wifi/BT module
	1*M.2 3052 B-Key, (PCIe X1+USB2.0+SIM), 5G NR/4G LTE

Power supply

Power	DC IN 9-36V, with short circuit protection, OVP&OCP
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Mechanical

Structure	Aluminum chassis, SGCC
Color	Blue+white
Mounting Dimension (L*W*H)	Desktop mounting, optional Din-Rail mounting
Weight	250*154*61.9mm 2.55KG

Environment

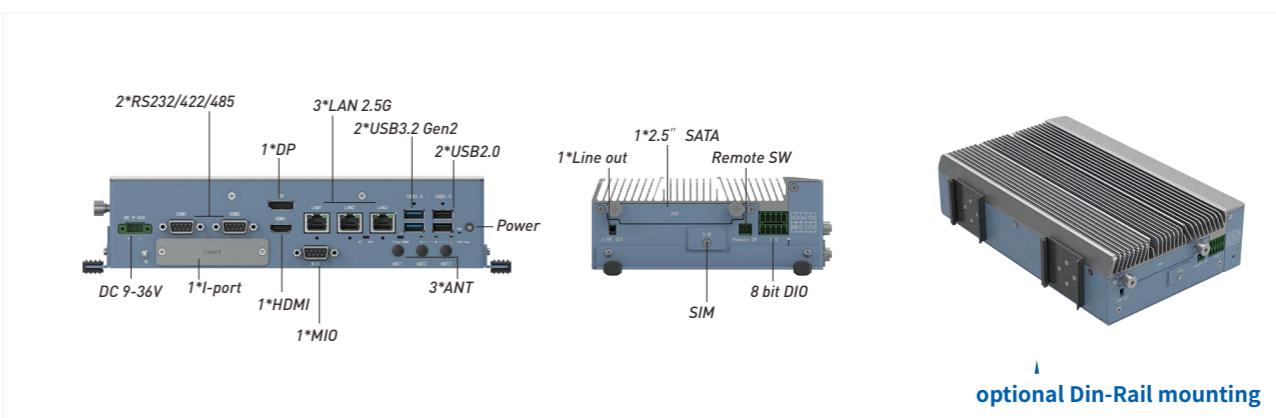
Operating Temp	-20°C~65°C, wide temp SSD, airflow;
Storage Temp	-40°C~85°C

Storage Humidity	10~90%@40°C, non-condensing
Vibration	5 grms/5~500Hz/random/during operation(SSD); 1 grms/5~500Hz/random/during operation(HDD)

Shock	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)
Certificates/ EMC	CE/FCC Class A

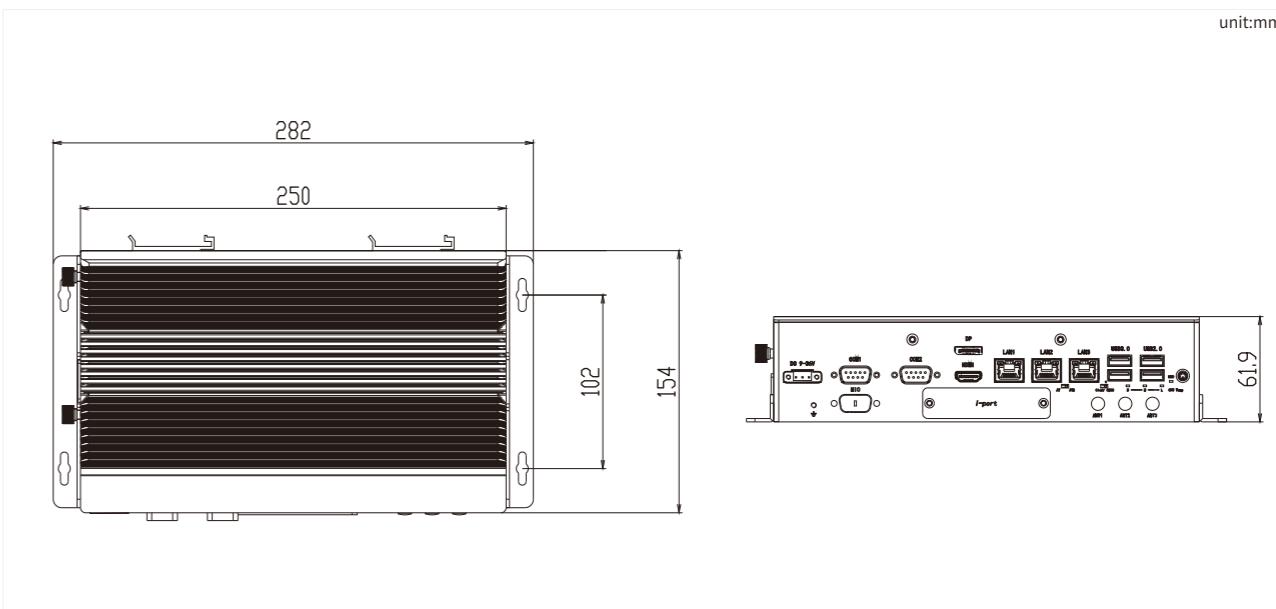
OS	Windows 10 64 bit, SUSE, Ubuntu, Wind River, Linux
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I/O View



optional Din-Rail mounting

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-3301-S001	Intel® Core i3-1115G4	
KMDA-3301-S002	Intel® Core i5-1135G7	2*DDR4 SODIMM, 3*2.5G-LAN, 2*USB3.2, 4*USB2.0, 2*COM, 8-bit DIO, 1*DP, 1*HDMI, Realtek ALC662VD out & Mic, 1*Mini PCIe, 1*M.2 B-key, 1*M.2 M-Key, 1*MIO, 1*I-Port, 1*mSATA, 1*2.5"SATA bay, DC-IN 9-36V
KMDA-3301-S003	Intel® Core i7-1165G7	
KMDA-3301-S004	Intel® Celeron 6305E	
PA-60DC12		AC/DC power adapter, DC 12V/5A 60W

KMDA-3302

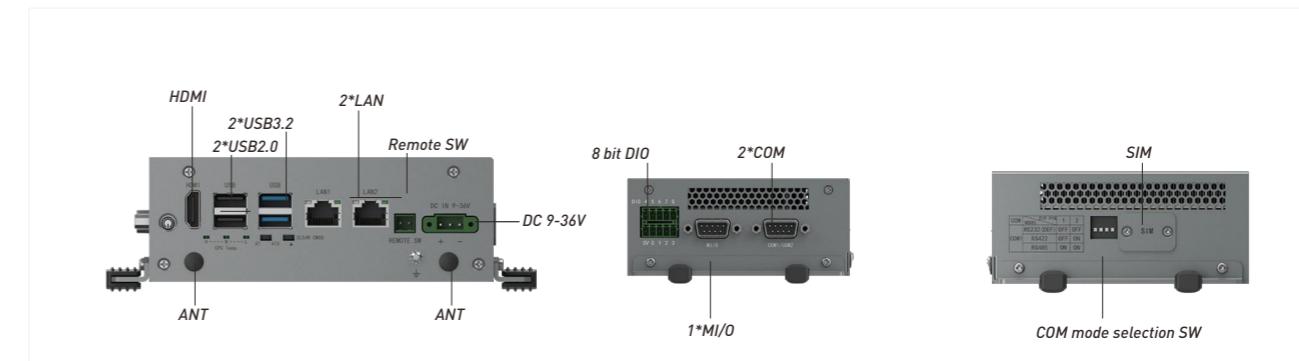
Intel® Tiger lake U Soc CPU, HDMI, 2*LAN, 2*COM, 8bit DIO, 4*USB ,1*Mini PCIe, 1*mSATA, 1*M.2 B-Key, 1*M.2 E-Key, DC 9-36V

Key Specification

- Intel® Tiger lake U Soc CPU
- SGCC box design, 4-wire speed control fan for heat dissipation
- 1*DDR4 3200MHz SODIMM, up to 32GB
- 1*HDMI 4K display output
- 2*I210AT Gigabit Ethernet port, 2*USB3.2, 2*USB2.0
- 8bit DIO, 1*RS232/422/485, 1*RS232
- 1*M.2 2230 E-Key, WiFi/BT
- 1*M.2 B-Key, with SIM card slot, 5G NR
- 1*Mini PCIe, CAN, optional switch to mSATA
- 1* Full Size mSATA for storage
- DC 9~36V, with OVP, OCP, SCP



I/O View



Product Overview

KMDA-3302 is a high-performance, small volume, and compact embedded box computer, designed with an SGCC box structure and equipped with a 4-wire speed control fan for heat dissipation. Powered by Intel® Tiger lake U Soc series CPU, with rich IO functions, slim body, anti-vibration design, suitable for mobile portable terminals, advertising machines, logistics visual inspection, AGV, AMR and other application scenarios.

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Product Parameters

System	
CPU	Intel® Tiger lake U Soc CPU (core i3-1115G4/i5-1135G7/i7-1165G7, Celeron 6305E), TDP 12W/15W/28W
RAM	1*DDR4 SO-DIMM, 3200MHz, 32GB max.
Graphics	Intel UHD Graphics/ Iris® Xe Graphics, DirectX12.1, OpenGL 4.6 and OpenCL 3.0, HDMI: 4096x2304@60Hz
LAN	2*Intel I210AT, 10M-1000M, WOL
USB	2*USB3.2 Gen 2; 2*USB2.0
Display	1*HDMI
Audio	/
COM/ Others	2*COM(RS232/422/485+RS232); 1*MIO(Opt.CAN/moudle); 1*SIM
DIO	1*8-bit DIO (2*5Pin)
Storage	
Storage	2*mSATA, SATA6.0;
Others	
LED	1*Power LED, 3*CPU Temp. LED
Switch	1*Power SW, 1*Remote SW, 1*AT/ATX SW, 1*Clear CMOS SW
WDT	programmable via software 1 to 255 second
OS	Windows 11*IoT enterprise, Windows 10*IoT enterprise, Android, SUSE, Ubuntu, Wind River, Red Hat*Enterprise, Wind River VxWorks*7, Yocto

Expansion

- 1*Mini PCIe(PCle X1+USB2.0), CAN2.0/mSATA;
- Expansion 1*M.2 3042/3052 B-Key(PCleX1/USB2.0+SIM), 5G NR/4G LTE;
- 1*M.2 2230 E-Key(PCleX1+USB2.0), WIFI/BT;

Power Supply

- Power& DC IN 9~36V, 3pin, with OVP,OCP,SCP;
- TDP 37.2W (Intel Core i7-1165G7 CPU, 4G DDR4 Ram, 64G SSD)

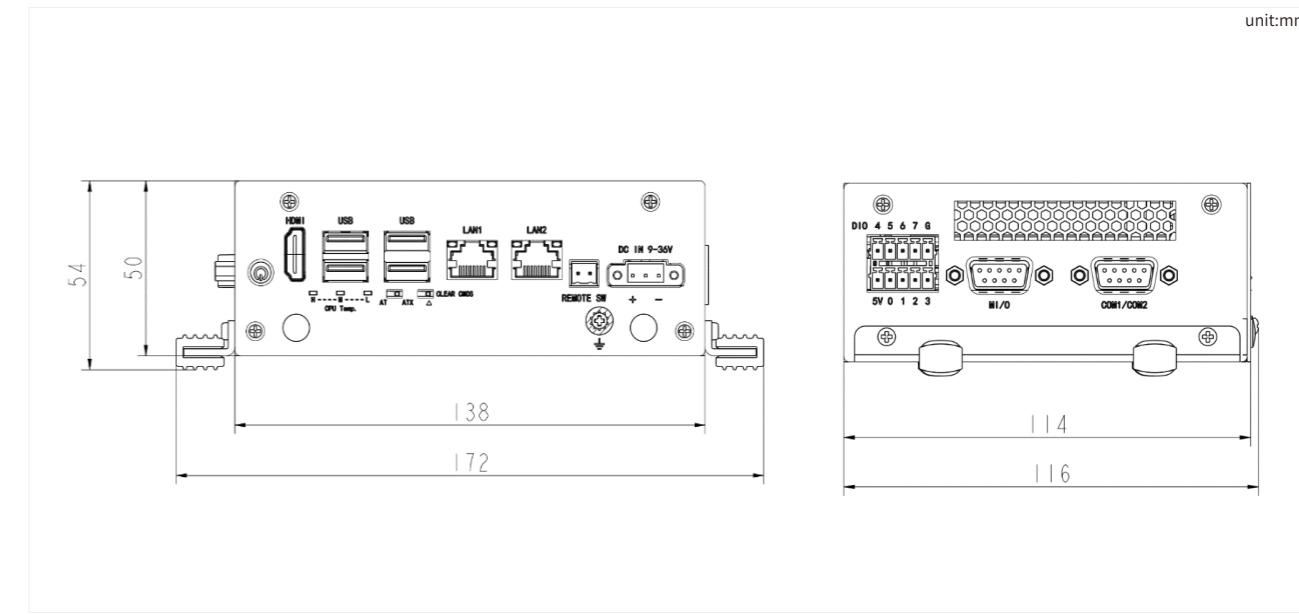
Mechanical

- Structure SGCC chassis
- Color Silver Gray
- Installation Desk mounting with anti-vibration non-slip foot pads, opt Din-Rail
- Dimension(W*H*D) 172*116*54mm
- Weight 0.89KG

Environment

- Operating Temp -20°C~60°C, SSD, airflow;
- Storage Temp -40°C~85°C
- Storage Humidity 10~95%@40°C, Non-condensing
- Vibration 5 grms/5~500Hz/random/during operation (SSD)
1 grms/5~500Hz/random/during operation (HDD)
- Shock 50g peak acceleration(duration 11ms) with SSD;
20g peak acceleration(duration 11ms) with HDD
- Certificate/EMC CE/FCC Class A

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-3302-S001	Intel® Core I3-1115G4	
KMDA-3302-S002	Intel® Core I5-1135G7	1*DDR4 SODIMM, 2*LAN, 2*USB3.2, 2*USB2.0, 2*COM, 8bit DIO, 1*HDMI, 1*Mini PCIe, 1*M.2 B-key, 1*M.2 E-Key, 1*MIO, 1*mSATA, DC-IN 9-36V
KMDA-3302-S003	Intel® Core I7-1165G7	
KMDA-3302-S004	Intel® Celeron 6305E	
PA-60DC12		AC/DC power adapter, DC 12V/5A 60W + X Standard Power Cable

KMDA-5611-S001

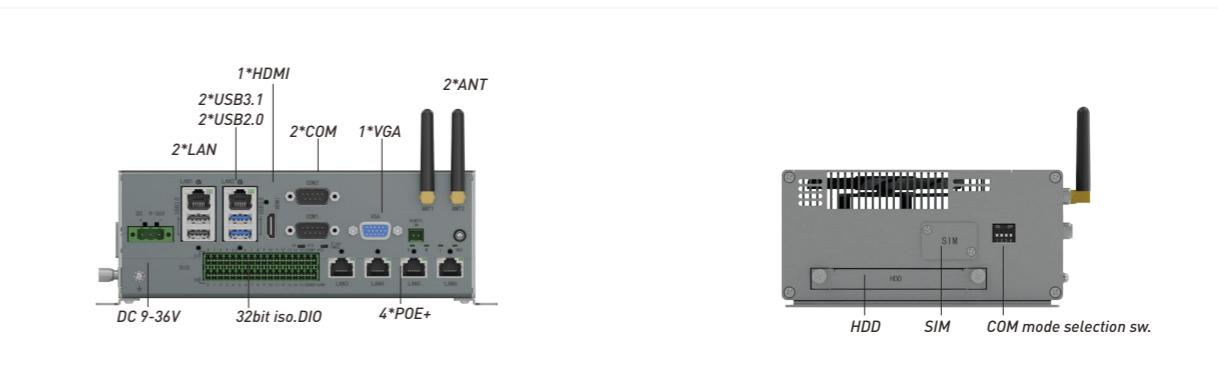
Intel® 8/9th Gen Coffee Lake LGA1151 CPU, 2*LAN, 4*POE+, 2*USB3.1, 3*USB2.0, 1*HDMI, 1*VGA, 2*COM, 32bit Iso. DIO, 1*mSATA, 1*Mini PCIe, 1*SATA3.0, DC 9-36V

Key Specification

- Intel® 8/9th Gen Coffee Lake LGA1151 CPU
- Intel® H310 Chipset
- 2*DDR4 2400/2666MHz SODIMM, up to 64GB
- 1*HDMI + 1*VGA
- 2*LAN, 4*POE+, 2*USB3.1, 3*USB2.0, 32bit Iso. DIO
- 1*RS232/485 and 1*RS232 COM
- 1*Mini-PCIe full size, with SIM card slot, 4G/WIFI/PCIe module
- 1*2.5"Easy-plug SATA3.0 bay and 1*mSATA
- DC IN 9-36V, with OVP,OCP and SCP



I/O View



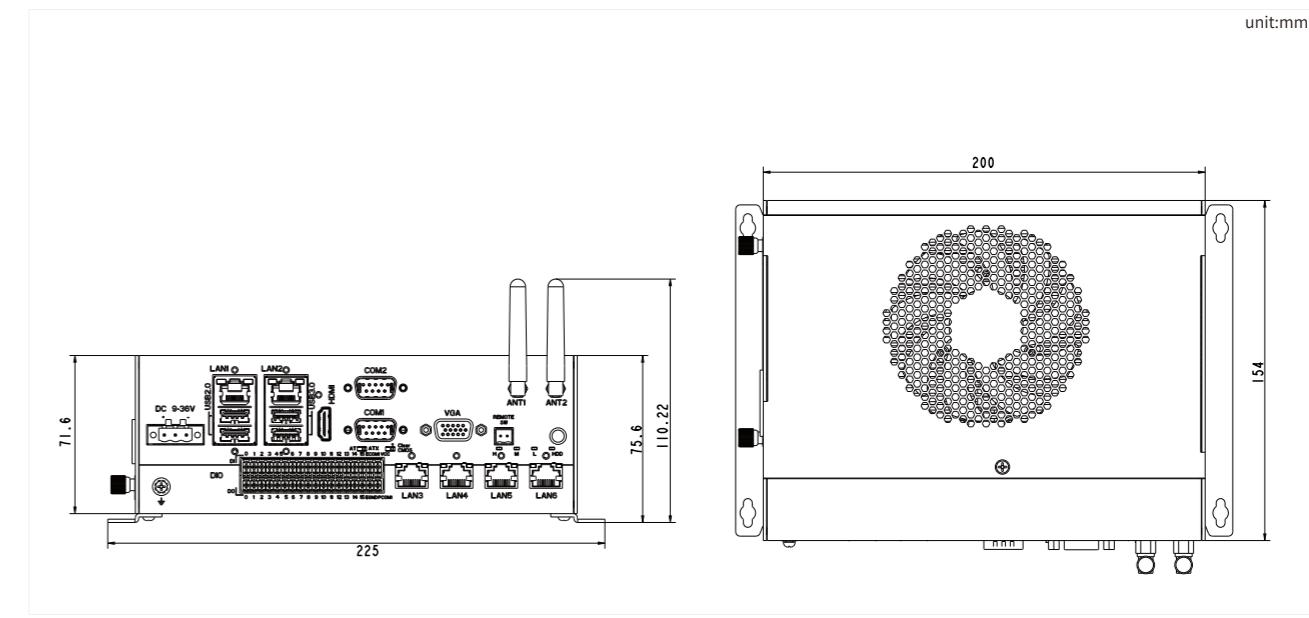
Product Overview

KMDA-5611-S001 is a high-performance box computer with H310 chipset, powered by Intel® 8/9th Gen Coffee Lake CPU, multi IO interfaces and moderate size. It is suitable for machine vision and industrial control and other industries and fields.

Product Parameters

System	
CPU	Intel® Coffee lake 9th/8th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1151 CPU, up to 65W, Intel® H310 PCH
RAM	2*260-Pin SODIMM, DDR4 2666/2400MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX11.1, OpenGL5.0, OpenCL 2.1; HDMI:4096*2160@24Hz, VGA:1920*1200@60Hz
LAN	4*Intel I210AT POE+, 10-1000M,WOL; 1*Intel I210AT+1*Intel I219 LM, 10-1000M, WOL
USB	2* USB3.2(5G), 2*USB2.0, 1*USB2.0(built-in)
Display	1*HDMI+1*VGA
Audio	/
COM/Others	1*RS232/485, 1*RS232;
DIO	32 bit iso. DIO(16bit DI-2.5KV-PNP/NPN;16bit DO-2.5KV);
Storage	
Storage	1*2.5" SATA3.0,6Gbps; 1*mSATA(SATA3.0),6Gbps
Others	
LED	1*Power LED, 1*HDD LED, 3*CPU Temp. LED
Switch	1*Power SW, Remote SW,1*AT/ATX SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
TPM	(Opt.)TPM2.0
OS	
OS	Windows 10 Enterprise & IOT Enterprise (64 位) (CFL-R) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R) Wind River VxWorks 7 (CFL-R)

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-5611/S001	Intel® 8/9th Gen Coffee Lake LGA1151 CPU, H310 PCH	2*DDR4 SODIMM, 2*LAN, 4*POE+, 2*USB3.1, 3*USB2.0, 2*COM, 1*HDMI, 1*VGA, 32bit Iso. DIO, 1*2.5" SATA bay, 1*mSATA, 1*Mini PCIe, 1*SIM card slot, DC 9-36V
PA-120DC19		AC/DC power adapter, DC 19V/6.32A,120W

KMDA-5611-S002

Intel® 8/9th Gen Coffee Lake LGA1151 CPU, 2*LAN, 2*USB3.1, 8*USB3.0, 3*USB2.0, 1*HDMI, 1*VGA, 2*COM, 32bit Iso. DIO, 1*mSATA, 1*Mini PCIe, 1*SATA3.0, DC 9-36V

Key Specification

- Intel® 8/9th Gen Coffee Lake LGA1151 CPU
- Intel® H310 Chipset
- 2*DDR4 2400/2666MHz SODIMM, up to 64GB
- 1*HDMI + 1*VGA
- 2*LAN, 2*USB3.1, 8*USB3.0, 3*USB2.0, 32bit Iso. DIO
- 1*RS232/485 and 1*RS232 COM
- 1*Mini-PCIe full size, with SIM card slot, 4G/WIFI/PCIe module
- 1*2.5"Easy-plug SATA3.0 bay and 1*mSATA
- DC IN 9-36V, with OVP,OCP and SCP



Product Overview

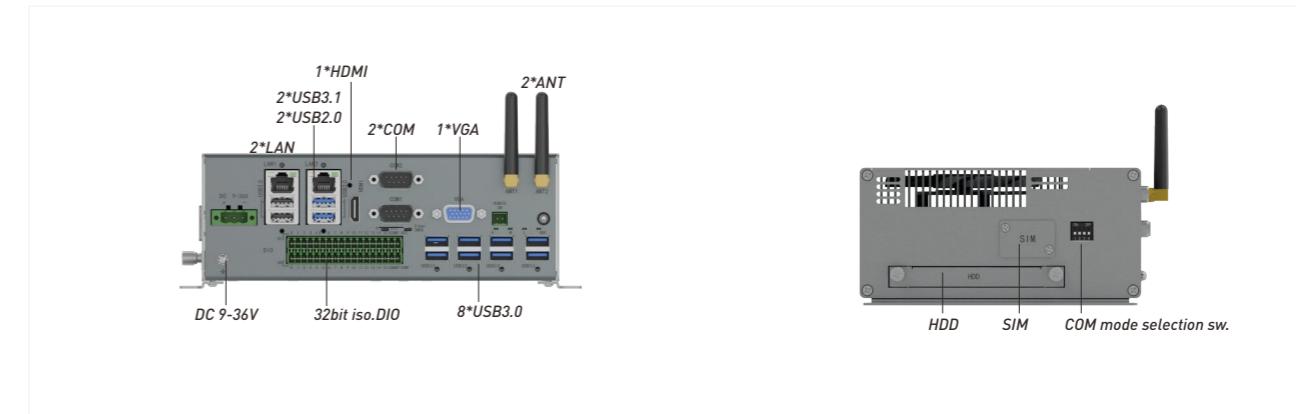
KMDA-5611-S002 is a high-performance box computer with H310 chipset, powered by Intel® 8/9th Gen Coffee Lake CPU, multi IO interfaces and moderate size. It is suitable for machine vision and industrial control and other industries and fields.

Product Parameters

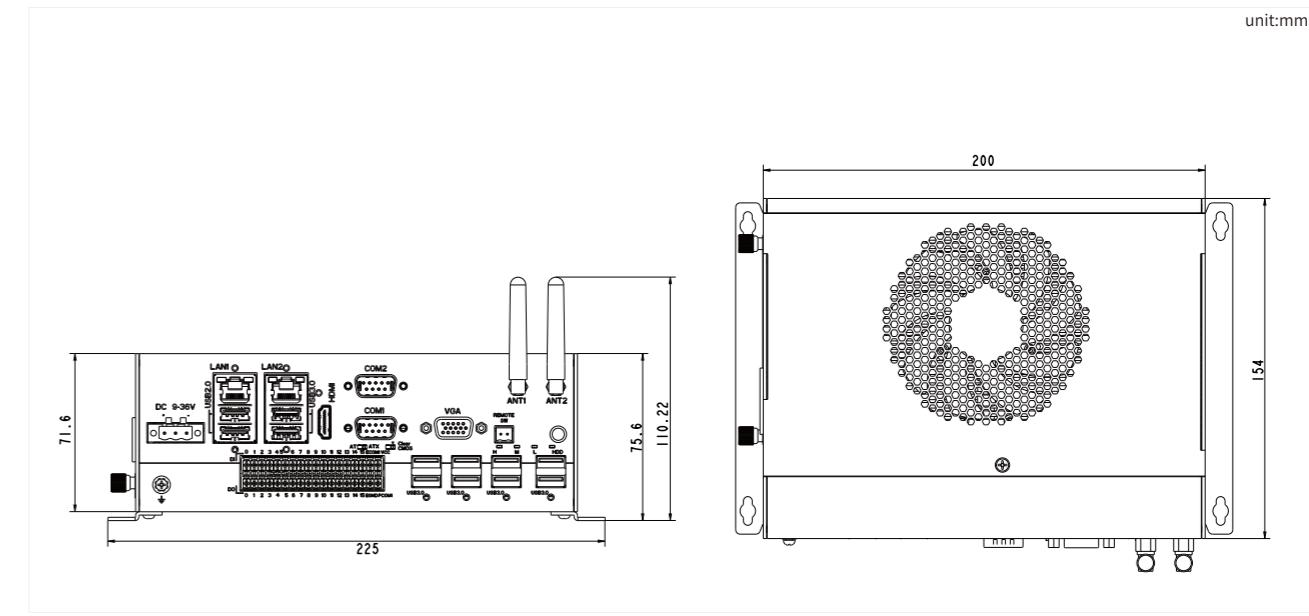
System	
CPU	Intel® Coffee lake 9th/8th-Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1151 CPU, up to 65W, Intel® H310 PCH
RAM	2*260-Pin SODIMM, DDR4 2666/2400MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX11.1, OpenGL5.0, OpenCL 2.1; HDMI:4096*2160@24Hz, VGA:1920*1200@60Hz
LAN	1*Intel I210AT, 10-1000M,WOL; 1*Intel I219 LM, 10-1000M, WOL
USB	8* USB3.0, 2*USB3.1(5G), 2*USB2.0, 1*USB2.0(built-in)
Display	1*HDMI+1*VGA
Audio	/
COM/Others	1*RS232/485, 1*RS232;
DIO	32 bit iso. DIO(16bit DI-2.5KV-PNP/NPN;16bit DO-2.5KV);
Storage	
Storage	1*2.5" SATA3.0,6Gbps; 1*mSATA(SATA3.0),6Gbps
Others	
LED	1*Power LED, 1*HDD LED, 3*CPU Temp. LED
Switch	1*Power SW, Remote SW,1*AT/ATX SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
TPM	(Opt.)TPM2.0
OS	
OS	Windows 10 Enterprise & IOT Enterprise (64 位) (CFL-R) Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R) Wind River VxWorks 7 (CFL-R)

Expansion	
Expansion	1*Mini-PCIe(+SIM),4G/WIFI/PCIe module
Power	
Power&TDP	DC IN 9-36V 3-pin Term. 5.0mm, OVP&OCP&SCP; TBD
Mechanical	
Structure	Aluminum-magnesium alloy, SGCC frame
Color	Silver Gray
Installation	Desktop Mounting/Wall(opt.), DIN-Rail(opt.)
Dimension	225*154*75.6mm
Weight	TBD
Environment	
Operating Temp	-20°C~60°C – SSD, air flow; -10°C~55°C – HDD, air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~95%@40°C, Non-condensing
Vibration	5grms/5~500Hz/random/in working(SSD); 1grms/5~500Hz/random/in working(HDD)
Shock	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)
Certificate/EMC	CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-5611/S002	Intel® 8/9th Gen Coffee Lake LGA1151 CPU, H310 PCH	2*DDR4 SODIMM, 2*LAN, 2*USB3.1, 8*USB3.0, 3*USB2.0, 2*COM, 1*HDMI, 1*VGA, 32bit Iso. DIO, 1*2.5"SATA bay, 1*mSATA, 1*Mini PCIe, 1*SIM card slot, DC 9-36V
PA-120DC19		AC/DC power adapter, DC 19V/6.32A,120W

KMDA-6611-S001

Intel® 10th Gen Comet Lake LGA1200 CPU, 2*LAN, 4*POE+, 2*USB3.2, 3*USB2.0, 1*HDMI, 1*VGA, 2*COM, 32bit Iso. DIO, 1*mSATA, 1*Mini PCIe, 1*SATA3.0, DC 9-36V

Key Specification

- Intel® 10th Gen Comet Lake LGA1200 CPU
- Intel® H420E Chipset
- 2*DDR4 2933MHz SODIMM, up to 64GB
- 1*HDMI + 1*VGA
- 2*LAN, 4*POE+, 2*USB3.2, 3*USB2.0, 32bit Iso. DIO
- 1*RS232/485 and 1*RS232 COM
- 1*Mini-PCIe full size, with SIM card slot, 4G/WIFI/PCIe module
- 1*2.5"Easy-plug SATA3.0 bay and 1*mSATA
- DC IN 9-36V, with OVP,OCP and SCP



I/O View



Product Overview

KMDA-6611-S001 is a high-performance box computer with H420E chipset, powered by Intel® 10th Gen Comet Lake CPU, multi IO interfaces and moderate size. It is suitable for machine vision and industrial control and other industries and fields.

Product Parameters

System	
CPU	Intel® Comet lake 10th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU, up to 65W, Intel® H420E PCH
RAM	2*260-Pin SODIMM, DDR4 2933MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX12, OpenGL4.5; HDMI:4096*2160@30Hz, VGA:1920*1200@60Hz
LAN	4*Intel I210AT POE+, 10-1000M,WOL; 1*Intel I210AT+1*Intel I219 LM, 10-1000M, WOL
USB	2* USB3.2(5G), 2*USB2.0, 1*USB2.0(built-in)
Display	1*HDMI+1*VGA
Audio	/
COM/Others	1*RS232/485, 1*RS232;
DIO	32 bit iso. DIO(16bit DI-2.5KV-PNP/NPN;16bit DO-2.5KV);
Storage	
Storage	1*2.5" SATA3.0,6Gbps; 1*mSATA(SATA3.0),6Gbps
Others	
LED	1*Power LED, 1*HDD LED, 3*CPU Temp. LED
Switch	1*Power SW, Remote SW,1*AT/ATX SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
TPM	(Opt.)TPM2.0
OS	
OS	Windows11, Windows 10 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7

Expansion

Expansion 1*Mini-PCIe(+SIM),4G/WIFI/PCIe module

Power

Power& TDP DC IN 9-36V 3-pin Term. 5.0mm, OVP&OCP&SCP; TBD

Mechanical

Structure Aluminum-magnesium alloy, SGCC frame

Color Silver Gray

Installation Desktop Mounting/Wall(opt.), DIN-Rail(opt.)

Dimension 225*154*75.6mm

Weight TBD

Environment

Operating Temp -20°C~60°C – SSD, air flow;

-10°C~55°C – HDD, air flow;

Storage Temp -40°C~85°C

Storage Humidity 10~95%@40°C, Non-condensing

Vibration 5grms/5~500Hz/random/in working(SSD);

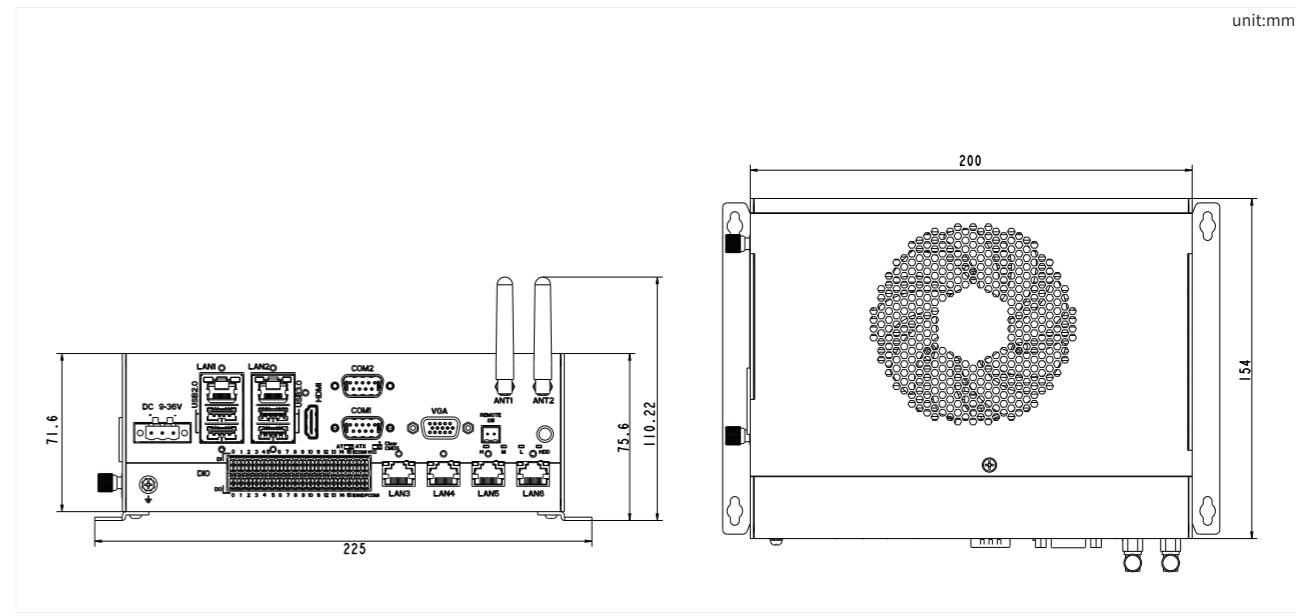
1grms/5~500Hz/random/in working(HDD)

Shock 50g peak acceleration(11ms duration)(SSD);

20g peak acceleration(11ms duration)(HDD)

Certificate/EMC CE/FCC Class A

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-6611/S001	Intel® 10th Gen Comet Lake LGA1200 CPU, H420E PCH	2*DDR4 SODIMM, 2*LAN, 4*POE+, 2*USB3.2, 3*USB2.0, 2*COM, 1*HDMI, 1*VGA, 32bit Iso. DIO, 1*2.5"SATA bay, 1*mSATA, 1*Mini PCIe, 1*SIM card slot, DC 9-36V
PA-120DC19		AC/DC power adapter, DC 19V/6.32A,120W

KMDA-6611-S002

Intel® 10th Gen Comet Lake LGA1200 CPU, 2*LAN, 2*USB3.1, 8*USB3.0, 3*USB2.0, 1*HDMI, 1*VGA, 2*COM, 32bit Iso. DIO, 1*mSATA, 1*Mini PCIe, 1*SATA3.0, DC 9-36V

Key Specification

- Intel® 10th Gen Comet Lake LGA1200 CPU
- Intel® H420E Chipset
- 2*DDR4 2933MHz SODIMM, up to 64GB
- 1*HDMI + 1*VGA
- 2*LAN, 2*USB3.1, 8*USB3.0, 3*USB2.0, 32bit Iso. DIO
- 1*RS232/485 and 1*RS232 COM
- 1*Mini-PCIe full size, with SIM card slot, 4G/WIFI/PCIe module
- 1*2.5"Easy-plug SATA3.0 bay and 1*mSATA
- DC IN 9-36V, with OVP,OCP and SCP



Product Overview

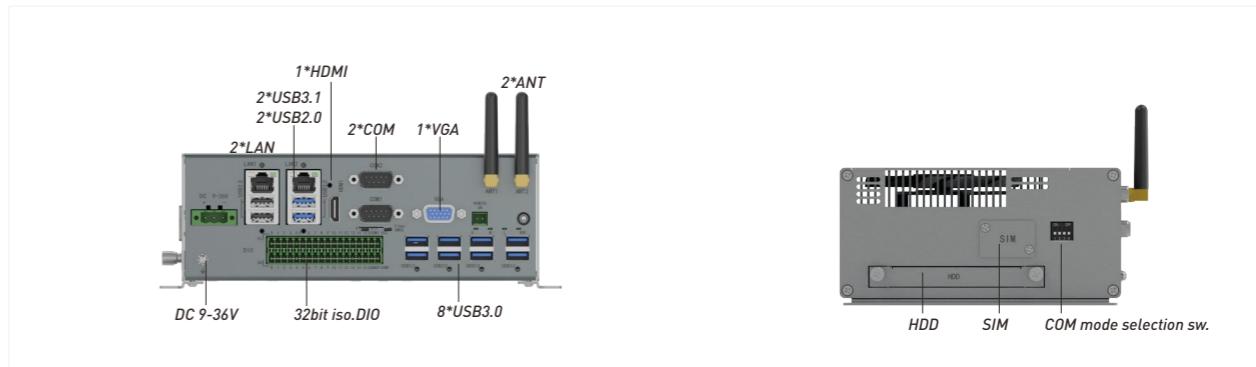
KMDA-6611-S002 is a high-performance box computer with H420E chipset, powered by Intel® 10th Gen Comet Lake CPU, multi IO interfaces and moderate size. It is suitable for machine vision and industrial control and other industries and fields.

Product Parameters

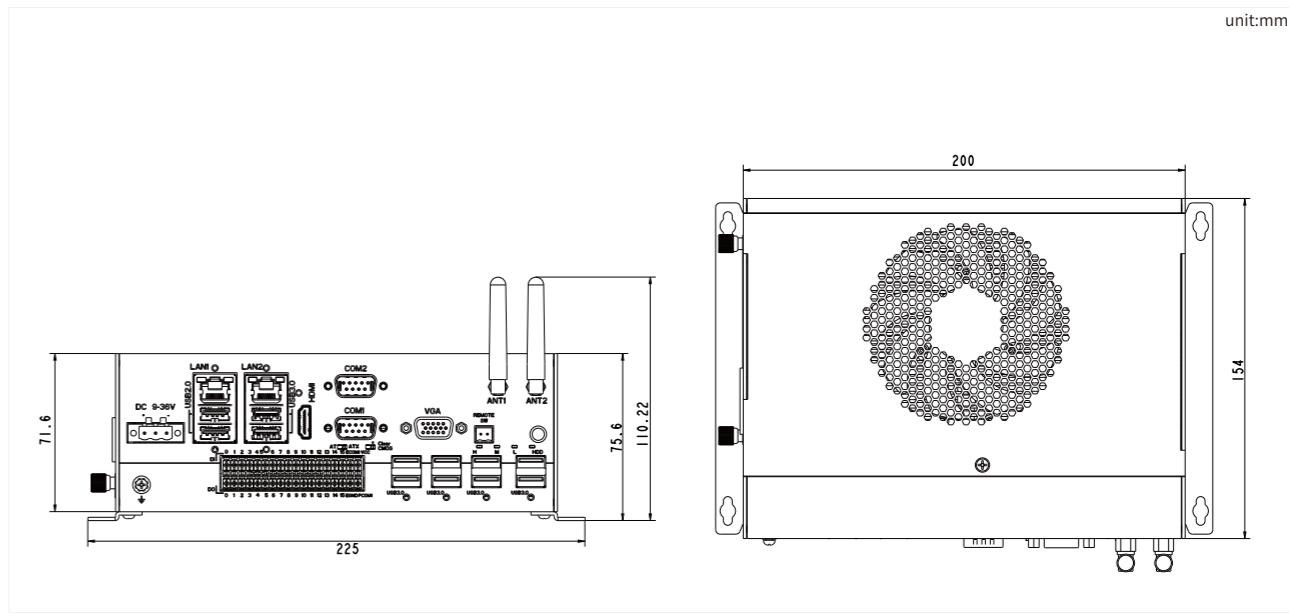
System	
CPU	Intel® Comet lake 10th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU, up to 65W, Intel® H420E PCH
RAM	2*260-Pin SODIMM, DDR4 2933MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX12, OpenGL4.5; HDMI:4096*2160@30Hz, VGA:1920*1200@60Hz
LAN	1*Intel I210AT, 10-1000M,WOL; 1*Intel I219 LM, 10-1000M, WOL
USB	8*USB3.0, 2*USB3.1(5G), 2*USB2.0, 1*USB2.0(built-in)
Display	1*HDMI+1*VGA
Audio	/
COM/Others	1*RS232/485, 1*RS232;
DIO	32 bit iso. DIO(16bit DI-2.5KV-PNP/NPN;16bit DO-2.5KV);
Storage	
Storage	1*2.5" SATA3.0,6Gbps; 1*mSATA(SATA3.0),6Gbps
Others	
LED	1*Power LED, 1*HDD LED, 3*CPU Temp. LED
Switch	1*Power SW, Remote SW,1*AT/ATX SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
TPM	(Opt.)TPM2.0
OS	
OS	Windows11, Windows 10 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7

Expansion	
Expansion	1*Mini-PCIe(+SIM),4G/WIFI/PCIe module
Power	
Power&TDP	DC IN 9-36V 3-pin Term. 5.0mm, OVP&OCP&SCP; TBD
Mechanical	
Structure	Aluminum-magnesium alloy, SGCC frame
Color	Silver Gray
Installation	Desktop Mounting/Wall(opt.), DIN-Rail(opt.)
Dimension	225*154*75.6mm
Weight	TBD
Environment	
Operating Temp	-20°C~60°C – SSD, air flow; -10°C~55°C – HDD, air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~95%@40°C, Non-condensing
Vibration	5grms/5~500Hz/random/in working(SSD); 1grms/5~500Hz/random/in working(HDD)
Shock	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)
Certificate/EMC	CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-6611/S002	Intel® 10th Gen Comet Lake LGA1200 CPU, H420E PCH	2*DDR4 SODIMM, 2*LAN, 2*USB3.1, 8*USB3.0, 3*USB2.0, 2*COM, 1*HDMI, 1*VGA, 32bit Iso. DIO, 1*2.5"SATA bay, 1*mSATA, 1*Mini PCIe, 1*SIM card slot, DC 9-36V
PA-120DC19		AC/DC power adapter, DC 19V/6.32A,120W

KMDA-7611-S

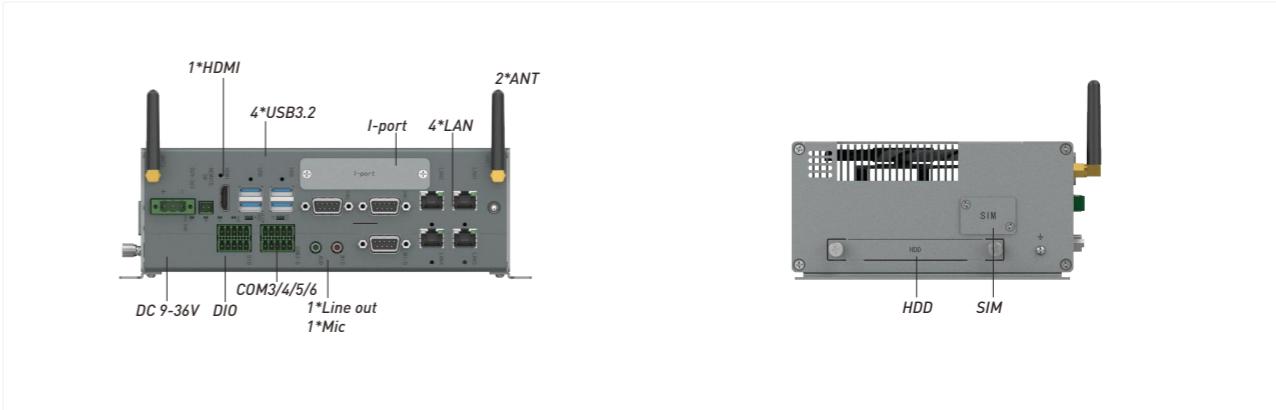
Intel® 12/13 Gen Alder Lake-S/Raptor Lake-S LGA1700 CPU, 4*LAN, 4*USB3.2, 1*HDMI, 6*COM, 8bit DIO, 1*mSATA, 2*Mini PCIe, 1*M.2 B-Key, 1*SATA3.0, DC 9-36V.

Key Specification

- Intel® 12/13th Gen Alder lake-S/Raptor Lake-S LGA1700 CPU
- Intel® H610 Chipset
- 2*DDR5 4800MHz SODIMM, up to 64GB
- 1*HDMI
- 4*LAN, 4*USB3.2, 1*USB2.0, 8bit Iso. DIO
- 1*MIC+1*LINE OUT
- 2*RS232/422/485 and 4*RS232 COM
- 2*Mini PCIe full size, function module that supports PCIe signals
- 1*M.2 3052/3042 B-Key with a SIM card slot, supports 5G NR module
- 1*2.5"Easy-plug SATA3.0 bay and 1*mSATA
- DC IN 9-36V, with OVP,OCP and SCP



I/O View



Product Overview

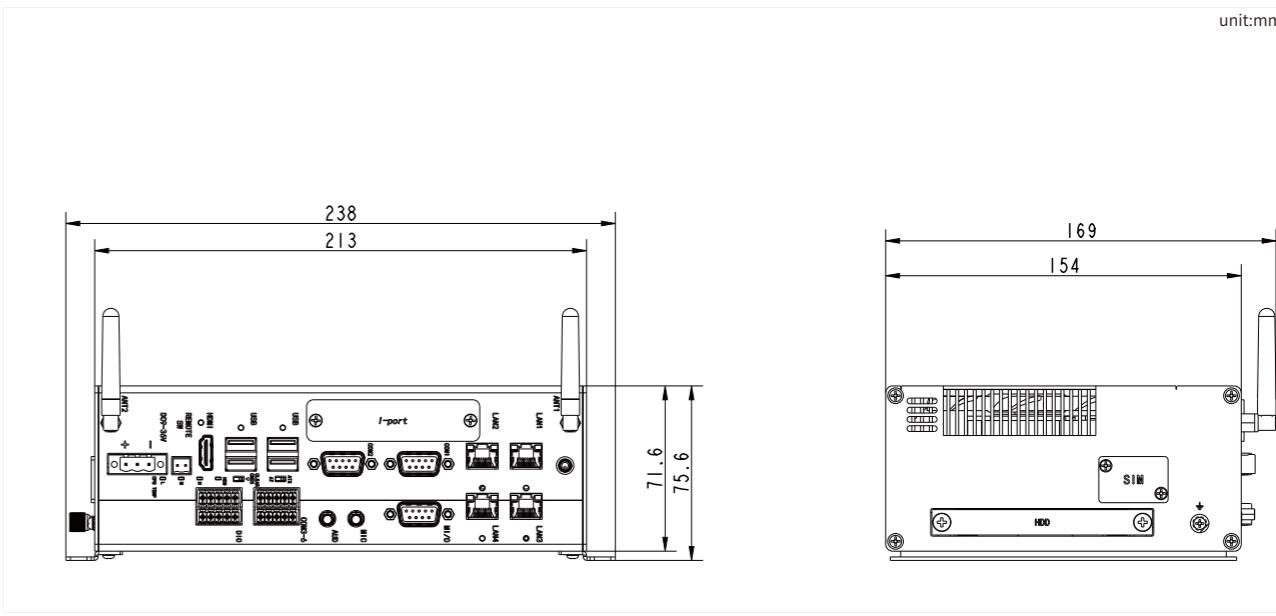
KMDA-7611-S001 is a high-performance box computer with H610 chipset, powered by Intel® 12/13th Gen Alder lake-S/Raptor Lake-S CPU, multi IO interfaces and moderate size. It is suitable for unmanned forklifts, machine vision, and industrial control and other industries and fields.

Product Parameters

System	
CPU	Intel® Alder lake-S/Raptor Lake-S 12/13th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH
RAM	2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; HDMI:4096*2160@60Hz
LAN	3*Intel I210AT, 10-1000M,WOL; 1*Intel I219 LM, 10-1000M, WOL
USB	2* USB3.2(10G), 2*USB3.2(5G), 1*USB2.0(built-in)
Display	HDMI
Audio	Realtek ALC897, 1*Line out+1*MIC
COM/Others	2*RS232/422/485, 4*RS232;
DIO	8bit isolatedDIO(4bit DI-2.5KV-PNP/NPN;4bit DO-2.5KV);
Storage	
Storage	1*2.5" SATA3.0; 1*mSATA(SATA3.0)
Others	
LED	1*Power LED, 1*HDD LED, 3*CPU Temp. LED
Switch	1*Power SW, Remote SW,1*AT/ATX SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
TPM	(Opt.)TPM2.0
OS	
OS	Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7

Expansion	
Expansion	2*Mini PCIe(PCIeX1/USB2.0),PCIe module; 1*M.2 3052/3042 B-Key(PCIeX1/USB2.0),5G NR
Power	
Power & TDP	DC IN 9-36V 3-pin Term. 5.0mm, OVP&OCP&SCP TDP:105.84W (Intel I3-12100/128GB SSD/32GB RAM)
Mechanical	
Structure	Aluminum-magnesium alloy, SGCC frame
Color	Silver Gray
Installation	Desktop Mounting/Wall(opt.), DIN-Rail(opt.)
Dimension	238*169*75.6mm
Weight	2.55KG
Environment	
Operating Temp	-20°C~60°C – SSD, air flow; -10°C~55°C – HDD, air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~95%@40°C, Non-condensing
Vibration	5grms/5~500Hz/random/in working(SSD); 1grms/5~500Hz/random/in working(HDD)
Shock	50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)
Certificate/EMC	CE/FCC Class A

Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-7611/S001	Intel®12/13 Gen Alderlake-S/Raptor Lake-S LGA1700 CPU, H610 PCH	2*DDR5 SODIMM, 4*LAN, 4*USB3.2, 1*USB2.0, 6*COM, 1*HDMI, Line out & Mic, 8bit Iso.DIO, 1*I-Port, 1*M I/O, 1*mSATA, 1*2.5" SATA bay, 2*Mini PCIe, 1*M.2 B-Key, 1*SIM, DC 9-36V.
PA-120DC19		AC/DC power adapter, DC 19V/6.32A, 120W

KMDA-7611-T

Intel® 12/13th Gen Alder Lake-S/Raptor Lake-S LGA1700 CPU, 2*LAN, 4*USB3.2, 1*HDMI, 2*COM, 1*mSATA, 2*Mini PCIe, 1*M.2 B-Key, DC 9-36V

Key Specification

- Intel® 12/13th Gen Alder lake-S/Raptor Lake-S LGA1700 CPU
- Intel® H610 Chipset
- 2*DDR5 4800MHz SODIMM, up to 64GB
- 1*HDMI
- 2*LAN, 4*USB3.2, 1*USB2.0, 8bit Iso. DIO
- 2*RS232/422/485 COM
- 2*Mini PCIe full size, function module that supports PCIe signals
- 1*M.2 3052/3042 B-Key with a SIM card slot, supports 5G NR module
- 1*mSATA
- DC IN 9-36V, with OVP,OCP and SCP



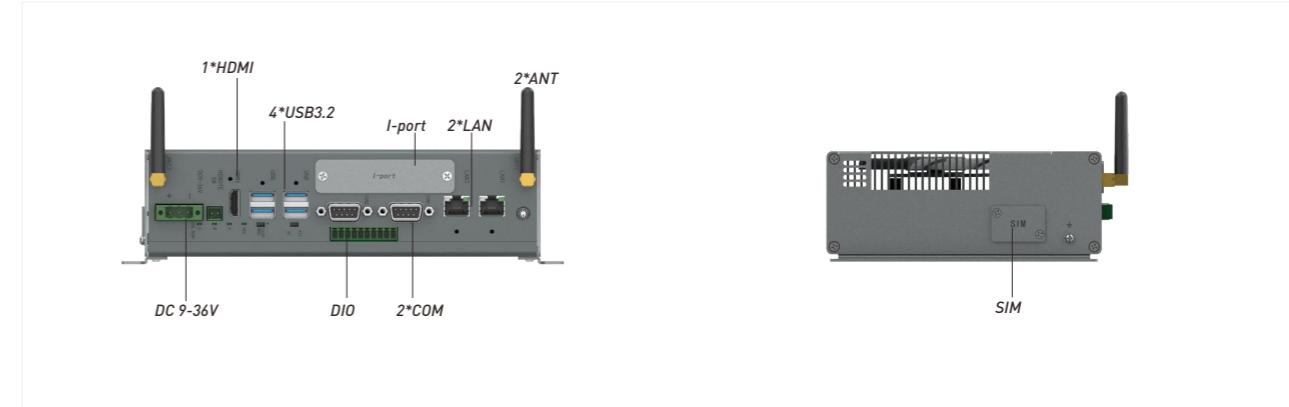
Product Overview

KMDA-7611-T001 is a high-performance box computer with H610 chipset, powered by Intel® 12/13th Gen Alder lake-S/Raptor Lake-S CPU, multi IO interfaces and moderate size. It is suitable for unmanned forklifts, machine vision, and industrial control and other industries and fields.

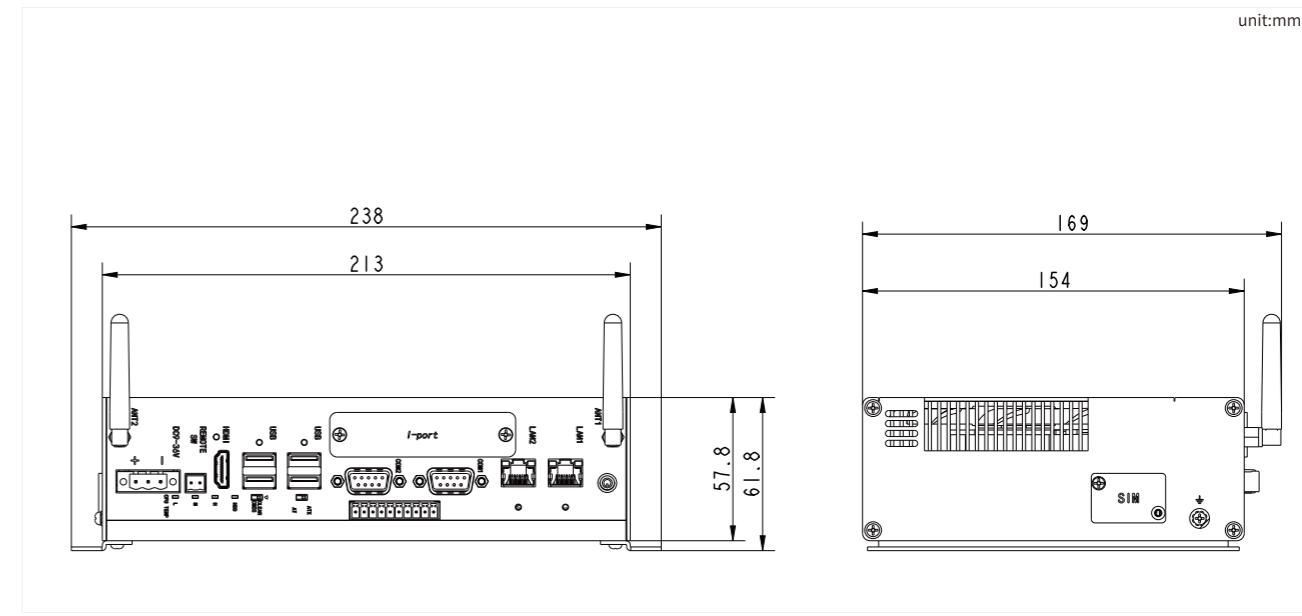
Product Parameters

System	
CPU	Intel® Alder lake-S/Raptor Lake-S 12/13th Gen Core™ i9/i7/i5/i3/Pentium/Celeron LGA1700 CPU, Intel® H610 PCH
RAM	2*262-Pin SODIMM, DDR5 4800MHz, 64GB max.
Graphics	Intel® UHD Graphics, Supports DirectX 12, OpenGL 4.5, OpenCL 3.0; HDMI:4096*2160@60Hz
LAN	1*Intel I210AT, 10-1000M,WOL; 1*Intel I219 LM, 10-1000M, WOL
USB	2* USB3.2(10G), 2*USB3.2(5G), 1*USB2.0(built-in)
Display	HDMI
Audio	/
COM/Others	2*RS232/422/485
DIO	8bit iso. DIO(4bit DI:2.5KV-PNP/NPN;4bit DO:2.5KV);
Storage	
Storage	1*mSATA(SATA3.0)
Others	
LED	1*Power LED, 1*HDD LED, 3*CPU Temp. LED
Switch	1*Power SW, Remote SW, 1*AT/ATX SW, 1*Clear CMOS
WDT	programmable via software 1 to 255 second
TPM	(Opt.)TPM2.0
OS	
OS	Windows 11, Windows 10 IoT Enterprise 2021 LTSC, Ubuntu, SuSe, Red Hat Enterprise, Wind River Linux, Wind River VxWorks 7

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
KMDA-7611/T001	Intel®12/13 Gen Alderlake-S/Raptor Lake-S LGA1700 CPU, H610 PCH	2*DDR5 SODIMM, 2*LAN, 4*USB3.2, 1*USB2.0, 2*COM, 1*HDMI, 8bit Iso. DIO, 1*I-Port, 1*mSATA, 2*Mini PCIe, 1*M.2 B-Key, 1*SIM card slot, DC 9-36V
PA-120DC19		AC/DC power adapter, DC 19V/6.32A, 120W

SCC-3116

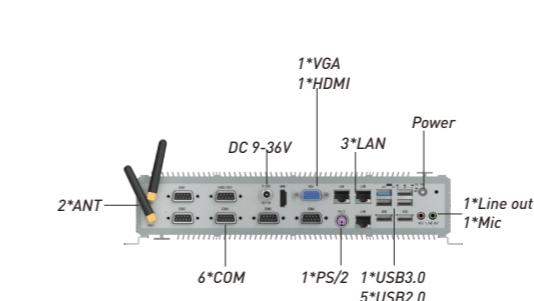
Intel® Baytrail Celeron J1900 CPU, 2/3*LAN, 7*USB, 6*COM, 1*HDMI+1*VGA dual display, optional 8-bit DIO, DC IN 9~36V

Key Specification

- Aluminum Chassis, fanless heat dissipation design
- Intel® Baytrail Celeron J1900 2.0~2.42G CPU
- 1*DDR3L 1333MHz SODIMM RAM, 8GB max.
- 1*HDMI &1*VGA, dual display
- 2/3*Gig LAN, 1*USB3.0, 6*USB2.0(one build-in)
- 6*COM, optional 8-bit DIO, 1*Line out,1*Mic
- 1*Mini PCIe(PCIeX1+USB signal), 1*PS/2
- 1*mSATA, 1*2.5' SATA bay, anti-vibration design, DC 9~36V wide voltage power supply



I/O View



Product Overview

SCC-3116 is a multi-IO design industrial box PC with aluminum chassis and fanless design. Equipped with Intel Baytrail Celeron J1900 CPU, DDR3L 1333Mhz SODIMM, Max. support upto 8GB. It is economical and high reliability, suitable for equipment automation, IoT signal acquisition and other applications.

Product Parameters

System

CPU	Intel® Baytrail-D Celeron J1900 , Main frequency 2.0~2.42GHz, quad-core, four-thread, 2M cache, 22nm, TDP 10W
RAM	1*DDR3L, 1333MHz SODIMM, Max. 8GB
Graphics	Intel HD Graphics, VGA : 1920*1200@60Hz, HDMI:1920*1080@60Hz, support 2 independent displays support OpenGL 3.2, DirectX 11, OpenCL 1.2, MPGE2/H.264
LAN	3*Intel I211AT PCIe Gig. Ethernet, 10/100/1000Mbps
USB	1* USB3.0, 6*USB2.0, 1*USB2.0 (build-in)
Display	1*HDMI+1*VGA
Audio	1*Line out+1*Mic,Realtek ALC662VD
COM/ Others	4*RS232/422/485, 2*RS232, 1*PS/2 (Mouse and keyboard)
DIO	8-bit DIO, programmable input and output (DB9)

Storage

Storage	1*2.5" SATA2,HDD/SSD;1*mSATA full-height card,Support AHCI mode
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Others

LED	1*power LED, 1*HDD LED, 3*CPU temperature LED
Switch	1*Power SW,1*Remote SW,1*AT/ATX SW, 1*Clear CMOS SW

WDT	programmable via software 1 to 255 second
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OS

OS	Windows 7, Windows 8.1, Windows 10, Linux Fedora Ubuntu
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Expansion

Expansion	1*Mini PCIe, with SIM slot , support 4G LTE/Wifi/BT,
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Power Supply

Power&	DC IN 9-36V D-Jack/M8,with short circuit protection, over voltage and over current protection,
TDP	14.4W(2.5" HDD)

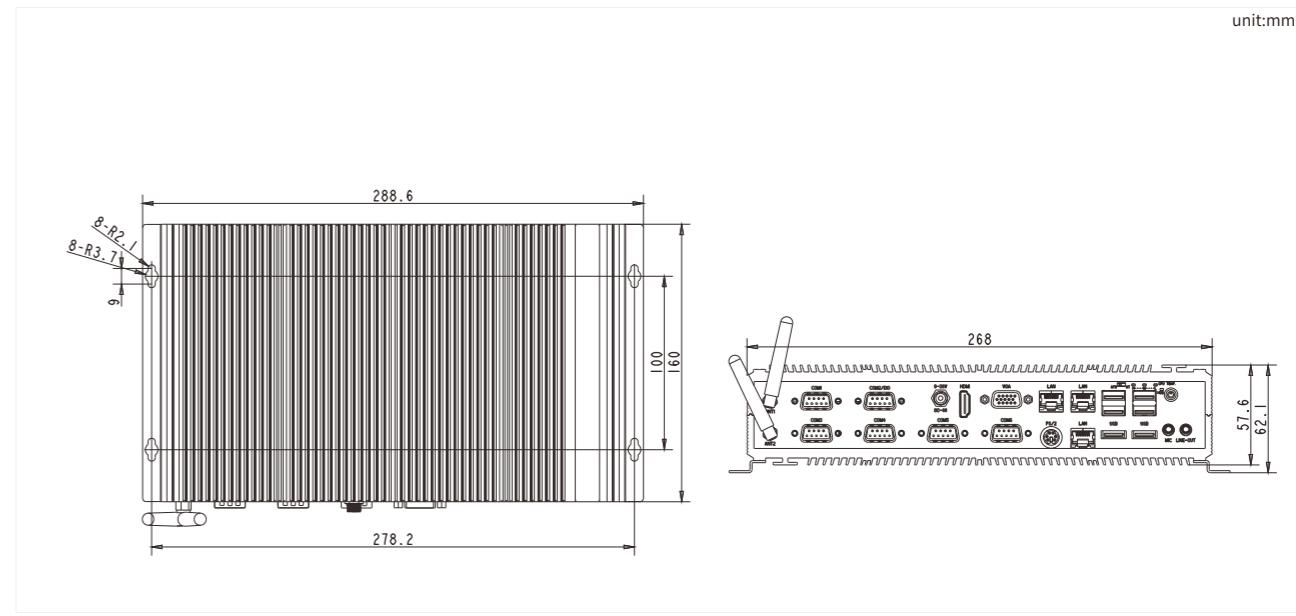
Mechanical

Structure	Aluminum Chassis, SGCC frame
Color	Silver gray
Installation	Desktop mounting
Dimension(W*H*D)	268*160*57.6mm
Weight	2.15KG

Environment

Operating Temp	-20°C~65°C SSD, with air flow, -10°C~55°C HDD, with air flow;
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No condensation
Vibration	5 grms/5~500Hz/random/during operation (SSD) 1 grms/5~500Hz/random/during operation (HDD)
Shock	50g peak acceleration(duration 11ms) with SSD; 20g peak acceleration(duration 11ms) with HDD
Certificate/EMC	CE/FCC Class A

Dimensions



Ordering Information

Model	Processor	Specifications
SCC-3116/T002	Intel® J1900 CPU	3*LAN, 1*USB3.0, 6*USB2.0, 6*COM, optional 8-bit DIO, 1*Mini PCIe, 1*HDMI,1*VGA, 1*PS/2, 1*Line out, 1*Mic, 1*2.5"SATA2 bay, 1*mSATA, DC 9~36V
PA-60DC12		AC/DC adapter, DC19V/6.32A 120W

ECC-U5000

Intel® Elkhart lake Soc CPU, 1*HDMI, 8*COM, 3*LAN, 2*USB3.1+2*USB2.0, 8*DI+6*DO, 2*CAN, 2*MiniPCIe, 1*mSATA, DC12V/9~36V(Opt.)

Key Specification

- Intel® Elkhart lake Soc CPU
- Intel® CPU SoC MCP, Fanless cooling design
- 1*DDR4 3200MHz SODIMM, Up to 32GB
- 1*HDMI, 1*mSATA
- 2*MiniPCIe(1*MiniPCIe supports 4G, and the other with PCIeX1 and USB2.0 signals)
- 8*COM(2*RS232/485+6*RS485)Tape isolation, 3*LAN,
- 2*USB3.2+2*USB2.0
- 8*DI+6*DO indicates isolation, 2*CAN indicates isolation
- DC 12V or 9~36V(optional) power input



Product Overview

ECC-U5000, equipped with Intel® Elkhart lake U series processor, with a comprehensive I/O interface, built-in 2*Mini PCIe expansion module, DC12V or 9~36V (optional) wide voltage DC power supply optional, the product adopts SGCC box design, exquisite and compact size. The main application scenarios are energy storage system integration and manufacturing.

Product Parameters

System

CPU Intel® Elkhart lake SoC CPU: Celeron J6412 2.0-2.6GHz

RAM 1*DDR4 3200 MHz SODIMM, 32GB max.

Graphics Intel UHD Graphics / Iris® Xe Graphics, Supports Intel DL boost, DirectX12.1, OpenGL 4.6 and OpenCL 3.0, HDMI:4096*2304@60Hz

LAN 3*RTL811H-VB, 10-1000M

USB 2*USB3.1; 2*USB2.0

Display 1*HDMI

Audio /

COM/Others 2*RS232/485, 6*RS485; 2*CAN

DIO 8*DI+6*DO

Storage

Storage 1*mSATA,SATA3.0 ,6 Gbps

Others

LED 1*HDD LED

Switch 1*Power SW, 1*AT/ATX SW, 1*Clear CMOS SW

WDT programmable via software 1 to 255 second

OS

OS Windows 10,Linux

Expansion

Expansion 1*Mini PCIe,(PCIeX1/USB2.0+SIM),4G LTE/Wifi/BT;
1*Mini PCIe,(PCIeX1/USB2.0)

Power Supply

Power& TDP DC-IN: 12V/9~36V (Opt.), OVP,OCP;
18.35W(CPU Celeron J6412 @2.00GHz, 8G DDR4, 128G mSATA)

Mechanical

Structure Aluminum rectangular profile cooling housing, SGCC box

Color Silver Gray

Installation Horizontal desktop installation

Dimension(W*H*D) 222*140*45mm

Weight 1.32KG

Environment

Operating Temp -20°C~60°C

Storage Temp -40°C~85°C

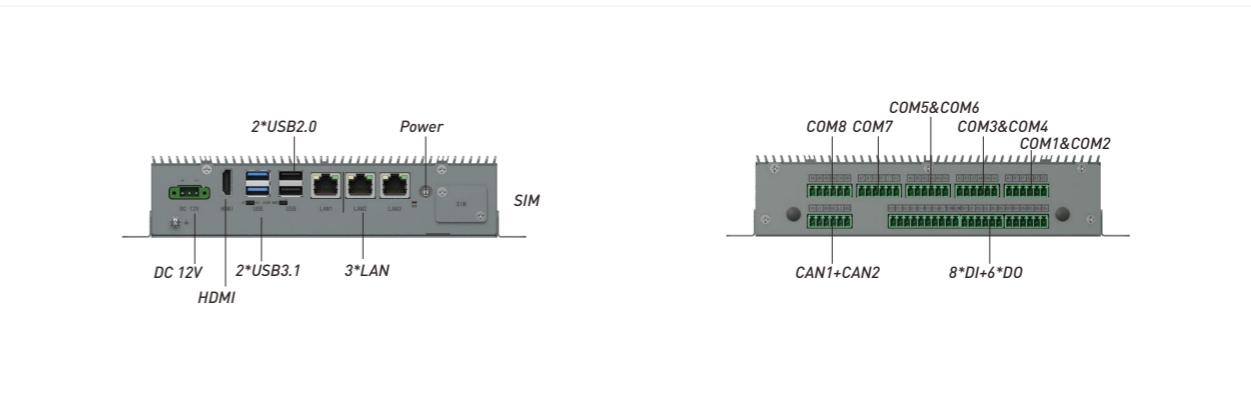
Storage Humidity 10~95%@40°C, non-condensing

Vibration 5 grms/5~500Hz/random/during operation (SSD)
1 grms/5~500Hz/random/during operation (HDD)

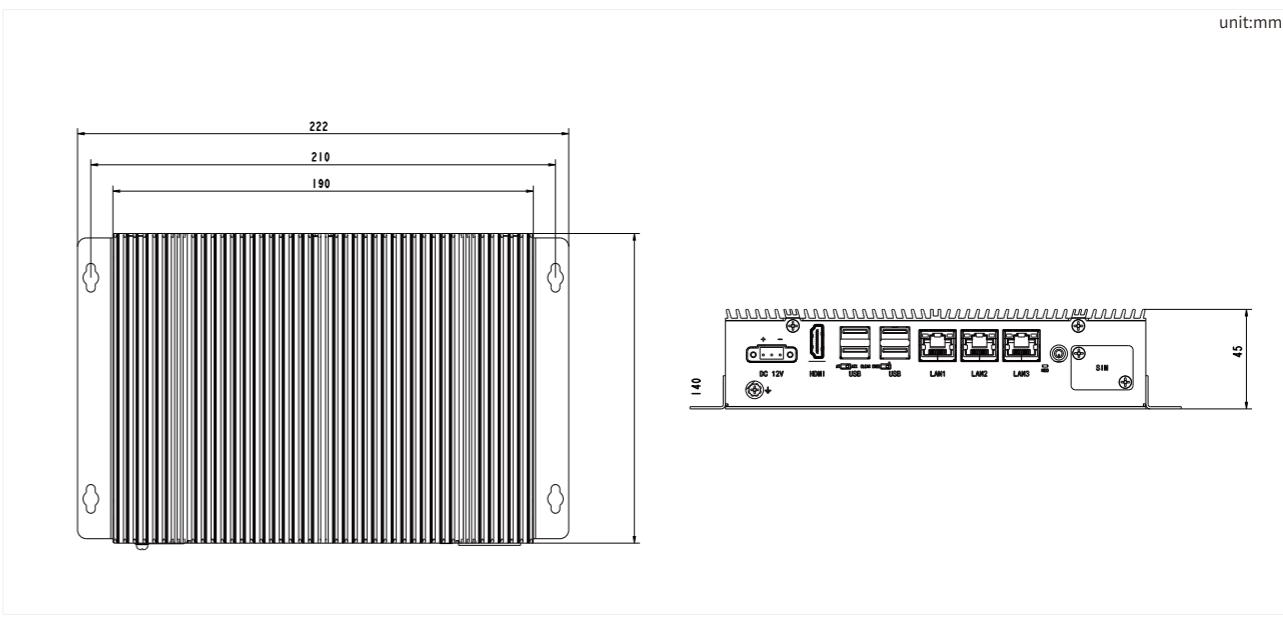
Shock 50g peak acceleration(duration 11ms) with SSD;
20g peak acceleration(duration 11ms) with HDD

Certificate/EMC CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	DC IN	Specifications
ECC-U5000/S001	12V	Intel® Celeron J6412,8*COM, 2*USB3.1+2*USB2.0, 3*LAN, 1*HDMI, 1*mSATA, 2*Mini PCIe with PCIeX1 and USB2.0 signals (1*MiniPCIe supports 4G, with SIM card slot, Another 1*MiniPCIe expansion port is reserved), 8*DI+6*DO, 2*CAN
ECC-U5000/S001-WP	9~36V (OFX-75)	
PA-60DC12		AC/DC power adapter, DC12V@5A,60W

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Connecting the Dots



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Connecting the Dots

ALAD
Industrial Panel PC



New product and differences for ALAD tablets

Model	CPU	Model	CPU	Model	CPU
A1010T/T(P)	Elkhart lake	K1020T	Sky lake-U/ Kaby lake-U	K1050T/T(P)	Tiger lake-U
A1210T/T(P)		K1220T		K1250T/T(P)	
A1510T(P)		K1520T		K1550T(P)	
A1710T/T(P)		K1720T		K1750T/T(P)	
A1810T(P)		K1820T(P)		K1850T(P)	
A1910T/T(P)		K1920T		K1950T/T(P)	
A2110T(P)		K2120T(P)		K2150T(P)	
A2310T(P)		K2320T(P)		K2350T(P)	



COMPLETE LIST

Industrial Panel PC List **D-01**

ALAD-K1050T(P) **D-05**

ALAD-K1250T(P) **D-07**

ALAD-K1550T(P) **D-09**

ALAD-K1551T(P) **D-11**

ALAD-K1750T(P) **D-13**

ALAD-K1850T(P) **D-15**

ALAD-K1950T(P) **D-17**

ALAD-K2150T(P) **D-19**

ALAD-K2350T(P) **D-21**

WPPC-H1580T **D-23**

WPPC-H1780T **D-25**

Display List **D-27**

ALAD-101T **D-29**

ALAD-151T **D-31**

ALAD-171T **D-33**

ALAD-181T(P) **D-35**

ALAD-191T **D-37**

ALAD-211T(P) **D-39**





	WPPC-H1580T	WPPC-H1780T
System		
CPU	Intel® Baytrail Celeron J1900 2.0-2.42G CPU	Intel® Baytrail Celeron J1900 2.0-2.42G CPU
RAM	1*DDR3L,1333Mhz SODIMM,Max.8GB Gen.7 Intel® HD Graphics LCD+HDMI+VGA display,OpenGL 3.2, Graphics DirectX 11, OpenCL 1.2, MPGE2/H.264 VGA:1920*1200@60Hz; HDMI:1920*1080@60Hz	1*DDR3L,1333Mhz SODIMM, Max.8GB Gen.7 Intel® HD Graphics LCD+HDMI+VGA display,OpenGL 3.2, DirectX 11, OpenCL 1.2, MPGE2/H.264 VGA:1920*1200@60Hz; HDMI:1920*1080@60Hz
I/O Interfaces		
LAN	2*Intel I211AT, Gigabit	2*Intel I211AT, Gigabit
USB	1*USB3.0,3*USB2.0	1*USB3.0,3*USB2.0
Display	1*HDMI+1*VGA	1*HDMI+1*VGA
Audio	Optional audio	Optional audio
Serial port	2*RS232/422/485	2*RS232/422/485
LCD Display		
Dimensions	15" TFT LED	17" TFT LED
Resolution	1024*768	1280*1024
Max. colors	16.2M	16.2M
Luminance(cd/m²)	350	600
Viewing Angle	80°(left), 80°(right), 80°(up), 80°(down)	80°(left), 80°(right), 70°(up), 80°(down)
Touch screen		
Touch type	5-wire resistive touch screen/ projected capacitive touch screen	5-wire resistive touch screen/ projected capacitive touch screen
Light Transmission	83/90%	83/90%
Controller	USB	USB
Storage		
Storage	1*2.5" SATA swappable, 1*mSATA, support AHCI	1*2.5" SATA swappable, 1*mSATA Full-height card, support AHCI
Expansion		
Expansion Port	1*Mini PCIe, with SIM slot	1*Mini PCIe, with SIM slot
Power Supply		
Input voltage & Power consumption	DC IN 9~36V, D-Jack w/M8, Power consumption: 19.5W	DC IN 9~36V, D-Jack w/M8, Power consumption: 30W
Mechanical		
Structure	SUS304 stainless steel/5052 Aluminum alloy/SECC	SUS304 stainless steel/5052 Aluminum alloy/SECC
Dimension (W*H*D)	405.22*328.22*52.1mm	429.51*364.51*52.1mm
Installation	Desktop mounting VESA(100mm*100mm)	Desktop mounting VESA(100mm*100mm)
Net Weight	5.8KG	5.57KG
Environmental		
Operating Temperature	0~ 60°C	0~ 60°C
Storage Temperature	-40°C~85°C	-40°C~85°C
Storage Humidity	10~90%@40°C, No-condensation	10~90%@40°C, No-condensation
Vibration	1g 5~500Hz	1g 5~500Hz
Shock	10g peak acceleration (duration 11ms) with HDD	10g peak acceleration (duration 11ms) with HDD
EMC	CE,FCC Class A	CE,FCC Class A
OS	Windows 7,Windows 8.1, Windows 10,Linux Fedora Ubuntu	Windows 7,Windows 8.1, Windows 10,Linux Fedora Ubuntu

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ALAD-K1050T(P)

10.1" TFT LCD Capacitive/Resistive Touch, Intel® Tigerlake CPU, 2*COM, 2*LAN, 4*USB3.2, 1* Line out, 1*2.5"SATA, 1*mSATA, DC 9~36V

Key Specification

- Aluminum die-casting chassis
- 10.1" TFT LCD, Multi-point capacitive/5 wire resistive touch
- Intel® Tigerlake CPU, fanless design
- 1*DDR4 3200 SODIMM, up to 32GB
- 1*Mini PCIe, 1*M.2 B-Key Type 3042/3052
- 2*COM, 2*LAN, 4*USB3.2, 1*8-bit DIO (Optional with COM1/2)
- 2.5"SATA Bay, 1*mSATA, 1*Line out, 2*2W Speaker
- DC 9~36V power input
- Standard VESA mount and panel mounting



Product Overview

The ALAD-K1050T(P) is a tablet powered by Intel® Tiger lake U series processors. It adopts 10.1 "1280*800 resolution LCD and fully fits surface projection multi-point capacitive/5 wire resistive touch screen. The product has a comprehensive I/O interface, supporting 1*2.5"SATA disk and 1*mSATA dual storage; Built-in 1*Mini PCIe and 1*M.2 3042/3052 expansions, wide voltage DC power supply from 9 to 36V, aluminum die-cast body without fan heat dissipation, various installation modes, suitable for intelligent MES system and device management HMI.

Product Parameters

System

CPU	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W
RAM	1*DDR4, 3200Mhz SODIMM, 32GB max.

Intel®UHD/ Intel® Iris® Xe Graphics:

Intel DL boost, DirectX12.1,
OpenGL 4.6 and OpenCL 3.0;
HDMI:4096*2304@60Hz

Expansion

1*Mini PCIe(PCle&USB),PCIe module;
1*M.2 3042/3052(+SIM),4G LTE/5G NR

Power Supply

Input voltage & TDP
DC IN 9~36V;
34.5W (CPU i7-1165G7, 8G DDR4, 128G SSD)

I/O Port

LAN	2*Intel I210AT, 10M-1000M, WOL
USB	4*USB3.2
Display	1*HDMI
Audio	1*Line out, Realtek ALC897,2*2W Speaker
Serial port	2*RS232/422/485

Mechanical

Structure	Aluminum die-casting front bezel , fin-shaped radiator shell
Dimension (W*H*D)	275*193*51mm Panel mounting opening size(W*H): 270*188mm
Installation	Panel/VESA(100*100/75*75mm)
Net Weight	1.85KG

Environmental

Operating Temp	0~50°C, HDD(-10~55°C, SSD), airflow
Storage Temp	-20°C~60°C
Storage Humidity	10~95%@40°C, non-condensing
Vibration	1g 5~500Hz,with HDD
Shock	10g peak acceleration(duration 11ms) with HDD
EMC	CE,FCC Class A

OS

Windows 11/10*IoT enterprise,
Android, SUSE, Ubuntu, Wind River,
Red Hat*Enterprise, Wind River
VxWorks*7, Yocto

LCD Display

Dimension	10.1" TFT LCD
Resolution	1280*800@60Hz
Max. colors	16.2M
Luminance(cd/m²)	350
Viewing Angle	85°(L), 85°(R), 85°(U), 85°(D)

Touchscreen

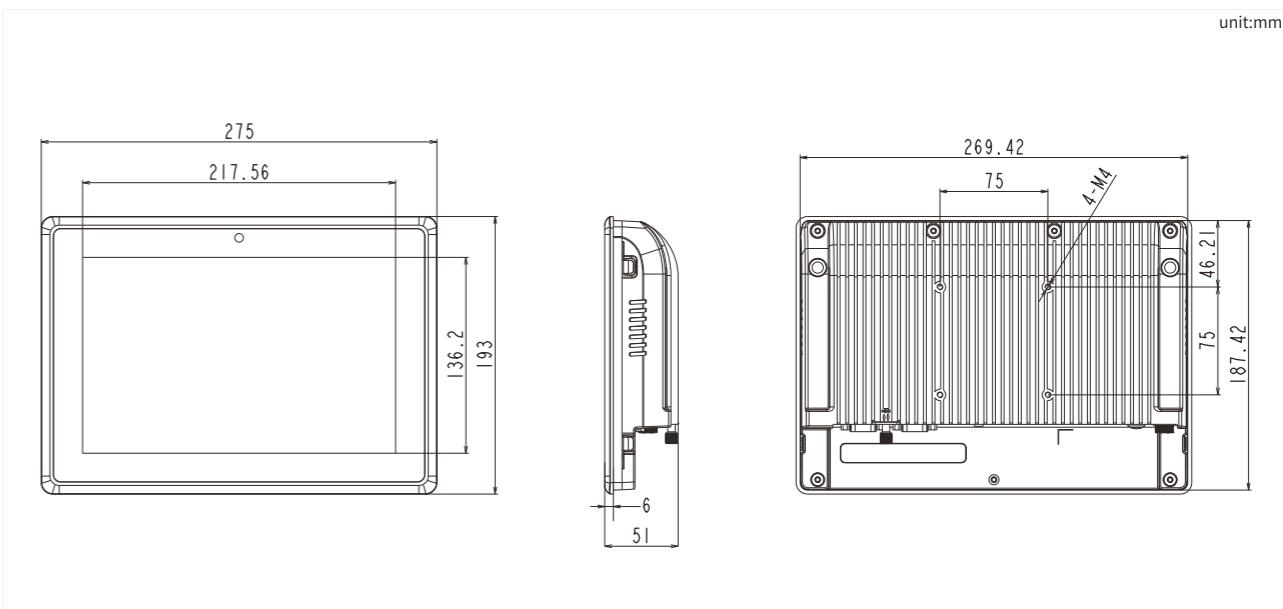
Touch type	5-wire resistive touch screen/projected capacitive touch screen
Transmittance	83%/ \geq 85%
Controller	USB

Storage	1*2.5" SATA3.0 HDD/SSD, 1*mSATA
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I/O View



Dimensions



Ordering Information

Model	CPU	Touch Screen	Specifications
ALAD-K1050/ S001	Intel® Core i3-1115G4	T: 5-wire resistive touch screen	
ALAD-K1050/ S002	Intel® Core i5-1135G7	T(P): Projected capacitive touch screen	
ALAD-K1050/ S003	Intel® Core i7-1165G7		10.1" LCD, 2*COM, 4*USB3.2, 2*LAN, 1*HDMI, 1*Mini PCIe, 1*M.2 B-Key , 1*Line out, 1*2.5"SATA Bay, 1*mSATA, 2*2W Speaker, DC 9~36V power input
ALAD-K1050/ S004	Intel® Celeron 6305E		
PA-60DC12	AC/DC power adapter, DC12V/5A, 60W		

ALAD-K1250T(P)

12.1" TFT LCD Capacitive/Resistive Touch, Intel® Tigerlake CPU, 4*COM, 2*LAN, 4*USB3.2, 1*USB2.0, 1* Line out, 1*2.5"SATA, 1*mSATA, DC 9~36V

Key Specification

- Aluminum die-casting chassis
- 12.1" TFT LCD, Multi-point capacitive/5 wire resistive touch
- Intel® Tigerlake CPU, fanless design
- 1*DDR4 3200 SODIMM, up to 32GB
- 1*Mini PCIe, 1*M.2 B-Key Type 3042/3052
- 4*COM, 2*LAN, 4*USB3.2, 1*USB2.0, 1*8-bit DIO(opt.)
- 2.5"SATA Bay, 1*mSATA, 1*Line out, 2*3W Speaker
- DC 9~36V power input
- Standard VESA mount and panel mounting



Product Overview

The ALAD-K1250T(P) is a tablet powered by Intel® Tiger lake U series processors. It adopts 12.1 "1024*768 resolution TFT LCD and fully fits surface projection multi-point capacitive/5 wire resistive touch screen. The product has a comprehensive I/O interface, supporting 1*2.5" SATA disk and 1*mSATA dual storage; Built-in 1*Mini PCIe and 1*M.2 3042/3052 expansions, wide voltage DC 9~36V, aluminum die-cast body without fan heat dissipation, various installation modes, suitable for intelligent MES system and device management HMI.

Product Parameters

System

CPU	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W
RAM	1*DDR4, 3200Mhz SODIMM, 32GB max.
Graphics	Intel®UHD/ Intel® Iris® Xe Graphics: Intel DL boost, DirectX12.1, OpenGL 4.6 and OpenCL 3.0; HDMI:4096*2304@60Hz

I/O Port

LAN	2*Intel I226V, 10M-1000M, WOL
USB	4*USB3.2, 1*USB2.0
Display	1*HDMI
Audio	1*Line out, Realtek ALC897,2*3W Speaker
Serial port	2*RS232/422/485+2*RS232

LCD Display

Dimension	12.1" TFT LCD
Resolution	1024*768@60Hz
Max. colors	16.2M
Luminance (cd/m²)	500
Viewing Angle	80°(L), 80°(R), 70°(U), 70°(D)

Touchscreen

Touch type	5-wire resistive touch screen/projected capacitive touch screen
Transmittance	83%/90%
Controller	USB

Storage

Storage	1*2.5" SATA3.0 HDD/SSD, 1*mSATA
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Expansion

Expansion	1*Mini PCIe(PCle&USB),PCIe module; 1*M.2 3042/3052(+SIM),4G LTE/5G NR
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Power Supply

Input voltage & TDP	DC IN 9~36V; 11.52W (CPU i7-1165G7, 8G DDR4, 128G SSD)
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Mechanical

Structure	Aluminum die-casting front bezel , fin-shaped radiator shell
Dimension (W*H*D)	315*259*51mm Panel mounting opening size(W*H): 303*247mm
Installation	Panel/VESA(100*100/75*75mm)
Net Weight	2.8KG

Environmental

Operating Temp	0~50°C, HDD(-10~55°C, SSD),airflow
Storage Temp	-20°C~60°C
Storage Humidity	10~95%@40°C, non-condensing
Vibration	1g 5~500Hz,with HDD
Shock	10g peak acceleration(duration 11ms) with HDD
EMC	CE,FCC Class A

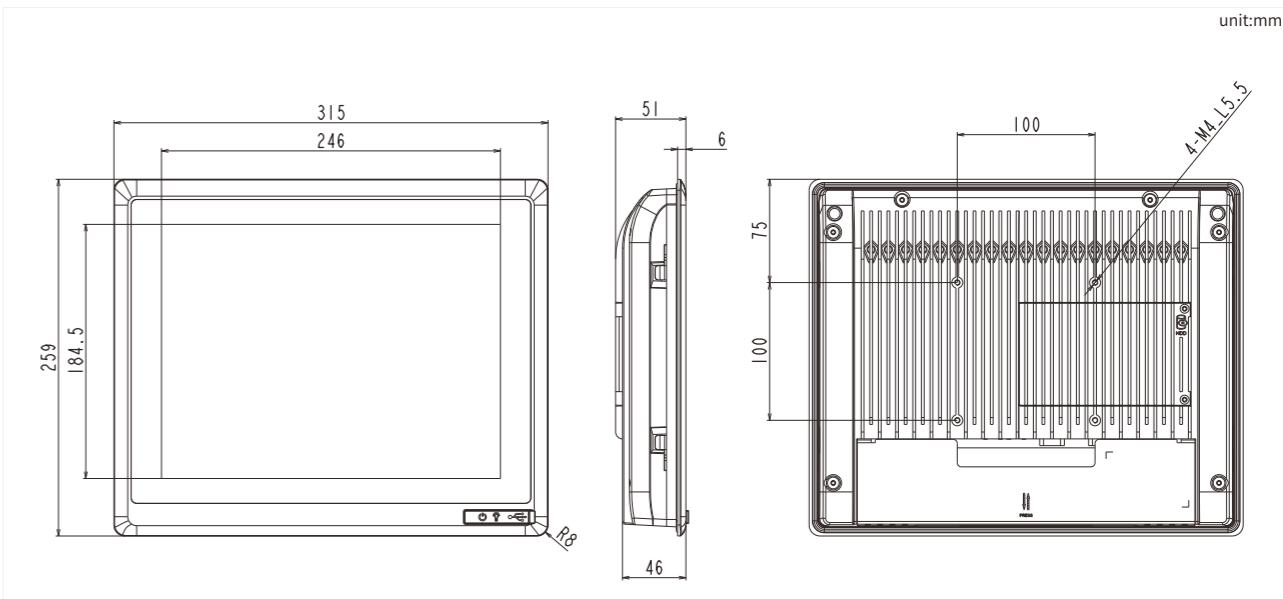
OS

Windows 11/10*IoT enterprise,
Android,SUSE,Ubuntu,Wind River,
Red Hat*Enterprise,Wind River
VxWorks*7,Yocto

I/O View



Dimensions



Ordering Information

Model	Processor	Touch Screen	Specifications
ALAD-K1250/ S001	Intel® Core i3-1115G4	T:	
ALAD-K1250/ S002	Intel® Core i5-1135G7	5-wire resistive touch screen	T(P): Projected capacitive touch screen
ALAD-K1250/ S003	Intel® Core i7-1165G7		12.1" TFT LCD, 4*COM, 4*USB3.2, 1*USB2.0, 2*LAN, 1*HDMI, 1*Mini PCIe, 1*M.2 B-Key , 1*Line out, 1*2.5"SATA Bay, 1*mSATA, 2*3W Speaker, DC 9~36V
ALAD-K1250/ S004	Intel® Celeron 6305E		
PA-60DC12	AC/DC power adapter, DC12V/5A, 60W		1*COM adapter cable (one drag two, DB9 form)

ALAD-K1550T(P)

15.6" TFT LCD Capacitive Touch, Intel® Tigerlake CPU, 4*COM, 2*LAN, 4*USB3.2, 1* Line out, 1*2.5" SATA bay, 1*mSATA, DC 9~36V

Key Specification

- Aluminum die-casting chassis, Full Flat Mirror Panel
- 15.6" Full HD LCD, Multi-point capacitive touch
- Intel® Tigerlake CPU, fanless design
- 1*DDR4 3200 SODIMM, up to 32GB
- 1*Mini PCIe, 1*M.2 B-Key Type 3042/3052
- 4*COM, 2*LAN, 4*USB3.2, 1*8-bit DIO (opt.)
- 2.5" SATA Bay, 1*mSATA, 1*Line out, 2*3W Speaker
- Optional 1*PCIeX4 slot (PCIE4 signal) or 1*PCI slot expansion
- DC 9~36V power input
- Standard VESA mount and panel mounting



Product Overview

ALAD-K1550T(P) is a full flat mirror panel powered by an Intel® Tiger lake U series processor. It adopts 15.6 "1920*1080 resolution full HD TFT LCD and fully fits surface projection multi-point capacitive touch screen. The product has a comprehensive I/O interface, supporting 1*2.5" SATA disk and 1*mSATA dual storage; Built-in 1*Mini PCIe and 1*M.2 3042/3052 expansions, wide voltage DC power supply from 9 to 36V, aluminum die-cast body without fan heat dissipation, various installation modes, suitable for intelligent MES system and device management HMI.

Product Parameters

System	
CPU	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W; Intel® CPU SoC MCP
RAM	1*DDR4 3200 MHz SODIMM, 32GB max.
Graphics	
Graphics	15.6 "1920*1080@60Hz Full HD TFT LCD, 1*HDMI for extended display Intel UHD Graphics or iRIS® Xe Graphics, Supports the Intel DL boost deep learning to strengthen technology, DirectX12.1, OpenGL 4.6 and OpenCL 3.0, HDMI: 4096*2304@60Hz

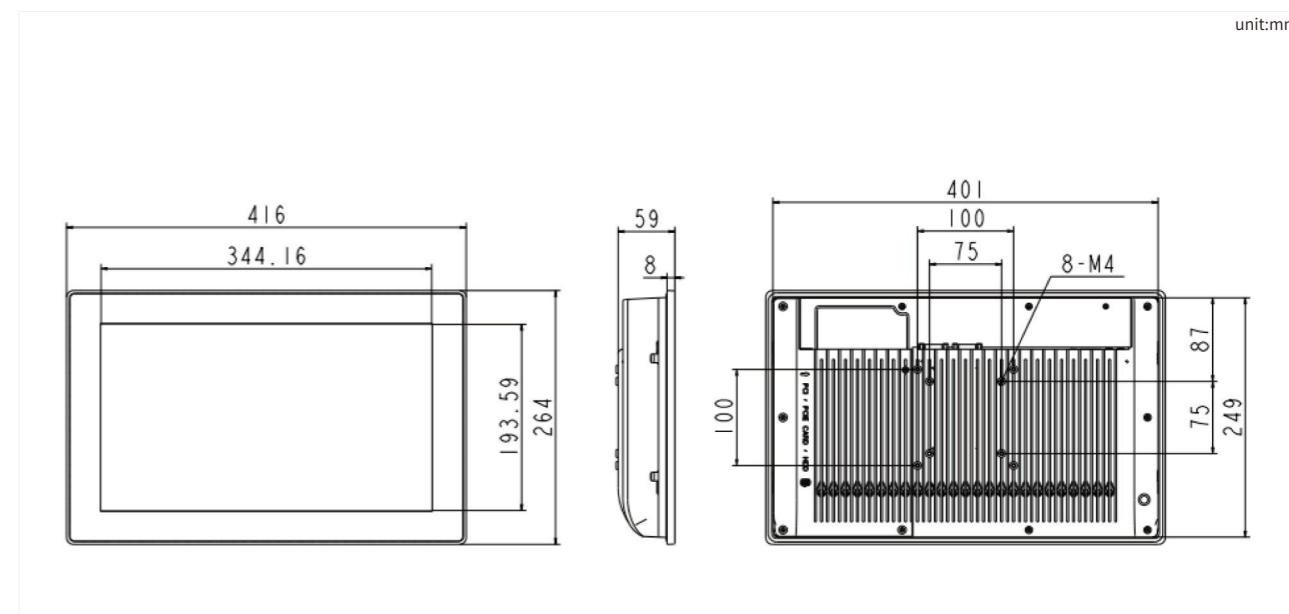
I/O Port	
LAN	2*Intel I226V, 10M-1000M, WOL
USB	4*USB3.2
Display	1*HDMI
Audio	1*Line out,Realtek ALC897, 2*3W Speaker
Serial port	2*RS232, 2*RS232/422/485 (DB9)
LCD Display	
Dimension	15.6" TFT LED
Resolution	1920*1080
Max. colors	16.2M
Luminance(cd/m²)	350
Viewing Angle	85°(L), 85°(R), 85°(U), 85°(D)

Touch Screen	
Touch type	Projected capacitive touch
Light Transmission	≥85%
Controller	EETI Industrial grade

I/O View



Dimensions



Ordering Information

Model	CPU	Touch Screen	Specifications
ALAD-K1550T(P)/S001	Intel® Core i3-1115G4		Industrial panel computer, 15.6" TFT LCD, 4*COM, 4*USB3.2, 1*USB2.0, 2*LAN, 1*HDMI, 1*Mini PCIe, 1*M.2 B-Key, 1*Line out, 1*2.5" SATA Bay, 1*mSATA, 2*3W Speaker, DC 9~36V power input
ALAD-K1550T(P)/S002	Intel® Core i5-1135G7	T(P): Projected Capacitive Touch	
ALAD-K1550T(P)/S003	Intel® Core i7-1165G7		
ALAD-K1550T(P)/S004	Intel® Celeron 6305E		
ECX-168	1*PCIeX4 slot(X4 signal) (non COM3&4 in use)		
ECI-169	1*32-bit PCI slot (non COM3&4 in use)		
PA-60DC12	AC/DC power adapter, DC12V@5A, 60W		
PA-120DC19	AC/DC power adapter, DC19V@6.32A, 120W (when use POE network card for expansion)		

ALAD-K1551T(P)

15" TFT LCD Capacitive/Resistive Touch, Intel® Tigerlake CPU, 4*COM, 2*LAN, 4*USB3.2, 1*USB2.0, 1* Line out, 1*2.5"SATA, 1*mSATA, DC 9~36V

Key Specification

- Aluminum die-casting chassis
- 15" TFT LCD, Multi-point capacitive touch
- Intel® Tigerlake CPU, fanless design
- 1*DDR4 3200 SODIMM, up to 32GB
- 1*Mini PCIe, 1*M.2 B-Key Type 3042/3052
- 4*COM, 2*LAN, 4*USB3.2, 1*USB2.0, 1*8-bit DIO(opt.)
- 2.5"SATA Bay, 1*mSATA, 1*Line out, 2*3W Speaker
- Optional 1*PCIeX4 slot (PCIE4 signal) or 1*PCI slot
- DC 9~36V power input
- Standard VESA mount and panel mounting



Product Overview

The ALAD-K1551T/T(P) is an industrial tablet powered by Intel® Tiger lake U series processors. It adopts 15 "1024*768 resolution TFT LCD and fully fits surface projection multi-point capacitive touch screen. The product has a comprehensive I/O interface, supporting 1*2.5"SATA disk and 1*mSATA dual storage; Built-in 1*Mini PCIe and 1*M.2 3042/3052 expansions, wide voltage DC power supply from 9 to 36V, aluminum die-cast body without fan heat dissipation, various installation modes, suitable for intelligent MES system and device management HMI.

Product Parameters

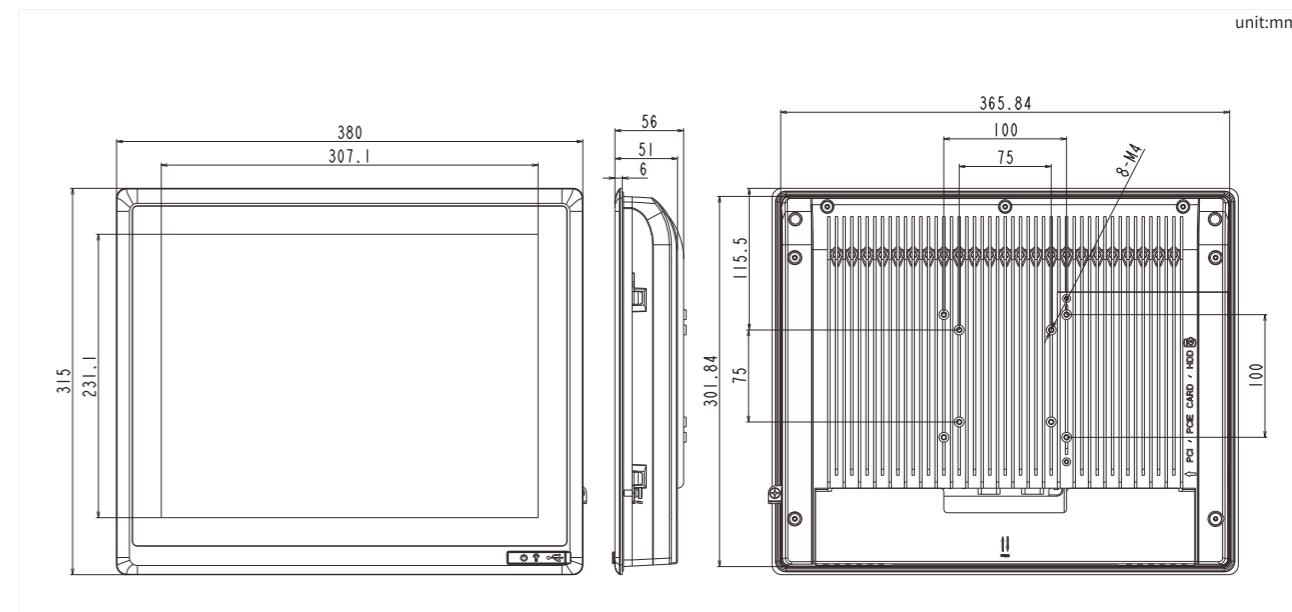
System	
CPU	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W
RAM	1*DDR4, 3200MHz SODIMM, 32GB max.
Graphics	Intel®UHD/ Intel® Iris® Xe Graphics: Intel DL boost, DirectX12.1, OpenGL 4.6 and OpenCL 3.0; HDMI:4096*2304@60Hz
I/O Port	
LAN	2*Intel I226V, 10M-1000M, WOL
USB	4*USB3.2, 1*USB2.0
Display	1*HDMI
Audio	1*Line out, Realtek ALC897, 2*3W Speaker
Serial port	2*RS232/422/485+2*RS232
LCD Display	
Dimension	15.0" TFT LCD
Resolution	1024*768@60Hz
Max. colors	16.2M
Luminance(cd/m²)	350
Viewing Angle	80°(L), 80°(R), 80°(U), 80°(D)
Touchscreen	
Touch type	5-wire resistive touch screen/projected capacitive touch screen
Transmittance	83%/90%
Controller	USB
Storage	
Storage	1*2.5" SATA3.0 HDD/SSD, 1*mSATA

Expansion	
Expansion	1*Mini PCIe(PCle&USB),PCIe module; 1*M.2 3042/3052(+SIM), 4G LTE/5G NR (Opt.)1*PCIeX4(X4)/1*32-bit PCI
Power Supply	
Input voltage & TDP	DC IN 9~36V; 11.52W (CPU i7-1165G7, 8G DDR4, 128G SSD)
Mechanical	
Structure	Aluminum die-casting front bezel , fin-shaped radiator shell
Dimension (W*H*D)	380*315*56mm Panel mounting opening size(W*H): 368*303mm
Installation	Panel/Rack/VESA(100*100/75*75mm)
Net Weight	4.3KG
Environmental	
Operating Temp	0~50°C, HDD(-10~55°C, SSD), airflow
Storage Temp	-20°C~60°C
Storage Humidity	10~95%@40°C, non-condensing
Vibration	1g 5~500Hz,with HDD
Shock	10g peak acceleration(duration 11ms) with HDD
EMC	CE,FCC Class A
OS	
	Windows 11/10*IoT enterprise, Android, SUSE, Ubuntu, Wind River, Red Hat*Enterprise, Wind River VxWorks*7, Yocto

I/O View



Dimensions



Ordering Information

Model	Processor	Touch Screen	Specifications
ALAD-K1551/S001	Intel® Core i3-1115G4	T:	15" TFT LCD, 4*COM, 4*USB3.2, 1*USB2.0, 2*LAN, 1*HDMI, 1*Mini PCIe, 1*M.2 B-Key, 1*Line out, 1*2.5"SATA, 1*mSATA, 2*3W Speaker, DC 9~36V
ALAD-K1551/S002	Intel® Core i5-1135G7	5 wire resistive touch	T(P): Projected Capacitive Touch
ALAD-K1551/S003	Intel® Core i7-1165G7		
ALAD-K1551/S004	Intel® Celeron 6305E		
ECX-168	1*PCIeX4 slot(X4) (non COM3&4 in use)		
ECI-169	1*32-bit PCI slot (non COM3&4 in use)		
PA-60DC12	AC/DC power adapter, DC12V@5A, 60W		
PA-120DC19	AC/DC power adapter, DC19V@6.32A, 120W (when use POE network card for expansion)		

ALAD-K1750T(P)

17.0" TFT LCD Capacitive/Resistive Touch, Intel® Tigerlake CPU, 4*COM, 2*LAN, 4*USB3.2, 1*USB2.0, 1* Line out, 1*2.5"SATA, 1*mSATA, DC 9~36V

Key Specification

- Aluminum die-casting chassis
- 17.0" TFT LCD, Multi-point capacitive/5 wire resistive touch
- Intel® Tigerlake CPU, fanless design
- 1*DDR4 3200 SODIMM, up to 32GB
- 1*Mini PCIe, 1*M.2 B-Key Type 3042/3052
- 4*COM, 2*LAN, 4*USB3.2, 1*USB2.0, 1*8-bit DIO(opt.)
- 2.5" SATA Bay, 1*mSATA, 1*Line out, 2*3W Speaker
- DC 9~36V power input
- Standard VESA mount and panel mounting



Product Overview

The ALAD-K1750T/T(P) is a tablet powered by Intel® Tiger lake U series processors. It adopts 17.0 "1280*1024 resolution TFT LCD and fully fits surface projection multi-point capacitive/5 wire resistive touch screen. The product has a comprehensive I/O interface, supporting 1*2.5 "SATA disk and 1*mSATA dual storage; Built-in 1*Mini PCIe and 1*M.2 3042/3052 expansions, wide voltage DC power supply from 9 to 36V, aluminum die-cast body without fan heat dissipation, various installation modes, suitable for intelligent MES system and device management HMI.

Product Parameters

System	
CPU	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W
RAM	1*DDR4, 3200Mhz SODIMM, 32GB max.
Graphics	Intel®UHD/ Intel® Iris® Xe Graphics: Intel DL boost, DirectX12.1, OpenGL 4.6 and OpenCL 3.0; HDMI:4096*2304@60Hz

I/O Port	
LAN	2*Intel I226V, 10M-1000M, WOL
USB	4*USB3.2, 1*USB2.0
Display	1*HDMI
Audio	1*Line out, Realtek ALC897, 2*3W Speaker
Serial port	2*RS232/422/485+2*RS232

LCD Display	
Dimension	17.0" TFT LCD
Resolution	1280*1024@60Hz
Max. colors	16.2M
Luminance(cd/m^2)	350
Viewing Angle	80°(L), 80°(R), 80°(U), 80°(D)
Touchscreen	
Touch type	5-wire resistive touch screen/projected capacitive touch screen
Transmittance	83%/90%
Controller	USB
Storage	
Storage	1*2.5" SATA3.0 HDD/SSD, 1*mSATA

Expansion	
Expansion	1*Mini PCIe(PCle&USB),PCIe module; 1*M.2 3042/3052(+SIM), 4G LTE/5G NR
Power Supply	
Input voltage & TDP	DC IN 9~36V; 11.52W (CPU i7-1165G7, 8G DDR4, 128G SSD)

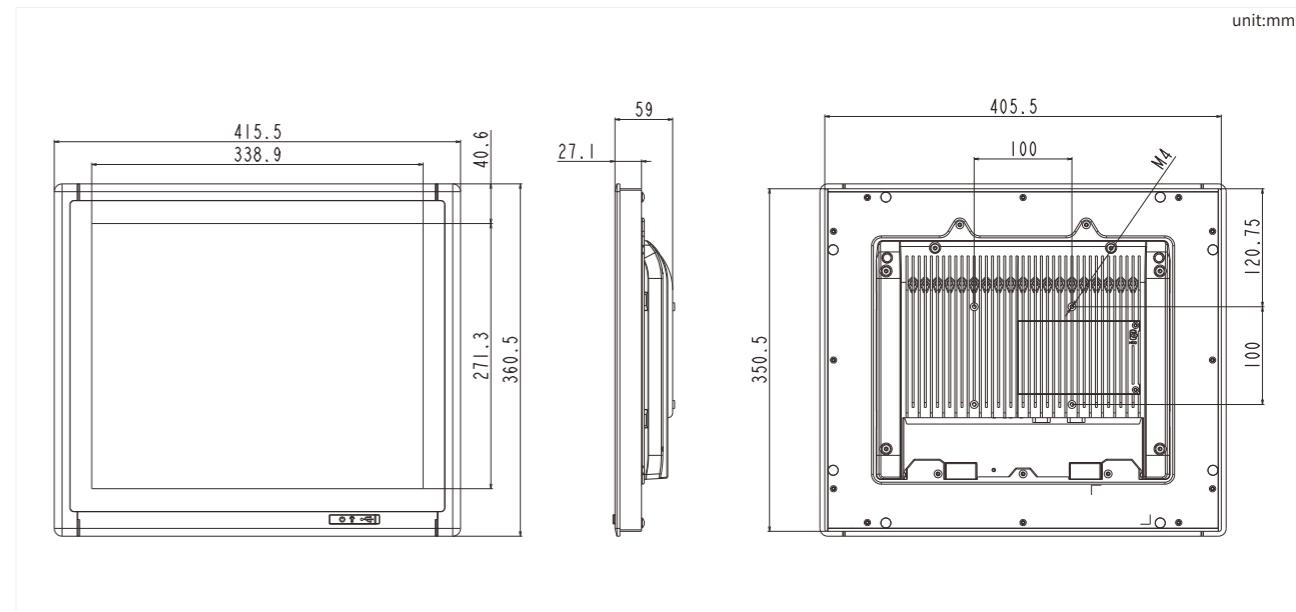
Mechanical	
Structure	Aluminum die-casting front bezel , fin-shaped radiator shell
Dimension (W*H*D)	415.5*360.5*59mm Panel mounting opening size(W*H): 407*352mm
Installation	Panel/Rack/VESA(100*100/75*75mm)
Net Weight	6.1KG

Environmental	
Operating Temp	0~50°C, HDD(-10~55°C, SSD),airflow
Storage Temp	-20°C~60°C
Storage Humidity	10~95%@40°C, non-condensing
Vibration	1g 5~500Hz,with HDD
Shock	10g peak acceleration(duration 11ms) with HDD
EMC	CE,FCC Class A
OS	Windows 11/10*IoT enterprise, Android,SUSE,Ubuntu, Wind River, Red Hat*Enterprise, Wind River VxWorks*7, Yocto

I/O View



Dimensions



Ordering Information

Model	Processor	Touch Screen	Specifications
ALAD-K1750/S001	Intel® Core i3-1115G4	T:	17" TFT LCD, 4*COM, 2*LAN, 4*USB3.2, 1*USB2.0, 1*HDMI, 1*Mini PCIe, 1*M.2 B-Key, 1*Line out, 1*2.5"SATA, 1*mSATA, 2*3W Amplifier, DC 9~36V
ALAD-K1750/S002	Intel® Core i5-1135G7	5-wire resistive touch screen	T(P): Projected capacitive touch screen
ALAD-K1750/S003	Intel® Core i7-1165G7		
ALAD-K1750/S004	Intel® Celeron 6305E		
PA-60DC12	AC/DC power adapter, DC12V/5A, 60W		1*COM adapter cable (one drag two, DB9 form)

ALAD-K1850T(P)

18.5" TFT LCD Capacitive Touch, Intel® Tigerlake CPU, 4*COM, 2*LAN, 4*USB3.2, 1* Line out, 1*2.5" SATA, 1*mSATA, DC 9~36V

Key Specification

- Aluminum die-casting chassis
- 18.5" TFT LCD, Multi-point capacitive touch
- Intel® Tigerlake CPU, fanless design
- 1*DDR4 3200 SODIMM, up to 32GB
- 1*Mini PCIe, 1*M.2 B-Key Type 3042/3052
- 4*COM, 2*LAN, 4*USB3.2, 1*8-bit DIO (opt.)
- 2.5" SATA Bay, 1*mSATA, 1*Line out, 2*3W Speaker
- DC 9~36V power input
- Standard VESA mount and panel mounting



Product Overview

The ALAD-K1850T(P) is a tablet powered by Intel® Tiger lake U-series processors. It adopts 18.5 "1366*768 resolution TFT LCD and fully fits surface projection multi-point capacitive touch screen. The product has a comprehensive I/O interface, supporting 1*2.5 "SATA disk and 1*mSATA dual storage; Built-in 1*Mini PCIe and 1*M.2 3042/3052 expansions, wide voltage DC power supply from 9 to 36V, aluminum die-cast body without fan heat dissipation, various installation modes, suitable for intelligent MES system and device management HMI.

Product Parameters

System

CPU	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W
RAM	1*DDR4, 3200MHz SODIMM, 32GB max.
Graphics	Intel®UHD/ Intel® Iris® Xe Graphics: Intel DL boost, DirectX12.1, OpenGL 4.6 and OpenCL 3.0; HDMI:4096*2304@60Hz

I/O Port

LAN	2*Intel I226V, 10M-1000M, WOL
USB	4*USB3.2
Display	1*HDMI
Audio	1*Line out, Realtek ALC897,2*3W Speaker
Serial port	2*RS232/422/485+2*RS232

LCD Display

Dimension	18.5" TFT LCD
Resolution	1366*768@60Hz
Max. colors	16.2M
Luminance (cd/m²)	350
Viewing Angle	85°(L), 85°(R), 80°(U), 80°(D)

Touchscreen

Touch type	projected capacitive touch screen
Transmittance	90%
Controller	USB

Storage

Storage	1*2.5" SATA3.0 HDD/SSD, 1*mSATA
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Expansion

Expansion	1*Mini PCIe(PCle&USB),PCIe module; 1*M.2 3042/3052(+SIM),4G LTE/5G NR
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Power Supply

Input voltage & TDP	DC IN 9~36V; 11.52W (CPU i7-1165G7, 8G DDR4, 128G SSD)
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Mechanical

Structure	Aluminum die-casting front bezel , fin-shaped radiator shell
Dimension (W*H*D)	483*305*59mm Panel mounting opening size(W*H): 474*396mm
Installation	Panel/VESA(100*100/75*75mm)
Net Weight	6.63KG

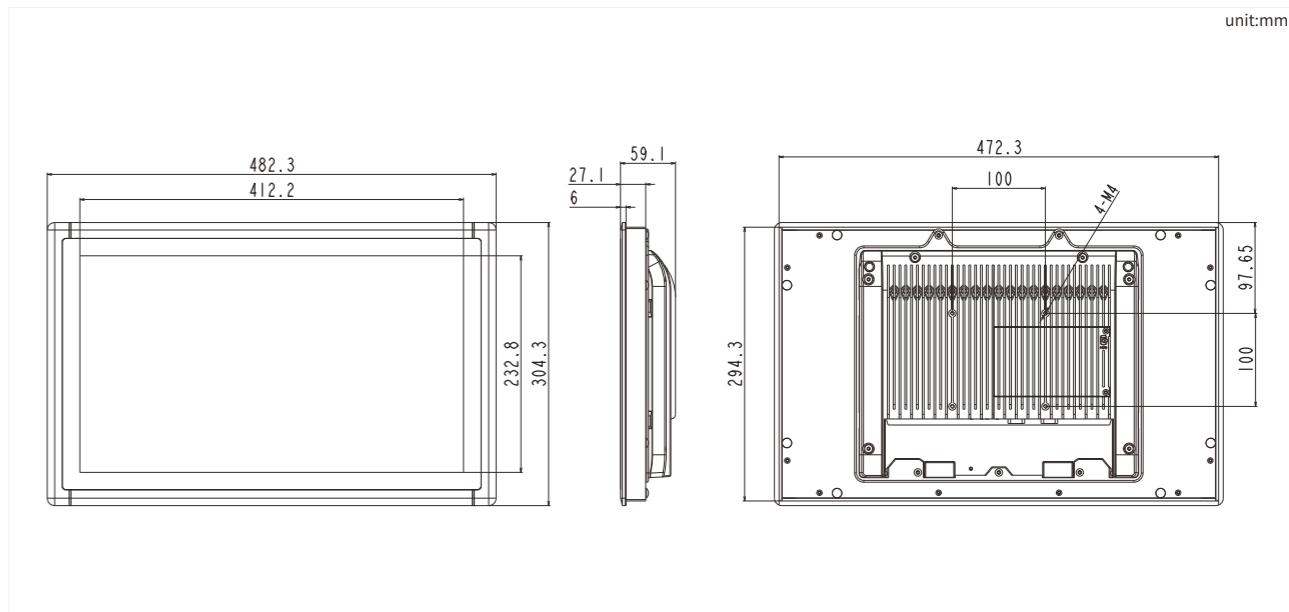
Environmental

Operating Temp	0~50°C, HDD(-10~55°C, SSD),airflow
Storage Temp	-20°C~60°C
Storage Humidity	10~95%@40°C, non-condensing
Vibration	1g 5~500Hz,with HDD
Shock	10g peak acceleration(duration 11ms) with HDD
EMC	CE,FCC Class A
OS	Windows 11/10*IoT enterprise, Android,SUSE,Ubuntu,Wind River, Red Hat*Enterprise,Wind River VxWorks*7,Yocto

I/O View



Dimensions



Ordering Information

Model	Processor	Touch Screen	Specifications
ALAD-K1850T(P)/S001	Intel® Core i3-1115G4		
ALAD-K1850T(P)/S002	Intel® Core i5-1135G7		
ALAD-K1850T(P)/S003	Intel® Core i7-1165G7		
ALAD-K1850T(P)/S004	Intel® Celeron 6305E		
PA-60DC12	AC/DC power adapter, DC12V/5A, 60W		
	1*COM adapter cable (one drag two, DB9 form)		
	T(P): Projected capacitive touch screen		18.5" TFT LCD, 4*COM, 2*LAN, 4*USB3.2, 1*HDMI, 1*Mini PCIe, 1*M.2 B-Key, 1*Line out, 1*2.5"SATA, 1*mSATA, 2*3W Amplifier, DC 9~36V

ALAD-K1950T(P)

19.0" TFT LCD Capacitive/Resistive Touch, Intel® Tigerlake CPU, 4*COM, 2*LAN, 4*USB3.2, 1*USB2.0, 1* Line out, 1*2.5"SATA, 1*mSATA, DC 9~36V

Key Specification

- Aluminum die-casting chassis
- 19.0" TFT HD LCD, Multi-point capacitive/5 wire resistive touch
- Intel® Tigerlake CPU, fanless design
- 1*DDR4 3200 SODIMM, up to 32GB
- 1*Mini PCIe, 1*M.2 B-Key Type 3042/3052
- 4*COM, 2*LAN, 4*USB3.2, 1*USB2.0, 1*8-bit DIO (opt.)
- 2.5"SATA Bay, 1*mSATA, 1*Line out, 2*3W Speaker
- Optional 1*PCIeX4(X4) or 1*PCI
- DC 9~36V power input
- Standard VESA mount and panel mounting



Product Overview

The ALAD-K1950T/T(P) is a tablet powered by Intel® Tiger lake U-series processors. It adopts 19.0 "1280*1024 resolution TFT LCD and fully fits surface projection multi-point capacitive/5 wire resistive touch. The product has a comprehensive I/O interface, supporting 1*2.5 "SATA disk and 1*mSATA dual storage; Built-in 1*Mini PCIe and 1*M.2 3042/3052 expansions, wide voltage DC power supply from 9 to 36V, aluminum die-cast body without fan heat dissipation, various installation modes, suitable for intelligent MES system and device management HMI.

Product Parameters

System	
CPU	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W
RAM	1*DDR4, 3200MHz SODIMM, 32GB max.
Graphics	Intel®UHD/ Intel® Iris® Xe Graphics: Intel DL boost, DirectX12.1, OpenGL 4.6 and OpenCL 3.0; HDMI:4096*2304@60Hz

I/O Port	
LAN	2*Intel I226V, 10M-1000M, WOL
USB	4*USB3.2, 1*USB2.0
Display	1*HDMI
Audio	1*Line out, Realtek ALC897, 2*3W Speaker
Serial port	2*RS232/422/485+2*RS232

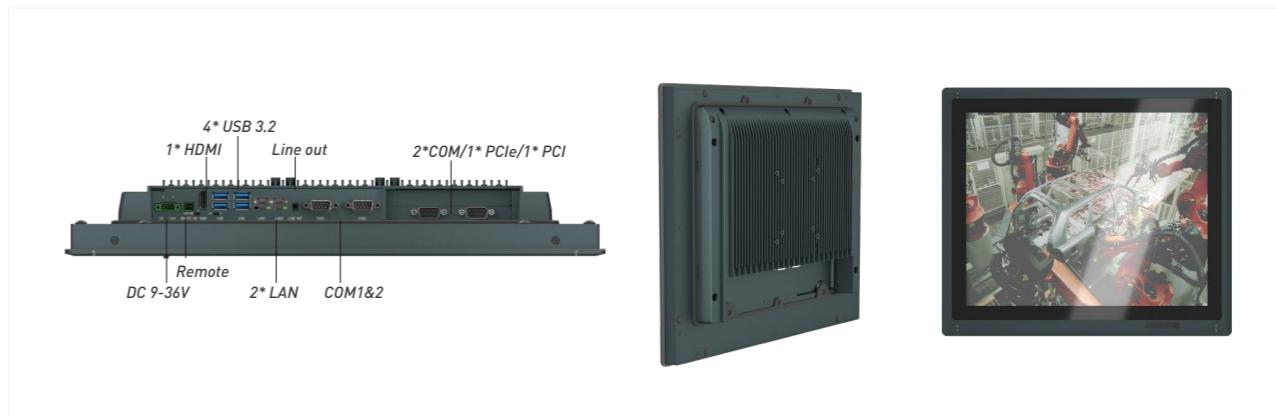
LCD Display	
Dimension	19.0" TFT LCD
Resolution	1280*1024@60Hz
Max. colors	16.7M
Luminance (cd/m²)	470
Viewing Angle	85°(L), 85°(R), 85°(U), 85°(D)
Touchscreen	
Touch type	5-wire resistive touch screen/projected capacitive touch screen
Transmittance	83%/90%
Controller	USB
Storage	
Storage	1*2.5" SATA3.0 HDD/SSD, 1*mSATA

Expansion	
Expansion	1*Mini PCIe(PCle&USB),PCle module; 1*M.2 3042/3052(+SIM), 4G LTE/5G NR
Power Supply	
Input voltage & TDP	DC IN 9~36V; 11.52W (CPU i7-1165G7, 8G DDR4, 128G SSD)

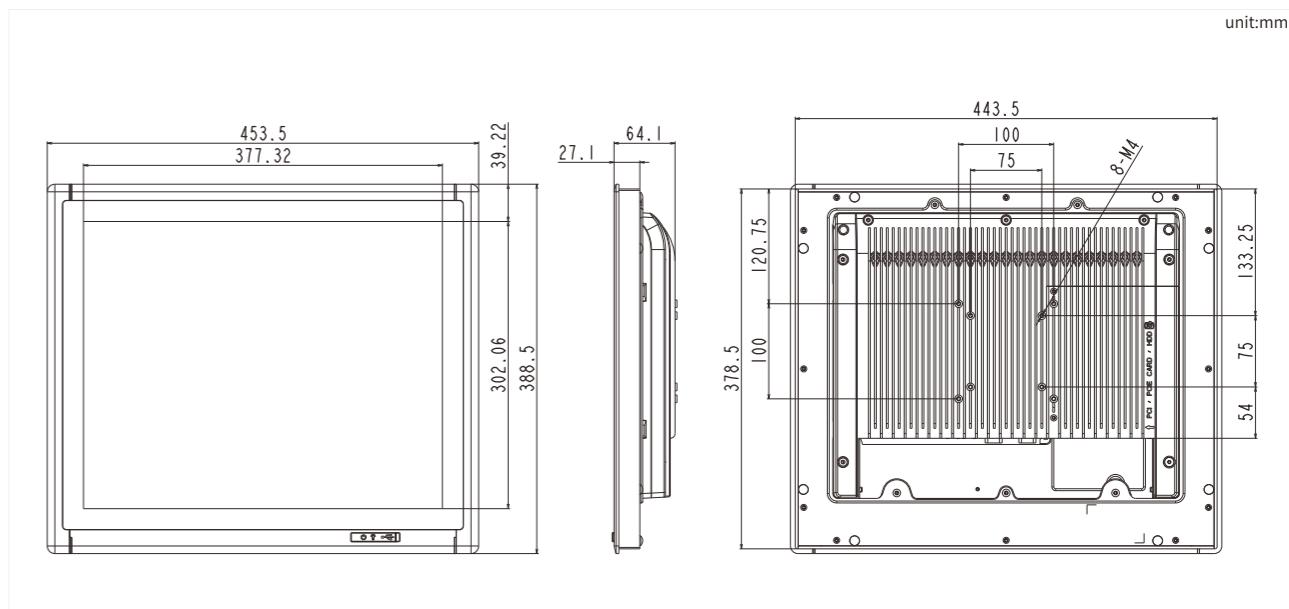
Mechanical	
Structure	Aluminum die-casting front bezel , fin-shaped radiator shell
Dimension (W*H*D)	453.5*388.5*64mm Panel mounting opening size(W*H): 445*380mm
Installation	Panel/Rack/VESA(100*100/75*75mm)
Net Weight	6.9KG

Environmental	
Operating Temp	0~50°C, HDD(-10~55°C, SSD), airflow
Storage Temp	-20°C~60°C
Storage Humidity	10~95%@40°C, non-condensing
Vibration	1g 5~500Hz,with HDD
Shock	10g peak acceleration(duration 11ms) with HDD
EMC	CE,FCC Class A
OS	Windows 11/10*IoT enterprise, Android,SUSE,Ubuntu, Wind River, Red Hat*Enterprise, Wind River VxWorks*7, Yocto

I/O View



Dimensions



Ordering Information

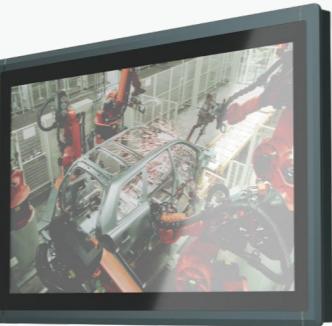
Model	Processor	Touch Screen	Specifications
ALAD-K1950/S001	Intel® Core i3-1115G4	T:	19" TFT LCD, 4*COM, 2*LAN, 4*USB3.2, 1*USB2.0, 1*HDMI, 1*Mini PCIe, 1*M.2 B-Key, 1*Line out, 1*2.5"SATA, 1*mSATA, 2*3W Amplifier, DC 9~36V
ALAD-K1950/S002	Intel® Core i5-1135G7	T:	Projected capacitive touch screen
ALAD-K1950/S003	Intel® Core i7-1165G7	T(P):	Projected capacitive touch screen
ALAD-K1950/S004	Intel® Celeron 6305E		
ECX-168			1*PCIeX4 slot(X4 signal) (non COM3&4 in use)
ECI-169			1*32-bit PCI slot (non COM3&4 in use)
PA-60DC12			AC/DC power adapter, DC12V@5A ,60W
PA-120DC19			AC/DC power adapter, DC19V@6.32A ,120W (when use POE network card for expansion)

ALAD-K2150T(P)

21.5" TFT LCD Capacitive Touch, Intel® Tigerlake CPU, 4*COM, 2*LAN, 4*USB3.2, 1* Line out, 1*2.5" SATA, 1*mSATA, DC 9~36V

Key Specification

- Aluminum die-casting chassis
- 21.5" TFT LCD, Multi-point capacitive touch
- Intel® Tigerlake CPU, fanless design
- 1*DDR4 3200 SODIMM, up to 32GB
- 1*Mini PCIe, 1*M.2 B-Key Type 3042/3052
- 4*COM, 2*LAN, 4*USB3.2, 1*8-bit DIO (opt.)
- 2.5"SATA Bay, 1*mSATA, 1*Line out, 2*3W Speaker
- Optional 1*PCIeX4 slot (PCIE4 signal) or 1*PCI slot
- DC 9~36V power input
- Standard VESA mount and panel mounting



Product Overview

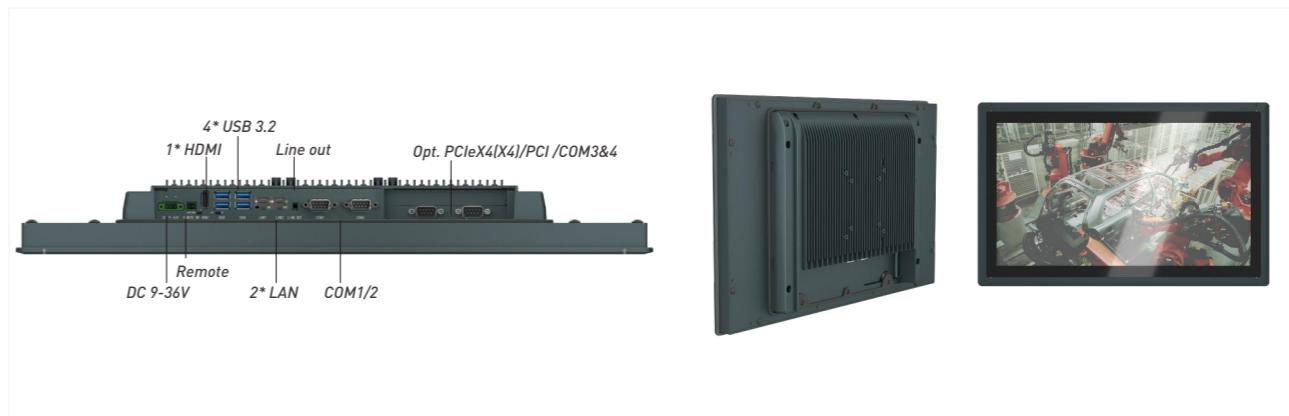
ALAD-K2150T(P) is a tablet powered by Intel® Tiger lake U series processors. It adopts 21.5 "1920*1080 resolution TFT LCD and fully fits surface projection multi-point capacitive touch screen. The product has a comprehensive I/O interface, supporting 1*2.5 "SATA disk and 1*mSATA dual storage; Built-in 1*Mini PCIe and 1*M.2 3042/3052 expansions, wide voltage DC power supply from 9 to 36V, aluminum die-cast body without fan heat dissipation, various installation modes, suitable for intelligent MES system and device management HMI.

Product Parameters

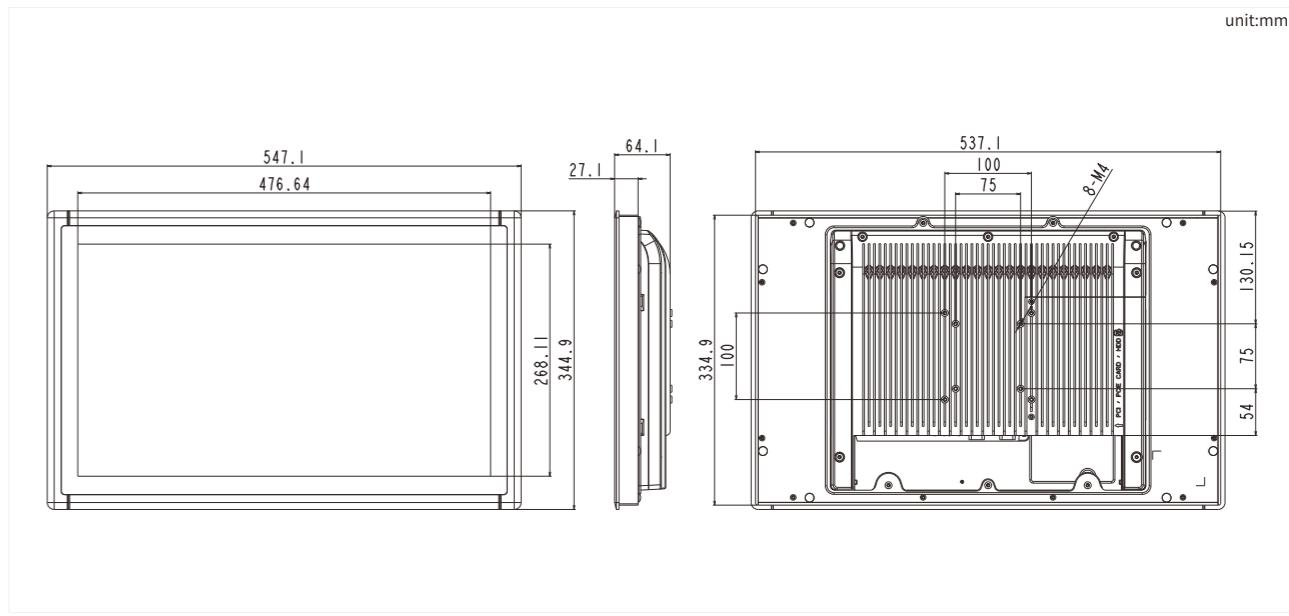
System	
CPU	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W
RAM	1*DDR4, 3200Mhz SODIMM, 32GB max.
Graphics	Intel®UHD/ Intel® Iris® Xe Graphics: Intel DL boost, DirectX12.1, OpenGL 4.6 and OpenCL 3.0; HDMI:4096*2304@60Hz
I/O Port	
LAN	2*Intel I226V, 10M-1000M, WOL
USB	4*USB3.2
Display	1*HDMI
Audio	1*Line out, Realtek ALC897,2*3W Speaker
Serial port	2*RS232/422/485+2*RS232
LCD Display	
Dimension	21.5" TFT LCD
Resolution	1920*1080@60Hz
Max. colors	16.7M
Luminance (cd/m²)	300
Viewing Angle	89°(L), 89°(R), 89°(U),89°(D)
Touchscreen	
Touch type	projected capacitive touch screen
Transmittance	90%
Controller	USB
Storage	
Storage	1*2.5" SATA3.0 HDD/SSD, 1*mSATA

Expansion	
Expansion	1*Mini PCIe(PCle&USB),PCIe/USB module; 1*M.2 B-Key 3042/3052(+SIM), 4G LTE/5G NR; Opt. 1*PCIeX4 (X4) or 1*32 bit PCI
Power Supply	
Input voltage & TDP	DC IN 9~36V; 11.52W (CPU i7-1165G7, 8G DDR4, 128G SSD)
Mechanical	
Structure	Aluminum die-casting front bezel , fin-shaped radiator shell
Dimension (W*H*D)	574*345*64mm Panel mounting opening size(W*H): 538*335mm
Installation	Panel/VESA(100*100/75*75mm)
Net Weight	8.15KG
Environmental	
Operating Temp	0~50°C, HDD(-10~55°C, SSD),airflow
Storage Temp	-20°C~60°C
Storage Humidity	10~95%@40°C, non-condensing
Vibration	1g 5~500Hz,with HDD
Shock	10g peak acceleration(duration 11ms) with HDD
EMC	CE,FCC Class A
OS	
	Windows 11/10*IoT enterprise, Android,SUSE,Ubuntu, Wind River, Red Hat*Enterprise, Wind River VxWorks*7, Yocto

I/O View



Dimensions



Ordering Information

Model	Processor	Touch Screen	Specifications
ALAD-K2150T(P)/S001	Intel® Core i3-1115G4		
ALAD-K2150T(P)/S002	Intel® Core i5-1135G7	T(P): Projected capacitive touch screen	21.5" TFT LCD,4*COM, 2*LAN, 4*USB3.2, 1*HDMI, 1*Mini PCIe, 1*M.2 B-Key, 1*Line out, 1*2.5"SATA, 1*mSATA, 2*3W Amplifier, DC 9~36V
ALAD-K2150T(P)/S003	Intel® Core i7-1165G7		
ALAD-K2150T(P)/S004	Intel® Celeron 6305E		
ECX-168	1*PCIeX4 slot (X4 signal) (non COM3&4 in use)		
ECI-169	1*32-bit PCI slot (non COM3&4 in use)		
PA-60DC12	AC/DC power adapter, DC12V@5A ,60W		
PA-120DC19	AC/DC power adapter, DC19V@6.32A ,120W (when use POE network card for expansion)		

ALAD-K2350T(P)

23.8" TFT LCD Capacitive Touch, Intel® Tigerlake CPU, 4*COM, 2*LAN, 4*USB3.2, 1* Line out, 1*2.5" SATA bay, 1*mSATA, DC 9~36V

Key Specification

- Aluminum die-casting chassis, Full Flat Mirror Panel
- 23.8" Full HD LCD, Multi-point capacitive touch
- Intel® Tigerlake CPU, fanless design
- 1*DDR4 3200 SODIMM, up to 32GB
- 1*Mini PCIe, 1*M.2 B-Key Type 3042/3052
- 4*COM, 2*LAN, 4*USB3.2, 1*8-bit DIO (opt.)
- 2.5"SATA Bay, 1*mSATA, 1*Line out, 2*3W Speaker
- Optional 1*PCIeX4(X4) or 1*PCI
- DC 9~36V power input
- Standard VESA mount and panel mounting



Product Overview

ALAD-K2350T(P) is a full flat mirror panel powered by an Intel® Tiger lake U series processor. It adopts 23.8 "1920*1080 resolution full HD TFT LCD and fully fits surface projection multi-point capacitive touch screen. The product has a comprehensive I/O interface, supporting 1*2.5 "SATA disk and 1*mSATA dual storage; Built-in 1*Mini PCIe and 1*M.2 3042/3052 expansions, wide voltage DC power supply from 9 to 36V, aluminum die-cast body without fan heat dissipation, various installation modes, suitable for intelligent MES system and device management HMI.

Product Parameters

System	
CPU	Intel® Tigerlake U Celeron/Core i3/i5/i7 CPU, ULT SoC, TDP 12W/15W
RAM	1*DDR4, 3200MHz SODIMM, 32GB max.
Graphics	Intel®UHD/ Intel® Iris® Xe Graphics: Intel DL boost, DirectX12.1, OpenGL 4.6 and OpenCL 3.0; HDMI:4096*2304@60Hz

I/O Port	
LAN	2*Intel I226V, 10M-1000M, WOL
USB	4*USB3.2
Display	1*HDMI
Audio	1*Line out, Realtek ALC897,2*3W Speaker
Serial port	2*RS232/422/485+2*RS232

LCD Display	
Dimension	23.8" TFT LCD
Resolution	1920*1080@60Hz
Max. colors	16.2M
Luminance (cd/m²)	350
Viewing Angle	89°(L), 89°(R), 89°(U),89°(D)

Touchscreen	
Touch type	projected capacitive touch screen
Transmittance	≥85%
Controller	USB

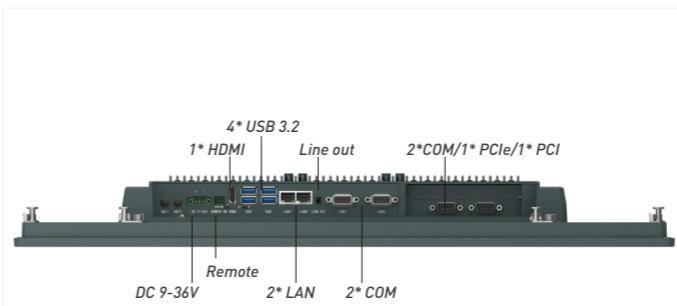
Storage	
Storage	1*2.5" SATA3.0 HDD/SSD, 1*mSATA

Expansion	
Expansion	1*Mini PCIe(PCle&USB),PCle/USB module; 1*M.2 B-Key 3042/3052(+SIM), 4G LTE/5G NR; Opt. 1*PCIeX4 (X4) or 1*32 bit PCI
Power Supply	
Input voltage & TDP	DC IN 9~36V; 11.52W (CPU i7-1165G7, 8G DDR4, 128G SSD)

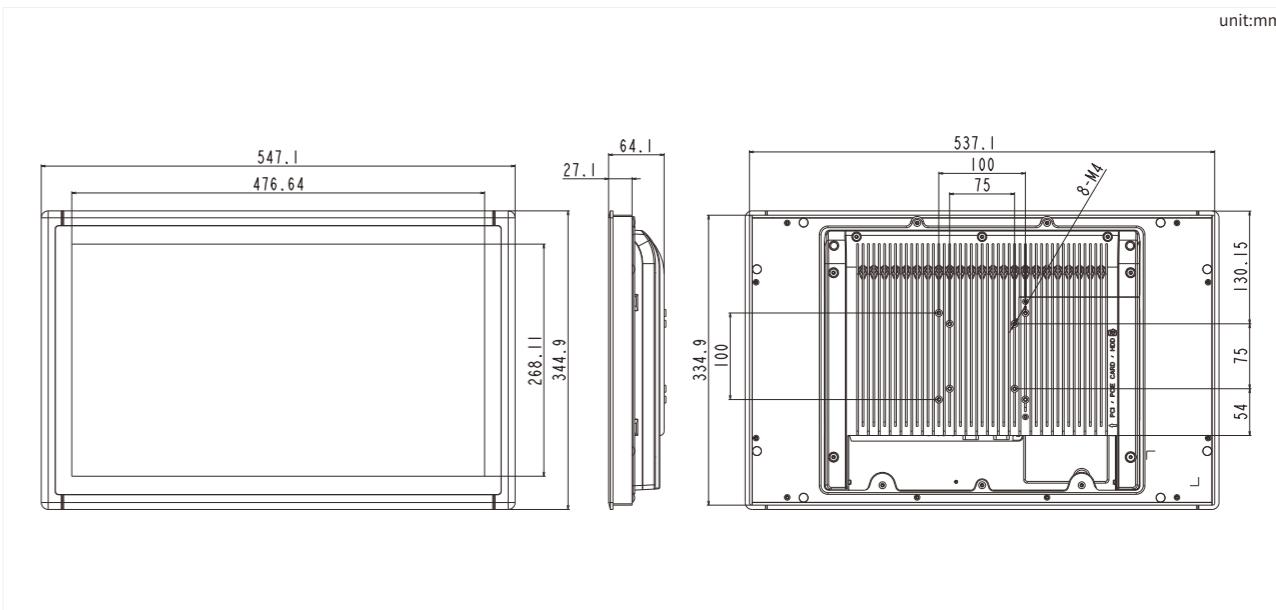
Mechanical	
Structure	Aluminum die-casting front bezel , fin-shaped radiator shell
Dimension (W*H*D)	594*375*64mm Panel mounting opening size(W*H): 583*364mm
Installation	Panel/VESA(100*100/75*75mm)
Net Weight	7.74KG

Environmental	
Operating Temp	0~50°C, HDD(-10 ~ 55°C, SSD),airflow
Storage Temp	-20°C~60°C
Storage Humidity	10~95%@40°C, non-condensing
Vibration	1g 5~500Hz,with HDD
Shock	10g peak acceleration(duration 11ms) with HDD
EMC	CE,FCC Class A
OS	Windows 11/10*IoT enterprise, Android,SUSE,Ubuntu,Wind River, Red Hat*Enterprise,Wind River VxWorks*7,Yocto

I/O View



Dimensions



Ordering Information

Model	Processor	Touch Screen	Specifications
ALAD-K2150T(P)/S001	Intel® Core i3-1115G4		
ALAD-K2150T(P)/S002	Intel® Core i5-1135G7	T(P): Projected capacitive touch screen	23.8" TFT LCD, 4*COM, 4*USB3.2, 2*LAN, 1*HDMI, 1*Mini PCIe, 1*M.2 B-Key , 1*Line out, 1*2.5" SATA Bay, 1*mSATA, 2*3W Speaker, DC 9~36V
ALAD-K2150T(P)/S003	Intel® Core i7-1165G7		
ALAD-K2150T(P)/S004	Intel® Celeron 6305E		
ECX-168	1*PCIeX4 slot(X4 signal) (non COM3&4 in use)		
ECI-169	1*32-bit PCI slot (non COM3&4 in use)		
PA-60DC12	AC/DC power adapter, DC12V@5A ,60W		
PA-120DC19	AC/DC power adapter, DC19V@6.32A ,120W (when use POE network card for expansion)		

WPPC-H1580T

Intel® Celeron J1900 CPU, 2*GbE LAN, 2*COM, 1*USB3.0, 3*USB2.0, 1*HDMI, 1*VGA, Stainless steel fanless design

Key Specification

- Intel® Baytrail Celeron J1900 2.0-2.42G CPU
- 1-Ch DDR3L 1333MHZ SODIMM, Up to 8GB
- SUS304 Stainless steel case, 3.0mm 5052 Aluminum alloy back cover
- True-flat design, fanless design
- IP65/IP66 panel protection
- 15" LED TFT LCD, capacitive/Resistive touch screen
- 1*HDMI, 1*VGA, 2*GbE LAN, 2*COM, 1*USB3.0, 3*USB2.0
- 1*Opt. ANT, support 4G LTE or WiFi/BT4.0
- 1*Mini PCIe (PCIe+USB, w/SIM)
- 1*Simple-swap 2.5" SATA bay, 1*mSATA
- DC 9~36V wide power input



Product Overview

WPPC-H1580T is a rugged and ultra-reliable fanless embedded waterproof panel PC. The front panel uses a SUS304 stainless steel shell, and the back cover uses a 3.0mm 5052 aluminum alloy design, which can not only meet the CPU heat dissipation, but also meet the VESA installation. It has the characteristics of super waterproof, sturdy and reliable, high performance, multiple IO, multiple expansion, and wide range of applications. It's suitable for wet, cold and harsh environments.

Product Parameters

System	
CPU	Intel® Baytrail Celeron J1900 2.0-2.42G CPU
RAM	1*DDR3L,1333Mhz SODIMM, Max.8GB

Storage	
Storage	1*2.5" SATA(swappable), 1*mSATA Full-height card, support AHCI

Graphics	
Graphics	Gen.7 Intel® HD Graphics,LCD+HDMI+VGA 3 displays, OpenGL 3.2, DirectX 11, OpenCL 1.2, MPGE2/H.264 VGA:1920*1200@60Hz; HDMI 1920*1080@60Hz

Expansion	
Expansion Port	1*Mini PCIe, with SIM slot

Power Supply	
Power Supply & Power consumption	DC IN 9~36V, D-Jack w/M8, Power consumption: 19.5W

Mechanical	
Structure	SUS304 Stainless steel /5052 Aluminum alloy/SECC
Dimension (W*H*D)	405.22*328.22*52.1mm
Installation	Desktop mounting VESA(100*100mm)
Net Weight	5.8KG

LCD Display	
Dimension	15" TFT LED

Environmental	
Operating Temp	0~60°C

I/O Port	
LAN	2*Intel I211AT, Gigabit

Power Supply & Power consumption	DC IN 9~36V, D-Jack w/M8, Power consumption: 19.5W
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Display	
Display	1*HDMI+1*VGA

Mechanical	
Structure	SUS304 Stainless steel /5052 Aluminum alloy/SECC

Audio	
Audio	optional audio

| Dimension (W*H*D) | 405.22*328.22*52.1mm |

Serial port	
Serial port	2*RS232/422/485

| Installation | Desktop mounting VESA(100*100mm) |

LCD Display	
Dimension	15" TFT LED

| Net Weight | 5.8KG |

Touchscreen	
Touch type	5-wire resistive touch screen/projected capacitive touch screen

Environmental	

Light Transmission	
Light Transmission	83/90%

| Operating Temp | 0~60°C |

Controller	
Controller	USB/USB

| Storage Temp | -40°C~85°C |

Viewing Angle	
Viewing Angle	80°(left), 80°(right), 80°(up), 80°(down)

| Storage Humidity | 10~90%@40°C, No-condensation |

Vibration	
Vibration	1g 5~500Hz

| Shock | 10g peak acceleration(duration 11ms) with HDD |

EMC	
EMC	CE,FCC Class A

| OS | Windows 7,Windows 8.1, |

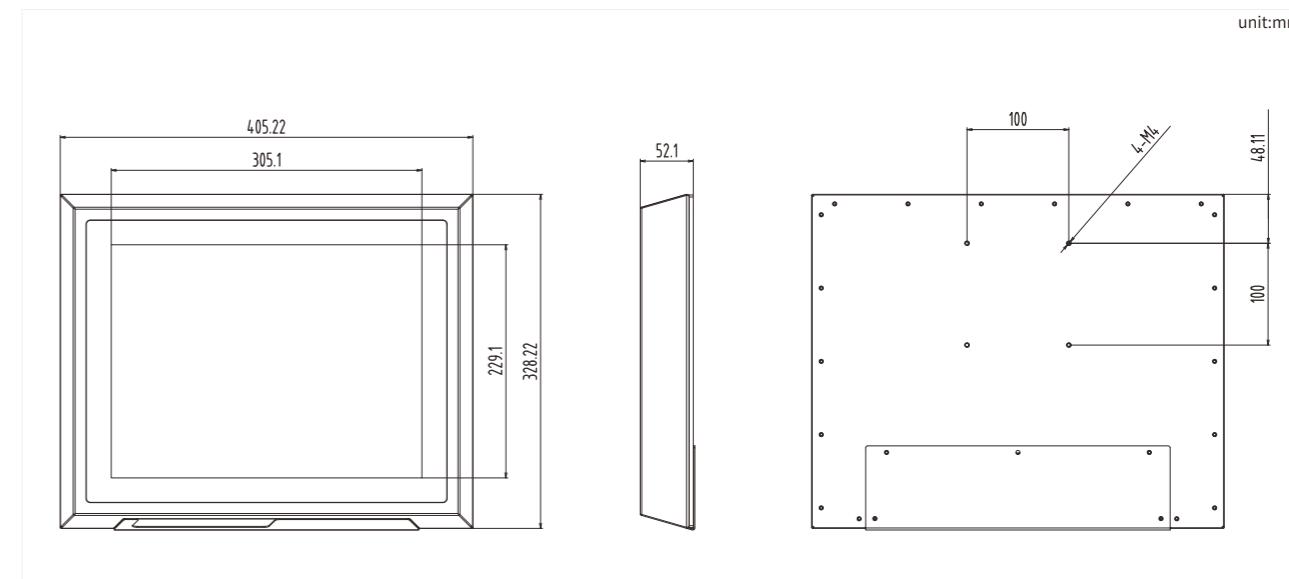
Controller	
Controller	USB/USB

| Windows 10,Linux Fedora Ubuntu | |

I/O View



Dimensions



Ordering Information

Model	Processor	Touch Screen
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WPPC-H1780T

Intel® Celeron J1900 CPU, 2*GbE LAN, 2*COM, 1*USB3.0, 3*USB2.0, 1*HDMI, 1*VGA, Stainless steel fanless design

Key Specification

- Intel® Baytrail Celeron J1900 2.0-2.42G CPU
- 1-Ch DDR3L 1333MHZ SODIMM, Up to 8GB
- SUS304 Stainless steel case, 3.0mm 5052 Aluminum alloy back cover
- True-flat design, fanless design
- IP65/IP66 panel protection
- 17" LED TFT LCD, Capacitive/Resistive touch screen
- 1*HDMI, 1*VGA, 2*GbE LAN, 2*COM, 1*USB3.0, 3*USB2.0
- 1*Opt. ANT, support 4G LTE or WiFi/BT4.0
- 1*Mini PCIe (PCIe+USB, w/SIM)
- 1*Simple-swap 2.5" SATA bay, 1*mSATA
- DC 9~36V wide power input



Product Overview

WPPC-H1780T is a rugged and ultra-reliable fanless embedded waterproof tablet PC. The front panel uses a SUS304 stainless steel shell, and the back cover uses a 3.0mm 5052 aluminum alloy design, which can not only meet the CPU heat dissipation, but also meet the VESA installation. It has the characteristics of advanced waterproof, sturdy and reliable, high performance, multiple IO, multiple expansion, and wide range of applications. It's suitable for wet, cold and harsh environments.

Product Parameters

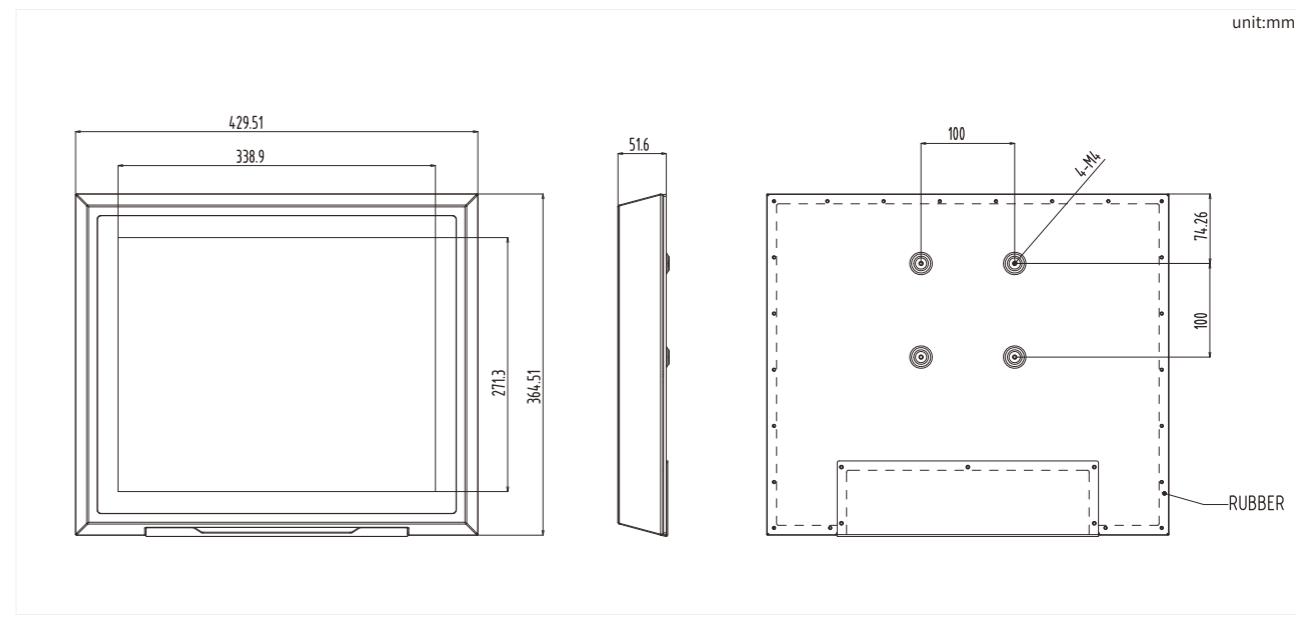
System	
CPU	Intel® Baytrail Celeron J1900 2.0-2.42G CPU
RAM	1*DDR3L,1333Mhz SODIMM Max. 8GB
Graphics	Gen.7 Intel® HD Graphics LCD+HDMI+VGA 3 displays, OpenGL 3.2, DirectX 11, OpenCL 1.2, MPGE2/H.264 VGA:1920*1200@60Hz; HDMI 1920*1080@60Hz
I/O Port	
LAN	2*Intel I211AT, Gigabit
USB	1*USB3.0, 3*USB2.0
Display	1*HDMI+1*VGA
Audio	optional audio
Serial port	2*RS232/422/485
LCD Display	
Display	17" TFT LED
Resolution	1280*1024
Max. colors	16.2M
Luminance(cd/m²)	600
Viewing Angle	80°(left), 80°(right), 70°(up), 80°(down)
Touchscreen	
Touch type	5-wire resistive touch screen/projected capacitive touch screen
Light Transmission	83/90%
Controller	USB/USB

Storage	
Storage	1*2.5" SATA (swappable) 1*mSATA Full-height card, support AHCI
Expansion	
Expansion Port	1*Mini PCIe, with SIM slot
Power Supply	
Power Supply & Power consumption	DC IN 9~36V, D-Jack w/M8, Power consumption: 30W
Mechanical	
Structure	SUS304 Stainless steel /5052 Aluminum alloy/SECC
Dimension (W*H*D)	429.51*364.51*52.1mm
Installation	Desktop mounting VESA(100*100mm)
Net Weight	5.57KG
Environmental	
Operating Temp	0~60°C
Storage Temp	-40°C~85°C
Storage Humidity	10~90%@40°C, No-condensation
Vibration	1g 5~500Hz
Shock	10g peak acceleration(duration 11ms) with HDD
EMC	CE,FCC Class A
OS	
Windows	7,Windows 8.1, Windows 10,Linux Fedora Ubuntu

I/O View

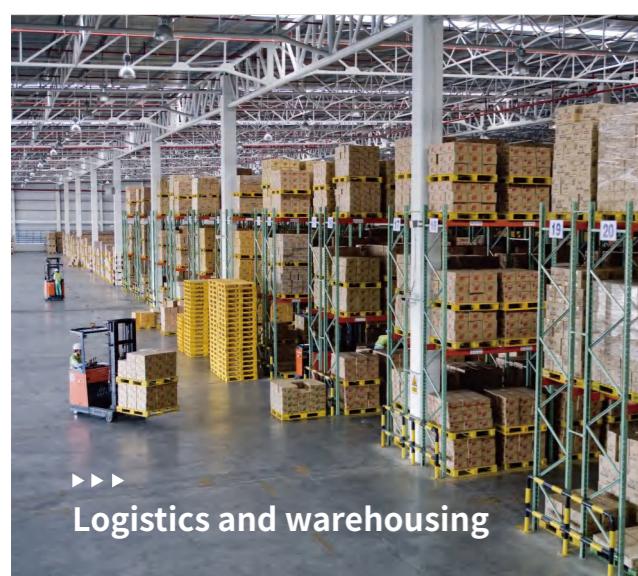


Dimensions



Ordering Information

Model	Processor	Touch Screen	Specifications
WPPC-H1780T-T001	Intel® Baytrail Celeron J1900 CPU	5-wire resistive touch screen	17" TFT LCD, 1*HDMI, 1*VGA, 2*GbE LAN, 2*COM, 1*Opt. ANT, 1*USB3.0, 3*USB2.0, 1*Mini PCIe, 1*swappable 2.5"SATA bay, 1*mSATA, DC 9~36V
WPPC-H1780T(P)-T001		Projected capacitive touch screen	
PA-60DC12		AC/DC power adapter, DC12V/5A, 60W	



ALAD-101T	ALAD-151T	ALAD-171T	ALAD-181T(P)	ALAD-191T	ALAD-211T(P)
LCD Display					
Dimension	10.1" TFT LED	15" TFT LED	17" TFT LED	18.5" TFT LED	19" TFT LED
Resolution	1280*800	1024*768	1280*1024	1366*768	1280*1024
Max. colors	16.7M	16.2M	16.2M	16.7M	16.7M
Max. Luminance	350	350	600	300	470
Viewing Angle	85°(left), 85°(right), 85°(up), 85°(down)	80°(left), 80°(right), 80°(up), 80°(down)	80°(left), 80°(right), 70°(up), 80°(down)	89°(left), 89°(right), 85°(up), 85°(down)	85°(left), 85°(right), 75°(up), 85°(down)
Backlight life	15000 hours/50000 hours	50000 hours	70000 hours	50000 hours	50000 hours
Touch screen					
Touch type	5-wire resistive touch screen/projected capacitive touch screen	5-wire resistive touch screen/projected capacitive touch screen	5-wire resistive touch screen/projected capacitive touch screen	Projected capacitive touch screen	5-wire resistive touch screen/projected capacitive touch screen
Light Transmission	80%/90%	83%/90%	80%/90%	90%	83%/90%
Controller	USB/USB	USB/USB,RS232	USB/USB	USB/RS232	USB/USB
I/O Port					
OSD menu/language	AUTO/Power/Menu/Source/UP (LEFT)/DOWN(RIGHT) Chinese, English, German, French, Russian, Italian, Spanish, Arabic and other optional languages	AUTO/Power/Menu/Source/UP (LEFT)/DOWN(RIGHT) Chinese, English, German, French, Russian, Italian, Spanish, Arabic and other optional languages	AUTO/Power/Menu/Source/UP (LEFT)/DOWN(RIGHT)	1*VGA+1*HDMI/1*DP (choose one)	1*VGA+1*HDMI/1*DP (choose one)
Display	1*VGA+1*HDMI/1*DP (choose one)	1*VGA+1*HDMI/1*DP (choose one)	1*VGA+1*HDMI/1*DP (choose one)	1*VGA+1*HDMI/1*DP (choose one)	1*VGA+1*HDMI/1*DP (choose one)
Audio	1*Line in, 2*2W power speaker	1*Line in, 2*3W power speaker	1*Line in, 2*3W power speaker	1*Line in, 2*3W power speaker	1*Line in, 2*3W power speaker
Touch interface	1*RS232 Touch, 1*USB Touch	1*RS232 Touch, 1*USB Touch	1*RS232 Touch, 1*USB Touch	1*RS232 Touch, 1*USB Touch	1*RS232 Touch, 1*USB Touch
Power					
Power Input	DC 10-30V	DC 10-30V	DC 10-30V	DC 10-30V	DC 10-30V
Power consumption	12V@0.65A (No Power output)	12V@0.65A (No Power output)	12V@1.6A (No Power output)	12V@1.6A (No Power output)	12V@1.6A (No Power output)
Standby power consumption	Standby power consumption <1W	Standby power consumption <1W	Standby power consumption <1W	Standby power consumption <1W	Standby power consumption <1W
Mechanical					
Structure	Aluminum alloy die-casting, flat panel, cooling fin case	Aluminum alloy die-casting, flat panel, cooling fin case	Aluminum alloy die-casting, flat panel, cooling fin case	Aluminum alloy die-casting, flat panel, cooling fin case	Aluminum alloy die-casting, flat panel, cooling fin case
Dimension (W*H*D)	275*193*51mm Panel mounting opening size(W*H): 271*189mm	380*315*56mm Panel mounting opening size(W*H): 367.3*303.3mm	415.5*360.5*59mm Panel mounting opening size (W*H): 407*352mm	482.3*304.3*59.1mm Panel mounting opening size (W*H): 473.8*295.8mm	453.5*388.5*64.1mm Panel mounting opening size (W*H): 445*380mm
Net Weight	1.8kg	4.3kg	TBD	6.6kg	TBD
Installation	Panel mounting, VESA (75*75mm)	Panel mounting, VESA (100*100/75*75mm)	Panel mounting, VESA (100*100mm)	Panel mounting, VESA (100*100/75*75mm)	Panel mounting, VESA (100*100/75*75mm)
Environmental					
Operating Temp	-20~70°C, with air flow	0~50°C, with air flow	0~50°C, with air flow	0~50°C, with air flow	0~50°C, with air flow
Storage Temp	-40~80°C	-20~60°C	-20~60°C	-40~80°C	-20~60°C
Humidity	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation	10~95%@40°C, No-condensation
Vibration	1g 5~500Hz	1g 5~500Hz	1g 5~500Hz	1g 5~500Hz	1g 5~500Hz
Shock	10g peak acceleration(duration 11ms)	10g peak acceleration(duration 11ms)	10g peak acceleration(duration 11ms)	10g peak acceleration(duration 11ms)	10g peak acceleration(duration 11ms)
Certificate	CE,FCC Class A	CE,FCC Class A	CE,FCC Class A	CE,FCC Class A	CE,FCC Class A

ALAD-101T

10.1" TFT LCD, Capacitive/Resistive touch screen, HDMI/DP (choose one), VGA display, OSD function keys

Key Specification

- Aluminum alloy die-casting, naturally streamlined design
- 10.1" high resolution TFT LCD (LED Backlight)
- 5 wire heat-resistant resistive touch screen
- Optional projected capacitive touch screen, support multi-touch
- HDMI/DP(choose one) and VG signal input
- Audio input, support 2*2W power speaker
- DC 10-30V power input
- True-flat panel, IP65 front panel



I/O View



Product Overview

ALAD-101T is an industrial touch display that supports 10.1" TFT LED LCD screen, high resolution 1280*800, USB and serial port dual-signal 5-wire resistive touch screen and optional capacitive touch screen. HDMI/DP (choose one). Variety of installation methods for application sites in different fields such as vehicle display, industrial automation, medical treatment, and new energy.

Product Parameters

Display Screen	
Dimension	10.1" TFT LED
Resolution	1280*800
Max. colors	16.7M
Max. Luminance	350
Viewing Angle	85°(left), 85°(right), 85°(up), 85°(down)
Backlight life	15000 hours/50000 hours

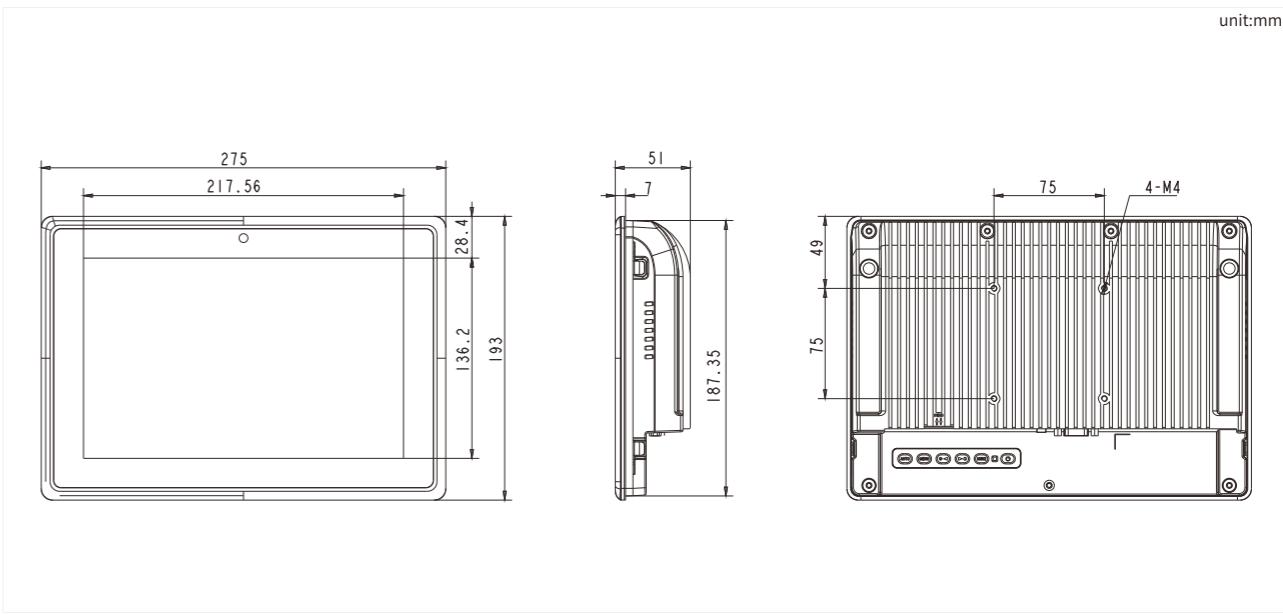
Touch Screen	
Type	5-wire resistive touch screen/projected capacitive touch screen
Light Transmission	80%/90%
Controller	USB/USB

I/O Port	
OSD menu/language	AUTO/Power/Menu/Source/UP (LEFT)/DOWN (RIGHT) Chinese, English, German, French, Russian, Italian, Spanish, Arabic and other optional languages
Display	1*VGA+1*HDMI/1*DP (choose one)
Audio	1*Line in, 2*2W power speaker
Touch interface	1*RS232 Touch, 1*USB Touch

Power	
Power input	DC 10-30V
Power consumption	12V@0.65A (No Power output)
Standby power consumption	Standby power consumption <1W
Mechanical	
Structure	Aluminum alloy die-casting, flat panel, cooling fin case
Dimension (W*H*D)	275*193*51mm Panel mounting opening size(W*H): 271*189mm
Net Weight	1.8kg
Installation	Panel mounting, VESA (75*75mm)

Environmental	
Operating Temp	-20~70°C, with air flow
Storage Temp	-40~80°C
Humidity	10~95%@40°C, No condensation
Vibration	1g 5~500Hz
Shock	10g peak acceleration(duration 11ms) with HDD
Certificate	CE,FCC Class A

Dimensions



Ordering Information

Model	Touch Screen	Specifications
ALAD-101T/S001-G	5-wire resistive touch screen	10.1" TFT LCD, 1*HDMI (default)/1*DP(optional), 1*VGA, 1*Line in, 2*2W power speaker, DC 10-30V power supply
ALAD-101T (P)/S001-G	Projected capacitive touch screen	
PA-60DC12		AC/DC power adapter, DC12V/5A, 60W

ALAD-151T

15" TFT LCD, Capacitive/Resistive touch screen, HDMI/DP (choose one), VGA display, OSD function keys

Key Specification

- Aluminum alloy die-casting, naturally streamlined design
- 15" high resolution TFT LCD (LED Backlight)
- 5 wire heat-resistant resistive touch screen
- Optional projected capacitive touch screen, support multi-touch
- HDMI/DP (choose one) and VGA signal input
- Audio input, optional support 2.3W power speakers
- DC 10-30V power input
- Flat panel, IP65 front panel



Product Overview

ALAD-151-G is an industrial touch display that supports 15" TFT LED LCD screen, high resolution 1280*800, USB and serial port dual-signal 5-wire resistive touch screen and optional capacitive touch screen. HDMI/DP (choose one). It is an industrial-standard multimedia display, with multiple installations suitable for different application sites.

Product Parameters

Display Screen

Dimension	15" TFT LED
Resolution	1024*768
Max. colors	16.2M
Max. Luminance	350
Viewing angle	80°(left), 80°(right), 80°(up), 80°(down)
Backlight life	50000 hours

Touch Screen

Type	5-wire resistive touch screen/projected capacitive touch screen
Light Transmission	83%/90%
Controller	USB/USB,RS232

I/O Port

OSD menu/language	AUTO/Power/Menu/Source/UP (LEFT)/DOWN (RIGHT) Chinese, English, German, French, Russian, Italian, Spanish, Arabic and other optional languages
Display	1*VGA+1*HDMI/1*DP (choose one)
Audio	1*Line in, 2*3W power speaker
Touch interface	1*RS232 Touch, 1*USB Touch

Power

Power input	DC 10-30V
Power consumption	12V@0.65A (No power output)
Standby power consumption	Standby power consumption <1W

Mechanical

Structure	Aluminum alloy die-casting, flat panel, cooling fin case
Dimension(w*h*d)	380*315*56mm Panel mounting opening size (W*H): 367.3*303.3mm
Net weight	4.3kg
Installation	Panel mounting, VESA (100*100/75*75mm)

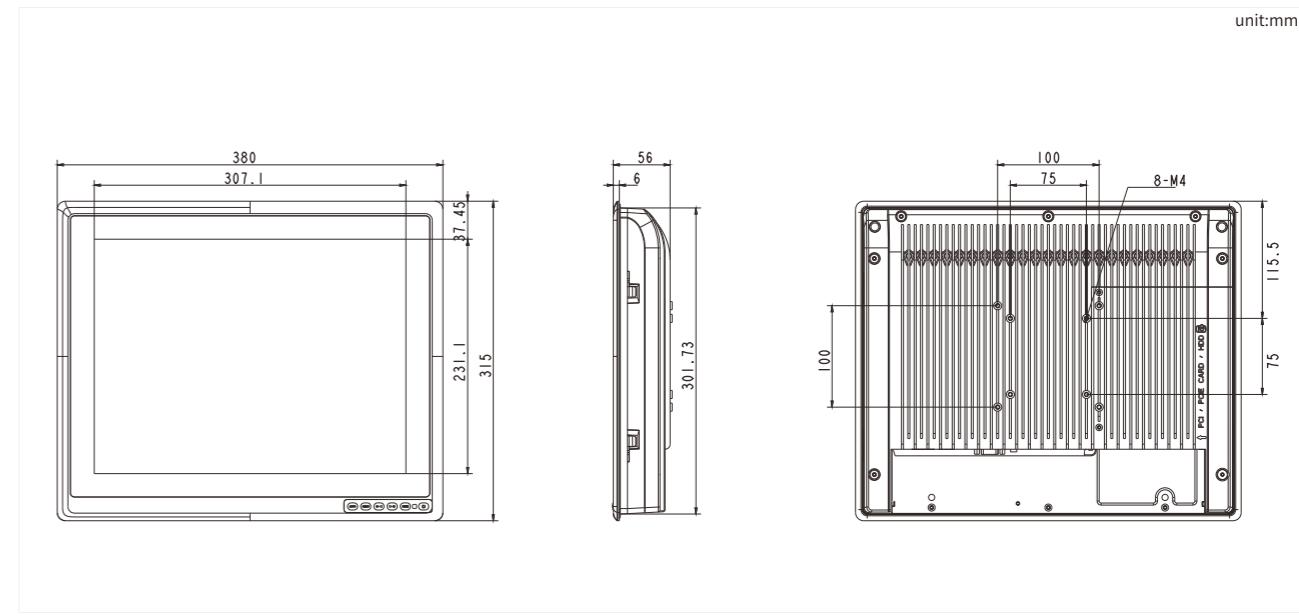
Environmental

Operating Temp	0~50°C, with air flow
Storage Temp	-20~60°C
Storage Humidity	10~95%@40°C, No-condensation
Vibration	1g 5~50Hz
Shock	10g peak acceleration(duration 11ms) with HDD
Certificate	CE,FCC Class A

I/O View



Dimensions



Ordering Information

Model	Touch Screen	Specifications
ALAD-151T/S001-G	5-wire resistive touch screen	15" TFT LCD, 1*HDMI (default)/1*DP(optional), 1*VGA, 1*Line in, 2*3W power speaker, DC 10-30V power supply
ALAD-151T (P)/S001-G	Projected capacitive touch screen	
PA-60DC12		AC/DC power adapter, DC12V/5A, 60W

ALAD-171T

17" TFT LCD, Capacitive/Resistive touch screen, HDMI/DP (choose one), VGA display, OSD function keys

Key Specification

- Aluminum alloy die-casting, naturally streamlined design
- 17" high resolution TFT LCD (LED Backlight)
- 5 wire heat-resistant resistive touch screen
- Optional projected capacitive touch screen, support multi-touch
- HDMI/DP (choose one) and VGA signal input
- Audio input, optional support 2.3W power speakers
- DC 10-30V power input
- Flat panel, IP65 front panel



Product Overview

ALAD-171T-G is an industrial touch display that supports 17" TFT LED LCD screen, high resolution 1280*1024, USB and serial port dual-signal 5-wire resistive touch screen and optional capacitive touch screen. HDMI/DP (choose one). It is an industrial-standard multimedia display, with multiple installations suitable for different application sites.

Product Parameters

Display Screen	
Dimension	17" TFT LED
Resolution	1280*1024
Max. colors	16.2M
Max. Luminance	600
Viewing angle	80°(left), 80°(right), 70°(up), 80°(down)
Backlight life	70000 hours

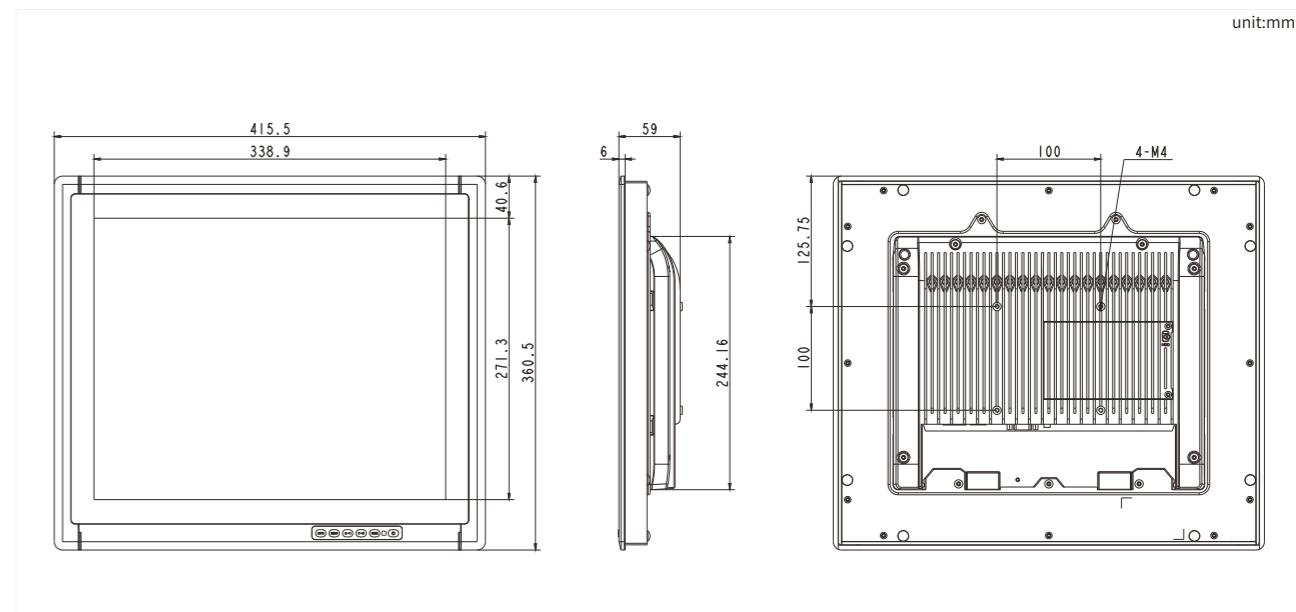
Touch Screen	
Type	5-wire resistive touch screen/projected capacitive touch screen
Light Transmission	80%/90%
Controller	USB/USB

I/O Port	
OSD menu /language	AUTO/Power/Menu/Source/UP (LEFT)/DOWN(RIGHT) Chinese, English, German, French, Russian, Italian, Spanish, Arabic and other optional languages
Display	1*VGA+1*HDMI/1*DP (choose one)
Audio	1*Line in, 2*3W power speaker
Touch interface	1*RS232 Touch, 1*USB Touch

I/O View



Dimensions



Ordering Information

Model	Touch Screen	Specifications
ALAD-171T/S001-G	5-wire resistive touch screen	17" TFT LCD, 1*HDMI (default)/1*DP(optional), 1*VGA, 1*Line in, 2*3W power speaker, DC 10-30V power supply
ALAD-171T (P)/S001-G	Projected capacitive touch screen	
PA-60DC12	AC/DC power adapter, DC12V/5A, 60W	

ALAD-181T(P)

18.5" TFT LCD, Capacitive touch screen , HDMI/DP (choose one), VGA dual signals, OSD function keys

Key Specification

- Aluminum alloy die-casting, naturally streamlined design
- 18.5" high resolution TFT LCD (LED Backlight)
- Projected capacitive touch screen, support multi-touch
- HDMI/DP (choose one) and VGA signal input
- Audio input, optional support 2.3W power speakers
- DC 10-30V power input
- IP65 certified full-flat panel protection



Product Overview

ALAD-181T-G is an industrial touch display that supports 18.5" TFT LED LCD screen, high resolution 1366*768, USB and serial port dual-signal capacitive touch screen. HDMI/DP (choose one). It is an industrial-standard multimedia display, with multiple installations suitable for different application sites.

Product Parameters

Display Screen	
Dimension	18.5" TFT LED
Resolution	1366*768
Max. colors	16.7M
Max. Luminance	300
View angle	89°(left), 89°(right), 85°(up), 85°(down)
Backlight life	50000 hours

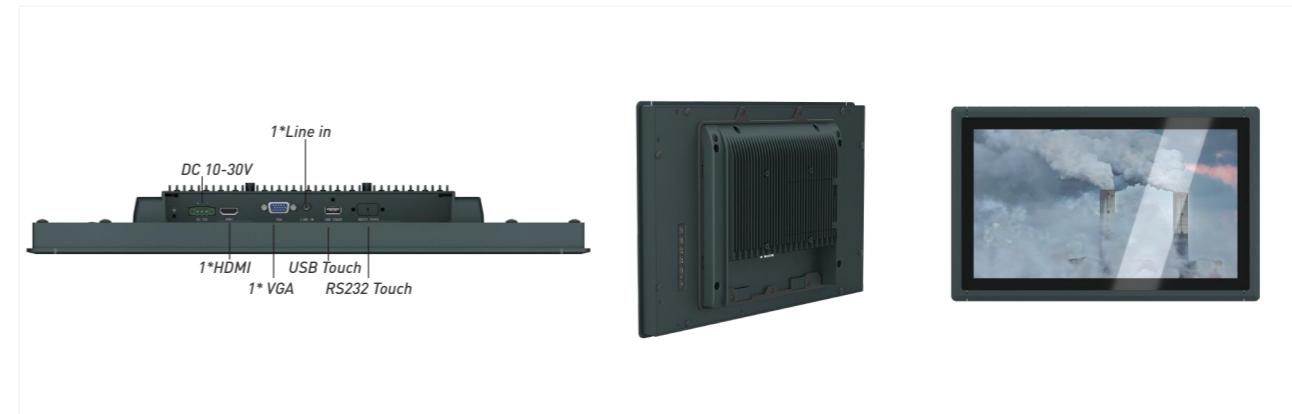
Touch Screen	
Type	Projected capacitive touch screen
Light Transmission	90%
Controller	USB/RS232

I/O Port	
OSD menu/language	AUTO/Power/Menu/Source/UP(LEFT)/DOWN(RIGHT) Chinese, English, German, French, Russian, Italian, Spanish, Arabic and other optional languages
Display	1*VGA+1*HDMI/1*DP (choose one)
Audio	1*Line in, 2*3 power speaker
Touch interface	1*RS232 Touch, 1*USB Touch

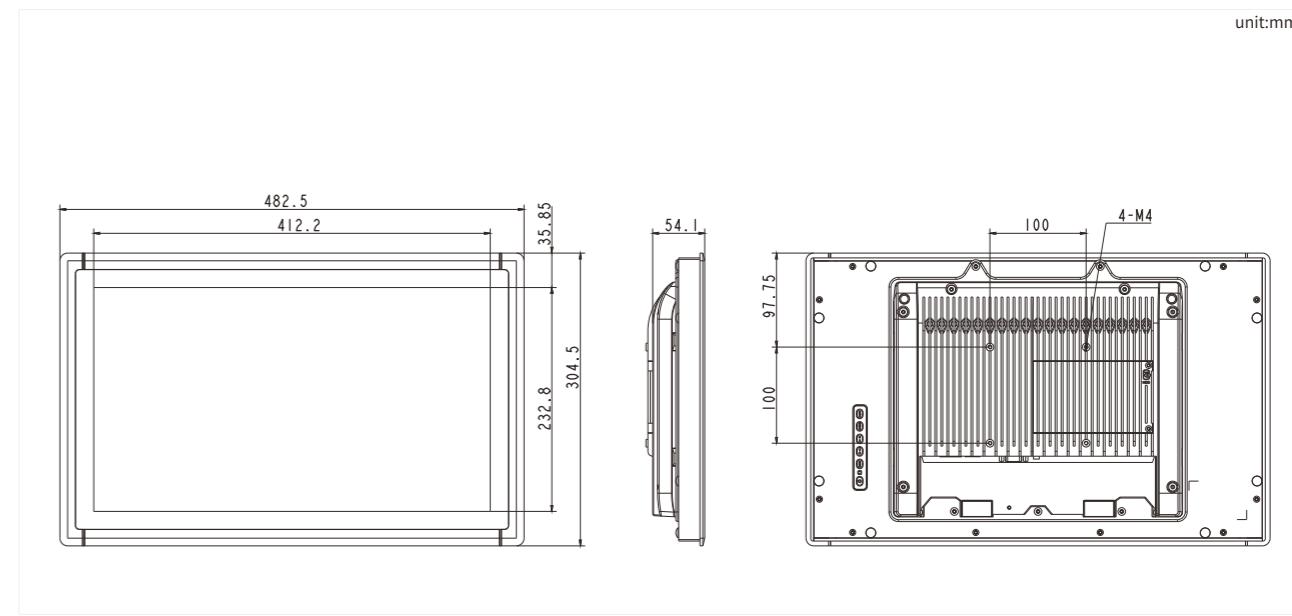
Power	
Power input	DC 10-30V
Power consumption	12V@1.6A (No power output)
Standby power consumption	Standby power consumption <1W
Mechanical	
Structure	Aluminum alloy die-casting, flat panel, cooling fin case
Dimension (W*H*D)	482.3*304.3*59.1mm Panel mounting opening size (W*H): 473.8*295.8mm
Net weight	6.6kg
Installation	Panel mounting, VESA (100*100/75*75mm)

Environmental	
Operating Temp	0~50°C, with air flow
Storage Temp	-20~60°C
Humidity	10~95%@40°C, No condensation
Vibration	1g 5~50Hz
Shock	10g peak acceleration(duration 11ms) with HDD
Certificate	CE,FCC Class A

I/O View



Dimensions



Ordering Information

Model	Touch Screen	Specifications
ALAD-181T (P)/S001-G	Projected capacitive touch screen	18.5" TFT LCD, 1*HDMI (default)/1*DP(optional), 1*VGA, 1*Line in, 2*3W power speaker, DC 10-30V power supply
PA-60DC12	AC/DC adapter, DC12V/5A, 60W	

ALAD-191T

19" TFT LCD, Capacitive/Resistive touch screen, HDMI/DP (choose one), VGA dual signals, OSD function keys

Key Specification

- Aluminum alloy die-casting, naturally streamlined design
- 19" high resolution TFT LCD (LED Backlight)
- 5 wire heat-resistant resistive touch screen
- Optional projected capacitive touch screen, support multi-touch
- HDMI/DP (choose one) and VGA signal input
- Audio input, optional support 2.3W power speakers
- DC 10-30V power input
- Flat panel, IP65 front panel



Product Overview

ALAD-191T-G is an industrial touch display that supports 19" TFT LED LCD screen, high resolution 1280*1024, USB and serial port dual-signal 5-wire resistive touch screen and optional capacitive touch screen. HDMI/DP (choose one). It is an industrial-standard multimedia display, with multiple installations suitable for different application sites.

Product Parameters

Display Screen	
Dimension	19" TFT LED
Resolution	1280*1024
Max. colors	16.7M
Max. Luminance	470
View angle	85°(left), 85°(right), 75°(up), 85°(down)
Backlight life	50000 hours

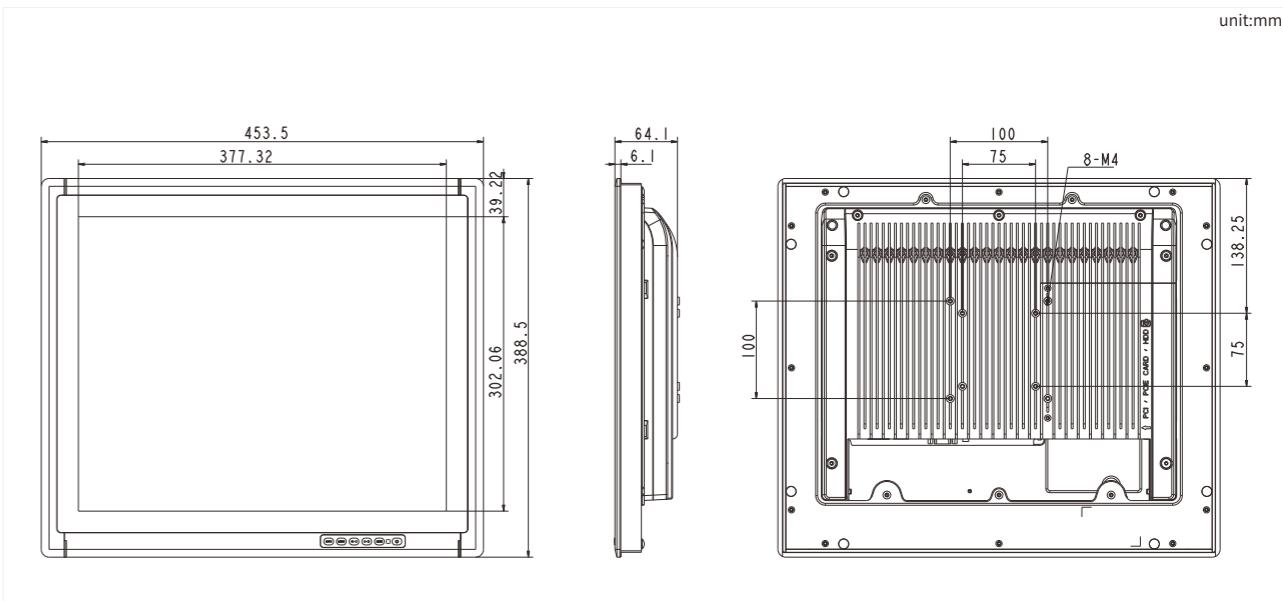
Touch Screen	
Type	5-wire resistive touch screen/projected capacitive touch screen
Light Transmission	83%/90%
Controller	USB/USB

I/O Port	
OSD menu/language	AUTO/Power/Menu/Source/UP (LEFT)/DOWN(RIGHT) Chinese, English, German, French, Russian, Italian, Spanish, Arabic and other optional languages
Display	1*VGA+1*HDMI/1*DP (choose one)
Audio	1*Line in, 2*3W power speaker
Touch interface	1*RS232 Touch, 1*USB Touch

I/O View



Dimensions



Ordering Information

Model	Touch Screen	Specifications
ALAD-191T/S001-G	5-wire resistive touch screen	19" TFT LCD, 1*HDMI (default)/1*DP(optional), 1*VGA, 1*Line in, 2*3W power speaker, DC 10-30V power supply
ALAD-191T (P) /S001-G	Projected capacitive touch screen	
PA-60DC12		AC/DC power adapter, DC12V/5A, 60W

ALAD-211T(P)

21.5" TFT LCD, Capacitive touch screen, HDMI/DP (choose one), VGA dual signals, OSD function keys

Key Specification

- Aluminum alloy die-casting, naturally streamlined design
- 21.5" high resolution TFT LCD (LED Backlight)
- Projected capacitive touch screen, support multi-touch
- HDMI/DP (choose one) and VGA signal input
- Audio input, optional support 2.3W power speakers
- DC 10-30V power input
- Flat panel, IP65 front panel



Product Overview

ALAD-211T-G is an industrial touch display that supports 21.5" TFT LED LCD screen, high resolution 1920*1080, USB and serial port dual-signal capacitive touch screen. HDMI/DP (choose one). It is an industrial-standard multimedia display, with multiple installations suitable for different application sites.

Product Parameters

Display Screen

Dimension	21.5" TFT LED
Resolution	1920*1080
Max. colors	16.7M
Max. Luminance	300
View angle	89°(left), 89°(right), 89°(up), 89°(down)
Backlight life	50000 hours

Touch Screen

Type	Projected capacitive touch screen
Light Transmission	90%
Controller	USB/RS232

I/O Port

OSD menu/language	AUTO/Power/Menu/Source/UP(LEFT)/DOWN(RIGHT) Chinese, English, German, French, Russian, Italian, Spanish, Arabic and other optional languages
Display	1*VGA+1*HDMI/1*DP (choose one)
Audio	1*Line in, 2*3W power speaker
Touch interface	1*RS232 Touch, 1*USB Touch

Power

Power input	DC 10-30V
Power consumption	12V@1.6A (No power output)
Standby power consumption	Standby power consumption <1W

Mechanical

Structure	Aluminum alloy die-casting, flat panel, cooling fin case
Dimension (W*H*D)	546.9*344.7*64.1mm
Panel mounting opening size (W*H)	537.5*335.3mm
Net weight	8.1kg
Installation	Panel mounting, VESA (100*100/75*75mm)

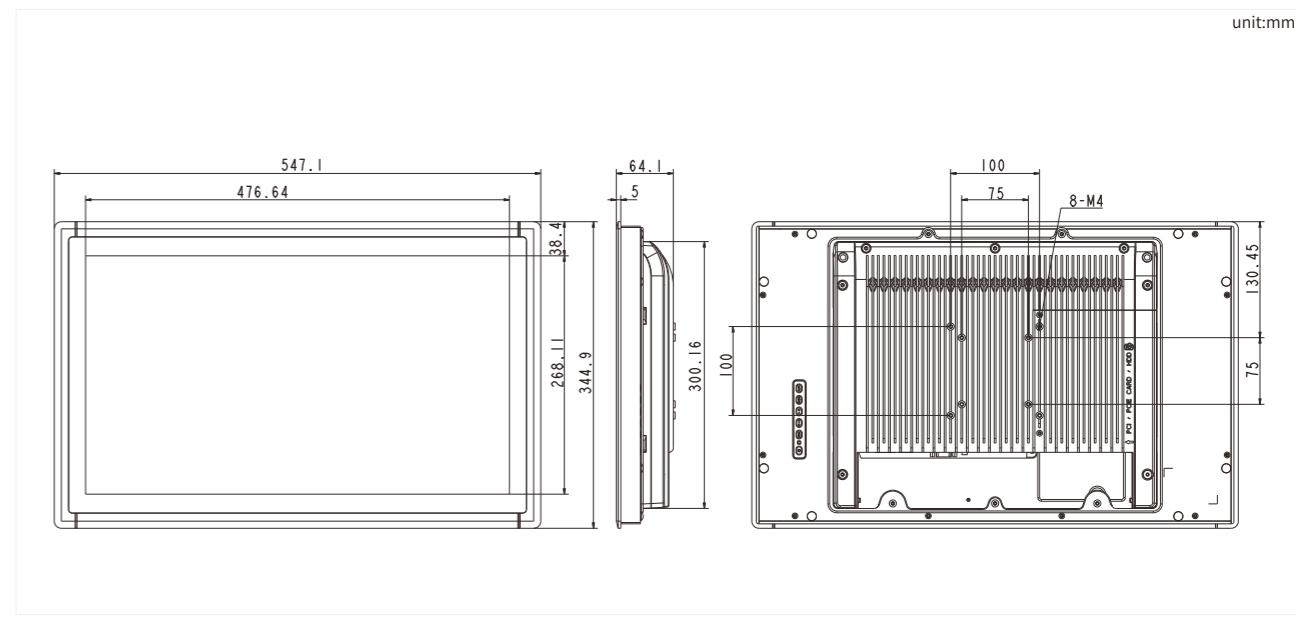
Environmental

Operating Temp	0~50°C, with air flow
Storage Temp	-20~60°C
Humidity	10~95%@40°C, No condensation
Vibration	1g 5~500Hz
Shock	10g peak acceleration(duration 11ms)
Certificate	CE,FCC Class A

I/O View



Dimensions



Ordering Information

Model	Touch Screen	Specifications
ALAD-211T (P)/S001-G	Projected capacitive touch screen	21.5" TFT LCD, 1*HDMI (default) / 1*DP (optional), 1*VGA, 1*Line in, 2*3W power speaker, DC 10-30V power supply
PA-60DC12	AC/DC power adapter, DC12V/5A, 60W	

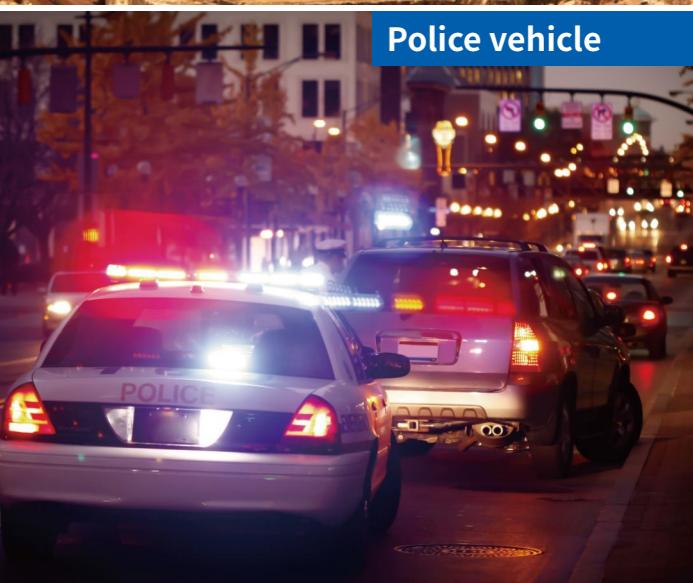
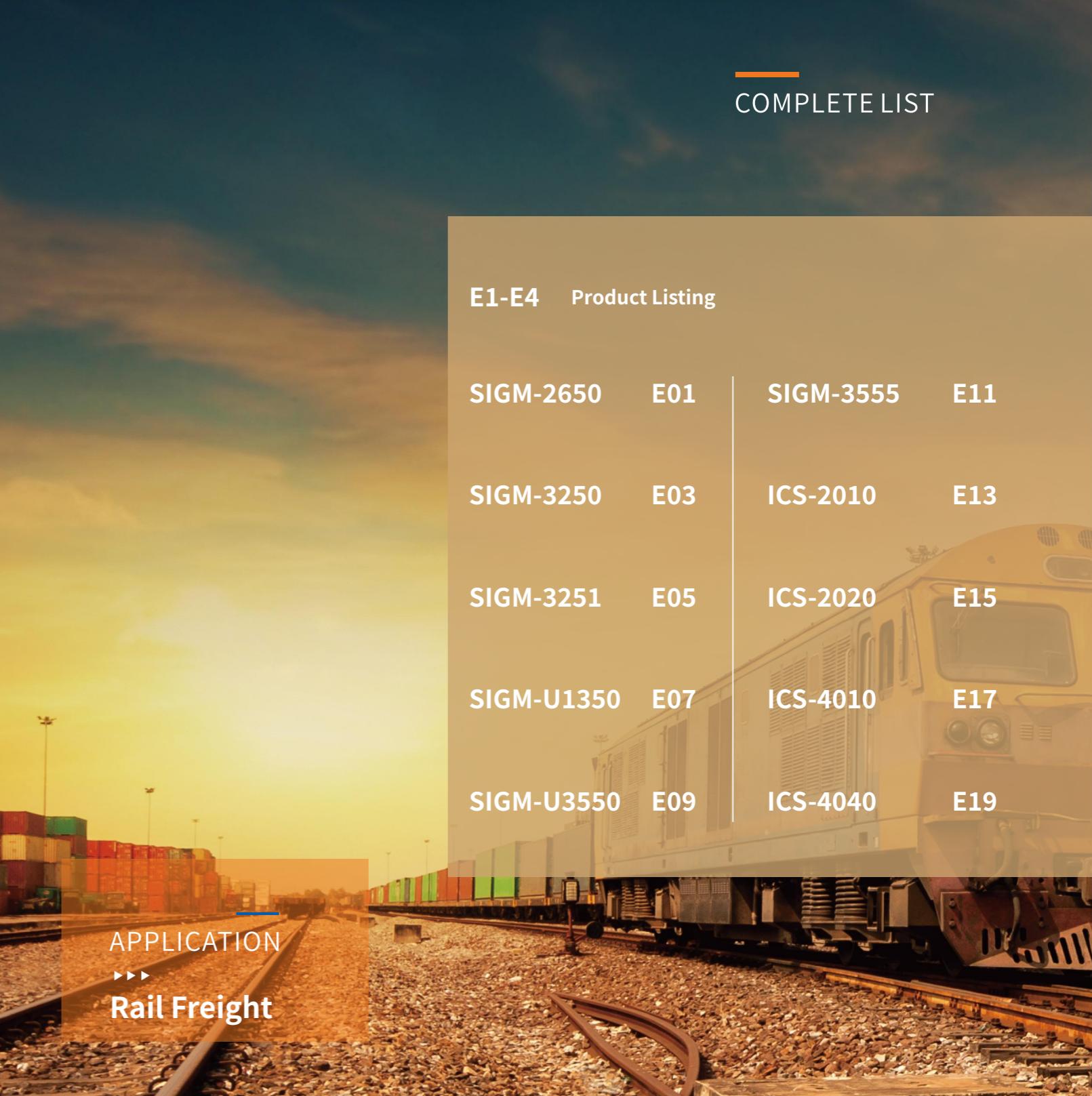
JHCTECH IoT Computer
Connecting the Dots

JHCTECH IoT Computer
Connecting the Dots

SIGM

Embedded In-vehicle Computer-SIGM





SIGM-2650	SIGM-3250	SIGM-3251	SIGM-U1350	SIGM-U3550	SIGM-U3555
System			System		
CPU	Intel® Apollo lake E3940 CPU, 4 Cores, 4 Threads, up to 1.8GHz, 2 MB L2, TDP 9.5W	Intel® Skylake/Kabylake-U CPU i3/i7 2 Cores , 4 Threads	Intel® Skylake/Kabylake-U CPU i3/i7 2 Cores , 4 Threads MLU220 8TOPS(INT8),4GB Ram, TDP8.5W	Intel® Skylake/Kabylake-U Corei3/i5/i7 CPU; Optional MLU220T MXM 8G Ram 16TOPS(INT8)	Intel Coffee lake-H Core I3/I5/I7/Xeon CPU, TDP 25W/45W
RAM	1*DDR3L, 1866MHz, onboard 4GB+1*SODIMM, max 8GB	DDR4, 2133MHz, onboard 4/8GB+1*SODIMM, max 16GB	DDR4, 2133MHz, onboard 4/8GB+1*LPDDR4 4GB, max 16GB	Onboard 4GB +1*SODIMM, 4+16GB max.	Onboard 8GB+ 1*SODIMM, 8+32GB max.
Graphics	Intel Gen. 9 HD Graphic 500, DP: 4096*2160@60Hz, Smart Display: 1920*1200@60Hz, VGA: 1920*1200@60Hz, support 3 display	CPU integrated Intel Gen. 9 HD Graphics, DP: 4096*2304@60Hz, Smart Display: 1920*1200@60Hz, VGA: 1920*1200@60Hz, support 2 independent displays	CPU integrated Intel Gen. 9 HD Graphics, DP: 4096*2304@60Hz, Smart Display: 1920*1200@60Hz, VGA: 1920*1200@60Hz, support 3 independent displays	Intel® Gen. 9 HD Graphics, DP:4096*2160@60Hz, Smart Display:1920*1200@60Hz, VGA:1920*1200@60Hz, 3 independent display	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1; Intel® UHD Graphics, DirectX 12, OpenGL 4.5, 2*HDMI 1.4: 4096 x 2304@24Hz
I/O			I/O		
LAN	2*Intel I210AT PCIe Gig. Ethernet, M12 connector, with POE function, support 802.3af(15.4W)	6*Intel I210AT PCIe Gig. Ethernet, M12 connectors, 4 of which have POE function, 802.3af(15.4W)	4*Intel I210AT PCIe Gig. Ethernet, 4*M12 connector 1*Intel I210IS PCIe Gig. Ethernet, 1*SFP	2*Intel® I210AT 10M-1000M (M12)	1*Intel I210AT(IT)+1*Intel I219LM(2*RJ45); 2*Intel I210AT(IT)[2*M12]; 3*Intel I210AT(IT)
USB	2* USB3.0; 1*USB2.0 ; 2*USB2.0 (M12)	2* USB3.0; 1*USB2.0 ; 2*USB2.0 (M12)	3*USB3.0; 1*USB2.0; 2*USB2.0 (M12)	2* USB3.0; 1*USB2.0 ; 2*USB2.0 (M12)	2* USB3.1; 8*USB2.0
Display	1*DP+1*VGA+1*Smart Display	1*DP+1*VGA		1*DP+1*VGA+1*Smart Display	1*DP+1*HDMI
Audio	optional support Realtek ALC662VD audio, Audio out and MIC	optional support Realtek ALC662VD audio, Audio out and MIC	Optional support Realtek ALC662VD audio, Audio out and MIC		(Opt.)Realtek ALC, 1*Line out+1*Mic
Serial port	1*RS232 isolated (DB9 male connector), 1*RS485 isolated (DB9 male connector), optional 2*CAN 2.0 (DB9 male connector)	1*RS232 isolated (DB9 male connector), 1*RS485 isolated (DB9 male connector), optional 2*CAN 2.0 (DB9 male connector)	1*RS232/RS422/RS485 DB9 (2.5KV opto-isolator), 2*RS232 DB9 (2.5KV opto-isolator), 1* RS232/485 DB9(2.5KV opto-isolator)	1*Console RS232 (RJ45)	1*RS232/RS485 (DB9)
DIO	4-ch input/4-ch output, isolated (DB9), 2.5KV opto-isolator input(H: 5-24V, L: 0-1.5V), opto-isolator output (200mA)	4-ch input/4-ch output, isolated (DB9), 2.5KV opto-isolator input (H: 5-24V, L: 0-1.5V) , opto-isolator output (200mA)	8-bit DIO, programmable TTL signal		8-bit DIO, TTL
Storage			Storage		
Storage	1*2.5" HDD SATA bay; 1*mSATA full height card (SATA+USB)	1*2.5" HDD SATA bay; 1*mSATA full height card (SATA+USB)	1*2.5" HDD SATA bay; 1*mSATA full height card(SATA+USB)	1*2.5" HDD SATA bay; 1*mSATA(SATA+USB)	4*2.5" HDD SATA bay(RAID0/1/5/10); 1*mSATA Slot7&8: 1*PCIe3.0X8(CPU)+1*USB3.1+1*USB2.0+1*G-LAN; Slot6: 1*PCIeX4+1*USB3.1+1*USB2.0, 1*G-LAN;
Expansion			Expansion		
Expansion Port	2*Mini PCIe, with dual SIM slot, support dual 4G LTE/Wifi/BT/GPS 1*Mini PCIe, optional mSATA 1*Mini PCIe with USB signal, When using 2*CAN, this slot is occupied	2*Mini PCIe, with dual SIM slot, support dual 4G LTE/Wifi/BT/GPS 1*Mini PCIe, optional mSATA 1*Mini PCIe with USB signal, optional mSATA	2*Mini PCIe, with dual SIM slot, support dual 4G LTE/Wifi/BT/GPS 1*Mini PCIe with USB signal, optional mSATA 1*Mini PCIe with USB signal	2*Mini PCIe(+SIM), 4G/GSM/Wifi/BT/GPS 1*Mini PCIe(SATA+USB), mSATA 1*Mini PCIe(PCIe X1/USB)	1*M.2 2230 E-key(PCIeX1/USB2.0/CNvio), WiFi6/BT5.0; 1*M.2 3052 B-key(PCIeX1/USB2.0+SIM), 5G NR/4G LTE; 1*M.2 Type 2280 M-Key(PCIeX4), NVME/PCIe Module
Power Supply			Power Supply		
Input voltage & Power Consumption	DC 9~36V input, 5-pin terminal port M12 (S001) Optional Railway power module, DC 48/72/110V input, 4-pin connector M12 (S002) consumption: 20.4W (E3940 CPU, 4G DDR3L, 128G SSD)	Railway power module, DC 48/72/110V input, 4-pin connector M12 (S00X), DC 9~36V input, 5-pin terminal port M12 (T00X) consumption: 28W (I5-6200U, 8GB)	Railway power module, DC 9~36V input, 4-pin connector (M12), consumption: 38W (I5-6500U CPU/8G DDR4)	Input voltage & TDP Railway power:DC 110V(43-160V), 4-pin M12; 28W(Non. MLU220T)/44.5W(with MLU220T)	DC 16.6-160V(Rail-way, ultra-wide voltage,4-pin M12); TDP: TBD
Mechanical			Mechanical		
Structure	Aluminum chassis, SGCC frame	Aluminum chassis, stainless steel frame	Aluminum chassis, stainless steel frame	Structure	Aluminum alloy mold, conductive oxidation process
Dimension (W*H*D)	250*154*72mm	270*154*64.5mm	270*154*82.4mm	Dimension (W*H*D)	430*44.5*283mm
Net weight	3.10KG	3.2KG	3.93KG	Net weight	TBD
Environmental			Environmental		
Operating temperature	EN50155 TX: -40~70°C(Operating10min in 85°C)	EN50155 TX: -40~70°C(Operating10min in 85°C)	EN50155 TX: -40~70°C	Operating temperature	EN50155 TX: -40~70°C
Storage temperature	-40°C~85°C	-40°C~85°C	-40°C~85°C	Storage temperature	-40°C~85°C
Storage humidity	10~90%@40°C, non-condensing	10~90%@40°C, non-condensing	10~90%@40°C, non-condensing	Storage humidity	10~95%@40°C, Non-condensation
Vibration	MIL-STD-801G, EN50155	MIL-STD-801G, EN50155	MIL-STD-810G, EN50155	Vibration	MIL-STD-810G, EN50155:2021
Shock	MIL-STD-801G, EN50155	MIL-STD-801G, EN50155	MIL-STD-810G, EN50155	Shock	MIL-STD-810G, EN50155:2021
Certification /EMC	EN50155, E-Mark, CE/FCC Class B	EN50155, E-Mark, CE/FCC Class B	EN50155, CE/FCC Class B	Certification /EMC	EN50155: 2017 & E-Mark & CE & FCC Class A
OS	Windows 10, Linux, Wind River VxWorks	Windows 7, Windows 10, Linux Fedora Ubuntu (Note: 7th gen Intel® Kabylake-U processor does not support Windows 7)	Linux Fedora Ubuntu	OS	Linux, Windows 7(SKL-U 32/64; KBL-U 64) , Windows 10 64bit(Windows does not support MLU220)
					Windows 10/11 Enterprise & IOT Enterprise, Ubuntu, SUSE, Redhat Enterprise , VxWorks
					Windows 10/11 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7

			
ICS-2010	ICS-2020	ICS-4010	ICS-4040
System			
CPU	1/2 Intel Xeon Gen2 scalable series processors, Intel® C621 PCH	1/2 Intel Xeon Gen4 scalable series processors, Intel® C741 PCH	1/2 Intel Xeon Gen2 scalable series processors, Intel® C621 PCH
RAM	16*DDR4,2933MHz ECC LRDIMM/RDIMM LRDIMM:4T (16*256GB); RDIMM:2T (16*128GB)	16*DDR4,2933MHz ECC LRDIMM/RDIMM LRDIMM:4T (16*256GB)	16*DDR5,5600MHz,3DS RDIMM/RDIMM 4T max. (16*256GB)
Graphics	VGA:1920*1200@60Hz,	VGA:1920*1200@60Hz,	VGA:1920*1200@60Hz,
I/O			
LAN	2*Intel I210AT 10M-1000M; 1*IPMI2.0, Aspeed AST2500 BMC	2*Broadcom BCM5720 1GBase-T; 1*IPMI2.0, Aspeed AST2600 BMC	2*Intel I210AT 10M-1000M; 1*IPMI2.0, Aspeed AST2500 BMC
USB	4* USB3.0+2*USB2.0	6* USB3.0	6* USB3.0+2*USB2.0
Display	1*VGA	1*VGA	1*VGA
Audio	/	/	/
Serial port	1*RS232 (DB9)	1*RS232 (DB9)	1*RS232 (DB9)
DIO	/	/	/
Storage			
Storage	2*2.5" SAS/SATA3.0,RAID0,1	2*2.5" SAS/SATA3.0,RAID0,1	8*2.5"/3.5" SAS/SATA, RAID0/1/5/10; 2*2.5" SAS/SATA
Expansion			
Expansion Port	2*PCIe3.0X16+1*PCIe3.0X8; 1*M.2 22110/2280 M-Key (PCIe3.0X4), 1*M.2 2280 M-Key (PCIe3.0X4)	2*PCIe5.0X16+1*PCIe5.0X8; 2*M.2 22110/2280 M-Key (PCIe4.0X2) ,NVMe; 3*MCIOX8(6*PCIe5.0X4 NVMe)	6*PCIe3.0X16+1*PCIe3.0X8(X4); 1*M.2 22110/2280 M-Key (PCIe4.0X4); 3*MCIO(PCIe5.0X8,6*NVMe)
Power Supply			
Input voltage & TDP	550W/800W/1200W/1600W; 1+1 hot swap redundant power supply	550W/800W/1200W/1600W; 1+1 hot swap redundant power supply	550W/800W/1200W/1600W/2000W/2200W; 1+1 hot swap redundant power supply
Mechanical			
Structure	Imported SGCC hot dip galvanized steel sheet, 19-inch rack 2U standard	Imported SGCC hot dip galvanized steel sheet, 19-inch rack 2U standard	Imported SGCC fingerprint resistant galvanized steel, 19-inch rack 4U standard
Dimension (W*H*D)	442*447*87mm	442*447*87mm	645*445*176.5mm
Net weight	TBD	TBD	18KG
Environmental			
Operating temp.	0~50°C	10~35°C	0~60°C
Storage temp.	-20°C~75°C	-40°C~70°C	-20°C~75°C
Storage humidity	5~95%@40°C, Non-condensation	5~95%@40°C, Non-condensation	5~95%@40°C, Non-condensation
Vibration	TBD	TBD	TBD
Shock	TBD	TBD	TBD
Certification /EMC	CCC/CE/FCC Class A	CCC/CE/FCC Class A	CCC/CE/FCC Class A
OS	Windows Server 2012/2008 R2(64-bit) , Windows SBS 2011(64-bit), Red Hat Enterprise Linux Server(32/64-bit), Suse Enterprise Linux Server(32/64-bit), Ubuntu Server(32/64-bit)	Windows Server 2012/2008 R2(64-bit) , Windows SBS 2011(64-bit), Red Hat Enterprise Linux Server(32/64-bit), Suse Enterprise Linux Server(32/64-bit), Ubuntu Server(32/64-bit)	Microsoft Windows Server, Microsoft Hyper-V Server, Red Hat Enterprise Linux, SUSE Linux Enterprise Server, CentOS, Ubuntu, Oracle Linux, VMware ESXi, Citrix XenServer

SIGM-2650

Intel® Apollo Lake E3940 CPU, 2*POE, 2*USB3.0, 2*COM, 8-bit isolated DIO, DC 9~36 wide voltage power supply, ITPS power management, Railway standard power input 48/72/110V

Key Specification

- Aluminum chassis, Fanless & Rugged design
- Intel® Apollo Lake E3940 CPU
- DDR3L up to 1866MHz, On-board+SODIMM, max 8GB
- 1*DP, 1*VGA, 1*Smart Display, 3 independent displays interface
- 2*GbE LAN(with POE 802.3af), 5*USB
- 2* isolation COM, 8-bit Iso. DIO, optional 2*CAN
- 4*Mini PCIe(1 optional mSATA), support GPS/WiFi/LTE/4G
- EN50155, E-Mark certification
- Optional support TPM2.0 security encryption, DC 9~36 wide voltage power supply, ITPS power management
- Optional railway standard power input DC 48/72/110V(±40%)



Product Overview

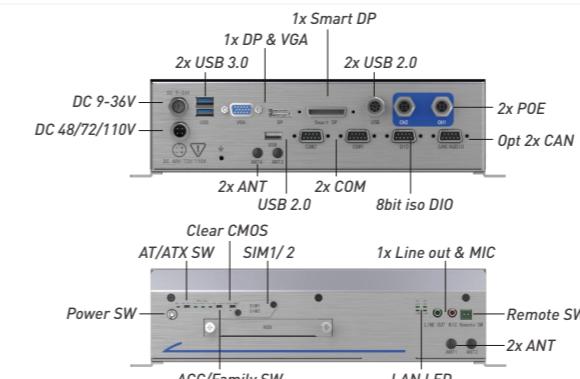
SIGM-2650 is a fanless rugged in-vehicle computer, equipped with Intel® Apollo Lake E3940 processor, supporting dual 4G VPN/Wifi/BT/GPS and other wireless functions. It is also equipped with ITPS vehicle power management, optional railway power input DC 48/72/110V Certified with E-mark and EN50155 , SIGM-2650 is highly suitable for road vehicle and rail vehicle industry applications.

Product Parameters

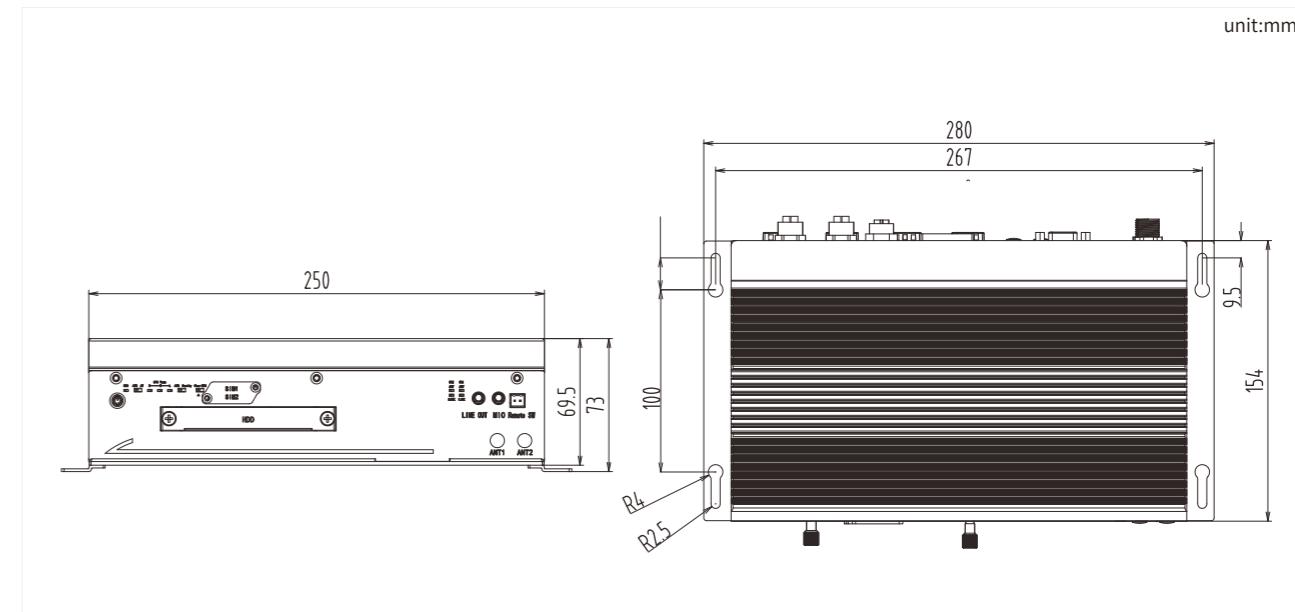
System

CPU	Intel® Apollo lake E3940 CPU, 4 Cores, 4 Threads, up to 1.8GHz, 2 MB L2, TDP 9.5W
RAM	1*DDR3L, 1866MHz, 1 onboard storage 4GB+1*SODIMM, max 8GB 2*Mini PCIe, with dual SIM slot, support dual 4GLTE/Wifi/BT/GPS
Expansion	1*Mini PCIe, optional mSATA 1*Mini PCIe with USB signal, when 2*CAN in use, this Mini-PCIe slot will be occupied
Graphics	Intel Gen. 9 HD Graphic 500, DP max resolution 4096*2160@60Hz, Smart Display max resolution 1920*1200@60Hz, VGA max resolution 1920*1200@60Hz, support 3 displays
Audio	optional support Realtek ALC662VD audio, Audio out and MIC
LAN	2*Intel I210AT PCIe Gig. Ethernet, M12, with POE function, support 802.3af(15.4W)
Storage	1*2.5" HDD SATA bay; 1*mSATA full height card (SATA+USB) 2*Gig-LAN, with POE 802.3af (M12) 2*USB3.0 (Type A); 1*USB2.0 (Type A); 2*USB2.0 (M12)
I/O Port	4-ch input/4-ch output, isolated (DB9 male connector), 2*SIM slot 1*RS232 isolated (DB9 male connector), 1*RS485 isolated (DB9 male connector), optional 2*CAN 2.0(DB9 male connector) 1*Audio-out and 1*MIC (3.5mm audio port) 1*DP+1*VGA+1*Smart Display
LED	1*PowerLED; 1*HDD LED; 3*CPU Temp LED Red is alarm, Yellow is high temp, Green is normal temp
Switches	1*power button, 1*remote switch(2-pin terminal), 1*AT/ATX switch, 1*Clear CMOS switch, 1*ACC/Family switch

I/O View



Dimensions



Ordering Information

Model	Processor	Specification
SIGM-2650/S001	Intel® Apollo Lake E3940 CPU	4GB+1*SODIMM DDR3L, 2*POE, 2*USB3.0, 3*USB2.0, 2*COM, 3*Mini PCIe, 1*Smart Display, 1*DP, 1*VGA, optional Audio out, Mic, 8-bit isolated DIO, 1*2.5" SATA drive bay 1*mSATA, DC 9~36V, ITPS
SIGM-2650/S002	Intel® Apollo Lake E3940 CPU	4GB+1*SODIMM DDR3L, 2*POE, 4*USB3.0, 3*USB2.0, 2*COM, 3*Mini PCIe, 1*Smart Display, 1*DP, 1*VGA, optional Audio out, Mic, 8-bit isolated DIO, 1*2.5" SATA drive bay, 1*mSATA, DC 48/72/110V
M12A-5P DC Cable		DC cable with M12 A-Code Female 5 pin connector to bare wire, PVC Multicore Cable, 100cm
M12A-4P DC Cable		DC cable with M12 A-Code Female 4pin connector to bare wire, PVC Multicore Cable, 100cm
M12A-8P USB Cable		USB cable with M12 A-Code Male 8pin connector to 2*Type A with dual M3 ear nut-hole, PVC Multicore Cable, 50cm
M12X-8P LAN/POE Cable		Internet cable with M12 X-Code Male 8 pin connector to RJ45 crystal head connector, PVC Multicore Cable, 180cm
PA-60DC12-M12A-5P		AC/DC power adapter with M12 A-Code Female 5 pin connector, DC12V@5A 60W (non LSZH cable, no in-vehicle certification)

SIGM-3250

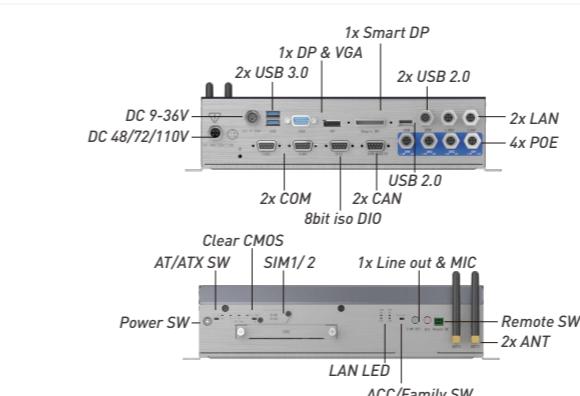
Intel® Skylake/Kabylake-U CPU, 2*LAN, 4*POE, 2*USB3.0, DP, VGA, Smart Display, 2* isolation COM, 8-bit isolated DIO, EN50155 certification

Key Specification

- Aluminum chassis, Fanless & Rugged design
- Intel® Skylake/Kabylake-U CPU
- 2-Ch DDR4, On-board 4/8GB+SODIMM, max 16GB
- 1*DP, 1*VGA, 1*Smart Display, 3 displays
- 2*LAN, 4*POE, 5*USB, Built-in dongle interface
- 2*isolation COM, 8-bit Iso. DIO, optional 2*CAN
- 4*Mini PCIe(1 optional mSATA), support GPS/WiFi/LTE/4G
- EN50155, E-Mark certification, optional support TPM2.0 security encryption,
- Railway standard power input DC 48/72/110V($\pm 40\%$)
- optional DC 9~36 Wide voltage power supply, with ITPS power management



I/O View



Product Overview

SIGM-3250 is a fanless rugged in-vehicle computer, powered by Intel® Skylake/Kabylake-U processor, supports dual 4G VPN/Wifi/BT/GPS and other wireless functions, DC 9~36V wide voltage power supply, ITPS power management and optional railway power input DC48/72/110V. Certified with E-mark and EN50155, SIGM-3250 is extremely suitable for road vehicles and intelligent rail transit system industry applications.

Product Parameters

System

CPU	Intel® Skylake/Kabylake-U CPU Core i3/i5/i7 series CPU
RAM	DDR4, 2133MHz, onboard 4/8GB+1*SODIMM, max 16GB 2*Mini PCIe, with dual SIM slot, support dual 4GLTE/Wifi/BT/GPS
Expansion	1*Mini PCIe, optional mSATA 1*Mini PCIe with USB signal, when 2*CAN is in use, this Mini-PCIe slot is occupied
Graphics	Intel Gen. 9 HD Graphic , DP: 4096*2304@60Hz, Smart Display: 1920*1200@60Hz, VGA: 1920*1200@60Hz, support 3 independent displays
Audio	optional support Realtek ALC662VD audio, Audio out and MIC
LAN	6*Intel I210AT PCIe Gig. Ethernet, M12, 4 with POE functions, support 802.3af(15.4W)
Storage	1*2.5" HDD SATA bay; 1*mSATA full size card (SATA+USB) 2*Gig-LAN (M12) , 4*Gig-LAN with POE 802.3af (M12) 2*USB3.0 (Type A); 1*USB2.0 (Type A); 2*USB2.0 (M12)
I/O Port	4-ch input/4-ch output, isolated (DB9 male connector), 2*SIM slot 1*RS232 isolated (DB9 male connector), 1*RS485 isolated (DB9 male connector), optional 2*CAN 2.0(DB9 male connector) 1*Audio-out and 1*MIC (3.5mm audio port) 1*DP+1*VGA+1*Smart Display
LED	1*PowerLED; 1*HDD LED; 3*CPU Temp LED Red is alarm, Yellow is high temp, Green is normal temp)
Switches	1*switch, 1*remote switch(2-pin terminal), 1*AT/ATX switch, 1*Clear CMOS switch, 1*ACC/Family switch

Watchdog timer	Programmable timeout interruption period or system reset from 1 to 255 secs
Power Requirement	Railway power module 48V/72V/110V input, 4-pin connector M12(S00X), DC 9-36V input, 5-pin connector M12(T00X) Consumption: 12V/2.33A(I5-6200U, 8GB)
OS	Windows 7, Windows 10, Linux Fedora Ubuntu (Note: 7th gen Intel® Kabylake-U processor does not support Windows 7)

Mechanical

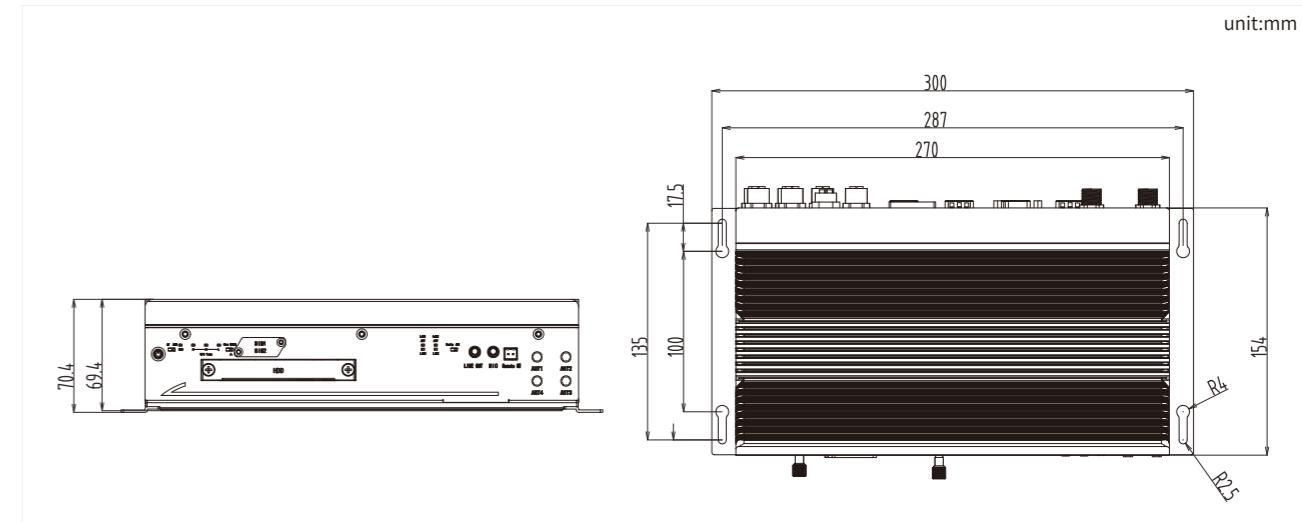
Structure	Aluminum chassis, stainless steel frame
Color	Silver grey
Installation method	Desktop Installation

Dimension (W*H*D)	270*154*64.5mm
Net weight	3.2KG

Environmental

Operating temperature	EN50155 TX: -40~70°C(Operating 10 minutes in 85°C)
Storage temperature	-40°C~85°C
Storage Humidity	10~90%@40°C, Non-condensing
Vibration	MIL-STD-801G, EN50155
Shock	MIL-STD-801G, EN50155
Certification /EMC	EN50155, E-Mark, CE/FCC Class B

Dimensions



Ordering Information

Model	Processor	Specification
SIGM-3250/S001	Core i3-6100U/i3-7100U	DDR3L, 2*LAN, 4*POE, 2*USB3.0, 3*USB2.0, 2* isolation COM, 3*Mini PCIe, 1*Smart Display, 1*DP, 1*VGA, optional Audio out, Mic, 8-bit isolated DIO, 1*2.5" SATA drive bay, 1*mSATA, DC 48/72/110V
SIGM-3250/S002	Core i5-6200U/i5-7200U	
SIGM-3250/S003	Core i7-6500U/i7-7500U	
SIGM-3250/T001	Core i3-6100U/i3-7100U	DDR3L, 2*LAN, 4*POE, 2*USB3.0, 3*USB2.0, 2* isolation COM, 3*Mini PCIe, 1*Smart Display, 1*DP, 1*VGA, optional Audio out, Mic, 8-bit isolated DIO, 1*2.5" SATA drive bay, 1*mSATA, DC 48/72/110V
SIGM-3250/T002	Core i5-6200U/i5-7200U	
SIGM-3250/T003	Core i7-6500U/i7-7500U	
M12A-5P DC Cable		DC cable with M12 A-Code Female 5 pin connector to bare wire, PVC Multicore Cable, 100cm
M12A-4P DC Cable		DC cable with M12 A-Code Female 4 pin connector to bare wire, PVC Multicore Cable, 100cm
M12A-8P USB Cable		USB cable with M12 A-Code Male 8 pin connector to 2*Type A with dual M3 ear nut-hole, PVC Multicore Cable, 50cm
M12X-8P LAN/POE Cable		Internet cable with M12 X-Code Male 8 pin connector to RJ45 crystal head connector, PVC Multicore Cable, 180cm
PA-60DC12-M12A-5P		AC/DC power adapter with M12 A-Code Female 5 pin connector, DC12V@5A 60W (non LSZH cable, no in-vehicle certification)
PA-120DC19-M12A-5P		AC/DC power adapter with M12 A-Code Female 5 pin connector, DC19V@6.32A 120W (non LSZH cable, no in-vehicle certification)

SIGM-3251

Intel® Skylake/Kabylake-U CPU, MLU220(8TOPS), LPDDR4 4GB, 4*LAN, 1*SFP, 5*USB, DP, VGA, 4* isolated COM, 8-bit programmable DIO, EN50155 certification

Key Specification

- All-in-One Rugged structure design, aluminum chassis with fanless heat dissipation
- Intel® Skylake/Kabylake-U CPU
- 2-Ch DDR4, On-board 4GB+LPDDR4 4GB
- Onboard Cambriion MLU220 AI acceleration chipset, AI computing power acceleration 8TOPS(INT8)
- 1*DP, 1*VGA,dual display interface
- 4*LAN, 1*SFP, 6*USB, built-in dongle interface
- 4* isolated COM, 8-bit programmable DIO with LED
- 4*Mini PCIe(1 optional mSATA), support GPS/WiFi/LTE/4G
- EN50155 certification, optional support TPM2.0 secure encryption,
- Railway power input DC 9-36V with wide voltage power supply



Product Overview

SIGM-3251 is a fanless rugged in-vehicle computer, equipped with Intel® Skylake /Kabylake-U processor and onboard Cambrian MLU220 AI acceleration chip, supports dual 4G full Netcom VPN/Wifi/BT/GPS and other wireless functions. It is also equipped with railway power input DC 9~36V with wide voltage power supply, has earned the EN50155 railway standard certification, is highly suitable for road vehicles, intelligent rail transit system industry applications.

Product Parameters

System

CPU	Intel® Skylake/Kabylake-U CPU Core i3/i5/i7 series CPU
AI Chipset	MLU220 8TOPS(INT8),4GB RAM, TDP8.5W
RAM	DDR4, 2133MHz, 1 onboard storage 4/8GB+1*LPDDR4 4GB, max 16GB 2*Mini PCIe, with dual SIM slot, support dual 4GLTE/Wifi/BT/GPS
Expansion	1*Mini PCIe, with USB signal, optional mSATA 1*Mini PCIe, with USB signal

Graphics Intel Gen. 9 HD Graphic , DP: 4096*2304@60Hz,
VGA: 1920*1200@60Hz, support 2 independent displays

Audio optional support Realtek ALC662VD audio, Audio out and MIC

LAN 4*Intel I210AT PCIe Gig. Ethernet, 4*M12
1*Intel I210IS PCIe Gig. Ethernet, 1*SFP

Storage 1*2.5" HDD SATA bay; 1*mSATA full size card (SATA+USB)

4*Gig-LAN (4*M12), 1*SFP
3*USB3.0 (Type A); 1*USB2.0 (Type A); 2*USB2.0 (M12)

8-bit programmable DIO (2*5Pin Phoenix terminal) , 1*Audio-out and

1*MIC(3.5mm audio port)

1*RS232/RS422/RS485 DB9 (2.5KV opto-isolator), 2*RS232 DB9 (2.5KV opto-isolator), 1* RS232/485 DB9(2.5KV opto-isolator)

2*SIM slot,1*DP+1*VGA

LED 1*PowerLED; 1*HDD LED; 3*CPU Temp LED
Red is alarm, Yellow is high temp, Green is normal temp)

Switches	1*power button, 1*remote switch(2-pin terminal), 1*AT/ATX switch, 1*Clear CMOS swtich
Watchdog timer	Programmable timeout interuption period or system reset from 1 to 255 secs
Power Requirement	Railway power module 9-36V input, 4-pin terminal port(M12), consumption: 12V/3.14A(I5-6500U CPU/8G DDR4)
OS	Linux Fedora Ubuntu

Mechanical

Structure Aluminum chassis, stainless steel frame

Color Silver gray

Installation Method Desktop installation

Dimension (W*H*D) 270*154*82.4mm

Netweight 3.93KG

Environmental

Operating temperature EN50155 TX: -40~70°C

Storage temperature -40°C~85°C

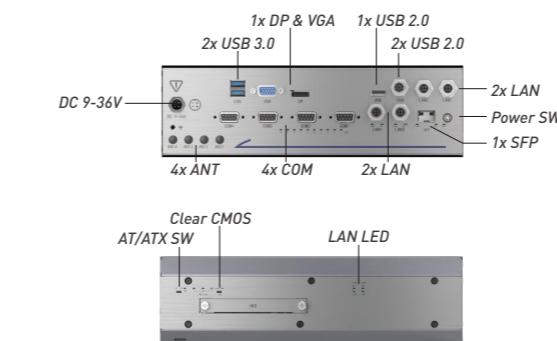
Storage humidity 10~90%@40°C, Non-condensing

Vibration MIL-STD-810G, EN50155

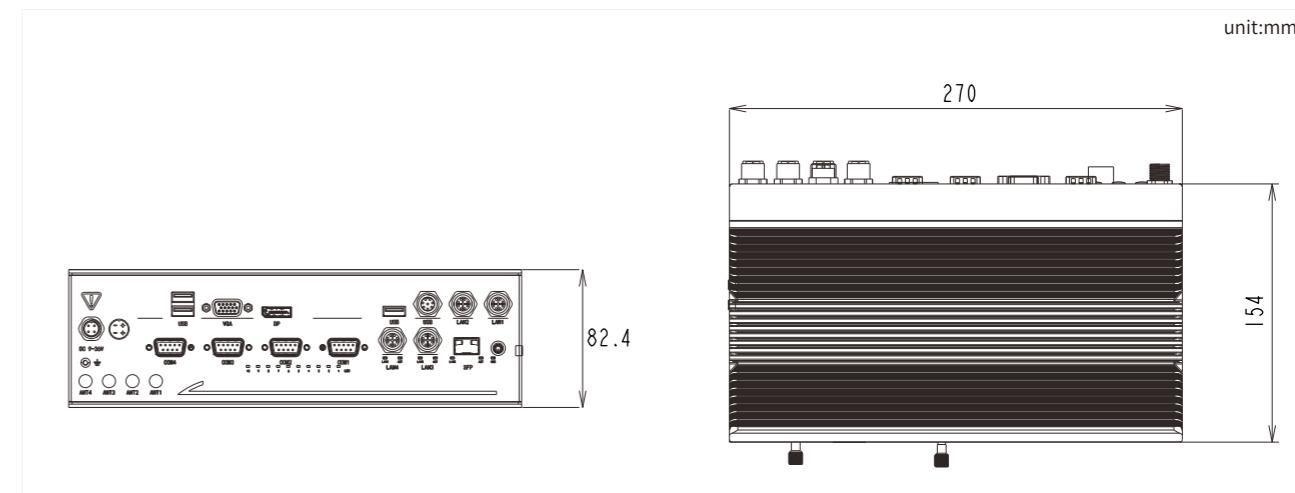
Shock MIL-STD-810G, EN50155

Certification /EMC EN50155, CE/FCC Class B

I/O View



Dimensions



Ordering information

Model	Processor	Specifications
SIGM-3251/S001	Core I3-6100U/I3-7100U	MLU220(8TOPS), 4GB+1*LPDDR4 4GB, 4*LAN, 1*SFP, 3*USB3.0, 3*USB2.0, 4*isolated COM, 3*Mini PCIe, 1*DP, 1*VGA, optional Audio out, Mic, 8-bit DIO, 1*2.5" SATA drive bay, 1*mSATA, DC 9~36V
SIGM-3251/S002	Core I5-6200U/I5-7200U	
SIGM-3251/S003	Core I7-6500U/I7-7500U	
	Mounting kits	19 inch 2U rack mounting kits
	M12A-5P DC Cable	DC cable with M12 A-Code Female 5 pin connector to bare wire, PVC Multicore Cable, 100cm
	M12A-4P DC Cable	DC cable with M12 A-Code Female 4 pin connector to bare wire, PVC Multicore Cable, 100cm
	M12A-8P USB Cable	USB cable with M12 A-Code Male 8 pin connector to 2*Type A with dual M3 ear nut-hole, PVC Multicore Cable, 50cm
	M12X-8P LAN/POE Cable	Internet cable with M12 X-Code Male 8 pin connector to RJ45 crystal head connector, PVC Multicore Cable, 180cm
	PA-60DC12-M12A-5P	AC/DC power adapter with M12 A-Code Female 5 pin connector, DC12V@5A 60W (non LSZH cable, no in-vehicle certification)

SIGM-U1350

Intel® Skylake/Kabylake-U CPU, MLU-220T-MXM, 1*DP, 1*VGA, 5*USB, 2*LAN, 1*SATA, 1*COM, 4*Mini PCIe, DC 110V

Key Specification

- Intel® Skylake/Kabylake-U CPU
- 2-Ch DDR4, On-board 4G+SODIMM, 20GB max.
- 1*DP, 1*VGA, 1*Smart Display, 3 display
- 2*LAN(M12), 5*USB(2*M12), built-in dongle interface
- 1*CONSOLE RS232(RJ45)
- 1*SATA3.0 2.5", 1*mSATA(Optional)
- 4*Mini PCIe(1*mSATA), support GPS/WiFi/LTE/4G
- MLU220T-MXM, 16TOPS
- EN50155, E-Mark certification, support TPM2.0
- Railway power input DC 110V (43V~ 160V)



Product Overview

SIGM-U1350 is a standard 1U rack mount fanless and rugged in-vehicle computer, powered by Intel® Skylake/Kabylake-U processors and equipped with the MLU220T-MXM module. It supports wireless functions such as dual 4G, global network VPN, WiFi, BT, and GPS, and features a wide voltage of DC 110V (43-110V). The product is EN50155 certified and suitable for road vehicles and intelligent rail transit systems.

Product Parameters

System

CPU	Intel® Skylake/Kabylake-U Corei3/i5/i7 CPU
AI Chipset	Optional MLU220T MXM 16TOPS(INT8)
RAM	2-ch DDR4, 2133MHz, onboard 4GB +1*SODIMM, 4+16GB max.
Graphics	Intel® Gen. 9 HD Graphics, DP:4096*2160@60Hz, Smart Display:1920*1200@60Hz, VGA:1920*1200@60Hz, 3 independent display
LAN	2*Intel® I210AT, 10-1000M(2*M12)
Audio	/
Storage	1*2.5" HDD SATA bay; 1*mSATA full size(SATA/USB)
I/O Port	2*Gig-LAN (M12 X-Coded) 2*USB3.0 Type A, 2*USB2.0 (M12 A-Coded), 1*USB2.0 Type A 1*Console RS232 (RJ45)
LED	1*PowerLED; 1*HDD LED; 3*CPU Temp LED Red is alarm, Yellow is high temp, Green is normal temp
Switches	1*Power, 1*Remote(2-pin), 1*AT/ATX, 1*Clear CMOS
Watchdog timer	Programmable timeout interruption period or system reset from 1 to 255 secs
OS	Linux, Windows 7(SKL-U 32/64; KBL-U 64),Windows 10 64bit(Windows does not support MLU220)

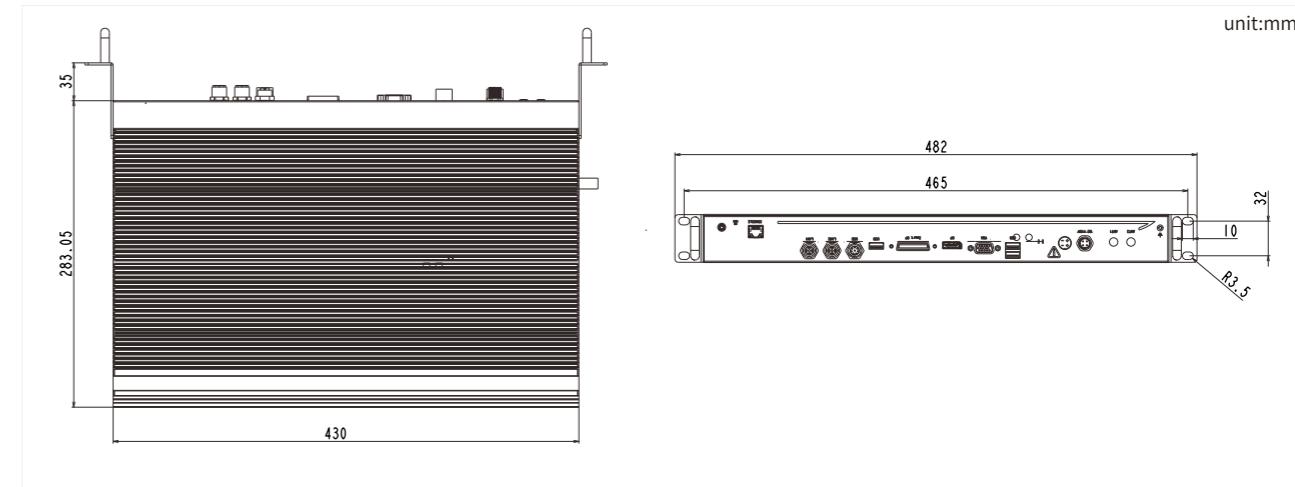
Mechanical

Structure	Aluminum chassis, stainless steel frame
Color	Silver gray
Installation Method	Rack installation
Dimension (W*H*D)	430*44.5*283mm
Weight	4.69KG
Environmental	
Operating temp	EN50155:2017 TX: -40~70°C
Storage temp	-40°C~85°C
Storage humidity	10~95%@40°C, No-condensation
Vibration	MIL-STD-810G, EN50155
Shock	MIL-STD-810G, EN50155
Certification /EMC	EN50155: 2017 & E-Mark & CE & FCC Class A

I/O View



Dimensions



Ordering information

Model	Processor	Specifications
SIGM-U1350/S001	Intel® I3-6100U/I3-7100U	On board 4GB+1*SODIMM DDR4
SIGM-U1350/S002	Intel® I5-6200U/I5-7200U	2*LAN, 2*USB3.0, 5*USB2.0, 1*COM(RJ45), 3*Mini PCIe, 1*DP, 1*VGA, 1*Smart Display, 1*mSATA, 1*SATA3, DC110V(43V~ 160V)
SIGM-U1350/S003	Intel® I7-6500U/I7-7500U	
SIGM-U1350/S004	Intel® 3855U/3865U	
MXM 3.1 GPU	Optional Cambricon MLU220T-MXM	
M12A-4P DC Cable	DC cable with M12 A-Code Female 4 pin connector to bare wire, PVC Multicore Cable, 100cm	
M12A-4P USB Cable	USB cable with M12 A-Code Male 8 pin connector to 2*Type A with dual M3 ear nut-hole, PVC Multicore Cable, 50cm	
M12X-8P LAN Cable	Internet cable with M12 X-Code Male 8 pin connector to RJ45 crystal head connector, PVC Multicore Cable, 180cm	

SIGM-U3550

3U CPCI-S.0 R2.0 Enclosure, 3U CPCI-S.0 R2.0 Processor Blade ,
Intel Coffee lake-H CPU, 9-slot CPCI-S.0 Backplane, 1+1 redundant 300W PSU, Intelligent Cooling design

Key Specification

- PICMG CompactPCI Serial(CPCI-S.0R2.0) standard
- 3U 84HP Enclosure with 9-slot CPCI-S.0 backplane and 2-slot power backplanes
- Intel®Coffee Lake-H CPU+CM246 PCH Processor Blade
- On-board 8G DDR4+1*DDR4 SODIMM, Ram. up to 40G
- 1*DP+1*HDMI, 2 display, 4*G-LAN, 2*USB3.1
- 1*mSATA, optional 4*2.5"SATA3.0 Storage Blades
- 8*3U CPCI-S.0 standard expansion slots
- 1+1 Redundant rail-way standard ultra-wide voltage
- 300W power supply DC 16.6~160V
- 3*12025 double Ball Bearing temperature control Fans,
- 1U chassis easy-plug design
- EN-50155:2021 certification



Product Overview

SIGM-U3550 is a 4U rack-mounted in-vehicle system conforms to the PICMG CompactPCI Serial standard. 3U Enclosure with 9-slot CPCI-S.0 backplane, 1 system slot and 8 expansion slots, 2 power supply slots. Standard with Intel Coffee Lake-H+CM246 3U CPCI-S.0 Processor blade, 2*PCIeX8, 2*PCIeX4, 2*PCIeX1, 2~4*2.5"SATA drive bay, memory on-board, 4*LAN, 1+1 redundant ultra-wide DC 16.6~160V 300W PSU. Aviation-grade reliability, suitable for rail-way and ship transportation, aviation, telecommunications and industrial automation. and other fields.

Product Parameters

System

CPU	Intel Coffee lake-H Core i3/i5/i7/Xeon CPU, TDP 25W or 45W
RAM	Dual-channel DDR4, On-board 8GB+ 1*SODIMM, 8+32GB max. Slot7&8: 1*PCIe3.0X8(CPU)+1*USB3.1+1*USB2.0+1*G-LAN; Slot6: 1*PCIeX4+1*USB3.1+1*USB2.0, 1*G-LAN; Slot5: 1*PCIeX4+1*USB3.1+1*USB2.0; Slot3&4: 1*PCIeX1+SATA3.0+1*USB2.0; Slot1&2: 1*SATA3.0+1*USB2.0; Slot9(System): 2*PCIeX8+2*PCIeX4+2*PCIeX1+4*USB3.1+ 4*SATA3.0+8*USB2.0+3*G-LAN 1*Intel I210AT(IT)+1*Intel I219LM(2*RJ45); 2*Intel I210AT(IT)[2*M12]; 3*Intel I210AT(IT)
Expansion	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1; DP:4096*2304@60Hz, HDMI:4096*2160@24Hz, support 2 independent displays
Graphics	4*2.5" HDD SATA bay(RAID0/1/5/10); 1*mSATA
Storage	4*Gig-LAN +2*USB3.1+ 1*DP+1*HDMI+1*COM(SHP); 3*Gig-LAN(Slot 6/7/8,P6); 4*USB3.1(Slot 5/6/7/8,P1); 8*USB2.0(Slot 1/2/3/4/5/6/7/8,P1)
I/O Port	1*Power LED, 1*HDD LED, 4* Network Connection LED (ACT/LINK), LED are all on the 8HP rear
LED	AT Power form, 1*Clear CMOS SW
Switches	programmable via software1 to 255 second
Watchdog timer	

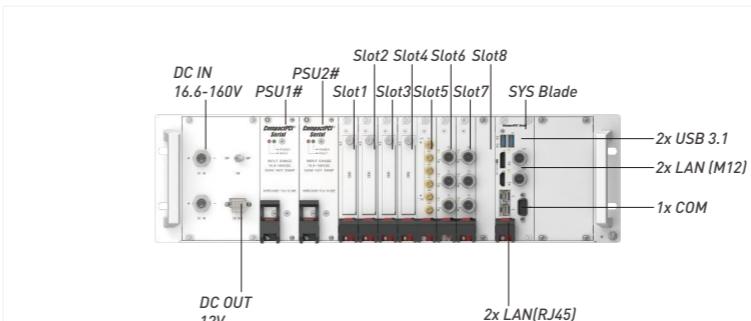
Mechanical

Structure	Aluminum alloy mold, conductive oxidation process
Color	Silver + Grey
Installation	Desktop/Rack Mounting
Dimension (W*H*D)	482.6*248.2*133mm(w kits), 435.8*208.5*133mm(n kits)
Weight	TBD

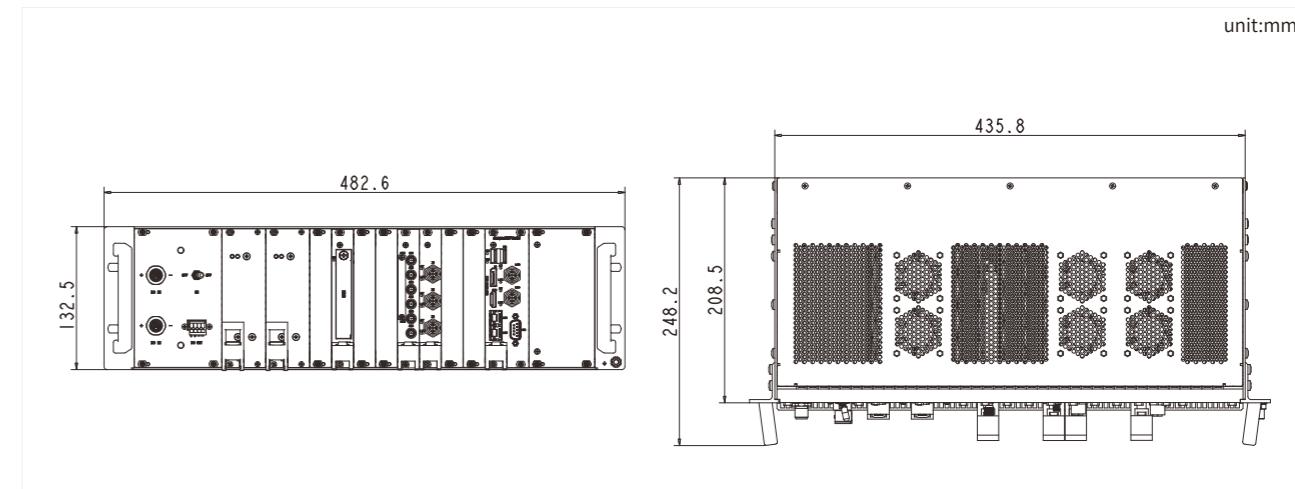
Environmental

Operating temp.	EN50155 QT3: -25~70°C(25W CPU); QT1: -25~55°C(45W CPU)
Storage temp.	-40°C~85°C
Storage humidity	10~95%@40°C, Non-condensing
Vibration	MIL-STD-810G, EN50155:2021
Shock	MIL-STD-810G, EN50155:2021
Certification/EMC	EN50155: 2021 & CE/FCC Class A

I/O View



Dimensions



Ordering information

Model	Processor	Specifications
SIGM-U3550/S001	Intel Core i3-9100HL	3U CPCI-S.0 R2.0 Enclosure+1U Fan Chassis, Intel CM246 PCH+Coffee Lake H CPU, on-board DDR4 8GB+1*SODIMM, 1*DP+1*HDMI, 4*G-LAN, 2*USB3.1, 1*RS232/422/485, 1*mSATA, 8*3U CPCI-S.0 expansion slot, 1+1 redundant power slot, default 1*300W PSU DC IN 16.6~160V.
SIGM-U3550/S002	Intel Xeon E-2254ME	
SIGM-U3550/S003	Intel Core i7-9850HE	
CPCIs-282	3*Intel I210AT(Gig. chip, IEEE 802.3af (15.4W/48V), M12 X-Code CPCI-S.0 3U	
CPCIs-283	2.5"SATA3.0 easy-plug design drive bay, CPCI-S.0 3U	
CPCIs-284	2*Full size Mini PCIe (w/SIM), 1*M.2 2230 E-Key, 1*M.2 3052 B-Key w/SIM, CPCI-S.0 3U	
OFX-DC300DC12V	DC 16.6~160V input, DC 12V&5VSB output, 300W PSU, CPCI-S.0 Peripheral Blade	
M12A-4P DC Cable	cable with M12 A-Code Female 4 pin connector to bare wire, PVC Multicore Cable, 4-wires 18AWG PVC, non LSZH cable, 100cm	
M12X-8P LAN/POE Cable	Internet cable with M12 X-Code Male 8pin connector to RJ45 crystal head connector, 8-wires CAT6,LSZH cable,180cm	
PA-300DC48-M12A-4P	AC-DC power supply, DC48V@7.32A, 85-305V AC input, DC 48V output, wide temperature fanless, 300W (non LSZH cable, no in-vehicle certification)	

SIGM-3555

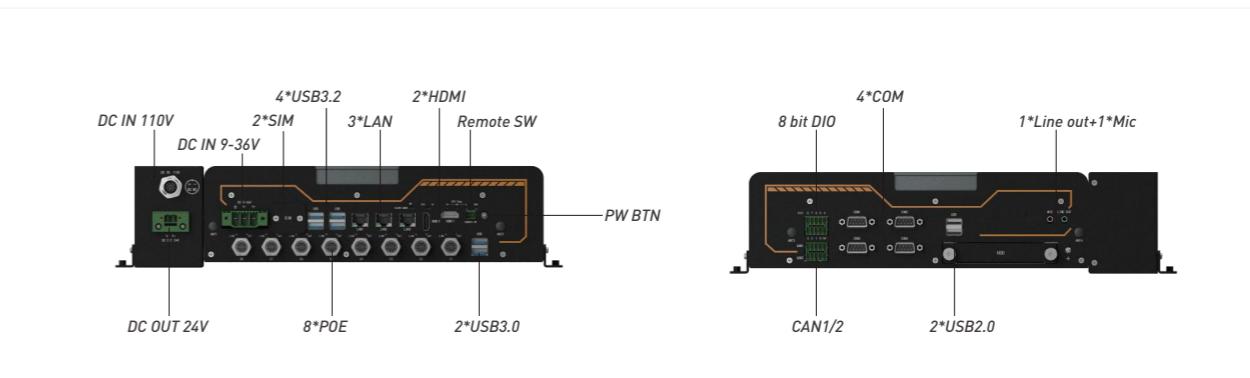
Intel® Comet lake Celeron/Pentium/Core™ i9/i7/i5/i3 CPU,11*LAN, 8*USB, 4*COM, 2*CAN, 3*M.2, 8 bit DIO, DC110V

Key Specification

- Intel® Comet lake 10th-Gen Celeron/Pentium/Core™ i9/i7/i5/i3 CPU
- Aluminum frame, fan-less
- 3*2.5G-LAN+8*Gig-LAN with POE function
- 8-bit DIO, 4*USB3.0, 2*USB3.0, 2*USB2.0, 4*COM
- 2*CAN, supports both CAN2.0A and CAN2.0B protocols, conforms to ISO/DIS 11898-1/2/3 standards
- 2*HDMI, 2 independent display
- 3*M.2 supports Gigabit WiFi6, 4G LTE/5G NR
- DC 110V rail-way standard isolated power supply, with reverse connection, overcurrent, overvoltage protection



I/O View



Product Overview

SIGM-3555 is a high-performance fanless AI edge computing system, equipped with Intel® Comet lake series processors, multi-network ports, multi-display and multi-I/O functions, 110V DC power supply, It is suitable for rail transit, vehicle-road cooperation C-V2X, special vehicle onboard, intelligent security, high-precision machine vision, medical imaging and other industries.

Product Parameters

System

CPU Intel® Comet lake 10th-Gen Celeron/Pentium/Core™ i9/i7/i5/i3 CPU, Intel® Q470 PCH

RAM 2*DDR4 SO-DIMM, 2933MHz, 64GB max.

Expansion 1*M.2 2230 E-key(PCIeX1/USB2.0+CNvio), WiFi6/BT5.0;

1*M.2 3052 B-key, PCIeX1/USB2.0+SIM, 5G NR/4G LTE; 1*M.2 2280 M-Key(PCIe4X4), NVME/PCIe module

LAN 3*Intel I226V,10M-2.5G, iAMT 13.0, vPro(Core i5/i7/i9 CPU); 8*Intel I210AT, IEEE 802.3af (15.4W/48V);

Graphics Intel UHD Graphics, Supports DirectX12, OpenGL 4.5; HDMI:4096*2304@24Hz, HDMI:4096*2304@24Hz

Storage 1*2.5" HDD SATA (RAID0/1); 1*M.2 2280 M-Key(PCIe4X4), NVMe

I/O Port F:3*2.5G-LAN;8*POE LAN (M12) ;4*USB3.2(10G); 2*USB3.0; 2*SIM; B:2*USB2.0;2*RS232/422/485(DB9); 2*RS485 (DB9); 1*8-bit DIO (2*5Pin); 2*CAN(2*5Pin);1*Line out+1*Mic (3.5mm);

LED 1*Power LED, 1*HDD LED, 3*CPU Temp. LED

Switches 1* Power w/LED,1*Remote SW, 1*F-panel, AT-ATX, Clear Cmos

Watchdog timer programmable via software1 to 255 second

Power& TDP

DC IN: 110V(rail-way standard isolated power supply , ±40%), maximum output power 250W; TDP: 110W(I7-10700 CPU)

OS

Windows 10 IoT Enterprise (64-bit), Windows 11 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux, Yocto Project (64-bit), Wind River VxWorks 7

Mechanical

Structure Aluminum-magnesium alloy, SGCC frame

Color Black

Installation Desktop Mounting

Dimension (W*H*D) 374*246*85mm(w kits), 342*222*85mm(n kits)

Weight 7.76KG

Environmental

Operating temp. EN50155 QT1: -25~55°C (TDP 35W CPU, airflow)

Storage temp. -40°C~85°C

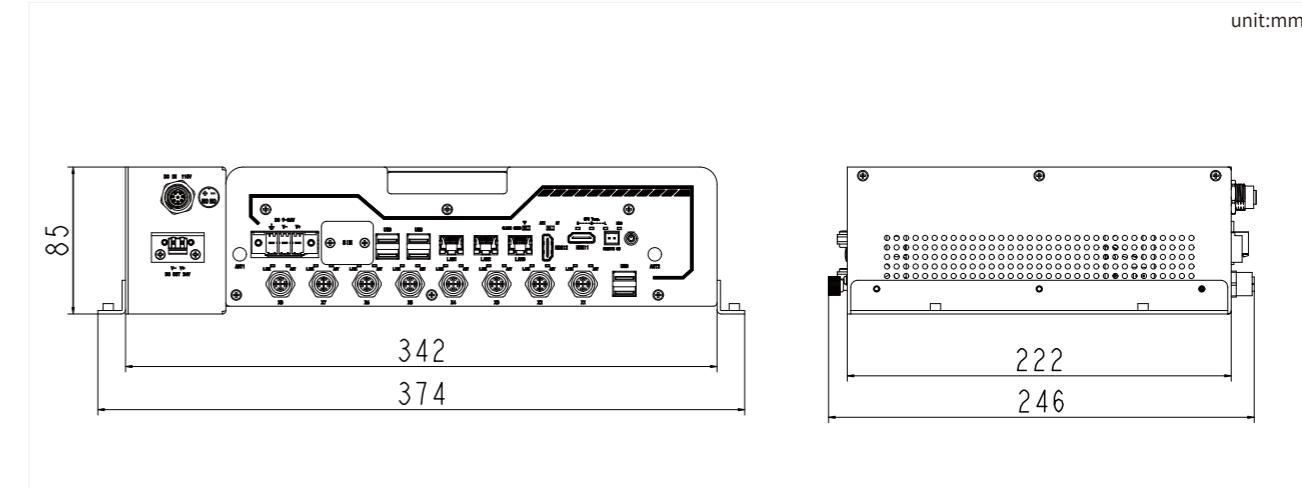
Storage humidity 10~95%@40°C, , Non-condensing

Vibration 5grms/5~500Hz/random/in working (SSD); 1grms/5~500Hz/random/in working (HDD)

Shock 50g peak acceleration(11ms duration)(SSD); 20g peak acceleration(11ms duration)(HDD)

Certification/EMC EN50155: 2021 & CE/FCC Class A

Dimensions



Ordering information

Model	Processor	Specifications
SIGM-3555/S001	Intel® Comet lake 10th-Gen Celeron/Pentium/Core™ i9/i7/i5/i3 CPU	Intel Q470 PCH, Intel CML LGA1200 CPU, 4*USB3.2, 2*USB3.0, 2*USB2.0, 4*COM, 8*POE, 2*CAN 1*M.2 E-Key, 1*M.2 B-Key, 2*HDMI, 1*MIC+1*Audio-out, 1*M.2 M-Key, 1*2.5"SATA bay, DC 110V rail-way standard isolated power supply
M12X-8P LAN/POE Cable	LAN cable, M12 X-Code Male 8pin connector to RJ45 , 8-core CAT6, LSZH cable, 180cm	
PA-300DC48-M12A-4P	AC-DC power supply, DC48V@7.32A,85-305V AC input, DC 48V output, wide temp. fanless, 300W (non LSZH cable, no in-vehicle certification)	

ICS-2010

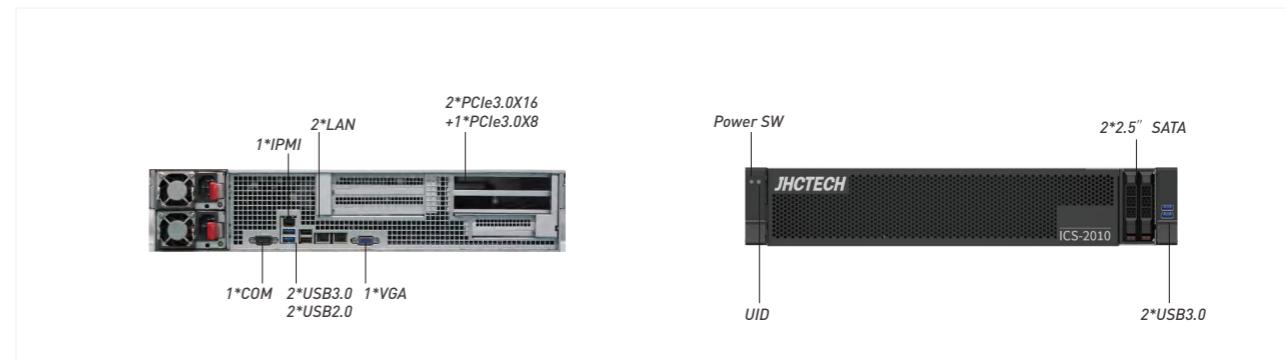
2U dual-channel server, Intel Xeon 2nd-gen scalable series processors,
2x2.5" hot swap drive bay, 3xPCIe slots, 1 VGA, 1xCOM, 4xUSB3.0, 2xLAN, 1xIPMI, support for different power redundancy power supply.

Key Specification

- 1/2 Intel Xeon Gen2 Scalable series processors
- 16*DDR4, 2133/2400 /2666/2933 MHz ECC LRDIMM /RDIMM
- 2*2.5" hot-swap hard drive bay
- Supports 2*PCIe3.0X16, 1*PCIe3.0X8
- 4*USB3.0, 1*VGA, 1*COM, 2*LAN, 1*IPMI
- 3*8038 hot swap high-speed fan
- In line with OTII standard
- 100-240V input, 550/800/1200/1600W 1+1 redundant power supply



I/O View



Product Overview

ICS-2010 is a dual-channel edge computing server, equipped with 1 or 2 2nd-gen Intel® Xeon extensible series processors, C621 chipsets, 16 ECC LRDIMM/RDIMM DDR4 memory slots, 2 M.2 ports, 2 Gigabit network ports, 1 management network port, 3 PCIe expansion slots. It supports a maximum of 2 full-height double-width GPU cards, which is oriented to the 5G edge server market and meets OTII standards, and is very suitable for inference servers in the edge AI field.

Product Parameters

System

CPU	1/2 Gen2 Intel® Xeon®Scalable Processors, Intel® C621 PCH
RAM	16*DDR4, 2933MHz ECC LRDIMM/RDIMM LRDIMM:4T (16*256GB); RDIMM:2T (16*128GB)
Expansion	2*PCIe3.0X16+1*PCIe3.0X8; 1*M.2 22110/2280 M-Key (PCIe3.0X4), 1*M.2 2280 M-Key (PCIe3.0X4)
LAN	2*Intel I210AT 10M-1000M; 1*IPMI2.0, Aspeed AST2500 BMC
display	VGA:1920*1200@60Hz,
Storage	2*2.5" SAS/SATA3.0,RAID0,1
I/O Port	F:2*USB3.0; B:1*VGA, 1*COM, 2*USB3.0, 1*IPMI (RJ45), 2*LAN (RJ45)
LED	1*Power LED, 1*ERROR LED, 1*HDD LED, 2*NIC network LED
Switches	1*Power SW, 1*RST, 1*UID
Watchdog timer	programmable via software1 to 255 second

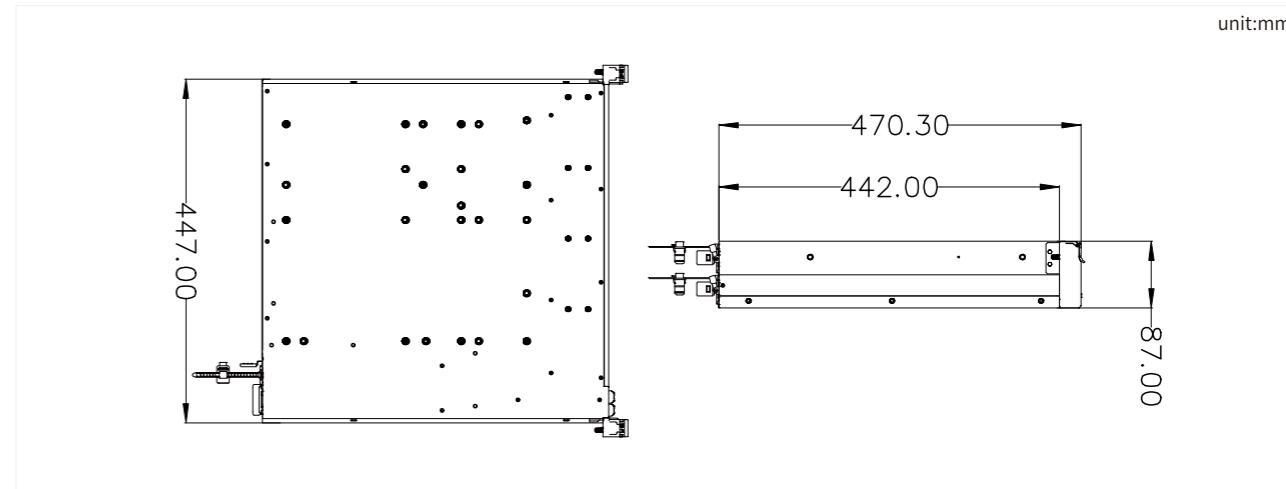
Mechanical

Structure	Imported SGCC hot dip galvanized steel sheet
Color	black + silvery
Installation Dimension (W*H*D)	Desktop Mounting
Weight	442*447*87mm
	TBD

Environmental

Operating temp.	0~50°C
Storage temp.	-20°C~75°C
Storage humidity	5~95%@40°C, Non-condensing
Vibration	TBD
Shock	TBD
Certification/EMC	CCC/CE/FCC Class A

Dimensions



Ordering information

Model	Processor	Specifications	
ICS-2010-S001-1600	1/2 Gen2 Intel® Xeon®Scalable Processors, Intel® C621 PCH	16*DDR4 LRDIMM/RDIMM, 2*LAN, 1*IPMI, 4*USB3.0, 2*USB2.0, 1*COM, 1*VGA, 2*2.5"SAS/SATA bay, 2*PCIe 3.0X16, 1*PCIe3.0X8, 2*M.2(Pcie3.0X4), 3*8038 temperature-controlled fan	1600W, 1+1 redundant power supply
ICS-2010-S001-1200			1200W, 1+1 redundant power supply
ICS-2010-S001-800			800W, 1+1 redundant power supply
ICS-2010-S001-550			550W, 1+1 redundant power supply

ICS-2020

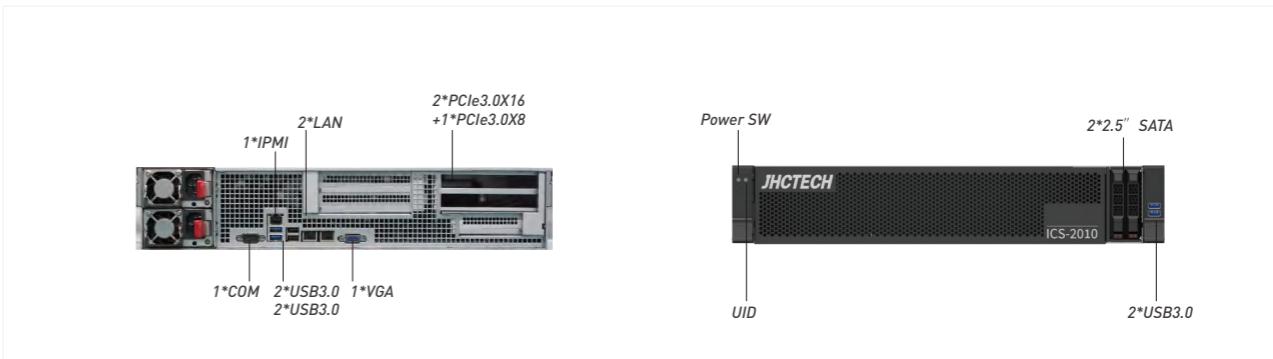
2U dual-channel server, Intel Xeon 4 expandable series processors, 2*2.5 "hot swap drive bay, three PCIe expansion slots, 1*VGA, 1*COM, 4*USB3.0, 2*LAN, 1*IPMI, support for different power supply redundancy.

Key Specification

- 1/2 Intel Xeon Gen4 Scalable series processors
- 16*DDR5,5600/5200/4800/4400/4000 MT/s ECC RDIMM(3D),4TB max.
- 2*2.5" hot-swap hard drive bay,
- Supports 2*PCIe5.0X16,1*PCIe5.0X8
- 4*USB3.0,1*VGA,1*COM,2*LAN,1*IPMI
- 3*8038 hot swap high-speed fan
- In line with OTII standard
- 100-240V input, 550/800/1200/1600W 1+1 redundant power supply



I/O View



Product Overview

ICS-2020 is a dual-channel edge computing server, equipped with 1 or 2 4th-gen Intel® Xeon extensible series processors, C741 chipsets, 16 3DS RDIMM/RDIMM DDR5 ECC memory slots, 2 M.2 ports, 2 Gigabit network ports, 1 management network port, 3 PCIe expansion slots. It supports a maximum of 2 full-height double-width GPU cards, which is oriented to the 5G edge server market and meets OTII standards, and is very suitable for inference servers in the edge AI field.

Product Parameters

System

CPU	1/2 Gen4 Intel® Xeon®Scalable Processors, Intel® C741 PCH
RAM	16*DDR5,5600MHz ECC RDIMM(3DS) 4TB max.(16*256GB)
Expansion	2*PCIe5.0X16+1*PCIe5.0X8; 1*M.2 22110/2280 M-Key (PCIe4.0X2), 3*M.2 22110/2280 NVMe

LAN	2*Broadcom BCM5720,1GBase-T; 1*IPMI2.0,Aspeed AST2600 BMC
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display	VGA:1920*1200@60Hz,
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Storage	2*2.5" SAS/SATA3.0,RAID0,1
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I/O Port	F:2*USB3.0; B:1*VGA, 1*COM, 4*USB3.0, 1*IPMI (RJ45), 2*LAN (RJ45)
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LED	1*Power LED, 1*ERROR LED, 1*HDD LED, 2*NIC network LED
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Switches	1*Power SW, 1*RST, 1*UID
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Watchdog timer	programmable via software1 to 255 second
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Mechanical

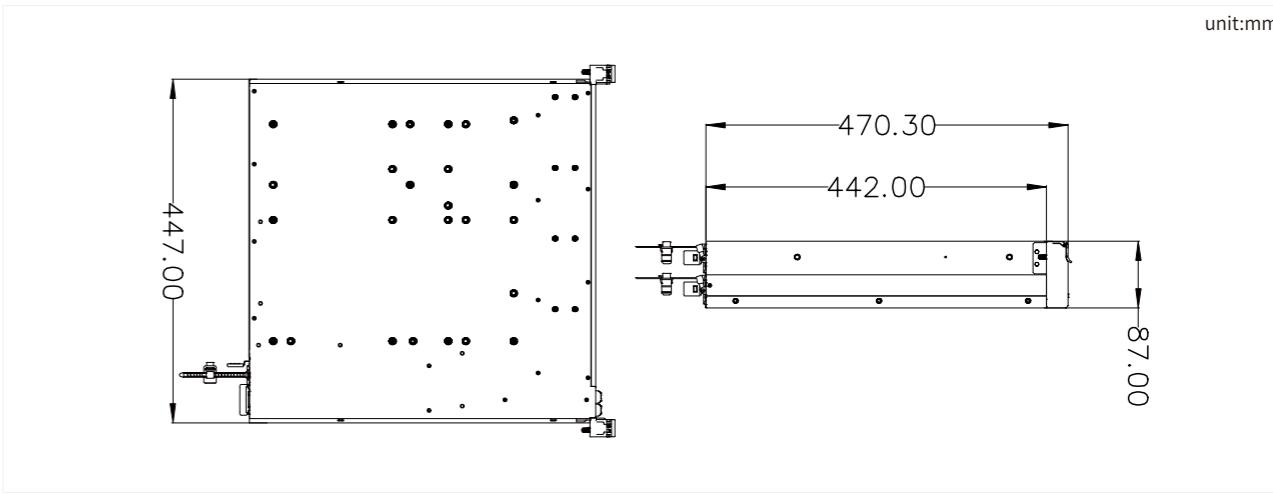
Structure	Imported SGCC hot dip galvanized steel sheet
Color	black + silvery
Installation Dimension (W*H*D)	Desktop Mounting
Weight	442*447*87mm TBD

Environmental

Operating temp.	0~50°C
Storage temp.	-20°C~75°C
Storage humidity	5~95%@40°C, Non-condensing

Vibration	TBD
Shock	TBD
Certification/EMC CCC/CE/FCC Class A	

Dimensions



Ordering information

Model	Processor	Specifications	
ICS-2020-S001-1600	1/2 Gen4 Intel® Xeon®Scalable Processors, Intel® Q741 PCH	16*DDR5 3DS RDIMM/RDIMM, 2*LAN, 1*IPMI, 6*USB3.0, 1*COM, 1*VGA, 2*2.5"SAS/SATA bay, 2*PCIe 5.0X16, 1*PCIe 5.0X8, 2*M.2(Pcie4.0X2), 3*8038 temperature-controlled fan	1600W, 1+1 redundant power supply
ICS-2020-S001-1200			1200W, 1+1 redundant power supply
ICS-2020-S001-800			800W, 1+1 redundant power supply
ICS-2020-S001-550			550W, 1+1 redundant power supply

ICS-4010

4U dual-channel server, Intel Xeon 2 expandable series processors,

2*2.5 "hot swap drive bay, three PCIe expansion slots, 1*VGA, 1*COM, 4*USB3.0, 2*LAN, 1*IPMI, support for different power supply redundancy.

Key Specification

- 1/2 Intel Xeon Gen2 scalable series processors
- 16*DDR4, 2133/2400 /2666/2933 MHz ECC LRDIMM /RDIMM,4TB max.
- 8x2.5/3.5" hot-swap drive bay and 2x2.5"SAS/ SATA drive bay(built-in)
- 6*PCIe3.0X16,1*PCIe3.0X8(X4 signal)
- 4*USB3.0, 2*USB2.0, 1*VGA,1*COM, 2*LAN,1*IPMI
- 4x8038 hot-swap high-speed fan+2x8038 fan module(rear)
- Supports 550/800/1200/1600/2000/2200W 1+1 redundant power supply



Product Overview

ICS-4010 is a dual-channel edge computing server, equipped with 1 or 2 2nd-gen Intel® Xeon extensible series processors, C621 chipsets, 16 ECC LRDIMM/RDIMM DDR4 memory slots, 1 M.2 ports, 2 Gigabit network ports, 1 management network port, 7 PCIe expansion slots, supports a maximum of four full-height, dual-width GPU cards. It has computing and storage capabilities, suitable for artificial intelligence, virtualization, cloud computing, big data processing, distributed storage, enterprise market or telecom business applications.

Product Parameters

System

CPU	1/2 Gen2 Intel® Xeon®Scalable Processors, Intel® C621 PCH
RAM	16*DDR4,2933MHz ECC LRDIMM/RDIMM LRDIMM:4TB max.(16*256GB); RDIMM:2TB max.(16*128GB)
Expansion	6*PCIe3.0X16+1*PCIe3.0X8(X4); 1*M.2 22110/2280 M-Key (PCIe3.0X4)

LAN	2*I210AT,10M-1000M; 1*IPMI2.0,Aspeed AST2500 BMC
display	VGA:1920*1200@60Hz,
Storage	8*2.5" SAS/SATA3.0,hot swap hard drive bay,RAID0,1,5,10; 2*2.5" SAS/SATA hard drive bay
I/O Port	F:2*USB3.0; B:1*VGA, 1*COM, 2*USB3.0, 2*USB2.0, 1*IPMI (RJ45), 2*LAN (RJ45)
LED	1*Power LED, 1*ERROR LED, 1*HDD LED, 2*NIC network LED
Switches	1*Power SW, 1*RST, 1*UID
Watchdog timer	programmable via software1 to 255 second

Power& TDP

Power& TDP	550W/800W/1200W/1600W/2000W/2200W, 1+1 hot swap redundant power supply
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OS

OS	Windows Server 2012/2008 R2(64-bit) , Windows SBS 2011(64-bit), Red Hat Enterprise Linux Server(32/64-bit), Suse Enterprise Linux Server(32/64-bit), Ubuntu Server(32/64-bit)
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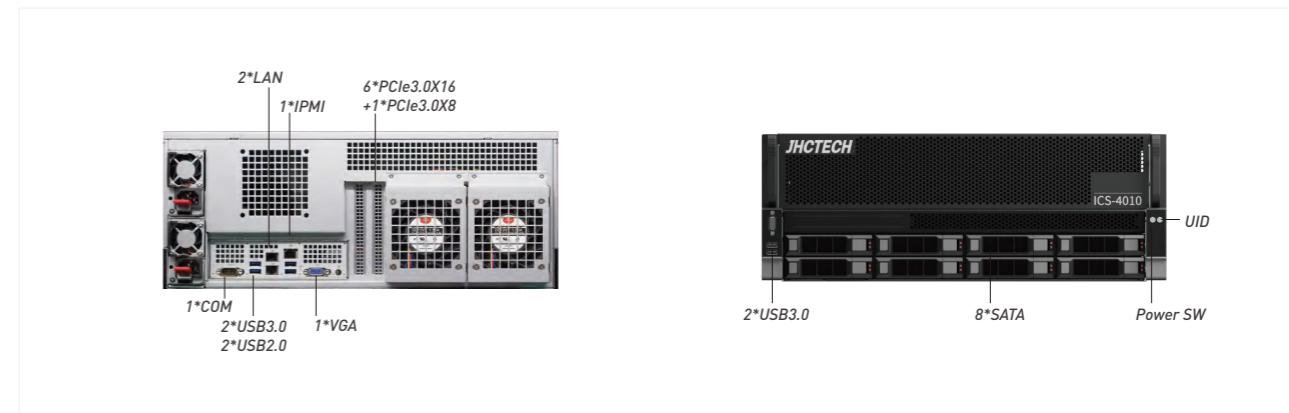
Mechanical

Structure	Imported SGCC hot dip galvanized steel sheet
Color	black + silvery
Installation Dimension (W*H*D)	Desktop Mounting 645*445*176.5mm
Weight	TBD

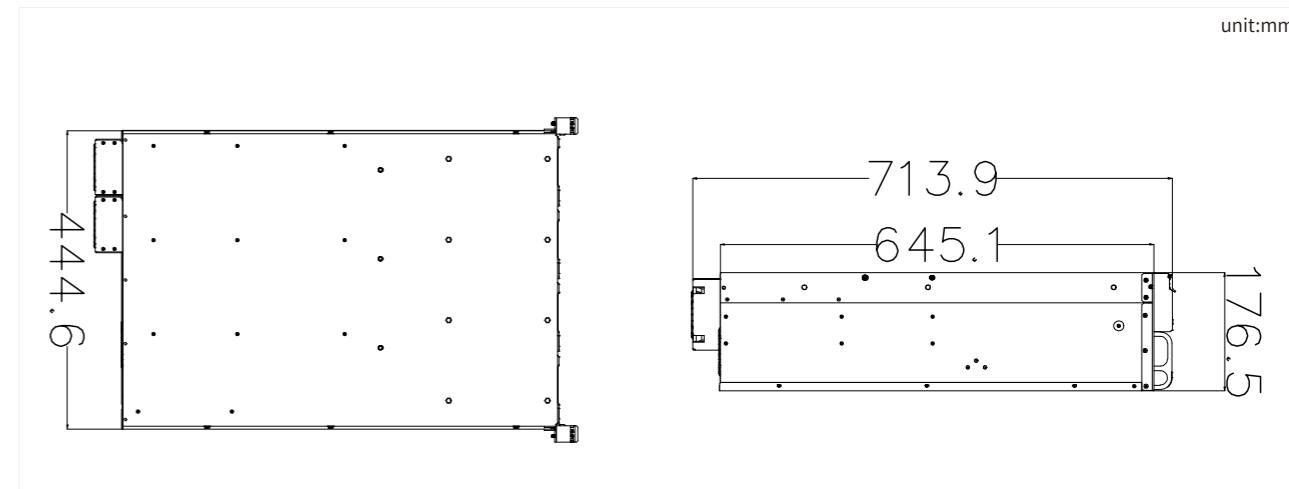
Environmental

Operating temp.	0~50°C
Storage temp.	-20°C~75°C
Storage humidity	5~95%@40°C, Non-condensing
Vibration	TBD
Shock	TBD
Certification/EMC	CCC/CE/FCC Class A

I/O View



Dimensions



Ordering information

Model	Processor	Specifications	
ICS-4010-S001-2200	Intel®Xeon Gen2 Scalable series processors Intel® C621 PCH	16*DDR4 LRDIMM/RDIMM, 2*LAN, 1*IPMI, 4*USB3.0, 2*USB2.0, 1*COM, 1*VGA, 8*3.5/2.5"SAS/SATA bay, 2*2.5"SAS/SATA bay(built-in) , 6*PCIe 3.0X16, 1*PCIe3.0X8(X4 signal), 2*M.2(Pcie3.0X4), 4x8038 temperature control fan+2x8038 fan module(rear)	2200W, 1+1 redundant power supply
ICS-4010-S001-2000			1600W, 1+1 redundant power supply
ICS-4010-S001-1600			1200W, 1+1 redundant power supply
ICS-4010-S001-1200			800W, 1+1 redundant power supply
ICS-4010-S001-800			800W, 1+1 redundant power supply
ICS-4010-S001-550			550W, 1+1 redundant power supply

ICS-4040

4U dual-channel server, Intel Xeon 4th-gen scalable series processors,

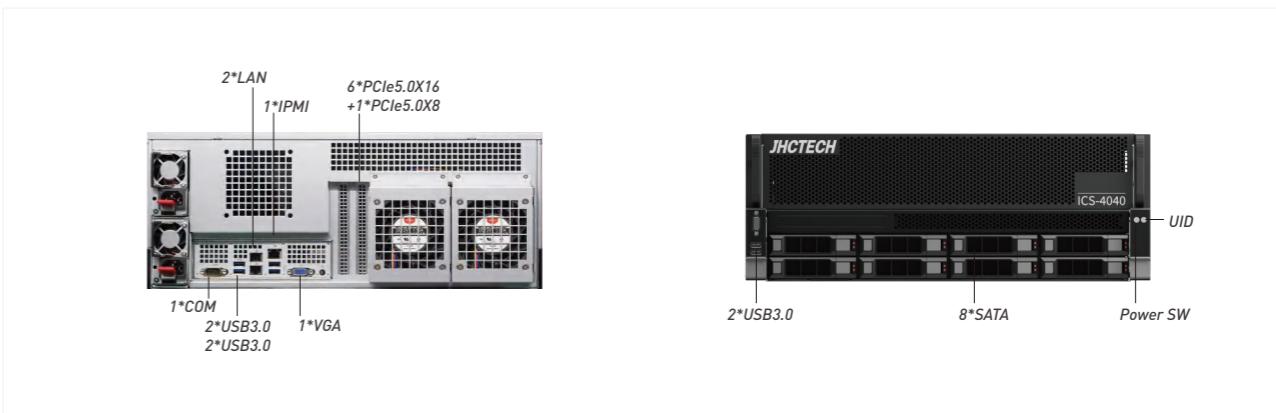
support 8x2.5/3.5" hot-swap drive bay and 2x2.5" SAS/SATA drive bay built-in), 7xPCIe expansion slots, 1xVGA, 1xCOM, 6xUSB3.0, 2xLAN, 1xIPMI

Key Specification

- 1/2 Intel Xeon Gen4 scalable series processors
- 16*DDR5, 5600/5200/4800/4400/4000 MT/s, 3DS RDIMM, 4TB max.
- 8x2.5/3.5" hot-swap drive bay and 2x2.5" SAS/ SATA drive bay(built-in)
- 6*PCIe5.0X16, 1*PCIe5.0X8
- 6*USB3.0, 1*VGA, 1*COM, 2*LAN, 1*IPMI
- 4x8038 hot-swap high-speed fan+2x8038 fan module(rear)
- Supports 550/800/1200/1600/2000/2200W 1+1 redundant power supply



I/O View



Product Overview

ICS-4040 is a dual-channel edge computing server, equipped with 1 or 2 4th-gen Intel® Xeon extensible series processors, C741 chipsets, 16 ECC RDIMM/3DS RDIMM DDR5 memory slots, 2 M.2 ports, 2 Gigabit network ports, 1 management network port, 7 PCIe expansion slots, supports a maximum of four full-height, dual-width GPU cards. It has computing and storage capabilities, suitable for artificial intelligence, virtualization, cloud computing, big data processing, distributed storage, enterprise market or telecom business applications.

Product Parameters

System

CPU	1/2 Gen4 Intel® Xeon® Scalable Processors, Intel® C741 PCH
RAM	16*DDR5, 5600MHz, 3DS RDIMM/RDIMM 4T max.(16*256GB)
Expansion	6*PCIe5.0X16+1*PCIe5.0X8(X4); 1*M.2 22110/2280 M-Key(PCIe4.0X4); 3*M.2(PCIe5.0X8), 6*NVMe(PCIe5.0X4)

LAN	2*Intel I210AT 10M-1000M; 1*IPMI2.0, Aspeed AST2600 BMC
display	VGA:1920*1200@60Hz,

Storage	8*2.5"/3.5" SAS/SATA, RAID0/1/5/10; 2*2.5" SAS/SATA
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I/O Port	F:2*USB3.0; B:1*VGA, 1*COM, 4*USB3.0; 1*IPMI (RJ45), 2*LAN (RJ45)
LED	1*Power LED(on power button), 2*LAN LED, 1*HDD LED

Switches	1*Power SW, 1*RST, 1*UID
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Watchdog timer	programmable via software1 to 255 second
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Mechanical

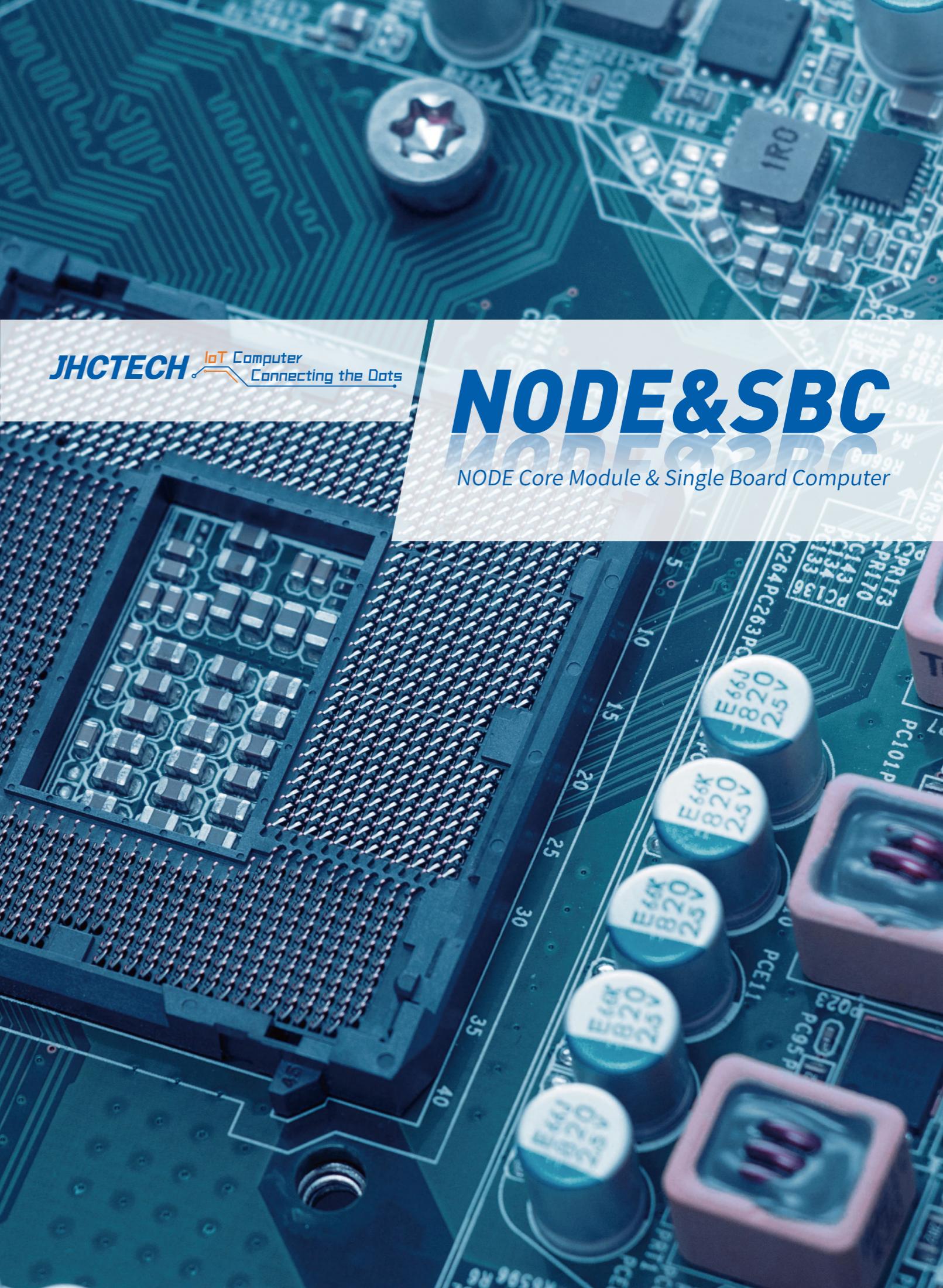
Structure	Imported SGCC fingerprint resistant galvanized steel, 19-inch rack 4U standard
Color	black + silvery
Installation	Desktop Mounting
Dimension (W*H*D)	645*445*176.5mm
Weight	18KG

Environmental

Operating temp.	5~35°C
Storage temp.	-40°C~65°C
Storage humidity	5~95%@40°C, Non-condensing
Vibration	TBD
Shock	TBD
Certification/EMC	CCC/CE/FCC Class A

Ordering information

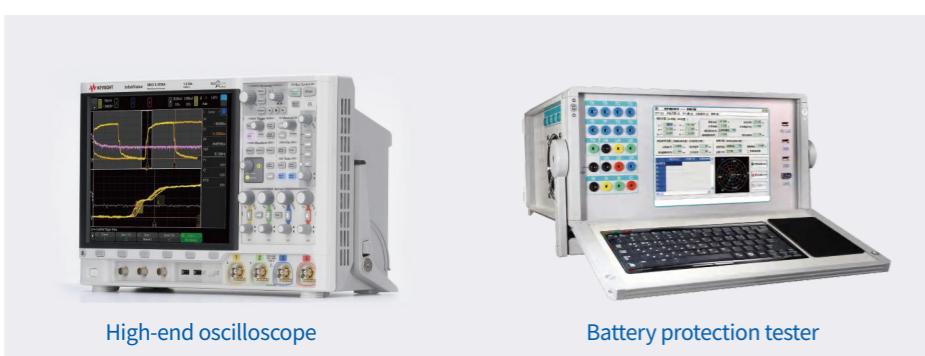
Model	Processor	Specifications
ICS-4040-S001-2200		2200W, 1+1 redundant power supply
ICS-4040-S001-2000		1600W, 1+1 redundant power supply
ICS-4040-S001-1600	Intel® Xeon Gen4 Scalable series processors	1200W, 1+1 redundant power supply
ICS-4040-S001-1200	Intel® C741 PCH	4x8038 temperature control fan+2x8038 fan module(rear)
ICS-4040-S001-800		800W, 1+1 redundant power supply
ICS-4040-S001-550		800W, 1+1 redundant power supply
		550W, 1+1 redundant power supply



APPLICATION



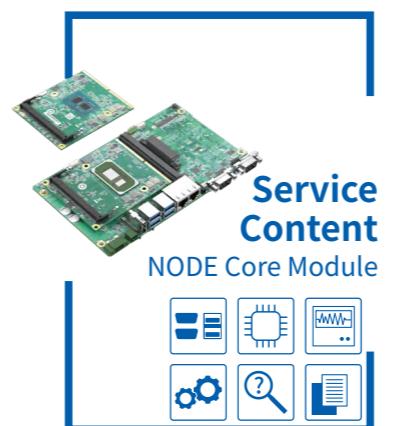
○ Industrial portable analyzer



Medical electronics

Product Listing F1-F6

NODE-I912	F01	ECM-I913	F15	PADR-M102-718	F31
		PITX-I915	F17		
NODE-I719	F03	MATX-I953	F19	PADR-M102-910	F33
NODE-I914	F05	MATX-I961	F21	PADR-M102-913	F35
NODE-I973	F07	MATX-I964	F23	PADR-S501-953	F37
EPI-I908	F09	ATX-I971	F25	PADR-S501-961	F39
ECM-I718	F11	ATX-I980	F27	PADR-S501-964	F41
ECM-I910	F13	PADR-M101	F29	PADR-S501-971	F43
				PADR-S501-980	F45



- ① Carrier Board Design: Comprehensive hardware and software design solutions
- ② Providing reference drawings and schematics for developing carrier boards.
- ③ BIOS customization support
- ④ Linux driver support
- ⑤ Review of Party A's schematic and layout designs
- ⑥ Hardware debugging support
- ⑦ Recommendations for product reliability, including heat dissipation and ESD protection

- ② Provide detailed electronic principle and structural heat dissipation design references
- ③ Structural, industrial and thermal design and other comprehensive design support



Standard Products

- ① Modular functionality for easy maintenance

- ② Standard applications

Customer Design:

- ① Simplified Customization Process
- ② Tailored to Individual Needs
- ③ Protect Core Technologies
- ④ Rapid Response to Market Trends

JHC Design:

- ① Reduce R&D Costs
- ② Improve Efficiency
- ③ Increased Product Value
- ④ Cost Reduction

Product Listing

NODE-I912	NODE-I719	NODE-I914	NODE-I973	EPI-I908	ECM-I718	ECM-I910	ECM-I913
Formfactor	INE Type F	NODE Type	NODE Type	NODE Type			
CPU	Intel® Tiger lake U SoC CPU: i7-1165G7, 4C8T, 2.8~4.7GHz/28W; i5-1135G7, 4C8T, 2.4~4.2GHz/28W; i3-1115G4, 2C4T, 3.0~4.1GHz/28W; Celeron 6305E, 2C2T, 1.8GHz/15W;	Intel Elkhart lake Soc CPU: Celeron J6412, 4C4T, 2.0-2.6GHz/10W Celeron N6210, 2C2T, 1.2-2.6GHz/6.5W	Intel® Tiger lake U SoC CPU: i7-1165G7, 4C8T, 2.8~4.7GHz/28W; i5-1135G7, 4C8T, 2.4~4.2GHz/28W; i3-1115G4, 2C4T, 3.0~4.1GHz/28W; Celeron 6305E, 2C2T, 1.8GHz/15W;	Intel® Comet lake-S CPU: Core i9/i7/i5/i3/Celeron	System CPU Intel® Skylake/Kabylake-U processor Celeron J6412 2.0-2.6GHz/ Celeron N6210 1.2-2.6GHz	Intel® Elkhart lake SoC CPU: Celeron J6412 2.0-2.6GHz/ Celeron N6210 1.2-2.6GHz	Intel Whiskey lake U Celeron/Core i3/i5/i7
DRAM	Dual-channel DDR4 2*260-pin SO-DIMM, up to 3200MHz, 64GB max.	Single channel DDR4 1*260-pin SO-DIMM, up to 3200MHz, 32GB max.	Single channel DDR4 1*260-pin SO-DIMM, up to 3200MHz, 32GB max.	Dual-channel DDR4 2*260-pin SO-DIMM, up to 2933MHz, 64GB max.	 RAM 1*DDR4,2133MHz,SODIMM, 16GB max.	1*DDR4 SODIMM,3200MHz, 32GB max.	2*DDR4 SODIMM,2400MHz, 32GB max.
Graphics	Intel UHD Graphics or Iris® Xe Graphics, Supports Intel® Deep Learning Boost, DirectX12.1,OpenGL 4.6 and OpenCL 2.0; HDMI 2.0: 4096x2304@60Hz, DP 1.4: 7680x4320@60Hz, eDP: 4096x2304@60Hz	Intel® UHD Graphics, DirectX12.1, OpenGL and OpenCL; DP1.4: 4096*2160@60Hz, eDP: 4096*2160@60Hz	Intel Iris® Xe Graphics, DirectX12.1, OpenGL 4.6 and OpenCL 3.0; HDMI 2.0: 4096x2304@60Hz, DP 1.4: 7680x4320@60Hz, eDP: 4096x2304@60Hz	Intel® UHD Graphics 630, DirectX 12, OpenGL 4.5 and OpenCL 2.1; HDMI:4096*2160@30Hz, DP:4096*2304@60Hz, eDP:4096*2304@60Hz	 Graphics Intel® Gen. 9 HD Graphics; HDMI & 48-Bit LVDS Dual display, support Intel HD video & wireless display technology; HDMI: 3840*2160@30Hz, DP: 4096*2160@60Hz, LVDS: 1920*1200@60Hz	Intel® Gen. 9 UHD Graphics,Support 3*4K independent display,DirectX 12,HEVC/H265 HW; HDMI :4096*2304@60Hz, DP:4096*2160@60Hz, LVDS :1920*1200@60Hz	Intel UHD Graphics or Xe Graphics ,Supports Intel DL boost,DirectX12.1,OpenGL 4.6 and OpenCL 3.0,HDMI:4096*2304@60Hz, DP:7680*4320@60Hz, LVDS:1920*1200@60Hz,3 independent display
Connector 1	X1*4/X4*1 PCIe Gen3 or USB3.2 X2*1	MXM 3.1 Goldfinger(281-Pin)	MXM 3.1 Goldfinger(281-Pin)	MXM 3.1 Goldfinger(281-Pin)	 I/O LAN 2*Intel® I210AT/I211AT, 10-1000 M	2*Realtek 8111H, 10-1000M,WOL	1*Intel® I226V, 10-1000M, 1*Intel® I219LM,10-1000M
	COM 1	DDI 2	eDP 1	DDI 2	 USB 4* USB3.0, 1*USB2.0(pin)	4*USB3.1(10G), 2*USB2.0(pin)	4*USB3.0, 2*USB2.0(pin)
	USB2.0 3	eDP 1	USB3.2 4	eDP 1	 Display 1*HDMI+1*LVDS(pin)	1*HDMI+1*DP+1*LVDS(pin)	1*HDMI(1.4)+1*DP(1.2)+1*eDP(pin)
	SATA 1	USB3.1 4	USB2.0 10	USB3.2 6	 Audio 1*Line out+1*Mic, Realtek ALC662,1*Amplifier	1*Line in+1*Line out+1*Mic, Realtek ALC897	1*Line in+1*Line out+1*Mic, Realtek ALC897
	DDI 1	USB2.0 10	PCIe3.0 X1*4	USB2.0 10	 Serial port &Others 2*RS232/422/485,2*RS232(pin); 2 channel power amplifier output; 1*SM Bus wafer; 1*Capacitive touch screen interface, 1*Resistive touch screen interface	1* RS232/422/485(pin),3*RS232(pin)	2* RS232/422/485(pin),2*RS232(pin)
	GPIO Up to 15 channels	PCIe3.0 X1*4	PCIe3.0 X2*1	PCIe3.0 X1*5	 DIO 8-bit DIO,programmable TTL	8-bit DIO,programmable TTL	8-bit DIO,programmable TTL
	F-Panel: Power SW/Reset/PW-LED/HDD-LED	PCIe3.0 X2*1	PCIe3.0 X4*1	PCIe3.0 X2*1	 Storage 2*SATA3 6.0Gbps;	1*SATA 3.0 HDD/SSD;	1*SATA 3.0 HDD/SSD,1*mSATA(optional)
	PCIe3.0 X1*1	SATA(PCleX1) 2	SATA(PCleX1) 4	SATA(PCleX1) 4	 storage 1*mSATA,support AHCI	1*mSATA	1*SATA 3.0 HDD/SSD; 1*mSATA(Optional)
Connector 2	PCIe3.0 or USB3.1 X2*1	eSPI 1	LPC(eSPI) 1	LPC(eSPI) 1	 Expansion 1*MiniPCIe(PCleX1/USB+SIM), 4G/LTE/GSM/Wifi/BT/GPS;	1*M.2 2230 E-key,WiFi5/BT5.0, or 1*M.2 3052 B-key(+SIM),4G LTE/5G NR;	1*Mini PCIe(PCleX1),PCIe module/mSATA; 1*M.2 2230 E-key,WiFi/BT5.0, or 1*M.2 3052 B-key(+SIM),4G LTE/5G NR;
	CPU PCIe Gen4 X1*2	HDA 1	HDA 1	HDA 1	 Expansion 1*80pin EIO:LPC, SM Bus,2*PCleX1	1*M.2 2230 E-key,WiFi5/BT5.0, or 1*M.2 3052 B-key(+SIM),4G LTE/5G NR;	1*Mini PCIe(PCleX1),PCIe module/mSATA; 1*M.2 2230 E-key,WiFi/BT5.0, or 1*M.2 3052 B-key(+SIM),4G LTE/5G NR;
	HDA 1	SM BUS 1	SM BUS 1	SM BUS 1	 Power Supply	DC 12V;	DC 12V;
	USB2.0 5	Legacy IO 1	Legacy IO 1	Legacy IO 1		or OFX-075 75W: DC IN 9-36V;	or OFX-075 75W: DC IN 9-36V;
	SATA 1	RTC 1	RTC 1	RTC 1		15.6W (J6412/32G DDR4/128 SSD)	19.92W (I5-8265U,8GB DDR, 500G SSD)
	DDI 1	UART 4	UART 4	UART 3			45.36W (i7-1165 G7/4G DDR4/128G SSD)
	COM 2	GPIO 3	GPIO 3	GPIO 3			
	GPIO Up to 30 channels	F-Panel: Power SW/Reset/PW-LED/HDD-LED	F-Panel: Power SW/Reset/PW-LED/HDD-LED	F-Panel: Power SW/Reset/PW-LED/HDD-LED	 Environment	146*102mm(Height: radiator with fan 37mm, fanless radiator 52mm, PCB:1.6mm)	146*102mm(Height: radiator with fan 37mm, fanless radiator 52mm, PCB:1.6mm)
Power& TDP	DC IN 12V; TDP-up:28W(Celeron 6305E~15W)	DC IN 12V;	DC IN 12V;	DC IN 12V;	 Dimension (W*H) 190*115mm	146*102mm(Height: radiator with fan 37mm, fanless radiator 52mm, PCB:1.6mm)	146*102mm(Height: radiator with fan 37mm, fanless radiator 52mm; PCB:1.6mm)
Operating temp.	0~60°C(Standard); -40~85°C(Extend)	0~60°C	0~60°C	0~60°C	 Operating temp. 0~60°C	0~60°C	0~60°C
Storage temp.	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	 Storage temp. -40°C~85°C	-40°C~85°C	-40°C~85°C
Storage Humidity	10~95%@40°C, Non-condensing	10~95%@40°C, Non-condensing	10~95%@40°C, Non-condensing	10~95%@40°C, Non-condensing	 Storage humidity 10~95%@40°C, No condensation	10~95%@40°C, No condensation	10~95%@40°C, No condensation
EMC/Certification	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	 Certification CE/FCC Class A	CE/FCC Class A	CE/FCC Class A
Watchdog Timer	Watchdog timeout programmable via software 1 to 255 second	Watchdog timeout programmable via software 1 to 255 second	Watchdog timeout programmable via software 1 to 255 second	Watchdog timeout programmable via software 1 to 255 second	 Watchdog timer programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second
OS Support	Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux	Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux	Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux	Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux	 OS Windows 7, Windows 10, Linux Fedora Ubuntu (Note: The seventh generation Intel® Kabylake-U processor does not support Windows 7)	Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux	Windows 10 IoT enterprise, Andriod, Ubuntu, Suse, Red Hat enterprise, Wind River Vxworks 7, Wind River,Red Hat Enterprise,Wind River Yocto
							Windows 11 IoT enterprise, Windows 10 IoT enterprise,Android,SUSE,Ubuntu, Wind River,Red Hat Enterprise,Wind River VxWorks 7,Yocto

      						
PITX-I915	MATX-I953	MATX-I961	MATX-I964	ATX-I971	ATX-I980	PADR-M101
System						
CPU	Intel® Tiger lake U Soc CPU (Core i3-1115G4/i5-1135G7/i7-1165G7, Celeron 6305E)	Intel® 6th/7th Gen Core i7/i5/i3/Pentium/Celeron LGA1151 CPU, 91W	Intel® Xeon® E or 9th/8th-Gen Pentium/Celeron/Core i7/i5/i3 LGA1151 CPU	Intel 8/9th Gen. Core i9/i7/i5/i3/Pentium/Celeron CPU,LGA 1151 Socket,max.95W	Intel 10th Gen Cometlake-S Core i9/i7/i5/i3/Pentium/Celeron CPU, LGA 1200 Socket,125W	Intel® Whiskey lake-U CPU, Core i7-8565U,Core i5-8265U,Core i3-8145U,Celeron 4305U
RAM	LPDDR4x Onboard memory, 16GB max.	2*DDR4 UDIMM,2133MHz, 32GB max.	4*DDR4 2666/2400MHz, 128GB max.	2* DDR4 288-Pin Non-ECC UDIMM, 2666MHz, 64GB max.	2* DDR4 288-Pin Non-ECC UDIMM, 2933MHz, 64GB max.	2*DDR4, 2400MHz, 32GB max.
Graphics	Intel UHD Graphics or iRIS® Xe Graphics , Supports Intel Deep Learning boost, DirectX12.1,OpenGL 4.6 and OpenCL 3.0, HDMI: 4096*2304@60Hz, eDP: 4096*2304@60Hz, 2 independent displays	Intel 9th HD Graphics, Direct3D 11.2,OpenGL 5.0, OpenCL 2.1; HDMI:3840*2160@30Hz VGA:1920*1200@60Hz DVI-D:1920 x 1200 @ 60Hz	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0,OpenCL 2.1 DP:4096*2304@60Hz, VGA:3840*2160@30Hz, HDMI:3840*2160@30Hz, 3 independent displays	Intel 9th HD Graphic, Supports Direct3D 11.2,OpenGL 5.0, OpenCL 2.1; HDMI:4096*2304@24Hz, VGA:1920*1200@60Hz, DVI-D:1920*1200@60Hz, 2 independent Display	Intel UHD Graphics, Supports DirectX12, OpenGL 4.5, OpenCL 2.1; HDMI:4096*2160@30Hz, VGA:1920*1200@60Hz DP:7680*4320@60Hz	Intel® Gen. 9 UHD Graphics, HDMI:4096*2304@24Hz, DP:4096*2304@60Hz,2 independent Display
I/O						
LAN	1*Intel® I210AT, 10-1000M; 1*Intel® I219LM, 10-1000M	1* Intel I210AT/I211AT,10-1000M Intel® I219LM,10-1000M,iVpro	2*Intel I210AT/I211AT,10-1000M; 1*Intel I219LM,10-1000M,WOL	1*Intel® I226V, 10M-2.5G,WOL	1*Intel® I226V, 10-1000M,WOL; 1*Intel® I219LM, 10-1000M,iVpro	4*USB3.1 Gen1(5Gbps) 1*DP+1*HDMI
USB	2*USB3.2, 2*USB2.0 (built-in)	4*USB3.0, 2*USB2.0, 4*USB3.0(optional) 2*USB2.0 pin,1*USB2.0(built-in)	4*USB3.1, 4*USB2.0, 2*USB3.1(pin),1*USB2.0(Built-in)	4*USB3.2(5Gbps), 2*USB2.0, 4*USB2.0(pin)	4*USB3.2(5G), 4*USB2.0, 3*USB2.0(pin)	1*Line out+1*Mic,Realtek ALC897 2*RS232/422/485, 1*RS232
Display	1*HDMI+1*eDP	1*HDMI +1*VGA+ 1*DVI-D	2*DP+1*HDMI	1*HDMI+1*VGA+1*DVD-D	1*HDMI+1*VGA	1*HDMI+1*DP+1*VGA
Audio	1*Line in+1*Line out+1*Mic, Realtek ALC897,1*Amplifier(optional)	1*Line in+1*Line out+1*Mic, Realtek ALC897	1*Line in+1*Line out+1*Mic, Realtek ALC897,1*Amplifier(Optional)	1*Line in+1*Line out+1*Mic, Realtek ALC897,1*Amplifier(Optional)	1*Line out+1*Mic,Realtek ALC897,1*Amplifier(Optional)	8bit DIO(OptionalRS232)programmable
Serial port &Others	1* RS232/422/485, 1*RS232	S001: 2*RS232/422/485, 4*RS232; S002: 2*RS232,10*RS232; 1*LPT, 1*LPC	4*RS232(pin); 1*PS/2(pin), 1*SM bus	1*RS232/422/485(DB9) 1*RS232/422/485(pin),4*RS232(pin); 1*PS/2(pin),1*SM bus,1*LPC	2* RS232/422/485, 4*RS232(pin); 1*LPT, 1*PS/2(pin)	1* RS232/422/485, 5* RS232(pin); 1*2.5" SATA,15mm
DIO	/	8-bit DIO,programmable TTL	8-bit DIO,Programmable TTL	8-bit DIO,programmable TTL	8-bit DIO,programmable TTL	
Storage						
storage	1*SATA 3.0, 6.0Gbps; 1*mSATA (Opt.)	4*SATA 3.0 HDD/SSD(1*SATA with power, support SATA DOM)	4*SATA3, HDD/SSD support RAID 0/1/5/10 1*M.2 2280 M-key(PCIe X4), NVMe	4*SATA3, HDD/SSD(1*5V SATA DOM); 1*M.2 2280/2242 M-key(PCIe X2), NVMe	4*SATA3, HDD/SSD	4*SATA3.0, RAID 0/1/10/5 1*M.2 2280 M-Key(PCIe4.0X4)
Expansion						
Expansion	1*Mini PCIe(PCIeX1),PCIe module/mSATA; 1*M.2 2230 E-key, WiFi5/BT5.0,	1*PCIeX16(X16); 2*PCIeX4(X1), 1*Mini PCIe, 1* 32-bit PCI	1*Mini PCIe(+SIM); 2*PCIeX16(1*X16/2*X8), 2*PCIeX8(Gen3, 2*X4)	1*PCIe3.0 X16(X16) , 2*PCIe2.0X4 (X1), 1*32-bit PCI; 1*M.2 2242/2280 M-Key(Gen2,PCIe X2)	1*PCIeX16; 3*PCIeX4(X2+X1+X1 / 1*PCIeX4); 3* 32-bit PCI	2*PCIe 5.0 X16 (X8)+ 2*PCIe 4.0 X4 (X4)+ 2*PCIe 3.0 X4(X4+X1)+ 1*32-bit PCI 1*M.2 2280 M-Key(PCIe4.0X4)
Power Supply						
Power& TDP	DC 12V; TDP:39.208W (i7-1165G7@2.8G)	24-Pin ATX+4-Pin ATX 12V 125W (i7-7700K/16G DDR4/128G SSD)	24-pin ATX/8-pin ATX 12V; 374W (i7-8700, 16GB DDR, 2*4TB, GTX-1660)	24-pin ATX+4-pin ATX 12V; 224W (i9-9900K /16G DDR4/128G SSD)	24-Pin ATX/8-Pin ATX 12V, Max. out put power: 280W	24-Pin ATX+8-Pin ATX 12V 110W(i7-12700K CPU/16G D4/128G SSD)
Environment						
Dimension (W*H)	100*72mm	244*244mm (Height:34.9mm,PCB: 1.6mm)	244*244mm (Height:30.8mm, PCB: 1.6mm)	244*244mm (Height:33.2mm, PCB: 1.6mm)	305*244mm (Height: 37.58mm, PCB: 1.6mm)	305*244mm (Height: 34.9mm, PCB: 1.6mm)
Operating temp.	0~60°C	0~60°C	0~60°C	0~60°C	0~60°C	0~60°C
Storage temp.	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C	-40°C~85°C
Storage humidity	10~95%@40°C, Non condensation	10~95%@40°C, Non condensation	10~95%@40°C, Non condensation	10~95%@40°C, Non condensation	10~95%@40°C, Non condensation	10~95%@40°C, Non condensation
Certification /EMC	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A	CE/FCC Class A
Watchdog timer	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	programmable via software 1 to 255 second	40°C~85°C 10~95%@40°C, Non-condensation
OS	Windows 11*IoT enterprise, Windows 10*IoT enterprise,Android,SUSE,Ubuntu, Wind River, Red Hat*Enterprise, Wind River VxWorks*7, Yocto	Windows 7(SKL-S:32bit/64bit, KBL-S:64bit), Windows 10,Linux	Windows 10 Enterprise & IOT Enterprise Windows Server 2016 (Intel® Xeon® E) Ubuntu,SuSe,Redhat Enterprise 1.2 Wind River VxWorks 7	Windows7,Windows 10 Enterprise & IOT Enterprise (64 bit)(CFL-R); Windows* Server 2016 (Intel® Xeon® E) Ubuntu*, SuSe*, Redhat Enterprise* 1.2, (Kernel 4.14) (CFL-R) Wind River*,VxWorks* 7 (CFL-R)	Windows 10,Windows 11,Linux Ubuntu	Windows 10/11 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux,Yocto Project (64-bit),Wind River VxWorks 7
						CE/FCC Class A
						Windows 10, SUSE, Ubuntu, Wind River, Red Hat Enterprise
						programmable via software 1 to 255 second

Optional function module



ECB-260 CANBus



OFX-075



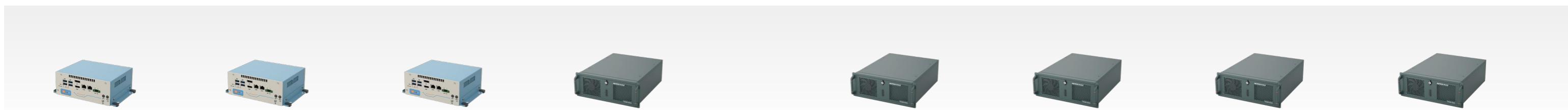
Input DC IN 9-36V

Output DC OUT 12V

TDP 54W~78W(max.)

Operating Temp 0°C~60°C

Dimension 53*38mm

**PADR-M102-718****PADR-M102-910****PADR-M102-913****PADR-S501-953****PADR-S501-961****PADR-S501-964****PADR-S501-971****PADR-S501-980****System**

CPU	Intel® Elkhart lake SoC CPU: Celeron J6412 Celeron N6210	Intel® Whiskey lake-U CPU, Core i7-8565U,Core i5-8265U,Core i3-8145U,Celeron 4305U	Intel® Tiger lake U Soc CPU , core i3-1115G4/i5-1135G7/i7-1165G7, Celeron 6305,TDP 12W/15W/28W	Intel 6/7th Gen. SKL/KBL-S Core i7/i5/i3/Pentium/Celeron LGA1151 CPU, up to 91W, H110 Chipset	Intel® 8/9th Gen. Coffee-S Core i9/i7/i5/i3 LGA1151 CPU,up to 95W,Q370 Chipset	Intel® 8/9th Gen. Coffee-S Core i9/i7/i5/i3 LGA1151 CPU,up to 95W,H310 Chipset	Intel 10th Gen. Cometlake-S Core i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU,up to 125W, H420E Chipset	Intel gen 12/13th Alderlake-S/Raptor Lake-S LGA1700 CPU; Q670 PCH
RAM	1*DDR4, 3200MHz, 32GB max.	2*DDR4, 2400MHz, 32GB max.	2*DDR4, 3200MHz, 64GB max.	2*288 pin DDR4, 2400MHz, 32GB max.	4*288 pin DDR4, 2666MHz, 128GB max.	2*288 pin DDR4, 2666MHz, 64GB max.	2*288 pin DDR4, 2933MHz, 64GB max.	2*288 pin DDR4, 2933MHz, 64GB max.

Graphics

Graphics	Intel® Gen. 10 UHD Graphics, HDMI:4096*2304@60Hz, DP:4096*2160@60Hz,2 independent Display	Intel® Gen. 9 UHD Graphics, HDMI:4096*2304@24Hz, DP:4096*2304@60Hz,2 independent Display	Intel UHD Graphics/ Xe Graphics , Supports Intel DL boost,DirectX12.1, OpenGL 4.6 and OpenCL 3.0, HDMI:4096*2304@24Hz, VGA:1920*1200@60Hz, DVI-D:1920*1200@60Hz DP:7680*4320@60Hz,2 independent Display	Intel HD Graphics, DirectX12,OpenGL 4.5; HDMI:4096*2304@24Hz, VGA:1920*1200@60Hz, DVI-D:1920*1200@60Hz DP:7680*4320@60Hz,2 independent Display	Intel® UHD Graphics,DirectX12,OpenGL 4.5; HDMI:4096*2304@24Hz, DP:4096*2304@60Hz,3 independent display	Intel® UHD Graphics,DirectX12,OpenGL 4.5; HDMI:4096*2160@30Hz, VGA:1920*1200@60Hz, DVI-D:1920*1200@60Hz	Intel® UHD Graphics,DirectX12,OpenGL 4.5; HDMI:4096*2160@30Hz, VGA:1920*1200@60Hz	Intel® UHD Graphics,DirectX12,OpenGL 4.5; HDMI:4096*2160@30Hz, VGA:1920*1200@60Hz
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I/O

LAN	2*Realtek 8111H,10-1000M,WOL	1*Intel I219LM,10-1000M,WOL;	1*Intel I219LM,10-1000M,WOL,iAMT13.0;	1*Intel I210AT/I211AT, 10-1000M,WOL;	2*Intel I210AT/I211AT, 10-1000M,WOL;	1*Intel I226V,10M-2.5G, WOL;	1*Intel I226V, 10M-2.5G, WOL;	1*Intel I226V,10M-2.5G, WOL;
USB	4*USB3.1	4*USB3.0(5G)	4*USB3.2	4*USB3.0(5Gbps), 5*USB2.0	4*USB3.1 Gen2(10Gbps), 7*USB2.0	4*USB3.1 Gen1(5Gbps), 5*USB2.0	4*USB3.2 Gen1(5Gbps), 5*USB2.0	4*USB3.2 Gen1(5Gbps), 5*USB2.0
Display	1*DP+1*HDMI	1*DP+1*HDMI	1*DP+1*HDMI	1*HDMI+1*VGA+1*DVI-D	2*DP+1*HDMI	1*HDMI+1*VGA+1*DVI-D	1*HDMI+1*VGA	1*HDMI+1*VGA
Audio	1*Line out+1*Mic,Realtek ALC897	1*Line out+1*Mic,Realtek ALC897	1*Line out+1*Mic,Realtek ALC662VD/ALC897	1*Line out+1*Mic,Realtek ALC662VD	1*Line out+1*Mic,Realtek ALC897	1*Line out+1*Mic,Realtek ALC897	1*Line out+1*Mic,Realtek ALC897	1*Line out+1*Mic,Realtek ALC897
Serial port &Others	2*RS232/422/485,1*RS232	2*RS232/422/485,1*RS232	2*RS232/422/485,1*RS232	2*RS232/422/485,1*RS232	2*RS232/422/485	2*RS232/422/485,1*RS232	2*RS232/422/485,2*RS232	2*RS232/422/485,2*RS232
DIO	8bit DIO(OptionalRS232)programmable	8bit DIO(OptionalRS232)programmable	8bit DIO(pin),programmable	8bit DIO(pin),programmable	8bit DIO(pin),programmable	8bit DIO(pin),programmable	8bit DIO(pin),programmable	8bit DIO(pin),programmable

Storage

storage	1*2.5" SATA,15mm; 1*mSATA	1*2.5" SATA,15mm; 1*mSATA(Optional)	1*2.5" SATA,15mm; 1*mSATA(Optional)	4xSATA3, 6.0Gbps , the box is designed with 4x3.5 " and 2x2.5 " a set of anti-vibration hard disk bay, 1 ultrathin DVD driver bay	4xSATA3, 6.0Gbps , the box is designed with 4x3.5 " and 2x2.5 " a set of anti-vibration hard disk bay, 1 ultrathin DVD driver bay	4xSATA3, 6.0Gbps , the box is designed with 4x3.5 " and 2x2.5 " a set of anti-vibration hard disk bay, 1 ultrathin DVD driver bay	4xSATA3, 6.0Gbps , the box is designed with 4x3.5 " and 2x2.5 " a set of anti-vibration hard disk bay, 1 ultrathin DVD driver bay	4xSATA3, 6.0Gbps , the box is designed with 4x3.5 " and 2x2.5 " a set of anti-vibration hard disk bay, 1 ultrathin DVD driver bay
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Expansion

Expansion	1*M.2 2230 B-Key,Wifi5/BT5.0, or 1*M.2 3052 E-Key,4G LTE/5G NR	1*Mini PCIe(+SIM),4G LTE/Wifi/BT/mSATA; 1*M.2 2230 E-Key,Wifi/BT	1*Mini PCIe,PCIe module/mSATA; 1*M.2 2230 E-Key,Wifi5/BT5.0, or 1*M.2 3052 B-Key(+SIM),4G LTE/5G NR	1*PCIe3.0 X16(X16)+ 2*PCIe2.0 X4(X1)+1*32 bit PCI; 1*Mini PCIe(X1)	2*PCIe3.0 X16(1*X16 or 2*X8)+ 2*PCIe3.0 X8(X4)+1*32 bit PCI; 1*M.2 2280 M-Key(PCIe3.0X4) 1*Mini PCIe(X1/USB+SIM)	1*PCIe3.0 X16(X8)+ 2*PCIe2.0 X4(X1)+1*32 bit PCI; 1*M.2 2280/2242 M-Key(PCIe2.0 X2) 3*32 bit PCI	1*PCIe3.0 X16(X16)+ 3*PCIe3.0 X4(X2+1 or Bios X4)+ 3*32 bit PCI	1*PCIe3.0 X16(X16)+ 3*PCIe3.0 X4(X2+1 or Bios X4)+ 3*32 bit PCI
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Power Supply

Power& TDP	DC 12V/DC 9-36V; TDP:TBD	DC 12V/DC 9-36V; 27.9W(I7-8565U,16GB DDR,1*4T SSD)	DC 12V/DC 9-36V; TDP:TBD	AC100-240V,Standard ATXPower 300W, Optional 500W/750W; TDP:TBD	AC100-240V,Standard ATXPower 300W, Optional 500W/750W/1000W; TDP:TBD	AC100-240V,Standard ATXPower 300W, Optional 500W/750W; 197.8W (I7-9900K/16G DDR4/256G SSD)	AC100-240V,Standard ATXPower 300W, Optional 500W/750W; 184.85W(I7-10700K/16G DDR4/256G SSD)	AC100-240V,Standard ATXPower 300W, Optional 500W/750W; 184.85W(I7-10700K/16G DDR4/256G SSD)
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Mechanical

Structure </

NODE-I912

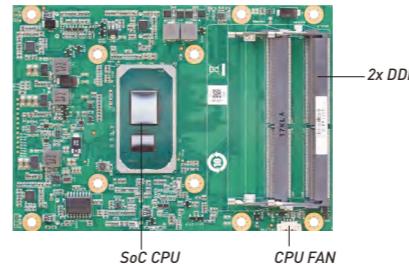
Intel® Tiger lake U Soc CPU, Intel IEN Type F, supports single-channel DDR4 3200 MHz, up to 64GB. DC IN 12V

Key Specification

- Intel® Tiger lake U Soc CPU module
- Intel® Core i7/i5/i3/Celeron
- Designed according to Intel IEN Type F specification
- Dual-channel DDR4 3200MHz, up to 64GB
- 4*PCIe×1 or 1*PCIe×4, 1*PCIe Gen3 lanes, 2*PCIe×1
- Gen4 lanes
- 3*GbE LAN, 2*SATA, 2*DDI, 4*USB3.1, 8*USB2.0, 3*COM,
- 1*HDA, eSPI, DIO
- DC IN 12V



I/O View



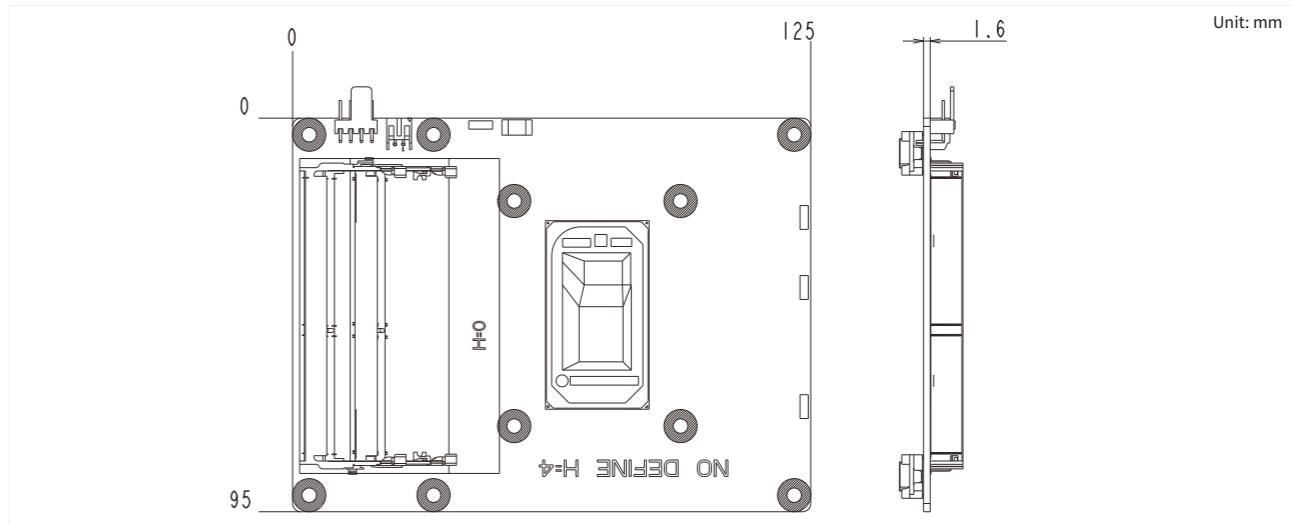
Product Overview

NODE-I912 powered by Intel® Tiger lake U Soc CPU, designed according to the INTEL industrial edge node Type F standard, supporting dual-channel DDR4 3200MHz memory, up to 64GB. NODE-I912 is a compact product with low power consumption and flexible expansion. It is suitable for medical imaging, military, rail transit and power applications.

Product Parameters

Formfactor		IN EN Type F
CPU	Intel® Tiger lake U SoC CPU:	i7-1165G7, 4C8T, 2.7~4.7GHz/28W; i5-1135G7, 4C8T, 2.4~4.2GHz/28W; i3-1115G4, 2C4T, 3.0~4.1GHz/28W; Celeron 6305E, 2C2T, 1.8GHz/15W;
DRAM	Dual-channel DDR4 2*260-pin SO-DIMM, up to 3200MHz, 64GB max.	
Graphics	Intel UHD Graphics or Iris® Xe Graphics, Supports Intel® Deep Learning Boost, DirectX12.1, OpenGL 4.6 and OpenCL 2.0; HDMI 2.0: 4096x2304@60Hz, DP 1.4: 7680x4320@60Hz, eDP: 4096x2304@60Hz	
Connector 1	eSPI and Fusa PCIe Gen3 4x1/1x4 PCIe Gen3 or USB3.2 2 COM 1 USB2.0 3 SATA 1 DDI 1 GPIO Up to 15 channels F-Panel: Power SW/Reset/PW-LED/HDD-LED	
OS Support	Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux	
Connector 2	PCIe Gen3 1 PCIe Gen3 or USB3.1 2 CPU PCIe Gen4 2 HDA 1 USB2.0 5 SATA 1 DDI 1 COM 2 GPIO Up to 30 channels	

Dimensions



Ordering Information

Module No.	CPU	Introduction
NODE-I912/S001	Intel® Core i3-1115G4	Intel® Tiger lake U Soc Core i7/i5/i3/Celeron CPU, 2*DDR4 3200MHz, Connector1(1*eSPI, Fusa, 4*PCIeX1, Legacy IO, 2*PCIe(USB3.1), Power SW/Reset/PW-LED/HDD-LED, 1*DDI, 3*USB2.0, 1*PCIe(SATA), 1*COM, GPIO),
NODE-I912/S001/GRE	Intel® Core i3-1115GRE	Connector2(1*DDI, 1*PCIe(SATA), 2*PCIe(USB3.1), 1*PCIeX1, 1*CPU PCIeX2, Legacy IO, HDA, 5*USB2.0, 2*COM, GPIO),
NODE-I912/S002	Intel® Core i5-1135G7	DC 12V power in
NODE-I912/S002/GRE	Intel® Core i5-1145GRE	
NODE-I912/S003	Intel® Core i7-1165G7	
NODE-I912/S003/GRE	Intel® Core i7-1185GRE	
NODE-I912/S004	Intel® Celeron 6305E	

NODE-I719

Intel Elkhart lake Soc CPU module, supports single-channel DDR4 3200 MHz, up to 32GB. DC IN 12V

Key Specification

- Intel Elkhart lake Soc CPU module
- Single-channel DDR4 3200MHz, up to 32GB
- 2*DDI output, 1*eDP
- 4*PCIeX1, 1*PCIeX2
- 2*SATA, 4*USB3.1, 10*USB2.0, 1*HDA, 4*UART, GPIO, 1*eSPI
- DC IN 12V



I/O View



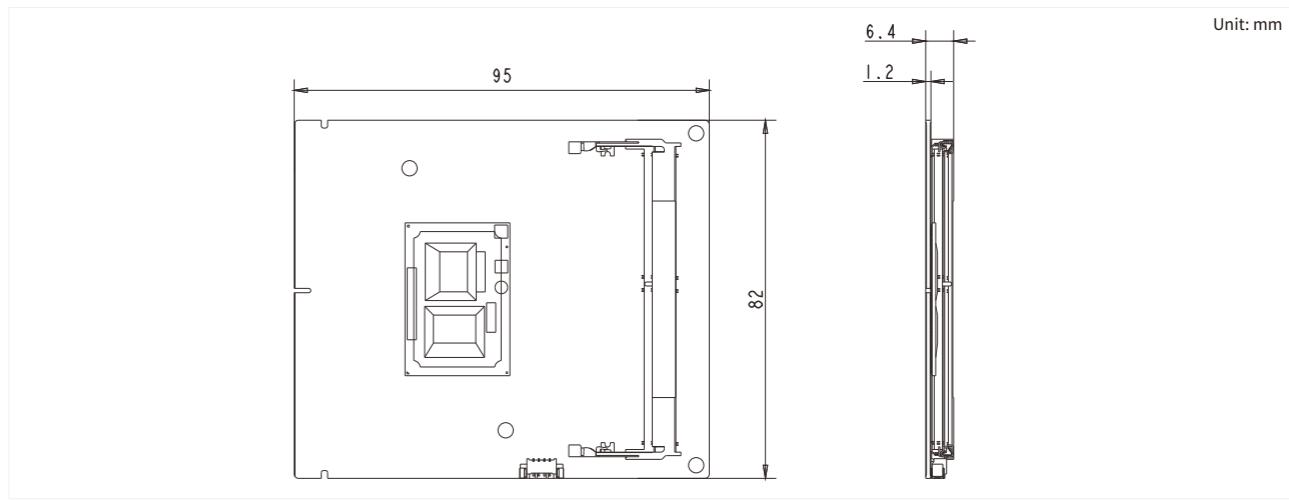
Product Overview

NODE-I719 powered by Intel Elkhart lake Soc CPU, supports single-channel DDR4 3200MHz memory, up to 32GB. The size of the motherboard module is thin and small, which is an economical product with low power consumption and flexible expansion, suitable for industrial automation, security, environmental protection, logistics and warehousing management applications.

Product Parameters

Formfactor		NODE Type	
CPU	Intel Elkhart lake Soc CPU:	Celeron J6412, 4C4T, 2.0-2.6GHz/10W	
	Celeron N6210, 2C2T, 1.2-2.6GHz/6.5W		
MXM 3.1 Goldfinger(281-Pin)			
DDI	2	Graphics	Intel® UHD Graphics, DirectX12.1, OpenGL and OpenCL; DP1.4: 4096*2160@60Hz, eDP: 4096*2160@60Hz
eDP	1	DRAM	Single channel DDR4 1*260-pin SO-DIMM, up to 3200MHz, 32GB max.
USB3.1	4	Power& TDP	DC IN 12V;
USB2.0	10	Dimension	95*82*6.4mm
PCIeX1	4	Operating temp.	0~60°C
PCIeX2	1	Storage temp.	-40°C~85°C
SATA(PCIeX1)	2	Storage Humidity	10~95%@40°C, Non-condensing
eSPI	1	EMC/Certification	CE/FCC Class A
HDA	1	Watchdog Timer	Watchdog timeout programmable via software 1 to 255 second
SM BUS	1		
Legacy IO	1		
RTC	1		
UART	4		
GPIO	3		
F-Panel: Power SW/Reset/PW-LED/HDD-LED		OS Support	Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux

Dimensions



Ordering Information

Module No.	CPU	Introduction
NODE-I719/S001	Intel® Celeron J6412	Intel Elkhart lake Soc CPU, 1*DDR4 3200MHz, MXM 3.1 Goldfinger(4*PCIeX1, 1*PCIeX2, 4*USB3.1, 10*USB2.0, 2*SATA, 1*HDA, Legacy IO, 1*eDP, 1*eSPI, 1*SPI, Power SW/Reset/PW-LED/HDD-LED, 2*DDI, 3 bit GPIO, SM BUS, RTC, 4*UART), DC 12V
NODE-I719/S002	Intel® Celeron N6210	

NODE-I914

Intel® Tiger lake U Soc CPU module, supports single-channel DDR4 3200 MHz, up to 32GB. DC IN 12V

Key Specification

- Intel® Tiger lake U Soc CPU module
- Single-channel DDR4 3200MHz, up to 32GB
- 2*DDI output, 1*eDP
- 4*PCIeX1, 1*PCIeX2, 1*PCIeX4
- 2*SATA 4*USB3.1, 10*USB2.0, 1*HDA, 4*UART, GPIO, 1*eSPI
- DC IN 12V



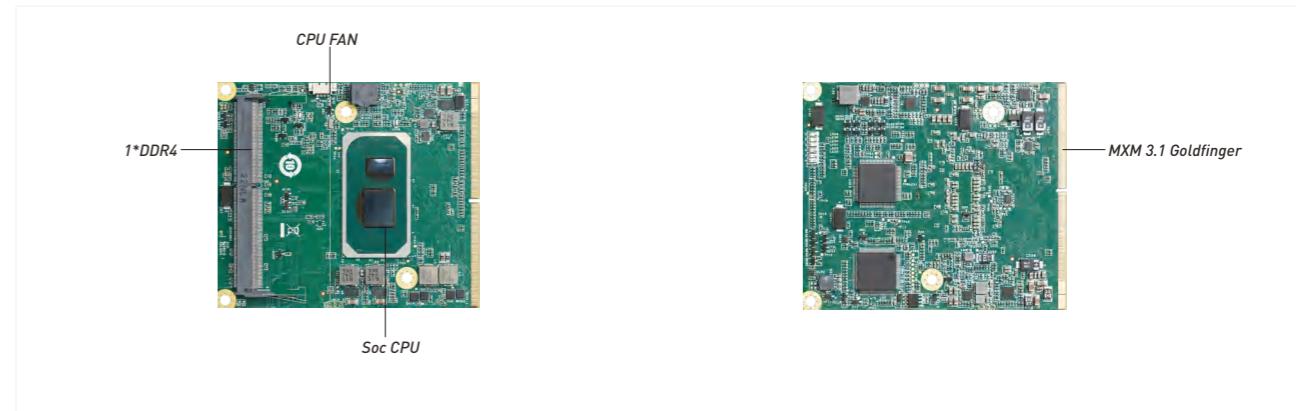
Product Overview

NODE-I914 powered by Intel® Tiger lake U Soc CPU, supporting single-channel DDR4 3200Mhz memory, up to 32GB. The size of the motherboard module is thin and small, which is an economical product with low power consumption and flexible expansion, suitable for industrial automation, security, environmental protection, logistics and warehousing management applications.

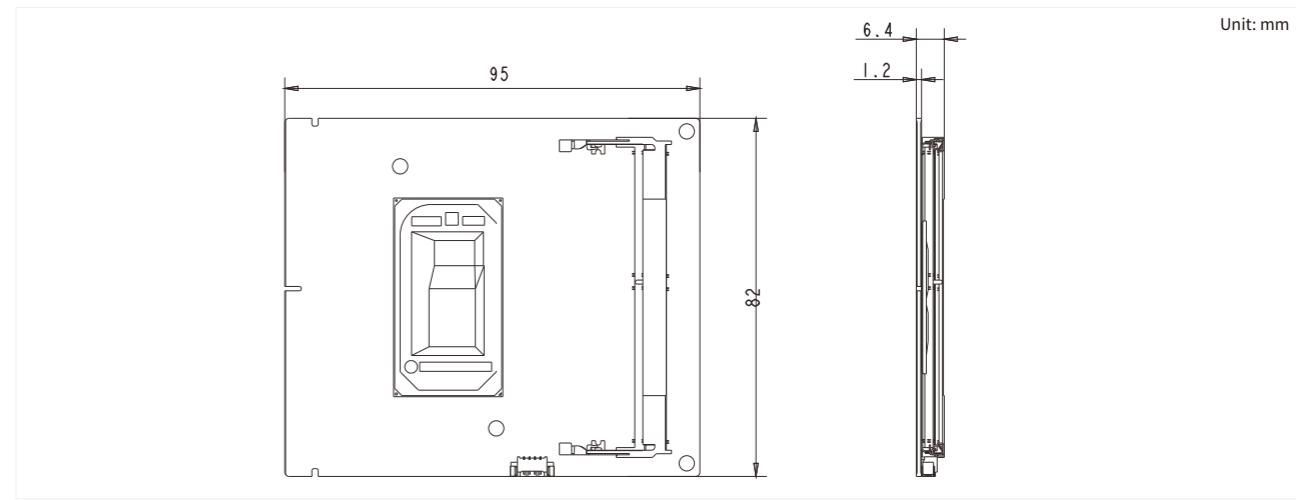
Product Parameters

Formfactor		NODE Type
CPU	Intel® Tiger lake U SoC CPU:	i7-1165G7, 4C8T, 2.7~4.7GHz/28W; i5-1135G7, 4C8T, 2.4~4.2GHz/28W; i3-1115G4, 2C4T, 3.0~4.1GHz/28W; Celeron 6305E, 2C2T, 1.8GHz/15W;
MXM 3.1 Goldfinger(281-Pin)	Graphics	Intel Iris® Xe Graphics, DirectX12.1, OpenGL 4.6 and OpenCL 3.0; HDMI 2.0: 4096x2304@60Hz, DP 1.4: 7680x4320@60Hz, eDP: 4096x2304@60Hz
DDI eDP USB3.2 USB2.0 PCIeX1 PCIeX2 SATA(PCIeX1) eSPI HDA SM BUS Legacy IO RTC UART GPIO	DRAM	Single channel DDR4 1*260-pin SO-DIMM, up to 3200MHz, 32GB max.
F-Panel: Power SW/Reset/PW-LED/HDD-LED	Power& TDP	DC IN 12V;
Dimension	95*82*6.4mm	
Operating temp.	0~60°C	
Storage temp.	-40°C~85°C	
Storage Humidity	10~90%@40°C, Non-condensing	
EMC/Certification	CE/FCC Class A	
Watchdog Timer	Watchdog timeout programmable via software 1 to 255 second	
OS Support	Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux	

I/O View



Dimensions



Ordering Information

Module No.	CPU	Introduction
NODE-I914/S001	Intel® Core i3-1115G4	Intel® Tiger lake U Soc Core i7/i5/i3/Celeron CPU, DDR4 3200MHz, 2*DDI, 1*eDP, 4*USB3.2, 10*USB2.0, 1*PCIeX2, 1*PCIeX4, RTC, 4*PCIeX1, 2*SATA, 1*eSPI, 1*HDA, 1*SPI, Legacy IO, SM BUS
NODE-I914/S002	Intel® Core i5-1135G7	Power SW/Reset/PW-LED/HDD-LED, 3 bit GPIO, 4*UART, DC 12V power in
NODE-I914/S003	Intel® Core i7-1165G7	
NODE-I914/S004	Intel® Celeron 6305E	

NODE-I973

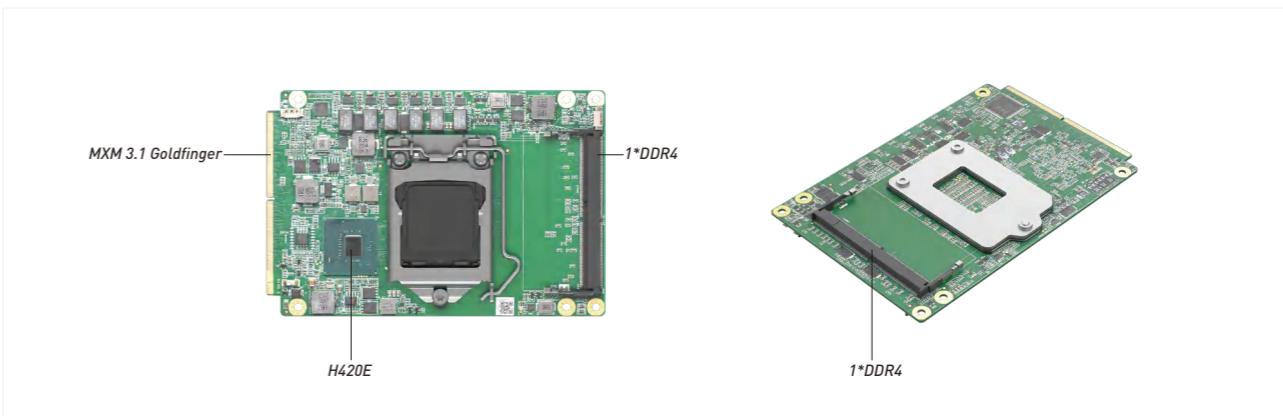
Intel® Comet lake-S CPU module, supports dual-channel DDR4 2933 MHz, up to 64GB. DC IN 12V

Key Specification

- Intel® Comet lake-S CPU module
- Dual-channel DDR4 2933MHz, up to 64GB
- Intel® H420E chipset with long life cycle
- 2*DDI output, 1*eDP
- 5*PCIeX1, 1*PCIeX2
- 2*SATA, 6*USB3.2, 10*USB2.0, 1*HDA, 3*URAT, GPIO, 1*LPC
- DC IN 12V



I/O View



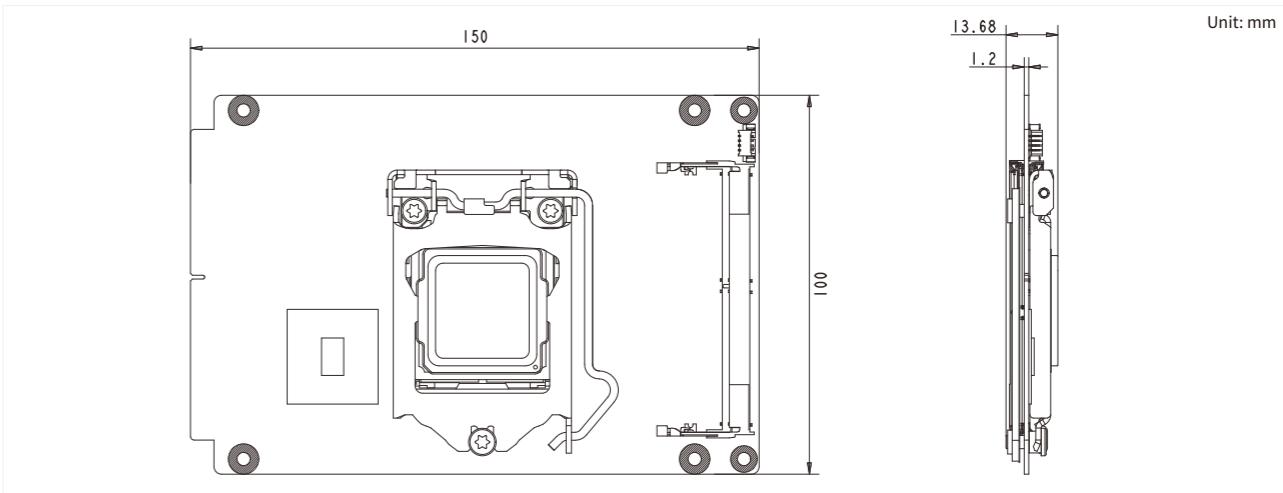
Product Overview

NODE-I973 powered by Intel® Comet lake-S CPU and Intel H420E chipset. supports dual-channel DDR4 2933MHz memory, up to 128GB. The size of the motherboard module is thin and small, which is an economical product with low power consumption and flexible expansion, suitable for industrial automation, security, environmental protection, logistics and warehousing management applications.

Product Parameters

Formfactor		NODE Type
CPU	Intel® Comet lake-S CPU: Core i9/i7/i5/i3/Celeron	
MXM 3.1 Goldfinger(281-Pin)		
Power&TDP		
DDI	2	DC IN 12V;
edP	1	
USB3.2	6	
USB2.0	10	
PCIeX1	5	
PCIeX2	1	
SATA(PCIeX1)	4	
eSPI	1	
HDA	1	
SM BUS	1	
Legacy IO	1	
RTC	1	
UART	3	
GPIO	3	
F-Panel: Power SW/Reset/PW-LED/HDD-LED		
OS Support		
Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux		
Graphics		
Intel® UHD Graphics 630, DirectX 12, OpenGL 4.5 and OpenCL 2.1; HDMI:4096*2160@30Hz, DP:4096*2304@60Hz, eDP:4096*2304@60Hz		
DRAM		
Dual-channel DDR4 2*260-pin SO-DIMM, up to 2933MHz, 64GB max.		
Power&TDP		
Dimension	150*100*13mm	
Operating temp.	0~60°C	
Storage temp.	-40°C~85°C	
Storage Humidity	10~95%@40°C, Non-condensing	
EMC/Certification	CE/FCC Class A	
Watchdog Timer	Watchdog timeout programmable via software 1 to 255 second	

Dimensions



Ordering Information

Module No.	CPU	Introduction
NODE-I973/S001	Intel® Comet lake-S	Intel Comet lake-S LGA1200 CPU+H420E PCH, 2*DDR4 2933MHz, MXM 3.1 Goldfinger(2*DDI, 1*eDP, 6*USB3.2, 10*USB2.0, 5*PCIeX1, 1*PCIeX2, RTC, 4*SATA, 1*HDA, SM BUS, Legacy IO, 1*SPI, 3*UART, 1*LPC, Power SW/Reset/PW-LED/HDD-LED, 3 bit GPIO, DC 12V

EPI-I908

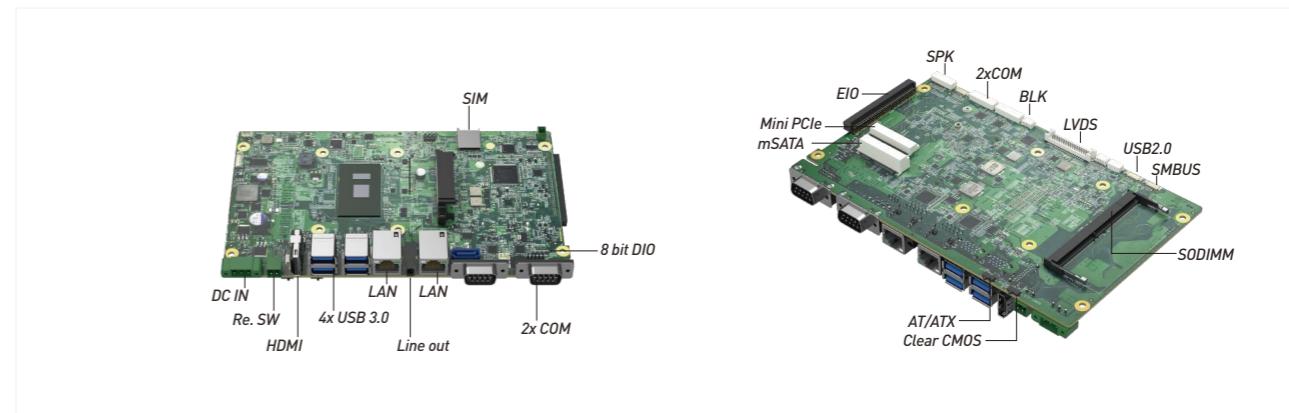
Intel® Skylake/Kabylake-U CPU, 1-CH DDR4, HDMI, LVDS, 2*LAN, 4*COM, 4*USB3.0, Audio, DC 9~36V.

Key Specification

- Intel® Skylake/Kabylake-U processor
- 1-Ch DDR4 SODIMM, 16GB max.
- 1*HDMI, 1*LVDS, Audio, power amplifier
- 2*LAN, 4*USB3.0, 2*USB2.0
- 4*COM, 1*JHC high-speed bus specification expansion interface EIO
- 1*Mini PCIe, 1*SIM card slot, support GPS/WiFi/LTE/GSM
- 2*SATA3.0 6Gbps, 1*mSATA for storage
- Optional support TPM 2.0 security encryption, iVpro technology
- DC 9~36V wide voltage power supply



I/O View



Product Overview

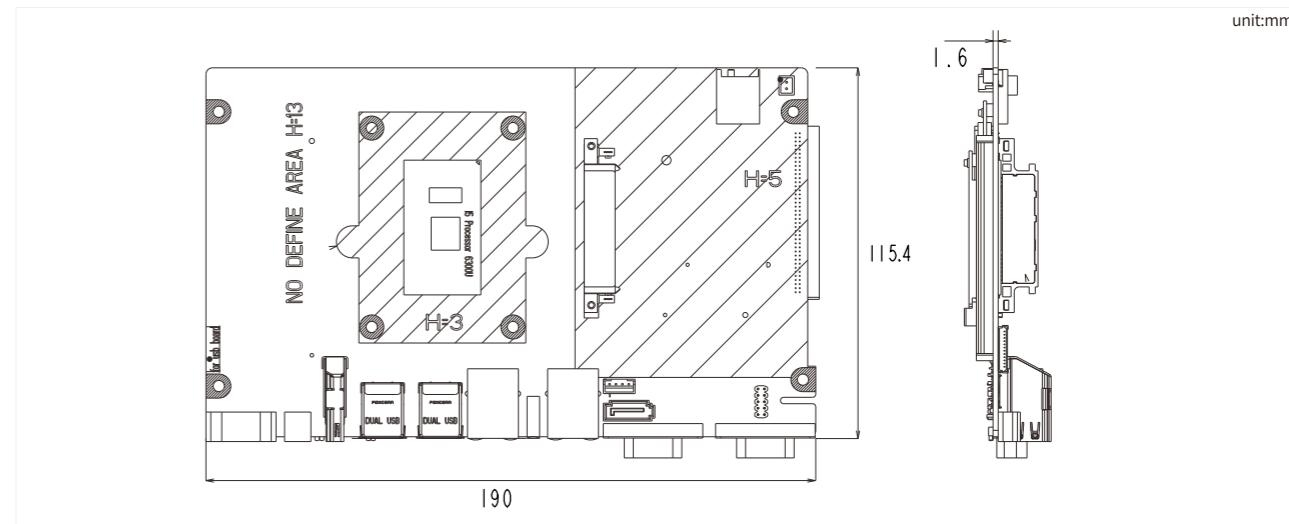
EPI-I908 is OSBC series embedded single board computer, equipped with Intel® Skylake/Kabylake-U processor, supports GPS/WiFi/LTE/GSM wireless function, DC 9~36V wide voltage power supply, compact size, complete functions, suitable for various compact embedded system application requirements.

Product Parameters

System	
CPU	Intel® Skylake/Kabylake-U processor Celeron/Core i3/i5/i7
RAM	1*DDR4,2133MHz,SODIMM, 16GB max.
Graphics	
Graphics	Intel® Gen. 9 HD Graphics; HDMI & 48-Bit LVDS Dual display, support Intel HD video technology, wireless display technology HDMI:3840*2160@30Hz LVDS:1920*1200@60Hz
I/O	
LAN	2*Intel® I210AT PCIe Gig. Ethernet,Gigabit
USB	4* USB3.0, 1*USB2.0
Display	1*HDMI+1*LVDS(48-bit pin)
Audio	1*Line out+1*Mic, Optional audio,1*Amplifier 2*RS232/422/485, 2*RS232(pin);
Serial port &Others	2 channel power amplifier output; 1*SM Bus wafer; 1*Capacitive touch screen interface; 1*Resistive touch screen interface
DIO	8-bit DIO,Programmable TTL
Others	
Control switch	1*2pin Remote switch;1*AT/ATX; 1*Clear CMOS
Indicator	Pin of motherboard (Power LED, HDD LED)
Watchdog timer	Watchdog timeout programmable via software 1 to 255 second
TPM	Optional support TPM2.0

Storage	
storage	2*SATA3 port,rate: 6.0Gbps; 1*mSATA,support AHCI
Expansion	
Expansion Port	1*MiniPCIe(PCleX1/USB+SIM),4G/L TE/GSM/Wifi/BT/GPS; 1*80pin EIO with LPC, SM Bus, 2*PCleX1
Power Supply	
Input voltage	DC 9~36V input, 3-pin terminal;
Power consumption	45W (I7-7500U, 4GB, 64GB SSD, 1TB HDD)
Environment	
Dimension(W*H)	190*115.4mm(Overall height 27.4mm, PCB thickness 1.6mm)
Operating temp	0~60°C
Storage temp	-40°C~85°C
Storage humidity	10~90%@40°C, No condensation
Certification/EMC	CE/FCC Class A
OS	
OS	Windows 7, Windows 10, Linux Fedora Ubuntu (The 7th generation Intel® Kabylake-U processor does not support Windows 7)

Dimensions



Ordering Information

Model	Processor	Specifications
EPI-I908/S001	Intel® I3-6100U/I3-7100U	1*SODIMM DDR4, 2*LAN, 4*USB3.0, 2*USB2.0, 4*COM, 1*Mini PCIe, 1*EIO, 1*8bit DIO(2*5 pin)
EPI-I908/S002	Intel® I5-6200U/I5-7200U	1*HDMI, 1*LVDS, optional 1*Line out+1*Mic, 1*Amplifier, 1*mSATA, 2*SATA3, DC 9~36V
EPI-I908/S003	Intel® I7-6500U/I7-7500U	
EPI-I908/S004	Intel® 3855U/3865U	
ECI-105	1 slot PCI backplane, providing 1 PCI expansion slot	
ECX-106	1 slot PCIe backplane, providing 1 PCIe1 expansion slot	

Optional Accessories

Model	Specifications
ECI-105	1 slot PCI, providing 1 PCI expansion slot
ECX-106	1 slot PCIe, providing 1 PCIe1 expansion slot

ECM-I718

Intel® Elkhart lake Soc CPU,single channel DDR4,1*HDMI,1*DP,2*LAN,4*USB3.1,4*COM,1*8bit DIO, 1*M.2 B-key/E-key,1*mSATA, 1*SATA3.0, DC 12V

Key Specification

- Intel® Elkhart lake Soc CPU
- Single channel DDR4 SODIMM, support 3200MHz, up to 32GB
- 1*HDMI, 1*DP, 1*48-bit LVDS, 3 independent displays
- 2*LAN, 4*USB3.1, 2*USB2.0, 4*COM, 1*8-bit DIO
- 1*M.2 2230 E-key supports WiFi/BT or 1*M.2 3052 B-key with SIM card slot, supports 4G LTE/5G NR
- 1*SATA3.0 HDD/SSD,1*mSATA(with USB2.0) for storage
- Active or passive, two different thickness radiator selection
- DC IN12V,9-36V wide power input for optional (OFX-075)



Product Overview

ECM-I718 is a 3.5-inch embedded mainboard equipped with Intel® Elkhart lake Soc CPU. It has complete IO functions, flexible selection of power supply, active and passive radiators, and the compact size is suitable for installation in limited space scenarios. It is very suitable for AGV and AMR, medical inspection, machine vision, industrial control, digital city and smart security and other industries and fields.

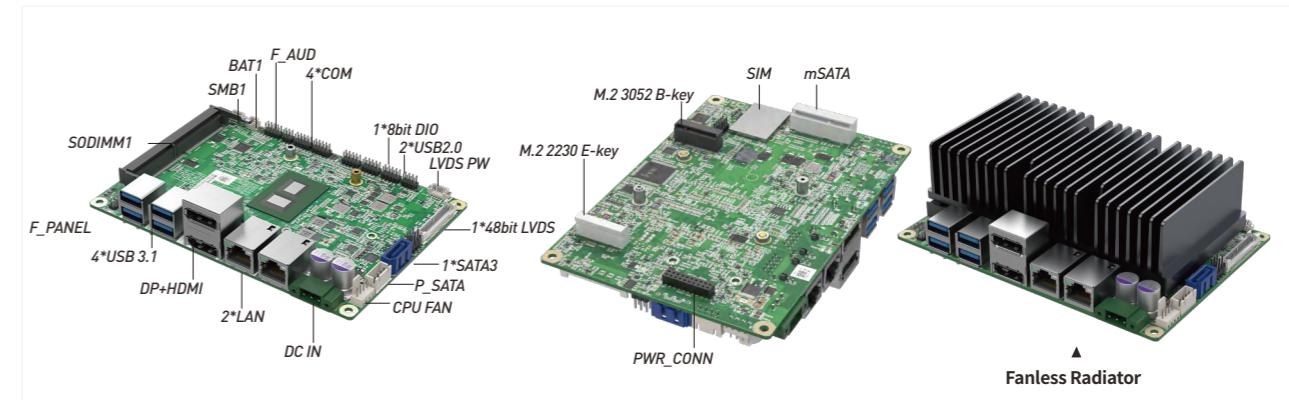
Product Parameters

System	
CPU	Intel® Elkhart lake SoC CPU: Celeron J6412 2.0-2.6GHz 4C4T/Celeron N6210 1.2-2.6GHz 2C2T
RAM	1*260 pin DDR4 SODIMM,3200MHz, 32GB max.
Graphics	Intel Gen10 UHD Graphics, H.265/HEVC/HW; HDMI:4096*2304@60Hz, DP:7680*4320@60Hz, LVDS:1920*1200@60Hz,3 independent display
I/O	
LAN	2*Realtek 8111H ,10-1000M,WOL
USB	4*USB3.1(10Gbps), 2*USB2.0(pin)
Display	1*HDMI+1*DP+1*LVDS(pin)
Audio	1*Line in+1*Line out+1*Mic,Realtek ALC897
COM& Others	1*RS232/422/485(pin),3*RS232(pin)
DIO	8-bit DIO,programmable TTL
Storage	1*SATA 3.0 HDD/SSD,6 Gbps,1*mSATA
Others	F_panel(PW SW, Reset SW),1*AT/ATX,1*Clear CMOS, 1* USB 5V/SB 1*PowerLED; 1*HDD LED; 3*CPU Temp LED Red is alarm, Yellow is high temp, Green is normal temp)
WDT	programmable via software 1 to 255 second

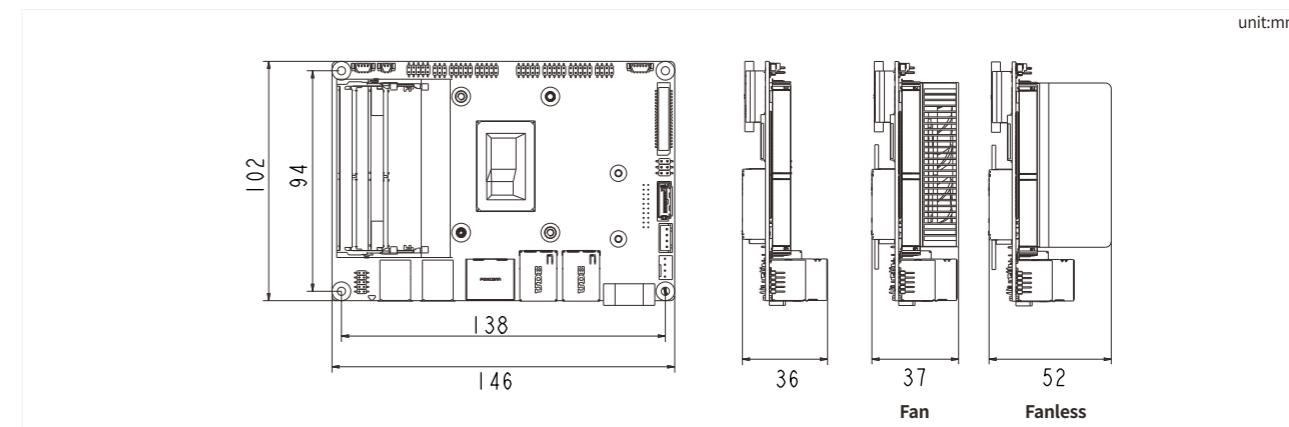
Expansion	
Expansion	1*M.2 2230 E-key(USB2.0/PCIeX1),WiFi5/BT 5.0; or 1*M.2 3052 B-key(USB2.0/PCIeX1+SIM),4G LTE/5G NR
Power	
Power& TDP	DC 12V; Optional OFX-075,75W,DC 9-36V; TDP:15.6W (CPU: Celeron J6412/32G DDR4/128 SSD)
Environment	

Dimension(W*H)	146*102mm(Height:radiator with fan 37mm,fanless radiator 52mm,PCB:1.6mm)
Operating Temp	0~60°C
Storage Temp	-40°C~85°C
Storage Temp	10~95%@40°C, No-condensation
Certificate/EMC	CE/FCC Class A
OS	Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	*Optional
ECM-I718/S001	Celeron J6412	1*SODIMM DDR4, 2*LAN, 4*USB3.1, 2*USB2.0, 1*M.2 2230 E-Key, 1*M.2 3052 B-Key(B or E-Key), 1*mSATA, 4*COM, 1*8-bit DIO, 1*DP, 1*HDMI, 1*LVDS, 1*SM BUS, 1*Audio, 1*SATA3.0, DC 12V	Radiator with Fan Pure copper+Aluminium alloy heat radiator,four-wire intelligent temperature control ball-bearing fan,silent ultra-thin design,fan cable 100mm,size: 137*70*24.2mm (After installation, the total thickness of the motherboard is 37mm)
ECM-I718/S002	Celeron N6210		
ECM-I718/S001-WP	Celeron J6412	1*SODIMM DDR4, 2*LAN, 4*USB3.1, 2*USB2.0, 1*M.2 2230 E-Key, 1*M.2 3052 B-Key(B or E-Key), 1*mSATA, 4*COM, 1*8-bit DIO, 1*DP, 1*HDMI, 1*LVDS, 1*SM BUS, 1*Audio, 1*SATA3.0, DC 12V	Fanless Radiator Pure copper+Aluminium alloy heat radiator,size: 137*70*39.3mm(After installation, the total thickness of the motherboard is 52mm)
ECM-I718/S002-WP	Celeron N6210		

Accessories

Standard		*Optional	
Serial ports cable	DB9 male,300mm	4	DIO cable
SATA cable	(7+15)pin SATA power supply +SATA data cable,300mm	1	Audio cable
Screw jumper	Two M2 screws +Two jumper caps (spare)	1	USB2.0 cable
DC-IN pin	3.81 pitch 3pin phoenix plug with earhole	1	

ECM-I910

Intel® Whiskey lake U CPU,Dual channel DDR4,1*HDMI,1*eDP,1*DP,2*LAN,4*USB3.0,4*COM,1*8-bit DIO,1*M.2 E-key,1*mini PCIe,DC 12V.

Key Specification

- Intel 8th Whiskey lake U Core i3/i5/i7/Celeron series processors
- Dual-channel DDR4 SODIMM, support up to 2400MHz, Max. 32GB
- 1*HDMI, 1*eDP, 3 independent 4K display ports
- 2*LAN, 10/100/1000Mbps, 4*USB3.0, 2*USB2.0, 4*COM, 1*8-bit DIO
- 1*M.2 2230 E-key, support WiFi 6/BT 5.0
- 1*Full-length Mini PCIe, support 4G/WiFi/BT(can be changed to mSATA via BIOS)
- 1*SATA3.0 HDD/SSD, 1*mSATA for storage (optional)
- Optional support TPM2.0, DC IN12V, optional 9-36V wide voltage input
- Compact size, complete functions, suitable for various compact embedded system application requirements



Product Overview

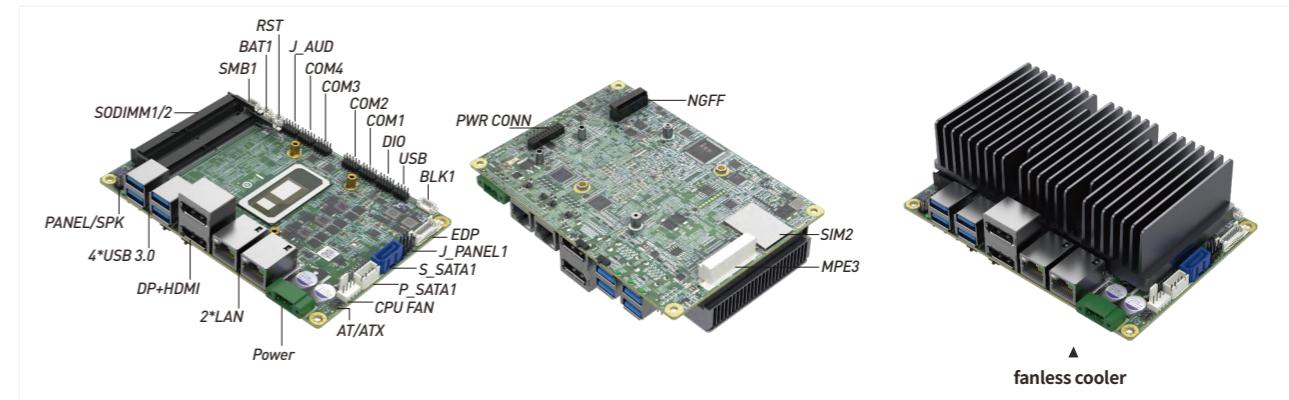
ECM-I910 is a standard 3.5-inch embedded single-board computer, equipped with Intel's 8th-generation Whiskey lake U Core i3/i5/i7/Celeron series processors. It supports 4G LTE/Wifi/BT and other wireless functions. It is with compact size and complete functions , suitable for various compact embedded system application requirements.

Product Parameters

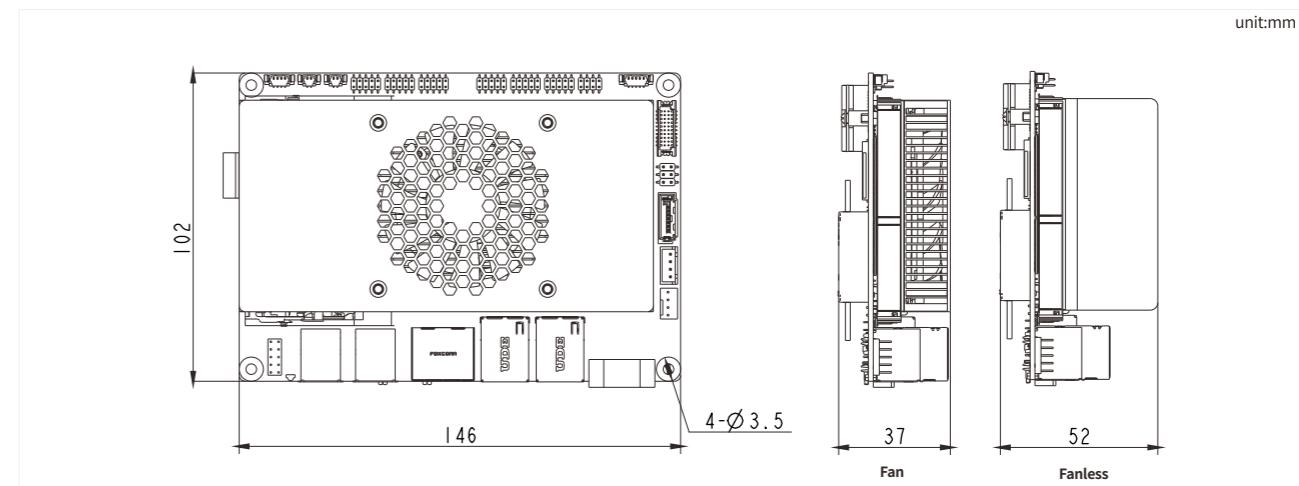
System	
CPU	Intel Whiskey lake U Celeron/Core i3/i5/i7
RAM	2*DDR4 SODIMM,2400MHz, 32GB max.
Graphics	
Graphics	Intel® Gen. 9 UHD Graphics,Support 3*4K independent display,DirectX 12,HEVC/H265 HW HD codec, the highest dynamic frequency can reach 1.2GHz;HDMI :4096*2304@24Hz; DP :4096*2304@60Hz; eDP :4096x2304@60Hz;
I/O	
LAN	1*Intel® I226V, 10-1000M; 1*Intel® I219LM, 10-1000M
USB	4*USB3.0, 2*USB2.0(pin)
Display	1*HDMI(1.4)+1*DP(1.2)+1*eDP(pin)
Audio	1*Line out+1*Mic(pin),Optional audio
Serial port &Others	2*RS232/422/485(pin),2*RS232(pin)
DIO	8-bit DIO,Programmable TTL
Others	
Control switch	(Power SW, Reset);1*AT/ATX;1*Clear CMOS
Indicator	1*power indicator light; 1*hard disk indicator light; 3*CPU temperature indicator light (Red is alarm, Yellow is high temperature, Green is normal temperature)
Watchdog timer	Watchdog timeout programmable via software 1 to 255 second
TPM	Optional support TPM2.0

Storage	
storage	1*SATA 3.0 HDD/SSD,1*mSATA(optional)
Expansion	
Expansion	1*M.2 2230 E-key,support WiFi/BT 5.0; 1*Mini PCIe(+SIM), 4G LTE,BIOS to mSATA
Power Supply	
Input voltage	DC 12V, optional OFX-075 75W DC 9-36V;
Power consumption	19.92W (I5-8265U, 8GB DDR, 500G SSD)
Environment	
Dimension(L*W)	146*102mm (Height: radiator with fan 37mm, fanless radiator 52mm, PCB:1.6mm)
Operating temp	0~60°C
Storage temp	-40°C~85°C
Storage humidity	10~95%@40°C, No condensation
Certification/EMC	CE/FCC Class A
OS	
OS	Windows 10 IoT enterprise, Andriod, Ubuntu, Suse, Red Hat enterprise, Wind River Vxworks 7, Yocto

I/O View



Dimensions



Ordering Information

*Optional		
Radiator with Fan	2*SODIMM DDR4, 2*LAN, 4*USB3.0, 2*USB2.0, 1*M.2 2230 E-Key, 1* Full size mini PCIe/mSATA, 4*COM, 1*8-bit DIO, 1*DP, 1*HDMI, 1*eDP, 1*Line out+1*Mic, 1*SATA3.0, DC 12V	Pure copper+Aluminium alloy heat radiator,intelligent temperature control ball-bearing fan,silent ultra-thin design,fan cable 100mm,size: 137*70*24.2mm (After installation, the total thickness of the motherboard is 37mm)
Fanless Radiator	2*SODIMM DDR4, 2*LAN, 4*USB3.0, 2*USB2.0, 1*M.2 2230 E-Key, 1* Full size mini PCIe/mSATA, 4*COM, 1*8-bit DIO, 1*DP, 1*HDMI, 1*eDP, 1*Line out+1*Mic, 1*SATA3.0, DC 9-36V	Pure copper+Aluminium alloy heat radiator,size: 137*70*39.3mm(After installation, the total thickness of the motherboard is 52mm)

Accessories

Standard		
Serial ports cable	DB9 male,300mm	4
SATA cable	(7+15)pin SATA power supply +SATA data cable,300mm	1
Screw jumper	Two M2 screws +Two jumper caps (spare)	1
DC-IN pin	3.81 pitch 3pin phoenix plug with earhole	1

*Optional		
DIO cable	DB9 male,300mm	
Audio cable	Three in a row (Line-out/Line-in/Mic) 3.5mm phone jack, 300mm	
USB2.0 cable	Two in a row Type A,300mm	

ECM-1913

Intel® Tiger lake U Soc CPU, Dual Channel DDR4, 1*HDMI, 1*DP, 2*LAN, 4*USB3.2, 4*COM, 1*8bit DIO, 1*M.2 B-key/E-key, 1*mSATA, 1*SATA3.0, DC 12V

| Key Specification

- Intel® Tiger lake Soc CPU
 - Dual channel DDR4 SODIMM, support 3200MHz, up to 64GB
 - 1*HDMI, 1*DP, 1*48-bit LVDS, 3 independent displays
 - 2*LAN, 4*USB3.2, 2*USB2.0, 4*COM, 1*8-bit DIO
 - 1*M.2 2230 E-key supports WIFI/BT or 1*M.2 3052 B-key with SIM card slot, supports 4G LTE/5G NR
 - 1*full size Mini PCIe, supports PCIe modules
 - 1*SATA3.0 HDD/SSD, 1*mSATA(Opt.) for storage
 - Active or passive, two different thickness radiator selection
 - DC IN12V,9-36V wide power input for optional (OFX-075)



Product Overview

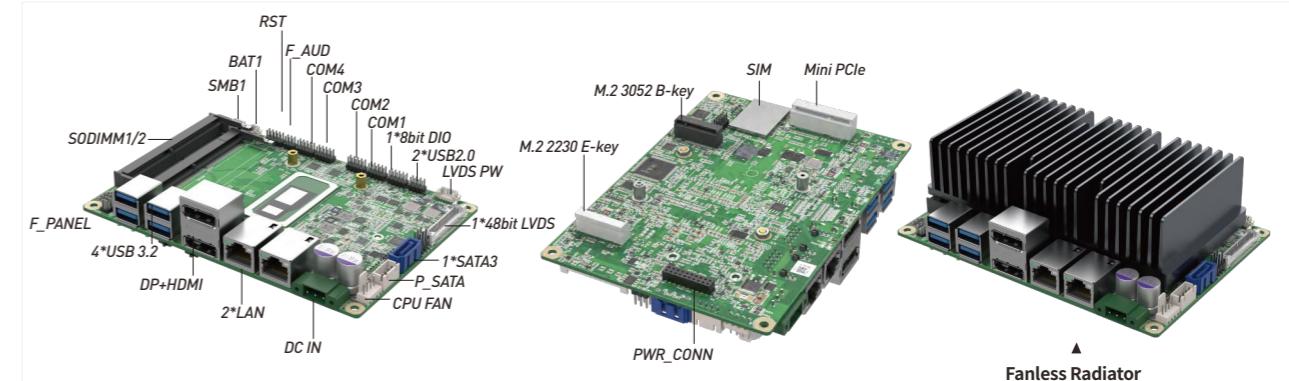
ECM-I913 is a 3.5-inch embedded mainboard equipped with Intel® Tiger Lake U Soc CPU. It has complete IO functions, flexible selection of power supply, active and passive radiators, and the compact size is suitable for installation in limited space scenarios. It is very suitable for AGV and AMR, medical inspection, machine vision, industrial control, digital city and smart security and other industries and fields.

Product Parameters

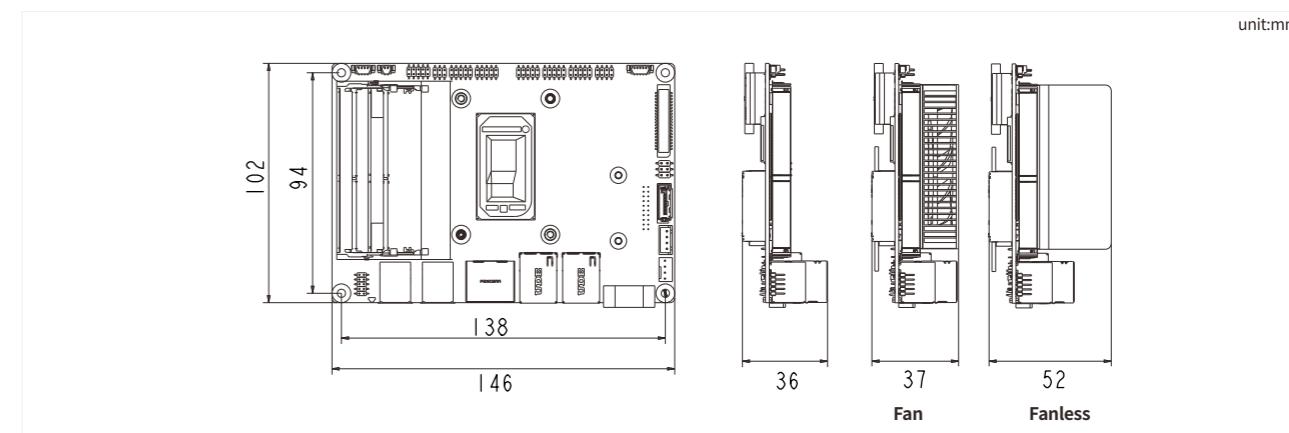
System	
CPU	Intel® Tiger lake U Soc CPU (core i3-1115G4/i5-1135G7/i7-1165G7, Celeron 6305),TDP 12W/15W/28W
RAM	2*DDR4 SODIMM,3200MHz, 64GB max.
Graphics	Intel UHD Graphics or Xe Graphics , Supports Intel DL boost, DirectX-12.1, OpenGL 4.6 and OpenCL 3.0, HDMI:4096*2304@60Hz, DP:7680*4320@60Hz, LVDS:1920*1200@60Hz,3 independent display
I/O	
LAN	1*Intel I226V , 10M-2.5G 1*Intel®I219LM ,iAMT13.0
USB	4*USB3.2 Gen2(10Gbps), 2*USB2.0(pin)
Display	1*HDMI+1*DP+1*LVDS(pin)
Audio	1*Line in+1*Line out+1*Mic,Realtek ALC897
COM& Others	2* RS232/422/485(pin),2*RS232(pin)
DIO	8-bit DIO,programmable TTL
Storage	
Storage	1*SATA 3.0 HDD/SSD,6 Gbps,1*mSATA(Optional)
Others	
Switch	1*F Panel(PW SW, Reset);1*AT/ATX;1*Clear CMOS; 1* USB 5V/SB
LED	1*PowerLED; 1*HDD LED; 3*CPU Temp LED Red is alarm, Yellow is high temp, Green is normal temp)
WDT	programmable via software 1 to 255 second

Expansion	1*Mini PCIe(PCIeX1),PCIe module/mSATA; Expansion 1*M.2 2230 E-key(USB2.0/PCIeX1),WiFi/BT 5.0, or 1*M.2 3052 B-key(USB2.0/PCIeX1+SIM),4G LTE/5G NR
Power	DC 12V; Power& TDP Optional OFX-075 75W,DC 9-36V; 45.36W (i7-1165 G7/4G DDR4/128G SSD)
Environment	Dimension (W*H) 146*102mm(Height: radiator with fan 37mm, fanless radiator 52mm, PCB:1.6mm) Operating Temp 0~60°C Storage Temp -40°C~85°C Storage Temp 10~95%@40°C, No-condensation Certificate/EMC CE/FCC Class A
OS	Windows 11*IoT enterprise, Windows 10*IoT enterprise,Android,- SUSE,Ubuntu,Wind River,Red Hat*Enterprise,Wind River VxWorks*7,Yocto

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	*Optional
ECM-I913/S001	Intel® Core i3-1115G4	2*SODIMM DDR4, 2*LAN, 4*USB3.2, 2*USB2.0, 1*M.2 2230 E-Key, 1*M.2 3052 B-Key(B or E-Key), 1* Full size mini PCIe/mSATA, 4*COM, 1*8-bit DIO, 1*DP, 1*HDMI, 1*LVDS, 1*SM BUS, 1*Audio, 1*SATA3.0, DC 12V	Radiator with Fan Pure copper+Aluminium alloy heat radiator,four-wire intelligent temperature control bearing fan,silent ultra-thin design,fan cable 100mm, size:137*70*24.2mm (After installation, the total thickness of the motherboard is 37mm)
ECM-I913/S002	Intel® Core i5-1135G7		
ECM-I913/S003	Intel® Core i7-1165G7		
ECM-I913/S004	Intel® Celeron 6305U		
ECM-I913/S001-WP	Intel® Core i3-1115G4	2*SODIMM DDR4, 2*LAN, 4*USB3.2, 2*USB2.0, 1*M.2 2230 E-Key, 1*M.2 3052 B-Key(B or E-Key), 1* Full size mini PCIe/mSATA, 4*COM, 1*8-bit DIO, 1*DP, 1*HDMI, 1*LVDS, 1*SM BUS, 1*Audio, 1*SATA3.0, DC 9-36V	Fanless Radiator Pure copper+Aluminium alloy heat radiator,size: 137*70*39.3mm(After installation, the total thickness of the motherboard is 52mm)
ECM-I913/S002-WP	Intel® Core i5-1135G7		
ECM-I913/S003-WP	Intel® Core i7-1165G7		
ECM-I913/S004-WP	Intel® Celeron 6305U		

Accessories

Standard		*Optional	
Serial ports cable	DB9 male,300mm	4	DIO cable
SATA cable	(7+15)pin SATA power supply +SATA data cable,300mm	1	AUDIO cable
Screw jumper	Two M2 screws +Two jumper caps (spare)	1	USB2.0 cable
DC-IN pin	3.81 pitch 3pin phoenix plug with earhole	1	Three in a row (Line-out/Line-in/Mic) 3.5mm phone jack, 300mm

PITX-I915

Intel® Tiger lake U Soc CPU, Onboard memory, 1*HDMI, 1*eDP, 2*LAN, 2*USB3.2, 2*COM, 1*M.2 E-key, 1*mSATA, 1*SATA3.0, DC 12V

Key Specification

- Intel® Tiger lake Soc CPU
- LPDDR4x Onboard memory, up to 16GB
- 1*HDMI, 1*eDP, 2 independent displays
- 2*LAN, 2*USB3.2, 2*USB2.0, 2*COM
- 1*M.2 2230 E-key supports WIFI/BT
- 1*full size Mini PCIe, supports PCIe modules
- 1*SATA3.0 HDD/SSD, 1*mSATA(Opt.) for storage
- Active or passive, two different thickness radiator selection
- DC IN12V



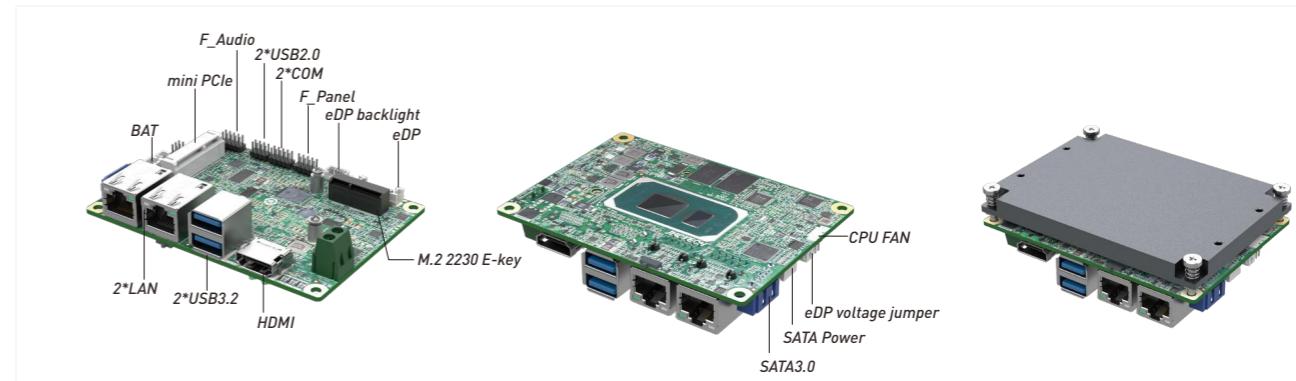
Product Overview

PITX-I915 is a 2.5-inch embedded mainboard equipped with Intel® Tiger Lake U Soc CPU. It has complete IO functions, mini size, active and passive radiators, and the compact size is suitable for installation in limited space scenarios. It is very suitable for AGV and AMR, medical inspection, machine vision, industrial control, digital city and smart security and other industries and fields.

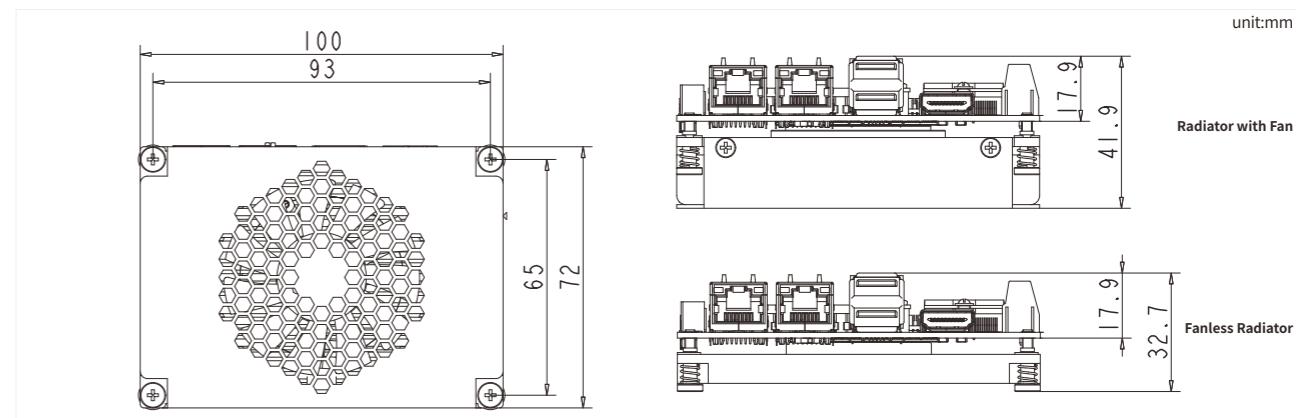
Product Parameters

System	
CPU	Intel® Tiger lake U Soc CPU (core i3-1115G4/i5-1135G7/i7-1165G7, Celeron 6305E), TDP 12W/15W/28W
RAM	Onboard LPDDR4X, 16GB max.
Graphics	
Graphics	Intel UHD Graphics /Iris® Xe Graphics , Supports Intel DL boost, DirectX12.1,OpenGL 4.6 and OpenCL 3.0, 2 independent displays; HDMI:4096*2304@60Hz, eDP:4096*2304@60Hz
I/O	
LAN	1*Intel I210AT ,10M-1000M 1*Intel®I219LM ,10M-1000M
USB	2*USB3.2, 2*USB2.0
Display	1*HDMI+1*eDP
Audio	1*Line in+1*Line out+1*Mic, Realtek ALC897
COM& Others	1*RS232/422/485, 1*RS232
DIO	/
Storage	
Storage	1*SATA 3.0 HDD/SSD, 6 Gbps, 1*mSATA (Opt.)
Others	
Switch	1*F Panel(PW SW,Reset);1*AT/ATX;1*Clear CMOS;1* USB 5V/SB
LED	1*Power LED; 1*HDD LED
WDT	programmable via software 1 to 255 second

I/O View



Dimensions



Ordering Information

Model	Processor	Onboard memory	Specifications	*Optional
PITX-I915/S001	Intel® Core i3-1115G4	8G LPDDR4X		Radiator with Fan
PITX-I915/S002	Intel® Core i5-1135G7	8G LPDDR4X	2*LAN, 2*USB3.2, 2*USB2.0, 1*M.2 2230 E-Key, 1* Full size mini PCIe/mSATA, 2*COM, 1*HDMI, 1*eDP, 1*Audio, 1*SATA3.0, DC 12V	Radiator with Fan
PITX-I915/S003	Intel® Core i7-1165G7	16G LPDDR4X		Fanless Radiator
PITX-I915/S004	Intel® Celeron 6305E	4G LPDDR4X		Fanless Radiator

Accessories

Standard			*Optional	
Serial ports cable	DB9 male,300mm	4	AUDIO cable	Three in a row (Line-out/Line-in/Mic) 3.5mm phone jack, 300mm
SATA cable	(7+15)pin SATA power supply +SATA data cable,300mm	1	USB2.0 cable	Two in a row Type A,300mm
Screw jumper	Two M2 screws +Two jumper caps (spare)	1		

MATX-I953

Intel® Core™ i7/i5/i3/ Pentium/Celeron CPU, VGA/HDMI/DVI-D, Dual LAN, 4/8*USB 3.0, 5*USB 2.0, 6/12*COM, 4*PCIe/PCI, ATX power

Key Specification

- Intel H110 PCH, supports Intel 6/7th Gen. SKL/KBL-S Core i7 / i5 / i3
- /Pentium/Celeron LGA1151 CPU
- Dual - channel 2*DDR4 2133/2400MHz UDIMM, up to 32GB
- Intel 9th HD Graphic , VGA+HDMI/ VGA +DVI-D/ HDMI+ DVI-D,
- 1*I219LM and 1*I210AT/I211AT dual Gigabit network ports
- 4/8*USB3.0, 5*USB2.0, 6/12*COM, 8bit DIO,1*LPT
- 1*PCIeX16, 1*PCI, 2*PCIeX4(X1), a total of four slots, 1* full-size Mini PCIe
- 4*SATA3.0 6.0Gbps, 1*Line out&1*Mic, optional amplifier
- 24pin ATX +4pin 12V ATX power



Product Overview

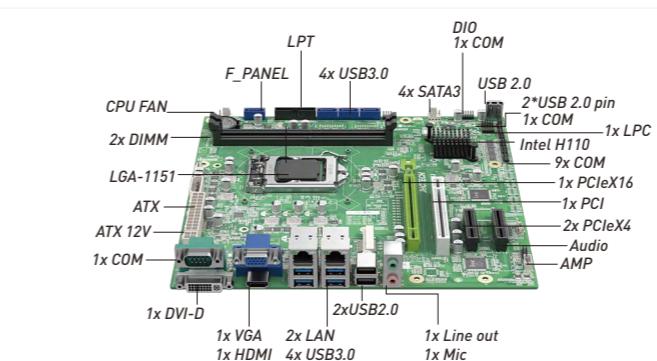
MATX-I953 is an industrial motherboard powered by Intel H110 chipset supporting Intel 6/7th Gen Core i7 / i5 / i3/Pentium/Celeron CPU, designed according to the standard Micro ATX motherboard specification. It is suitable for all 4U rack and wall-mounted rack on the market, very suitable for machine vision and data acquisition and other fields.

Product Parameters

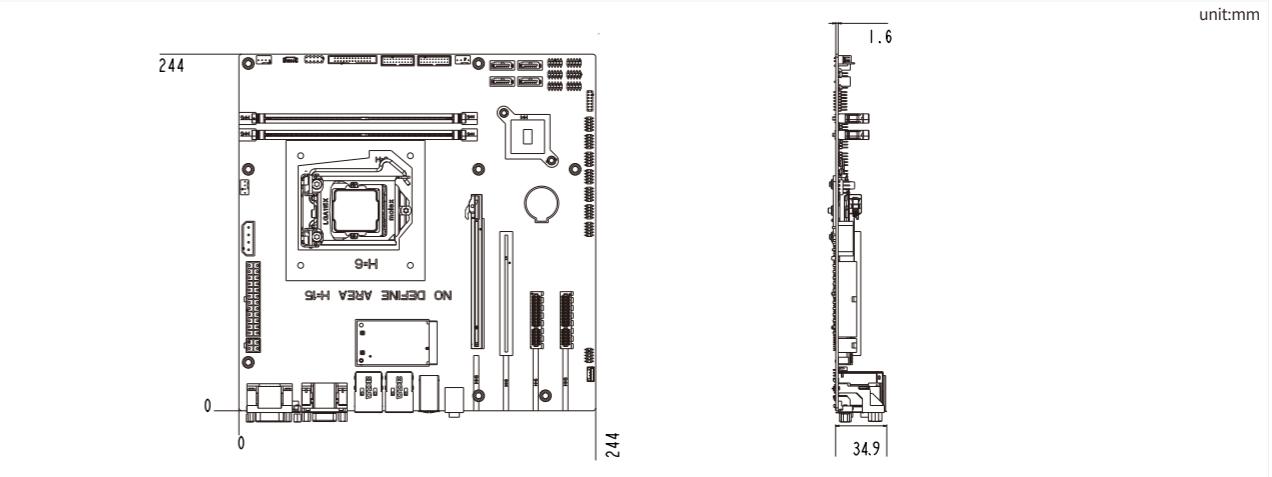
System	
CPU	Intel® 6th/7th Gen Core i7/i5/i3/ Pentium/Celeron LGA1151 CPU,H110 chipset,up to 91W
RAM	2*DDR4 Non-ECC UDIMM, 2400MHz,max 32GB
Graphics	Intel Gen. 9 HD Graphics, HEVC/H265 HW HD Codec; HDMI:3840*2160@30Hz
Graphics	VGA:1920*1200@60Hz DVI-D:1920 x 1200 @ 60Hz
I/O	
LAN	1*Intel® I210AT,10-1000M, 1*Intel® I219LM,10-1000M,WOL
USB	4*USB3.0,3*USB2.0,2*USB2.0(pin), 4*USB3.0(S002,2*5pin)
Display	1*HDMI + 1*DVI-D + 1*VGA
Audio	1*Line out+1*Mic,optimal audio, 1* Amplifier(optional)
Serial Port&Others	2*RS232/422/485,4*RS232,optional added 6*RS232, 1*PS/2,1*LPT,1*LPC
DIO	8-bit DIO,programmable TTL
Storage	
Storage	4*SATA 3.0 HDD/SSD(1*SATA with power,support SATADOM)

Others	
Control SW indicator	F_PANEL(USB Power jumper, AT/ATX jumper, Clear CMOS jumper)
Watchdog timer	Power LED,hard disk LED
	programmable via software 1 to 255 second
Expansion	
Expansion	1*PCIe3.0X16(X16)+2*PCIe2.0X4(x1)+ 1* 32-bit PCI; 1*MiniPCIe(PCIeX1)
Power supply	
Power supply& Consumption	24-Pin ATX/8-Pin ATX 12V; 125W (I7-7700K CPU/16G DDR4/128G SSD
Environment	
Dimension(w*L*H)	244*244*34.9mm; PCB:1.6mm
Operating temp	0~60°C
Storage temp	-40°C~85°C
Storage humidity	10~95%@40°C, no condensation
Certificate/EMC	CE/FCC Class A
OS	
	Windows 7, Windows 10, Linux Fedora Ubuntu (Note:The 7th Intel® Kabylake CPU do not support Windows 7 32bit)

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
MATX-I953/S001	Intel H110+ SKL/KAL-S LGA1151 CPU	4*USB3.0 6*COM 2*LAN, 5*USB2.0, 8bitGPIO,1*PCIe X16, 2*PCIe X4(x 1 signal), 1*PCI, 1*Mini PCIe, 1*HDMI, 1*VGA, 1*DVI-D, 1*Line out and 1*Mic, optional Amplifier,4*SATA3,1*LPT, 24-pin ATX/4-pin ATX provides 12V power supply
MATX-I953/S002		8*USB3.0 12*COM 2*LAN, 5*USB2.0, 8bitGPIO,1*PCIe X16, 2*PCIe X4(x 1 signal), 1*PCI, 1*Mini PCIe, 1*HDMI, 1*VGA, 1*DVI-D, 1*Line out and 1*Mic, optional Amplifier,4*SATA3,1*LPT, 24-pin ATX/4-pin ATX provides 12V power supply

Accessories

Standard	Amount	Optional	
Serial ports cable	DB9 male, 300mm	DIO cable	DB9 male, 600mm
SATA cable	SATA 7pin data cable, 420mm	Audio cable	Three in a row(Line-out/Line-in/Mic) 3.5mm phone jack, 300mm
I/O block slice	Full IO opening, 0.5mm stainless steel	Serial ports cable	DB9 male, 300mm
Screw&jumper	2*M2 screws, 2*M2.25 screws+2*2.0&2.5 jumper caps	USB2.0 cable	Two in a row Type A, 300mm
		USB3.0 cable	Two in a row Type A, 300mm
		Parallel ports cable	DB25 female, 300mm
		PS/2 cable	Two in a row 6pin S-female keyboard & mouse port, 300mm
		SATA cable	SATA 7pin data cable, 420mm
		CPU radiator1	LGA115X, TDP 35-65W wind-cooling radiator
		CPU radiator2	LGA115X, TDP 95W wind-cooling radiator

MATX-I961

Intel® Coffee Lake-R LGA1151 CPU, M-ATX, HDMI, 2*DP, 3*LAN, 4*COM, 6*USB3.2, 7*USB2.0, 4*SATA3.0, Workstation-grade performance

Key Specification

- Intel® Xeon® E or 9th/8th-Gen Pentium/Celeron/Core i7/i5/i3
- Intel® Q370/C246 Chipset
- 4*DDR4 2666/2400MHz DIMM, Max. 128GB
- 2*DP, 1*HDMI, support 3 independent displays
- 3*LAN, 6*USB3.2 Gen2, 7*USB2.0, 4*COM
- 1*PCIeX16 or 2*PCIeX8+2*PCIeX4 expansion
- 1*Mini PCIe, with SIM card slot, support 4G/WIFI/GPS/GSM/BT
- 4*SATA3.0, 1*M.2 2280 M-Key(PCIe X4)
- Optional support TPM 2.0 security encryption, support AMT12.0, Intel® Vpro technology
- ATX Power (12V/5V/3.3V)



Product Overview

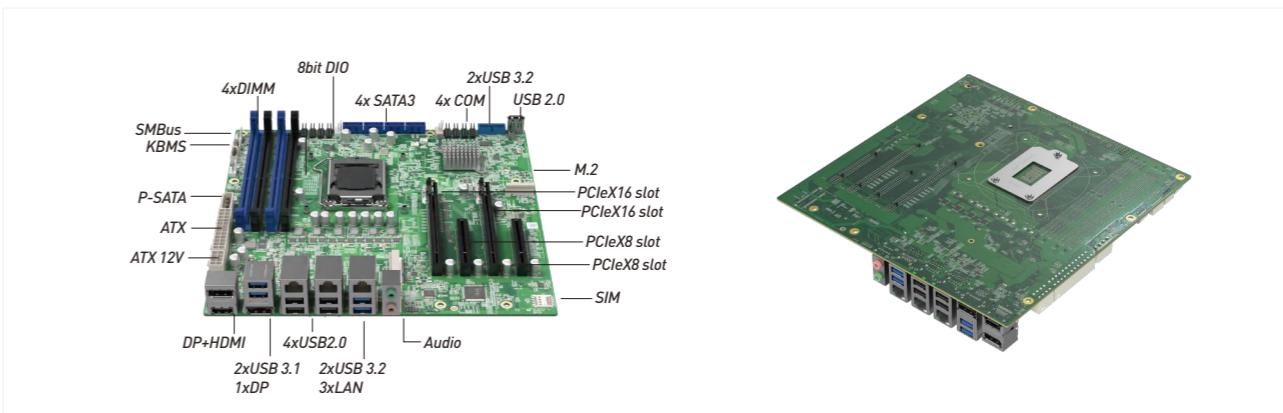
MATX-I961 is ESBC series embedded single board computer, equipped with Intel® Xeon® E or 9th/8th-Gen Pentium/Celeron/Core i7/i5/i3, up to 8 cores and 16 threads processor, supports 4G/WIFI/GPS/GSM/BT and other wireless functions, ATX Power power supply, complete functions, suitable for various embedded system application requirements.

Product Parameters

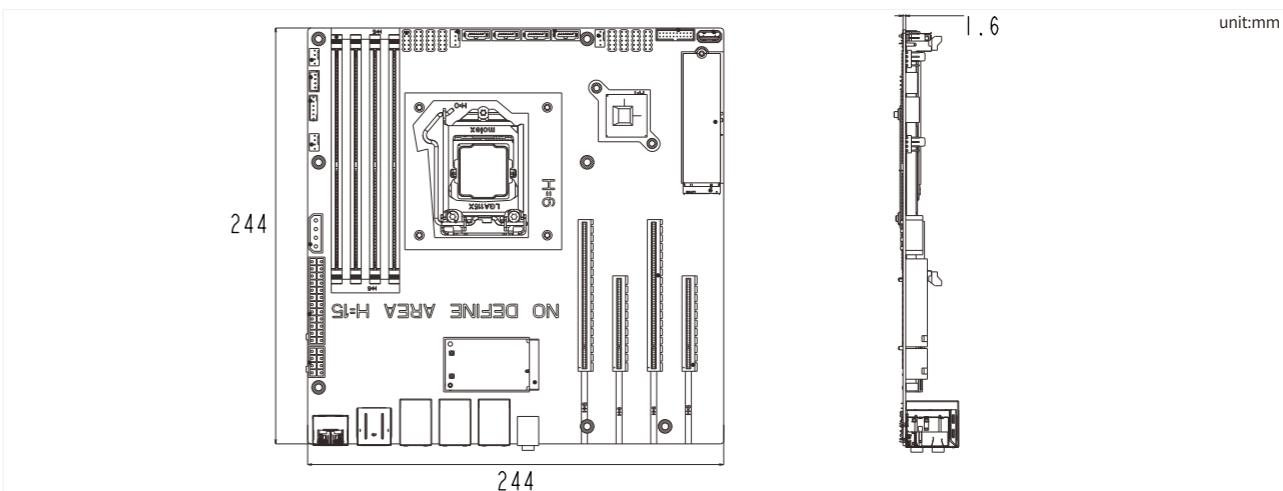
System	
CPU	Intel® Xeon® E or 9th/8th-Gen Pentium/Celeron/Core i7/i5/i3 LGA1151 processor
RAM	4*DDR4 2666/2400MHz, 128GB max.
Graphics	Intel UHD Graphics, Supports DirectX11.1, OpenGL 5.0 and OpenCL 2.1 DP:4096*2304@60Hz, HDMI:3840*2160@30Hz,Support 3 independent displays
I/O	
LAN	2*Intel I210AT PCIe, 10/100/1000 Mbps; 1*Intel I219LM PCIe, 10/100/1000 Mbps, Support Intel vPro
USB	4*USB3.2 Gen2, 4*USB2.0, 2*USB3.2 Gen2(pin), 1*USB2.0(build-in)
Display	2*DP+1*HDMI
Audio	1*Line out+1*Mic, Optional audio
Serial port &Others	4*RS232(pin), 1*PS/2(pin), 1*SM bus(pin)
DIO	8-bit DIO, Programmable TTL
Storage	
storage	4*SATA3, HDD/SSD support RAID 0/1/5/10 1*M.2 2280 M-key(PCIe X4), Support NVMe storage
Others	
Control switch	Power SW, Reset
Indicator	1*power indicator light; 1*hard disk indicator light; 3*CPU temperature indicator light (Red is alarm, Yellow is high temperature, Green is normal temperature)
Watchdog timer	Watchdog timeout programmable via software 1 to 255 second
TPM	Optional support TPM2.0

Expansion	
Expansion Port	1*Mini PCIe with SIM slot
	2*PCIe X16 slot (1*PCIe X16/2*PCIe X8)
	2*PCIe X8 slot (Gen3, 2*PCIe X4)
Power Supply	
Input voltage	24-pin ATX/8-pin ATX 12V,
Power consumption	374W (i7-8700, 16GB DDR, 2*4TB, GTX-1660)
Environment	
Dimension (L*W*H)	244*244*30.8mm, PCB: 1.6mm
Operating temp	0~60°C
Storage temp	-40°C~85°C
Storage humidity	10~90%@40°C, No condensation
Certification/EMC	CE/FCC Class A
OS	
OS	Windows 10 Enterprise & IOT Enterprise Windows Server 2016 (Intel® Xeon® E) Ubuntu, SuSe, Redhat Enterprise 1,2 Wind River VxWorks 7

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
MATX-I961/S001	Intel® Q370+Coffelake-R LGA1151 CPU	3*LAN, 6*USB3.1, 7*USB2.0, 4*COM, 1*Mini PCIe, 1*M.2 2280 M-Key, 8bit DIO, 1*PCIe X16(or 2*PCIe X8), 2*PCIe X4, 1*HDMI, 2*DP, 1*Line out+1*Mic, 1*PS/2, 4*SATA3, 24-pin ATX/8-pin ATX 12V
MATX-I961/S002	Intel® C246+Coffelake-R LGA1151-R CPU	
ECB-246+ECD-2460	Mini PCIe dual Intel I210AT Gigabit Ethernet port module, 2*RJ45 interface, with cable	
ECB-260 CAN module	Mini PCIe dual isolation CAN module, 2*DB9, with cable	

Accessories

Standard	Amount	Optional
Serial ports cable	DB9 male, 300mm	4
SATA cable	SATA 7pin data cable, 420mm	2
I/O block slice	Full IO opening, 0.5mm stainless steel	1
Screw&jumper	2*M2 screws, 2*M2.25 screws+2*2.0&2.5 jumper caps	1
DIO cable	DB9 male, 600mm	
Audio cable	Three in a row(Line-out/Line-in/Mic) 3.5mm phone jack, 300mm	
Serial ports cable	DB9 male, 300mm	
USB2.0 cable	Two in a row Type A, 300mm	
USB3.0 cable	Two in a row Type A, 300mm	
Parallel ports cable	DB25 female, 300mm	
PS/2 cable	Two in a row 6pin S-female keyboard & mouse port, 300mm	
SATA cable	SATA 7pin data cable, 420mm	
CPU radiator1	LGA115X, TDP 35-65W wind-cooling radiator	
CPU radiator2	LGA115X, TDP 95W wind-cooling radiator	

MATX-I964

Intel 8/9th LGA1151 CPU, Dual-channel DDR4, VGA/HDMI/DVI-D, Dual LAN, 4*USB 3.1, 6*USB 2.0, 6*COM, 4*PCIe/PCI, ATX power

Key Specification

- Intel H310 PCH, supports Intel 8/9th Gen. Coffee lake-S Core i9 / i7 / i5 / i3
- /Pentium/Celeron LGA1151 CPU
- Dual - channel DDR4 2666MHz UDIMM, up to 64GB
- VGA+HDMI/ VGA +DVI-D/ HDMI +DVI-D dual independent displays
- 1*I219LM and 1*I226V dual Gigabit network ports
- 4*USB3.1, 6*USB2.0, 6*COM, 1*8bit GPIO, 1*LPT
- 1*PCIe X16, 1*PCI, 2*PCIe X4, a total of four slots;
- 4*SATA3.0 6.0Gbps, 1*M.2 2242/2280 M-Key, NVMe
- Realtek ALC897 HD audio chip, support 5.1 channels, optional support amplifier
- 24pin ATX +4pin 12V ATX power



Product Overview

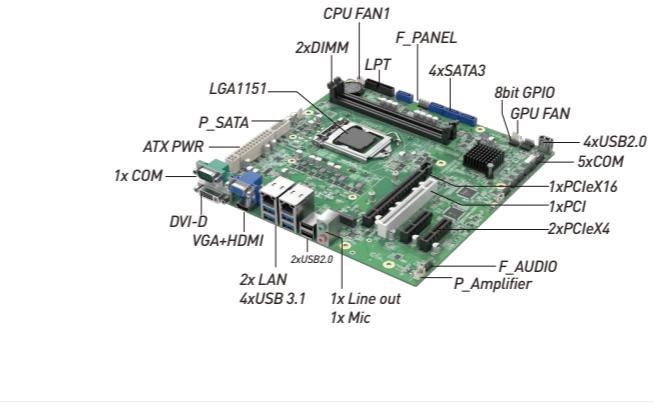
MATX-I964 is an industrial motherboard powered by Intel H310 chipset, supporting Intel 8/9th Gen Core i9 / i7 / i5 / i3 /Pentium/Celeron CPU, designed according to the standard Micro ATX motherboard specification. It is suitable for all 4U rack and wall-mounted rack on the market, very suitable for machine vision, data acquisition and other fields.

Product Parameters

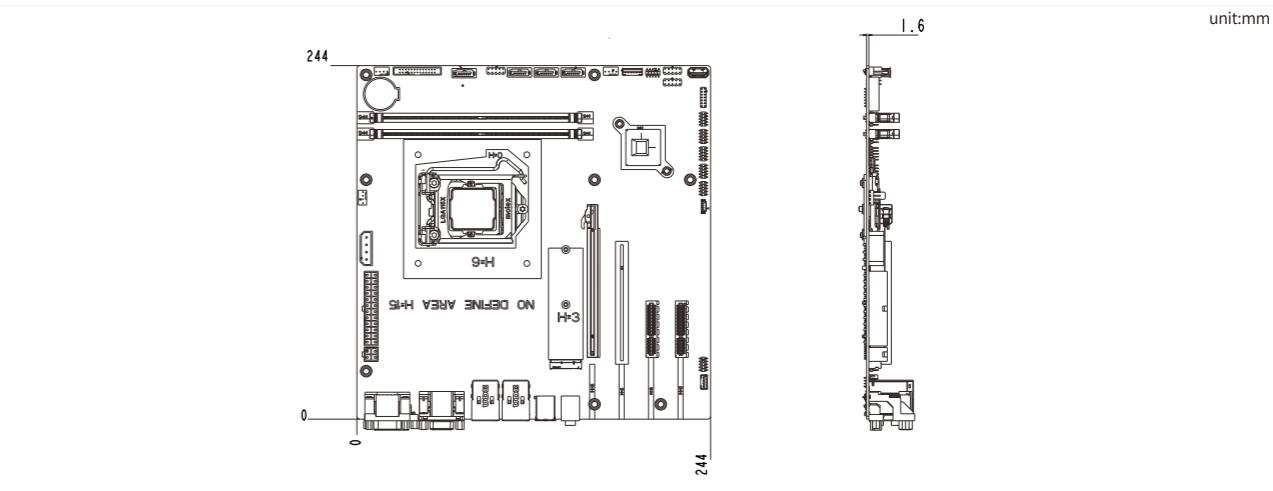
System	
CPU	Intel 8/9th Gen. Core i9/i7/i5/i3/Pentium/Celeron CPU, LGA 1151 Socket, TDP max. 95W, Intel H310 PCH
RAM	2*DDR4 Non-ECC UDIMM, 2666MHz, 64GB max.
Graphics	Intel 9th HD Graphic, AVC/VC1/MPEG2/HEVC/VP8/JPEG.HW, Direct3D 11.2, OpenGL 5.0, OpenCL 2.1, HDMI:4096*2304@24Hz, VGA:1920*1200@60Hz, DVI-D:1920*1200@60Hz, 2 independent Display
I/O	
LAN	1*Intel® I226V, 10M-2.5G, WOLRemote 1*Intel® I219LM, 10-1000M, WOLRemote
USB	4*USB3.1 Gen2(5Gbps), 2*USB2.0(5V System or 5V SB); 4*USB2.0(pin)
Display	1*HDMI+1*VGA+1*DVI-D
Audio	1*Line out+1*Mic, Realtek ALC897, Optional 2*3W Amplifier
COM& Others	1*RS232/422/485(DB9), 1*RS232/422/485(pin)4*RS232(pin), 1*LPC, 1*PS/2(pin), 1*SM bus(pin)
DIO	8-bit DIO, programmable TTL
Storage	
Storage	4*SATA3; 1*M.2 2242/2280 M-key(PCIe X2), NVMe Storage

Others	
Switch	F_PANEL(Power SW, Reset), Clear CMOS, AT/ATX, USB Power
LED	1*PowerLED; 1*HDD LED; 3*CPU Temp LED (Red is alarm, Yellow is high temp, Green is normal temp)
WDT	programmable via software 1 to 255 second
Expansion	
Expansion	1*PCIe3.0 X16(X16) + 2*PCIe2.0 X4 (X1)+1*32-bit PCI; 1*M.2 2242/2280 M-Key(PCIe2.0 X2)
Power	
Power& TDP	24-pin ATX + 4-pin 12V, TDP: 224W (I9-9900K/16G DDR4/128G SSD)
Environment	
Dimension(W*H)	244*244mm(Top Side:33.2mm; PCB:1.6mm)
Operating Temp	0~60°C
Storage Temp	-40°C~85°C
Storage Temp	10~95%@40°C, No-condensation
Certificate/EMC	CE/FCC Class A
OS	
	Windows7, Windows® 10 Enterprise & IOT Enterprise (64 bit)(CFL-R), Windows® Server 2016 (Intel® Xeon® E) Ubuntu®, SuSe®, Redhat Enterprise® 1,2 (Kernel 4.14) (CFL-R) Wind River®, VxWorks® 7 (CFL-R)

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
MATX-I964/S001	Intel® H310+Coffee lake-S LGA1151 CPU	2*LAN, 4*USB3.1, 6*USB2.0, 6*COM, 1*8 bit GPIO, 1*PCIe X16, 2*PCIe X4(X1), 1*PCI, 1*M.2 M-Key, 1*HDMI, 1*VGA, 1*DVI-D, 1*Line out and 1*Mic, optional Amplifier, 4*SATA3(1*SATA DOM), 1*LPT, 1*PS2, 24-pin ATX/4-pin ATX provides 12V power supply

Accessories

Standard	Optional
Serial ports cable	DB9 male, 300mm
SATA cable	SATA 7pin data cable, 420mm
I/O block slice	Full IO opening, 0.5mm stainless steel
Screw jumper	Two M2 screws + Two jumper caps (spare)
DIO cable	DB9 male, 300mm
AuDIO cable	Three in a row (Line-out/Line-in/Mic) 3.5mm phone jack, 300mm
Parallel ports cable	DB25 female, 300mm
USB2.0 cable	Two in a row Type A, 300mm
PS/2 cable	Two in a row 6pin S-female, 300mm
CPUradiator1	LGA115X, TDP 35-65W wind-cooling radiator
CPUradiator2	LGA115X, TDP 95W wind-cooling radiator
SATA cable	SATA 7pin data cable, 420mm

ATX-1971

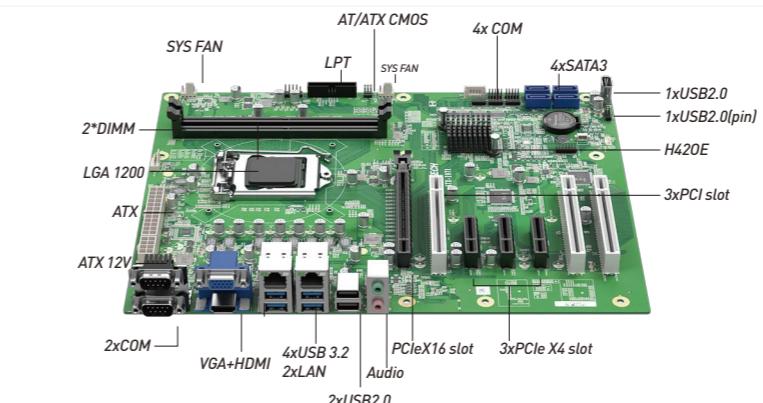
Intel® Comet lake-S CPU, H420E, 2*LAN, 1*VGA, 1*HDMI, 6*COM, 4*USB3.2, 5*USB2.0, 4*SATA3.0, 8-bit DIO, ATX power

Key Specification

- Intel® 10th Gen. Cometlake-S Core i9/i7/i5/i3/Pentium/Celeron CPU
- Intel H420E Chipset
- 2*DDR4 2400/2666/2933MHZ SODIMM, Max 64GB
- Intel UHD Graphic, 1*HDMI+1*VGA, dual independent display
- 1*I226V, 2.5G; 1*I219 LM, 10/100/1000 Mbps
- 6*USB3.0, 2*USB2.0, 6*COM, 8-bit DIO
- 1*PCIe X16, 3*PCIe X4, 3*32-bit PCI
- 4*SATA3.0, 6.0 Gbps; Audio, TPM 2.0(Opt.)
- 24pin ATX+8pin 12V ATX



I/O View



Product Overview

ATX-1971 is powered by Intel® 10th Gen Core i9/i7/i5/i3/Pentium/Celeron processor CPU with Intel H420E chipset. It is designed according to the standard ATX hole size, and is fully adapted to all rack and wall-mounted chassis on the market, and is very suitable for machine vision, CNC machinery, data acquisition and other fields.

Product Parameters

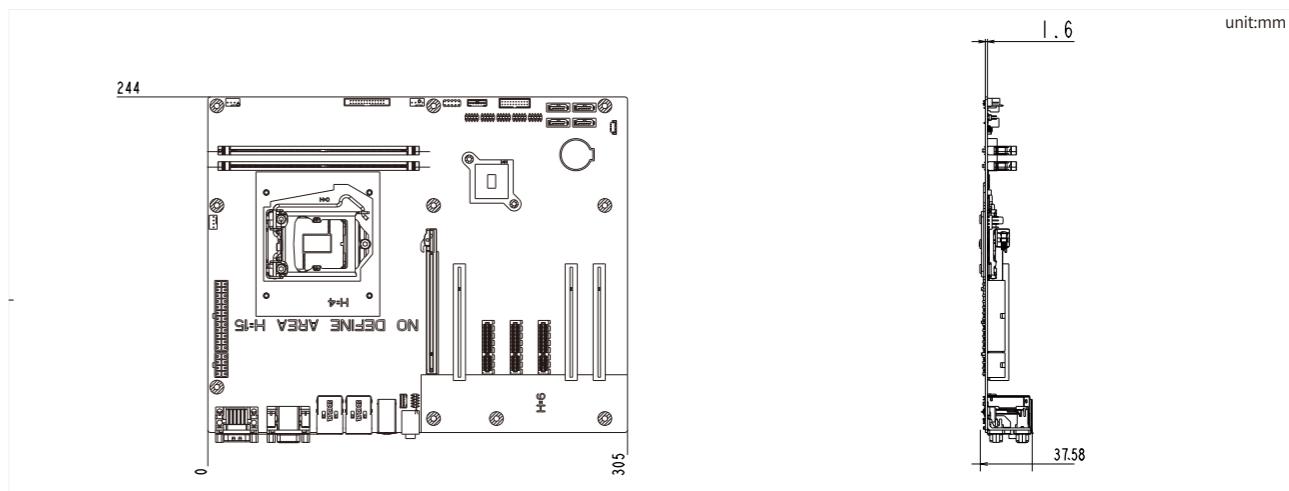
System	
CPU	Intel 10th Gen. Cometlake-S Core i9/i7/i5/i3/Pentium/Celeron CPU, LGA 1200 Socket, up tp 125W
RAM	2* DDR4 288-Pin Non-ECC UDIMM, 2400/2666/2933MHz, 64GB max.
Graphics	Intel UHD Graphics, Supports DirectX12, OpenGL 4.5 and OpenCL 2.1, HW Decode: AVC/H.264, MPEG2, VC1/WMV9, JPEG/MJPEG, HEVC/H265, VP8, VP9 HW Encode: MPEG2, AVC/H264, JPEG, HEVC/H265, VP8, VP9 HDMI: 4096*2160@30Hz, VGA: 1920*1200@60Hz
I/O	
LAN	1*Intel® I226V 10M-2.5G, WOL; 1*Intel® I219LM 10-1000M, WOL
USB	4*USB3.2, 2*USB2.0, 3*USB2.0(Build-in)
Display	1*HDMI+1*VGA
Audio	1*Line out+1*Mic, Optional Audio, 1*Amplifier(optional)
Serial port & Others	2* RS232/422/485, 4*RS232(pin), 1*LPT(pin), 1*PS/2(pin)
DIO	8-bit DIO, Programmable TTL
Storage	
storage	4*SATA3, HDD/SSD
Others	
Control switch	Power SW, Reset
LED	1*power LED; 1*HDD LED; 3*CPU temp LED (Red is alarm, Yellow is high temperature, Green is normal temperature)
Watchdog timer	programmable via software 1 to 255 second

Expansion	
Expansion	1*PCIe3.0X16(X16)+ 3*PCIe3.0X4 (X2+X1+X1 or 1*PCIe3.0X4)+ 3* 32-bit PCI
Power Supply	
Input voltage	24-Pin ATX/8-Pin ATX 12V, Max. out put power: 280W
Environment	

Dimension (L*W*H) 305*244*37.58mm, PCB:1.6mm
Operating temp 0~60°C
Storage temp -40°C~85°C
Storage humidity 10~95%@40°C, No condensation
Certification/ EMC CE/FCC Class A

OS OC Windows 10 Enterprise & IOT Enterprise
Windows Server 2016 (Intel® Xeon® E)
Ubuntu, SuSe, Redhat Enterprise 1,2
Wind River VxWorks 7

Dimensions



Ordering Information

Model	Processor	Specifications
ATX-1971/S001	Intel® H420E+Cometlake-S LGA1151 CPU	2*LAN, 4*USB3.2, 5*USB2.0, 6*COM, 3*PCI, 8bit DIO, 1*LPT, 1*HDMI, 1*VGA, 1*Line out, 1*Mic, PS/2, 4*SATA3, Amplifier (Opt.), 24-pin ATX/8-pin ATX 12V

Accessories

Standard	*Optional
Serial ports cable	DB9 male,300mm
SATA cable	SATA 7pin data cable,420mm
I/O block slice	Full IO opening, 0.5mm stainless steel
Screw jumper	Two M2 screws +Two jumper caps (spare)
DIO cable	DB9 male,300mm
AuDIO cable	Three in a row (Line-out/Line-in/Mic) 3.5mm phone jack, 300mm
Parallel ports cable	DB25 female,300mm
USB2.0 cable	Two in a row Type A,300mm
PS/2 cable	Two in a row 6pin S-female,300mm
CPUradiator1	LGA115X, TDP 35-65W wind-cooling radiator
CPUradiator2	LGA115X, TDP 95W wind-cooling radiator
SATA cable	SATA 7pin data cable,420mm

ATX-1980

Intel® Q670 PCH+Alder lake-S CPU, 2*LAN,1*DP,1*HDMI,1*VGA,6*COM,6*USB3.2,7*USB2.0,4*SATA3.0,6*PCIe+1*PCI

Key Specification

- Intel 12th/13th Gen. Alder lake-S/Raptor Lake-S Core i9/i7/i5/i3/Pentium/Celeron CPU, LGA1700 Socket
- Intel Q670, high-performance chipsets
- Dual - channel 4*DDR4 3200MHz UDIMM, up to 128GB
- Intel UHD Graphic, 1*DP+1*HDMI+1*VGA, three independent displays
- 1*I219LM and 1*I226V, dual Gigabit network ports
- 6*USB3.2,7*USB2.0,6*COM,8bit DIO
- 2*PCIeX16(X8),1*PCI,4*PCIeX4 (3 for X4 ,
1 for X1) a total of seven slots, 1*M.2 2280 M-key
- 4*SATA3.0 6.0Gbps, support Raid0/1/10/5
- 24pin ATX +8pin 12V ATX power



Product Overview

ATX-1980 is an industrial motherboard powered by Intel Q670 chipset, supporting Intel®12th/13th Gen Core i9/i7/i5/i3/Pentium/Celeron CPU, designed according to the standard ATX motherboard specification and has seven PCIe and PCI extensions. It fits all 4U chassis and wall-mounted chassis on the market, and is suitable for machine vision, CNC machinery, digital medical and casino games and other fields.

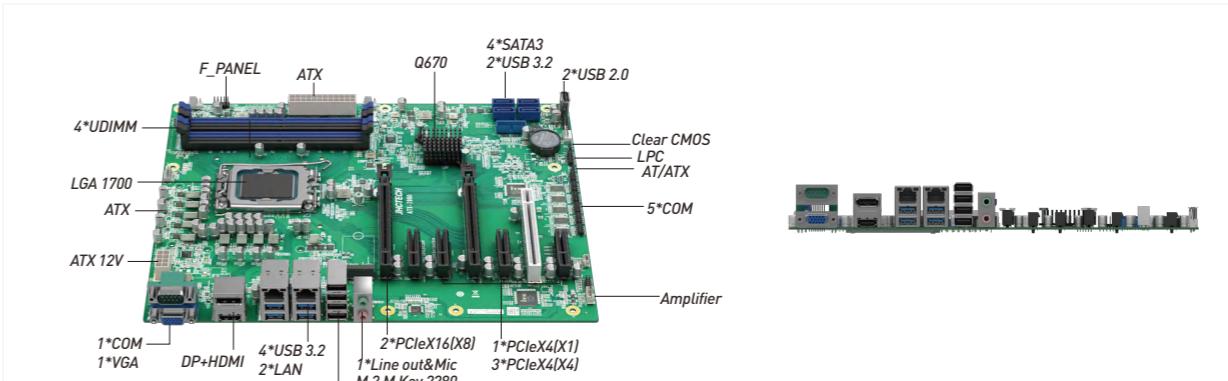
Product Parameters

System	
CPU	Intel 12th Gen. Alder lake-S Core i9/i7/i5/i3/Pentium/Celeron CPU,LGA1700 Socket,Q670 PCH, 125W max.
RAM	4*288-pin Non-ECC UDIMM , dual channel DDR4 3200MHz, 128GB max.
Graphics	Intel Xe 700 UHD Graphics , DirectX 12, OpenGL 4.5, OpenCL 2.1; HW Decode: AVC/H.264, MPEG2, VC1/WMV9, JPEG/MJPEG, HEVC/H265, VP8, VP9; HW Encode: MPEG2, AVC/H264, JPEG, HEVC/H265, VP8, VP9; DP:7680*4320@60Hz, HDMI:4096*2160@60Hz, VGA:1920*1200@60Hz
I/O	
LAN	1*Intel® I226V, 10M-2.5G, WOLRemote 1*Intel® I219LM, 10-1000M,iAMT13.0, vPro
USB	4*USB3.2(10G),4*USB2.0, 2*USB3.2(10G,pin),3*USB2.0(pin)
Display	1*DP+1*HDMI+1*VGA
Audio	1*Line out+1*Mic,Realtek ALC897; 1*Amplifier(Optional)
COM& Others	1* RS232/422/485(DB9),5*COM(pin)
DIO	8-bit DIO
Storage	4*SATA3.0, RAID0/1/10/5;

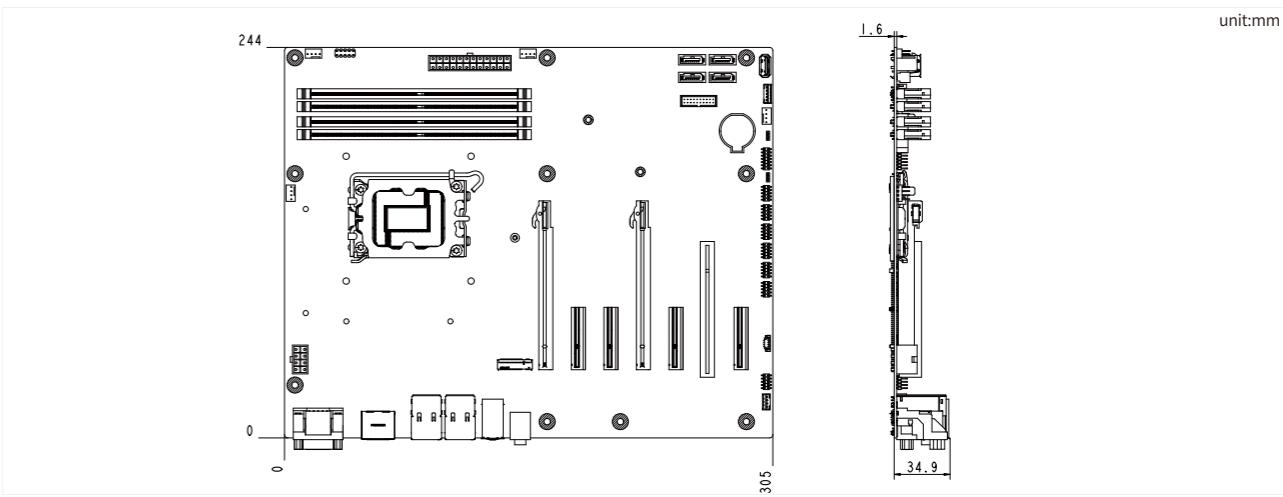
Others	
Switch	Power SW, Reset,USB Power, AT/ATX, Clear CMOS
LED	Power LED,HDD LED
WDT	programmable via software 1 to 255 second
TPM	Optional TPM 2.0
Expansion	
Expansion	2*PCIe5.0X16(X8)+2*PCIe4.0X4(X4)+2*PCIe3.0X4(X4+X1)+ 1* 32-bit PCI; 1*M.2 2280 M-Key (PCIe4.0X4)

Power	
Power& TDP	24-Pin ATX + 8-Pin ATX 12V; TDP: 110W (I7-12700K CPU/16G DDR4/128G SSD,non.AI Card)
Environment	
Dimension (W*L*H)	305*244*34.9mm; PCB:1.6mm
Operating Temp	0~60°C
Storage Temp	-40°C~85°C
Storage Temp	10~95%@40°C, No-condensation
Certificate/EMC	CE/FCC Class A
OS	
	Windows 10/11 IoT Enterprise (64-bit), Windows Server 2019, Ubuntu, SUSE, Redhat Enterprise, Wind River Linux,Yocto Project (64-bit),Wind River VxWorks 7

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
ATX-1980/S001	Intel® Q670+Alder lake-S LGA1700 CPU	2*LAN, 6*USB3.2, 7*USB2.0, 6*COM, 2*PCIe X16(X8), 4*PCIeX4(3*X4,1*X1), 1*PCI, 1*M.2 M-key, 1*HDMI, 1*DP, 1*VGA, 1*Line out&1*Mic, Amplifier(Optional), 8bit DIO, 4*SATA3, 24-pin ATX+8-pin ATX 12V

Accessories

Standard	*Optional
Serial ports cable	DB9 male,300mm
SATA cable	SATA 7pin data cable,420mm
I/O block slice	Full IO opening, 0.5mm stainless steel
Screw jumper	Two M2 screws +Two jumper caps (spare)
DIO cable	DB9 male,600mm
AuDIO cable	Three in a row (Line-out/Line-in/Mic) 3.5mm phone jack, 300mm
Serial ports cable	DB9 male,300mm
USB2.0 cable	Two in a row Type A,300mm
USB3.0 cable	Two in a row Type A,300mm
CPUradiator1	LGA1700, TDP 65W wind-cooling radiator
CPUradiator2	LGA115X, TDP 125W wind-cooling radiator
SATA cable	SATA 7pin data cable,420mm

PADR-M101

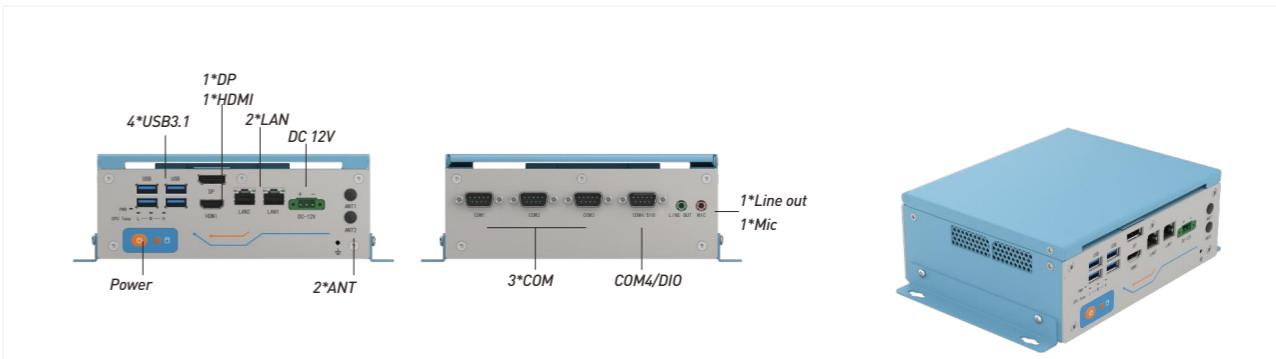
Intel® Whiskey lake U CPU,2-CH DDR4,1*HDMI,1*DP,2*LAN,4*USB3.1,4*COM,1*M.2 E-key,1*F-Mini PCIe,DC 12V/DC9-36V

Key Specification

- SGCC box design, 4-line temperature-controlled fan silent heat dissipation
- Intel® Core i3/i5/i7/Celeron CPU
- 2-Ch DDR4 2400MHz SODIMM, 32GB max.
- 1*HDMI,1*DP,dual 4K Display
- 1*Line out,1*Mic,4*USB3.1
- 2*GbE LAN,4*COM ,8-bit DIO(Optional)
- 1*M.2,2230 E-Key, 1*Mini-PCIe(+SIM),Optional mSATA
- 1*2.5"SATA bay for storage
- DC 12V,or DC 9~36V



I/O View



Product Overview

PADR-M101 is an embedded box computer, which adopts SGCC box structure design and has a built-in 4-wire debugging fan for silent cooling. Power by Intel® Whiskey lake U architecture, adopt 8th generation Intel® Core TM i3/i5/i7/Celeron U Series CPU, dual 4K display, rich IO interface. DC 12V or wide voltage DC 9-36V, small size, beautiful appearance, easy to manufacture, suitable for mobile portable terminals, advertising machines, AGV, medical analysis equipment and other application scenarios.

Product Parameters

System

CPU	Intel® Core i3/i5/i7/Celeron U
RAM	2*DDR4, 2400MHz, 32GB max.
Graphics	Intel® Gen. 9 UHD Graphics; HDMI:4096*2304@24Hz, DP:4096*2304@60Hz,2 independent Display
LAN	1*Intel I226V,10-1000M; 1*Intel I219LM, 10-1000M
USB	4*USB3.1 Gen1(5Gbps)
Display	1*DP+1*HDMI
Audio	1*Line out+1*Mic,Realtek ALC897
COM/others	2*RS232/422/485, 2*RS232;
DIO	1*8-bit DIO (Optional,DB9)

Storage

Storage	1*2.5" SATA,max.15mm thick HDD
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Others

LED	1*PowerLED, 1*HDD LED, 3*CPU Temp LED Red is alarm, Yellow is high temp, Green is normal temp
Switch	1*PowerSW
WDT	programmable via software 1 to 255 second

OS

OS	Windows 10, SUSE, Ubuntu, Wind River, Red Hat Enterprise
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Expansion

Expansion	1*Mini PCIe(+SIM),4G LTE/Wifi/BT,BIOS to mSATA;
	1*M.2 E-Key,Wifi/BT

Power

Power& TDP	DC 12V, or DC 9~36V; 27.87W (I7-8565U, 16GB DDR , 1*4T SSD)
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Mechanical

Structure	SGCC
Color	Silk Grey+Pastel Blue
Installation	desktop mounting
Dimension (W*H*D)	200*140*67.5mm
Weight	1.51KG

Environment

Operating Temp	0°C~50°C - Radiator with Fan,SSD;
Storage Temp	-40°C~85°C

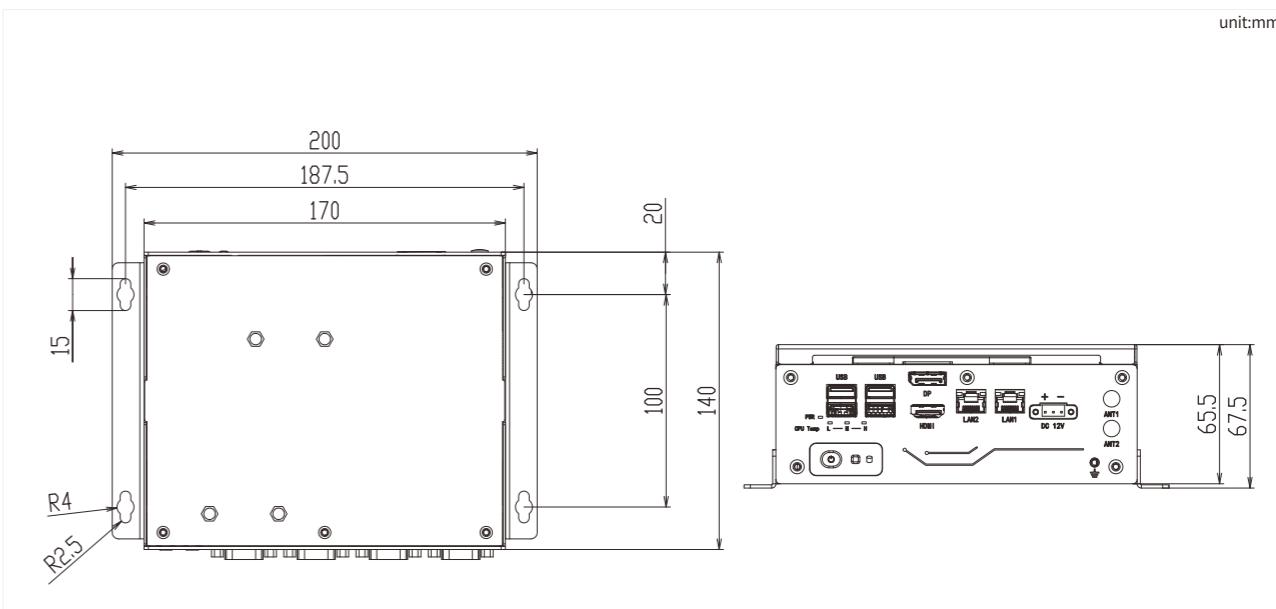
Storage Temp	10~95%@40°C, No-condensation
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Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)
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Shock	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
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Certificate	CE/FCC Class A
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Dimensions



Ordering Information

Model	Processor	Specifications
PADR-M101/S001	Intel® Core i3-8145U	DDR4 2*SO-DIMM,1*HDMI,1*DP,1*Line out&1*Mic, 2*LAN,4*USB3.1,4*COM,8-bit DIO(Optional),1*M.2 E key, 1*Mini PCIe/mSATA,1*2.5" SATA,DC 12V
PADR-M101/S002	Intel® Core i5-8265U	
PADR-M101/S003	Intel® Core i7-8565U	
PADR-M101/S004	Intel® Celeron 4305U	
PADR-M101/S001-WP	Intel® Core i3-8145U	DDR4 2*SO-DIMM,1*HDMI,1*DP,1*Line out&1*Mic, 2*LAN,4*USB3.1,4*COM,8-bit DIO(Optional),1*M.2 E key, 1*Mini PCIe/mSATA,1*2.5" SATA,DC 9-36V
PADR-M101/S002-WP	Intel® Core i5-8265U	
PADR-M101/S003-WP	Intel® Core i7-8565U	
PADR-M101/S004-WP	Intel® Celeron 4305U	
PA-60DC12		AC/DC adapter, DC 12V/5A 60W+X standard power cable

PADR-M102-718

Intel® Elkhart lake CPU, 1*DDR4, HDMI+DP, 2*LAN, 4*USB3.1, 3/4*COM, 1*DIO, 1*M.2 E-key / 1*M.2 B-key, 1*mSATA, 1*SATA3.0, DC 12V/DC 9-36V

Key Specification

- SGCC box design, 4-line temperature-controlled fan silent heat
- dissipation
- Intel® Elkhart lake Soc CPU
- 1*DDR4 3200MHz SODIMM, up to 32GB
- 1*HDMI, 1*DP, supports dual 4K display
- 1*Line out&Mic, 4*USB3.1
- 2*GbE LAN, 3/4*COM, 8-bit DIO
- 1*M.2 2230 E-Key / 1*M.2 3052 B-key with a SIM card slot
- 1*2.5 "SATA bay + 1*mSATA for storage
- DC 12V or DC 9-36V



Product Overview

PADR-M102-718 is an embedded box computer, which adopts SGCC box structure design and has a built-in 4-wire debugging fan for silent cooling. Power by Intel® Elkhart lake architecture, adopt Intel® Celeron series processor, dual 4K display, rich IO interface. DC 12V or wide voltage DC 9-36V, small size, beautiful appearance, easy to manufacture, suitable for mobile portable terminals, advertising machines, AGV, medical analysis equipment and other application scenarios.

Product Parameters

System

CPU Intel® Elkhart lake SoC CPU: Celeron J6412 2.0-2.6GHz 4C4T/
Celeron N6210 1.2-2.6GHz 2C2T

RAM 1*260 pin DDR4, 3200MHz, 32GB max.
Intel® Gen. 10 UHD Graphics;

Graphics HDMI:4096*2304@60Hz,
DP:4096*2160@60Hz, 2 independent Display

LAN 2*Realtek 8111H, 10-1000M, WOL

USB 4*USB3.1(5Gbps)

Display 1*DP+1*HDMI

Audio 1*Line out+1*Mic, Realtek ALC897

COM/others 2*RS232/422/485, 1*RS232;

DIO 1*8-bit DIO (Optional RS232)

Storage

Storage 1*2.5" SATA, max. 15mm thick HDD ; 1*mSATA

Others

LED 1*Power LED, 1*HDD LED, 3*CPU Temp LED
Red is alarm, Yellow is high temp, Green is normal temp

Switch 1*Power SW

WDT programmable via software 1 to 255 second

OS

OS Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux

Expansion

Expansion 1*M.2 2230 E-Key (PCIe X1/USB 2.0), WiFi5/BT5.0,
or 1*M.2 3052 B-Key (+SIM), 4G LTE/5G NR

Power

Power& TDP DC 12V(3-pin) or DC 9-36V;
TDP: TBD

Mechanical

Structure SGCC

Color Silk Grey+Pastel Blue

Installation desktop mounting

Dimension (W*H*D) 204*148*70mm

Weight 1.55KG

Environment

Operating Temp 0°C~50°C - Radiator with Fan, SSD;

Storage Temp -40°C~85°C

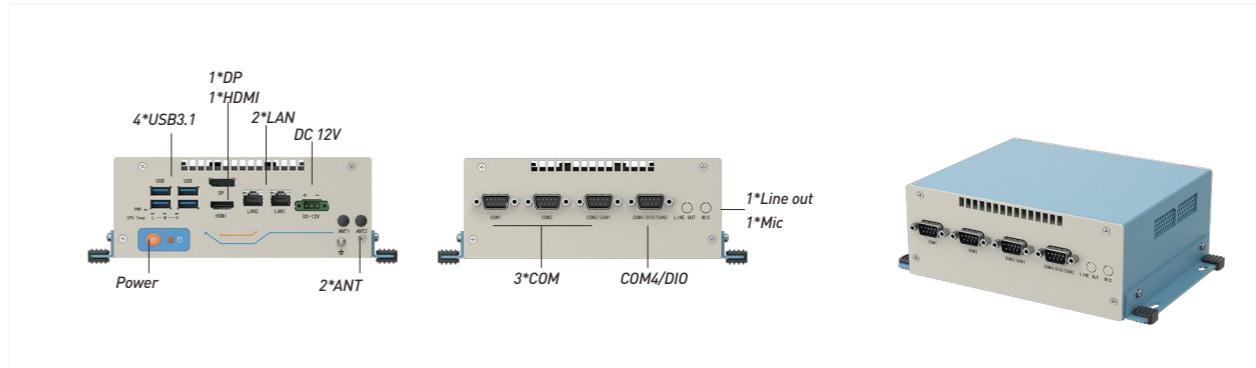
Storage Temp 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/operation(SSD);
1 grms/5~500Hz/random/operation(HDD)

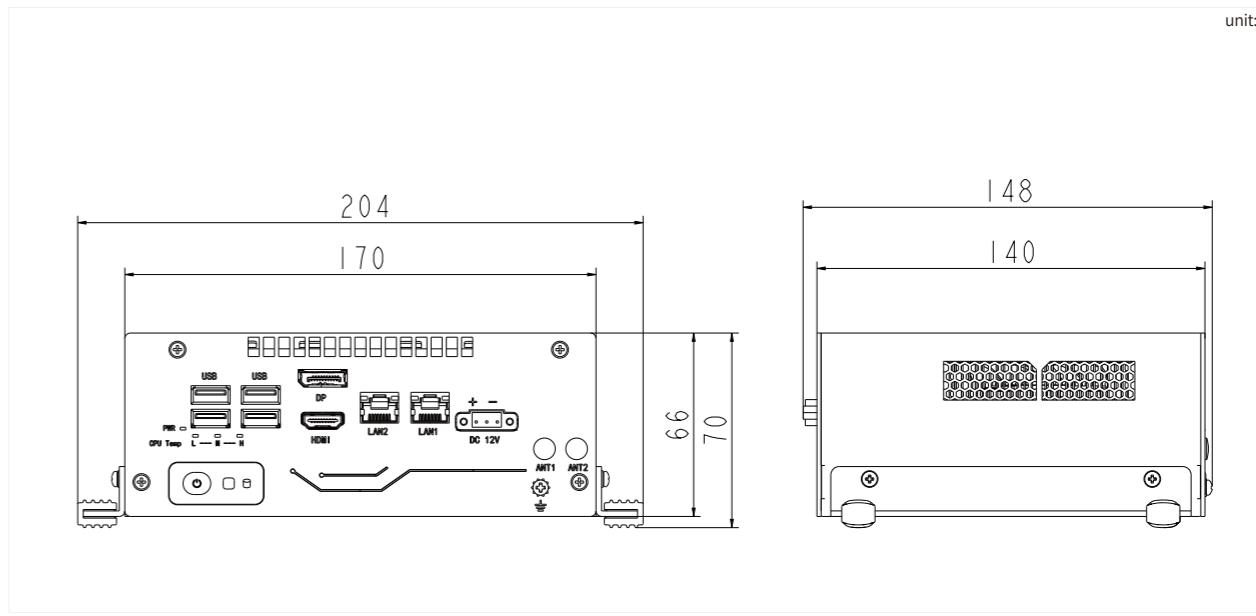
Shock 50g peak acceleration(duration 11ms, SSD);
20g peak acceleration(duration 11ms, HDD)

Certificate/EMC CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
PADR-M102-718/S001	Intel® Celeron J6412	1*DDR4 SO-DIMM, 1*HDMI, 1*DP, 1*Line out&Mic, 2*LAN, 4*USB3.1, 3/4*COM, 8-bit DIO, 1*M.2 E-key / 1*M.2 B-key (B or E-Key), 1*mSATA, 1*2.5"SATA, DC 12V
PADR-M102-718/S002	Intel® Celeron N6210	
PADR-M102-718/S001-WP	Intel® Celeron J6412	1*DDR4 SO-DIMM, 1*HDMI, 1*DP, 1*Line out&Mic, 2*LAN, 4*USB3.1, 3/4*COM, 8-bit DIO, 1*M.2 E-key / 1*M.2 B-key (B or E-Key), 1*mSATA, 1*2.5"SATA, DC 9-36V
PADR-M102-718/S002-WP	Intel® Celeron N6210	
PA-60DC12		AC/DC adapter, DC 12V/5A 60W+X standard power cable

PADR-M102-910

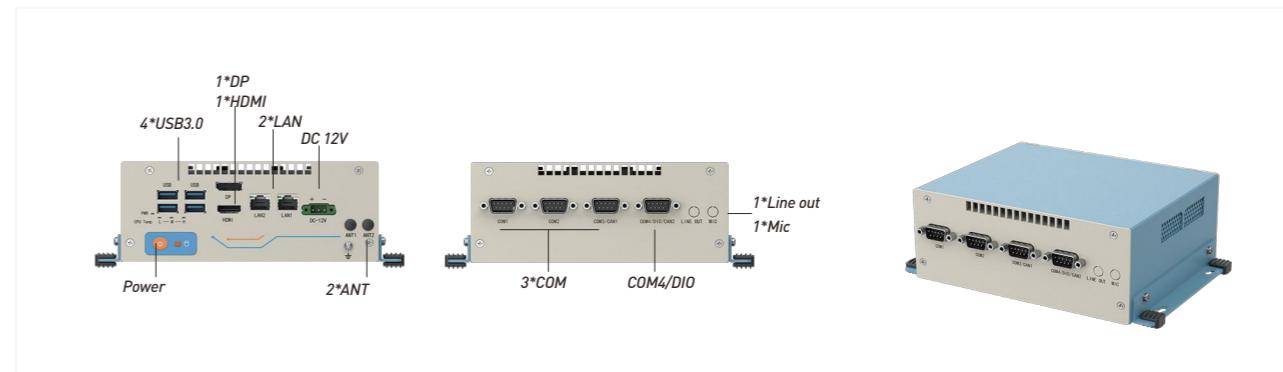
Intel® Whiskey lake U CPU,2-CH DDR4,HDMI+DP,2*LAN,4*USB3.0,3/4*COM,1*M.2 E-key,1*Mini PCIe,DC 12V/DC 9-36V

Key Specification

- SGCC box design, 4-line temperature-controlled fan silent heat dissipation
- Intel® Whiskey lake-U Core TM i3/i5/i7/Celeron series CPU
- 2-Ch DDR4 2400MHz SODIMM, up to 32GB
- 1*HDMI,1*DP,supports dual 4K display
- 1*Line out&Mic,4*USB3.0
- 2*GbE LAN,3/4*COM,8-bit DIO
- 1*M.2 2230 E-Key, 1*Mini-PCIe with a SIM card slot, optional mSATA
- 1*2.5 "SATA bay for storage
- DC 12V or DC 9-36V



I/O View



Product Overview

PADR-M102-910 is an embedded box computer, which adopts SGCC box structure design and has a built-in 4-wire debugging fan for silent cooling. Power by Intel® Whiskey lake U architecture, adopt 8th generation Intel® Core TM i3/i5/i7/Celeron U Series CPU, dual 4K display, rich IO interface. DC 12V or wide voltage DC 9-36V, small size, beautiful appearance, easy to manufacture, suitable for mobile portable terminals, advertising machines, AGV, medical analysis equipment and other application scenarios.

Product Parameters

System

CPU Intel® Whiskey lake-U CPU, Core i7-8565U 1.8-4.6 GHz, Core i5-8265U 1.6-3.9 GHz; Core i3-8145U 2.1-3.9 GHz; Celeron 4305U 2.2 GHz

RAM 2* DDR4, 2400MHz, 32GB max.

Graphics Intel® Gen. 9 UHD Graphics; HDMI:4096*2304@24Hz,

DP:4096*2304@60Hz,2 independent Display

LAN 1*Intel® I219LM,10-1000M,WOL;

1*Intel® I226V,10-1000M,WOL

USB 4*USB3.0(5Gbps)

Display 1*DP+1*HDMI

Audio 1*Line out+1*Mic,Realtek ALC897

COM/others 2*RS232/422/485, 1*RS232;

DIO 1*8-bit DIO (OptionalRS232)

Storage

Storage 1*2.5" SATA,15mm thick HDD

Others

LED 1*PowerLED, 1*HDD LED, 3*CPU Temp LED (Red is alarm, Yellow is high temp, Green is normal temp)

Switch 1*PowerSW

WDT programmable via software 1 to 255 second

OS

OS Windows 11, Windows 10, SUSE, Ubuntu, Wind River, Red Hat Enterprise

Expansion

Expansion 1*M.2 2230 E-Key(PCleX1/USB2.0),Wifi/BT; 1*Mini PCIe(+SIM),4G LTE/Wifi/BT/mSATA

Power

Power& TDP DC 12V(3-pin) or DC 9-36V; 27.87W (i7-8565U, 16GB DDR4, 1*4T SSD)

Mechanical

Structure SGCC

Color Silk Grey+Pastel Blue

Installation desktop mounting

Dimension (W*H*D) 204*148*70mm

Weight 1.55KG

Environment

Operating Temp 0°C~50°C – Radiator with Fan,SSD;

Storage Temp -40°C~85°C

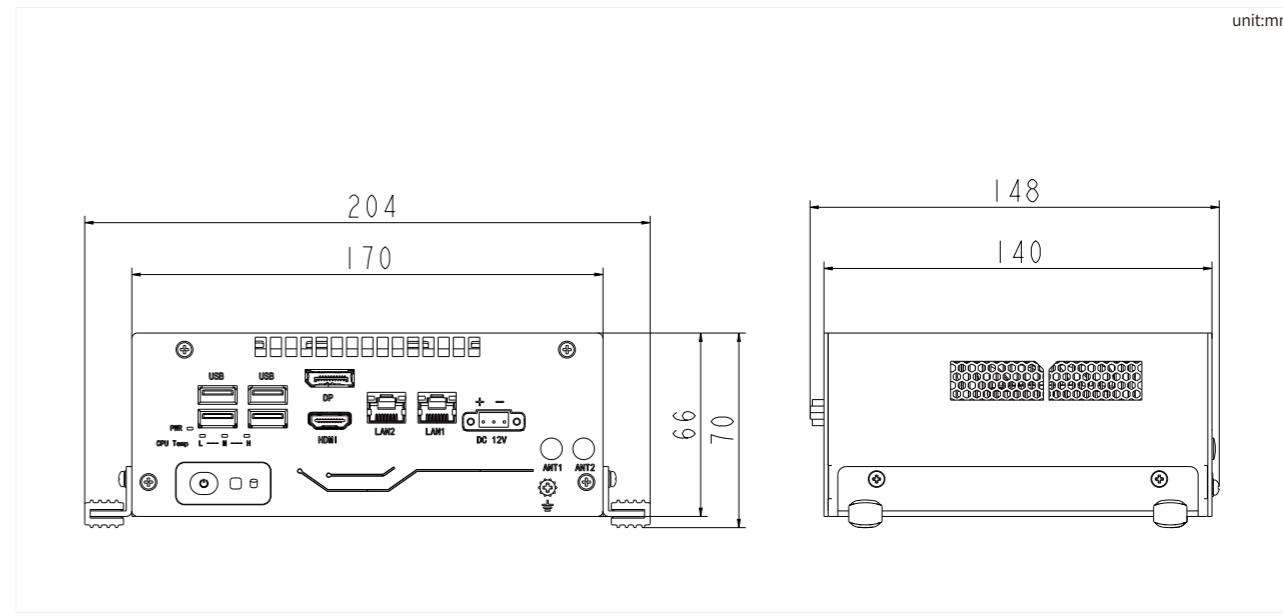
Storage Temp 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)

Shock 50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)

Certificate/EMC CE/FCC Class A

Dimensions



Ordering Information

Model	Processor	Specifications
PADR-M102-910/S001	Intel® Core i3-8145U	
PADR-M102-910/S002	Intel® Core i5-8265U	2*SO-DIMM,1*HDMI,1*DP,1*Line out&Mic,2*LAN,4*USB3.0,3/4*COM,8-bit DIO, 1*M.2 E-key,1*Mini PCIe/mSATA,1*2.5"SATA,DC 12V
PADR-M102-910/S003	Intel® Core i7-8565U	
PADR-M102-910/S004	Intel® Celeron 4305U	
PADR-M102-910/S001-WP	Intel® Core i3-8145U	
PADR-M102-910/S002-WP	Intel® Core i5-8265U	2*SO-DIMM,1*HDMI,1*DP,1*Line out&Mic,2*LAN,4*USB3.0,3/4*COM,8-bit DIO, 1*M.2 E-key,1*Mini PCIe/mSATA,1*2.5"SATA,DC 9-36V
PADR-M102-910/S003-WP	Intel® Core i7-8565U	
PADR-M102-910/S004-WP	Intel® Celeron 4305U	
PA-60DC12		AC/DC adapter, DC 12V/5A 60W+X standard power cable

PADR-M102-913

Intel® Tiger lake U CPU,2-CH DDR4,HDMI+DP,2*LAN,4*USB3.2,3/4*COM,1*M.2 E-key / 1*M.2 B-key,1*mSATA / 1*Mini-PCIe,DC 12V/DC 9-36V

Key Specification

- SGCC box design, 4-line temperature-controlled fan silent heat dissipation
- Intel® Tiger lake U Core TM i3/i5/i7/Celeron series CPU
- 2*DDR4 3200MHz SODIMM, up to 64GB
- 1*HDMI,1*DP,supports 4K+8K display
- 1*Line out&Mic,4*USB3.2
- 2*GbE LAN,3/4*COM,8-bit DIO
- 1*M.2 2230 E-Key / 1*M.2 3052 B-key(+SIM),1*Mini-PCIe(mSATA)
- 1*2.5 "SATA bay for storage
- DC 12V or DC 9-36V



Product Overview

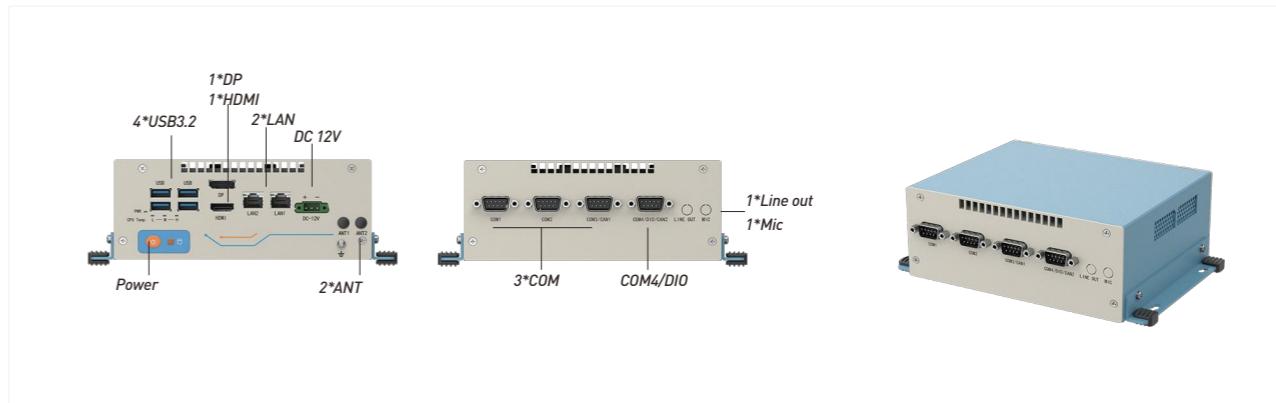
PADR-M102-913 is an embedded box computer, which adopts SGCC box structure design and has a built-in 4-wire debugging fan for silent cooling. Power by Intel® Tiger lake U architecture, adopt the 11th generation Intel® Core TM i3/i5/i7/Celeron series CPU, 4K+8K display, rich IO interface. DC 12V or wide voltage DC 9-36V, small size, beautiful appearance, easy to manufacture, suitable for mobile portable terminals, advertising machines, AGV, medical analysis equipment and other application scenarios.

Product Parameters

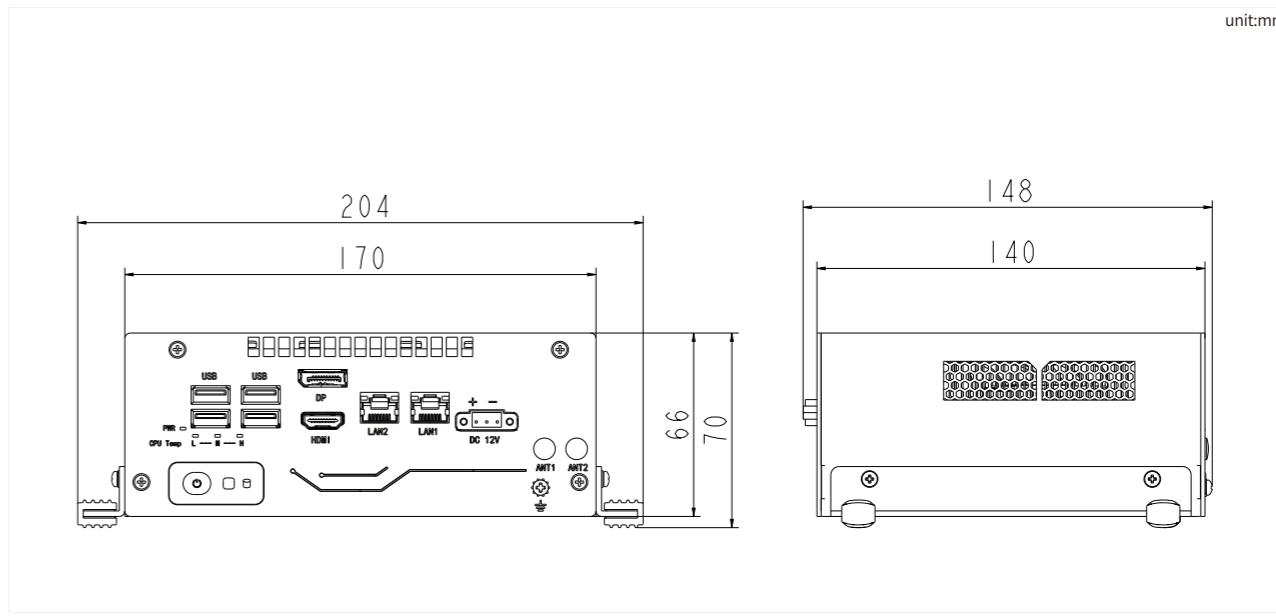
System	
CPU	Intel® Tiger lake U Soc CPU, core i3-1115G4/i5-1135G7/i7-1165G7, Celeron 6305, TDP 12W/15W/28W
RAM	2*DDR4, 3200MHz, 64GB max.
Graphics	Intel UHD Graphics/Xe Graphics, Supports Intel DL boost, DirectX 12.1,OpenGL 4.6 and OpenCL 3.0; HDMI:4096*2304@60Hz,DP:7680*4320@60Hz,2 independent Display
LAN	1*Intel® I219LM,10-1000M,WOL,iAMT13.0 1*Intel® I226V,10-1000M,WOL
USB	4*USB3.2(5Gbps)
Display	1*DP+1*HDMI
Audio	1*Line out+1*Mic,Realtek ALC897
COM/others	2*RS232/422/485, 1*RS232;
DIO	1*8-bit DIO (OptionalRS232)
Storage	
Storage	1*2.5" SATA,max.15mm thick HDD ; 1*mSATA(Optional)
Others	
LED	1*PowerLED, 1*HDD LED, 3*CPU Temp LED Red is alarm, Yellow is high temp, Green is normal temp)
Switch	1*PowerSW
WDT	programmable via software 1 to 255 second
OS	
OS	Windows 10/Windows 11 64 bit, SUSE, Ubuntu, Wind River, Linux

Expansion	
Expansion	1*Mini PCIe(PCIeX1),PCIe module/mSATA;
	1*M.2 2230 E-Key(PCIeX1/USB2.0),WiFi5/BT5.0, or 1*M.2 3052 B-Key(+SIM),4G LTE/5G NR;
Power	
Power& TDP	DC 12V(3-pin) or DC 9-36V; TDP: TBD
Mechanical	
Structure	SGCC
Color	Silk Grey+Pastel Blue
Installation Dimension (W*H*D)	desktop mounting 204*148*70mm
Weight	1.55KG
Environment	
Operating Temp	0°C~50°C – Radiator with Fan,SSD;
Storage Temp	-40°C~85°C
Storage Temp	10~95%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)
Shock	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Certificate/EMC	CE/FCC Class A

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications
PADR-M102-913/S001	Intel® Core i3-1115G4	DDR4 2*SO-DIMM,1*HDMI,1*DP,1*Line out&Mic,2*LAN,4*USB3.2,3/4*COM,8-bit DIO, 1*M.2 E-key/1*M.2 B-key(B or E-Key),1*Mini PCIe/mSATA,1*2.5"SATA,DC 12V
PADR-M102-913/S002	Intel® Core i5-1135G7	
PADR-M102-913/S003	Intel® Core i7-1165G7	
PADR-M102-913/S004	Intel® Celeron 6305	
PADR-M102-913/S001-WP	Intel® Core i3-1115G4	DDR4 2*SO-DIMM,1*HDMI,1*DP,1*Line out&Mic,2*LAN,4*USB3.2,3/4*COM,8-bit DIO, 1*M.2 E-key/1*M.2 B-key(B or E-Key),1*Mini PCIe/mSATA,1*2.5"SATA,DC 9-36V
PADR-M102-913/S002-WP	Intel® Core i5-1135G7	
PADR-M102-913/S003-WP	Intel® Core i7-1165G7	
PADR-M102-913/S004-WP	Intel® Celeron 6305	
PA-60DC12		AC/DC adapter, DC 12V/5A 60W+X standard power cable

PADR-S501-953

Intel® SKL/KBL-S CPU, 2xLAN, VGA+HDMI+DVI, 3xCOM, 4xUSB3.0, 5xUSB2.0, 4xPCIe/PCI, 4xSATA Bay, 4U rackmount, ATX power

Key Specification

- Intel gen 6/7th SKL/KBL-S LGA1151 CPU+H110 PCH
- Dual channel 2xDDR4 2133/2400MHz UDIMM, up to 32GB
- Intel 9th HD Graphic, VGA+HDMI+DVI-D 3 display
- 1xI219LM Gig. Ethernet+1xI211AT Gig. Ethernet
- 4xUSB3.0, 5xUSB2.0 (two front and one built-in), Audio out and Mic
- 2xRS232/422/485, 1xRS232, optional 1xLPT or 8 bit DIO
- 1xPCIeX16+1xPCI+2xPCIeX4, 1xFull size Mini PCIe
- 4x3.5 "SATA3.0 shock resistant and anti-vibration hard disk bay
- Standard 19"4U rackmount chassis with high efficiency air cooling design
- Standard PS2 ATX power supply, 300/500/750W



Product Overview

PADR-S501-953 is a standard 19"4U rackmount industrial computer with an Intel H110 chipset powered by Intel® gen 6/7th SKL/KBL-S LGA1151 series CPU. Rich functional IO, 4 PCIe/PCI expansion capabilities, excellent air cooling design, power consumption ladder ATX power supply selection, suitable for machine vision, CNC machine tools and factory production line automation and other fields.

Product Parameters

System

CPU Intel 6/7th Gen. SKL/KBL-S Core i7/i5/i3/Pentium/Celeron LGA1151 CPU, 91W, H110 chipset

RAM 2*288-pin Non-ECC UDIMM, dual channel DDR4 2400MHz, 32GB max. Intel HD Graphics, Supports DirectX 12, OpenGL 4.5

Graphics AVC/VC1/MPEG2/HEVC/VP8/JPEG.HW
HDMI:4096x2304@24Hz,VGA:1920x1200@60Hz,
DVI-D:1920*1200@60Hz

LAN 1*Intel I211AT/120AT, 10-1000M, WOLRemote
1*Intel I219LM, 10-1000M, WOLRemote

USB 4*USB3.0(5Gbps), 5*USB2.0

Display 1*HDMI+1*VGA+1*DVI-D

Audio 1*Line out+1*Mic, Realtek ALC897

COM/others 2*RS232/422/485, 1*RS232; Optional 1*LPT

DIO 1*8-bit DIO (Optional)

Storage

Storage 4xSATA3, 6.0Gbps interface, the box is designed with 4x3.5" and 2x2.5" a set of anti-vibration hard disk bay, 1 ultrathin DVD driver bay

Others

LED Power LED, HDD LED

Switch 1*Power SW, USB Power, AT/ATX, Clear CMOS,

WDT programmable via software 1 to 255 second

OS

OS Windows 7(SKL-S32bit &64bit, KBL-S64bit),
Windows 10, Linux

Expansion

Expansion 1*PCIe3.0 X16(X16) + 2*PCIe2.0 X4(X1) + 1*32 bit PCI;
1*Full size Mini PCIe(X1)

Power

Power&TDP AC100-240V, Standard ATX Power 300W, Optional 500W or 750W;
TBD

Mechanical

Structure Door with lock design, SGCC steel plate, metal mold molding

Cooling Linear airflow, 12025 ball bearing fan, optional 2*8025 ball bearing fan

Color Granite grey

Installation Dimension (W*H*D) Mounted on 19" rack, optional mounting rail set
430*470*173mm

Weight 14 KG

Environment

Operating Temp 0°C~50°C

Storage Temp -40°C~85°C

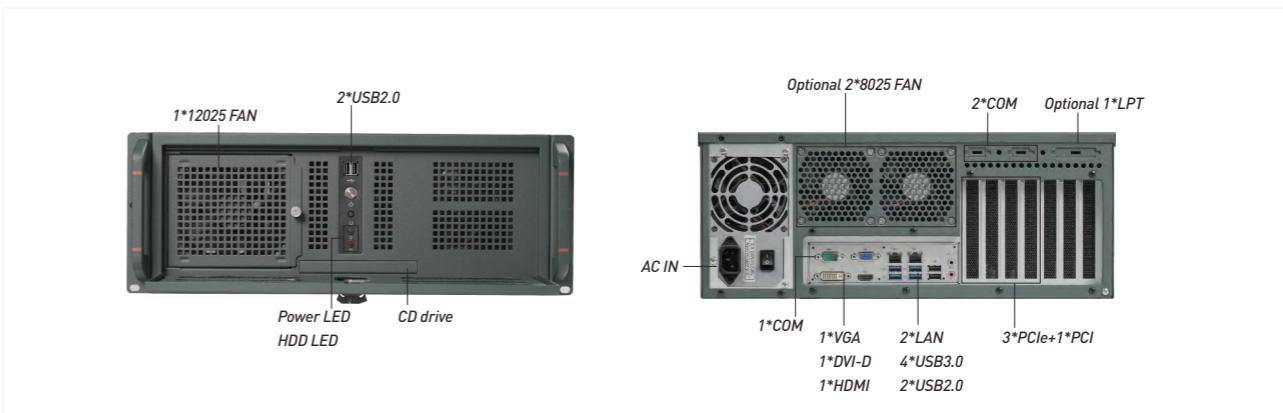
Storage Temp 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/operation(SSD);
1 grms/5~500Hz/random/operation(HDD)

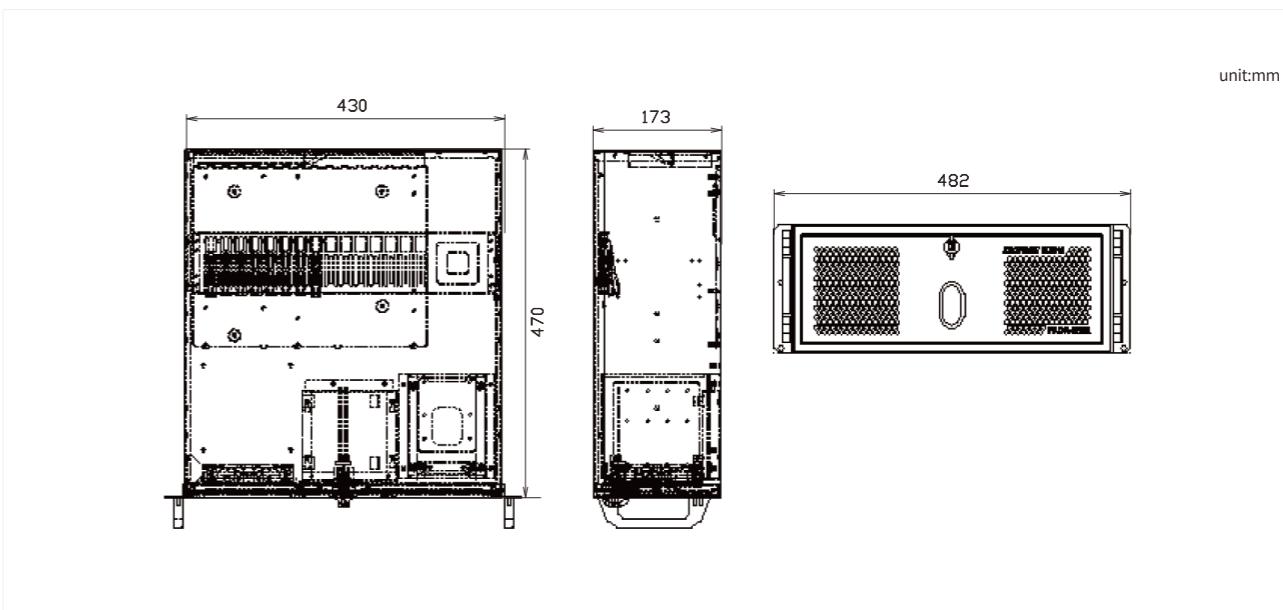
Shock 50g peak acceleration(duration 11ms, SSD);
20g peak acceleration(duration 11ms, HDD)

Certificate/EMC CE/FCC Class A, 3C

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Power
PADR-S501/953-300	Intel® Skylake-S/Kabylake-S LGA1151 CPU, H110 PCH	2xDDR4 UDIMM, 2xLAN, 4xUSB3.0, 5xUSB2.0, 3xCOM, 1xPCIe X16, 2xPCIe X4(X1), 1x32bit PCI, 1xMini PCIe, 1xHDMI, 1xVGA, 1xDVI-D, 1xLine out & 1xMic, 4x3.5"SATA	AC 220-230V, ATX 300W
PADR-S501/953-500			AC 100-240V, ATX 500W
PADR-S501/953-750			AC 100-240V, ATX 750W

Accessories

Standard	Amount	Optional	Optional
Screw jumper package		LGA115X, TDP 35-65W CPU wind-cooling radiator	A pair of guide rail mounting parts
Air Filter	1	LGA115X, TDP 95W CPU wind cooling radiator	8025 Dual ball bearing DC 12V fans
AC power supply cable		one 4pin to 2+6pin GPU power cable	DB25 female head parallel port cable
		SATA 7pin data cable, 420mm	DB9 male needle DIO cable

PADR-S501-961

Intel® Coffee lake-R CPU, 3xLAN, 2xDP+1xHDMI, 2xCOM, 4xUSB3.1, 7xUSB2.0, 4xPCIe, 4xSATA Bay, 4U rackmount, ATX power

Key Specification

- Intel gen 8/9th Coffee lake-R LGA1151 CPU+Q370 PCH
- Dual channel 4xDDR4 2666/2400MHz DIMM, up to 128GB
- Intel UHD Graphic, 2xDP+1xHDMI three independent display
- 1xI219LM Gig. Ethernet+2xI210AT Gig. Ethernet
- 4xUSB3.1, 7xUSB2.0 (two front and one built-in), Audio out and Mic
- 2xRS232/422/485, 8 bit DIO
- 1xPCIeX16 or 2xPCIeX8+2xPCIeX4
- 1xMini PCIe with a SIM card slot, 1xM.2 2280 M-Key
- 4x3.5 "SATA3.0 shock resistant and anti-vibration hard disk bay
- Standard 19"4U rackmount chassis with high efficiency air cooling design
- Standard PS2 ATX power supply,300/500/750/1000W



Product Overview

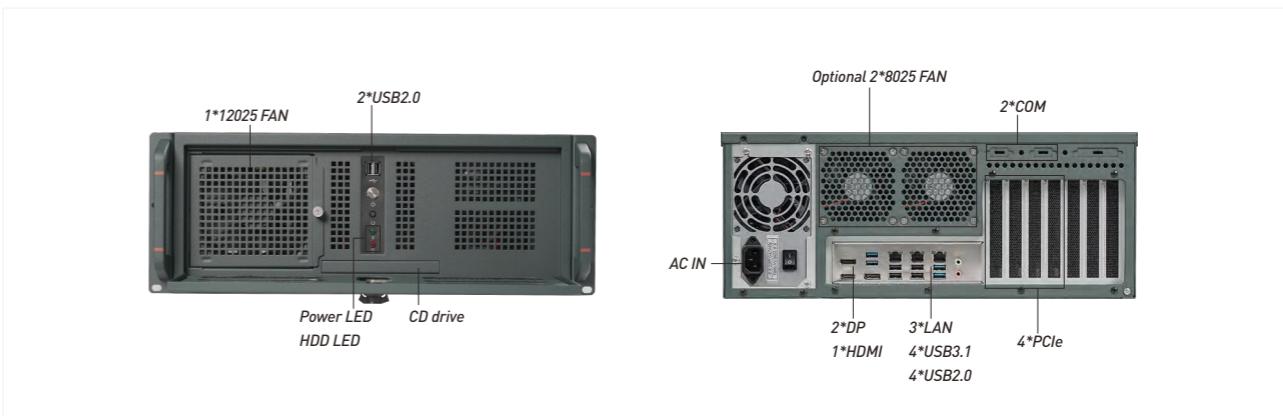
PADR-S501-961 is a standard 19"4U rackmount industrial computer with an Intel Q370 chipset powered by Intel® gen 8/9th Coffee lake-R LGA1151 series CPU. Rich functional IO, 4 PCIe expansion capabilities, excellent air cooling design, power consumption ladder ATX power supply selection, suitable for machine vision, CNC machine tools and factory production line automation and other fields.

Product Parameters

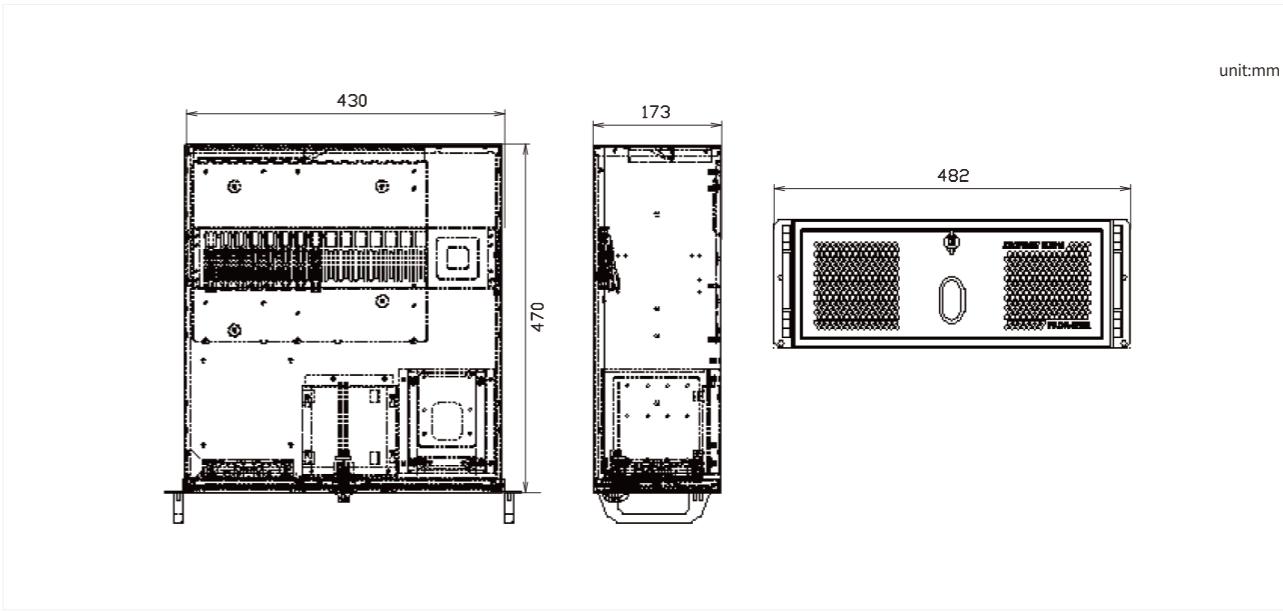
System	
CPU	Intel® 8/9th Gen. Coffee-S Core i9/i7/i5/i3 LGA1151 CPU, 最高95W,Q370chipset
RAM	4*288-pin Non-ECC UDIMM , dual channelDDR4 2400/2666MHz, 128GB max. Intel UHD Graphics, Supports DirectX 12, OpenGL 4.5;
Graphics	HDMI:4096x2304@24Hz, DP:4096*2304@60Hz,3 independent display
LAN	2*Intel I210AT/I211AT,10-1000M,WOLRemote 1*Intel I219LM,10-1000M,WOL/AMT12.0/iVpro
USB	4*USB3.1 Gen2(10Gbps),7*USB2.0
Display	2*DP+1*HDMI
Audio	1*Line out+1*Mic,Realtek ALC662VD
COM/others	2*RS232/422/485; 1*PS/2
DIO	1*8-bit DIO (Optional)
Storage	
Storage	4xSATA3, 6.0Gbps interface, the box is designed with 4x3.5 " and 2x2.5" a set of anti-vibration hard disk bay, 1 ultrathin DVD driver bay
Others	
LED	Power LED,HDD LED
Switch	1*Power SW, USB Power , AT/ATX , Clear CMOS ,
WDT	programmable via software 1 to 255 second
OS	
OS	Windows 10 Enterprise & IOT Enterprise(64 bit)(CFL-R) Windows Server 2016 (Intel® Xeon® E) Ubuntu,SuSe, Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R) Wind River VxWorks 7 (CFL-R)

Expansion	
Expansion	2*PCIe3.0 X16(1*X16 or 2*X8)+2*PCIe3.0 X8(X4)+1*32 bit PCI; 1*Full size Mini PCIe(X1/USB+SIM); 1*M.2 2280 M-key(PCIe3.0 X4)
Power	
Power& TDP	AC100-240V,StandardATXPower300W,Optional500W/750W/1000W; TDP:TBD
Mechanical	
Structure	Door with lock design, SGCC steel plate, metal mold molding
Cooling	Linear airflow, front 12025 fan, optional 2*8025 ball bearing fan
Color	Granite grey
Installation Dimension (W*H*D)	430*470*173mm
Weight	14 KG
Environment	
Operating Temp	0°C~50°C
Storage Temp	-40°C~85°C
Storage Temp	10~95%@40°C, No-condensation
Vibration	5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)
Shock	50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)
Certificate/EMC	CE/FCC Class A ,3C

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Power
PADR-S501/961-300			AC 220-230V,ATX 300W
PADR-S501/961-500	Intel® Coffee lake-R LGA1151 CPU,Q370 PCH	4xDDR4 DIMM, 3xLAN, 4xUSB3.1, 7xUSB2.0, 2xCOM, 1xMini PCIe, 1xM.2 2280 M-Key, 1xPCIe X16 (or 2xPCIeX8), 2xPCIeX4, 1xHDMI, 2xDP, 1xLine out & 1xMic, 4x3.5"SATA	AC 100-240V,ATX 500W
PADR-S501/961-750			AC 100-240V,ATX 750W
PADR-S501/961-1000			AC 100-240V,ATX 1000W

Accessories

Standard	Amount	Optional
Screw jumper package		LGA115X, TDP 35-65W CPU wind-cooling radiator
Air Filter	1	LGA115X, TDP 95W CPU wind cooling radiator
AC power supply cable		one 4pin to 2+6pin GPU power cable
		SATA 7pin data cable,420mm
		DB9 male needle DIO cable

PADR-S501-964

Intel® Coffee lake-S CPU, 2xLAN, VGA+HDMI+DVI, 3xCOM, 4xUSB3.1, 5xUSB2.0, 4xPCIe/PCI, 4xSATA Bay, 4U rackmount, ATX power

Key Specification

- Intel gen 8/9th Coffee lake-S LGA1151 CPU+H310 PCH
- Dual channel 2xDDR4 2666MHz UDIMM, up to 64GB
- VGA+HDMI/ VGA +DVI-D/ HDMI+ DVI-D 2 independent display
- 1xI219LM Gig. Ethernet+1xI226V Gig. Ethernet
- 4xUSB3.1, 5xUSB2.0 (two front and two built-in), Audio out and Mic
- 2xRS232/422/485, 1xRS232, optional 1xLPT or 8 bit DIO
- 1xPCIeX16+1xPCI+2xPCIeX4, 1*M.2 2242/2280 M-Key
- 4x3.5 "SATA3.0 shock resistant and anti-vibration hard disk bay
- Standard 19"4U rackmount chassis with high efficiency air cooling design
- Standard PS2 ATX power supply, 300/500/750W



Product Overview

PADR-S501-964 is a standard 19"4U rackmount industrial computer with an Intel H310 chipset powered by Intel® gen 8/9th Coffee lake-S LGA1151 series CPU. Rich functional IO, 4 PCIe/PCI expansion capabilities, excellent air cooling design, power consumption ladder ATX power supply selection, suitable for machine vision, CNC machine tools and factory production line automation and other fields.

Product Parameters

System

CPU Intel 8/9th Gen. Coffee lake-S Core i9/i7/i5/i3/Pentium/Celeron LGA1151 CPU, 95W, H310 chipset

RAM 2*288-pin Non-ECC UDIMM , dual channel DDR4 2666MHz, 64GB max. Intel UHD Graphics, Supports DirectX 12, OpenGL 4.5,

Graphics HDMI:4096x2304@24Hz,VGA:1920x1200@60Hz, DVI-D:1920*1200@60Hz; 2 independent Display

LAN 1*Intel I226V, 10M-2.5G, WOL; 1*Intel I219LM, 10-1000M, WOL

USB 4*USB3.1 Gen1(5Gbps), 5*USB2.0

Display 1*HDMI+1*VGA+1*DVI-D

Audio 1*Line out+1*Mic, Realtek ALC897

COM/others 2*RS232/422/485, 1*RS232; Optional 1*LPT

DIO 1*8-bit DIO (Optional)

Storage

Storage 4xSATA3, 6.0Gbps interface, the box is designed with 4x3.5 "and 2x2.5 " a set of anti-vibration hard disk bay, 1 ultrathin DVD driver bay

Others

LED Power LED, HDD LED

Switch 1*Power SW, USB Power, AT/ATX, Clear CMOS,

WDT programmable via software 1 to 255 second

OS

OS Windows7, Windows 10 Enterprise & IOT Enterprise (64 bit)(CFL-R); Windows Server 2016 (Intel® Xeon® E), Ubuntu, SuSe, Redhat Enterprise 1,2 (Kernel 4.14) (CFL-R), Wind River, VxWorks 7 (CFL-R)

Expansion

Expansion 1*PCIe3.0 X16(X16) + 2*PCIe2.0 X4(X1) + 1*32 bit PCI; 1*M.2 2280 M-key(PCIe2.0 X2)

Power

Power& TDP AC100-240V, Standard ATX Power 300W, Optional 500W/750W; TDP: 197.8W (i7-9900K CPU/16G DDR4/256G SSD)

Mechanical

Structure Door with lock design, SGCC steel plate, metal mold molding

Cooling Linear airflow, front 12025 fan, optional 2*8025 ball bearing fan

Color Granite grey

Installation Dimension (W*H*D) Mounted on 19" rack, optional mounting rail set 430*470*173mm

Weight 14 KG

Environment

Operating Temp 0°C~50°C

Storage Temp -40°C~85°C

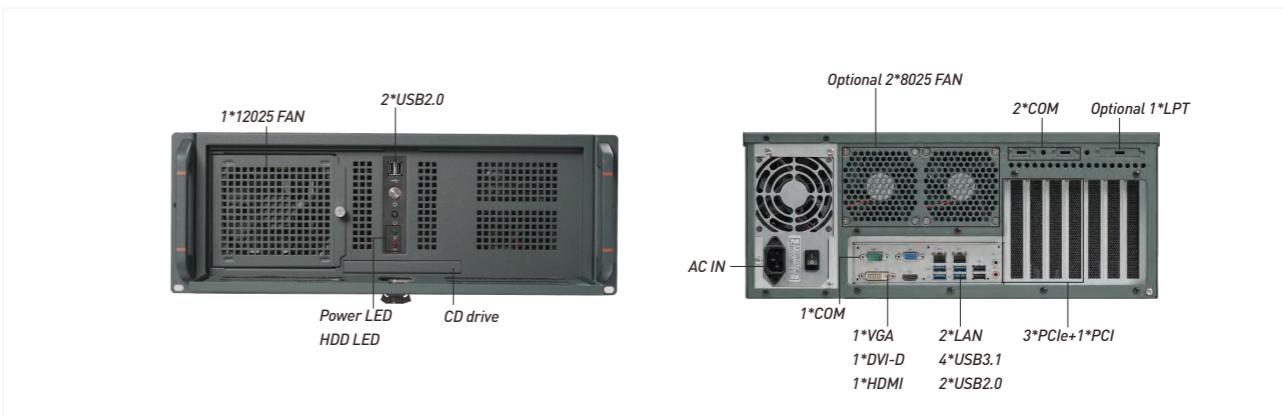
Storage Temp 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/operation(SSD); 1 grms/5~500Hz/random/operation(HDD)

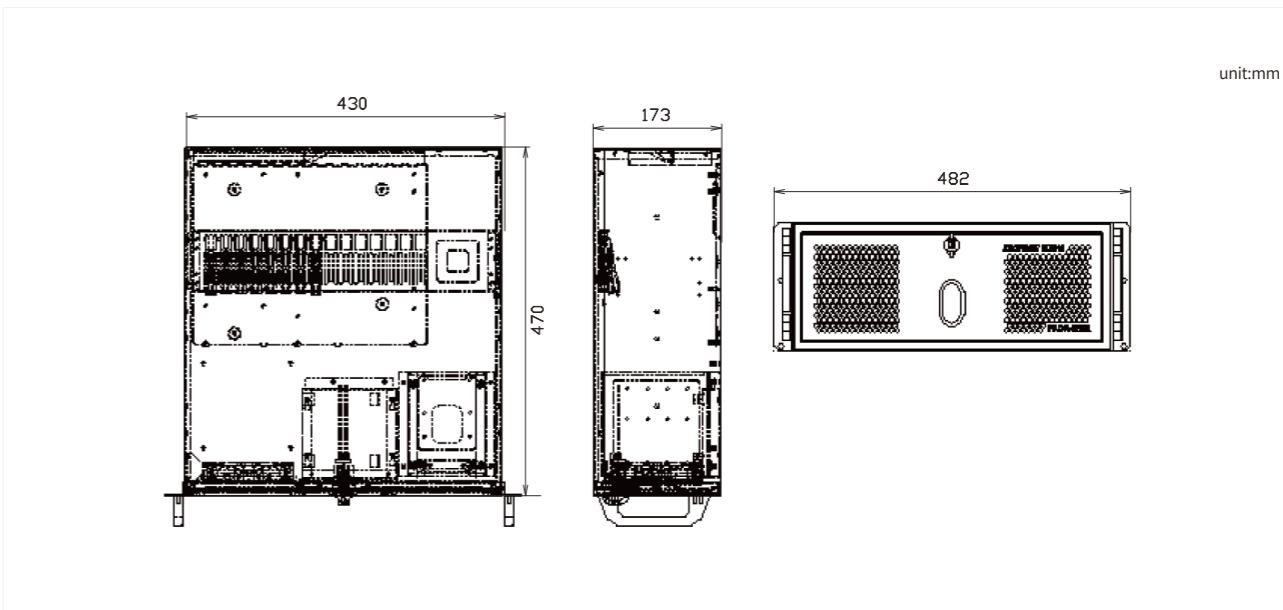
Shock 50g peak acceleration(duration 11ms,SSD); 20g peak acceleration(duration 11ms,HDD)

Certificate/EMC CE/FCC Class A, 3C

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Power
PADR-S501/964-300	Intel® Coffee lake-S LGA1151 CPU, H310 PCH	2xDDR4 UDIMM, 2xLAN, 4xUSB3.1, 5xUSB2.0, 3xCOM, 1xPCIe X16, 2xPCIe X4(X1), 1x32bit PCI, 1xM.2 M-Key, 1xHDMI, 1xVGA, 1xDVI-D, 1xLine out & 1xMic, 4x3.5"SATA	AC 220-230V, ATX 300W
PADR-S501/964-500			AC 100-240V, ATX 500W
PADR-S501/964-750			AC 100-240V, ATX 750W

Accessories

Standard	Amount	Optional	Optional
Screw jumper package		LGA115X, TDP 35-65W CPU wind-cooling radiator	A pair of guide rail mounting parts
Air Filter	1	LGA115X, TDP 95W CPU wind cooling radiator	8025 Dual ball bearing DC 12V fans
AC power supply cable		one 4pin to 2+6pin GPU power cable	DB25 female head parallel port cable
		SATA 7pin data cable, 420mm	DB9 male needle DIO cable

PADR-S501-971

Intel® Comet lake-S CPU, 2xLAN, VGA+HDMI, 4xCOM, 4xUSB3.2, 5xUSB2.0, 7xPCIe/PCI, 4xSATA Bay, 4U rackmount, ATX power

Key Specification

- Intel gen 10th Cometlake-S LGA1200 CPU+H420E PCH
- Dual channel 2xDDR4 2933MHz DIMM, up to 64GB
- Intel UHD Graphic, 1xVGA+1xHDMI dual independent display
- 1xI219LM Gig. Ethernet+1xI226V 2.5Gig. Ethernet
- 4xUSB3.2, 5xUSB2.0 (two front and one built-in), Audio out and Mic
- 2xRS232/422/485, 2xRS232, optional 1xLPT or 8 bit DIO
- 1xPCIeX16+3xPCI+3xPCIeX4
- 4x3.5 "SATA3.0 shock resistant and anti-vibration hard disk bay
- Standard 19"4U rackmount chassis with high efficiency air cooling design
- Standard PS2 ATX power supply, 300/500/750W



Product Overview

PADR-S501-971 is a standard 19"4U rackmount industrial computer with an Intel H420E chipset powered by Intel® gen 10th Comet lake-S LGA1200 series CPU. Rich functional IO, 7 PCIe/PCI expansion capabilities, excellent air cooling design, power consumption ladder ATX power supply selection, suitable for machine vision, CNC machine tools and factory production line automation and other fields.

Product Parameters

System

CPU Intel 10th Gen. Cometlake-S Core i9/i7/i5/i3/Pentium/Celeron LGA1200 CPU, 125W, H420E chipset

RAM 2*288-pin Non-ECC UDIMM , dual channel DDR4 2933MHz, 64GB max. Intel UHD Graphics, Supports DirectX 12, OpenGL 4.5

Graphics AVC/VC1/MPEG2/HEVC/VP8/JPEG.HW
HDMI:4096x2160@30Hz,VGA:1920x1200@60Hz,

LAN 1*Intel I226V, 10M-2.5G, WOL;
1*Intel I219LM, 10-1000M, WOL

USB 4*USB3.2 Gen1(5Gbps), 5*USB2.0

Display 1*HDMI+1*VGA

Audio 1*Line out+1*Mic, Realtek ALC897

COM/others 2*RS232/422/485, 2*RS232; Optional 1*LPT

DIO 1*8-bit DIO (Optional)

Storage

Storage 4xSATA3, 6.0Gbps interface, the box is designed with 4x3.5 "and 2x2.5" a set of anti-vibration hard disk bay, 1 ultrathin DVD driver bay

Others

LED Power LED, HDD LED

Switch 1*Power SW, USB Power, AT/ATX, Clear CMOS,

WDT programmable via software 1 to 255 second

OS

OS Windows 10, Windows 11, Linux Ubuntu

Expansion

Expansion 1*PCIe3.0 X16(X16) +
3*PCIe3.0 X4(X2+1+1 or X4) + 3*32 bit PCI

Power

Power&TDP AC100-240V, Standard ATX Power 300W, Optional 500W/750W;
TDP: 184.85W(I7-10700K CPU/16G DDR4/256G SSD)

Mechanical

Structure Door with lock design, SGCC steel plate, metal mold molding

Cooling Linear airflow, front 12025 fan, optional 2*8025 ball bearing fan

Color Granite grey

Installation Dimension (W*H*D) Mounted on 19"rack, optional mounting rail set
430*470*173mm

Weight 14 KG

Environment

Operating Temp 0°C~50°C

Storage Temp -40°C~85°C

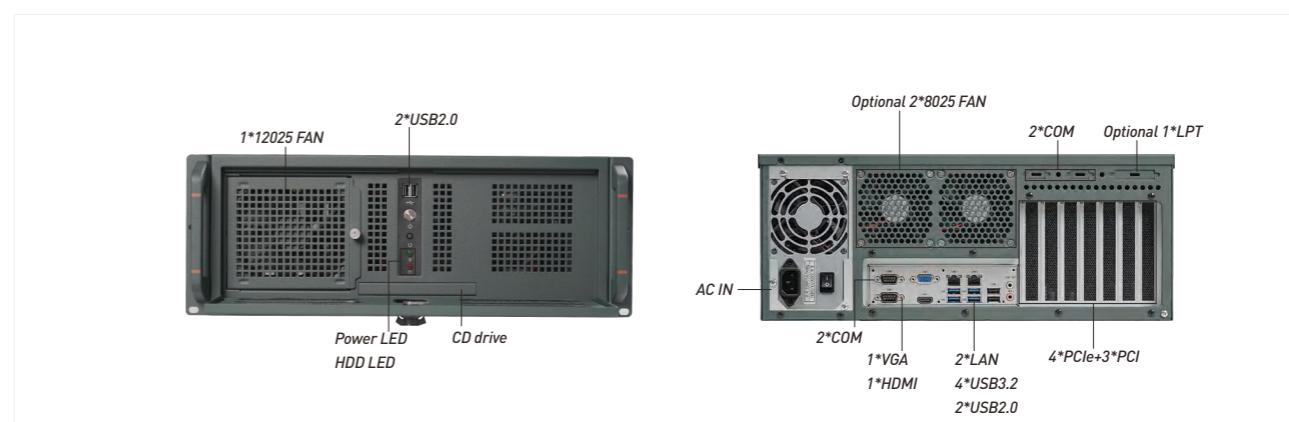
Storage Temp 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/operation(SSD);
1 grms/5~500Hz/random/operation(HDD)

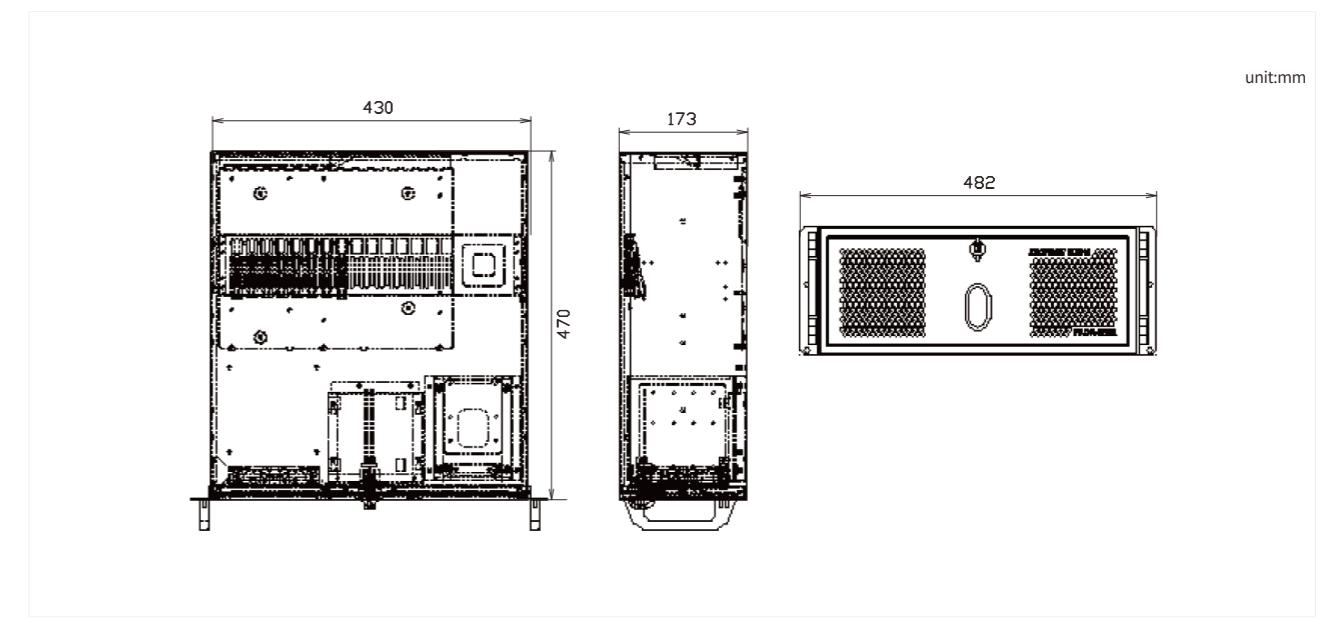
Shock 50g peak acceleration(duration 11ms, SSD);
20g peak acceleration(duration 11ms, HDD)

Certificate/EMC CE/FCC Class A, 3C

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Power
PADR-S501-971-300	Intel® Cometlake-S LGA1200 CPU, H420E PCH	2xDDR4 UDIMM, 2xLAN, 4xUSB3.2, 5xUSB2.0, 4xCOM, 1xPCIe X16, 3xPCIe X4(X2+1+1 or X4), 3x32bit PCI, 1xHDMI, 1xVGA, 1xLine out & 1xMic, 4x3.5"SATA	AC 220-230V, ATX 300W
PADR-S501-971-500			AC 100-240V, ATX 500W
PADR-S501-971-750			AC 100-240V, ATX 750W

Accessories

Standard	Amount	Optional	Optional
Screw jumper package		LGA115X, TDP 35-65W CPU wind-cooling radiator	A pair of guide rail mounting parts
Air Filter	1	LGA115X, TDP 125W CPU wind cooling radiator	8025 Dual ball bearing DC 12V fans
AC power supply cable		one 4pin to 2+6pin GPU power cable	DB25 female head parallel port cable
		SATA 7pin data cable, 420mm	DB9 male needle DIO cable

PADR-S501-980

Intel® Alder lake-S/Raptor Lake-S CPU, 2xLAN, VGA+HDMI+DP, 3xCOM, 4xUSB3.2,7xUSB2.0, 7xPCIe/PCI, 4xSATA Bay, 4U rackmount, ATX power

Key Specification

- Intel gen 12/13th Alderlake-S/Raptor Lake-S LGA1700 CPU+Q670 PCH
- Dual channel 4xDDR4 3200MHz UDIMM, up to 128GB
- Intel UHD Graphic, 1xVGA+1xHDMI+1xDP three independent display
- 1xI219LM Gig. Ethernet+1xI226V Gig. Ethernet
- 4xUSB3.2,7xUSB2.0 (two front and one built-in), Audio out and Mic
- 2xRS232/422/485, 1xRS232, optional 8-bit DIO
- 2xPCIeX16+1xPCI+4xPCIeX4
- 4x3.5 "SATA3.0 shock resistant and anti-vibration hard disk bay
- Standard 19"4U rackmount chassis with high efficiency air cooling design
- Standard PS2 ATX power supply, 300/500/750/1000W



Product Overview

PADR-S501-980 is a standard 19"4U rackmount industrial computer with an Intel Q670 chipset powered by Intel® gen 12/13th Alder lake-S/Raptor Lake-S LGA1700 series CPU. Rich functional IO, 7 PCIe/PCI expansion capabilities, excellent air cooling design, power consumption ladder ATX power supply selection, suitable for machine vision, CNC machine tools and factory production line automation and other fields.

Product Parameters

System

CPU Intel gen 12/13th Alderlake-S/Raptor Lake-S LGA1700 CPU; Q670 PCH

RAM 2*288-pin Non-ECC UDIMM , dual channel DDR4 2933MHz, 64GB max. Intel UHD Graphics, Supports DirectX 12, OpenGL 4.5

Graphics AVC/VC1/MPEG2/HEVC/VP8/JPEG.HW
HDMI:4096x2160@30Hz,VGA:1920x1200@60Hz,

LAN 1*Intel I226V,10M-2.5G,WOL;
1*Intel I219LM,10-1000M,WOL

USB 4*USB3.2 Gen1(5Gbps),5*USB2.0

Display 1*HDMI+1*VGA

Audio 1*Line out+1*Mic,Realtek ALC897

COM/others 2*RS232/422/485, 2*RS232; Optional 1*LPT

DIO 1*8-bit DIO (Optional)

Storage

Storage 4xSATA3, 6.0Gbps interface, the box is designed with 4x3.5 "and 2x2.5" a set of anti-vibration hard disk bay, 1 ultrathin DVD driver bay

Others

LED Power LED,HDD LED

Switch 1*Power SW, USB Power ,AT/ATX ,Clear CMOS ,

WDT programmable via software 1 to 255 second

OS

OS Windows 10, Windows 11,Linux Ubuntu

Expansion

Expansion 1*PCIe3.0 X16(X16) +
3*PCIe3.0 X4(X2+1+1 or X4) + 3*32 bit PCI

Power

Power&TDP AC100-240V,StandardATXPower300W,Optional500W/750W;
TDP:184.85W(i7-10700K CPU/16G DDR4/256G SSD)

Mechanical

Structure Door with lock design, SGCC steel plate, metal mold molding

Cooling Linear airflow, front 12025 FAN ,optional 2*8025 ball bearing fan

Color Granite grey

Installation Dimension (W*H*D) Mounted on 19"rack, optional mounting rail set
430*470*173mm

Weight 14 KG

Environment

Operating Temp 0°C~50°C

Storage Temp -40°C~85°C

Storage Temp 10~95%@40°C, No-condensation

Vibration 5 grms/5~500Hz/random/operation(SSD);
1 grms/5~500Hz/random/operation(HDD)

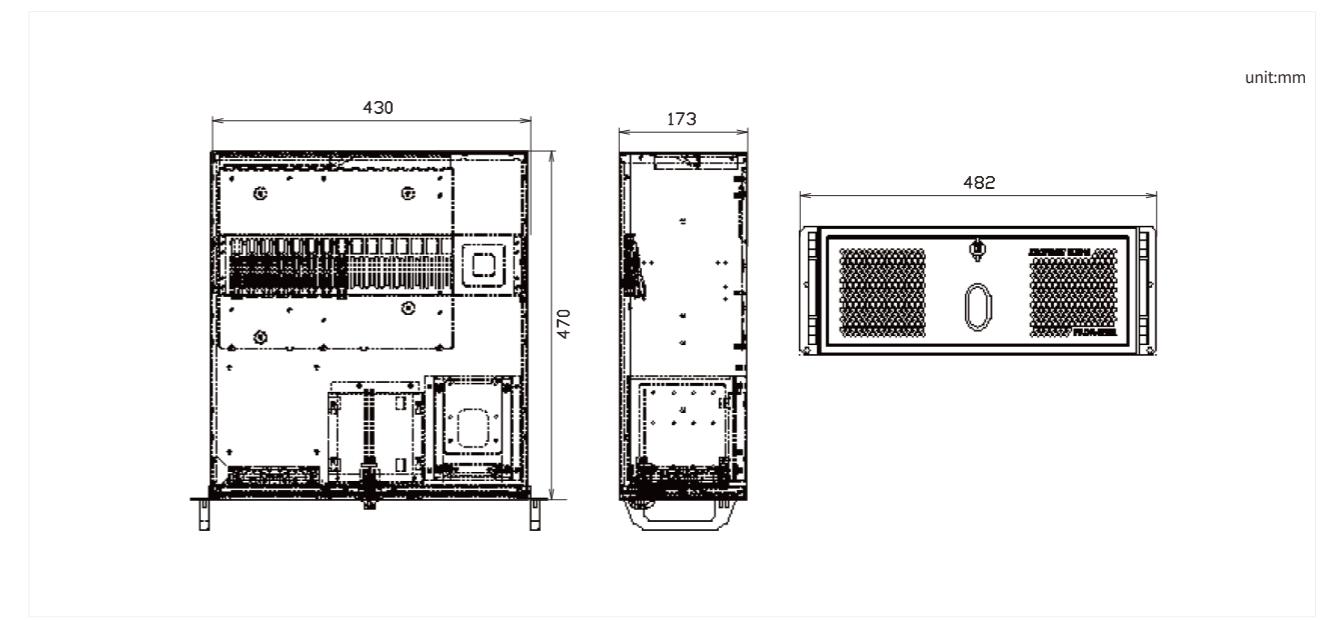
Shock 50g peak acceleration(duration 11ms,SSD);
20g peak acceleration(duration 11ms,HDD)

Certificate/EMC CE/FCC Class A,3C

I/O View



Dimensions



Ordering Information

Model	Processor	Specifications	Power
PADR-S501-980-300WP		4xDDR4 UDIMM, 2xLAN, 4xUSB3.2, 7xUSB2.0(one built-in), 3xCOM, 2xPCIe X16 (X8), 4xPCIeX4 (three are X4 s, one is X1 s), 1x32bit PCI, 1xM.2 M-Key, 1xHDMI, 1xVGA, 1xDP, 1xLine out and 1xMic, 4x3.5"SATA bay	AC 220-230V,ATX 300W
PADR-S501-980-500	Intel® Q670 PCH+Alder lake-S/Raptor Lake-S LGA1700 CPU		AC 100-240V,ATX 500W
PADR-S501-980-750			AC 100-240V,ATX 750W
PADR-S501-980-1000			AC 100-240V,ATX 1000W

Accessories

Standard	Amount	Optional	Optional
Screw jumper package		LGA1700, TDP 65W CPU wind-cooling radiator	A pair of guide rail mounting parts
Air Filter	1	LGA1700, TDP 95W CPU wind cooling radiator	8025 Dual ball bearing DC 12V fans
AC power supply cable		LGA1700, TDP 125W CPU wind cooling radiator	two 4pin to 2+6pin GPU power cable
		SATA 7pin data cable,420mm	DB9 male needle DIO cable